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Reference Manual

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Contents

Chap Intro	ter 1 duction
1.1	ARM920T Microprocessor Core
1.2	AHB to IP Bus Interfaces (AIPIs)1-
1.3	External Interface Module (EIM)
1.4	SDRAM Controller (SDRAMC)
1.5	Clock Generation Module (CGM) and Power Control Module
1.6	Two Universal Asynchronous Receiver/Transmitters (UART 1 and UART 2)
1.7	Serial Peripheral Interface (SPI)1-
1.8	Two General-Purpose 32-Bit Counters/Timers
1.9	Watchdog Timer
1.10	Real-Time Clock/Sampling Timer (RTC)
1.11	LCD Controller (LCDC)
1.12	Pulse-Width Modulation (PWM) Module
1.13	Universal Serial Bus (USB) Device
1.14	Direct Memory Access Controller (DMAC) 1-
1.15	Synchronous Serial Interface and Inter-IC Sound (SSI/I ² S) Module
1.16	Inter-IC (I ² C) Bus Module
1.17	General-Purpose I/O (GPIO) Ports
1.18	Bootstrap Mode
1.19	Power Management Features
1.20	Operating Voltage Range
1.21	Packaging
Chap Signa	ter 2 Il Descriptions and Pin Assignments
2.1	Signal and Pin Information
Chap Memo	ter 3 ory Map
3.1 3.1.1 3.1.2 3.1.3 3.1.4 3.2	Memory Space3-Memory Map3-Internal Register Space3-External Memory3-Double Map Image3-Internal Registers3-
Chap ARM	ter 4 920T Processor

4.1 4.2

4-3
4-3
4-3
4-3
4-3
4-4
4-4
4-4
4-4
4-5
4-5
4-5
4-5
4-5
4-6
4-6
4-6
4-7
4-7
4-7
1 -/
4-7
4-7
4-7
4-7
4-7
4-7 4-8 4-9
4-7 4-8 4-9
4-7 4-8 4-9 5-1 5-2
4-7 4-8 4-9
4-7 4-8 4-9 5-1 5-2
4-7 4-8 4-9 5-1 5-2
4-7 4-8 4-9 5-1 5-2
4-7 4-8 4-9 5-1 5-2
4-7 4-8 4-9 5-1 5-2 5-2
4-7 4-8 4-9 5-1 5-2 5-2
4-7 4-8 4-9 5-1 5-2 5-2
4-7 4-8 4-9 5-1 5-2 5-2 6-1 6-1 6-2
4-7 4-8 4-9 5-1 5-2 5-2 6-1 6-2 6-3
4-7 4-8 4-9 5-1 5-2 5-2 6-1 6-2 6-3
4-7 4-8 4-9 5-1 5-2 5-2 6-1 6-2 6-3
4-7 4-8 4-9 5-1 5-2 5-2 6-1 6-3 6-3
4-7 4-8 4-9 5-1 5-2 5-2 6-1 6-2 6-3

7-8
7-10
eral Size Register 0 7-10
eral Size Register 1 7-11
7-12
7-13
7-14
7-15
7-15
7-16
7-17
/-10
8-1
8-2
8-2
8-4
0.6
8-6
8-6 8-7
9-1 9-1 9-2 9-2 9-3
9-1 9-1 9-2 9-2 9-3 9-3
9-1 9-1 9-2 9-2 9-3
9-1 9-1 9-2 9-2 9-3 9-3
9-1 9-1 9-2 9-2 9-3 9-3 9-3
9-1 9-1 9-2 9-2 9-3 9-3 9-3
9-1 9-1 9-2 9-2 9-3 9-3 9-3 9-3
8-7 9-1 9-1 9-2 9-2 9-3 9-3 9-3 9-3 9-3 9-3
9-1 9-1 9-2 9-2 9-3 9-3 9-3 9-3 9-5 9-7
9-1 9-1 9-2 9-2 9-2 9-3 9-3 9-3 9-3 9-3 9-5 9-7
9-1 9-1 9-2 9-2 9-3 9-3 9-3 9-3 9-3 9-5 9-7
9-1 9-1 9-2 9-2 9-2 9-3 9-3 9-3 9-3 9-3 9-5 9-7

10.4.1	Interrupt Control Register	10-6
10.4.2	Normal Interrupt Mask Register	10-8
10.4.3	Interrupt Enable Number Register	10-9
10.4.4	Interrupt Disable Number Register	. 10-10
10.4.5	Interrupt Enable Register High and Interrupt Enable Register Low	. 10-11
10.4.5.1	Interrupt Enable Register High	10-11
10.4.5.2	Interrupt Enable Register Low	. 10-12
10.4.6	Interrupt Type Register High and Interrupt Type Register Low	. 10-13
10.4.6.1	Interrupt Type Register High	. 10-13
10.4.6.2	Interrupt Type Register Low	10-14
10.4.7	Normal Interrupt Priority Level Registers	10-14
10.4.7.1	Normal Interrupt Priority Level Register 7	. 10-15
10.4.7.2	Normal Interrupt Priority Level Register 6	10-16
10.4.7.3	Normal Interrupt Priority Level Register 5	. 10-17
10.4.7.4	Normal Interrupt Priority Level Register 4.	10-18
10.4.7.5	Normal Interrupt Priority Level Register 3	. 10-19
10.4.7.6	Normal Interrupt Priority Level Register 2	
10.4.7.7	Normal Interrupt Priority Level Register 1	10-21
10.4.7.8	Normal Interrupt Priority Level Register 0	
10.4.8	Normal Interrupt Vector and Status Register	
10.4.9	Fast Interrupt Vector and Status Register	
10.4.10	Interrupt Source Register High and Interrupt Source Register Low	
10.4.10.1	Interrupt Source Register High	
10.4.10.2	Interrupt Source Register Low	
10.4.11	Interrupt Force Register High and Interrupt Force Register Low	
10.4.11.1	Interrupt Force Register High	
10.4.11.2	Interrupt Force Register Low	
10.4.12	Normal Interrupt Pending Register High and Normal Interrupt Pending Register Low	
10.4.12.1	Normal Interrupt Pending Register High	
10.4.12.2	Normal Interrupt Pending Register Low	
10.4.13	Fast Interrupt Pending Register High and Fast Interrupt Pending Register Low	
10.4.13.1	Fast Interrupt Pending Register High	
10.4.13.2	Fast Interrupt Pending Register Low	
	M920T Processor Interrupt Controller Operation	
10.5.1	ARM920T Processor Prioritization of Exception Sources	
10.5.2	AITC Prioritization of Interrupt Sources	
10.5.3	Assigning and Enabling Interrupt Sources	
10.5.4	Enabling Interrupts Sources	
10.5.5	Typical Interrupt Entry Sequences	
10.5.6	Writing Reentrant Normal Interrupt Routines	
10.2.0	Training Reconstruct Northan Interrupt Reduction	. 10 55
Chapter External	11 Interface Module (EIM)	
11.1 Ov	erview	. 11-1

vi Freescale Semiconductor

11.2	EIM I/O Signals	11-1
11.2.1	Address Bus	11-1
11.2.2	Data Bus	11-1
11.2.3	Read/Write	11-1
11.2.4	Control Signals	11-2
11.2.4.	1 OE—Output Enable	11-2
11.2.4.2	2 EB [3:0]—Enable Bytes	11-2
11.2.4.3	B DTACK—Data Transfer Acknowledge	11-2
11.2.5	Chip Select Outputs	
11.2.5.		
11.2.5.2	Chip Select 1–Chip Select 5 ($\overline{CS1}$ – $\overline{CS5}$)	11-3
11.2.6	Burst Mode Signals	11-3
11.2.6.	BCLK—Burst Clock	11-3
11.2.6.2	2 LBA —Load Burst Address	11-3
11.2.6.3	B ECB—End Current Burst	11-3
11.3	Pin Configuration for EIM	11-3
11.4	Typical EIM System Connections	11-5
11.5	EIM Functionality	11-8
11.5.1	Configurable Bus Sizing	11-8
11.5.2	Programmable Output Generation	11-8
11.5.3	Burst Mode Operation	
11.5.4	Burst Clock Divisor	11-8
11.5.5	Burst Clock Start	11-9
11.5.6	Page Mode Emulation	11-9
11.5.7	Error Conditions	11-9
11.6	Programming Model	1-10
11.6.1	Chip Select 0 Control Registers	1-11
11.6.1.	Chip Select 0 Upper Control Register	1-11
11.6.1.2	Chip Select 0 Lower Control Register	1-12
11.6.2	Chip Select 1–Chip Select 5 Control Registers	1-12
11.6.2.	Chip Select 1–Chip Select 5 Upper Control Registers	1-12
11.6.2.2	Chip Select 1–Chip Select 5 Lower Control Registers	1-13
11.6.3	EIM Configuration Register	1-19
Chapt		
Phase	e-Locked Loop and Clock Controller	
12.1	Introduction	12_1
	Clock Sources	
12.2.1	Low Frequency Clock Source.	
12.2.1	High Frequency Clock Source	
	DPLL Output Frequency Calculation	
12.3.1	DPLL Phase and Frequency Jitter	
	MC9328MXS Power Management	
12.4.1	PLL Operation at Power-Up.	
14.7.1		14-4

12.4.2	PLL Operation at Wake-Up	12-4
12.4.3	ARM920T Processor Low-Power Modes	12-4
12.4.4	SDRAM Power Modes	12-4
12.4.5	Power Management in the Clock Controller	12-4
12.5 Pro	ogramming Model	
12.5.1	Clock Source Control Register	
12.5.2	Peripheral Clock Divider Register	
12.5.3	Programming Digital Phase Locked Loops	
12.5.3.1	MCU PLL Control Register 0.	
12.5.3.2	MCU PLL and System Clock Control Register 1	
12.5.4	Generation of 48 MHz Clocks	
12.5.4.1	System PLL Control Register 0	12-12
12.5.4.2	System PLL Control Register 1	
Chapter DMA Co		
	ntures	
13.2 Blo	ock Diagram	13-2
	nal Description	13-3
13.3.1	Big Endian and Little Endian	
13.4 Pro	ogramming Model	13-4
13.4.1	General Registers	
13.4.1.1	DMA Control Register	13-8
13.4.1.2	DMA Interrupt Status Register	13-9
13.4.1.3	DMA Interrupt Mask Register	13-10
13.4.1.4	DMA Burst Time-Out Status Register	13-11
13.4.1.5	DMA Request Time-Out Status Register	13-12
13.4.1.6	DMA Transfer Error Status Register	
13.4.1.7	DMA Buffer Overflow Status Register	13-14
13.4.1.8	DMA Burst Time-Out Control Register	13-15
13.4.2	2D Memory Registers (A and B)	13-16
13.4.2.1	W-Size Registers.	13-16
13.4.2.2	X-Size Registers	13-17
13.4.2.3	Y-Size Registers	
13.4.3	Channel Registers	13-18
13.4.3.1	Channel Source Address Register	13-19
13.4.3.2	Destination Address Registers	13-20
13.4.3.3	Channel Count Registers	13-21
13.4.3.4	Channel Control Registers	
13.4.3.5	Channel Request Source Select Registers	
13.4.3.6	Channel Burst Length Registers	
13.4.3.7	Channel Request Time-Out Registers	13-27
13.4.3.8	Channel 0 Bus Utilization Control Register	
13.5 DN	AA Request Table	13-30

viii Freescale Semiconductor

Chapter 14 Watchdog Timer Module

14.1	General Overview	14-1
14.2	Watchdog Timer Operation	14-1
14.2.1	Timing Specifications	
14.2.2	Watchdog During Reset	14-2
14.2.2.	Power-On Reset	14-2
14.2.2.		
14.3	Watchdog After Reset	14-2
14.3.1	Initial Load	14-2
14.3.2	Countdown	14-2
14.3.3	Reload	
14.3.4	Time-Out.	14-3
14.3.5	Halting the Counter	14-3
14.4	Watchdog Control	
14.4.1	Interrupt Control	14-3
14.4.2	Reset Sources	14-3
14.5	State Machine	14-4
14.6	Watchdog Timer I/O Signals	14-5
14.7	Programming Model	
14.7.1	Watchdog Control Register	14-6
14.7.2	Watchdog Service Register	
14.7.3	Watchdog Status Register	
Chan	ter 15	
	l Peripheral Interface Module (SPI 1)	
	•	1.5.1
15.1	SPI Block Diagram	
15.2	Operation	
15.2.1	Phase and Polarity Configurations	
15.2.2	Signals	
15.2.3	Pin Configuration	
15.3	Programming Model	
15.3.1	Receive (RX) Data Register	
15.3.2	Transmit (TX) Data Register	
15.3.3	Control Register	
15.3.4	Interrupt Control/Status Register	
15.3.5	Test Register	
15.3.6	Sample Period Control Register	
15.3.7	DMA Control Register	
15.3.8	Soft Reset Register	5-14

Chapter 16 LCD Controller

16.1	Introduction	16-1
16.2	Features	16-1
16.3	LCDC Operation	16-2
16.3.1	LCD Screen Format	16-2
16.3.2	Panning	16-3
16.3.3	Display Data Mapping	16-3
16.3.4	Black-and-White Operation	
16.3.5	Gray-Scale Operation	16-7
16.3.6	Color Generation.	16-8
16.3.7	Frame Rate Modulation Control (FRC)	16-10
16.3.8	Panel Interface Signals and Timing	16-11
16.3.8.	Pin Configuration for LCDC	16-11
16.3.8.2	Passive Matrix Panel Interface Signals	16-12
16.3.8.	Passive Panel Interface Timing	16-13
16.3.9	8 bpp Mode Color STN Panel	16-14
16.3.9.	Active Matrix Panel Interface Signals	16-14
16.3.9.2	2 Active Panel Interface Timing	16-16
16.4	Programming Model	16-18
16.4.1	Screen Start Address Register	16-20
16.4.2	Size Register	16-21
16.4.3	Virtual Page Width Register	16-22
16.4.4	Panel Configuration Register	
16.4.5	Horizontal Configuration Register	16-26
16.4.6	Vertical Configuration Register	
16.4.7	Panning Offset Register	16-28
16.4.8	LCD Cursor Position Register	16-29
16.4.9	LCD Cursor Width Height and Blink Register	16-30
16.4.10	LCD Color Cursor Mapping Register	16-31
16.4.11	Sharp Configuration 1 Register	16-32
16.4.12	PWM Contrast Control Register	16-34
16.4.13	Refresh Mode Control Register	16-35
16.4.14	DMA Control Register	16-36
16.4.15	Interrupt Configuration Register	16-37
16.4.16	Interrupt Status Register	16-38
16.4.17		
16.4.17	One Bit/Pixel Monochrome Mode	16-39
16.4.17	7.2 Four Bits/Pixel Gray-Scale Mode	16-39
16.4.17		
16.4.17	Eight Bits/Pixel Passive Matrix Color Mode	16-40
16.4.17		
16.4.17		
16.4.17	7.7 Twelve Bits/Pixel and Sixteen Bits/Pixel Active Matrix Color Mode	16-42

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Chapter 17 Pulse-Width Modulator (PWM)

17.1	Introduction	17-1
17.2	PWM Signals	17-1
17.2.1	Clock Signals	
17.2.2	Pin Configuration for PWM	
17.3	PWM Operation	
17.3.1	Playback Mode	
17.3.2	Tone Mode	
17.3.3	Digital-to-Analog Converter (D/A) Mode	17-3
17.4	Programming Model	
17.4.1	PWM Control Register	
17.4.1.	1 HCTR and BCTR Bit Description	17-6
17.4.2	PWM Sample Register	
17.4.3	PWM Period Register	
17.4.4	PWM Counter Register	
Chapt Real-	ter 18 Time Clock (RTC)	
18.1	Operation	18-2
18.1.1	Prescaler and Counter	18-2
18.1.2	Alarm	18-3
18.1.3	Sampling Timer	18-3
18.1.4	Minute Stopwatch	18-3
18.2	Programming Model	18-4
18.2.1	RTC Days Counter Register	
18.2.2	RTC Hours and Minutes Counter Register	18-5
18.2.3	RTC Seconds Counter Register	
18.2.4	RTC Day Alarm Register	
18.2.5	RTC Hours and Minutes Alarm Register	18-9
18.2.6	RTC Seconds Alarm Register	
18.2.7	RTC Control Register	
18.2.8	RTC Interrupt Status Register	
18.2.9	RTC Interrupt Enable Register	
18.2.10	Stopwatch Minutes Register	8-15
Chapt SDRA	ter 19 IM Memory Controller	
19.1	Features	19-1
19.2	Block Diagram	19-2
19.3	Functional Overview.	
19.3.1	SDRAM Command Controller	
19.3.2		19-3

19.3.3	Row and Column Address Multiplexer	. 19-3
19.3.4	Data Aligner and Multiplexer	
19.3.5	Configuration Registers	. 19-3
19.3.6	Refresh Request Counter	
19.3.7	Powerdown Timer	
19.3.8	DMA Operation with the SDRAM Controller	. 19-4
19.3.9	SDCLK—SDRAM Clock.	
19.3.10	SDCKE0, SDCKE1—SDRAM Clock Enables	
19.3.11	CSD0, CSD1—SDRAM Chip-Select.	. 19-5
19.3.12	DQ [31:0]—Data Bus (Internal)	
19.3.13	MA [11:0]—Multiplexed Address Bus	
19.3.14	SDBA [4:0], SDIBA [3:0]—Non-Multiplexed Address Bus	
19.3.15	DQM3, DQM2, DQM1, DQM0—Data Qualifier Mask	
19.3.16	SDWE—Write Enable	
19.3.17	RAS—Row Address Strobe	
19.3.18	CAS—Column Address Strobe	
19.3.19	RESET SF—Reset or Powerdown	
19.3.20	Pin Configuration for SDRAMC	
19.4 Pro	ogramming Model	
19.4.1	SDRAM Control Registers	
19.4.2	SDRAM Reset Register	
19.4.3	Miscellaneous Register	
19.5 Op	erating Modes	
19.5.1	SDRAM and SyncFlash Command Encoding	
19.5.2	Normal Read/Write Mode (SMODE = 000)	
19.5.3	Precharge Command Mode (SMODE = 001)	
19.5.4	Auto-Refresh Mode (SMODE = 010)	19-25
19.5.5	Set Mode Register Mode (SMODE = 011)	
19.5.6	SyncFlash Load Command Mode	
19.5.7	SyncFlash Program Mode	19-27
19.6 Ge	neral Operation	19-28
19.6.1	Address Multiplexing	19-29
19.6.1.1	Multiplexed Address Bus	19-29
19.6.1.2	Non-Multiplexed Address Bus	19-31
19.6.1.3	Bank Addresses	19-31
19.6.2	Refresh	19-32
19.6.3	Self-Refresh	19-33
19.6.3.1	Self-Refresh During RESET_IN	19-33
19.6.3.2	Self-Refresh During Low-Power Mode	19-33
19.6.3.3	Powerdown Operation During Reset and Low-Power Modes	
19.6.4	Clock Suspend Low-Power Mode	
19.6.4.1	Powerdown (Precharge Powerdown)	19-35
19.6.4.2	Clock Suspend (Active Powerdown)	
19.6.4.3	Refresh During Powerdown or Clock Suspend	
19.7 SD	RAM Operation	

xii Freescale Semiconductor

1070	SDRAM Selection	1) 51
19.7.2	Configuring Controller for SDRAM Memory Array	19-38
19.7.2.	1 CAS Latency	19-38
19.7.2.		
19.7.2.	Row-to-Column Delay	19-38
19.7.2.		
19.7.2.		
19.7.2.		
19.7.3	SDRAM Reset Initialization	
19.7.4	Mode Register Programming	
19.7.5	Mode Register Programming Examples	
19.7.5.		
19.7.5.		
19.7.6	SDRAM Memory Refresh	
19.8	SyncFlash Operation	
19.8.1	SyncFlash Reset Initialization	
19.8.2	SyncFlash Mode Register Programming	
19.8.3	Booting From SyncFlash	
19.8.4	SyncFlash Configuration	
19.8.5	SyncFlash Programming	
19.8.6	Clock Suspend Timer Use with SyncFlash	
19.8.7	Powerdown Operation with SyncFlash	
19.9	Deep Powerdown Operation with SyncFlash	
Gene	ter 20 ral-Purpose Timers Operation	20.2
20.1 20.1.1	Operation	
ZU I I	•	
	Pin Configuration for General-Purpose Timers	20-2
20.2	Pin Configuration for General-Purpose Timers	20-2
20.2 20.2.1	Pin Configuration for General-Purpose Timers Programming Model	20-2 20-3 20-3
20.2 20.2.1 20.2.2	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2.	20-2 20-3 20-3
20.2 20.2.1 20.2.2 20.2.3	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2.	20-2 20-3 20-5 20-6
20.2 20.2.1 20.2.2 20.2.3 20.2.4	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2.	20-2 20-3 20-5 20-6 20-7
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2. Timer Counter Registers 1 and 2.	20-2 20-3 20-3 20-5 20-6 20-7 20-8
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2.	20-2 20-3 20-3 20-5 20-6 20-7 20-8
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2. Timer Counter Registers 1 and 2. Timer Status Registers 1 and 2. Timer Status Registers 1 and 2.	20-2 20-3 20-3 20-5 20-6 20-7 20-8
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2. Timer Counter Registers 1 and 2. Timer Status Registers 1 and 2.	20-2 20-3 20-3 20-5 20-6 20-7 20-8
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap Unive	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2. Timer Counter Registers 1 and 2. Timer Status Registers 1 and 2. Timer Status Registers 1 and 2.	20-2 20-3 20-3 20-5 20-6 20-8 20-9
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap Unive	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2. Timer Counter Registers 1 and 2. Timer Status Registers 1 and 2.	20-2 20-3 20-3 20-5 20-6 20-7 20-8 20-9
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap Unive	Pin Configuration for General-Purpose Timers Programming Model. Timer Control Registers 1 and 2. Timer Prescaler Registers 1 and 2. Timer Compare Registers 1 and 2. Timer Capture Registers 1 and 2. Timer Counter Registers 1 and 2. Timer Status Registers 1 and 2. Tersal Asynchronous Receiver/Transmitters (UART) Modules Introduction.	20-2 20-3 20-5 20-6 20-8 20-9
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap Unive 21.1 21.2 21.2.1	Pin Configuration for General-Purpose Timers Programming Model Timer Control Registers 1 and 2 Timer Prescaler Registers 1 and 2 Timer Compare Registers 1 and 2 Timer Capture Registers 1 and 2 Timer Counter Registers 1 and 2 Timer Status Registers 1 and 2 Timer Status Registers 1 and 2 Inter Status Registers 1 and 2 Introduction Features Module Interface	20-2 20-3 20-5 20-6 20-8 20-9
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap Unive 21.1 21.2 21.2.1 21.2.2	Pin Configuration for General-Purpose Timers Programming Model Timer Control Registers 1 and 2 Timer Prescaler Registers 1 and 2 Timer Compare Registers 1 and 2 Timer Capture Registers 1 and 2 Timer Counter Registers 1 and 2 Timer Status Registers 1 and 2 Timer Status Registers 1 and 2 Inter 21 Persal Asynchronous Receiver/Transmitters (UART) Modules Introduction. Features	20-2 20-3 20-5 20-6 20-7 20-8 20-9
20.2 20.2.1 20.2.2 20.2.3 20.2.4 20.2.5 20.2.6 Chap	Pin Configuration for General-Purpose Timers Programming Model Timer Control Registers 1 and 2 Timer Prescaler Registers 1 and 2 Timer Compare Registers 1 and 2 Timer Capture Registers 1 and 2 Timer Counter Registers 1 and 2 Timer Status Registers 1 and 2 Timer Status Registers 1 and 2 Timer Status Registers 1 and 2 Inter 21 Persal Asynchronous Receiver/Transmitters (UART) Modules Introduction Features Module Interface UART Pin Configuration	20-2 20-3 20-5 20-6 20-7 20-8 21-1 21-1 21-2 21-3 21-4

21.4.1	RTS—UART Request To Send	. 21-5
21.4.2	RTS Edge Triggered Interrupt	. 21-6
21.4.3	DTR—Data Terminal Ready	. 21-6
21.4.4	DTR Edge Triggered Interrupt	. 21-7
21.4.5	DSR—Data Set Ready	. 21-7
21.4.6	DCD—Data Carrier Detect.	. 21-7
21.4.7	RI—Ring Indicator	. 21-7
21.4.8	CTS—Clear To Send	
21.4.9	Programmable CTS Deassertion.	
21.4.10	TXD—UART Transmit	
21.4.11	RXD—UART Receive	
21.5 Sub	p-Block Description	. 21-9
21.5.1	Transmitter	
21.5.2	Transmitter FIFO Empty Interrupt Suppression	
21.5.3	Receiver	
21.5.4	Idle Line Detect	
21.5.4.1	Idle Condition Detect Configuration	
21.5.5	Receiver Wake	
21.5.6	Receiving a BREAK Condition	
21.5.7	Vote Logic	
21.5.8	Binary Rate Multiplier (BRM)	
21.5.9	Baud Rate Automatic Detection Logic	
21.5.9.1	Baud Rate Automatic Detection Protocol.	
21.5.10	Escape Sequence Detection	
21.6 Infi	rared Interface	
	gramming Model	
21.7.1	UART Receiver Registers	
21.7.2	UART Transmitter Registers	
21.7.3	UART Control Register 1	
21.7.4	UART Control Register 2	
21.7.5	UART Control Register 3	
21.7.5.1	UART1 Control Register 3	
21.7.5.2	UART2 Control Register 3	
21.7.6	UART Control Register 4	
21.7.7	UART FIFO Control Registers	
21.7.8	UART Status Register 1	
21.7.9	UART Status Register 2	
21.7.10	UART Escape Character Registers	
21.7.11	UART Escape Timer Registers.	
21.7.12	UART BRM Incremental Registers	
21.7.13	UART BRM Modulator Registers	
21.7.14	UART Baud Rate Count Registers	
21.7.15	UART BRM Incremental Preset Registers 1–4	
21.7.16	UART BRM Modulator Preset Registers 1–4	
21.7.17	UART Test Register 1	
	5	

xiv Freescale Semiconductor

21.8	UART Operation in Low-Power System States	21-52
Chap USB	ter 22 Device Port	
22.1	Introduction	
22.1.1	Features	
22.2	Module Components	
22.2.1	Universal Serial Bus Device Controller	
22.2.2	Synchronization and Transaction Decode	
22.2.3	Endpoint FIFO Architecture	
22.2.4	Control Logic	
22.2.5	USB Transceiver Interface	
22.2.6	Signal Description	
22.2.7	Pin Configuration for USB	
22.3	Programming Model	
22.3.1	USB Frame Register	
22.3.2	USB Specification Register	
22.3.3	USB Status Register	
22.3.4	USB Control Register	22-11
22.3.5	USB Descriptor RAM Address Register	22-13
22.3.6	USB Descriptor RAM/Endpoint Buffer Data Register	22-14
22.3.7	USB Interrupt Register	
22.3.8	USB Interrupt Mask Register	22-17
22.3.9	USB Enable Register	
22.3.10	Endpoint n Status/Control Registers	22-19
22.3.11	Endpoint n Interrupt Status Registers	22-20
22.3.12	Endpoint n Interrupt Mask Register	22-23
22.3.13	Endpoint n FIFO Data Registers	22-25
22.3.14	Endpoint n FIFO Status Registers	22-26
22.3.15	Endpoint n FIFO Control Registers	22-28
22.3.16	USB Endpoint n Last Read Frame Pointer Registers	22-30
22.3.17	USB Endpoint n Last Write Frame Pointer Registers	22-31
22.3.18	B Endpoint n FIFO Alarm Registers	22-32
22.3.19	Endpoint n FIFO Read Pointer Registers	22-33
22.3.20	Endpoint n FIFO Write Pointer Registers	22-34
22.4	Programmer's Reference	22-34
22.5	Device Initialization	22-35
22.5.1	Configuration Download	22-36
22.5.1.		
22.5.1.		
22.5.1.	•	
22.5.1.		
22.6	Exception Handling	
22.6.1	Unable to Complete Device Request	
	•	

ΧV

Freescale Semiconductor

22.6.2	Aborted Device Request	22-38			
22.6.3	Unable to Fill or Empty FIFO Due to Temporary Problem				
22.6.4	Catastrophic Error				
22.7 Da	ata Transfer Operations	22-39			
22.7.1	USB Packets	22-39			
22.7.1.1	Short Packets	22-39			
22.7.1.2	Sending Packets	22-40			
22.7.1.3	Receiving Packets	22-40			
22.7.1.4	Programming the FIFO Controller	22-41			
22.7.2	USB Transfers	22-41			
22.7.2.1	Data Transfers to the Host	22-41			
22.7.2.2	Data Transfers to the Device	22-42			
22.7.3	Control Transfers	22-42			
22.7.4	Bulk Traffic	22-42			
22.7.4.1	Bulk OUT	22-42			
22.7.4.2	Bulk IN	22-43			
22.7.5	Interrupt Traffic	22-43			
22.7.6	Isochronous Operations	22-43			
22.7.6.1	Isochronous Transfers in a Nutshell	22-43			
22.7.6.2	The SYNCH_FRAME Standard Request	22-44			
22.8 Int	terrupt Services	22-44			
22.8.1	USB General Interrupts	22-44			
22.8.1.1	MSOF—Missed Start-of-Frame	22-44			
22.8.1.2	SOF—Start-of-Frame	22-44			
22.8.1.3	RESET_STOP—End of USB Reset Signaling	22-44			
22.8.1.4	RESET_START—Start of USB Reset Signaling	22-45			
22.8.1.5	WAKEUP—Resume (Wakeup) Signaling Detected				
22.8.1.6	SUSP—USB Suspended				
22.8.1.7	FRAME_MATCH—Match Detected in USB_FRAME Register	22-45			
22.8.1.8	CFG_CHG—Host Changed USB Device Configuration				
22.8.2	Endpoint Interrupts				
22.8.2.1	FIFO_FULL	22-45			
22.8.2.2	FIFO_EMPTY				
22.8.2.3	FIFO_ERROR				
22.8.2.4	FIFO_HIGH				
22.8.2.5	FIFO_LOW				
22.8.2.6	EOT—End of Transfer				
22.8.2.7	DEVREQ—Device Request				
22.8.2.8	MDEVREQ—Multiple Device Request.				
22.8.2.9	EOF—End of Frame.				
22.8.3	Interrupts, Missed Interrupts, and the USB				
22.8.3.1	SOF				
22.8.3.2	CFG_CHG				
22.8.3.3	EOT				
22.8.3.4	DEVREQ	22-47			

xvi Freescale Semiconductor

22.9	Reset Operation.	22-47
22.9.1	Hard Reset	22-48
22.9.2	USB Software Reset	22-48
22.9.3	UDC Reset	22-48
22.9.4	USB Reset Signaling	22-48
Chan	ter 23	
I ² C M	odule	
23.1	Overview	. 23-1
23.2	Interface Features	. 23-1
23.3	I ² C System Configuration	. 23-2
23.4	I ² C Protocol	. 23-3
23.4.1	Clock Synchronization	
23.4.2	Arbitration Procedure	. 23-5
23.4.3	Handshaking	. 23-5
23.4.4	Clock Stretching	
23.5	Pin Configuration for I ² C	
23.6	Programming Model	
23.6.1	I ² C Address Register	
23.6.2	I ² C Frequency Divider Register	. 23-8
23.6.3	I ² C Control Register	23-10
23.6.4	I ² C Status Register	
23.6.5	I ² C Data I/O Register	
23.7	I ² C Programming Examples	23-13
23.7.1	Initialization Sequence	
23.7.2	Generation of START	23-14
23.7.3	Post-Transfer Software Response	23-14
23.7.4	Generation of STOP	
23.7.5	Generation of Repeated START	
23.7.6	Slave Mode	
23.7.7	Arbitration Lost	23-15
O b an	to:: 04	
	ter 24 hronous Serial Interface (SSI)	
24.1	Introduction	. 24-1
24.2	SSI Architecture	
24.2.1	SSI Clocking.	
24.2.1.		
24.2.1.		
24.2.1.	SSI Clock and Frame Sync Generation	
24.2.3	Pin Configuration for SSI	
24.2.3		
24.2.3. 24.3	Programming Model	
24.3.1	SSI Transmit Data Register	
∠¬.J.1	551 Transmit Data Register	. 44-0

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor xvii

24.3.2	SSI Transmit FIFO Register	24-9
24.3.3	SSI Transmit Shift Register	
24.3.4	SSI Receive Data Register	
24.3.5	SSI Receive FIFO Register	24-12
24.3.6		
24.3.7	SSI Control/Status Register	24-15
24.3.7.	g .	
24.3.8	SSI Transmit Configuration Register	24-21
24.3.9	SSI Receive Configuration Register	24-23
24.3.10		
24.3.10		
24.3.1		
24.3.12	2 SSI FIFO Control/Status Register	24-31
24.3.13		
24.4	SSI Data and Control Pins	
24.4.1	SSI TXDAT, Serial Transmit Data	24-35
24.4.2	SSI RXDAT, Serial Receive Data	24-35
24.4.3	SSI TXCLK, Serial Transmit Clock	24-35
24.4.4	SSI RXCLK, Serial Receive Clock	24-35
24.4.5	SSI TXFS, Serial Transmit Frame Sync	
24.4.6		
24.5	SSI Operating Modes	
24.5.1	Normal Mode	24-39
24.5.1.	Normal Mode Transmit	24-39
24.5.1.	Normal Mode Receive	24-39
24.5.2	Network Mode	24-41
24.5.2.	1 Network Mode Transmit	24-41
24.5.2.	Network Mode Receive	24-42
24.6	Gated Clock Mode	24-43
24.7	External Frame and Clock Operation	24-44
24.8	SSI Reset and Initialization Procedure	24-44
	ter 25 Module and I/O Multiplexer (IOMUX)	
25.1	General Description	25-1
25.2	GPIO Module Overview.	
25.2.1	GPIO Module Features	
25.2.2	Interrupts	
25.2.3	GPIO Signal Description	
25.3	GPIO Module Block Diagram	
25.4	Pin Configuration for GPIO	
25.5	Programming Model	
25.5.1	Data Direction Registers	
25.5.2	Output Configuration Registers	
	1 0 0	

xviii Freescale Semiconductor

25.5.2.1	Output Configuration Register 1	25-9
25.5.2.2	Output Configuration Register 2	
25.5.3	Input Configuration Registers	25-11
25.5.3.1	Input Configuration Register A1	25-11
25.5.3.2	Input Configuration Register A2	25-12
25.5.3.3	Input Configuration Register B1	25-13
25.5.3.4	Input Configuration Register B2	25-14
25.5.4	Data Registers	25-15
25.5.5	GPIO In Use Registers	25-16
25.5.6	Sample Status Registers	25-17
25.5.7	Interrupt Configuration Registers	25-18
25.5.7.1	Interrupt Configuration Register 1	25-18
25.5.7.2	Interrupt Configuration Register 2	25-19
25.5.8	Interrupt Mask Registers	25-20
25.5.9	Interrupt Status Registers	25-21
25.5.10	General Purpose Registers	25-22
25.5.11	Software Reset Registers	25-23
25.5.12	Pull Up Enable Registers	25-24

Freescale Semiconductor xix

About This Book

This reference manual describes the features and operation of the MC9328MXS (i.MXS) microprocessor, It provides the details of how to initialize, configure, and program the MC9328MXS. The manual presumes basic knowledge of ARM920TTM architecture.

Audience

The MC9328MXS Reference Manual is intended to provide a design engineer with the necessary data to successfully integrate the MC9328MXS into a wide variety of applications. It is assumed that the reader has a good working knowledge of the ARM920T processor. For programming information about the ARM920T processor, see the documents listed in the Suggested Reading section of this preface.

Organization

The MC9328MXS Reference Manual is organized into chapters that cover the operation and programming of the i.MXS device. Summaries of the chapters follow.

Chapter 1	Introduction: This chapter contains a device feature list, overview of system modules, and system block diagrams.
Chapter 2	Signal Descriptions and Pin Assignments: This chapter's content has been moved to the MC9328MXS Data Sheet.
Chapter 3	Memory Map: This chapter summarizes the memory organization, programming information and a listing of all of the registers in the MC9328MXS.
Chapter 4	ARM920T Processor: This chapter provides a high-level overview of the ARM920T processor including the ARM9 Thumb [®] instruction set.
Chapter 5	Embedded Trace Macrocell (ETM): This chapter provides a summary of the operation and features of the ARM Embedded Trace Macrocell TM .
Chapter 6	Reset Module: The reset module processes of all of the system reset signals required by the MC9328MXS. This chapter gives a detailed description of the reset module and associated timing and signals.
Chapter 7	AHB to IP Bus Interface (AIPI): This chapter provides an overview of the R-AHB to IP bus interface. The AIPI module in the MC9328MXS acts as an interface between the R-AHB (Reduced ARM Advanced High-performance Bus) and lower bandwidth peripherals.
Chapter 8	System Control: This chapter describes the operation of and programming models for the system multiplex control, peripheral control, ID register, and I/O drive control registers.
Chapter 9	Bootstrap Mode Operation: The operation of bootstrap models is described in detail in

using the UART controller.

this chapter. This chapter describes programming information necessary to allow a system to initialize a target system and download a program or data to the target system's RAM

Freescale Semiconductor xxi

Chapter 10	Interrupt Controller (AITC): This chapter provides a description and operational considerations for interrupt controller operation to perform interrupt masking, priority support, and hardware acceleration of normal interrupts.	
Chapter 11	External Interface Module (EIM): This chapter describes the external interface module and shows how the module handles the interface to devices external to the MC9328MXS, including generation of chip selects for external peripherals and memory.	
Chapter 12	Phase-Locked Loop and Clock Controller: This chapter provides detailed information about the operation and programming of the clock generation module as well as the recommended circuit schematics for external clock circuits. It also describes and provides programming information about the operation of the power control module and the system power states.	
Chapter 13	DMA Controller (DMAC): This chapter describes the operation of the direct memory access controller contained in the MC9328MXS. The DMA controller provides two memory channels and four I/O channels to support a wide variety of DMA operations.	
Chapter 14	Watchdog Timer Module: The operation of the watchdog timer module is described in this chapter. It includes information of how the watchdog timer protects against system failures by providing a method of escaping from unexpected events or programming errors.	
Chapter 15	Serial Peripheral Interface Module (SPI 1) : The programming and operation of the serial peripheral interface module (SPI 1) is described in this chapter.	
Chapter 16	LCD Controller (LCDC): This chapter describes the operation and programming of the liquid crystal display controller, which provides display data for external LCD drivers or for an LCD panel.	
Chapter 17	Pulse-Width Modulator (PWM): This chapter describes the operation and configuration of the pulse-width modulator. Programming information is also provided.	
Chapter 18	Real-Time Clock (RTC): This chapter describes the operation of the real-time clock module, which is composed of a prescaler, time-of-day (TOD) clock, TOD alarm, programmable real-time interrupt, watchdog timer, and minute stopwatch as well as control registers and bus interface hardware.	
Chapter 19	SDRAM Memory Controller (SDRAMC): The operation and programming of the SDRAM controller is described in this chapter. This module provides a glueless interface to 16-bit or 32-bit synchronous DRAM.	
Chapter 20	General-Purpose Timers: This chapter describes the two 16-bit timers that can be used as both watchdogs and alarms.	
Chapter 21	Universal Asynchronous Receiver/Transmitters (UART): This chapter describes the capabilities and operation of the three UARTs. It also discusses how to configure and program the UART modules.	
Chapter 22	USB Device Port: This chapter provides configuration, interface description and detailed programming information for designers to achieve the optimum performance from the USB device.	
Chapter 23	I²C Module: This chapter describes the I ² C module of the MC9328MXS including I ² C protocol, clock synchronization, and the registers in the I ² C programming mode.	
Chapter 24	Synchronous Serial Interface (SSI): This chapter presents the two Synchronous Serial Interface modules and discusses the architecture, programming model, operating modes, and initialization of the SSI.	

MC9328MXS Reference Manual, Rev. 1

xxii Freescale Semiconductor

Chapter 25

GPIO and **I/O** Multiplexer (IOMUX): This chapter covers all GPIO lines found in the MC9328MXS. Because each pin is individually configurable, a detailed description of the operation is provided.

Document Revision History

Table 0-1 includes technical content changes made for this revision.

Table 0-1. Revision History

Location	Description of Change
Chapter 2	Removed Signal Description and Signal Multiplexing table and placed into the Data Sheet.
Chapter 9 Boot: Section 9.1, "Operation," on page 9-1	Made changes to the first paragraph in the Operation section, adding information regarding Ignore RTS and keep CTS always active.
Chapter 10 AITC: Section 10.3, "AITC Inter- rupt Controller Signals," on page 10-3	Added third paragraph explaining that some signals are shown with overbars to represent the logic inside the chip. However, all asserted interrupts result in the associated bit being a 1 in the Interrupt Source Registers.
Chapter 19 SDRAM: Section 19.7.2.6, "Memory Configuration Examples," on page 19-39	SDRAM chapter. Added note following first paragraph regarding examples following the JEDEC standards.
Chapter 21 UART: Section 21.5.2, "Transmit- ter FIFO Empty Interrupt Suppression," on page 21-11, and Section 21.7.7, "UART FIFO Control Registers," on page 21-38	 Added new paragraph and table following bulleted list. Paragraph explains the conditions of when an interrupt is asserted. The new bulleted list provides the conditions to avoid the TxFIFO being overwritten. Added content to TXTL Bit 15–10 description.
Chapter 22 USB: Section 22.5.1, "Configura- tion Download," on page 22-36	Added last three sentences to first paragraph of the Configuration Download.
Chapter 22 USB Table 22-2 on page 22-2	USB Chapter. Added USB Specific Interrupt table.
Chapter 23 I ² C: Section 23, "I ² C Module," on page 23-1Section 23.6, "Programming Model," on page 23-6 and associated registers	Changed I ² C module's register addresses from \$BA +0x, to 0x00217 within the Memory Map table as well as each individual register table.

Freescale Semiconductor xxiii

Suggested Reading

The following documents are required for a complete description of the MC9328MXS and are necessary to design properly with the device. Especially for those not familiar with the ARM920T processor or previous DragonBall products, the following documents will be helpful when used in conjunction with this manual.

ARM Architecture Reference Manual (ARM Ltd., order number ARM DDI 0100)

ARM9DT1 Data Sheet Manual (ARM Ltd., order number ARM DDI 0029)

ARM Technical Refines Manual (ARM Ltd., order number ARM DDI 0151C)

EMT9 Technical Reference Manual (ARM Ltd., order number DDI O157E)

MC9328MXS Product Brief (order number MC9328MXSP/D)

MC9328MXS Data Sheet (order number MC9328MXS/D)

The manuals may be found at the Motorola Semiconductors World Wide Web site at http://www.motorola.com/semiconductors. These documents may be downloaded directly from the World Wide Web site, or printed versions may be ordered. The World Wide Web site also may have useful application notes.

Conventions

This reference manual uses the following conventions:

- OVERBAR is used to indicate a signal that is active when pulled low: for example, RESET.
- Logic level one is a voltage that corresponds to Boolean true (1) state.
- Logic level zero is a voltage that corresponds to Boolean false (0) state.
- To set a bit or bits means to establish logic level one.
- To *clear* a bit or bits means to establish logic level zero.
- A signal is an electronic construct whose state conveys or changes in state convey information.
- A pin is an external physical connection. The same pin can be used to connect a number of signals.
- Asserted means that a discrete signal is in active logic state.
 - Active low signals change from logic level one to logic level zero.
 - Active high signals change from logic level zero to logic level one.
- Negated means that an asserted discrete signal changes logic state.
 - Active low signals change from logic level zero to logic level one.
 - Active high signals change from logic level one to logic level zero.
- LSB means *least significant bit* or *bits*, and MSB means *most significant bit* or *bits*. References to low and high bytes or words are spelled out.
- Numbers preceded by a percent sign (%) are binary. Numbers preceded by a dollar sign (\$) or 0x are hexadecimal.

Definitions, Acronyms, and Abbreviations

The following list defines acronyms and abbreviations used in this document.

ADC analog-to-digital converter

AFE analog front end

API application programming interface

BCD binary coded decimal

BER bit error ratio

CGM clock generation module CRC cyclic redundancy check

CSIC complex instruction set computer

DAC digital-to-analog converter
DDR RAM double data rate RAM
DMA direct memory access

DRAM dynamic random access memory

FEC forward error correction

FIFO first in first out

GPIO general purpose input/output

I/O Input/Output

ICE in-circuit emulation

IrDa infrared

JTAG joint test action group MAP mold array process

MAPBGA mold array process ball grid array
MIPS million instructions per second

PLL phase locked loop

PWM pulse-width modulator

RTC real-time clock

SIM system integration module

SDRAM synchronous dynamic random access memory

SPI serial peripheral interface

SRAM static random access memory

TQFP thin quad flat pack

UART universal asynchronous receiver/transmitter

USB universal serial bus

XTAL crystal

Freescale Semiconductor xxv

MC9328MXS Reference Manual, Rev. 1

xxvi Freescale Semiconductor

Chapter 1 Introduction

The i.MX (Media Extensions) series provides a leap in performance with an ARM9™ microprocessor core and highly integrated system functions. i.MX products specifically address the requirements of the portable product market by providing intelligent integrated peripherals, an advanced processor core, and power management capabilities.

The MC9328MXS is equipped with an optimized feature set to provide a low-cost solution for a variety of applications. The ARM920TDMI core speed is programmable from 0 to 100 MHz, while system speed is programmable from 0 to 96 MHz.

The MC9328MXS provides the following benefits:

- Provides uncompromising performance in a very low-power system design
- Connectivity features include SPI, UART, USB, and SSI/I²S
- Supports a wide variety of applications including the most popular PDA designs and other portable applications

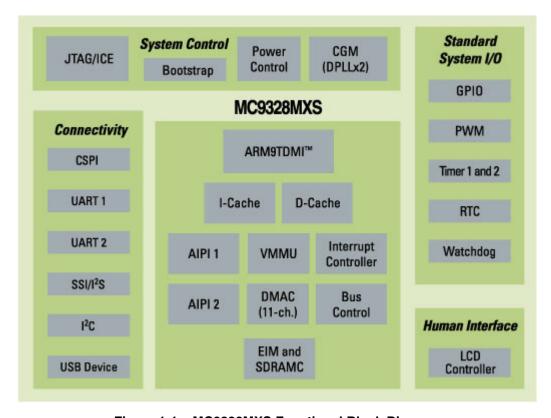


Figure 1-1. MC9328MXS Functional Block Diagram

Freescale Semiconductor 1-1

ARM920T Microprocessor Core

To support a wide variety of applications, the MC9328MXS boasts a robust array of features, including the following:

- ARM920T Microprocessor Core
- AHB to IP Bus Interfaces (AIPIs)
- External Interface Module (EIM)
- SDRAM Controller (SDRAMC)
- DPLL Clock and Power Control Module
- Two Universal Asynchronous Receiver/Transmitters (UART 1 and UART 2)
- One Serial Peripheral Interface (SPI)
- Two General-Purpose 32-bit Counters/Timers
- Watchdog Timer
- Real-Time Clock/Sampling Timer (RTC)
- LCD Controller (LCDC)
- Pulse-Width Modulation (PWM) Module
- Universal Serial Bus (USB) Device
- Direct Memory Access Controller (DMAC)
- Synchronous Serial Interface (SSI1) and Inter-IC Sound (I²S) Module
- Inter-IC (I²C) Bus Module
- General-Purpose I/O (GPIO) Ports
- Bootstrap Mode
- 225-pin PBGA Package

The following sections detail the features of the MC9328MXS's functional blocks.

1.1 ARM920T Microprocessor Core

The MC9328MXS uses the ARM920T microprocessor core which has the following features:

- 100 MHz maximum processing speed
- 16 Kbyte instruction cache and 16 Kbyte data cache
- ARM9 high performance 32-bit RISC engine
- Thumb® 16-bit compressed instruction set for a leading level of code density
- EmbeddedICETM JTAG software debug
- 100-percent user code binary compatibility with ARM7TDMI® processors
- ARM9TDMI® core, including integrated caches, write buffers, and bus interface units, provides CPU-cache transparency
- Advanced Microcontroller Bus Architecture (AMBATM) system-on-chip multi-master bus interface
- Flexible CPU and bus clocking relationships including asynchronous, synchronous, and single-clock configurations

1-2 Freescale Semiconductor

- Cache locking to support mixed loads of real-time and user applications
- Virtual Memory Management Unit (VMMU)

1.2 AHB to IP Bus Interfaces (AIPIs)

The MC9328MXS AIPIs provide a communication interface between the high-speed AHB bus and a lower-speed IP bus for slow slave peripherals.

1.3 External Interface Module (EIM)

The MC9328MXS EIM features:

- Up to six chip selects for external devices, each with 16 Mbyte of address space (chip selects for ROM support a maximum of 32 Mbyte of address space)
- Programmable protection, port size, and wait states for each chip select
- Internal/external boot ROM selection
- Selectable bus watchdog counter
- Burst support for external AMDTM or Intel[®] flash with 32-bit data path
- Interrupt controller to handle a maximum of 63 interrupt sources
- Vectored interrupt capability with prioritization for 16 sources

1.4 SDRAM Controller (SDRAMC)

The MC9328MXS SDRAMC features:

- Supports 4 banks of 64-, 128-, or 256-Mbit synchronous DRAMs
- Includes 2 independent chip-selects
 - Up to 64 Mbyte per chip-select
 - Up to four banks simultaneously active per chip-select
 - JEDEC standard pinout and operation
- Supports burst reads of word (32-bit) data types
- PC100 compliant interface
 - 100 MHz system clock achievable with "-8" option PC100 compliant memories
 - single and fixed-length (8-word) word access
 - Typical access time of 8-1-1-1 at 100 MHz
- Software configurable bus width, row and column sizes, and delays for differing system requirements
- Built in auto-refresh timer and state machine
- Hardware supported self-refresh entry and exit which keeps data valid during system reset and low-power modes
- Auto-powerdown (clock suspend) timer

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1.5 Clock Generation Module (CGM) and Power Control Module

The MC9328MXS CGM and Power Control Module features:

- Digital phase-locked loops (PLLs) and clock controller for all internal clocks generation
- MCUPLL generates FCLK to the CPU from either a 32 kHz or 32.768 kHz
- System PLL generates the system clock and the 48 MHz clock for the USB from a 16 MHz or either a 32 kHz or 32.768 kHz
- Support for three power modes for different power consumption needs: run, doze, and stop

1.6 Two Universal Asynchronous Receiver/Transmitters (UART 1 and UART 2)

The MC9328MXS UARTs features:

- Support for serial data transmit/receive operation: 7 or 8 data bits, 1 or 2 stop bits, and programmable parity (even, odd, or none)
- Programmable baud rates up to 1.00 MHz
- 32-byte FIFO on Tx and 32 half-word FIFO on Rx that support autobaud
- IrDA 1.0 support

1.7 Serial Peripheral Interface (SPI)

The MC9328MXS SPI features:

- Master/slave configurable
- Up to 16-bit programmable data transfer
- 8 × 16 FIFO for both Tx and Rx data

1.8 Two General-Purpose 32-Bit Counters/Timers

The MC9328MXS General-Purpose Counters/Timers features:

- Automatic interrupt generation
- Programmable timer input/output pins
- Input capture capability with programmable trigger edge
- Output compare with programmable mode

1.9 Watchdog Timer

The MC9328MXS Watchdog Timer features:

- Programmable time out of 0.5 s to 64 s
- Resolution of 0.5 s

1.10 Real-Time Clock/Sampling Timer (RTC)

The MC9328MXS RTC features:

- 32.768 kHz or 32 kHz
- Full clock features: seconds, minutes, hours, and days
- Capable of counting up to 512 days
- Minute countdown timer with interrupt
- Programmable daily alarm with interrupt
- Sampling timer with interrupt
- Once-per-second, once-per-minute, once-per-hour, and once-per-day interrupts
- Interrupt generation for digitizer sampling or keyboard debouncing

1.11 LCD Controller (LCDC)

The MC9328MXS LCDC features:

- Software programmable screen size (a maximum of 640 × 512 pixels) to support single (non-split) monochrome, color STN panels, and color TFT panels
- Support for 4 bpp (bits per pixel), 8 bpp, and 12 bpp for passive color panels
- Support for 4 bpp, 8 bpp, 12 bpp, and 16 bpp for TFT panels
 - Up to 256 colors out of a palette of 4096 for 8 bpp
 - True 64K color for 16 bpp
- In color STN mode, the maximum bit depth is 12 bpp
- In BW mode, the maximum bit depth is 4 bpp
- Up to 16 grey levels out of 16 palettes
- Capable of directly driving popular LCD drivers from manufacturers including Motorola, Sharp, Hitachi, and Toshiba
- Support for data bus width for 12- or 16-bit TFT panels
- Panel interface of 8-, 4-, and 2-bits, and a 1-bit wide LCD panel data bus for monochrome panels
- Direct interface to Sharp® 320 × 240 HR-TFT panel
- Support for logical operation between color hardware cursor and background
- Uses system memory as display memory
- LCD contrast control using 8-bit PWM
- Support for self-refresh LCD modules
- Hardware panning (soft horizontal scrolling)

1.12 Pulse-Width Modulation (PWM) Module

The MC9328MXS PWM Module features:

- 4×16 FIFO to minimize interrupt overhead
- 16-bit resolution

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Universal Serial Bus (USB) Device

· Sound and melody generation

1.13 Universal Serial Bus (USB) Device

The MC9328MXS USB Device features:

- Compliant with *Universal Serial Bus Specification*, revision 1.1
- Up to six logical endpoints—see Table 1-1 on page 1-6
- Support for isochronous communications pipes
 - Frame match interrupt feature notifies the user when a specific USB frame occurs
 - For DMA access, the maximum packet size for the isochronous endpoint is restricted by the FIFO size of the endpoint
 - For programmed I/O, isochronous data packets range from 0 bytes to 1023 bytes
- Support for control, bulk, and interrupt pipes
 - Packet sizes are limited to 8, 16, 32, or 64 bytes
 - Maximum packet size depends on the FIFO size of the endpoint
- Support (via a register bit) for a remote wake-up feature
- Full-speed (12 MHz) operation
- Operation can be programmed for both bus-powered and self-powered mode

Table 1-1. Endpoint Configurations

Endpoint	Direction	Physical FIFO Size (Bytes)	Endpoint Configuration	Maximum Packet Size (Bytes)
0	IN and OUT	32	Control	32
1–5	IN or OUT	32 or 64 ¹	Control, interrupt, bulk, or isochronous	User configurable: 8, 16, 32, or 64 (depending on FIFO size)

^{1.}FIFO1 and FIFO2 are 64 bytes each; FIFO3, FIFO4, and FIFO5 are 32 bytes each.

1.14 Direct Memory Access Controller (DMAC)

The MC9328MXS DMAC features:

- 11 channels to support linear memory, 2D memory, FIFO, and End-of-Burst Enable FIFO for both source and destination
- Support for 8-, 16-, or 32-bit FIFO port size and memory port size data transfer
- Support for big-endian and little-endian
- Configurable DMA burst length for each channel up to 16 words, 32 half-words, or 64 bytes
- Bus utilization control for a channel that is not triggered by DMA requests
- Bulk data transfer complete or transfer error interrupts provided to interrupt handler (and then to the core)
- DMA burst time-out error terminates the DMA cycle when the burst cannot be completed within a programmed timing period

MC9328MXS Reference Manual, Rev. 1

1-6 Freescale Semiconductor

• Acknowledge signal provided to peripheral after DMA burst is complete

1.15 Synchronous Serial Interface and Inter-IC Sound (SSI/I²S) Module

The MC9328MXS SSI/I²S Module features:

- Supports generic SSI interface for external audio chip or interprocessor communication
- Supports Philips standard Inter-IC Sound (I²S) bus for external digital audio chip interface

1.16 Inter-IC (I²C) Bus Module

The MC9328MXS I²C Bus Module features:

- Support for Philips I²C-bus standard for external digital control
- Support for 3.3 V tolerant devices
- Multiple-master operation
- Software-programmable for 1 of 64 different serial clock frequencies
- Software-selectable acknowledge bit
- Interrupt-driven, byte-by-byte data transfer
- Arbitration-lost interrupt with automatic mode switching from master to slave
- Calling address identification interrupt
- Start and stop signal generation and detection
- Repeated START signal generation
- Acknowledge bit generation and detection
- Bus-busy detection

1.17 General-Purpose I/O (GPIO) Ports

The MC9328MXS GPIO ports feature:

- Interrupt capability
- 97 total I/O pins multiplexed with most dedicated functions for pin efficiency

1.18 Bootstrap Mode

The MC9328MXS Bootstrap Mode features:

- Allows user to initialize system and download program or data to system memory through UART
- Accepts execution command to run program stored in system memory
- Supports memory/register read/write operation of selectable data size of byte, half-word, or word
- Provides a 32-byte instruction buffer for ARM920T core vector table storage, instruction storage and execution

Freescale Semiconductor 1-7

Power Management Features

1.19 Power Management Features

The MC9328MXS provides the following power management features:

- Programmable clock synthesizer using either a 32 kHz or 32.768 kHz crystal for full frequency control
- Low-power stop capabilities
- Modules that can be individually shut down
- Lowest power mode control

1.20 Operating Voltage Range

The MC9328MXS operating voltages are as follows:

- I/O voltage—1.7 V to 2.0 V or 2.7 V to 3.3 V
- Internal logic voltage—1.7 V to 1.9 V

1.21 Packaging

The MC9328MXS features the package:

• 225-contact PBGA 13 mm × 13 mm package, with 0.8 mm ball pitch

Chapter 2 Signal Descriptions and Pin Assignments

2.1 Signal and Pin Information

For information about the MC9328MXS signals and their pin assignments refer to the MC9328MXS data sheet (document order number: MC9328MXS)).

Freescale Semiconductor 2-1

Signal and Pin Information

2-2 Freescale Semiconductor

Chapter 3 Memory Map

This chapter describes the memory maps and the chip configuration registers of the MC9328MXS.

3.1 Memory Space

The ARM920T microprocessor implements a virtual addressing mechanism. Refer to the ARM920T Memory Management Unit in the ARM9 technical reference manual for more information on this topic.

The ARM920T processor physical memory map can be divided according to the addresses shown in Figure 3-1 on page 3-2.

3.1.1 Memory Map

The base address referred to in each peripheral register address is the address from this table. The exact address description of each of the peripherals is described in each peripheral section.

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Memory Space

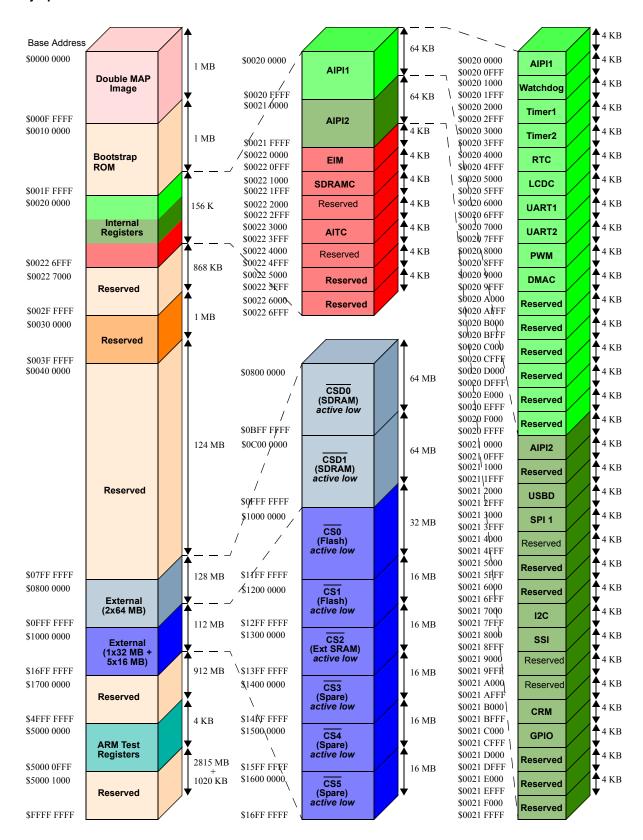


Figure 3-1. MC9328MXS MCU Physical Memory Map (4 Gbyte)

3-2 Freescale Semiconductor

Table 3-1. MCU Memory Space (Physical Addresses)

Address	Description	Size
\$0000 0000 - \$000F FFFF	Double Map Image	1 Mbyte
\$0010 0000 - \$001F FFFF	Bootstrap ROM	1 Mbyte
\$0020 0000 - \$0020 0FFF	AIPI1	4 kbyte
\$0020 1000 - \$0020 1FFF	WatchDog	4 kbyte
\$0020 2000 - \$0020 2FFF	TIMER1	4 kbyte
\$0020 3000 - \$0020 3FFF	TIMER2	4 kbyte
\$0020 4000 - \$0020 4FFF	RTC	4 kbyte
\$0020 5000 - \$0020 5FFF	LCDC	4 kbyte
\$0020 6000 - \$0020 6FFF	UART1	4 kbyte
\$0020 7000 - \$0020 7FFF	UART2	4 kbyte
\$0020 8000 - \$0020 8FFF	PWM	4 kbyte
\$0020 9000 - \$0020 9FFF	DMAC	4 kbyte
\$0020 A000 - \$0020 AFFF	Reserved	4 kbyte
\$0020 B000 - \$0020 BFFF	Reserved	4 kbyte
\$0020 C000 - \$0020 CFFF	Reserved	4 kbyte
\$0020 D000 - \$0020 DFFF	Reserved	4 kbyte
\$0020 E000 - \$0020 EFFF	Reserved	4 kbyte
\$0020 F000 - \$0020 FFFF	Reserved	4 kbyte
\$0021 0000 - \$0021 0FFF	AIPI2	4 kbyte
\$0021 1000 - \$0021 1FFF	Reserved	4 kbyte
\$0021 2000 - \$0021 2FFF	USBD	4 kbyte
\$0021 3000 - \$0021 3FFF	SPI 1	4 kbyte
\$0021 5000 - \$0021 5FFF	Reserved	4 kbyte
\$0021 6000 - \$0021 6FFF	Reserved	4 kbyte
\$0021 7000 - \$0021 7FFF	12C	4 kbyte
\$0021 8000 - \$0021 8FFF	SSI	4 kbyte
\$0021 B000 - \$0021 BFFF	CRM	4 kbyte
\$0021 C000 - \$0021 CFFF	GPIO	4 kbyte

Freescale Semiconductor 3-3

Memory Space

Table 3-1. MCU Memory Space (Physical Addresses) (continued)

Address	Description	Size
\$0021 D000 - \$0021 DFFF	Reserved	4 kbyte
\$0021 E000 - \$0021 EFFF	Reserved	4 kbyte
\$0021 F000 - \$0021 FFFF	Reserved	4 kbyte
\$0022 0000 - \$0022 0FFF	EIM	4 kbyte
\$0022 1000 - \$0022 1FFF	SDRAMC	4 kbyte
\$0022 3000 - \$0022 3FFF	AITC	4 kbyte
\$0022 5000 - \$0022 5FFF	Reserved	4 kbyte
\$0022 6000 - \$0022 6FFF	Reserved	4 kbyte
\$0022 7000 - \$002F FFFF	Reserved	868 kbyte
\$0030 0000 - \$003F FFFF	Reserved	1 Mbyte
\$0040 0000 - \$07FF FFFF	Reserved	124 Mbyte
\$0800 0000 - \$0BFF FFFF	External memory (CSD0)	64 Mbyte
\$0C00 0000 - \$0FFF FFFF	External memory (CSD1)	64 Mbyte
\$1000 0000 - \$11FF FFFF	External memory (CS0)	32 Mbyte
\$1200 0000 - \$12FF FFFF	External memory (CS1)	16 Mbyte
\$1300 0000 - \$13FF FFFF	External Memory (CS2)	16 Mbyte
\$1400 0000 - \$14FF FFFF	External Memory (CS3)	16 Mbyte
\$1500 0000 - \$15FF FFFF	External Memory (CS4)	16 Mbyte
\$1600 0000 - \$16FF FFFF	External Memory (CS5)	16 Mbyte
\$1700 0000 - \$4FFF FFFF	Reserved	912 Mbyte
\$5000 0000 - \$5000 0FFF	ARM920T Test Registers	4 kbyte
\$5000 1000 - \$FFFF FFFF	Reserved	2815 Mbyte + 1020 kbyte

3.1.2 Internal Register Space

Internal registers are located from 0x00200000 to 0x00224FFF. Some of the MC9328MXS peripherals are each allocated 4 Kbyte starting at address \$00200000 and they are connected to the AIPI1 (AHB IP Interface). Any ARM920T core write access to these modules will experience two wait states—that is, any write access will be a three cycle long access, and any ARM920T core read access from these modules will have one wait state—that is, any read access will be two cycle long access. The other MC9328MXS peripherals are each allocated 4 Kbyte

3-4 Freescale Semiconductor

starting at address \$00210000 and they are connected to the AIPI2. Any ARM920T core write access to these modules will have two wait states—that is, any write access will be a three cycle long access, and any ARM920T core read access from these modules will have one wait state—any read access will be two cycle long access.

- 4 kbyte address space beginning at 0x00220000 to 0x00220FFF is assigned for EIM internal registers.
- 4 kbyte address space beginning at 0x00221000 to 0x00221FFF is assigned for SDRAMC internal registers.
- 4 kbyte address space beginning at 0x00223000 to 0x00223FFF is assigned for AITC internal registers.

Within each 4 kbyte peripheral space, any number of architected registers may be defined (as outlined in the chapter for each peripheral), and software must explicitly address them making no assumptions regarding multiple mapping.

3.1.3 External Memory

There are 240 Mbytes of the memory map allocated for external chip access, beginning at address \$08000000. There are 8 external chip selects which are allocated 64 Mbyte each for CSD1–CSD0, 16 Mbyte each for CS5Q–CS1, and 32 Mbyte for CS0.

3.1.4 Double Map Image

The first 1 Mbyte system address space (starting at address \$0) is defined as double map image space. This address space is mapped to the first 1 Mbyte of boot ROM upon power up. In MC9328MXS the boot ROM can be either SyncFlash, CS0, or Bootstrap ROM. After system power up, reading or writing to the double map space (\$0000,0000 to \$000F,FFFF) is the same as reading or writing to the first 1 Mbyte of the selected boot ROM which is controlled by the configuration of BOOT [3:0] input pins.

Freescale Semiconductor 3-5

Internal Registers

3.2 Internal Registers

The internal registers in the MC9328MXS are listed in Table 3-2.

Table 3-2. Internal Registers Sorted by Address

Module Name	Address	Name	Description
USBD	0x0021213C	USB_EP5_LWFP	Endpoint 5 Last Write Frame Pointer Register
USBD	0x00212140	USB_EP5_FALRM	Endpoint 5 FIFO Alarm Register
USBD	0x00212144	USB_EP5_FRDP	Endpoint 5 FIFO Read Pointer Register
USBD	0x00212148	USB_EP5_FWRP	Endpoint 5 FIFO Write Pointer Register
SPI 1	0x00213000	RXDATAREG1	SPI 1 Rx Data Register
SPI 1	0x00213004	TXDATAREG1	SPI 1 Tx Data Register
SPI 1	0x00213008	CONTROLREG1	SPI 1 Control Register
SPI 1	0x0021300C	INTREG1	SPI 1 Interrupt Control/Status Register
SPI 1	0x00213010	TESTREG1	SPI 1 Test Register
SPI 1	0x00213014	PERIODREG1	SPI 1 Sample Period Control Register
SPI 1	0x00213018	DMAREG1	SPI 1 DMA Control Register
SPI 1	0x0021301C	RESETREG1	SPI 1 Soft Reset Register
I ² C	0x00217000	IADR	I ² C Address Register
I ² C	0x00217004	IFDR	I ² C Frequency Divider Register
I ² C	0x00217008	I2CR	I ² C Control Register
I ² C	0x0021700C	I2CSR	I ² C Status Register
I ² C	0x00217010	I2DR	I ² C Data I/O Register
SSI	0x00218000	STX	SSI Transmit Data Register
SSI	0x00218004	SRX	SSI Receive Data Register
SSI	0x00218020	SFCSR	SSI FIFO Control/Status Register
SSI	0x00218028	SOR	SSI Option Register
PLLCLK	0x0021B000	CSCR	Clock Source Control Register
PLLCLK	0x0021B004	MPCTL0	MCU PLL Control Register 0
PLLCLK	0x0021B0008	MPCTL1	MCU PLL and System Clock Control Register 1

3-6 Freescale Semiconductor

Table 3-2. Internal Registers Sorted by Address (continued)

Module Name	Address	Name	Description
PLLCLK	0x0021B00C	SPCTL0	System PLL Control Register 0
PLLCLK	0x0021B010	SPCTL1	System PLL Control Register 1
PLLCLK	0x0021B020	PCDR	Peripheral Clock Divider Register
AITC	0x00223044	FIVECSR	Fast Interrupt Vector and Status Register
AITC	0x00223048	INTSRCH	Interrupt Source Register High
AITC	0x0022304C	INTSRCL	Interrupt Source Register Low
AITC	0x00223050	INTFRCH	Interrupt Force Register High
AITC	0x00223054	INTFRCL	Interrupt Force Register Low
AITC	0x00223058	NIPNDH	Normal Interrupt Pending Register High
AITC	0x0022305C	NIPNDL	Normal Interrupt Pending Register Low
AITC	0x00223060	FIPNDH	Fast Interrupt Pending Register High
AITC	0x00223064	FIPNDL	Fast Interrupt Pending Register Low

Freescale Semiconductor 3-7

Internal Registers

3-8 Freescale Semiconductor

Chapter 4 ARM920T Processor

This chapter describes the operational features of the ARM920TTM high-performance processor that includes an overall summary of both the ARM920T processor core and the Thumb® instruction set as well as the operational modes. For detailed technical and programming information about the ARM920T processor refer to the ARM920T Technical Reference Manual (ARM Limited: 2001, order number DDI 0151C).

4.1 Introduction

The ARM920T processor is a high-performance 32-bit RISC integer processor macrocell combining an ARM9TDMITM core with:

- 16 kbyte instruction and 16 kbyte data caches
- Instruction and data Memory Management Units (MMUs)
- Write buffer
- AMBATM (Advanced Microprocessor Bus Architecture) bus interface
- Embedded Trace Macrocell (ETM) interface

An enhanced ARM® architecture v4 MMU implementation provides translation and access permission checks for instruction and data addresses. The ARM920T high-performance processor solution gives considerable savings in chip complexity and area, chip system design, and power consumption. The ARM920T processor is 100% user code binary compatible with ARM7TDMI®, and backwards compatible with the ARM7TM Thumb® Family and the StrongARM® processor families, giving designers software-compatible processors with a range of price/performance points from 60 MIPS to 200+ MIPS.

MC9328MXS Reference Manual, Rev. 1 4-1 Freescale Semiconductor

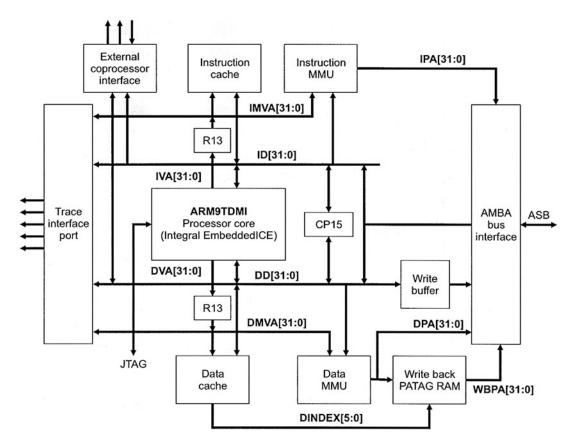


Figure 4-1. ARM920T Core Functional Block Diagram

4.2 ARM920T Macrocell

The ARM920T macrocell is based on the ARM9TDMI™ Harvard architecture processor core, with an efficient 5-stage pipeline. The architecture of the processor core or integer unit is described in more detail later in this chapter.

To reduce the effect of main memory bandwidth and latency on performance, the ARM920T processor includes:

- Instruction cache
- Data cache
- MMU
- TLBs
- Write buffer
- Physical address TAG RAM

4-2 Freescale Semiconductor

4.2.1 Caches

Two 16 kbyte caches are implemented, one for instructions, the other for data, both with an 8-word line size. A 32-bit data bus connects each cache to the ARM9TDMI core allowing a 32-bit instruction to be fetched and fed into the instruction Decode stage of the pipeline at the same time as a 32-bit data access for the Memory stage of the pipeline.

4.2.2 Cache Lock-Down

Cache lock-down is provided to allow critical code sequences to be locked into the cache to ensure predictability for real-time code. The cache replacement algorithm can be selected by the operating system as either pseudo random or round-robin. Both caches are 64-way set associative. Lock-down operates on a per-set basis.

4.2.3 Write Buffer

The ARM920T processor also incorporates a 16-entry write buffer, to avoid stalling the processor when writes to external memory are performed.

4.2.4 PATAG RAM

The ARM920T processor implements PATAG RAM to perform write-backs from the data cache. The physical address of all the lines held in the data cache is stored by the PATAG memory, removing the need for address translation when evicting a line from the cache.

4.2.5 MMUs

The standard ARM920T processor implements an enhanced ARM v4 memory management unit (MMU) to provide translation and access permission checks for the instruction and data address ports of the ARM9TDMI core.

The MMU features are:

- Standard ARM9TM v4 MMU mapping sizes, domains, and access protection scheme
- Mapping sizes are 1 Mbyte sections, 64 kbyte large pages, 4 kbyte small pages, and new 1 kbyte tiny pages
- Access permissions for sections
- Access permissions for large pages and small pages can be specified separately for each quarter of the page (these quarters are called subpages)
- 16 domains implemented in hardware
- 64-entry instruction TLB and 64-entry data TLB
- Hardware page table walks
- Round-robin replacement algorithm (also called cyclic)

4.2.6 System Controller

The system controller oversees the interaction between the instruction and data caches and the Bus Interface Unit. It controls internal arbitration between the blocks and stalls appropriate blocks when required.

Freescale Semiconductor 4-3

ARMv4T Architecture

The system controller arbitrates between instruction and data access to schedule single or simultaneous requests to the MMUs and the Bus Interface Unit. The system controller receives acknowledgement from each resource to allow execution to continue.

The physical address of all the lines held in the data cache is stored by the PATAG memory, removing the need for address translation when evicting a line from the cache.

4.2.7 Control Coprocessor (CP15)

The CP15 allows configuration of the caches, the write buffer, and other ARM920T processor options.

Several registers within CP15 are available for program control, providing access to features such as:

- Invalidate whole TLB using CP15
- Invalidate TLB entry, selected by modified virtual address, using CP15
- Independent lock-down of instruction TLB and data TLB using CP15 register 10
- Big or little-endian operation
- Low-power state
- Memory partitioning and protection
- Page table address
- Cache and TLB maintenance operations

4.3 ARMv4T Architecture

The following sections summarize the registers and instruction sets of the ARMv4T architecture.

4.3.1 Registers

The ARM920T processor core consists of a 32-bit data path and associated control logic. This data path contains 31 general purpose registers, coupled to a full shifter, Arithmetic Logic Unit, and multiplier. At any one time 16 registers are visible to the user. The remainder are synonyms used to speed up exception processing. Register 15 is the Program Counter (PC) and can be used in all instructions to reference data relative to the current instruction. R14 holds the return address after a subroutine call. R13 is used (by software convention) as a stack pointer.

4.3.2 Modes and Exception Handling

All exceptions have banked registers for R14 and R13. After an exception, R14 holds the return address for exception processing. This address is used both to return after the exception is processed and to address the instruction that caused the exception.

R13 is banked across exception modes to provide each exception handler with a private stack pointer. The fast interrupt mode also banks registers 8 to 12 so that interrupt processing can begin without the need to save or restore these registers.

A seventh processing mode, System mode, does not have any banked registers. It uses the User mode registers. System mode runs tasks that require a privileged processor mode and allows them to invoke all classes of exceptions.

4-4 Freescale Semiconductor

4.3.3 Status Registers

All other processor states are held in status registers. The current operating processor status is in the Current Program Status Register (CPSR). The CPSR holds:

- Four ALU flags (Negative, Zero, Carry, and Overflow)
- Two interrupt disable bits (one for each type of interrupt)
- A bit to indicate ARM9 or Thumb execution
- Five bits to encode the current processor mode

All five exception modes also have a Saved Program Status Register (SPSR) that holds the CPSR of the task immediately before the exception occurred.

4.3.4 Exception Types

ARM9TDMI core supports five types of exception, and a privileged processing mode for each type. The types of exceptions are:

- Fast interrupt (FIQ)
- Normal interrupt (IRQ)
- Memory aborts (used to implement memory protection or virtual memory)
- Attempted execution of an undefined instruction
- Software interrupts (SWIs)

4.3.5 Conditional Execution

All ARM9 instructions (with the exception of BLX) are conditionally executed. Instructions optionally update the four condition code flags (Negative, Zero, Carry, and Overflow) according to their result. Subsequent instructions are conditionally executed according to the status of flags. Fifteen conditions are implemented.

4.4 Four Classes of Instructions

The ARM9 and Thumb instruction sets can be divided into four broad classes of instruction:

- Data processing instructions
- Load and store instructions
- Branch instructions
- Coprocessor instructions

4.4.1 Data Processing Instructions

The data processing instructions operate on data held in general purpose registers. Of the two source operands, one is always a register. The other has two basic forms:

- An immediate value
- A register value optionally shifted

Freescale Semiconductor 4-5

MC9328MXS Reference Manual, Rev. 1

Four Classes of Instructions

If the operand is a shifted register, the shift amount might have an immediate value or the value of another register. Four types of shift can be specified. Most data processing instructions can perform a shift followed by a logical or arithmetic operation. Multiply instructions come in two classes:

- Normal, 32-bit result
- Long, 32-bit result variants

Both types of multiply instruction can optionally perform an accumulate operation.

4.4.2 Load and Store Instructions

The second class of instruction is load and store instructions. These instructions come in two main types:

- Load or store the value of a single register
- Load and store multiple register values

Load and store single register instructions can transfer a 32-bit word, a 16-bit halfword and an 8-bit byte between memory and a register. Byte and halfword loads might be automatically zero extended or sign extended as they are loaded. Swap instructions perform an atomic load and store as a synchronization primitive.

4.4.2.1 Addressing Modes

Load and store instructions have three primary addressing modes:

- Offset
- Pre-indexed
- Post-indexed

They are formed by adding or subtracting an immediate or register based offset to or from a base register. Register-based offsets can also be scaled with shift operations. Pre-indexed and post-indexed addressing modes update the base register with the base plus offset calculation. As the PC is a general purpose register, a 32-bit value can be loaded directly into the PC to perform a jump to any address in the 4 Gbyte memory space.

4.4.2.2 Block Transfers

Load and store multiple instructions perform a block transfer of any number of the general purpose registers to or from memory. Four addressing modes are provided:

- Pre-increment addressing
- Post-increment addressing
- Pre-decrement addressing
- Post-decrement addressing

The base address is specified by a register value (that can be optionally updated after the transfer). As the subroutine return address and the PC values are in general-purpose registers, very efficient subroutine calls can be constructed.

4.4.3 Branch Instructions

As well as allowing any data processing or load instruction to change control flow (by writing the PC) a standard branch instruction is provided with 24-bit signed offset, allowing forward and backward branches of up to 32 Mbyte.

4.4.3.1 Branch with Link

There is a Branch with Link (BL) that allows efficient subroutine calls. BL preserves the address of the instruction after the branch in R14 (the Link Register, or LR). This allows a move instruction to put the LR in to the PC and return to the instruction after the branch.

The third type of branch (BX and BLX) switches between ARM9 and Thumb instruction sets optionally with the return address preserving link option.

4.4.4 Coprocessor Instructions

There are three types of coprocessor instructions:

- Coprocessor data processing instructions invoke a coprocessor-specific internal operation
- Coprocessor register transfer instructions allow a coprocessor value to be transferred to or from an ARM920T processor register
- Coprocessor data transfer instructions transfer coprocessor data to or from memory, where the ARM920T calculates the address of the transfer

4.5 The ARM9 Instruction Set

The instruction set used by the ARM920T processor is summarized in Table 4-1.

Table 4-1. ARM920T Instruction Set

Mnemonic	Operation	Mnemonic	Operation
MOV	Move	MVN	Move Not
ADD	Add	ADC	Add with Carry
SUB	Subtract	SBC	Subtract with Carry
RSB	Reverse Subtract	RSC	Reverse Subtract with Carry
CMP	Compare	CMN	Compare Negated
TST	Test	TEQ	Test Equivalence
AND	Logical AND	BIC	Bit Clear
FOR	Logical Exclusive OR	ORR	Logical (inclusive) OR
MUL	Multiply	MLA	Multiply Accumulate
SMULL	Sign Long Multiply	SMLAL	Signed Long Multiply Accumulate
UMULL	Unsigned Long Multiply	UMLAL	Unsigned Long Multiply Accumulate
CLZ	Count Leading Zeroes	BKPT	Breakpoint

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor 4-7

The ARM Thumb Instruction Set

Table 4-1. ARM920T Instruction Set (continued)

Mnemonic	Operation	Mnemonic	Operation
MRS	Move From Status Register	MSR	Move to Status Register
В	Branch	-	-
BL	Branch and Link	BLX	Branch and Link and Exchange
BX	Branch and Exchange	SWI	Software Interrupt
LDR	Load Word	STR	Store Word
LDRH	Load Halfword	STRH	Store Halfword
LDRB	Load Byte	STRB	Store Byte
LDRSH	Load Signed Halfword	LDRSB	Load Signed Byte
LDMIA	Load Multiple	STMIA	Store Multiple
SWP	Swap Word	SWPB	Swap Byte
CDP	Coprocessor Data Processing	_	-
MRC	Move From Coprocessor	MCR	Move to Coprocessor
LDC	Load To Coprocessor	STC	Store From Coprocessor

4.6 The ARM Thumb Instruction Set

The ARM Thumb instruction set is summarized in Table 4-2.

Table 4-2. ARM Thumb Instruction Set

Mnemonic	Operation	Mnemonic	Operation
MOV	Move	MVN	Move Not
ADD	Add	ADC	Add with Carry
SUB	Subtract	SBC	Subtract with Carry
RSB	Reverse Subtract	RSC	Reverse Subtract with Carry
СМР	Compare	CMN	Compare Negated
TST	Test	NEG	Negate
AND	Logical AND	BIC	Bit Clear
FOR	Logical Exclusive OR	ORR	Logical (inclusive) OR
LSL	Logical Shift Left	LSR	Logical Shift Right
ASR	Arithmetic Shift Right	ROR	Rotate Right
MUL	Multiply	ВКРТ	Breakpoint
В	Unconditional Branch	Bcc	Conditional Branch
BL	Branch and Link	BLX	Branch and Link and Exchange

MC9328MXS Reference Manual, Rev. 1

4-8 Freescale Semiconductor

Table 4-2. ARM Thumb Instruction Set (continued)

Mnemonic	Operation	Mnemonic	Operation
BX	Branch and Exchange	SWI	Software Interrupt
LDR	Load Word	STR	Store Word
LDRH	Load Halfword	STRH	Store Halfword
LDRB	Load Byte	STRB	Store Byte
LDRSH	Load Signed Halfword	LDRSB	Load Signed Byte
LDMIA	Load Multiple	STMIA	Store Multiple
PUSH	Push Registers to stack	POP	Pop Registers from stack

4.6.1 ARM920T Modes and Registers

The modes and registers of the ARM920T processor are shown in Table 4-3.

Table 4-3. Register Availability by Mode

User and System Modes	Supervisor Mode	Abort Mode	Undefined Mode	Interrupt Mode	Fast Interrupt Mode
R0	R0	R0	R0	R0	R0
R1	R1	R1	R1	R1	R1
R2	R2	R2	R2	R2	R2
R3	R3	R3	R3	R3	R3
R4	R4	R4	R4	R4	R4
R5	R5	R5	R5	R5	R5
R6	R6	R6	R6	R6	R6
R7	R7	R7	R7	R7	R7
R8	R8	R8	R8	R8	R8_FIQ
R9	R9	R9	R9	R9	R9_FIQ
R10	R10	R10	R10	R10	R10_FIQ
R11	R11	R11	R11	R11	R11_FIQ
R12	R12	R12	R12	R12	R12_FIQ
R13	R13_SVC	R13_ABORT	R13_UNDEF	R13_IRQ	R13_FIQ
R14	R14_SVC	R14_ABORT	R14_UNDEF	R14_IRQ	R14_FIQ
PC	PC	PC	PC	PC	PC
CPSR	CPSR	CPSR	CPSR	CPSR	CPSR
	SPSR_SVC	SPSR_ABORT	SPSR_UNDEF	SPSR_IRQ	SPSR_FIQ
	= Mode-specific banked registers				

Freescale Semiconductor 4-9

The ARM Thumb Instruction Set

4-10 Freescale Semiconductor

Chapter 5 Embedded Trace Macrocell (ETM)

The MC9328MXS is equipped with an ARM9 Embedded Trace MacrocellTM (ETM9) module for real time debugging which is a great help to a system designer because the MC9328MXS is a highly integrated processor, a very limited number of pins are available for debug purposes. ETM signals in MC9328MXS are multiplexed with other function pins. This chapter contains a brief summary of the ETM features, for details of ETM operation, please refer to the *ETM9 Technical Reference Manual* Rev.2a (ARM Limited: 2001, order number DDI0157E).

5.1 Introduction to the ETM

The ETM provides instruction and data trace for the ARM9TM family of microprocessors. This document describes the interface between an ARM Thumb® family processor and the ETM. For details of the interface between an ARM7TM processor and ETM7, refer to the *ETM7 Technical Reference Manual* Rev.1 (ARM Limited: 2001, order number DDI0158D). The block diagram of the ETM is shown in Figure 5-1.

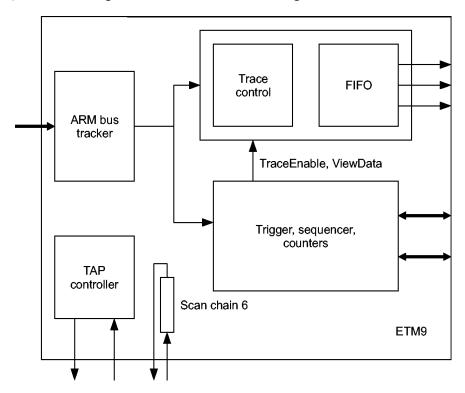


Figure 5-1. ETM Block Diagram

Freescale Semiconductor 5-1

5.2 Programming and Reading ETM Registers

All registers in the ETM9 are programmed through a JTAG interface. The interface is an extension of the ARM920T processor's TAP controller, and is assigned scan chain 6. The scan chain consists of a 40-bit shift register comprising:

- 32-bit data field
- 7-bit address field
- A read/write bit.

The data to be written is scanned into the 32-bit data field, the address of the register into the 7-bit address field, and 1 into the read/write bit.

A register is read by scanning its address into the address field and a 0 into the read/write bit. The 32-bit data field is ignored. A read or a write takes place when the TAP controller enters the UPDATE-DR state.

For further details of ETM registers, see the Embedded Trace Macrocell specification.

GPIO Port A [27:24]

5.3 Pin Configuration for ETM

The ETM module uses 13 pins on the MC9328MXS. These pins are multiplexed with other functions on the device, and must be configured for ETM operation. Table 5-1 identifies the pin configuration, however, only the 5 pins of the 13 that are multiplexed are shown.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Pin	Setting	Configuration Procedure
ETMTRACESYNC	Alternate function of GPIO Port A [0]	Clear bit 0 of Port A GPIO In Use Register (GIUS_A) Set bit 0 of Port A General Purpose Register (GPR_A)
ETMTRACECLK	Alternate function of GPIO Port A [31]	Clear bit 31 of Port A GPIO In Use Register (GIUS_A) Set bit 31 of Port A General Purpose Register (GPR_A)
ETMPIPESTAT [2:0]	Alternate function of GPIO Port A [30:28]	Clear bits [30:28] of Port A GPIO In Use Register (GIUS_A) Set bits [30:28] of Port A General Purpose Register (GPR_A)
ETMTRACEPKT [7:4]	Alternate function of GPIO Port A [20:17]	Clear bits [20:17] of Port A GPIO In Use Register (GIUS_A) Set bits [20:17] of Port A General Purpose Register (GPR_A)
ETMTRACEPKT [3:0]	Alternate function of	Clear bits [27:24] of Port A GPIO In Use Register (GIUS_A)

Set bits [27:24] of Port A General Purpose Register (GPR_A)

Table 5-1. ETM Pin Configuration

MC9328MXS Reference Manual, Rev. 1

5-2 Freescale Semiconductor

Chapter 6 Reset Module

The reset module controls or distributes all of the system reset signals used by the MC9328MXS. This chapter provides a detailed description of the operation of this module.

6.1 Functional Description of the Reset Module

A simplified block diagram of the reset module is shown in Figure 6-1. The reset module generates two distinct events—a global reset and an ARM920T processor reset.

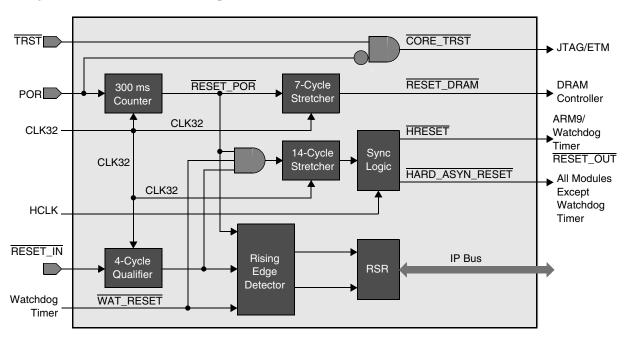


Figure 6-1. Reset Module Block Diagram

6.1.1 Global Reset

A global reset simultaneously asserts three reset signals: <u>HRESET</u>, <u>RESET_DRAM</u>, and <u>CORE_TRST</u>. These signals remain asserted for 14 CLK32 cycles. The <u>RESET_DRAM</u> signal is deasserted 7 CLK32 cycles before <u>HRESET</u> and <u>HARD_ASYN_RESET</u>. This 7-cycle period provides the DRAM with time to execute any necessary self-refresh operations. The timing diagram in Figure 6-2 on page 6-2 shows the relationship of the reset signal timings. See Table 6-1 for reset module signal and pin definitions.

There is one source capable of generating a global reset: A high condition on the POR pin for at least 4×32 kHz clocks when the 32 kHz crystal oscillator is running.

Freescale Semiconductor 6-1

MC9328MXS Reference Manual, Rev. 1

Functional Description of the Reset Module

The following signal conditions are not capable of generating a global reset, however they reset the ARM920T core:

- An external qualified low condition on the RESET_IN pin
- A low condition on WAT RESET

NOTE:

Due to the asynchronous nature of the RESET signal, the time period required to qualify the signal may vary, and the HRESET timing relative to the rising edge of RESET is also affected. A RESET signal shorter than 3 CLK32 cycles will not be qualified, a RESET signal equal to or longer than 4 CLK32 cycles will always be qualified, and any period length that is more than 3 and less than 4 CLK32 cycles is undefined.

IMPORTANT:

POR is the reset signal for all the reset module flip-flops. For this reason, an external reset signal is qualified if it lasts more than 4 CLK32 cycles when POR is deasserted.

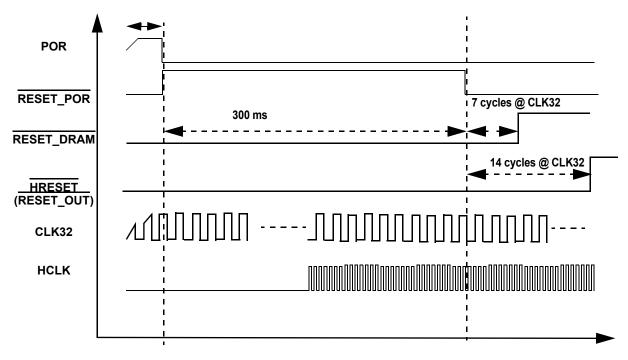


Figure 6-2. DRAM and Internal Reset Timing Diagram

6.1.2 ARM920T Processor Reset

Any qualified global reset signal resets the ARM920T processor and all related peripherals to their default state. After the internal reset is deasserted, the ARM920T processor begins fetching code from the internal bootstrap ROM, sync flash, or CS0 space. The memory location of the fetch depends on the configuration of the BOOT pins on the rising edge of HRESET (see Section 8.2, "System Boot Mode Selection," on page 8-7).

6-2 Freescale Semiconductor

Table 6-1. R	Reset Module Pin	and Signal Desc	riptions
--------------	------------------	-----------------	----------

Signal Name	Direction	Signal Description
CLK32	IN	32 kHz Clock —A 32 kHz clock signal derived from the input crystal oscillator circuit in the PLL.
POR	IN	Power-On Reset —An internal active high Schmitt trigger signal from the POR pin. The POR signal is normally generated by an external RC circuit designed to detect a power-up event.
RESET	IN	Reset—An external active low Schmitt trigger signal from the RESET_IN pin. When this signal goes active, all modules (except the reset module and the clock control module) are reset.
TRST	IN	Test Reset Pin —An external active low signal from the $\overline{\text{TRST}}$ pin. The Test Reset Pin is used to asynchronously initialize the JTAG controller.
WAT_RESET	IN	Watchdog Timer Reset —An active low signal generated by the watchdog timer when a time-out period has expired.
CORE_TRST	OUT	Core Test Reset—An active low signal that resets the JTAG module and the ETM.
HARD_ASYN_RESET	OUT	Hard Asynchronous Reset —An active low signal that resets all peripheral modules except the watchdog timer module. The rising edge of this signal is synchronous with HCLK.
HRESET	OUT	Hard Reset —An active low signal that resets the ARM920T processor and the watchdog timer module. This signal is deasserted during the low phase of HCLK. This signal also appears on the RESET_OUT pin of the MC9328MXS.
RESET_DRAM	OUT	DRAM Reset—An active low signal that resets the DRAM controller.

6.2 Programming Model

The Reset Source Register (RSR), the only register in the reset module, can be written to or read by the ARM920T processor through the IP bus interface.

6.2.1 Reset Source Register (RSR)

The Reset Source Register is a 16-bit read-only register used by the ARM920T processor to determine the source of the last MC9328MXS. hardware reset. The source of the last hardware reset is defined in Table 6-2 and Table 6-3 on page 6-4.

If several sources' signals overlap and if the signals are released during the same CLK32 cycle (which also causes the assertion of the RESET_OUT signal), only the highest-priority event is registered by the RSR using the following priority order:

- 1. POR signal
- 2. Qualified external reset signal
- 3. Watchdog signal

Otherwise, the last signal that is released is honored.

Freescale Semiconductor 6-3

RSR				F	Rese	t So	urce	Re	giste	er					0x0	Addr 021B800
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								•	0x0000)						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
															WDR	EXR
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILGET									0x0000)						

Table 6-2. RSR Register Description

Name	Description	Settings					
Reserved Bits 31–2	Reserved—These bits are reserved and should read 0.						
WDR Bit 1	Watchdog Reset—Indicates whether the last reset was caused by a Watchdog count expiration.	0 = Reset was NOT a Watchdog count expiration 1 = Reset WAS a Watchdog count expiration					
EXR Bit 0	External Reset —Indicates whether the last reset was caused by a RESET_IN pin assertion.	0 = Reset was NOT a RESET_IN pin assertion 1 = Reset WAS a RESET_IN pin assertion					

Table 6-3. Hardware Reset Source Matrix

Source	WDR	EXR
POR	0	0
Qualified external reset	0	1
Watchdog time-out	1	0

Chapter 7 AHB to IP Bus Interface (AIPI)

7.1 Overview

This chapter provides an overview of the R-AHB to IP bus interface (AIPI). The AIPI module in the MC9328MXS acts as an interface between the R-AHB (Reduced ARM Advanced High-performance Bus) and lower bandwidth peripherals.

7.1.1 Features

The AIPI provides the following features:

- All peripheral read transactions require a minimum of two system clocks (R-AHB side) and all write transactions require a minimum of three system clocks (R-AHB side).
- Support of 8-bit, 16-bit, and 32-bit IP bus peripherals.
- Byte, half word, and word read and write are supported to and from each peripheral in both big and little endian mode.
- Support of multi-cycle accesses (16-bit operations to 8-bit peripherals, and 32-bit operations to 16-bit and 8-bit peripherals).
- Ability to restrict user to limit access to peripherals in their natural size only.
- Support of 15 external IP bus peripherals. Muxiplexers are incorporated to support the 15 separate read data buses, and the transfer wait and transfer error from peripherals.
- A watchdog timer is provided to time-out peripheral access if operation does not terminate with 512 clock cycles.
- Use of a single asynchronous reset and one global clock with both edges.
- The AIPI module is implemented using MUX-D scan methodology for testability.

7.1.2 General Information

The AIPI is the interface between the R-AHB and on-chip IP bus peripherals as shown in Figure 7-1 on page 7-2.

IP bus peripherals are modules that contain readable/writable control and status registers. The R-AHB master reads and writes these registers through the AIPI. The AIPI generates module enables, the module address, transfer attributes, byte enables and write data as inputs to the IP bus peripherals. The AIPI captures read data (qualified by IPS_XFR_WAIT) from the IP bus interface and drives it on the R-AHB. The AIPI module terminates the transfer by asserting AIPI HREADY OUT.

The register maps of all IP bus peripherals are located on 4096 byte boundaries. Each IP bus peripheral is allocated one 4-kbyte block (minimum block size) of the memory map, configured as 1024 32-bit internal registers (or 2048 16-bit internal registers, or 4096 8-bit internal registers), activated by one of 15 module enables from the AIPI. Up

Freescale Semiconductor 7-1

Overview

to 15 IP bus peripherals may be implemented, occupying contiguous blocks of 4 kbytes, for a total of 60 kbytes. The exact address assignment for the IP bus peripherals is system dependent, and is defined in the system specification. Each IP bus peripheral will select its internal registers based on the address driven on the IPS_ADDR signals.

The AIPI is responsible for telling the IP bus peripherals if the access is in supervisor or user mode. The AIPI may block user mode accesses to certain IP bus peripherals or it may allow the individual IP bus peripherals to determine if user mode accesses are allowed. Please see Section 7.2, "Programming Model," for more information.

The AIPI supports multi-cycle accesses to IP bus peripherals when the R-AHB master requests data transfers that are larger than the targeted IP bus peripheral's data bus width. Table 7-1 through Table 7-4 provides more information on both single-cycle and multi-cycle accesses. For data access that are larger than the target IP bus peripheral, the AIPI will duplicated the data across all the byte lanes on the AHB, i.e. for a word read from 8 bit peripheral, the same data read will appear on byte lanes [31:24, [23:16], [15:8] and [7:0]. Similarly for a byte write to the peripheral, the core will duplicate the same byte over the byte lanes of the AHB for the write operation.

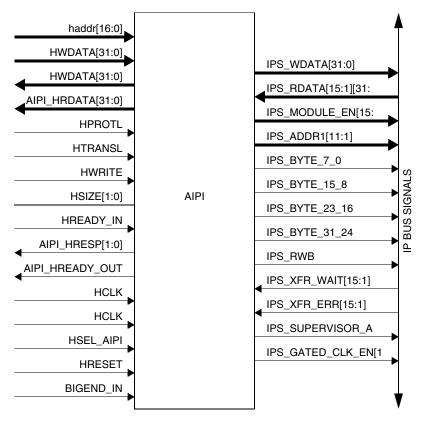


Figure 7-1. AIPI Interface

7-2 Freescale Semiconductor

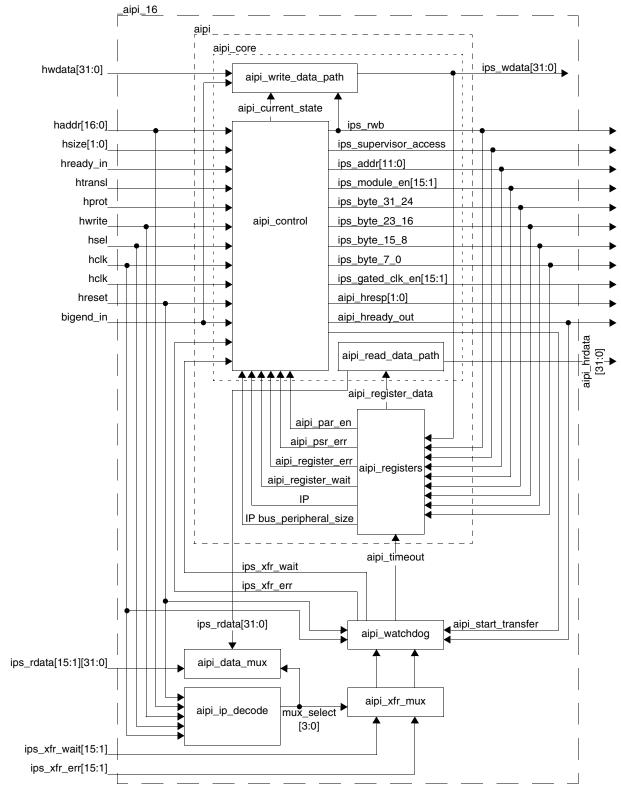


Figure 7-2. Block Diagram of the AIPI Module

Freescale Semiconductor 7-3

Overview

Table 7-1. R-AHB to IP Bus Interface Operation (Big Endian—Read Operation)

Transfer	had	ddr	IP Bus	ips_	addr	Active Bus Section (IP Bus to R-AHB)				
Size	[1]	[0]	Bus Size	[1]	[0]	R-AHB [31:24]	R-AHB [23:16]	R-AHB [15:8]	R-AHB [7:0]	
Byte	0	0	8-bit	0	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
	0	1		0	1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
	1	0		1	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
	1	1		1	1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
	0	0	16-bit	0	Х	ips_rdata[15:8]	ips_rdata[7:0]	_	-	
	0	1				ips_rdata[15:8]	ips_rdata[7:0]	_	-	
	1	0		1	Х	_	_	ips_rdata[15:8]	ips_rdata[7:0]	
	1	1				_	_	ips_rdata[15:8]	ips_rdata[7:0]	
	0	0	32-bit	Х	Х	ips_rdata[31:24]	_	_	-	
	0	1				_	ips_rdata[23:16]	_	-	
	1	0		Х	Х	_	_	ips_rdata[15:8]	-	
	1	1				_	_	_	ips_rdata[7:0]	
Half Word	0	NA	8-bit	0	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
	1			1	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
	0		16-bit	0	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]	
	1			1	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]	
	0		32-bit	Χ	Х	ips_rdata[31:24]	ips_rdata[23:16]	_	_	
	1			Χ	Х	_	_	ips_rdata[15:8]	ips_rdata[7:0]	
Word	NA	NA	8-bit	0	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
				1	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	
			16-bit	0	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]	
				1	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]	
			32-bit	Χ	Χ	ips_rdata[31:24]	ips_rdata[23:16]	ips_rdata[15:8]	ips_rdata[7:0]	

7-4 Freescale Semiconductor

Table 7-2. R-AHB to IP Bus Interface Operation (Big Endian—Write Operation)

Transfer	ha	ddr	IP Bug	ips_	addr	A	ctive Bus Section (R-AHB to IP Bus)	
Size	[1]	[0]	Bus Size	[1]	[0]	R-AHB [31:24]	R-AHB [23:16]	R-AHB [15:8]	R-AHB [7:0]
Byte	0	0	8-bit	0	0	ips_wdata[7:0]	_	_	_
	0	1		0	1	-	ips_wdata[7:0]	_	_
	1	0		1	0	_	_	ips_wdata[7:0]	-
	1	1		1	1	_	_	_	ips_wdata[7:0]
	0	0	16-bit	0	Х	ips_wdata[15:8]	-	_	_
	0	1				_	ips_wdata[7:0]	_	_
	1	0		1	Х	_	_	ips_wdata[15:8]	-
	1	1				_	_	_	ips_wdata[7:0]
	0	0	32-bit	Х	Х	ips_wdata[31:24]	_	_	_
	0	1				_	ips_wdata[23:16]	_	_
	1	0		Х	Х	_	_	ips_wdata[15:8]	_
	1	1				_	-	_	ips_wdata[7:0]
Half	0	NA	8-bit	0	0	ips_wdata[7:0]	_	_	_
Word					1	_	ips_wdata[7:0]	_	_
	1			1	0	_	_	ips_wdata[7:0]	_
					1	_	_	_	ips_wdata[7:0]
	0		16-bit	0	Х	ips_wdata[15:8]	ips_wdata[7:0]	_	_
	1			1	Х	_	_	ips_wdata[15:8]	ips_wdata[7:0]
	0		32-bit	Х	Х	ips_wdata[31:24]	ips_wdata[23:16]	_	_
	1			Х	Х	_	_	ips_wdata[15:8]	ips_wdata[7:0]
Word	NA	NA	8-bit	0	0	ips_wdata[7:0]	_	_	_
					1	_	ips_wdata[7:0]	_	_
				1	0	_	_	ips_wdata[7:0]	_
					1	_	_	_	ips_wdata[7:0]
			16-bit	0	Х	ips_wdata[15:8]	ips_wdata[7:0]	_	_
				1	Х	_	_	ips_wdata[15:8]	ips_wdata[7:0]
			32-bit	Х	Х	ips_wdata[31:24]	ips_wdata[23:16]	ips_wdata[15:8]	ips_wdata[7:0]

Overview

Table 7-3. R-AHB to IP Bus Interface Operation (Little Endian—Read Operation)

Iransfer Rus				ctive Bus Section (IP Bus to R-AHB)				
Size	[1]	[0]	Size	[1]	[0]	R-AHB [31:24]	R-AHB [23:16]	R-AHB [15:8]	R-AHB [7:0]
Byte	0	0	8-bit	0	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
	0	1		0	1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
	1	0		1	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
	1	1		1	1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
	0	0	16-bit	0	Х	_	_	ips_rdata[15:8]	ips_rdata[7:0]
	0	1				_	_	ips_rdata[15:8]	ips_rdata[7:0]
	1	0		1	Х	ips_rdata[15:8]	ips_rdata[7:0]	-	_
	1	1				ips_rdata[15:8]	ips_rdata[7:0]	-	_
	0	0	32-bit	Х	Х	-	_	-	ips_rdata[7:0]
	0	1				_	_	ips_rdata[15:8]	_
	1	0		Х	Х	-	ips_rdata[23:16]	_	_
	1	1				ips_rdata[31:24]	_	_	_
Half	0	NA	8-bit	0	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
Word					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
	1			1	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
	0		16-bit	0	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]
	1			1	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]
	0		32-bit	Х	Х	-	_	ips_rdata[15:8]	ips_rdata[7:0]
	1			Х	Х	ips_rdata[31:24]	ips_rdata[23:16]	_	_
Word	NA	NA	8-bit	0	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
				1	0	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
					1	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]	ips_rdata[7:0]
			16-bit	0	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]
				1	Х	ips_rdata[15:8]	ips_rdata[7:0]	ips_rdata[15:8]	ips_rdata[7:0]
			32-bit	Х	Х	ips_rdata[31:24]	ips_rdata[23:16]	ips_rdata[15:8]	ips_rdata[7:0]

7-6 Freescale Semiconductor

Table 7-4. R-AHB to IP Bus Interface Operation (Little Endian—Write Operation)

Transfer	ha	ddr	IP Bus	ips_	addr	Α	Active Bus Section (R-AHB to IP Bus)				
Size	[1]	[0]	Size	[1]	[0]	R-AHB [31:24]	R-AHB [23:16]	R-AHB [15:8]	R-AHB [7:0]		
Byte	0	0	8-bit	0	0	-	_	_	ips_wdata[7:0]		
	0	1		0	1	-	_	ips_wdata[7:0]	_		
	1	0		1	0	-	ips_wdata[7:0]	_	-		
	1	1		1	1	ips_wdata[7:0]	-	-	_		
	0	0	16-bit	0	Х	-	_	-	ips_wdata[7:0]		
	0	1				_	_	ips_wdata[15:8]	_		
	1	0		1	Х	_	ips_wdata[7:0]	_	_		
	1	1				ips_wdata[15:8]	_	_	_		
	0	0	32-bit	Х	Х	-	_	-	ips_wdata[7:0]		
	0	1				_	-	ips_wdata[15:8]	_		
	1	0		Х	Х	-	ips_wdata[23:16]	-	_		
	1	1				ips_wdata[31:24]	-	-	_		
Half	0	NA	8-bit	0	0	_	_	_	ips_wdata[7:0]		
Word					1	_	_	ips_wdata[7:0]	-		
	1			1	0	-	ips_wdata[7:0]	-	_		
					1	ips_wdata[7:0]	_	_	_		
	0		16-bit	0	Х	-	_	ips_wdata[15:8]	ips_wdata[7:0]		
	1			1	Х	ips_wdata[15:8]	ips_wdata[7:0]	_	_		
	0		32-bit	Х	Х	_	_	ips_wdata[15:8]	ips_wdata[7:0]		
	1			Х	Х	ips_wdata[31:24]	ips_wdata[23:16]	_	_		
Word	NA	NA	8-bit	0	0	_	_	_	ips_wdata[7:0]		
					1	_	_	ips_wdata[7:0]	_		
				1	0	_	ips_wdata[7:0]	_	_		
					1	ips_wdata[7:0]	_	_	_		
			16-bit	0	Χ	_	_	ips_wdata[15:8]	ips_wdata[7:0]		
				1	Χ	ips_wdata[15:8]	ips_wdata[7:0]	_	_		
			32-bit	Х	Χ	ips_wdata[31:24]	ips_wdata[23:16]	ips_wdata[15:8]	ips_wdata[7:0]		

7.2 Programming Model

There are six registers that reside inside the AIPI module. Two system clocks are required for read accesses and three system clocks are required for write accesses to the AIPI registers. Table 7-5 is a summary of these registers and their addresses.

Table 7-5. AIPI Module Register Memory Map

Description	Name	Address
	AIPI1	
AIPI1 Peripheral Size Register 0	PSR0_1	0x00200000
AIPI1 Peripheral Size Register 1	PSR1_1	0x00200004
AIPI1 Peripheral Access Register	PAR_1	0x00200008
AIPI1 Peripheral Control Register	PCR_1	0x0020000C
AIPI1 Time-Out Status Register	TSR_1	0x00200010
	AIPI2	
AIPI2 Peripheral Size Register 0	PSR0_2	0x00210000
AIPI2 Peripheral Size Register 1	PSR1_2	0x00210004
AIPI2 Peripheral Access Register	PAR_2	0x00210008
AIPI2 Peripheral Control Register	PCR_2	0x0021000C
AIPI2Time-Out Status Register	TSR_2	0x00210010

Table 7-6 illustrates the peripheral address associated with the corresponding module_en number. Refer to Chapter 3, "Memory Map," to see the corresponding address assigned to each peripheral.

Table 7-6. Peripheral Address MODULE_EN Numbers

AIPI 1		AIPI 2	
Address	MODULE_EN	Address	MODULE_EN
0x0020 1000 – 0x0020 1FFF	1	0x0021 1000 – 0x0021 1FFF	1
0x0020 2000 – 0x0020 2FFF	2	0x0021 2000 – 0x0021 2FFF	2
0x0020 3000 – 0x0020 3FFF	3	0x0021 3000 - 0x0021 3FFF	3
0x0020 4000 – 0x0020 4FFF	4	0x0021 4000 - 0x0021 4FFF	4
0x0020 5000 – 0x0020 5FFF	5	0x0021 5000 - 0x0021 5FFF	5
0x0020 6000 – 0x0020 6FFF	6	0x0021 6000 - 0x0021 6FFF	6
0x0020 7000 – 0x0020 7FFF	7	0x0021 7000 – 0x0021 7FFF	7
0x0020 8000 – 0x0020 8FFF	8	0x0021 8000 - 0x0021 8FFF	8
0x0020 9000 – 0x0020 9FFF	9	0x0021 9000 – 0x0021 9FFF	9
0x0020 A000 – 0x0020 AFFF	10	0x0021 A000 – 0x0021 AFFF	10
0x0020 B000 – 0x0020 BFFF	11	0x0021 B000 – 0x0021 BFFF	11

MC9328MXS Reference Manual, Rev. 1

7-8 Freescale Semiconductor

Table 7-6. Peripheral Address MODULE_EN Numbers (continued)

AIPI 1		AIPI 2				
Address	MODULE_EN	Address	MODULE_EN			
0x0020 C000 – 0x0020 CFFF	12	0x0021 C000 – 0x0021 CFFF	12			
0x0020 D000 – 0x0020 DFFF	13	0x0021 D000 – 0x0021 DFFF	13			
0x0020 E000 – 0x0020 EFFF	14	0x0021 E000 – 0x0021 EFFF	14			
0x0020 F000 – 0x0020 FFFF	15	0x0021 F000 – 0x0021 FFFF	15			

Programming Model

Peripheral Size Registers[1:0] 7.2.1

These registers control the size of the IP bus peripheral in each IP bus peripheral location. Peripheral locations that are not occupied must have their corresponding bits in the PSRs (Peripheral Size Registers) programmed to 1 in each register.

The least significant bit in the PSRs is a read only bit as it governs the AIPI registers themselves. They are set and cleared appropriately to indicate the registers are 32 bits. Bits 31 through 16 in both registers are preset to 1 and the fields are reserved and can only be read.

7.2.1.1 AIPI1 Peripheral Size Register 0 and AIPI2 Peripheral Size Register 0

PSR0_ PSR0_	_			AIPI2 Peripheral Size Register 0												
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE																
III				_						_			_			
PSR0_1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET								0xFF	FF							
PSR0_2	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET								0xFF	FF							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							МС	D_EN_I	L							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r
PSR0_1	1	1	1		1		0	0	0	0	0	0	0	0	0	0
RESET								0x								
PSR0_2	1	1		0	0	1	0	0	0			1	0	0		0
RESET								0x								

Table 7-7. AIPI1 Peripheral Size Register 0 and AIPI2 Peripheral Size Register 0 Description

Name	Description Settings								
Reserved Bits 31–16	Reserved—These bits are reserved and should read 1.	d—These bits are reserved and should read 1.							
MOD_EN_L Bits 15–1	Module_En (lower)—Each bit represents the lower bit of the 2-bit field (PSR1 + PSR0) that represents the Module_En number.	See Table 7-9 for bit settings							
Reserved Bit 0	Reserved—This bit is reserved and should read 0.								

7.2.1.2 AIPI1 Peripheral Size Register 1 and AIPI2 Peripheral Size Register 1

PSR1 PSR1	_	,												Addr 0x00200004 0x00210004		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE																
PSR_1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET	0xFFFF															
PSR_2	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET																
ВІТ	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	MOD_EN_U															
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r
PSR_1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET	0xFFFF															
PSR_2	1	1	1	1	1	0	1	1	1	1	1	0	1	1	1	1
RESET								0xFB	EF							

Table 7-8. AIPI1 Peripheral Size Register 1 and AIPI2 Peripheral Size Register 1 Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 1.	
MOD_EN_U Bits 15–1	Module_En (upper) —Each bit represents the upper bit of the 2-bit field (PSR1 + PSR0) that represents the Module_En number.	See Table 7-9 for bit settings
Reserved Bit 0	Reserved—This bit is reserved and should read 0.	

The PSRs work together to indicate the size of the IP bus peripheral occupying the corresponding <code>ips_module_en</code> location, or to indicate there is no IP bus peripheral occupying the corresponding <code>ips_module_en</code> location. A good example of how the PSRs work is the AIPI registers themselves. When haddr[16:12] is decoded to select the AIPI registers, {PSR1[bit0], PSR0[bit0]} returns a value of 10, indicating that the AIPI registers are word width registers. Table 7-9 shows how to program the PSR registers based on the size or availability of an IP bus peripheral.

Table 7-9.	PSR Data	Bus Size	Encoding
-------------------	----------	-----------------	-----------------

PSR[1:	0] Bits	IP Bus Peripheral Size [x]
PSR1[x]	PSR0[x]	(module_en [x])
0	0	8-bit
0	1	16-bit
1	0	32-bit
1	1	Unoccupied

7.2.2 Peripheral Access Registers

These registers are used to tell the AIPI whether or not the IP bus peripheral corresponding to the bit location in the register may be accessed in user mode. If the peripheral may be accessed in supervisor mode only and a user mode access is attempted an abort will be generated and no IP bus activity occurs. If the peripheral can be accessed in user mode, then the IPS_SUPERVISOR_ACCESS bit reflects whether the attempted access is in supervisor or user mode and the peripheral itself can decide whether to accept a user access (if one is attempted) or issue an error response.

The least significant bit in the PAR is a read only bit as it governs the AIPI registers themselves. It is set to indicate supervisor access only. Bits 31 through 16 in both registers are preset to 1 and the fields are reserved and can only be read.

PAR_1 AIPI1 Peripheral Access Register PAR_2 AIPI2 Peripheral Access Register									Addr 0x00200008 0x00210008							
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE																
PAR_1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET	0xFFFF															
PAR_2	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET	0xFFFF															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	ACCESS															
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r
PAR_1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET	0xFFFF															
PAR_2	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET								0xFF	FF							

7-12 Freescale Semiconductor

Table 7-10. Peripheral Access Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 1.	
ACCESS Bits 15–1	Access Control—Each bit controls the access mode of the corresponding peripheral.	 0 = Assigned peripheral determines access mode. 1 = the corresponding peripheral is a supervisor access only peripheral.
Reserved Bit 0	Reserved—This bit is reserved and should read 1.	

7.2.3 Peripheral Control Register

These registers are to tell the AIPI whether or not the IP bus peripheral corresponding to the bit location in the register can be accessed in their natural size only. When set to 1, only byte access is allowed on an 8-bit peripheral, only halfword access is allowed on a 16-bit peripheral, and only word access is allowed on a 32-bit peripheral. When set to 1, any access other than natural size that is attempted on the peripheral results in an error response and no IP bus activity occurs.

The least significant bit in the PCR is a read-only bit and the AIPI registers are not governed by this bit. Bits 31 through 16 in both registers are preset to 0 and the fields are reserved and can only be read.

PCR_2	-									Addr 0x0020000C 0x0021000C						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE																
PCR_1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
PCR_2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							ACCE	SS_MO	DE							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	r						
PCR_1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
PCR_2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							

Freescale Semiconductor 7-13

Programming Model

Table 7-11. Peripheral Control Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read zero.	
ACCESS_MODE Bits 15–1	Module Access Mode—Each bit controls the method of access used by the corresponding peripheral assigned to the Module_en.	0 = sub-word and word access is allowed on the peripheral 1 = corresponding peripheral can only be accessed in the natural size. i.e. byte accesses on 8-bit peripherals, half-word accesses on 16-bit peripherals and word accesses on 32-bit peripherals.
Reserved Bit 0	Reserved—This bit is reserved and should read 1.	

7.2.4 Time-Out Status Register

These registers contain status of the AIPI module prior to the occurrence of the time-out event. The Time-Out registers are read-only and status is updated due to time-out operation and module_en must be active. The register is clear during initial reset.

TSR_1 TSR_2	<u> </u>								Addr 0x00200010 0x00210010							
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	ТО	RW					ADE	R					BE4	BE3	BE2	BE1
TYPE	rw	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
TSR_1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
TSR_2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							MOE	ULE_E	N							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
TSR_1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
TSR_2	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							

7-14 Freescale Semiconductor

Table 7-12. Time-Out Status Register Description

Name	Description	Settings
TO Bit 31	Time-Out —This bit when set to 1 indicates a time-out event and may be cleared by the user.	0 = No time-out event 1 = time-out event
RW Bit 30	This bit contains the ips_rwb status prior to time-out event.	-
ADDR Bits 29–20	Address—These bits contains the ips_addr[11:2] status prior to time-out event.	-
BE4 Bit 19	This bit contains the ips_byte_31_24 status prior to time-out event.	-
BE3 Bit 18	This bit contains the ips_byte_23_16 status prior to time-out event.	-
BE2 Bit 17	This bit contains the ips_byte_15_8 status prior to time-out event.	-
BE1 Bit 16	This bit contains the ips_byte_7_0 status prior to time-out event.	-
MODULE_EN Bits 15–1	Module Enable Status —These bits contains the module_en[15:1] status prior to time-out event. Refer to Table 7-6 to determine which peripheral is assigned to which module_en number.	0= Corresponding module has not timed out 1 = Corresponding module has timed out
Reserved Bit 0	Reserved—This bit is reserved and should read 0.	

7.3 Programming Example

This section covers programming examples written in assembly code to illustrate the data access through the AIPI module.

7.3.1 Data Access to 8-Bit Peripherals

The followings codes are executed with the ARM920T core set to big and little endian modes:

```
r0,
                =0x11223344
LDR
                =0x55667788
LDR
        r1,
LDR
                =8BIT PERIPHERAL_ADDRESS
        r2,
                [r2, \overline{\#}0x0]
STRB
        r0,
STRB
                [r2, #0x1]
        r1,
                [r2, #0x2]
[r2, #0x4]
STRH
        r0,
STR
        r1,
LDRB
        r3,
                 [r2, #0x0]
                 [r2, #0x1]
[r2, #0x2]
LDRB
        r4,
LDRH
        r5,
LDR
                 [r2, #0x4]
        r6,
```

The Table 7-13 on page 7-16 illustrates the difference in the 8-bit peripheral register content.

Freescale Semiconductor 7-15

Table 7-13. Core and 8-Bit Peripheral Register Content After Code Execution

Address	Peripheral Registers					
0	44		-			
1	88		-			
2	44		-			
3	33		_			
4	88		_			
5	77	-				
6	66		-			
7	55		-			
Address	С	ore Re	egiste	rs		
r3	00	00	00	44		
r4	00	00	00	88		
r5	00	00 33 44				
r6	55	66	77	88		

7.3.2 Data Access to 16-Bit Peripherals

The followings codes are executed with the ARM core set to big and little endian modes.

```
LDR
        r0,
                =0x11223344
LDR
        r1,
               =0x55667788
               =16BIT PERIPHERAL_ADDRESS
LDR
        r2,
       r0,
STRB
                [r2, \#\overline{0}x0]
                [r2, #0x1]
[r2, #0x2]
STRB
        r1,
STRH
        r0,
                [r2, #0x4]
STR
        r1,
LDRB
        r3,
                [r2, #0x0]
LDRB
        r4,
                [r2, #0x1]
LDRH
        r5,
                [r2, #0x2]
LDR
                [r2, #0x4]
        r6,
```

The Table 7-14 and Table 7-15 illustrate the difference in the 16-bit peripheral register content.

Table 7-14. Core and 16-Bit Peripheral Register Content (Little Endian)

Address	Peripheral Registers							
0	88	44	-					
2	33	44	_					
4	77	88	_					

MC9328MXS Reference Manual, Rev. 1

7-16 Freescale Semiconductor

Table 7-14. Core and 16-Bit Peripheral Register Content (Little Endian) (continued)

Address	Peripheral Registers						
6	55	66	_				
Address	Core Registers						
r3	00	00	00	44			
r4	00	00	00	88			
r5	00	00	33	44			
r6	55	66	77	88			

Table 7-15. Core and 16-Bit Peripheral Register Content (Big Endian)

Address	Peripheral Registers						
0	44	88	_				
2	33	44	_				
4	55	66	_				
6	77	88	_				
	Core Registers						
Address	С	ore Re	egiste	rs			
Address r3	00	ore Re	egiste 00	r s 44			
r3	00	00	00	44			

7.3.3 Data Access to 32-Bit Peripherals

The followings codes are executed with the ARM core set to big and little endian modes.

```
LDR
        r0,
                =0x11223344
        r1,
LDR
                =0x55667788
               =32BIT_PERIPHERAL_ADDRESS
[r2, #0x0]
LDR
        r2,
STRB
        r0,
                [r2, #0x1]
STRB
        r1,
STRH
        r0,
                        [r2, #0x2]
        r1,
                [r2, #0x4]
STR
                [r2, #0x0]
LDRB
        r3,
               [r2, #0x1]
[r2, #0x2]
[r2, #0x4]
LDRB
        r4,
LDRH
        r5,
LDR
        r6,
```

The Table 7-16 and Table 7-17 on page 7-18 illustrate the difference in the 32-bit peripheral register content.

Freescale Semiconductor 7-17

Table 7-16. Core and 32-bit Peripheral Register Content (Little Endian)

Address	Peripheral Registers						
0	33	44	88	44			
4	55	66	77	88			
Address	Core Registers						
r3	00	00	00	44			
r4	00	00	00	88			
r5	00	00	33	44			
r6	55	66	77	88			

Table 7-17. Core and 32-bit Peripheral Register Content (Big Endian)

Address	Peripheral Registers						
0	44	88	33	44			
4	55	66	77	88			
Address	С	ore Re	egiste	rs			
r3	00	00	00	44			
r4	00	00 00 00 88					
r5	00 00 33 44						
r6	55	88					

7.3.4 Special Consideration for Non-Natural Size Access

A programmer must exercise care when accessing peripherals using access other than their natural size. An example of such access includes byte access to a 32-bits peripheral and word access to 8-bit peripheral. The examples in the previous section clearly illustrate the difference in byte accessing a 32-bits peripheral in both big and little endian modes. An instruction such as:

is accessing using byte lane[15:8] in little endian, while byte lane[23:16] is accessed using big endian mode. Therefore, if a programmer is using byte access to set up control information in 32-bit register, extreme care must be taken to ensure the desired byte is written during the desired endian mode.

Chapter 8 System Control

This chapter describes the system control module of the MC9328MXS microprocessor. The system control module enables system software to control, customize, or read the status of the following functions:

- Multiplexing of SSI signals
- Multiplexing of the SDRAM/SyncFlash chip select signal
- Chip ID
- System boot mode selection

8.1 Programming Model

The system control module includes four user-accessible 32-bit registers. Table 8-1 summarizes these registers and their addresses.

Table 8-1. System Control Module Register Memory Map

Description	Name	Address
Silicon ID Register	SIDR	0x0021B804
Function Multiplexing Control Register	FMCR	0x0021B808
Global Peripheral Control Register	GPCR	0x0021B80C
Global Clock Control Register	GCCR	0x0021B810

Freescale Semiconductor 8-1

Programming Model

8.1.1 Silicon ID Register

This 32-bit read-only register shows the chip identification. The bit assignments for the register are shown in the following register display. The settings for the bits in the register are listed in Table 8-2.

SIDR					Sil	icon	ID F	Regis	ter					02	<002 1	Addr IB804
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	SID															
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1
HLOLI								0x04	D4							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								SIE)							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	1	0	0	1	0	0	0	0	0	0	0	1	1	1	0	1
TILOLI								0xC0	1D							

Table 8-2. Silicon ID Register Description

Name	Description	Settings
SID Bits 31–0	Silicon ID—Contains the chip identification number of the MC9328MXS.	Silicon ID: Mask 1L = 0x04D4 C01D Mask 2L = 0x00D4 C01D

8.1.2 Function Multiplexing Control Register

The Function Multiplexing Control Register (FMCR) controls the multiplexing of the signal lines shared by the SSI module. It also controls the SDRAM/SyncFlash chip select lines and masking of the external bus request. See Table 8-3 for detailed description of bit settings.

FMCR	Function Multiplexing Control Register								0х	Addr 0x0021B808						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0:	x0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
									SSI_RXFS_SEL	SSI_RXCLK_SEL	SSI_RXDAT_SEL	SSI_TXFS_SEL	SSI_TXCLK_SEL	EXT_BR_EN	SDCS1_SEL	SDCS0_SEL
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1
								0:	x0003							

Table 8-3. Function Multiplexing Control Register Description

Name	Description	Settings
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.	
SSI_RXFS_SEL Bit 7	SSI Receive Frame Sync Input Select—Selects the Receive Frame Sync input source. See Figure 24-1 on page 24-2.	0 = input from Port C 1 = input from Port B
SSI_RXCLK_SEL Bit 6	SSI Receive Clock Select—Selects the Receive Clock input source. See Figure 24-1 on page 24-2.	0 = input from Port C 1 = input from Port B
SSI_RXDAT_SEL Bit 5	SSI Receive Data Select—Selects the Receive Data input source. See Figure 24-1 on page 24-2.	0 = input from Port C 1 = input from Port B
SSI_TXFS_SEL Bit 4	SSI Transmit Frame Sync Select —Selects the Transmit Frame Sync input source. See Figure 24-1 on page 24-2.	0 = input from Port C 1 = input from Port B
SSI_TXCLK_SEL Bit 3	SSI Transmit Clock Select—Selects the Transmit Clock input source. See Figure 24-1 on page 24-2.	0 = input from Port C 1 = input from Port B
EXT_BR_EN Bit 2	External Bus Request Control—Chooses whether the external bus request function is masked or enabled. The external bus request is a test signal and the EXT_BR_EN bit must be clear during normal operation.	0 = External bus request masked 1 = External bus request enabled
SDCS1_SEL Bit 1	SDRAM/SyncFlash Chip-Select—Selects the function of the CS3/CSD1 pin.	0 = CS3 selected 1 = CSD1 selected
SDCS0_SEL Bit 0	SDRAM/SyncFlash Chip-Select—Selects the function of the CS2/CSD0 pin.	0 = CS2 selected 1 = CSD0 selected

Freescale Semiconductor 8-3

Programming Model

8.1.3 Global Peripheral Control Register

The Global Peripheral Control Register (GPCR) controls the driving force parameters of the bus and several other functions in the MC9328MXS. Descriptions of the register settings appear in Table 8-6.

GPCR	Global Peripheral Control Register								0x	Addr 0x0021B80C						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x0	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	MEMC_TEST_EN				WO IS SO		DS CNTL		DS ADDB		DS DATA	l	IP_CLK_GATING_EN	HCLK_GATING_EN		
TYPE	rw	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	w	rw	rw
RESET	0	0	0	0	0	0	1	1	1	1	1	1	1	0	1	1
HESET								0x03	BFC							

Table 8-4. Global Peripheral Control Register Description

Name	Description	Settings				
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.					
MEMC_TEST_EN Bits15	Active high of this bit switches the inner test signals from MEMC to GPIO for debug purposes.	0 = Normal 1 = Switch MEMC inner test signals to GPIO for debug purpose.				
Reserved Bits 14–12	Reserved—These bits are reserved and should read 0.					
DS_SLOW Bits 11–10	Driving Strength Slow I/O —Controls the driving strength of all slow I/O signals.	00 = 26 MHz/15 pF 01 = 26 MHz/30 pF 10 = 26 MHz/45 pF 11 = 26 MHz/greater than 45 pF				
DS_CNTL Bits 9–8	Driving Strength Bus Control Signals —Controls the driving strength of bus control signals.	00 = 50 MHz/15 pF 01 = 50 MHz/30 pF 10 = 100 MHz/15 pF 11 = 100 MHz/30 pF				

8-4 Freescale Semiconductor

Table 8-4. Global Peripheral Control Register Description (continued)

Name	Description	Settings
DS_ADDR Bits 7–6	Driving Strength Address Bus —Controls the driving strength of the address bus.	00 = 50 MHz/15 pF 01 = 50 MHz/30 pF 10 = 100 MHz/15 pF 11 = 100 MHz/30 pF
DS_DATA Bits 5–4	Driving Strength Data Bus —Controls the driving strength of the data bus.	00 = 50 MHz/15 pF 01 = 50 MHz/30 pF 10 = 100 MHz/15 pF 11 = 100 MHz/30 pF
IP_CLK_GATING_EN Bit 3	IP Clock Gating Enabled—Controls ips_gated_clk signal.	0 = ips_gated_clk is continuous clock 1 = ips_gated_clk will be gated by aipi1_gated_clk_en or aipi2_gated_clk_en
HCLK_GATING_EN Bit 2	HCLK_GATING_Enabled—This bit only applies to functional and register access clocks; DMA and AITC. The functional clock and register access clock can be either a gated clock or continuous clock. Low value of this bit can disable clock gating for DMA/ AITC and make their clock become a continuous clock. This bit is write only and when read, will always be 0. Note: Clocks of DMA/DSPA can also be turned off by corresponding bits in GCCR. When their clocks are turned off in GCCR, this bit has no effect on these modules because their clocks are off. Please refer GCCR register description for detail information.	1 = hclk gating enabled, some hclk to DMA/AITC/ is gated clock 0 = hclk gating disabled, all hclk becomes continuous clock
Reserved Bit 1–0	Reserved—These bits are reserved and should read 1.	<u> </u>

Freescale Semiconductor 8-5

Programming Model

8.1.4 Global Clock Control Register

The Global Clock Control Register (GCCR) provides additional power saving capabilities by controlling the clocks in the following MC9328MXS modules: DMA and USB. It also controls the clock source for Bootstrap mode.

GCCR					Glo	obal	Cloc	k Co	ontro	l Re	giste	er			0x002	Addr 1B810
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NLOLI										0x0	000					
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												BROM_CLK_EN	DMA_CLK_EN			USBD_CLK_EN
TYPE	r	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1
TILOLI										0x0	00F					

Table 8-5. Global Clock Control Register Description

Name	Description	Settings						
Reserved Bits 31–5	Reserved—These bits are reserved and should read 0.	ved—These bits are reserved and should read 0.						
BROM_CLK_EN Bit 4	BROM Clock Enable—Only available in Bootstrap mode. This bit enables/disables the operational system boot mode of the MC9328MXS upon system reset. The boot mode is determined by the settings of these pins.	0 = Clock gating is controlled by setting of BOOT[3:0] pins. 1 = Overrides the setting of the BOOT[3:0] pins and forces the HCLK to be used as clock.						
DMA_CLK_EN Bit 3	DMA Clock Enable —Enables/Disables clock input to the DMA module.	0 = DMA clock input is disabled. 1 = DMA clock input is enabled (default).						
Reserved Bit 2–1	Reserved—These bits are reserved	0 = Perferred setting. Used to minimize power consumption. 1 = Default.						
USBD_CLK_EN Bit 0	USBD Clock Enable—Enables/Disables clock input to the USB module.	0 = USB clock input is disabled. 1 = USB clock input is enabled (default).						

8.2 System Boot Mode Selection

The operational system boot mode of the MC9328MXS upon system reset is determined by the configuration of the four external input pins BOOT[3:0]. The settings of these pins control the following functions:

- CS0 boot function of the EIM module
- Control of the SyncFlash chip select (CSD1) boot function of the SDRAM controller

The settings of the system control module for the system boot mode selection are displayed in Table 8-6.

The MC9328MXS always begins fetching instructions from address 0x000000000 after reset. The BOOT[3:0] pins control the memory region that is mapped to address 0x0. The boot modes are defined in Table 8-6. The BOOT[3:0] pins also control the initial configuration (for example bus width) for the external memory regions. When an external chip select is enabled by the BOOT[3:0] pins, the first 1 Mbyte range (0x0000000–0x000FFFFF) of the chip select's memory space is also mapped to address 0x0.

For example, by setting BOOT[3:0] to 0110, the MC9328MXS will boot from the CS0 memory region using a 32-bit data bus width. The first 1 Mbyte of the CS0 memory space (0x10000000–0x100FFFFF) will be mapped to addresses 0x00000000–0x000FFFFF.

NOTE:

The BOOT pins must not change once the MC9328MXS is out of reset. To achieve logic 0, a BOOT input must be tied to GND through a 1 kohm resistor. Otherwise, excessive current may occur at power up. BOOT[3] must always be terminated with a 1 kohm resistor to GND.

NOTE:

If Bootstrap ROM is not selected for the boot mode, the internal ROM is not accessible.

Table 8-6. System Boot Mode Selection

Inputs BOOT[3:0]	Output Signals Active Device
0000	Bootstrap ROM
0001	16-bit SyncFlash D[15:0]
0010	32-bit SyncFlash
0011	8-bit CS0 at D[7:0]
0100	16-bit CS0 at D[31:16]
0101	16-bit CS0 at D[15:0]
0110	32-bit CS0 at D[31:0]
0111	Reserved

Freescale Semiconductor 8-7

System Boot Mode Selection

8-8 Freescale Semiconductor

Chapter 9 Bootstrap Mode Operation

Bootstrap mode is designed to allow you to initialize a target system and download programs or data to the target system's RAM using the UART 1 or UART 2 controller. After a program is downloaded, it can be executed, which gives you a simple debugging environment for failure analysis and a channel to update programs stored in flash memory. Bootstrap mode has the following capabilities:

- Allows you to initialize your system and download programs and data to system memory using UART 1 or UART 2.
- Accepts execution commands to run programs stored in system memory
- Supports memory and register read and write operations of selectable data size (byte, half-word, or word)
- Provides an 8-word instruction buffer for ARM920T vector table storage, instruction storage and execution

9.1 Operation

In bootstrap mode, only MC9328MXS's UART 1 and UART 2 controllers are initialized. They are configured to auto-baud detection mode, ignore RTS, keep CTS always active, no parity, 8-bit character length, and one stop bit. Then they are ready to accept bootstrap data download. The first character received must be a or A. This character determines the baud rate to be used and which UART port is being used for bootstrapping. The first character is not part of a program or data being downloaded. To download the data or program, the code must be converted to a bootstrap format file, which is a text file that contains bootstrap records. A DOS-executable program, STOB.EXE, can be downloaded from the i.MX Web site to convert an S-record file to a bootstrap format file.

The MC9328MXS's internal registers must be initialized as the target system before a program can be downloaded to system memory. Because these internal registers can be treated as a type of memory, each of them can be initialized by issuing a bootstrap record.

The bootstrap design provides an 8-word instruction buffer to which ARM920T core instructions can be downloaded. The buffers are word-access only. This feature enables the ARM920T core instructions to be run even if the memory systems are disabled or in a core stand-alone system. The instruction buffer starts at 0x00000004. Regardless of the operation (initializing internal registers, downloading a program to system RAM, or issuing a core instruction), bootstrap mode will only accept bootstrap record transfers that are made with the UART. The record type determines what action will occur.

The instruction buffer allows users to download the vector table onto the buffer without the use of external ROM or Flash, the feature provides a fast and easy environment to users when using IRQ during program debug.

9.1.1 Entering Bootstrap Mode

Bootstrap mode is the debug mode of the MC9328MXS. To enter bootstrap mode, the BOOT pins must be properly configured during system reset. After reset, the bootstrap ROM is selected for reset vector fetch cycles.

Freescale Semiconductor 9-1

9.1.2 Bootstrap Record Format

Only bootstrap records (b-records) are accepted for data transfers in bootstrap mode. The b-record format is shown in Table 9-1, and Table 9-2 further defines the COUNT/MODE byte. All b-records are in uppercase. Each byte is represented by two ASCII characters during transfer (for example, a byte of value 0x12 will be represented by the characters 12).

Table 9-1. Bootstrap Record Format

4 Bytes	1 Byte	N (Count) Bytes
Address	Count/mode	Data

Table 9-2. Definition of COUNT/MODE Byte

Bit(s)	Definition	Settings
7–6	Data size	00 = Byte 01 = Half-word 10 = Reserved 11 = Word
5	Read/write flag	0 = Write 1 = Read
4–0	Data count in number of bytes	Value from 0 to 31

NOTE:

- 1. A half-word is defined as 16 bits, while a word is defined as 32 bits.
- 2. The address specified must fall on a data size boundary: for word access, the last 2 bits of the address must be 0, while for half-word access, the last bit of the address must be 0. The data count in the COUNT/MODE byte must be a multiple of the data size: for word access, the data count must be a multiple of four, while for half-word access, the data count must be in multiple of two. If either the address or the data count is not on an appropriate data size boundary, the bootloader program will return a * character (asterisk) to indicate that an error has occurred, and the bootloader will then start waiting for a new b-record.
- 3. During a read operation, a / character (forward slash) is returned after the last data has been returned.
- 4. A data count of zero (disregard the value of data size and the status of the mode flag) has a special meaning: execute from the address specified. In this case, no data will follow the COUNT/MODE byte.

Comments can be added to files of b-records. As described above, the shortest b-record consists of 10 ASCII characters (when the data count is 0) of 0 to 9 or A to F (hexadecimal digits). Comments included must not contain patterns to prevent the comments from being considered a b-record.

9.1.3 Registers Used in Bootloader Program

The bootloader program uses general-purpose registers r5 to r12 as well as r13 as the return register and r14 as the link register. All the other registers can be used by target programs.

MC9328MXS Reference Manual, Rev. 1

9-2 Freescale Semiconductor

9.1.4 Setting Up the RS-232 Terminal

To set up communication between your target system and the PC, set the communication specifications to the baud rate desired, no parity, 8-bit character length, and 1 stop bit. You may pause after each line (b-record) is transferred to make sure each transferred ASCII character is echoed.

After setting up the hardware, powering up the system, and entering bootstrap mode, send an a or A character to the target system to initiate the link. Once the bootloader receives this character, it adjusts the baud rate. If the link is successful, the bootloader will return the special character: (colon) as an acknowledgment.

9.1.5 Changing the Speed of Communication

You can change the communication baud rate after communication is set up in the RS-232 terminal. Simply issue a b-record to re-initialize the baud control register of the UART controller. After the last character of this b-record is sent, the echo of this last character will be transmitted at the new speed. The maximum speed recommended for Bootstrap is 57600 baud.

9.2 B-Record Example

Before you can download a program to system memory, the target system may need to be initialized using the internal registers. An init file can be built using a text editor. Code Example 9-1 initializes the memory location to 0x12345678 in word access mode, the location to 0x7788 in half-word access mode, and the location to 0x55 in byte access mode.

Code Example 9-1. init.b Example

// init.b -- Initialization Example

0000C412345678 initialize 0x0000 to 0x12345678 0006427788 initialize 0x0006 to 0x7788 00090155 initialize 0x0009 to 0x55

With b-records similar to those stated above, a target program can be downloaded to memory and executed from the address chosen with the following b-record:

1122334400 execute from 11223344

The target program may exit and return to the bootloader program by jumping to address 0x00000100, where the bootloader program starts.

9.3 Instruction Buffer Usage

A 8-word instruction buffer is provided for ARM920T core vector table storage, instruction and data storage. The buffer starts at 0x00000004. Up to eight instructions can be loaded to the instruction buffer for execution. Usually, the last instruction is an unconditional jump instruction (jmp) that jumps to the start of the bootloader program (0x00000100).

Code Example 9-2 fills memory locations starting from 0x00310000 to 0x00FF (the length of 0x100) with 0x12345678.

Freescale Semiconductor 9-3

Instruction Buffer Usage

Code Example 9-2. Instruction Buffer Sample

```
r1 = 0x0000
                                                // starting address is 0x00FF
         1dr
         ldr
                  r2 = 0x100
                                                // length is 0x100
                                                // data to fill is 0x12345678
                  r3 = 0x12345678
         ldr
                  r4,=0x00000100
                                                // bootloader program
         ldr
loop:
                  r3,[r1, r2]
                                                // store data
         str
                                                // decrement address
         subs
                  r2,r2, #4
                                                // loop back till r2 down to 0x0
         bne
                  loop
                                                // return to bootloader program
         mov
                  pc, r4
```

Because the instruction buffer is of limited size, the programmer cannot do everything at the same time. The program can be broken into five parts, as shown in Table 9-3.

Table 9-3. Program Breakdown

Part			C	Code
1		ldr mov	r4,=0x00000100 pc, r4	// bootloader address 0x00000100 // return to bootloader program
2		ldr mov	r1,=0x0000 pc, r4	// starting address is 0x0000 // return to bootloader program
3		ldr mov	r2,=0x00000100 pc, r4	// length is 0x100 // return to bootloader program
4		ldr mov	r3,=0x12345678 pc, r4	// data to fill is 0x12345678 // return to bootloader program
5	loop	str subs bne mov	r3,[r1, r2] r2,r2, #4 loop pc, r4	<pre>// store data // decrement address // loop back till r2 down to 0x0 // return to bootloader program</pre>

Breaking down the register initialization into three parts is not mandatory, however it produces similar b-records and therefore is easier to manage.

The resulting b-records appear in Table 9-4.

Table 9-4. Resulting B-Records

B-Record Number	B-Record
1	00000004 08E3A04F40E1A0F004 0000000400
2	00000004 08E3A019C4E1A0F004 0000000400
3	00000004 08E3A02F40E1A0F004 0000000400
4	00000004 0CE59F3000E1A0F00412345678 0000000400
5	00000004 0FE7813002E25220041AFFFFCE1A0F004 0000000400

MC9328MXS Reference Manual, Rev. 1

9-4 Freescale Semiconductor

Note that all b-records start at the same address, 0x00000004, which is the starting address of the instruction buffer. B-records 1, 2, and 3 are very similar and can be used as prototype b-records for general-purpose register initialization.

Therefore, the resulting b-record file will be as follows:

Code Example 9-3. Bootloader B-Record

```
00000004 08E3A04F40E1A0F004initialize r4 to 0x00000100 (bootloader start) 0000000400 execute and return to bootloader 00000004 08E3A019C4E1A0F004initialize r1 to 0x0000 (start) 0000000400 execute and return to bootloader 00000004 08E3A02F40E1A0F004initialize r2 to 0x100 (length) 0000000400 execute and return to bootloader 00000004 0CE59F3000E1A0F00412345678initialize r3 to 0x12345678 (content) 0000000400 execute and return to bootloader 00000004 0FE7813002E25220041AFFFFFCE1A0F004memory fill 0000000400 execute and return to bootloader
```

9.4 Simple Read/Write Examples

Table 9-5 provides examples demonstrating how to perform memory and register reads/writes of various data sizes. Code Example 9-4 shows an example of the code used for Vector Tables

Code Example 9-4.

;	0x00				
NOP		;	0x04	(programmable	buffer)
NOP		;	0x08	(programmable	buffer)
DCD C	IRQ Handler	;	0x0C	(programmable	buffer)
DCD C	_FIQ_Handler	;	0x10	(programmable	buffer)
NOP		;	0x14	(programmable	buffer)
LDR P	C, IRQ Addr	;	0x18	(programmable	buffer)
LDR P	C, FIQ_Addr	;	0x1C	(programmable	buffer)
OCD 0	_	;	0x20	(programmable	buffer)
	NOP NOP DCD C DCD C NOP LDR P LDR P	NOP C_IRQ_Handler CCD C_FIQ_Handler NOP LDR PC, IRQ_Addr LDR PC, FIQ_Addr	NOP ; NOP ; NOP ; DCD C_IRQ_Handler ; DCD C_FIQ_Handler ; NOP ; LDR PC, IRQ_Addr ; LDR PC, FIQ_Addr ;	0x04	; 0x04 (programmable ; 0x08 (programmable ; 0x08 (programmable)CD C_IRQ_Handler ; 0x0C (programmable)CD C_FIQ_Handler ; 0x10 (programmable)CD ; 0x14 (programmable)CDR PC, IRQ_Addr ; 0x18 (programmable)CDR PC, FIQ_Addr ; 0x1C (programmable)CDR

Table 9-5. Read/Write Examples

Example Type	B-Record	Return Value
Read 3 bytes starting from location 0x00310000	0031000023	0031000003XXYYZZ/ (where XX, YY, and ZZ are data in byte)
Read 3 half-words starting from location 0x00310000	0031000066 (6 bytes = 3 half-words)	0031000066XXXXYYYYZZZZ/ (where XXXX, YYYY, and ZZZZ are data in half-word)
Read 3 words starting from location 0x00310000	00310000EC (12 bytes = 3 words)	00310000ECXXXXXXXXYYYYYYYYYZZZZZZZZ/ (where XXXXXXXX, YYYYYYYY, and ZZZZZZZZ are data in word)
Write 3 bytes starting from location 0x00310000	0031000003112233	0031000003112233/
Write 3 half-words starting from location 0x00310000	0031000046111122223333 (6 bytes = 3 half-words)	0031000046111122223333/

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor 9-5

Simple Read/Write Examples

Table 9-5. Read/Write Examples (continued)

Example Type	B-Record	Return Value
Write 3 words starting from location 0x00310000	00310000CC11111111122222222 33333333 (12 bytes = 3 words)	00310000CC1111111122222222333333333/

9.5 Bootloader Flowchart

Figure 9-1 on page 9-7 illustrates how the bootloader program operates inside the MC9328MXS. The bootloader starts when the MC9328MXS enters bootstrap mode.

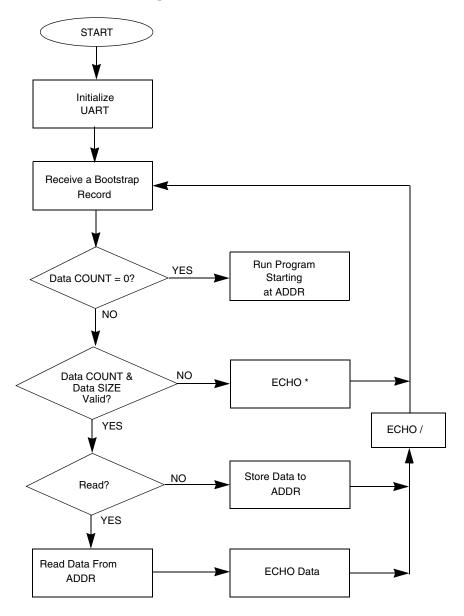


Figure 9-1. Bootloader Program Operation

9.6 Special Notes

The following summary items may be helpful when working in bootstrap mode.

• A b-record is a string of uppercase hex characters with optional comments that follow.

MC9328MXS Reference Manual, Rev. 1

Special Notes

- Comments in a b-record or b-record file must not contain any word or symbol that is longer than nine characters. However, the following characters can be used in a string of any length (all of these have an ASCII code value that is less than 0x30):
 - space
 - ! (exclamation point)
 - " (quotation mark)
 - # (number sign)
 - \$ (dollar sign)
 - % (percentage symbol)
 - & (ampersand)
 - ((opening parenthesis)
 -) (closing parenthesis)
 - * (asterisk)
 - + (plus sign)
 - - (minus sign)
 - . (period)
 - / (forward slash)
 - , (comma)
- The bootloader program echoes all characters being received, however only those having an ASCII code value greater than or equal to 0x30 are kept for b-record assembling. Sending a character that is not a b-record (ASCII code value less than 0x30) will force the bootloader to start a new b-record.
- General-purpose registers –r14 and supervisor scratch register are used by the bootloader program. Writing to these registers may corrupt the bootloader program.
- Please visit the DragonBall Web site for bootstrap utility programs.

Chapter 10 Interrupt Controller (AITC)

This chapter describes the ARM9 Interrupt Controller (AITC) that is used to control and prioritize up to 64 interrupts in the MC9328MXS. This chapter describes the registers and bit settings plus all other information necessary to write the software necessary to write interrupt service routines.

10.1 Introduction

The MC9328MXS interrupt controller (AITC) is a 32-bit peripheral that collects interrupt requests from a maximum of 64 sources and provides an interface to the ARM920T processor.

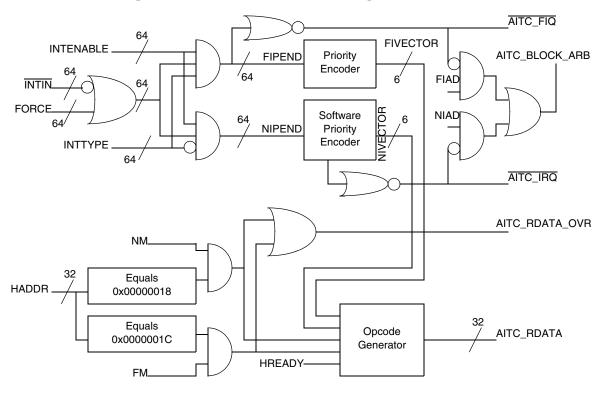


Figure 10-1. AITC Block Diagram

The AITC performs the following functions:

- Supports a maximum of 64 interrupt sources
- Supports fast and normal interrupts
- Selects normal or fast interrupt request for any interrupt source
- Indicates pending interrupt sources via a register for normal and fast interrupts

Freescale Semiconductor 10-1

Operation

- Detects all pending interrupts and distinguishes by priority level
- Independently enables or disables any interrupt source
- Provides a mechanism for software to schedule an interrupt
- Supports a maximum of 16 software controlled priority levels for normal interrupts and priority masking

10.2 Operation

The interrupt controller consists of a set of control registers and associated logic to perform interrupt masking, priority support, and hardware acceleration of normal interrupts.

The interrupt source registers (INTSRCH and INTFRCL) are a pair of 32-bit status registers with a single interrupt source associated with each of the 64 bits. An interrupt line or set of interrupt lines is routed from each interrupt source to the INTSRCH or INTFRCL register. This configuration allows the ARM920T processor of the MC9328MXS to monitor a maximum of 64 distinct interrupt sources.

Interrupt requests can be forcibly asserted through the interrupt force registers (INTFRCH and INTFRCL). Each bit in these registers is logically ORed with the corresponding hardware request line prior to input to the INTSRCH or INTFRCL registers.

There is a corresponding set of interrupt enable registers (INTENABLEH and INTENABLEL), each 32 bits wide, that allow individual bit masking of the INTSRCH and INTFRCL registers. There is also a corresponding set of interrupt type registers (INTTYPEH and INTTYPEL) that selects whether an interrupt source generates a normal or fast interrupt to the ARM920T processor.

There is a corresponding set of normal interrupt pending registers (NIPNDH and NIPNDL) that indicate pending normal interrupt requests, and are equivalent to the logical AND of the interrupt source registers (INTSRCH and INTSRCL), the interrupt enable registers (INTENABLEH and INTENABLEL), and the NOT of the interrupt type registers (INTTYPEH and INTTYPEL). The NIPNDH and NIPNDL register bits are bit-wise NORed together to generate the nIRQ signal that is routed to the ARM920T processor. This ARM920T processor input signal is maskable by the normal interrupt disable bit (I bit) in the program status register (CPSR). The normal interrupt vector register (NIVECSR) indicates the vector index of highest priority pending normal interrupt.

There is a corresponding set of fast interrupt pending registers (FIPNDH and FIPNDL) that indicate pending fast interrupt requests, and are equivalent to the logical AND of the interrupt source registers (INTSRCH and INTSRCL), the interrupt enable registers (INTENABLEH and INTENABLEL), and the interrupt type registers (INTTYPEH and INTTYPEL). The FIPNDH and FIPNDL register bits are bit-wise NORed together to generate the nFIQ signal that is routed to the ARM920T processor. This ARM920T processor input signal is maskable by the fast interrupt disable bit (F bit) in the CPSR. The fast interrupt vector register (FIVECSR) indicates the vector index of highest priority pending fast interrupt.

All interrupt controller registers are readable and writable in supervisor mode only. Writes attempted to read-only registers are ignored. These registers must be written with 32-bit stores only.

The INTFRCH and INTFRCL registers are provided for software generation of interrupts. By enabling interrupts for these bit positions, software can force an interrupt request. This register also provides an alternate method of interrupt assertion for debugging hardware interrupt service routines.

The interrupt requests are prioritized in the following order:

- 1. Fast interrupt requests, in order of highest number
- Normal interrupt requests, in order of highest priority level, then highest source number with the same priority

MC9328MXS Reference Manual, Rev. 1

10-2 Freescale Semiconductor

The AITC provides 16 software controlled priority levels for normal interrupts and every interrupt can be placed in any priority level. The AITC also provides a normal interrupt priority level mask (NIMASK) that disables any interrupt with a priority level less than or equal to the mask. When a level 0 normal interrupt and a level 1 normal interrupt are asserted at the same time, the level 1 normal interrupt is selected unless NIMASK has disabled level 1 normal interrupts. When two level 1 normal interrupts are asserted at the same time, the level 1 normal interrupt with the highest source number is selected unless NIMASK has disabled level 1 normal interrupts.

10.3 AITC Interrupt Controller Signals

The active-low INTIN [63:0] input signals indicate that a peripheral device is requesting an interrupt to the interrupt controller. The interrupt controller recognizes an interrupt is asserted on the rising edge of the clock and does not latch and hold the interrupt. The peripheral must keep the interrupt request asserted until the software acknowledges and clears the interrupt request.

The interrupt source assignment of INTIN [63:0] is shown Table 10-1. Interrupt sources in the table that are labeled 'unused' may be used by software to force an interrupt request for a specific source using either the INTFRCH or INTRFRCL registers.

In Table 10-1, some signals are shown with overbars to represent the logic inside the chip. However, all asserted interrupts result in the associated bit being a 1 in the Interrupt Source Registers

Bit #	Name of Interrupt						
0	Unused	16	Unused	32	Unused	48	USBD_INT [1]
1	Unused	17	RTC_INT	33	Unused	49	USBD_INT [2]
2	Unused	18	RTC_SAM_INT	34	PWM_INT	50	USBD_INT [3]
3	Unused	19	UART2_MINT_PFERR	35	Unused	51	USBD_INT [4]
4	Unused	20	UART2_MINT_RTS	36	Unused	52	USBD_INT [5]
5	Unused	21	UART2_MINT_DTR	37	Unused	53	USBD_INT [6]
6	Unused	22	UART2_MINT_UARTC	38	Unused	54	Unused
7	Unused	23	UART2_MINT_TX	39	I2C_INT	55	Unused
8	Unused	24	UART2_MINT_RX	40	Unused	56	Unused
9	Unused	25	UART1_MINT_PFERR	41	SPI1_INT	57	Unused
10	MSIRQ	26	UART1_MINT_RTS	42	SSI_TX_INT	58	TIMER2_INT
11	GPIO_INT_PORTA	27	UART1_MINT_DTR	43	SSI_TX_ERR_INT	59	TIMER1_INT
12	GPIO_INT_PORTB	28	UART1_MINT_UARTC	44	SSI_RX_INT	60	DMA_ERR
13	GPIO_INT_PORTC	29	UART1_MINT_TX	45	SSI_RX_ERR_INT	61	DMA_INT
14	LCDC_INT	30	UART1_MINT_RX	46	Unused	62	GPIO_INT_PORTD
15	Unused	31	Unused	47	USBD_INT [0]	63	WDT_INT

Table 10-1. Interrupt Assignment

Freescale Semiconductor 10-3

10.4 Programming Model

The AITC module includes 26 user-accessible 32-bit registers. All of these registers are single cycle access because the AITC sits on the native bus of the ARM920T processor. Table 10-2 summarizes these registers and their addresses. Table 10-3 provides an overview of the register fields.

Table 10-2. AITC Module Register Memory Map

Description	Name	Address
Interrupt Control Register	INTCNTL	0x00223000
Normal Interrupt Mask Register	NIMASK	0x00223004
Interrupt Enable Number Register	INTENNUM	0x00223008
Interrupt Disable Number Register	INTDISNUM	0x0022300C
Interrupt Enable Register High	INTENABLEH	0x00223010
Interrupt Enable Register Low	INTENABLEL	0x00223014
Interrupt Type Register High	INTTYPEH	0x00223018
Interrupt Type Register Low	INTTYPEL	0x0022301C
Normal Interrupt Priority Level Register 7	NIPRIORITY7	0x00223020
Normal Interrupt Priority Level Register 6	NIPRIORITY6	0x00223024
Normal Interrupt Priority Level Register 5	NIPRIORITY5	0x00223028
Normal Interrupt Priority Level Register 4	NIPRIORITY4	0x0022302C
Normal Interrupt Priority Level Register 3	NIPRIORITY3	0x00223030
Normal Interrupt Priority Level Register 2	NIPRIORITY2	0x00223034
Normal Interrupt Priority Level Register 1	NIPRIORITY1	0x00223038
Normal Interrupt Priority Level Register 0	NIPRIORITY0	0x0022303C
Normal Interrupt Vector and Status Register	NIVECSR	0x00223040
Fast Interrupt Vector and Status Register	FIVECSR	0x00223044
Interrupt Source Register High	INTSRCH	0x00223048
Interrupt Source Register Low	INTSRCL	0x0022304C
Interrupt Force Register High	INTFRCH	0x00223050
Interrupt Force Register Low	INTFRCL	0x00223054
Normal Interrupt Pending Register High	NIPNDH	0x00223058
Normal Interrupt Pending Register Low	NIPNDL	0x0022305C
Fast Interrupt Pending Register High	FIPNDH	0x00223060
Fast Interrupt Pending Register Low	FIPNDL	0x00223064

10-4 Freescale Semiconductor

Table 10-3. Register Field Summary

Name		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4 3	2	1 0				
INAITIG	R	0	0	0	0	0	0	0	0	0	0	0	20	13	0	0	0	0	0	0	0	0	0			_	_	_	_		0 0				
INTCNTL	W	0	U	U	U	0	U	U	0	U	U	U	NIAD	FIAD	0	0	U	U	0	U	0	U	U	U	U	U	U	,		U					
NIMASK	R	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	NII	MA	ck.				
MINIASK	W																												INI	IVIA	JIX.				
INTENNUM	R	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0 0	0	0 0				
Erurom	W																												ΕN	NUI	Л				
INTDISNUM	R	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0 0	0	0 0				
	W																												DIS	NU	M				
INTENABLEH	R													INTEN	ABLE	E [63	:32]																		
	W																																		
INTENABLEL	R	INTENABLE [31:0]																																	
	W																																		
INTTYPEH	R		INTTYPE [63:32]																																
	W																																		
INTTYPEL	R W													INT	YPE	[31:0	0]																		
	vv R																																		
NIPRIORITY7	W		NIP	PR63 NIPR62 NIPR61 NIPR60						NIP	N	IPR	}	NIPR57			' I	NIPI	R56																
	R																																		
NIPRIORITY6	w		NIP	R55	,		NIPI	R54			NI	PR	53		NIPR	52			NIP	R51		N	IPR	150)	N	PF	349)	NIPI	R48				
	R																																		
NIPRIORITY5	W		NIP	R47	•		NIPI	R46			NI	PR4	15		NIPR	44			NIP	R43		N	IPR	142		N	PF	341		NIPI	R40				
	R																												T						
NIPRIORITY4	W		NIP	R39)		NIPI	R38			NI	PR	37		NIPR	36			NIP	R35		N	IIPR	134	-	N	PF	333	3 1	NIPI	R32				
AUDDIODITI (O	R																																		
NIPRIORITY3	W		NΙΡ	R31			NIPI	H30			NI	PR2	29		NIPR	28			NIP	H27		N	IIPR	126	,	N	PΕ	R25)	NIPI	R24				
NIDDIODITVO	R		NID	Daa	ı,		MID	200			KII	PR2	01		MIDD	20			NID	D10		N I	חסו)10	,	N	рг) 4 T	, ,	יםוו	D16				
NIPRIORITY2	W		INIP	R23)		NIPI	122			IVI	r H2	<u> </u>		NIPR	ZU			NIP	n 19		IN	IIPR	ııd	,	IN	-	317		NIP!	R16				
NIPRIORITY1	R		NID	R15			NIPI	R1/			NII	PR ⁻	13		NIPR	12			NIP	R11		N	IIPR	210	,	N	IP	R9		NIP	Be				
MEDIONITI	W		INIP	1110	'		INIF	114			IVI	ı-Π	10		ואורה	114			ואור	1111		IN	יור' ה	110	'	I۱	115	פרו		יאור	110				
NIPRIORITY0	R		NIF	PR7			NIP	R6			N	IPR	5		NIPF	R4			NIF	R3		N	NIPF	32		N	IIP	R1	T	NIP	R0				
	W			,									-		1									_											
NIVECSR	R								ı	VIVI	ECT	OR											NIF	PRI	LV	L									
	W																																		
FIVECSR	R													FI	VECT	OR																			
	W																																		

Programming Model

Table 10-3. Register Field Summary (continued)

Name		31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8 7	6	5	4 3	2	1 0
INTSRCH	R													IN	IN [6	3:32]														
INTORUM	W																													
INTSRCL	R													IN	TIN [3	31:0]														
INTORIOL	W																													
INTFRCH	R													FOF	RCE [63.33)]													
INTERIOR	W													1 01	iol į	00.02	-1													
INTFRCL	R													FO	RCE	[31:0]	1													
	W													. 0		[01.0	J													
NIPNDH	R													NIPI	END [63:32	2]													
	W																													
NIPNDL	R				ı	ı	ı							NIP	END	[31:0]													
	W																													
FIPNDH	R													FIPE	END [63:32	2]													
11111111	W																													
FIPNDL	R													FIP	END	[31:0]		,											
NBE	W																													

10.4.1 Interrupt Control Register

The Interrupt Control Register (INTCNTL) is located on the ARM920T processor's native bus, is accessible in 1 cycle, and can be accessed only in supervisor mode. This register must be accessed only on word (32-bit) boundaries.

INTCN	CNTL Interrupt Control Register												0x	Addr 0x00223000				
ВІТ	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
												NIAD	FIAD					
TYPE	r	r	r	r	r	r	r	r	r	r	r	rw	rw	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HLJLI	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
TILOLI								0x00	00									

10-6 Freescale Semiconductor

Table 10-4. Interrupt Control Register Description

Name	Description	Settings
Reserved Bits 31–21	Reserved—These bits are reserved and should read 0.	
NIAD Bit 20	Normal Interrupt Arbiter Disable—Enables/Disables the assertion of a bus request to the ARM9 core when the normal interrupt signal (nIRQ) is asserted. When an alternate master has ownership of the bus when a normal interrupt occurs, the bus is given back to the ARM9 core after the DMA device has completed its accesses, so the IRQ_DIS bit does not affect alternate master accesses that are in progress. Note: To prevent an alternate master from accessing the bus during an interrupt service routine, do not clear the interrupt flag until the end of the service routine.	0 = Disregard the normal interrupt flag when evaluating bus requests 1 = Normal interrupt flag prevents alternate masters from accessing the system bus
FIAD Bit 19	Fast Interrupt Arbiter Disable—Enables/Disables the assertion of a bus request to the ARM9 core when the fast interrupt signal (nFIQ) is asserted. When an alternate master has ownership of the bus when a fast interrupt occurs, the bus is given back to the ARM9 core after the DMA device has completed its accesses, so the IRQ_DIS bit does not affect alternate master accesses that are in progress. Note: To prevent an alternate master from accessing the bus during an interrupt service routine, do not clear the interrupt flag until the end of the service routine.	0 = Disregard the fast interrupt flag when evaluating bus requests 1 = Fast interrupt flag prevents alternate masters from accessing the system bus
Reserved Bits 18–0	Reserved—These bits are reserved and should read 0.	I

Freescale Semiconductor 10-7

Programming Model

10.4.2 Normal Interrupt Mask Register

The Normal Interrupt Mask Register (NIMASK) controls the normal interrupt mask level. All normal interrupts with a priority level less than or equal to the NIMASK are disabled. The priority levels of normal interrupts are determined by the normal interrupt priority level registers (NIPRIORITY7, NIPRIORITY6, NIPRIORITY5, NIPRIORITY4, NIPRIORITY3, NIPRIORITY2, NIPRIORITY1, and NIPRIORITY0). The reset state of this register does not disable any normal interrupts.

Writing all 1's, or -1, to the NIMASK sets the normal interrupt mask to -1 and does not disable any normal interrupt priority levels.

This hardware mechanism creates reentrant normal interrupt routines by disabling lower priority normal interrupts. Refer to Section 10.5.6, "Writing Reentrant Normal Interrupt Routines," on page 10-35 for more details on the use of the NIMASK register.

This register is located on the ARM920T processor's native bus, is accessible in 1 cycle, and can be accessed only in supervisor mode. This register must be accessed only on word (32-bit) boundaries.

NIMAS	SK				Nor	mal I	Addr 0x00223004									
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
														NIMASK		
TYPE	r	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
NESEI								0x00	1F							

Table 10-5. Normal Interrupt Mask Register Description

Name	Description	Settings
Reserved Bits 31–5	Reserved—These bits are reserved and should read 0.	
NIMASK Bits 4–0	Normal Interrupt Mask—Controls normal interrupt mask level. All normal interrupts of priority level less than or equal to the NIMASK are disabled. Settings are shown in decimal. Setting bit 4 disables all normal interrupts.	0 = Disable priority level 0 normal interrupts 1 = Disable priority level 1 and lower normal interrupts 16+ = Disable all normal interrupts.

10-8 Freescale Semiconductor

10.4.3 Interrupt Enable Number Register

The Interrupt Enable Number Register (INTENNUM) provides hardware accelerated enabling of interrupts. Any write to INTENNUM enables one interrupt source. For example, when the 6 LSBs = 000000, interrupt source 0 is enabled; when the 6 LSBs = 000001, interrupt source 1 is enabled, and so forth. This register is decoded into a single hot mask that is logically ORed with the INTENABLEH and the INTENABLEL registers.

This hardware mechanism removes the requirement for an atomic read/modify/write sequence to enable an interrupt source. For example, to enable interrupts 10 and 20, the software performs two writes to the AITC: first write 10, then write 20 to the INTENNUM register (the order of the writes is irrelevant to the AITC).

This register is located on the ARM920T processor's native bus, is accessible in 1 cycle, and can be accessed only in supervisor mode. This register must be accessed only on word (32-bit) boundaries. This register is self-clearing and therefore always reads back all 0s.

INTEN	TENNUM Interrupt Enable Number Register													0x(Addr 0x00223008		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
													ENI	NUM			
TYPE	r	r	r	r	r	r	r	r	r	r	slfclr	slfclr	slfclr	slfclr	slfclr	slfclr	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESEI								0x00	00								

Table 10-6. Interrupt Enable Number Register Description

Name	Description	Settings
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.	
ENNUM Bits 5–0	Interrupt Enable Number—Enables/Disables the interrupt source associated with this value.	0x00 = Enable interrupt source 0 0x01 = Enable interrupt source 1 0x3F = Enable interrupt source 63

Programming Model

10.4.4 Interrupt Disable Number Register

The Interrupt Disable Number Register (INTDISNUM) provides hardware accelerated disabling of interrupts. Any write to this register disables one interrupt source. When the 6 LSBs = 000000, then interrupt source 0 is disabled; when the 6 LSBs = 000001, then interrupt source 1 is disabled, and so forth. This register is decoded into a single hot mask that is inverted and logically ANDed with the INTENABLEH and the INTENABLEL registers.

This hardware mechanism removes the requirement for an atomic read/modify/write sequence to disable an interrupt source. To disable interrupts 10 and 20, the software performs two writes to the AITC: first write 10, then write 20 to INTDISNUM register (the order of the writes is irrelevant to the AITC).

This register is located on the ARM920T processor's native bus, is accessible in 1 cycle, and can be accessed only in supervisor mode. This register must be accessed only on word (32-bit) boundaries. This register is self-clearing and therefore always reads back all 0s.

INTDI	NTDISNUM Interrupt Disable Number Register													0x0	Addr 0x0022300C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET								0x00	00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
													DIS	NUM				
TYPE	r	r	r	r	r	r	r	r	r	r	slfclr	slfclr	slfclr	slfclr	slfclr	slfclr		
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									

Table 10-7. Interrupt Disable Number Register Description

Name	Description	Settings
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.	
DISNUM Bits 5–0	Interrupt Disable Number—Enables/Disables the interrupt source associated with this value.	0x00 = Disable interrupt source 0 0x01 = Disable interrupt source 1 0x3F = Disable interrupt source 63

10-10 Freescale Semiconductor

10.4.5 Interrupt Enable Register High and Interrupt Enable Register Low

The Interrupt Enable Register High (INTENABLEH) and the Interrupt Enable Register Low (INTENABLEL) registers enable pending interrupt requests to the ARM920T processor. Each bit in these registers corresponds to an interrupt source available in the system. The reset state of both registers is all interrupts masked.

These registers are updated by the following methods:

- Write directly to the INTENABLEH and INTENABLEL registers
- Set bits with the INTENNUM register
- Clear bits with the INTDISNUM register

These registers are located on the ARM920T processor's native bus, are accessible in 1 cycle, and can be accessed only in supervisor mode. These registers must be accessed only on word (32-bit) boundaries.

10.4.5.1 Interrupt Enable Register High

INTEN	IABL	EH			Interrupt Enable Register High										Addr 0x00223010			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
							INT	ENABL	E [63:48	3]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
							INT	ENABL	E [47:32	2]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET								0x00	00									

Table 10-8. Interrupt Enable Register High Description

Name	Description	Settings
INTENABLE Bits 31–0	Interrupt Enable—Enables/Disables the individual bit interrupt sources to request a normal interrupt or a fast interrupt. When INTENABLE is set and the corresponding interrupt source is asserted, the interrupt controller asserts a normal or a fast interrupt request depending on the associated INTTYPEH and INTTYPEL setting.	0 = Interrupt disabled 1 = Interrupt enabled and generates a normal or fast interrupt upon assertion

Freescale Semiconductor 10-11

10.4.5.2 Interrupt Enable Register Low

INTEN	IABL	EL		Interrupt Enable Register Low												Addr 0x00223014			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
	INTENABLE [31:16]																		
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
HESEI								0x00	00										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
							IN [.]	TENABL	E [15:0]									
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
NESEI								0x00	00										

Table 10-9. Interrupt Enable Register Low Description

Name	Description	Settings
INTENABLE Bits 31–0	Interrupt Enable—Enables/Disables the individual bit interrupt sources to request a normal interrupt or a fast interrupt. When INTENABLE is set and the corresponding interrupt source is asserted, the interrupt controller asserts a normal or a fast interrupt request depending on the associated INTTYPEH and INTTYPEL setting.	0 = Interrupt disabled 1 = Interrupt enabled and generates a normal or fast interrupt upon assertion

A -1 -1--

10.4.6 Interrupt Type Register High and Interrupt Type Register Low

The Interrupt Type Register High (INTTYPEH) and the Interrupt Type Register Low (INTTYPEL) registers select whether a pending interrupt source, when enabled with the INTENABLEH and INTENABLEL registers, creates a normal interrupt or a fast interrupt to the ARM920T processor. Each bit in this register corresponds to an interrupt source available in the system. The reset state of both registers is all interrupts generate a normal interrupt.

These registers are located on the ARM920T processor's native bus, are accessible in 1 cycle, and can be accessed only in supervisor mode. These registers must be accessed only on word (32-bit) boundaries.

10.4.6.1 Interrupt Type Register High

INTTY	PEH		Interrupt Type Register High												Addr 0x00223018			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
							IN	ITTYPE	[63:48]									
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESET	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
							IN	ITTYPE	[47:32]									
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET								0x00	000									

Table 10-10. Interrupt Type Register High Description

Name	Description	Settings
INTTYPE Bits 31–0	Interrupt Type—Controls whether the individual interrupt sources request a normal interrupt or a fast interrupt. When a INTTYPE bit is set and the corresponding interrupt source is asserted, the interrupt controller asserts a fast interrupt request.	0 = Interrupt source generates a normal interrupt (nIRQ) 1 = Interrupt source generates a fast interrupt (nFIQ)

Freescale Semiconductor 10-13

10.4.6.2 Interrupt Type Register Low

INTTY	PEL		Interrupt Type Register Low												Addr 0x0022301C		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
							II	ITTYPE	[31:16]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
							I	NTTYPE	[15:0]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
ILOLI								0x00	000								

Table 10-11. Interrupt Type Register Low Description

Name	Description	Settings
INTTYPE Bits 31–0	Interrupt Type—Controls whether the individual interrupt sources request a normal interrupt or a fast interrupt. When a bit is set in INTTYPE and the corresponding interrupt source is asserted, the interrupt controller asserts a fast interrupt request.	0 = Interrupt source generates a normal interrupt (nIRQ) 1 = Interrupt source generates a fast interrupt (nFIQ)

10.4.7 Normal Interrupt Priority Level Registers

The normal interrupt priority level registers (NIPRIORITY7, NIPRIORITY6, NIPRIORITY5, NIPRIORITY4, NIPRIORITY3, NIPRIORITY2, NIPRIORITY1, and NIPRIORITY0) provide a software controllable prioritization of normal interrupts. Normal interrupts with a higher priority level preempt normal interrupts with a lower priority. The reset state of these registers forces all normal interrupts to the lowest priority level.

When a level 0 normal interrupt and a level 1 normal interrupt are asserted at the same time, the level 1 normal interrupt is selected assuming that NIMASK has not disabled level 1 normal interrupts. When two level 1 normal interrupts are asserted at the same time, the level 1 normal interrupt with the highest source number is selected, also assuming that NIMASK has not disabled level 1 normal interrupts.

These registers are located on the ARM920T processor's native bus, are accessible in 1 cycle, and can be accessed only in supervisor mode. These registers must be accessed only on word (32-bit) boundaries.

10-14 Freescale Semiconductor

10.4.7.1 Normal Interrupt Priority Level Register 7

NIPRI	ORIT	Y 7		No	rmal	0x	Addr 0x00223020											
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
		NIPI	R63			NIP	R62			NIF	R61			NIPR60				
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESET						0x0000												
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
		NIPI	R59			NIP	R58			NIP	R57			NIP	R56			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESEI								0x00	000									

Table 10-12. Normal Interrupt Priority Level Register 7 Description

Name	Description	Settings
NIPR63 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt
NIPR62 Bits 27–24	These registers do not affect the prioritization of fast interrupt priorities.	1111 = Highest priority normal interrupt
NIPR61 Bits 23–20		
NIPR60 Bits 19–16		
NIPR59 Bits 15–12		
NIPR58 Bits 11–8		
NIPR57 Bits 7–4		
NIPR56 Bits 3–0		

10.4.7.2 Normal Interrupt Priority Level Register 6

NIPRI	ORIT	Y 6		No	rmal	0x	Addr 0x00223024											
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
		NIPI	R55		NIPR54					NIF	R53			NIPR52				
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET						0x0000												
BIT	15	14	13	12	11	10	9	8	7	16	5	4	3	2	1	0		
		NIPI	R51			NIP	R50			NIP	R49			NIP	R48			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET								0x00	000									

Table 10-13. Normal Interrupt Priority Level Register 6 Description

Name	Description	Settings
NIPR55 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt 1111 = Highest priority normal interrupt
NIPR54 Bits 27–24	These registers do not affect the prioritization of fast interrupt priorities.	TTTT = Tilgriest priority normal interrupt
NIPR53 Bits 23–20		
NIPR52 Bits 19–16		
NIPR51 Bits 15–12		
NIPR50 Bits 11–8		
NIPR49 Bits 7–4		
NIPR48 Bits 3–0		

10.4.7.3 Normal Interrupt Priority Level Register 5

NIPRI	ORIT	Y5		No	rmal	0x	Addr 0x00223028										
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
		NIPI	R47							NIP	R45			NIPR44			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
		NIPI	R43			NIP	R42			NIP	'R41			NIP	R40		
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	000								

Table 10-14. Normal Interrupt Priority Level Register 5 Description

Name	Description	Settings
NIPR47 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt
NIPR46 Bits 27–24	These registers do not affect the prioritization of fast interrupt priorities.	1111 = Highest priority normal interrupt
NIPR45 Bits 23–20		
NIPR44 Bits 19–16		
NIPR43 Bits 15–12		
NIPR42 Bits 11–8		
NIPR41 Bits 7–4		
NIPR40 Bits 3–0		

10.4.7.4 Normal Interrupt Priority Level Register 4

NIPRI	ORIT	Y 4		No	rmal	0x0	Addr 0x0022302C										
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
		NIPR39 NIPR38								NIF	R37			NIPR36			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NLOLI								0x00	000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
		NIP	R35			NIP	R34			NIF	R33			NIP	R32		
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESEI								0x00	000								

Table 10-15. Normal Interrupt Priority Level Register 4 Description

Name	Description	Settings
NIPR39 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt
NIPR38 Bits 27–24	These registers do not affect the prioritization of fast interrupt priorities.	1111 = Highest priority normal interrupt
NIPR37 Bits 23–20		
NIPR36 Bits 19–16		
NIPR35 Bits 15–12		
NIPR34 Bits 11–8		
NIPR33 Bits 7–4		
NIPR32 Bits 3–0		

10.4.7.5 Normal Interrupt Priority Level Register 3

NIPRI	ORIT	Y 3		No	rmal	Interr		Addr 0x00223030									
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
		NIPR31				NIPR30				NIP	R29			NIPR28			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
		NIPI	R27			NIP	R26			NIP	R25			NIP	R24		
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESEI								0x00	00								

Table 10-16. Normal Interrupt Priority Level Register 3 Description

Name	Description	Settings
NIPR31 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt 1111 = Highest priority normal interrupt
NIPR30	Source.	1111 – Highest phonty hormal interrupt
Bits 27–24	These registers do not affect the prioritization of fast interrupt	
NIPR29 Bits 23–20	priorities.	
NIPR28		
Bits 19-16		
NIPR27 Bits 15–12		
NIPR26 Bits 11–8		
NIPR25 Bits 7–4		
NIPR24 Bits 3–0		

10.4.7.6 Normal Interrupt Priority Level Register 2

NIPRI	ORIT	Y2		No	rmal	0x	Addr 0x00223034											
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
		NIPI	R23			NIP	R22			NIF	R21			NIPR20				
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESEI		0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
		NIPI	R19			NIP	R18			NIF	R17			NIP	R16			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET								0x00	000									

Table 10-17. Normal Interrupt Priority Level Register 2 Description

Name	Description	Settings
NIPR23 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt 1111 = Highest priority normal interrupt
NIPR22 Bits 27–24	These registers do not affect the prioritization of fast interrupt priorities.	TTTT = Tilgriest priority normal interrupt
NIPR21 Bits 23–20	phonies.	
NIPR20 Bits 19–16		
NIPR19 Bits 15–12		
NIPR18 Bits 11–8		
NIPR17 Bits 7–4		
NIPR16 Bits 3–0		

10.4.7.7 Normal Interrupt Priority Level Register 1

NIPRI	ORIT	Y1		No	rmal	0x	Addr 0x00223038											
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
		NIPI	R15			NIP	R14		NIPR13					NIPR12				
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESET								0x00	00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
		NIPI	R11			NIP	R10			NIF	PR9			NIF	PR8			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESEI								0x00	00									

Table 10-18. Normal Interrupt Priority Level Register 1 Description

Name	Description	Settings
NIPR15 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt 1111 = Highest priority normal interrupt
NIPR14 Bits 27–24	These registers do not affect the prioritization of fast interrupt	1111 - Thighest phonty normal interrupt
NIPR13 Bits 23–20	priorities.	
NIPR12 Bits 19–16		
NIPR11 Bits 15–12		
NIPR10 Bits 11–8		
NIPR9 Bits 7–4		
NIPR8 Bits 3–0		

10.4.7.8 Normal Interrupt Priority Level Register 0

NIPRI	ORIT	Y0		No	rmal	0x0	Addr 0x0022303C									
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		NIP	R7			NIF	PR6		NIPR5					NIF	PR4	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		NIP	R3			NIF	PR2			NIF	PR1			NIF	PR0	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	000							

Table 10-19. Normal Interrupt Priority Level Register 0 Description

Name	Description	Settings
NIPR7 Bits 31–28	Normal Interrupt Priority Level—Selects the software controlled priority level for the associated normal interrupt source.	0000 = Lowest priority normal interrupt 1111 = Highest priority normal interrupt
NIPR6 Bits 27–24	These registers do not affect the prioritization of fast interrupt priorities.	TTTT = Trigitest priority normal interrupt
NIPR5 Bits 23–20	phonies.	
NIPR4 Bits 19–16		
NIPR3 Bits 15–12		
NIPR2 Bits 11–8		
NIPR1 Bits 7–4		
NIPR0 Bits 3–0		

10.4.8 Normal Interrupt Vector and Status Register

The Normal Interrupt Vector and Status Register (NIVECSR) specifies the priority of the highest pending normal interrupt and provides the vector index of the interrupt's service routine. This number can be directly used as an index into a vector table to select the highest pending normal interrupt source.

This read-only register is located on the ARM920T processor's native bus, is accessible in 1 cycle, and can be accessed only in supervisor mode. This register must be accessed only on word (32-bit) boundaries.

NIVE	CSR			Nor	mal lı	nterru	pt Ve	ctor a	ind S	tatus	Regi	ster		Addr 0x00223040			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
								NIVECT	ΓOR								
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
TILOLI								0xFFI	=F								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								NIPRIL	_VL								
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
NLOEI								0xFFI	=F								

Table 10-20. Normal Interrupt Vector and Status Register Description

Name	Description	Settings
NIVECTOR Bits 31–16	Normal Interrupt Vector—Indicates vector index for the highest pending normal interrupt. Settings are shown in decimal.	 0 = Interrupt 0 highest priority pending normal interrupt 1 = Interrupt 1 highest priority pending normal interrupt 63 = Interrupt 63 highest priority pending normal interrupt 64+ = No normal interrupt request pending
NIPRILVL Bits 15–0	Normal Interrupt Priority Level—Indicates the priority level of the highest priority normal interrupt. This number can be written to the NIMASK to disable the current priority normal interrupts to build a reentrant normal interrupt system. Settings are shown in decimal.	0 = Highest priority normal interrupt is level 0 1 = Highest priority normal interrupt is level 1 15 = Highest priority normal interrupt is level 15 16+ = No normal interrupt request pending

Programming Model

10.4.9 Fast Interrupt Vector and Status Register

The Fast Interrupt Vector and Status Register (FIVECSR) specifies the priority of the highest pending fast interrupt and provides the vector index for the interrupt's service routine. This number can be directly used as an index into a vector table to select the highest pending fast interrupt source.

This read-only register is located on the ARM920T processor's native bus, is accessible in 1 cycle, and can be accessed only in supervisor mode. This register must be accessed only on word (32-bit) boundaries.

FIVEC	SR			Fas	st Inte	Addr 0x00223044										
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
							FI	/ECTO	R [31:16]						
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
RESET								0xFF	FF							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							FI	VECTO	R [15:0]							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
NESET								0xFF	FF							

Table 10-21. Fast Interrupt Vector and Status Register Description

Name	Description	Settings
FIVECTOR Bits 31–0	Fast Interrupt Vector—Indicates vector index for the highest pending fast interrupt.	0 = Interrupt 0 is highest pending fast interrupt 1 = Interrupt 1 is highest pending fast interrupt 63 = Interrupt 63 is highest pending fast interrupt 64+ = not used, does not occur

10-24 Freescale Semiconductor

10.4.10 Interrupt Source Register High and Interrupt Source Register Low

The Interrupt Source Register High (INTSRCH) and the Interrupt Source Register Low (INTSRCL) registers are each 32 bits wide. INTSRCH and INTSRCL reflect the status of all interrupt request inputs into the interrupt controller. Bit positions that are not used always read 0 (no request pending). The peripheral circuits generating the requests determine the state of this register out of reset; normally, the requests are inactive.

These read-only registers are located on the ARM920T processor's native bus, are accessible in 1 cycle, and can be accessed only in supervisor mode. These registers must be accessed only on word (32-bit) boundaries.

10.4.10.1 Interrupt Source Register High

INTSR	RCH				Inte	errup	t Sou	rce F	Regist	ter H	igh			Addr 0x00223048			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
								INTIN [6	63:48]								
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								INTIN [4	17:32]								
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	00								

Table 10-22. Interrupt Source Register High Description

Name	Description	Settings
INTIN Bits 31–0	Interrupt Source—Indicates the state of the corresponding hardware interrupt source.	0 = Interrupt source negated 1 = Interrupt source asserted

NOTE:

The peripheral circuits generating the requests determine the state of this register out of reset; normally, the requests are inactive. This read-only register must be accessed only on word (32-bit) boundaries.

10.4.10.2 Interrupt Source Register Low

INTSR	RCL				Int	errup	t Sou	ırce F	Regis	ter L	OW			0x0	Addr 0x0022304C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
								INTIN [3	31:16]									
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET								0x00	00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
								INTIN [15:0]									
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HLSEI								0x00	00									

A -1 -1--

Table 10-23. Interrupt Source Register Low Description

Name	Description	Settings
INTIN Bits 31–0	Interrupt Source —Indicates the state of the corresponding hardware interrupt source.	0 = Interrupt source negated 1 = Interrupt source asserted

NOTE:

The state of this register out of reset is determined by the peripheral circuits generating the requests; normally, the requests are inactive. This read-only register must be accessed only on word (32-bit) boundaries.

10-26 Freescale Semiconductor

A -1 -1--

10.4.11 Interrupt Force Register High and Interrupt Force Register Low

The Interrupt Force Register High (INTFRCH) and the Interrupt Force Register Low (INTFRCL) registers are each 32 bits wide. The interrupt forces registers allow for software generation of interrupts for each of the possible interrupt sources for functional or debugging purposes. The system level design can reserve one or more sources for software purposes to allow software to self-schedule interrupts by forcing one or more of these sources in the appropriate interrupt force register(s).

These registers are located on the ARM920T processor's native bus, are accessible in 1 cycle, and can be accessed only in supervisor mode. These registers must be accessed only on word (32-bit) boundaries.

10.4.11.1 Interrupt Force Register High

INTFR	CH				Int	errup	t For	ce R	egiste	er Hi	gh			Addr 0x00223050			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
							F	ORCE	[63:48]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESET								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
							F	ORCE	[47:32]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET								0x00	00								

Table 10-24. Interrupt Force Register High Description

Name	Description	Settings
FORCE Bits 31–0	Interrupt Source Force Request—Forces a request for the corresponding interrupt source.	0 = Standard interrupt operation 1 = Interrupt forced asserted

10.4.11.2 Interrupt Force Register Low

INTFR	CL				In	terru	ot For	ce R	egist	er Lo	W			Addr 0x00223054			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
							F	ORCE	[31:16]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESEI								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								FORCE	[15:0]								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET								0x00	00								

Table 10-25. Interrupt Force Register Low Description

Name	Description	Settings
FORCE Bits 31–0	Interrupt Source Force Request—Forces a request for the corresponding interrupt source.	0 = Standard interrupt operation 1 = Interrupt forced asserted

10.4.12 Normal Interrupt Pending Register High and Normal Interrupt Pending Register Low

The Normal Interrupt Pending Register High (NIPNDH) and the Normal Interrupt Pending Register Low (NIPNDL) registers are 32-bits wide and monitor the outputs of the enable and masking operations. These registers are actually only a set of buffers, so the reset state of these registers is determined by the normal interrupt enable registers, the interrupt mask register, and the interrupt source registers.

These read-only registers are located on the ARM920T processor's native bus, are accessible in 1 cycle, and can be accessed only in supervisor mode. These registers must be accessed only on word (32-bit) boundaries.

10.4.12.1 Normal Interrupt Pending Register High

NIPNE	NIPNDH Normal Interrupt Pending Register High													Addr 0x00223058			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
							N	IIPEND	[63:48]								
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESEI								0x00	000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
							١	IIPEND	[47:32]								
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESEI								0x00	000								

Table 10-26. Normal Interrupt Pending Register High Description

Name	Description	Settings
NIPEND Bits 31–0	Normal Interrupt Pending Bit—Indicates whether a normal interrupt is pending. When a normal interrupt enable bit is set and the corresponding interrupt source is asserted, the interrupt controller asserts a normal interrupt request. The normal interrupt pending bits reflect the interrupt input lines that are asserted and are currently enabled to generate a normal interrupt.	0 = No normal interrupt request 1 = Normal interrupt request pending

Programming Model

10.4.12.2 Normal Interrupt Pending Register Low

NIPNDL Normal Interrupt Pending Register Low												0x0	Addr 0x0022305C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
							١	IIPEND	[31:16]							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							ı	VIPEND	[15:0]							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ILOLI								0x00	00							

Table 10-27. Normal Interrupt Pending Register Low Description

Name	Description	Settings
NIPEND Bits 31–0	Normal Interrupt Pending Bit—Indicates whether a normal interrupt is pending. When a normal interrupt enable bit is set and the corresponding interrupt source is asserted, the interrupt controller asserts a normal interrupt request. The normal interrupt pending bits reflect the interrupt input lines that are asserted and are currently enabled to generate a normal interrupt.	0 = No normal interrupt request 1 = Normal interrupt request pending

10.4.13 Fast Interrupt Pending Register High and Fast Interrupt Pending Register Low

The Fast Interrupt Pending Register High (FIPNDH) and the Fast Interrupt Pending Register Low (FIPNDL) registers are 32-bits wide and monitor the outputs of the enable and masking operations. These registers are actually only a set of buffers, so the reset state of these registers is determined by the fast interrupt enable registers, the interrupt mask register, and the interrupt source registers.

These read-only registers are located on the ARM920T processor's native bus, are accessible in 1 cycle, and can be accessed only in supervisor mode. These registers must be accessed only on word (32-bit) boundaries.

10.4.13.1 Fast Interrupt Pending Register High

FIPNDH Fast Interrupt Pending Register High												0x	Addr 0x00223060			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
							F	IPEND	[63:48]							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							F	IPEND	[47:32]							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							

Table 10-28. Fast Interrupt Pending Register High Description

Name	Description	Settings
FIPEND Bits 31–0	Fast Interrupt Pending Bit—Indicates if a fast interrupt request is pending. When a fast interrupt enable bit is set and the corresponding interrupt source is asserted, the interrupt controller asserts a fast interrupt request. The fast interrupt pending bits reflect the interrupt input lines that are asserted and are currently enabled to generate a fast interrupt.	0 = No fast interrupt request pending1 = Fast interrupt request pending

Programming Model

10.4.13.2 Fast Interrupt Pending Register Low

FIPNDL Fast Interrupt Pending Register Low													Addi 0x00223064			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
							F	IPEND	[31:16]							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							I	FIPEND	[15:0]							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							

Table 10-29. Fast Interrupt Pending Register Low Description

Name	Description	Settings
FIPEND Bits 31–0	Fast Interrupt Pending Bit—Indicates if a fast interrupt request is pending. When a fast interrupt enable bit is set and the corresponding interrupt source is asserted, the interrupt controller asserts a fast interrupt request. The fast interrupt pending bits reflect the interrupt input lines that are asserted and are currently enabled to generate a fast interrupt.	0 = No fast interrupt request pending 1 = Fast interrupt request pending

10-32 Freescale Semiconductor

10.5 ARM920T Processor Interrupt Controller Operation

This section discusses the ARM920T processor prioritization of various exceptions and interrupt sources, two methods of enabling or disabling interrupts, and provides a typical pipeline sequence.

10.5.1 ARM920T Processor Prioritization of Exception Sources

The ARM920T processor prioritizes the various exceptions as follows:

- Reset (highest priority)
- Data Abort
- Fast Interrupt
- Normal Interrupt
- Prefetch Abort
- Undefined Instruction and SWI (lowest priority)

10.5.2 AITC Prioritization of Interrupt Sources

The AITC module prioritizes the various interrupt sources by source number. Higher source numbers have higher priority. Fast interrupts always have higher priority than normal interrupts.

Interrupt requests are prioritized as follows:

- 1. Fast interrupt requests, in order of highest source number
- 2. Normal interrupt requests, in order of highest priority level, then in order of highest source number with the same priority level

10.5.3 Assigning and Enabling Interrupt Sources

The interrupt controller provides flexible assignment of any interrupt source to either of the two ARM920T processor interrupt request inputs. This is done by setting the appropriate bits in the INTENABLEH and INTENABLEL registers and the INTTYPEH and INTTYPEL registers. Interrupt assignment is usually done once during system initialization and does not affect interrupt latency.

Interrupt assignment is the first of three steps required to enable an interrupt source, and this is done by the MC9328MXS hardware. The second step is to program the source to generate interrupt requests. The final step is to enable the interrupt inputs in the ARM920T processor by clearing the normal interrupt disable (I) and/or the fast interrupt disable (F) bits in the processor status register (CPSR).

10.5.4 Enabling Interrupts Sources

There are two methods of enabling or disabling interrupts in the AITC. The first method is to directly read the INTENABLEH and INTENABLEL registers, logically OR or BIT CLEAR these registers with a generated mask, then write back to the INTENABLEH and INTENABLEL registers.

The second method is performing an atomic write to source number of the INTENNUM register. The AITC decodes this 6-bit register and enables one of the 64 interrupt sources. The AITC automatically generates a single hot enable mask and logically ORs this mask to the correct INTENABLEH and INTENABLEL register. To disable interrupts, the procedure is exactly the same except the source number is written to the INTDISNUM register.

10.5.5 Typical Interrupt Entry Sequences

The Table 10-30 is a typical pipeline sequence for the ARM920T processor when a normal interrupt occurs. Assuming single cycle memories, it takes approximately 6 clocks from the acknowledgement of the normal interrupt within the ARM920T processor until the first opcode of the interrupt routine is fetched.

Time Address -2 -1 0 1 2 3 4 5 6 7 8 nIRQ nIRQ **ACK** Assert Last ADDR Fetch Dec Exec Link Adjust before nIRQ +4/+2 Fetch Dec +8 / +4 Fetch 0x00000018 Fetch Exec Wrbk Dec Data Fetch Dec +8 Fetch Vector Table Vector N/A nIRQ Routine Fetch Dec Exec +4 Fetch Dec +8 Fetch

Table 10-30. Typical Hardware Accelerated Normal Interrupt Entry Sequence

The Table 10-31 on page 10-34 is a typical pipeline sequence for the ARM920T processor when a fast interrupt occurs, assuming that the FIQ service routine begins at 0x0000001C and single cycle memories.

Time **Address -2** -1 1 2 3 nFIQ nFIQ Assert **ACK** Last ADDR before nFIQ Fetch Dec Exec Link Adjust +4/+2 Fetch Dec +8/+4 Fetch 0x0000001C Fetch Dec Exec +4 Fetch Dec +8 Fetch

Table 10-31. Typical Fast Interrupt Entry Sequence

MC9328MXS Reference Manual, Rev. 1

10-34 Freescale Semiconductor

10.5.6 Writing Reentrant Normal Interrupt Routines

The AITC can create a reentrant normal interrupt system. This enables preempting of lower priority level interrupts by higher priority level interrupts. This requires a small amount of software support and overhead. The following shows the steps necessary to accomplish this:

- 1. Push the link register (LR IRQ) onto the stack (SP IRQ).
- 2. Push the saved status register (SPSR IRQ) onto the stack.
- 3. Read the current value of NIMASK and push this value onto the stack.
- 4. Read current priority level via NIVECSR.
- 5. Interrupts of the equal or lesser priority than the current priority level must be masked via the NIMASK register by writing value from NIVECSR.
- 6. Clear the I bit in the ARM920T processor via a MSR / MRS command sequence (a higher priority normal interrupt can preempt a lower priority one) and change the operating mode of the ARM920T processor to system mode from IRQ mode.
- 7. Push the System Mode Link Register (LR) onto the stack (SP USER).
- 8. The traditional interrupt service routine is now included.
- 9. Pop the System Mode Link Register (LR) from the stack (SP USER).
- 10. Set the I bit in the ARM920T processor via a MSR/MRS command sequence (disables all normal interrupts) and change the operating mode of the ARM920T processor to IRQ mode from system mode.
- 11. Pop the original value of the normal interrupt mask and write the value to the NIMASK register.
- 12. Pop the Saved Status Register from the stack (SP_IRQ).
- 13. Pop the link register from the stack into the PC.
- 14. Return from nIRQ.

NOTE:

These steps are still in development and are subject to change. Steps 1, 2, 13, and 14 are automatically done by most C compilers and are included for completeness.



10-36 Freescale Semiconductor

Chapter 11 External Interface Module (EIM)

11.1 Overview

The External Interface Module (EIM) handles the interface to devices external to the MC9328MXS, including generation of chip selects for external peripherals and memory, and provides the following features:

- Six chip selects for external devices: \overline{CSO} , covering a range of 32 Mbyte, and \overline{CSI} – \overline{CSS} , covering a range of 16 Mbyte each
- Selectable protection for each chip select
- Reset programmable data port size for $\overline{\text{CS0}}$
- Programmable data port size for each chip select
- Address suppression during burst mode operations
- Synchronous burst mode support for burst flash devices
- Programmable wait-state generator for each chip select
- Supports big endian and little endian modes of operation
- Programmable general output capability for unused chip select outputs

11.2 EIM I/O Signals

The EIM I/O signals provide communication and control pathways between external devices and the MC9328MXS. A summary of the I/O signal pins is provided in Table 11-2 on page 11-4. Each signal is described in the following sections.

11.2.1 Address Bus

The A [24:0] signals are address bus outputs used to address external devices.

11.2.2 Data Bus

The D [31:0] signals are bidirectional data bus pins used to transfer data between the MC9328MXS and an external device

11.2.3 Read/Write

The R/W output signal indicates if the current bus access is in a read or write cycle. A high (logic one) level indicates a read cycle, and a low (logic zero) level indicates a write cycle.

EIM I/O Signals

11.2.4 Control Signals

The OE and EB [3:0] signals are used to control external device's interface to the external data bus.

11.2.4.1 OE—Output Enable

This active-low output signal indicates the bus access is a read, and enable slave devices to drive the data bus with read data.

11.2.4.2 **EB** [3:0]—Enable Bytes

These active-low output pins indicate active data bytes for the current access. They may be configured to assert for read and write cycles or for write cycles only as programmed in the CS configuration registers. EB [0] corresponds to D [31:24], EB [1] corresponds to D [23:16], EB [2] corresponds to D [15:8], and EB [3] corresponds to D [7:0]. In the case of a 16-bit operation, or controlling the enable byte signals for half-word operation, either EB[0] or EB[1] may be used for D[31:16], and either EB[2] or EB[3] may be used for D[15:0]. For word addressing, any of on the EB[3:0] signals may be used.

This is especially useful when interfacing to external devices or memories that require strict timing control over the write enable signal. Since there is no way to control the timing of the EIM WE signal, any one of the EB[3:0] signals (if not already being used for enable byte control), may be used as the write enable signal. The bits WEA and WEN in the Chip Select Control registers are used to vary the timing of these signals according to the bit settings in those registers. The corresponding EB[3:0] signal that can be used for a corresponding set of D[31:0] signals follows the EB[3:0] to D[31:0] mapping given above.

NOTE

The pulse of OE, R/W, EB, and CS signals cannot be configured to less than one system clock period (HCLK).

11.2.4.3 DTACK—Data Transfer Acknowledge

The DTACK signal is the external input data acknowledge signal that only supported by CS[5]. When the external DTACK signal is used as a data acknowledge signal, the bus time-out monitor generates a bus error when a bus cycle is not terminated by the external DTACK signal after 1022 clocks counts have elapsed.

The maximum wait state supported by the DTACK signal at 96 MHz is 10.645us. This can be calculated by dividing the number of maximum wait state cycles (in this case 1022) by the system clock frequency (HCLK). For designs requiring a longer wait state time greater than 10.645us, it is necessary to reduce the system clock frequency HCLK to an appropriate value that is less than 96 MHz. The system clock HCLK can be divided by setting the BLCK_DIV bits in the Clock Source Control Register to the desired value. For more detailed information about setting the BCLK_DIV bits, see Chapter 12, "Phase-Locked Loop and Clock Controller."

11.2.5 Chip Select Outputs

11.2.5.1 Chip Select 0 (CSO)

The CS0 output signal is active-low and is asserted based on a decode of internal address bus bits A[31:24] of the accessed address, and at reset is based on the value of the BOOTMOD [3:0] inputs. The port size is determined by the state of the BOOTMOD[3:0] inputs. See Section 8.2, "System Boot Mode Selection," on page 8-7 for more information.

MC9328MXS Reference Manual, Rev. 1

11-2 Freescale Semiconductor

11.2.5.2 Chip Select 1-Chip Select 5 (CS1-CS5)

The CS1 through CS5 output signals are active-low and are asserted based on a decode of the internal address bus bits A [31:24] of the accessed address. When disabled, these pins can be used as programmable general-purpose outputs. Table 11-1 specifies the address range for each Chip Select output.

CSEN [x] A [31:24] **Chip Select** Cleared Inactive CS₀ 0001000x Set CS₁ 00010010 Set CS2 Set 00010011 CS3 Set 00010100 00010101 CS₄ Set CS₅ 00010110 Set

Table 11-1. Chip Select Address Range

11.2.6 Burst Mode Signals

11.2.6.1 BCLK—Burst Clock

The BCLK output signal is used to clock external burst capable devices to synchronize the loading and incrementing of addresses, and delivery of burst read data to the EIM. Its behavior is affected by the BCM bit in the EIM configuration register and the SYNC, BCD, PME, and BCS bits in the EIM control registers.

11.2.6.2 LBA—Load Burst Address

The \overline{LBA} active-low output signal is asserted during burst mode accesses to cause the external burst capable device to load a new starting burst address. Assertion of \overline{LBA} indicates that a valid address is present on the address bus. Its behavior is affected by the SYNC, BCD, PME, and BCS bits in the EIM control registers.

11.2.6.3 ECB—End Current Burst

The \overline{ECB} active-low input signal is asserted by external burst capable devices to indicate the end of the current (continuous) burst sequence. Following assertion, the EIM terminates the current burst sequence and initiates a new one.

11.3 Pin Configuration for EIM

Table 11-2 lists the pins used for the EIM module. Many of these pins are multiplexed with other functions on the device, and must be configured for EIM operation.

Pin Configuration for EIM

Table 11-2. EIM Pin List

Pin Name	Direction Description										
	External I/O Signals										
D [31:0]	Input/ Output	External 32-bit data bus									
A [24:0]	Output	External address bus									
<u>CS</u> [5:0]	Output	Active low external chip selects									
DTACK	Input	External input data acknowledge signal for CS5									
EB [3:0]	Output	Active low external enable bytes signals. EB [0] controls D [31:24]*									
ŌĒ	Output	Active low output enable for external data bus									
BCLK (burst clock)	Output	Clock for external synchronous memories (such as burst flash) - burst clock.									
LBA	Output	Active low signal sent to flash device causing the external device to latch the address.									
RW	Output	Indicates whether external access is a read (high) or write (low) cycle									
ECB	ECB Input Input signal identifies when to end an external burst access										
*EB [1] controls D [23:16], EB [2] controls D [15:8], EB [3] controls D [7:0]											

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Table 11-3. Pin Configuration

Pins	Setting	Configuration Procedure
D [31:0]	Not Multiplexed	
A [24]	Primary function of GPIO Port A [0]	Clear bit 0 of Port A GPIO In Use Register (GIUS_A) Clear bit 0 of Port A General Purpose Register (GPR_A)
A [23:16]	Primary function of GPIO Port A [31:24]	Clear bits [31:24] of Port A GPIO In Use Register (GIUS_A) Clear bits [31:24] of Port A General Purpose Register (GPR_A)
A [15:1]	Not Multiplexed	
A [0]	Primary function of GPIO Port A [21]	Clear bit 21 of Port A GPIO In Use Register (GIUS_A) Clear bit 21 of Port A General Purpose Register (GPR_A)
CS [5:4]	Primary function of GPIO Port A [23:22]	Clear bits [23:22] of Port A GPIO In Use Register (GIUS_A) Clear bits [23:22] of Port A General Purpose Register (GPR_A)
<u>CS</u> [3]	Primary function of pin shared with SDRAM's CSD1	Clear bit 1 (SDCS1_SEL) of Function Muxing Control Register (FMCR)

MC9328MXS Reference Manual, Rev. 1

11-4 Freescale Semiconductor

Table 11-3. Pin Configuration (continued)

Pins	Setting	Configuration Procedure							
CS [2]	Primary function of pin shared with SDRAM's CSD0	Clear bit 0 (SDCS0_SEL) of Function Muxing Control Register (FMCR)							
CS [1:0]	Not Multiplexed								
DTACK	Primary function of GPIO Port A[17	Clear bit 17 of Port A GPIO In Use Register (GIUS_A) Clear bit 17 of the Port A General Purpose Register (GPR_A)							
EB [3:0]	Not Multiplexed								
ŌĒ	Not Multiplexed								
BCLK	Primary function of GPIO Port A [18]	Clear bit 18 of Port A GPIO In Use Register (GIUS_A) Clear bit 18 of Port A General Purpose Register (GPR_A)							
LBA	Primary function of GPIO Port A [19]	Clear bit 19 of Port A GPIO In Use Register (GIUS_A) Clear bit 19 of Port A General Purpose Register (GPR_A)							
RW	Not Multiplexed								
ECB	Primary function of GPIO Port A [20]	Clear bit 20 of Port A GPIO In Use Register (GIUS_A) Clear bit 20 of Port A General Purpose Register (GPR_A)							

11.4 **Typical EIM System Connections**

The following figures show example connections of the EIM with burst and asynchronous memories:

- Figure 11-1 illustrates a typical set of EIM interfaces to external memory and peripherals.
- Figure 11-2 illustrates the EIM interface to two supported external burst flash devices.

MC9328MXS Reference Manual, Rev. 1

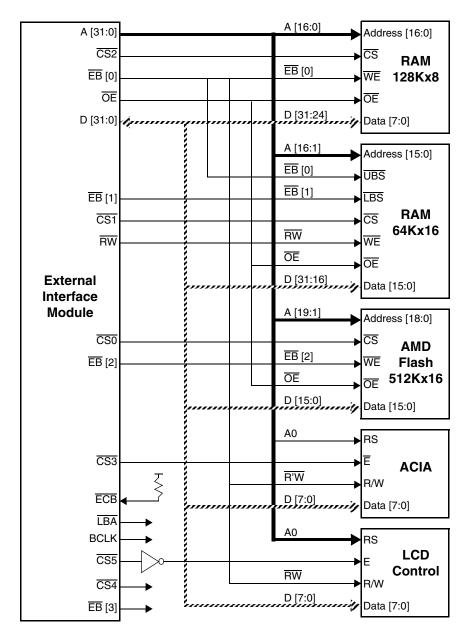


Figure 11-1. Example of EIM Interface to Memory and Peripherals

11-6 Freescale Semiconductor

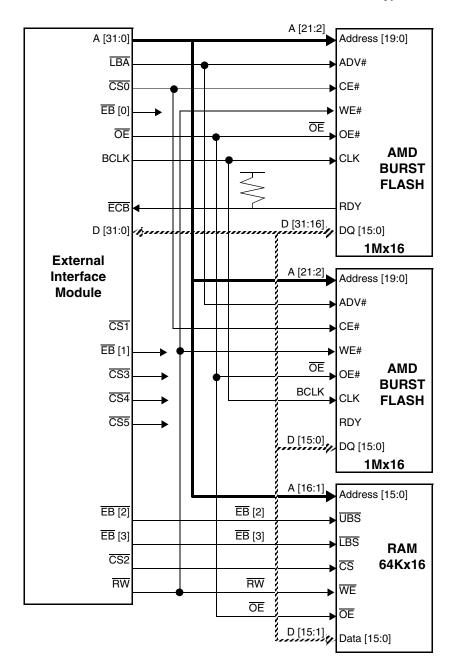


Figure 11-2. Example of EIM Interface to Burst Memory

11.5 EIM Functionality

11.5.1 Configurable Bus Sizing

The EIM supports byte, halfword, and word operands, allowing access to 8-bit ports, 16-bit ports, and 32-bit ports. It does not support misaligned transfers.

The port size is programmable via the DSZ bits in the corresponding chip select control register. In addition, the portion of the data bus used for transfer to or from an 8-bit port or 16-bit port is programmable via the same bits. An 8-bit port can reside on external data bus bits D [31:24], D [23:16], D [15:8] or D [7:0]. A 16-bit port can reside on external data bus bits D [31:16] or D [15:0].

Word access to or from an 8-bit port requires four external bus cycles to complete the transfer. Word access to or from a 16-bit port requires two external bus cycles to complete the transfer. Half-word access to or from an 8-bit port requires two external bus cycles to complete the transfer. In the case of a multi-cycle transfer, the lower two address bits, A [1:0], are incremented appropriately.

The EIM has a data multiplexer that routes the four bytes of the AHB interface data bus to the required positions to allow proper interfacing to memory and peripherals.

11.5.2 Programmable Output Generation

Unused chip select outputs can be configured to provide a programmable output signal. This functionality is not provided for the \overline{CS} [0] output signal. When the CSEN bit is cleared, \overline{CS} [0] is always inactive. To operate as a programmable output pin, the corresponding CSEN control bit must be cleared.

11.5.3 Burst Mode Operation

When burst mode is enabled, the EIM attempts to burst read data from as many sequential address locations as possible, limited only by the length of the burst flash internal page buffer, or the non-sequential nature of the ARM920T processor code or data stream. The EIM only displays the first address accessed in a burst sequence unless the page mode emulation (PME) bit is set.

For the first access in a burst sequence, the EIM asserts load burst address (\overline{LBA}), causing the external burst device to latch the starting burst address, and then toggles the burst clock (BCLK) for a predefined number of cycles to latch the first unit of data. Subsequently read data units are burst from the external device in fewer clock cycles, realizing an overall increase in bus bandwidth.

Burst accesses is terminated by the EIM when it detects that the next ARM920T processor access is not sequential in nature, or when the external burst device needs additional cycles to retrieve the next requested memory location. In the latter case, the burst flash device provides an \overline{ECB} signal to the EIM whenever it must terminate the on-going burst sequence and initiate a new (long first access) burst sequence.

11.5.4 Burst Clock Divisor

In some cases it is necessary to slow the external bus in relation to the internal bus to allow accesses to burst devices that have a maximum operating frequency that is lower than the operating frequency of the internal AHB bus. The internal bus frequency can be divided by 2, 3, or 4 for presentation on the external bus in burst mode operation.

11-8 Freescale Semiconductor

Programming the BCD bits to various values (see Table 11-5, "Chip Select Control Registers Description") affects two signals on the external bus, \overline{LBA} (load burst address) and BCLK (burst clock). The \overline{LBA} signal is asserted immediately and remains asserted until the first falling edge of the BCLK signal. The BCLK signal runs with a 50% duty cycle until a non-sequential internal request is received or an external \overline{ECB} signal is recognized.

When programming these bits, ensure that the WSC and DOL fields are coordinated to provide the desired external bus waveforms. For example, when the BCD bits are programmed to 01, the DOL bits must be programmed to 0001, 0011, 0101, When the BCD bits are programmed to 10, the DOL must be programmed to 0010, 0101, 1000,

The BCM bit in the EIM configuration register has priority over the BCD bits. When BCM = 1, the BCLK runs at maximum frequency.

11.5.5 Burst Clock Start

To allow greater flexibility in achieving the minimum number of wait states on burst accesses, the user can determine when they want the BCLK (burst clock) to start toggling. This allows the BCLK to be skewed from the point of data capture on the system clock by any number of system clock phases. Use caution when setting these bits in conjunction with the BCD, WSC, and DOL bits. See the external timing diagrams for some examples of how to use the BCS, BCD, WSC, and DOL bits together.

11.5.6 Page Mode Emulation

Setting the PME bit causes the EIM to perform burst accesses by emulating page mode operation. The \overline{LBA} signal remains asserted for the entire access, the burst clock does not send a signal, and the external address asserts for each access made. The initial access timing is dictated by the WSC bits and the page mode access timing is dictated by the DOL bits.

The EIM can take advantage of improved page timing for sequential accesses only. Accesses that are on the page, however are not sequential in nature, have their timing dictated by the WSC bits. The page size can be set via the PSZ bits to 4, 8, 16, or 32 words (the word size is determined by the data width of the external memory, such as the DSZ bits).

11.5.7 Error Conditions

The following conditions cause an error condition to be asserted to the ARM920T processor:

- Access to a disabled chip select (access to a mapped chip select address space where the CSEN bit in the
 corresponding chip select control register is clear)
- Write access to a write-protected chip select address space (the WP bit in the corresponding chip select control register is set)
- User access to a supervisor-protected chip select address space (the SP bit in the corresponding chip select control register is set)
- User read or write access to a chip select control register or the EIM configuration register
- Byte or halfword access to a chip select control register or the EIM configuration register

Programming Model

11.6 Programming Model

The EIM module includes thirteen user-accessible 32-bit registers. There is a common register called the EIM Configuration Register that contains control bits that configure the EIM for certain operation modes. The other twelve registers are pairs of control registers for each chip select. The layout of the control register is slightly different for the CS0 register output because \overline{CS} [0] does not support the programmable output function. These registers are accessible only in supervisor mode with word (32-bit) reads and writes.

Complete decoding is not performed, so shadowing can occur with these registers. The user must not attempt to address these registers at any other address location other than those listed in Table 11-4.

Table 11-4. EIM Module Register Memory Map

Description	Name	Address
Chip Select 0 Upper Control Register	CS0U	0x00220000
Chip Select 0 Lower Control Register	CS0L	0x00220004
Chip Select 1 Upper Control Register	CS1U	0x00220008
Chip Select 1 Lower Control Register	CS1L	0x0022000C
Chip Select 2 Upper Control Register	CS2U	0x00220010
Chip Select 2 Lower Control Register	CS2L	0x00220014
Chip Select 3 Upper Control Register	CS3U	0x00220018
Chip Select 3 Lower Control Register	CS3L	0x0022001C
Chip Select 4 Upper Control Register	CS4U	0x00220020
Chip Select 4 Lower Control Register	CS4L	0x00220024
Chip Select 5 Upper Control Register	CS5U	0x00220028
Chip Select 5 Lower Control Register	CS5L	0x0022002C
EIM Configuration Register	EIM	0x00220030

11-10 Freescale Semiconductor

11.6.1 Chip Select 0 Control Registers

The layout of the Chip Select 0 control registers are slightly different from the other Chip Select control registers because \overline{CS} [0] does not support the programmable output function.

The 64 bits of control are divided into two registers, Chip Select 0 Upper Control Register and Chip Select 0 Lower Control Register.

- Bits [63:32] are located in Chip Select 0 Upper Control Register.
- Bits [31:0] are located in Chip Select 0 Lower Control Register.

11.6.1.1 Chip Select 0 Upper Control Register

CS0L	J	Chip Select 0 Upper Control Register ¹											Addr 0x00220000			
BIT	63	62	61	60	59	58	57	56	55	54	53	52	51	50	49	48
			В	CD	BCS			P	SZ	PME	SYNC		DO	OL		
TYPE	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET								0x	0000							
BIT	47	46	45	44	43	42	41	40	39	38	37	36	35	34	33	32
	CN	1C			W	WSC				wws			EDC			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0
NESEI								0x3	3E00							

¹For bit descriptions, see Table 11-5 on page 11-13.

11.6.1.2 Chip Select 0 Lower Control Register

CS0L	Chip Select 0 Lower Control Register ¹											Addr 0x00220004				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		0	EA			0	EN			W	ΈA			WI	EN	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
HLOLI								0x0	0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		C	SA		EBC		DSZ			SP		WP				CSEN
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	r	rw	r	r	r	rw
RESET	0	0	0	0	1	*	*	*	0	0	0	0	0	0	0	1
TILOLI								0x0	0801							

A -1 -1--

11.6.2 Chip Select 1-Chip Select 5 Control Registers

The layout of the control registers for Chip Selects 1 through 5 are identical.

The 64 bits of control per chip select are divided into an Upper and a Lower register.

- Bits [63:32] are located in Chip Select x Upper Control Register.
- Bits [31:0] are located in Chip Select x Lower Control Register.

11.6.2.1 Chip Select 1-Chip Select 5 Upper Control Registers

For bit descriptions for all of these registers, see Table 11-5 on page 11-13.

¹For bit descriptions, see Table 11-5 on page 11-13.

^{*}Configurable on reset.

11.6.2.2 Chip Select 1-Chip Select 5 Lower Control Registers

For bit descriptions for Chip Select 1–Chip Select 5 registers, see Table 11-5.

CS1L CS2L CS3L CS4L CS5L	- - -				Chip S Chip S Chip S	Chip Select 1 Lower Control Register Chip Select 2 Lower Control Register Chip Select 3 Lower Control Register Chip Select 4 Lower Control Register Chip Select 5 Lower Control Register									Addr 0x0022000C 0x00220014 0x0022001C 0x00220024 0x0022002C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
		O	EΑ			0	EN		WEA				WEN					
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
TILOLI								0x00	000									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
		С	SA		EBC		DSZ			SP		WP			PA	CSEN		
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	r	rw	r	r	rw	rw		
RESET	0	0	0	0	1	0	0	0	0	0	0	0	0	0	1	0		
TILOLI								30x0	302									

Table 11-5. Chip Select Control Registers Description

Name	Description	Settings				
DTACK_SEL Bit 63	DTACK Select—This bit is used to select the functionality of the DTACK input signal for CS5 to support either a generic DTACK signal or the Compact Flash/PCMCIA wait function. To select the DTACK functionality on CS5, the WSC bits for CS5 must be set to 111111.	0 = Generic DTACK function 1 = Compact Flash/PCMCIA wait function				
BCD Bits 61–60	Burst Clock Divisor—Contains the value used to program the burst clock divisor. See Section 11.5.4, "Burst Clock Divisor," for more information on the burst clock divisors. When the BCM bit is set (BCM = 1) in the EIM configuration register, BCD is ignored. BCD is cleared by a hardware reset.	00 = Divisor is 1 01 = Divisor is 2 10 = Divisor is 3 11 = Divisor is 4				
BCS Bits 59–56	Burst Clock Start—Determines the number of half cycles after LBA assertion before the first rising edge of BCLK (burst clock) is seen. A value of 0 results in a half clock delay, not an immediate assertion. When the BCM bit is set (BCM = 1) in the EIM configuration register, this overrides the BCS bits. BCS is cleared by a hardware reset.	0000 = 1 half cycle before BCLK (burst clock) 0001 = 2 half cycles before BCLK (burst clock) 1111 = 16 half cycles before BCLK (burst clock)				

Programming Model

Table 11-5. Chip Select Control Registers Description (continued)

Description	Settings
Page Size—Indicates the number of words (where "word" is defined by the port size or DSZ bits) in a page in memory. This ensures that the EIM does not burst past a page boundary when the PME bit is set.	00 = 4 words in a page 01 = 8 words in a page 10 = 16 words in a page 11 = 32 words in a page
Page Mode Emulation—Enables/Disables page mode emulation in burst mode. When PME is set, the external address asserts for each piece of data requested. Additionally, the LBA and BCLK signals behave as they do when an asynchronous access is performed. PME is cleared by a hardware reset.	0 = Disables page mode emulation 1 = Enables page mode emulation
Synchronous Burst Mode Enable—Enables/Disables synchronous burst mode. When enabled, the EIM is capable of interfacing to burst flash devices through additional burst control signals: BCLK (burst clock), LBA, and ECB. The sequencing of these additional I/Os is controlled by other EIM configuration register bit settings as defined below. SYNC is cleared by a hardware reset.	0 = Disables synchronous burst mode 1 = Enables synchronous burst mode
Data Output Length—Specifies the expected number of system clock cycles required for burst read data to be valid on the data bus before it is latched by the EIM. The reset value specifies that burst data is held for a single system clock period. As system clock frequencies increase, it may become necessary to delay sampling the data for multiple system clock periods to meet burst flash max frequency specifications and/or EIM data setup time requirements. DOL has no effect on EIM data latching when SYNC = 0.	0000 = 1system clock delays 0001 = 1system clock delays 0010 = 2system clock delays 0011 = 3system clock delays 1111 = 15 system clock delays
Chip Select Negation Clock Cycles—Specifies the minimum number of clock cycles a chip select must remain negated after it is negated. CNC has no effect on write accesses when any CSA bit is set.	00 = Minimum negation is 0 clock cycles 01 = Minimum negation is 1 clock cycle 10 = Minimum negation is 2 clock cycles 11 = Minimum negation is 3 clock cycles
	Page Size—Indicates the number of words (where "word" is defined by the port size or DSZ bits) in a page in memory. This ensures that the EIM does not burst past a page boundary when the PME bit is set. PSZ is cleared by a hardware reset. Page Mode Emulation—Enables/Disables page mode emulation in burst mode. When PME is set, the external address asserts for each piece of data requested. Additionally, the LBA and BCLK signals behave as they do when an asynchronous access is performed. PME is cleared by a hardware reset. Synchronous Burst Mode Enable—Enables/Disables synchronous burst mode. When enabled, the EIM is capable of interfacing to burst flash devices through additional burst control signals: BCLK (burst clock), LBA, and ECB. The sequencing of these additional I/Os is controlled by other EIM configuration register bit settings as defined below. SYNC is cleared by a hardware reset. Data Output Length—Specifies the expected number of system clock cycles required for burst read data to be valid on the data bus before it is latched by the EIM. The reset value specifies that burst data is held for a single system clock period. As system clock frequencies increase, it may become necessary to delay sampling the data for multiple system clock periods to meet burst flash max frequency specifications and/or EIM data setup time requirements. DOL has no effect on EIM data latching when SYNC = 0. DOL is cleared by a hardware reset. Chip Select Negation Clock Cycles—Specifies the minimum number of clock cycles a chip select must remain negated after it is negated. CNC has no effect on write accesses when any CSA bit is

11-14 Freescale Semiconductor

Table 11-5. Chip Select Control Registers Description (continued)

Name	Description	Settings
WSC Bits 45–40	Wait State Control— For SYNC = 0: WSC programs the number of wait-states for an access to the external device connected to the chip select. Table 11-6, "Chip Select Wait State and Burst Delay Encoding" shows the encoding of this field. When WWS is cleared, setting: • WSC = 000000 results in 2 clock transfers • WSC = 0001110 results in 2 clock transfers • WSC = 001110 results in 15 clock transfers • WSC = 111110 results in 63 clock transfers • WSC=111111 selects DTACK input functionality for CS5 For SYNC = 1: WSC programs the number of system clock cycles required for the initial access of a burst sequence initiated by the EIM to an external burst device. See Table 11-6, "Chip Select Wait State and Burst Delay Encoding" and to the EIM synchronous burst read timing diagrams for further details. to, the WSC WSC is set to 111110 by a hardware reset for CS0. WSC is cleared by a hardware reset for CS1-CS5.	See Table 11-6, "Chip Select Wait State and Burst Delay Encoding"
Reserved Bit 39	Reserved—This bit is reserved and should read 0.	
wws Bits 38–36	Write Wait State—Determines whether additional wait-states are required for write cycles. This is useful for writing to memories that require additional data setup time. WWS is cleared by a hardware reset.	See Table 11-6, "Chip Select Wait State and Burst Delay Encoding"
EDC Bits 35–32	Extra Dead Cycles—Determines whether idle cycles are inserted after a read cycle for back-to-back external transfers to eliminate data bus contention. This is useful for slow memory and peripherals that use long \overline{CS} or \overline{OE} to output data three-state times. Idle cycles are not inserted for back-to-back external reads from the same chip select.	0000 = 0 Idle cycles inserted 0001 = 1 Idle cycle inserted 1111 = 15 Idle cycles inserted

Freescale Semiconductor

Table 11-5. Chip Select Control Registers Description (continued)

Name	Description	Settings
OEA Bits 31–28	OE Assert—Determines when OE is asserted during read cycles.	0000 = 0 half clocks before assertion 0001 = 1 half clock before assertion
	For SYNC = 0: OEA determines the number of half clocks before \overline{OE} asserts during a read cycle.	 1111 = 15 half clocks before assertion
	For SYNC = 1: After the initial burst access, \overline{OE} is asserted continuously for subsequent burst accesses, and is not affected by OEA (see burst read timing diagrams for more detail). The behavior of \overline{OE} on the initial burst access is the same as when SYNC = 0. When the EBC bit in the corresponding register is clear, the \overline{EB} [3:0] outputs are similarly affected.	
	The OEA bits do not affect the cycle length.	
	OEA is cleared by a hardware reset.	
OEN Bits 27–24	OE Negate—Determines when OE is negated during a read cycle. Setting the SYNC bit (SYNC = 1) overrides OEN and OE negates at the end of a read access and no sooner. When EBC in the corresponding register is clear, the EB [3:0] outputs are similarly affected.	0000 = 0 half clocks before end of access 0001 = 1 half clock before end of access 1111 = 15 half clocks before end of access
	OEN does not affect the cycle length.	
	OEN is cleared by a hardware reset.	
WEA Bits 23–20	EB [3:0] Assert—Determines when EB [3:0] is asserted during write cycles. This is useful to meet data setup time requirements for slow memories. WEA does not affect the cycle length.	0000 = 0 half clocks before assertion 0001 = 1 half clock before assertion 1111 = 15 half clocks before assertion
	WEA is cleared by a hardware reset.	
WEN Bits 19–16	EB [3:0] Negate During Write—Determines when EB [3:0] outputs are negated during a write cycle. This is useful to meet data hold time requirements for slow memories. WEN does not affect the cycle length.	0000 = 0 half clocks before end of access 0001 = 1 half clock before end of access 1111 = 15 half clocks before end of access
	WEN is cleared by a hardware reset.	

11-16 Freescale Semiconductor

Table 11-5. Chip Select Control Registers Description (continued)

Name	Description	Settings			
CSA Bits 15–12	Chip Select Assert—Determines when chip select is asserted and negated for devices that require additional address setup time and additional address/data hold times. CSA affects only external writes, and is ignored on external reads.	0000 = 0 clocks before assertion and 0 clocks following negation 0001 = 1 clock before assertion and 1 clock following negation			
	CSA does not affect the cycle length.	1111 = 15 clocks before assertion and 15 clocks after negation			
	CSA is cleared by a hardware reset.				
EBC Bit 11	Enable Byte Control—Indicates the access types that assert the enable byte outputs (EB [3:0]). EBC is set by a hardware reset.	0 = Both read and write accesses assert the \overline{EB} [3:0] outputs, thus configuring the access as byte enables 1 = Only write accesses assert the \overline{EB} [3:0] outputs, thus configuring the access as byte write enables; the \overline{EB} [3:0] outputs are configured as byte write enables for accesses to dual x16 or quad x8 memories			
DSZ Bits 10–8	Data Port Size—Defines the width of the external device's data port as shown in the table, DSZ Bit Encoding, to the right. At hardware reset, the value of DSZ is 000 for CS1-CS5. For CS0, DSZ is mapped based on the value of the EIM_BOOT_DSZ [2:0] bits. EIM_BOOT_DSZ [2] maps to DSZ [2], EIM_BOOT_DSZ [1] maps to DSZ [1] and EIM_BOOT_DSZ [0] maps to DSZ [0].				
Reserved Bit 7	Reserved—This bit is reserved and should read 0.				
SP Bit 6	Supervisor Protect—Prevents accesses to the address range defined by the corresponding chip select when the access is attempted in the User mode of ARM9 core operation. SPI is cleared by a hardware reset.	0 = User mode accesses are allowed in the range of chip select 1 = User mode accesses are prohibited; attempts to access an address mapped by this chip select in User mode results in a TEA to the ARM9 core and no assertion of the chip select output			
Reserved Bit 5	Reserved—This bit is reserved and should read 0.				
WP Bit 4	Write Protect—Prevents writes to the address range defined by the corresponding chip select. WP is cleared by a hardware reset.	0 = Writes are allowed in the range of chip select 1 = Writes are prohibited; attempts to write to an address mapped by this chip select result in a TEA to the ARM9 core and no assertion of the chip select output			
Reserved Bits 3–2	Reserved—These bits are reserved and should read 0.	,			

Freescale Semiconductor

Table 11-5. Chip Select Control Registers Description (continued)

Name	Description	Settings
PA Bit 1	Pin Assert—Controls the chip select pin when it is operating as a programmable output pin (when the CSEN bit is clear). PA is not available (reserved) for CSO. PA is set by a hardware reset for CS1–CS5.	0 = Brings the chip select output to logic-low 1 = Brings the chip select output to logic-high
CSEN Bit 0	Chip Select Enable—Controls the operation of the chip select pin. Except for CSO, CSEN is cleared by reset, disabling the chip select output pin. When enabled, the PA control bit is ignored. CSEN in the CSO control register is set at reset to allow CSO to select from an external boot ROM. CSEN is set by a hardware reset for CSO. CSEN is cleared by a hardware reset for CS1—CS5.	0 = Chip select function is disabled; attempts to access an address mapped by this chip select results in an error and no assertion of the chip select output When disabled, the pin is a general purpose output controlled by the value of PA control bit. When CSEN in the CS0 control register is clear, CS0 is inactive. 1 = Chip select is enabled, and is asserted when presented with a valid AHB access.

11-18 Freescale Semiconductor

11.6.3 EIM Configuration Register

Table 11-6. Chip Select Wait State and Burst Delay Encoding

	Number of Wait-States									
WSC [5:0]	ww	S = 0	ww	S = 1	ww	S = 7				
	Read Access	Write Access	Read Access	Write Access	Read Access	Write Access				
000000	1	1	1	1	1	7				
000001	1	1	1	2	1	8				
000010	2	2	2	3	2	9				
000011	3	3	3	4	3	10				
000100	4	4	4	5	4	11				
000101	5	5	5	6	5	12				
000110	6	6	6	7	6	13				
000111	7	7	7	8	7	14				
001000	8	8	8	9	8	15				
001001	9	9	9	10	9	16				
001010	10	10	10	11	10	17				
001011	11	11	11	12	11	18				
001100	12	12	12	13	12	19				
001101	13	13	13	14	13	20				
001110	14	14	14	15	14	21				
001111	15	15	15	16	15	22				
010000	16	16	16	17	16	23				
010001	17	17	17	18	17	24				
010010	18	18	18	19	18	25				
010011	19	19	19	20	19	26				
010100	20	20	20	21	20	27				
010101	21	21	21	22	21	28				
010110	22	22	22	23	22	29				
010111	23	23	23	24	23	30				
011000	24	24	24	25	24	31				
011001	25	25	25	26	25	32				
011010	26	26	26	27	26	33				
011011	27	27	27	28	27	34				
011100	28	28	28	29	28	35				
011101	29	29	29	30	29	36				
011110	30	30	30	31	30	37				

Freescale Semiconductor 11-19

Table 11-6. Chip Select Wait State and Burst Delay Encoding (continued)

	Number of Wait-States							
WSC [5:0]	ww	S = 0	ww	S = 1	ww	S = 7		
	Read Access	Write Access	Read Access	Read Access Write Access		Write Access		
011111	31	31	31	32	31	38		
100000	32	32	32	33	32	39		
100001	33	33	33	34	33	40		
100010	34	34	34	35	34	41		
100011	35	35	35	36	35	42		
100100	36	36	36	37	36	43		
100101	37	37	37	38	37	44		
100110	38	38	38	39	38	45		
100111	39	39	39	40	39	46		
101000	40	40	40	41	40	47		
101001	41	41	41	42	41	48		
101010	42	42	42	43	42	49		
101011	43	43	43	44	43	50		
101100	44	44	44	45	44	51		
101101	45	45	45	46	45	52		
101110	46	46	46	47	46	53		
101111	47	47	47	48	47	54		
110000	48	48	48	49	48	55		
110001	49	49	49	50	49	56		
110010	50	50	50	51	50	57		
110011	51	51	51	52	51	58		
110100	52	52	52	53	52	59		
110101	53	53	53	54	53	60		
110110	54	54	54	55	54	61		
110111	55	55	55	56	55	62		
111000	56	56	56	57	56	63		
111001	57	57	57	58	57	63		
111010	58	58	58	59	58	63		
111011	59	59	59	60	59	63		
111100	60	60	60	61	60	63		
111101	61	61	61	62	61	63		
111110	62	62	62	63	62	63		

MC9328MXS Reference Manual, Rev. 1

11-20 Freescale Semiconductor

Table 11-6. Chip Select Wait State and Burst Delay Encoding (continued)

	Number of Wait-States									
WSC [5:0]	ww:	WWS = 0				S = 7				
	Read Access	Write Access	Read Access	Write Access	Read Access	Write Access				
111111	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved				

The EIM Configuration Register contains the bit that controls the operation of the burst clock.

EIM	EIM Configuration Register								0x00		ddr 030					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x0000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
														ВСМ		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	rw	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET								0x0000								

Table 11-7. EIM Configuration Register Description

Name	Description	Settings				
Reserved Bits 31–3	Reserved—These bits are reserved and should read 0.					
BCM Bit 2	Burst Clock Mode—Selects the burst clock mode of operation. BCM is cleared by a hardware reset.	 0 = The burst clock runs only when accessing a chip select range with the SYNC bit set. When the burst clock is not running, it remains in a logic 0 state; when the burst clock is running, it is configured by the BCD and BCS bits in the chip select control register. 1 = The burst clock runs all the time (independent of chip select accesses). 				
Reserved Bits 1–0	Reserved—These bits are reserved and should read 0.					

Freescale Semiconductor 11-21

MC9328MXS Reference Manual, Rev. 1

11-22 Freescale Semiconductor

Chapter 12 Phase-Locked Loop and Clock Controller

12.1 Introduction

To produce the wide range of on-chip clock frequencies required by the MC9328MXS, the core clock generator uses a two-stage phase locked loop (PLL). The first stage is a premultiplier PLL. If the input crystal frequency is 32.768 kHz, the premultiplier multiplies it by a factor of 512 to 16.78 MHz. If the input crystal frequency is 32 kHz, the premultiplier multiplies it to 16.384 MHz. The second stage is a digital PLL (DPLL) that produces an output frequency determined by system requirements and used throughout the entire system. The two DPLLs (MCU PLL and System PLL) use digital and mixed analog/digital chips to provide clock generation for wireless communication and other applications. Power management of the MC9328MXS is accomplished by controlling the operation of the premultiplier, MCU PLL and System PLL units, as shown in Figure 12-1 on page 12-2.

12.2 Clock Sources

The distribution of clocks in the MC9328MXS is shown in Figure 12-1 on page 12-2. Clock signal name definitions are provided in Table 12-1 on page 12-2.

The 32kHz clock source can be configured in two ways. The user can place a 32 kHz or 32.768 kHz crystal across EXTAL32K and XTAL32K with appropriate load capacitors. Alternately, an external 32 kHz or 32.768 kHz oscillator can be used; the signal is AC coupled into EXTAL32K and XTAL32K is floated.

The 16 MHz external crystal oscillator is not recommended for use and must be disabled using the CSCR register. Note that the 32 kHz oscillator must be used and satisfies all system requirements.

12.2.1 Low Frequency Clock Source

The MC9328MXS can use either a 32 kHz or a 32.768 kHz crystal as the external low frequency source. Throughout this chapter, the low frequency crystal is referred to as the 32 kHz crystal. The signal from the external 32 kHz crystal is the source of the CLK32 signal that is sent to the real time clock (RTC). The output of the 32 kHz crystal is also input to the premultiplier PLL to produce the 16.78 MHz signal that is input to the MCU PLL (it is 16.78 MHz if a 32.768 kHz crystal is used). The output of the MCU PLL is sent to the prescaler (PRESC) module to produce the fast clock (FCLK) signal for the ARMTDMI core.

The 16.384 MHz output of the premultiplier PLL also can be a source for the System PLL by setting the System_SEL bit in the Clock Source Control Register to produce all of the system clocks from a single 32 kHz crystal oscillator. See Section 12.3.1, "DPLL Phase and Frequency Jitter," for more detailed information on phase and frequency jitter specifications using this configuration.

Freescale Semiconductor 12-1

12.2.2 High Frequency Clock Source

The System PLL produces the USBPLLCLK signal that is the source for the following clock signals:

- CLK48M—for the USB
- HCLK and BCLK—HCLK is the MC9328MXS system clock and BCLK goes to the ARMTDMI core.
- Peripheral Clocks 1, 2, and 3—The peripheral clocks (PERCLK) provide clock signals to both integrated and external peripherals.

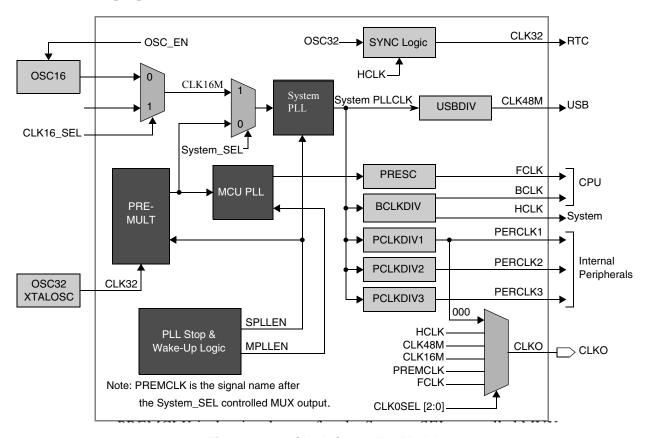


Figure 12-1. Clock Controller Module

Table 12-1. Clock Controller Module Signal Descriptions

Signal Names	I/O	Description			
CLK48M	0	ontinuous 48 MHz clock output when System PLL is enabled or when external 3 MHz clock is selected.			
FCLK	0	Fast clock (FCLK) output to the CPU.	Run		
HCLK	0	System clock (HCLK) output to the CPU (as BCLK) and to the system. This is a continuous clock (when the system is not in sleep mode) normally used for bus non-stop system logic (such as bus arbiter or interrupt controller) when the system is running.	Run		
CLKO	0	Output internal clock to the CLKO pin.	Run		

MC9328MXS Reference Manual, Rev. 1

12-2 Freescale Semiconductor

Table 12-1. Clock Controller Module Signal Descriptions (continued)

Signal Names	I/O	Description	Default
PERCLK1, 2, 3	0	Output clocks used by the peripheral modules.	

12.3 DPLL Output Frequency Calculation

The DPLL (both the MCU PLL and System PLL) produce a high frequency clock that exhibits both a low frequency jitter and a low phase jitter. The DPLL output clock frequency (f_{dpll}) is determined by the Equation 12-1:

$$f_{dpll} = 2f_{ref} \cdot \frac{MFl + MFN / (MFD+1)}{PD + 1}$$

Egn. 12-1

where:

- f_{ref} is the reference frequency
- MFI is an integer part of a multiplication factor (MF)
- MFN is the numerator and MFD is the denominator of the MF
- PD is the predivider factor

12.3.1 DPLL Phase and Frequency Jitter

Spectral purity of the DPLL output clock is characterized by both phase and frequency jitter. Phase jitter is a measure of clock phase fluctuations relative to an ideal clock phase. The output clock also can be skewed relative to the reference clock. Frequency jitter is a measure of clock period fluctuations relative to an ideal clock period. Frequency jitter is calculated as a difference of phase jitter values for adjacent clocks.

DPLL jitter requirements vary according to system configuration. For many stand-alone processors and asynchronous multiprocessor applications, only the frequency jitter value is important (slow phase jitter and clock skew do not affect system performance). In these systems, it is not necessary to adjust the output clock phase with an input clock phase. The clock generation mode in which slow phase fluctuations are permissible is called Frequency Only Lock (FOL) mode.

Phase error is sometimes important for synchronous applications and sampling analog-to-digital (A/D) and digital-to-analog (D/A) precision converters. The DPLL mode providing minimum phase jitter and skew elimination is Frequency and Phase Lock (FPL) mode. The DPLL mode is user selectable.

The DPLL communicates with the clock module. This block contains a control register and provides an interface between the DPLL and the ARMTDMI core.

12.4 MC9328MXS Power Management

The operation of the PLL and clock controller at different stages of power management is described in the following sections.

Freescale Semiconductor 12-3

MC9328MXS Power Management

12.4.1 PLL Operation at Power-Up

The crystal oscillator begins oscillating within several hundred milliseconds of initial power-up. While reset remains asserted, the PLL begins the lockup sequence and locks 1 ms after the crystal oscillator becomes stable. After lockup occurs, the system clock is available at the default System PLL output frequency of 96 MHz (when a 32 kHz crystal is used).

12.4.2 PLL Operation at Wake-Up

When the device is awakened from stop mode by a wake-up event, the DPLL locks within 300 μ s. The crystal oscillator is always on after initial power-up, so crystal startup time is not a factor. The PLL output clock starts operating as soon as it achieves lock.

12.4.3 ARM920T Processor Low-Power Modes

The MC9328MXS provides two power saving modes, doze and stop:

- In stop mode, the MCU PLL and the System PLL are shut down and only the 32 kHz clock is running.
- In doze mode, the CPU executes a wait for interrupt instruction.

These modes are controlled by the clock control logic and a sequence of CPU instructions. Most of the peripheral modules can enable or disable the incoming clock signal (PERCLK 1, 2, or 3) through clock gating circuitry from the peripheral bus.

12.4.4 SDRAM Power Modes

When the SDRAM controller (SDRAMC) is enabled, the external SDRAM operates in distributed-refresh mode or in self-refresh mode (as shown in Table 12-2). The SDRAM wake-up latency is approximately 20 system clock cycles (HCLK). The SDRAMC can wake up from self-refresh mode when it is in a SDRAM cycle. In doze mode, the SDRAM enters self-refresh mode. When a bus cycle accesses the SDRAM or SyncFlash, the controller wakes up and completes the bus cycle, then returns to self-refresh mode.

SDRAM	Run	Doze	Stop
SDRAM	Distributed-refresh Self-refresh		Self-refresh
SyncFlash	Run	Low-power mode	Deep power-down mode

Table 12-2. SDRAM/SyncFlash Operation During Power Modes

12.4.5 Power Management in the Clock Controller

Power management in the MC9328MXS is achieved by controlling the duty cycles of the clock system efficiently. The clocking control scheme is shown in Table 12-3.

12-4 Freescale Semiconductor

Table 12-3. Power Management in the Clock Controller

Device/Signal	Shut-Down Conditions	Wake-Up Conditions
System PLL	When 0 is written to the SPEN bit and the PLL shut-down count times out (for details see the SD_CNT settings in Table 12-5 on page 12-6).	When IRQ or FIQ is asserted.
MCU PLL	When 0 is written to the MPEN bit.	When IRQ or FIQ is asserted, or 1 is written to the MPEN bit.
Premultiplier	Same as System PLL.	Same as System PLL.
CLK32	Continuously running.	Continuously running.

The PLL and Clock Controller module includes six user-accessible 32-bit registers. Table 12-4 summarizes these registers and their addresses.

Table 12-4. PLL and Clock Controller Module Register Memory Map

Description	Name	Address
Clock Source Control Register	CSCR	0x0021B000
Peripheral Clock Divider Register	PCDR	0x0021B020
MCU PLL Control Register 0	MPCTL0	0x0021B004
MCU PLL and System Clock Control Register 1	MPCTL1	0x0021B008
System PLL Control Register 0	SPCTL0	0x0021B00C
System PLL Control Register 1	SPCTL1	0x0021B010

12.5.1 Clock Source Control Register

This register controls the various clock sources to the internal modules of the MC9328MXS. It allows the bypass of the 32 kHz derived clock source to the System PLL when the design requires clock signals with greater frequency and phase jitter performance than the internal PLL using the 32 kHz clock source provides.

CSCR	ł	Clock Source Control Register												02	0x0021B000		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
	CLK	O_SEL	-	U	SB_D	IV	SD_	CNT		SPLL_ RESTART	MPLL_ RESTART			CLK16 _SEL	OSC _EN	System _SEL	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	r	r	rw	rw	rw	
RESET	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0	0	
TILOLI									0	x0F00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	PRESC			BCL	C_DIV										SPEN	MPEN	
TYPE	rw	r	rw	rw	rw	rw	r	r	r	r	r	r	r	r	rw	rw	
RESET	1	0	1	0	1	1	0	0	0	0	0	0	0	0	1	1	
TILOLI									0	xAC03							

Table 12-5. Clock Source Control Register Description

Name	Description	Settings
CLKO_SEL Bits 31–29	CLKO Select—Selects the clock signal source that is output on the CLKO pin.	000 = PERCLK1 001 = HCLK 010 = CLK48M 011 = CLK16M 100 = PREMCLK 101 = FCLK
USB_DIV Bits 28–26	USB Divider—Contains the integer divider value used to generate the CLK48M signal for the USB modules.	000 = System PLL clock divide by 1 001 = System PLL clock divide by 2 . 111 = System PLL clock divide by 8
SD_CNT Bits 25–24	Shut-Down Control—Contains the value that sets the duration of System PLL clock output after 0 is written to the SPEN bit. The power controller requests the bus before System PLL shutdown. Any unmasked interrupt event enables the System PLL.	00 = System PLL shuts down after next rising edge of CLK32 is detected and the current bus cycle is completed. A minimum of 16 HCLK cycles is guaranteed from writing ¡°0¡± to SPEN bit. 01 = System PLL shuts down after the second rising edge of CLK32 is detected. 10 = System PLL shuts down after the third rising edge of CLK32 is detected. 11 = System PLL shuts down after forth rising edge of CLK32 is detected.
Reserved Bit 23	Reserved—This bit is reserved and should read 0.	

12-6 Freescale Semiconductor

Table 12-5. Clock Source Control Register Description (continued)

Name	Description	Settings
SPLL_ RESTART Bit 22	SPLL Restart—Restarts System PLL at new assigned frequency. SPLL_RESTART self-clears after 1 (min) or 2 (max) cycles of CLK32.	0 = No Effect 1 = Restarts System PLL at new frequency
MPLL_ RESTART Bit 21	MPLL Restart —Restarts the MCU PLL at a new assigned frequency. MPLL_RESTART self-clears after 1 (min) or 2 (max) cycles of CLK32.	0 = No Effect 1 = Restarts MCU PLL at new frequency
Reserved Bits 20–19	Reserved—These bits are reserved and should read 0.	
OSC_EN Bit 17	Oscillator Enable—Enables the 16 MHz oscillator circuit when set (available when using an external crystal input). When clear, the oscillator circuit control is disabled which bypasses the oscillator circuit when using external clock input. This oscillator is not recommended for use.	0 = Disable the external 16 MHz oscillator circuit (Recommended) 1 = Enable the external 16 MHz oscillator circuit
System_SEL Bit 16	System Select—Selects the clock source of the System PLL input. When set, the external high frequency clock input is selected.	0 = Clock source is the internal premultiplier 1 = Clock source is the external high frequency clock
PRESC Bit 15	Prescaler—Defines the MPU PLL clock prescaler.	0 = Prescaler divides by 1 1 = Prescaler divides by 2
Reserved Bit 14	Reserved—This bit is reserved and should read 0.	
BCLK_DIV Bits 13–10	BClock Divider —Contains the 4-bit integer divider values for the generation of the BCLK and HCLK.	0000 = System PLLCLK divided by 1 0001 = System PLLCLK divided by 2 1111 = System PLLCLK divided by 16
Reserved Bits 9–2	Reserved—These bits are reserved and should read 0.	
SPEN Bit 1	System PLL Enable—Enables/Disables the System PLL. When software writes 0 to SPEN, the System PLL shuts down after SDCNT times out. SPEN sets automatically when SPLLEN asserts, and on system reset.	0 = System PLL disabled 1 = System PLL enabled
MPEN Bit 0	MCU PLL Enable—Enables/Disables the MCU PLL. When cleared, the MCU PLL is disabled. When software writes 0 to MPEN, the PLL shuts down immediately. MPEN sets automatically when MPLLEN asserts, and on system reset.	0 = MCU PLL disabled 1 = MCU PLL enabled

12.5.2 Peripheral Clock Divider Register

Each peripheral module in the MC9328MXS uses clock signals from one of the three clock sources shown in Table 12-6. The three peripheral clock dividers (PCLKDIV1, PCLKDIV2, PCLKDIV3) provide flexible clock configuration capability so that a minimum set of clock frequencies can satisfy a large group of modules to achieve better power efficiency.

Freescale Semiconductor 12-7

Table 12-6. Clock Sources for Peripherals

Clock Source	Peripheral
PERCLK1	UART1, UART2, Timer1, Timer2, PWM
PERCLK2	LCD, SPI 1
PERCLK3	SSI
HCLK	SDRAM, I ² C, DMA

Addr PCDR Peripheral Clock Divider Register 0x0021B020 ВІТ 27 31 30 29 28 26 25 24 23 22 21 20 19 18 17 16 PCLK_DIV3 TYPE r r r r r r rw rw rw rw rw rw 0 0 0 0 0 0 0 0 0 0 0 0 0 1 RESET 0x000B BIT 15 14 13 12 9 8 7 6 5 4 3 0 11 10 2 PCLK_DIV2 PCLK_DIV1 **TYPE** r r r rw rw rw rw rw rw rw 0 0 0 0 0 1 0 0 0 1 0 1 1 0 1 1 RESET 0x00BB

Table 12-7. Peripheral Clock Divider Register Description

Name	Description	Settings
Reserved Bits 31–23	Reserved—These bits are reserved and should read 0.	
PCLK_DIV3 Bits 22–16	Peripheral Clock Divider 3—Contains the 7-bit integer divider that produces the PERCLK3 clock signal for the peripherals. The input to the PCLK_DIV3 divider circuit is System PLLCLK.	0000000 = Divide by 1 0000001 = Divide by 2 1111111 = Divide by 128
Reserved Bits 15–8	Reserved—These bits are reserved and should read 0.	
PCLK_DIV2 Bits 7–4	Peripheral Clock Divider 2—Contains the 4-bit integer divider that produces the PERCLK2 clock signal for the peripherals. The input to the PCLK_DIV2 divider circuit is System PLLCLK.	0000 = Divide by 1 0001 = Divide by 2 1111 = Divide by 16
PCLK_DIV1 Bits 3–0	Peripheral Clock Divider 1—Contains the 4-bit integer divider that produces the PERCLK1 clock signal for the peripherals. The input to the PCLK_DIV1 divider circuit is System PLLCLK.	0000 = Divide by 1 0001 = Divide by 2 1111 = Divide by 16

MC9328MXS Reference Manual, Rev. 1

12-8 Freescale Semiconductor

12.5.3 Programming Digital Phase Locked Loops

There are two DPLLs in the MC9328MXS—the MCU PLL and the System PLL. The MCU PLL primarily generates FCLK to the CPU, and the System PLL derives all system clocks to the entire MC9328MXS and generates clocks that produce the programmable frequency range required by modules such as the USB, UARTs, and SSI.

The MCU PLL derives the ARM920T processor's CPU clock FCLK, and the System PLL derives the ARM920T processor's CPU clock BCLK, as well as the system clocks PERCLK 1, 2, and 3, and HCLK. The MCU PLL frequency is determined by the speed requirement of the ARM920T processor. The recommended settings for both MCU PLL and System PLL, which produces the least amount of signal jitter, are shown in Table 12-8.

Premultiplier Input Crystal Frequency	PLL Input Frequency (Premultiplier Output)	PD	MFD	MFI	MFN	PLL Output Frequency		
32 kHz	16.384 MHz	0	63	5	55	192 MHz		

Table 12-8. Sample Frequency Table

12.5.3.1 MCU PLL Control Register 0

The MCU PLL Control Register 0 (MPCTL0) is a 32-bit register that controls the operation of the MCU PLL. The MPCTL0 control bits are described in the following sections. A delay of 56 FCLK cycles (about 10–30 FCLK cycles for MCU PLL controller plus 2–26 FCLK cycles are necessary to get EDRAM_IDLE and SDRAM_IDLE signals) is required between two write accesses to MPCTL0 register. The following is a procedure for changing the MCU PLL settings:

- 1. Program the desired values of PD, MFD, MFI, and MFN into the MPCTL0.
- 2. Set the MPLL RESTART bit in the CSCR (it will self-clear).
- 3. New PLL settings will take place.

MPCT	L0		MCU PLL Control Register 0										0x0	Addı 0x0021B004		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
				Р	D						M	FD				
TYPE	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
RESET								0x00	3F							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
				М	FI						M	FN				
TYPE	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	1	0	1	0	0	0	0	1	1	0	1	1	1
NESET								0x14	37							

Freescale Semiconductor 12-9

Table 12-9. MCU PLL Control Register 0 Description

Name	Description	Settings
Reserved Bits 31–30	Reserved—These bits are reserved and should read 0.	
PD Bits 29–26	Predivider Factor —Defines the predivider factor (PD) applied to the PLL input frequency. PD is an integer between 0 and 15 (inclusive). PD is chosen to ensure that the resulting output frequency remains within the specified range. When a new value is written into PD bits, the PLL loses its lock; after a time delay, the PLL re-locks. The output of the MCU PLL is determined by Equation 12-1.	0000 = 0 0001 = 1 1111 = 15
MFD Bits 25–16	Multiplication Factor (Denominator Part) —Defines the denominator part of the BRM value for the MF. When a new value is written into the MFD bits, the PLL loses its lock; after a time delay, the PLL re-locks.	0x000 = Reserved 0x001 = 1 0x3FF = 1023
Reserved Bits 15–14	Reserved—These bits are reserved and should read 0.	
MFI Bits 13–10	Multiplication Factor (Integer) —Defines the integer part of the BRM value for the MF. The MFI is encoded so that MFI < 5 results in MFI = 5. When a new value is written into the MFI bits, the PLL loses its lock: after a time delay, the PLL re-locks. The VCO oscillates at a frequency determined by Equation 12-1. Where PD is the division factor of the predivider, MFI is the integer part of the total MF, MFN is the numerator of the fractional part of the MF, and MFD is its denominator part. The MF is chosen to ensure that the resulting VCO output frequency remains within the specified range.	0000-0101 = 5 0110 = 6 1111 = 15
MFN Bits 9–0	Multiplication Factor (Numerator) —Defines the numerator of the BRM value for the MF. When a new value is written into the MFN bits, the PLL loses its lock; after a time delay, the PLL re-locks.	0x000 = 0 0x001 = 1 0x3FE = 1022 0x3FF = Reserved

MC9328MXS Reference Manual, Rev. 1

12.5.3.2 MCU PLL and System Clock Control Register 1

The MCU PLL and System Clock Control Register 1 (MPCTL1) is a 32-bit register that directs the operation of the on-chip MCU PLL. The MPCTL1 control bits are described in Table 12-10.

MPCT	ΓL1		MCU PLL and System Clock Control Register 1												Addr 0x0021B008			
BIT	31	30 29	28	27	26	25	24	23	22	21	20	19	18	17	16			
TYPE	r	r r	r	r	r	r	r	r	r	r	r	r	r	r	r			
RESET	0	0 0	0	0	0	0	0	0	0	0	0	0	0	0	0			
TILOLI								0	x0000									
BIT	15	14 13	12	11	10	9	8	7	6	5	4	3	2	1	0			
									BRMO									
TYPE	r	r r	r	r	r	r	r	r	rw	r	r	r	r	r	r			
RESET	0	0 0	0	0	0	0	0	0	0	0	0	0	0	0	0			
NESEI								0	x0000									

Table 12-10. MCU PLL and System Clock Control Register 1 Description

Name	Description	Settings
Reserved Bits 31–7	Reserved—These bits are reserved and should read 0.	
BRMO Bit 6	BRM Order —Controls the BRM order. The first order BRM is used if a MF fractional part is both more than 1/10 and less than 9/10. In other cases, the second order BRM is used. The BRMO bit is cleared by a hardware reset. A delay of reference cycles is required between two write accesses to BRMO.	0 = BRM contains first order 1 = BRM contains second order
Reserved Bits 5–0	Reserved—These bits are reserved and should read 0.	

12.5.4 Generation of 48 MHz Clocks

The USB interface clock (CLK48M) is used internally by the USB module. Its frequency is set to 48 MHz using the PLL control registers assuming a default input clock frequency 16.384 MHz. This input clock frequency assumes a 32 kHz crystal input.

The predivider/multiplier output depends on the input clock frequency as shown in Table 12-11.

Table 12-11. System PLL Multiplier Factor

Premultiplier Input Crystal Frequency	PLL Input Frequency (Premultiplier Output)	PD	MFD	MFI	MFN	PLL Output Frequency	USBDIV	USB Clock Frequency		
32 kHz	16.384 MHz	1	63	5	55	96 MHz	2	48 MHz		
The default setting exception is USB_DIV. The user must program this to 001.										

12.5.4.1 System PLL Control Register 0

The System PLL Control Register 0 (SPCTL0) is a 32-bit register that controls the operation of the System PLL. The SPCTL0 control bits are described in the following sections. A delay of 30 System PLLCLK cycles is required between two write accesses to SPCTL0 register. The following is a procedure for changing the System PLL settings:

- 1. Program the desired values of PD, MFD, MFI, and MFN into the SPCTL0.
- 2. Set the SPLL_RESTART bit in the CSCR (it will self-clear).
- 3. New PLL settings will take place.

SPCT	L0		System PLL Control Register 0									0x0021B00C				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
				Р	D						M	IFD				
TYPE	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	1	0	0	0	0	1	1	1	1	1	1
NESET								0x04	3F							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
				M	IFI						M	IFN				
TYPE	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	1	0	1	0	0	0	0	1	1	0	1	1	1
NESEI								0x14	37							

A -1 -1-

Table 12-12. System PLL Control Register 0 Description

Name	Description	Settings
Reserved Bits 31–30	Reserved—These bits are reserved and should read 0.	
PD Bits 29–26	Predivider Factor —Defines the predivider factor (PD) that is applied to the PLL input frequency. PD is an integer between 0 and 15 (inclusive). The System PLL oscillates at a frequency determined by Equation 12-1. The PD is chosen to ensure that the resulting VCO output frequency remains within the specified range. When a new value is written into the PD bits, the PLL loses its lock: after a time delay, the PLL re-locks.	0000 = 0 0001 = 1 1111 = 15

MC9328MXS Reference Manual, Rev. 1

12-12 Freescale Semiconductor

Table 12-12. System PLL Control Register 0 Description (continued)

Name	Description	Settings
MFD Bits 25–16	Multiplication Factor (Denominator Part) —Defines the denominator part of the BRM value for the MF. When a new value is written into the MFD9–MFD0 bits, the PLL loses its lock: after a time delay, the PLL re-locks.	0x000 = Reserved 0x001 = 1 0x3FF = 1023
Reserved Bits 15–14	Reserved—These bits are reserved and should read 0.	
MFI Bits 13–10	Multiplication Factor (Integer Part) —Defines the integer part of the BRM value for the MF. The MFI is decoded so that MFI < 5 results in MFI = 5. The System PLL oscillates at a frequency determined by Equation 12-1. Where PD is the division factor of the predivider, MFI is the integer part of the total MF, MFN is the numerator of the fractional part of the MF, and MFD is the denominator part of the MF. The MF is chosen to ensure that the resulting VCO output frequency remains within the specified range. When a new value is written into the MFI bits, the PLL loses its lock; after a time delay, the PLL re-locks.	0000-0101 = 5 0110 = 6 1111 = 15
MFN Bits 9–0	Multiplication Factor (Numerator Part) —Defines the numerator part of the BRM value for the MF. When a new value is written into the MFN bits, the PLL loses its lock; after a time delay, the PLL re-locks.	0x000 = 0 0x001 = 1 0x3FE = 1022 0x3FF = Reserved

12.5.4.2 System PLL Control Register 1

The System PLL control register 1 (SPCTL1) is a 32-bit read/write register in the MCU memory map that directs the operation of the System PLL. The SPCTL1 control bits are described in this section.

SPCTL	1		System PLL Control Register 1										0x00	Addr 21B010		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET										0x0000						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	LF									BRMO						
TYPE	rw	r	r	r	r	r	r	r	r	rw	r	r	r	r	r	r
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET										0x0000						

Freescale Semiconductor 12-13

Table 12-13. System PLL Control Register 1 Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
LF Bit 15	Lock Flag—Indicates whether the System PLL is locked. When set, the System PLL clock output is valid. When cleared, the System PLL clock output remains at logic high.	0 = System PLL is not locked 1 = System PLL is locked
Reserved Bits 14–7	Reserved—These bits are reserved and should read 0.	
BRMO Bit 6	BRM Order Bit —Controls the BRM order. The first order BRM is used if a MF fractional part is both more than 1/10 and less than 9/10. In other cases, the second order BRM is used. The BRMO bit is cleared by a hardware reset.	0 = BRM has first order 1 = BRM has second order
Reserved Bits 5–0	Reserved—These bits are reserved and should read 0.	

12-14 Freescale Semiconductor

Chapter 13 DMA Controller

The Direct Memory Access Controller (DMAC) of the MC9328MXS provides eleven channels supporting linear memory, 2D memory, FIFO and end-of-burst enable FIFO transfers to provide support for a wide variety of DMA operations.

13.1 Features

The MC9328MXS DMAC features are:

- Eleven channels support linear memory, FIFO, and end-of-burst enable FIFO for both source and destination.
- Any one of the eleven channels can be configured to support 2D memory.
- Increment, decrement, and no-change support for source and destination addresses.
- Each channel is configurable to response to any of the 32 DMA request signals.
- Supports 8, 16, or 32-bit FIFO and memory port size data transfers.
- Supports both big and little endian.
- DMA is configurable to a maximum of 16 words, 32 half-words, or 64 bytes for each channel.
- Bus utilization control for the channel that is not trigger by a DMA request.
- Burst time-out errors terminate the DMA cycle when the burst cannot be completed within a programmed time count.
- Buffer overflow errors terminate the DMA cycle when the internal buffer receives more than 64 bytes of data. This is useful when the source mode is set to end-of-burst enable FIFO, in case the DMA_EOBI signal is not detected after 64 bytes of data are received.
- Transfer errors terminate the DMA cycle when a transfer error is detected during a DMA burst.
- DMA request time-out errors are generated for channels that are triggered by DMA requests to interrupt the CPU when a DMA request is not asserted after a programmed time count.
- Interrupts provided to the interrupt controller (and subsequently to the core) on bulk data transfer complete or transfer error
- Each peripheral supporting DMA transfer generates a DMA_REQ signal to the DMA controller, assuming that each FIFO has a unique system address and generates a dedicated DMA_REQ signal to the DMA controller. For example, an USB device with 8 end-points has 8 DMA request signals to the DMA if they all support DMA transfer.
- The DMA controller provides an acknowledge signal to the peripheral after a DMA burst is complete. This signal is sometimes used by the peripheral to clear some status bits.
- Repeat data transfer function supports automatic USB host–USB device bulk/iso data stream transfer.

Freescale Semiconductor

13.2 Block Diagram

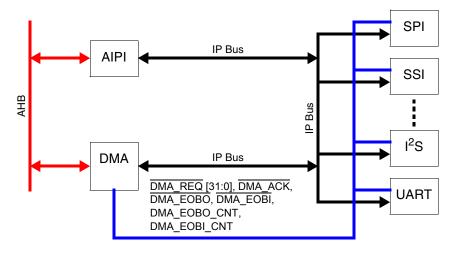


Figure 13-1. DMAC in MC9328MXS

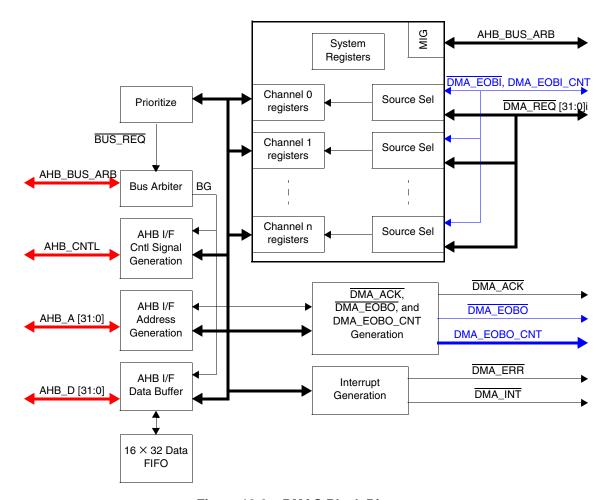


Figure 13-2. DMAC Block Diagram

MC9328MXS Reference Manual, Rev. 1

13-2 Freescale Semiconductor

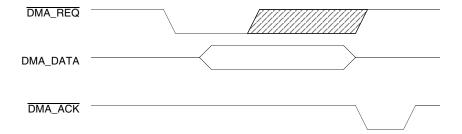


Figure 13-3. DMA Request and Acknowledge Timing Diagram

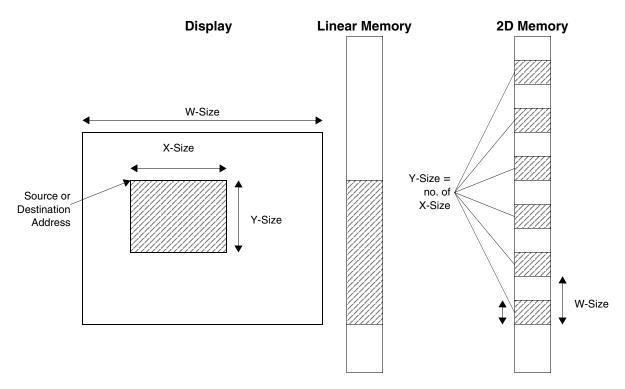


Figure 13-4. 2D Memory Diagram

13.3 Signal Description

The MC9328MXS signal descriptions are identified in Table 13-1.

Table 13-1. Signal Description

Signal	Description
AHB_xxx	AHB bus signals
IP Bus	IP bus signals
DMA_REQ	DMA request signal generated by peripherals. One FIFO should generate one DMA_REQ signal. This signal must be negated by the peripheral automatically before the rising edge of DMA_ACK. It is usually negated when the FIFO is read.

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor 13-3

Table 13-1. Signal Description (continued)

Signal	Description
DMA_ACK	DMA request acknowledge generated by the DMA controller to signal the end of a DMA burst.
DMA_EOBI	This signal is asserted by the USB device when the last data of the burst is read from the FIFO.
DMA_EOBI_CNT	This signal is asserted by the USB device when the last data of the burst is read from the FIFO to indicate the number of valid bytes.
DMA_EOBO	This signal is asserted by the DMA controller when the last data of the burst is written to the FIFO.
DMA_EOBO_CNT	This signal is asserted by the DMA controller when the last data of the burst is written to the FIFO to indicate the number of valid bytes.
DMA_ERR	This signal is asserted by DMA controller when any DMA error is detected.
DMA_INT	This signal is asserted by DMA controller when data transfer is complete—that is, the data count reaches the desired level.

13.3.1 Big Endian and Little Endian

The BIG_ENDIAN signal determines the MC9328MXS memory endian configuration. BIG_ENDIAN is a static pin to the processor and if it is driven logic-high at power on reset the processor's memory system is configured as big endian. If it is driven logic-low at power on reset the processor's memory system is configured as little endian. The pin should not be changed after power on reset (POR) deasserts or during operation.

13.4 Programming Model

The DMA module includes 107 user-accessible 32-bit registers. These registers are divided into three groups by function:

- General registers for all functional blocks (see Section 13.4.1, on page 13-8)
- 2D memory registers to control the display width and the x and y of the window (see Section 13.4.2, on page 13-16)
- Channel registers to control and configure channels 0–10 (see Section 13.4.3, on page 13-18)

Table 13-2 summarizes these registers and their addresses.

Table 13-2. DMA Module Register Memory Map

Description	Name	Address
General Registers	3	
DMA Control Register	DCR	0x00209000
DMA Interrupt Status Register	DISR	0x00209004
DMA Interrupt Mask Register	DIMR	0x00209008

MC9328MXS Reference Manual, Rev. 1

13-4 Freescale Semiconductor

Table 13-2. DMA Module Register Memory Map (continued)

Description	Name	Address
DMA Burst Time-Out Status Register	DBTOSR	0x0020900C
DMA Request Time-Out Status Register	DRTOSR	0x00209010
DMA Transfer Error Status Register	DSESR	0x00209014
DMA Buffer Overflow Status Register	DBOSR	0x00209018
DMA Burst Time-Out Control Register	DBTOCR	0x0020901C
2D Memory Registe	ers	
W-Size Register A	WSRA	0x00209040
X-Size Register A	XSRA	0x00209044
Y-Size Register A	YSRA	0x00209048
W-Size Register B	WSRB	0x0020904C
X-Size Register B	XSRB	0x00209050
Y-Size Register B	YSRB	0x00209054
Channel Registers	S	
Channel 0 Source Address Register Channel 0 Destination Address Register Channel 0 Count Register Channel 0 Control Register Channel 0 Request Source Select Register Channel 0 Burst Length Register Channel 0 Request Time-Out Register Channel 0 Bus Utilization Control Register	SAR0 DAR0 CNTR0 CCR0 RSSR0 BLR0 RTOR0 BUCR0	0x00209080 0x00209084 0x00209088 0x0020908C 0x00209090 0x00209094 0x00209098
Channel 1 Source Address Register Channel 1 Destination Address Register Channel 1 Count Register Channel 1 Control Register Channel 1 Request Source Select Register Channel 1 Burst Length Register Channel 1 Request Time-Out Register Channel 1 Bus Utilization Control Register	SAR1 DAR1 CNTR1 CCR1 RSSR1 BLR1 RTOR1 BUCR1	0x002090C0 0x002090C4 0x002090C8 0x002090CC 0x002090D0 0x002090D4 0x002090D8 0x002090D8
Channel 2 Source Address Register Channel 2 Destination Address Register Channel 2 Count Register Channel 2 Control Register Channel 2 Request Source Select Register Channel 2 Burst Length Register Channel 2 Request Time-Out Register Channel 2 Bus Utilization Control Register	SAR2 DAR2 CNTR2 CCR2 RSSR2 BLR2 RTOR2 BUCR2	0x00209100 0x00209104 0x00209108 0x0020910C 0x00209110 0x00209114 0x00209118

Freescale Semiconductor 13-5

Table 13-2. DMA Module Register Memory Map (continued)

Description	Name	Address
Channel 3 Source Address Register Channel 3 Destination Address Register Channel 3 Count Register Channel 3 Control Register Channel 3 Request Source Select Register Channel 3 Burst Length Register Channel 3 Request Time-Out Register Channel 3 Bus Utilization Control Register	SAR3 DAR3 CNTR3 CCR3 RSSR3 BLR3 RTOR3 BUCR3	0x00209140 0x00209144 0x00209148 0x0020914C 0x00209150 0x00209154 0x00209158
Channel 4 Source Address Register Channel 4 Destination Address Register Channel 4 Count Register Channel 4 Control Register Channel 4 Request Source Select Register Channel 4 Burst Length Register Channel 4 Request Time-Out Register Channel 4 Bus Utilization Control Register	SAR4 DAR4 CNTR4 CCR4 RSSR4 BLR4 RTOR4 BUCR4	0x00209180 0x00209184 0x00209188 0x0020918C 0x00209190 0x00209194 0x00209198
Channel 5 Source Address Register Channel 5 Destination Address Register Channel 5 Count Register Channel 5 Control Register Channel 5 Request Source Select Register Channel 5 Burst Length Register Channel 5 Request Time-Out Register Channel 5 Bus Utilization Control Register	SAR5 DAR5 CNTR5 CCR5 RSSR5 BLR5 RTOR5 BUCR5	0x002091C0 0x002091C4 0x002091C8 0x002091CC 0x002091D0 0x002091D4 0x002091D8
Channel 6 Source Address Register Channel 6 Destination Address Register Channel 6 Count Register Channel 6 Control Register Channel 6 Request Source Select Register Channel 6 Burst Length Register Channel 6 Request Time-Out Register Channel 6 Bus Utilization Control Register	SAR6 DAR6 CNTR6 CCR6 RSSR6 BLR6 RTOR6 BUCR6	0x00209200 0x00209204 0x00209208 0x0020920C 0x00209210 0x00209214 0x00209218 0x00209218
Channel 7 Source Address Register Channel 7 Destination Address Register Channel 7 Count Register Channel 7 Control Register Channel 7 Request Source Select Register Channel 7 Burst Length Register Channel 7 Request Time-Out Register Channel 7 Bus Utilization Control Register	SAR7 DAR7 CNTR7 CCR7 RSSR7 BLR7 RTOR7 BUCR7	0x00209240 0x00209244 0x00209248 0x0020924C 0x00209250 0x00209254 0x00209258 0x00209258
Channel 8 Source Address Register Channel 8 Destination Address Register Channel 8 Count Register Channel 8 Control Register Channel 8 Request Source Select Register Channel 8 Burst Length Register Channel 8 Request Time-Out Register Channel 8 Bus Utilization Control Register	SAR8 DAR8 CNTR8 CCR8 RSSR8 BLR8 RTOR8 BUCR8	0x00209280 0x00209284 0x00209288 0x0020928C 0x00209290 0x00209294 0x00209298

MC9328MXS Reference Manual, Rev. 1

13-6 Freescale Semiconductor

Table 13-2. DMA Module Register Memory Map (continued)

Description	Name	Address
Channel 9 Source Address Register Channel 9 Destination Address Register Channel 9 Count Register Channel 9 Control Register Channel 9 Request Source Select Register Channel 9 Burst Length Register Channel 9 Request Time-Out Register Channel 9 Bus Utilization Control Register	SAR9 DAR9 CNTR9 CCR9 RSSR9 BLR9 RTOR9 BUCR9	0x002092C0 0x002092C4 0x002092C8 0x002092CC 0x002092D0 0x002092D4 0x002092D8 0x002092D8
Channel 10 Source Address Register Channel 10 Destination Address Register Channel 10 Count Register Channel 10 Control Register Channel 10 Request Source Select Register Channel 10 Burst Length Register Channel 10 Request Time-Out Register Channel 10 Bus Utilization Control Register	SAR10 DAR10 CNTR10 CCR10 RSSR10 BLR10 RTOR10 BUCR10	0x00209300 0x00209304 0x00209308 0x0020930C 0x00209310 0x00209314 0x00209318

13.4.1 General Registers

This section describes the function of the general registers.

13.4.1.1 DMA Control Register

The DMA Control Register (DCR) controls the input of the system clock and the resetting of the DMA module.

DCR		DMA Control Register														Addr 9000
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
															DRST	DEN
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	W	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							

Table 13-3. DMA Control Register Description

Name	Description	Settings
Reserved Bits 31–2	Reserved—These bits are reserved and should read 0.	
DRST Bit 1	DMA Reset —Generates a 3-cycle reset pulse that resets the entire DMA module, bringing the module to its reset condition. DRST always reads 0.	0 = No effect 1 = Generates a 3-cycle reset pulse
DEN Bit 0	DMA Enable —Enables/Disables the system clock to the DMA module.	0 = DMA disable 1 = DMA enable

13-8 Freescale Semiconductor

13.4.1.2 DMA Interrupt Status Register

The DMA Interrupt Status Register (DISR) contains the interrupt status of each channel in the DMAC. The status bit is set whenever the corresponding DMA channel data transfer is complete. When any bit in the DMA Interrupt Status Register (DISR) is set and the corresponding bit in the interrupt mask register is cleared, a DMA_INT is asserted to the interrupt controller (AITC). When an interrupt occurs, the interrupt service routine must check the DISR to determine the interrupting channel. Each bit is cleared by writing 1 to it. The DISR bit cannot be cleared when the DMA channel is disabled.

DISR		DMA Interrupt Status Register														Addr 0x00209004					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16					
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r					
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0					
NLOLI								0x00	00												
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0					
						CH10	CH9	CH8	CH7	CH6	CH5	CH4	CH3	CH2	CH1	CH0					
TYPE	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw					
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0					
NESEI								0x00	00												

Table 13-4. DMA Interrupt Status Register Description

Name	Description	Settings
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.	
CH10–CH0 Bits 10–0	Channel 10 to 0 Interrupt Status—Indicates the interrupt status for each DMA channel.	0 = No interrupt 1 = Interrupt is pending

13.4.1.3 DMA Interrupt Mask Register

The DMA Interrupt Mask Register (DIMR) masks both normal interrupts and error interrupts generated by the corresponding channel. There is one control bit for each channel. When an interrupt is masked, the interrupt controller does not generate an interrupt request to the AITC, however the status of the interrupt can be observed from the interrupt status register, burst time-out status register, request time-out status register, or the transfer error status register. At reset, all the interrupts are masked and all the bits in this register are set to 1.

DIMR					D	MA In	terru	pt Ma	ısk R	egist	er			Addr 0x00209008					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
HESET								0x00	00										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
						CH10	CH9	CH8	CH7	CH6	CH5	CH4	СНЗ	CH2	CH1	CH0			
TYPE	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw			
DECET	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1			
RESET								0x07	FF										

Table 13-5. DMA Interrupt Mask Register Description

Name	Description	Settings
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.	
CH10–CH0 Bits 10–0	Channel 10 to 0—Controls the interrupts for each DMA channel.	0 = Enables interrupts 1 = Disables interrupts

13.4.1.4 DMA Burst Time-Out Status Register

A burst time-out is set when a DMA burst cannot be completed within the number of clock cycles specified in the DMA Burst Time-Out Control Register (DBTOCR) of the channel. When any bit is set in this register and the corresponding bit in the interrupt mask register is cleared, a $\overline{DMA_ERR}$ is asserted to the interrupt controller (AITC). The DMA burst time-out status register (DBTOSR) indicates the channel, if any, that is currently being serviced and whether a burst time-out was detected. Each bit is cleared by writing 1 to it.

DBTO	SR			D	MA	Burst	Time	-Out	Statu	ıs Re	egiste	er		Addr 0x0020900C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
						CH10	CH9	CH8	CH7	CH6	CH5	CH4	СНЗ	CH2	CH1	CH0	
TYPE	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESEI								0x00	00								

Table 13-6. DMA Burst Time-Out Status Register Description

Name	Description	Settings
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.	
CH10–CH0 Bits 10–0	Channel 10 to 0—Indicates the burst time-out status of each DMA channel.	0 = No burst time-out 1 = Burst time-out

13.4.1.5 DMA Request Time-Out Status Register

A DMA request time-out is set when there is no DMA request from the selected $\overline{DMA_REQ}$ source within the pre-assigned number of clock cycles specified in the request time-out control register (DBTOCR) for the channel. When any bit is set in this register and the corresponding bit in the interrupt mask register is cleared, a $\overline{DMA_ERR}$ is asserted to the AITC. The DMA Request Time-Out Status Register (DRTOSR) indicates the enabled channel, if any, that detected a DMA request time-out. Clear each bit by writing 1 to it.

DRTO	SR			DM	IA R	eques	st Tim	ne-Ou	ut Sta	ıtus F	Regis	ter		0x	Addr 0x00209010			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESET								0x00	000									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
						CH10	CH9	CH8	CH7	CH6	CH5	CH4	СНЗ	CH2	CH1	CH0		
TYPE	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									

Table 13-7. DMA Request Time-Out Status Register Description

Name	Description	Settings
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.	
CH10–CH0 Bits 10–0	Channel 10 to 0—Indicates the request time-out status of each DMA channel.	0 = No DMA request time-out 1 = DMA request time-out

13.4.1.6 DMA Transfer Error Status Register

A DMA transfer error is set when the AHB bus signal HRESP [1:0] = ERROR is asserted during a DMA transfer. When any bit is set in this register and the corresponding bit in the interrupt mask register is cleared, a DMA_ERR is asserted to the AITC. The DMA Transfer Error Status Register (DSESR) indicates the channel, if any, detected a transfer error during a DMA burst. Clear each bit by writing 1 to it.

DSES	R			[OMA	Trans	sfer E	Frror S	Statu	s Re	giste	r		Addr 0x00209014			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
						CH10	CH9	CH8	CH7	CH6	CH5	CH4	СНЗ	CH2	CH1	CH0	
TYPE	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
DEOET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET								0x00	00								

Table 13-8. DMA Transfer Error Status Register Description

Name	Description	Settings
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.	
CH10–CH0 Bits 10–0	Channel 10 to 0—Indicates the DMA transfer error status of each DMA channel.	0 = No transfer error 1 = Transfer error

13.4.1.7 DMA Buffer Overflow Status Register

The DMA Buffer Overflow Status Register (DBOSR) indicates whether the internal buffer of the DMA Controller overflowed during a data transfer. The channel is not enabled until the corresponding bit is cleared. When any bit is set in this register and the corresponding bit in the interrupt mask register is cleared, a DMA_ERR is asserted to the AITC.

DBOSR DMA B					Buffer	Buffer Overflow Status Register								Addr 0x00209018		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						CH10	CH9	CH8	CH7	CH6	CH5	CH4	СНЗ	CH2	CH1	CH0
TYPE	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET	0x0000															

Table 13-9. DMA Buffer Overflow Status Register Description

Name	Description	Settings					
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.						
CH10–CH0 Bits 10–0	Channel 10 to 0—Indicates the buffer overflow error status of each DMA channel.	0 = No buffer overflow occurred 1 = Buffer overflow occurred					

13.4.1.8 DMA Burst Time-Out Control Register

This register sets the time-out for DMA transfer cycle for all DMA channels, so that the DMA controller can release the AHB and IP buses on error. An internal counter starts counting when a DMA burst cycle starts, and resets to zero when the burst is completed. When the counter reaches the count value set in the register, it asserts an interrupt and sets the corresponding error bit in the DMA burst time-out error register. The system clock is used as input clock to the counter.

DBTOCR DMA Burst Time-Out Control Register													0x0		Addr 0020901C		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESEI	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	EN								CNT								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESEI								0x00	000								

Table 13-10. DMA Burst Time-Out Control Register Description

Name	Description Settings										
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.										
EN Bit 15	Enable—Enables/Disables the burst time-out.	0 = Disables burst time-out 1 = Enables burst time-out									
CNT Bits 14–0	Count—Contains the time-out count down value.										

13.4.2 2D Memory Registers (A and B)

The two sets of 2D memory registers allow any one channel of the eleven channels to select any register set to define the respective 2D memory size.

13.4.2.1 W-Size Registers

The W-Size registers (WSRA and WSRB) define the number of bytes that make up the display width. This allows the DMA controller to calculate the next starting address of another row by adding the source/destination address to the contents of the W-Size register.

WSRA WSRB							/-Size /-Size	•							0020	Addr 9040 904C
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								WS	3							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw						
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ILOLI								0x00	00							

Table 13-11. W-Size Registers Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
WS Bits 15–0	W-Size—Contains the number of bytes that make up the display width.

13-16 Freescale Semiconductor

13.4.2.2 X-Size Registers

The X-Size registers (XSRA and XSRB) contain the number of bytes per row of the window. The value of this register is used by the DMA controller to determine when to jump to the next row.

XSRA XSRB							-Size -Size	_								Addr 9044 9050
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								XS	;							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw						
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESEI								0x00	00							

Table 13-12. X-Size Registers Description

Name	Description Settings									
Reserved Bits 31–16 Reserved—These bits are reserved and should read 0.										
XS Bits 15–0	X-Size—Contains the number of bytes per row that define the X-Size of the 2D me	emory.								

13.4.2.3 Y-Size Registers

The Y-Size registers (YSRA and YSRB) contain the number of rows in the 2D memory window. This setting is used by the DMA controller to calculate the total size of the transfer.

YSRA YSRB							-Size -Size	_							0020	Addr 9048 9054
ВІТ	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								YS	3							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw						
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HLOEI								0x00	00							

Table 13-13. Y-Size Registers Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
YS Bits 15–0	Y-Size—Contains the number of rows that make up the 2D memory window.

13.4.3 Channel Registers

Channels 0 to 10 support linear memory, 2D memory, FIFO, and end-of-burst enable FIFO transfer. Only one enabled channel may be configured for 2D memory at any time.

The interrupt request DMA_REQ [31:0] does not have a priority assigned. The only priority available is the priority that is defined for each channel: channel 10 has the highest priority and channel 0 has the lowest priority. Channel priority is implemented only when more than one request occurs at the same time, otherwise, channels are serviced on a first come, first serve basis.

Each channel generates a normal interrupt to the interrupt handler when the data count reaches the selected value and the channel source mode is not set to end-of-burst enable FIFO.

Each channel generates an error interrupt to the interrupt handler when the following conditions exist:

- A DMA request time-out is true
- A DMA burst time-out is true during a burst cycle
- The internal buffer overflows during a burst cycle
- A transfer error acknowledge is asserted during a burst cycle

MC9328MXS Reference Manual, Rev. 1

13-18 Freescale Semiconductor

13.4.3.1 Channel Source Address Register

Each of the channel source address registers contain the source address for the DMA cycle. The value of the register remains unchanged throughout the DMA process. If the memory direction bit (MDIR) in the channel control register (CCR) is clear (indicating a memory address increment), then the channel source address register contains the starting address of the memory block. If MDIR is set (indicating a memory address decrement), then the channel source address register contains the ending address of the memory block.

															1	Addr
SAR0				(Chan	nel 0	Sour	ce Ad	ddres	s Re	giste	r		0x	0020	9080
SAR1				(Chan	nel 1	Sour	ce A	ddres	s Re	giste	r		0x	00209	90C0
SAR2				(Chan	nel 2	Sour	ce A	ddres	s Re	giste	r		0x	0020	9100
SAR3				(Chan	nel 3	Sour	ce A	ddres	s Re	giste	r		0x	0020	9140
SAR4				(Chan	nel 4	Sour	ce A	ddres	s Re	giste	r		0x	0020	9180
SAR5				(Chan	nel 5	Sour	ce A	ddres	s Re	giste	r		0x	00209	91C0
SAR6				(Chan	nel 6	Sour	ce A	ddres	s Re	giste	r		0x	0020	9200
SAR7				(Chan	nel 7	Sour	ce A	ddres	s Re	giste	r		0x	0020	9240
SAR8				(Chan	nel 8	Sour	ce A	ddres	s Re	giste	r		0x	0020	9280
SAR9				(Chan	nel 9	Sour	ce A	ddres	s Re	giste	r		0x	00209	92C0
SAR10 Channel 10 Source Address Register 0x00209300											9300					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								SA [31	:16]							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							SA [1	5:2]							SA [1]	SA [0]
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
								0x00	00							

Table 13-14. Channel Source Address Register Description

Name	Description
SA [31:2] Bits 31–2	Source Address—Contains the source address from where data is read during a DMA transfer.
SA [1], SA [0] Bits 1–0	Source Address [1] and Source Address [0]—To ensure that all addresses are word-aligned these bits are set internally to 0. These bits will be read/write as any value if and only if running in big endian and source mode set to FIFO. This is to allow FIFO to use offset address during big endian mode.

13.4.3.2 Destination Address Registers

Each of the destination address registers (DARx) contain the destination address for a DMA cycle. The value of the register remains unchanged throughout the DMA process. If the memory direction bit (MDIR) in the channel control register (CCR) is clear (indicating a memory address increment), then the destination address register contains the starting address of the memory block. If MDIR is set (indicating a memory address decrement), then the destination address register contains the ending address of the memory block.

																Addr
DAR0			(Chan	nel 0	Dest	inatio	n Ad	dres	s Re	giste	r		0x	0020	9084
DAR1			(Chan	nel 1	Dest	inatio	n Ad	dres	s Re	giste	r		0x	00209	90C4
DAR2			(Chan	nel 2	Dest	inatio	n Ad	dres	s Re	giste	r		0x	0020	9104
DAR3			(Chan	nel 3	Dest	inatio	n Ad	dres	s Re	giste	r		0x	0020	9144
DAR4			(Chan	nel 4	Dest	inatio	n Ad	dres	s Re	giste	r		0x	0020	9184
DAR5			(Chan	nel 5	Dest	inatio	n Ad	dres	s Re	giste	r		0x	00209	91C4
DAR6			(Chan	nel 6	Dest	inatio	n Ad	dres	s Re	giste	r		0x	0020	9204
DAR7			(Chan	nel 7	Dest	inatio	n Ad	dres	s Re	giste	r		0x	002091C4 00209204 00209244 002092C4 00209304	
DAR8			(Chan	nel 8	Dest	inatio	n Ad	dres	s Re	giste	r		0x	0020	9284
DAR9 Channel 9 Destination Address Register DAR10 Channel 10 Destination Address Register												0x	00209	92C4		
3											9304					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								DA [31	1:16]							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							DA [1	5:2]							DA [1]	DA [0]
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
								0x00	00							

Table 13-15. Channel Destination Address Registers Description

Name	Description
DA [31:2] Bits 31–2	Destination Address—Contains the destination address to which data is written to during a DMA transfer.
DA [1], DA [0] Bits 1–0	Destination Address [1] and Destination Address [0] —To ensure that all addresses are word-aligned, these bits are set internally to 0.

13-20 Freescale Semiconductor

13.4.3.3 Channel Count Registers

Each of the channel count registers (CNTRx) contain the number of bytes of data to be transferred. There is an internal counter that counts up (number of bytes—4 for word, 2 for halfword and 1 for byte) for every DMA transfer. The internal counter is compared with the register after every transfer. When the counter value matches with the register value, the channel is disabled until the CEN bit is cleared and reset, or the RPT bit in the associated channel control register is set to 1. The internal counter is reset to 0 when the channel is enabled again.

The length of the last DMA burst can be shorter than the regular burst length specified in the burst length register. However, when data is transferred out from an I/O FIFO and the last burst is less than BL, the I/O device must generate a DMA request for the last transfer. When data is transferred to an I/O FIFO and the last burst is less than BL, only the remaining number of data is transferred.

When the source mode is set to end-of-burst enable FIFO, this register becomes a read only register and the value of the register is the number of bytes being transferred.

																Addr	
CNTR	0				(Chani	nel 0	Cour	nt Re	giste	r			0x	0020	9088	
CNTR	1				(Chani	nel 1	Cour	nt Re	giste	r			0x0	0209	90C8	
CNTR	2				(Chani	nel 2	Cour	nt Re	giste	r			0x	0020	9108	
CNTR	3				(Chani	nel 3	Cour	nt Re	giste	r			0x00209148			
CNTR	4				(Chani	nel 4	Cour	nt Re	giste	r			0x00209188			
CNTR5 Channel 5 Count Register														0x002091C8			
CNTR6 Channel 6 Count Register														0x	0020	9208	
G														0x	0020	9248	
CNTR8 Channel 8 Count Register 0x002092													9288				
CNTR9 Channel 9 Count Register 0x0020920												92C8					
CNTR10 Channel 10 Count Register 0x00209												9308					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
		CNT															
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
								0x00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								CN									
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET								0x00	00								

Table 13-16. Channel Count Registers Description

Name	Description
Reserved Bits 31–24	Reserved—These bits are reserved and should read 0.
CNT Bits 23–0	Count—Contains the number of bytes of data to be transferred during a DMA cycle.

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor 13-21

13.4.3.4 Channel Control Registers

Each of the channel control registers (CCRx) controls and displays the status of a DMA channel operation.

NOTE:

While any one of the eleven channels may be configured for 2D memory, only one enabled channel may be configured for 2D memory at any time, This constraint does not apply to configuring the DMA channels for linear memory, FIFO, and end-of-burst enable FIFO.

								4	Addr							
CCR)			(Chann	el 0 C	ontro	l Reg	ister					0x0	0209	08C
CCR1				(Chann	el 1 C	ontro	l Reg	ister				C)x00	209	OCC
CCR2	2			(Chann	el 2 C	ontro	l Reg	ister				(0x0	0209	10C
CCR3 Channel 3 Control Register 0x00														0209	14C	
CCR4 Channel 4 Control Register 0x002													0209	18C		
CCR5 Channel 5 Control Register 0x00209													1CC			
CCR6 Channel 6 Control Register 0x00209													20C			
CCR7 Channel 7 Control Register 0x0020924														24C		
CCR8 Channel 8 Control Register 0x0020928C														28C		
CCR9 Channel 9 Control Register 0x002092CC												2CC				
CCR1					Channe			_								30C
ВІТ	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
İ	-			-												
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET	Ū	Ü	· ·	· ·	Ū	· ·		x0000		· ·	Ū	ŭ	·	Ū	Ū	Ū
							·	X0000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			DM	OD	SM	OD	MDIR	MSEL	DS	SIZ	SS	SIZ	REN	RPT	FRC	CEN
TYPE	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	W	rw
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET							0	x0000								

Table 13-17. Channel Control Registers Description

Name	Description	Settings
Reserved Bits 31–14	Reserved—These bits are reserved and should read 0.	
DMOD Bits 13–12	Destination Mode —Selects the destination transfer mode.	00 = Linear memory 01 = 2D memory 10 = FIFO 11 = End-of-burst enable FIFO

MC9328MXS Reference Manual, Rev. 1

13-22 Freescale Semiconductor

Table 13-17. Channel Control Registers Description (continued)

Name	Description	Settings
SMOD Bits 11–10	Source Mode—Selects the source transfer mode.	00 = Linear memory 01 = 2D memory 10 = FIFO 11 = End-of-burst enable FIFO
MDIR Bit 9	Memory Direction—Selects the memory address direction.	0 = Memory address increment 1 = Memory address decrement
MSEL Bit 8	Memory Select —Selects the 2D memory register set when either source and/or destination is programmed to 2D memory mode.	0 = 2D memory register set A selected 1 = 2D memory register set B selected
DSIZ Bits 7–6	Destination Size —Selects the destination size of a data transfer. Note: DSIZ1:DSIZ0 always reads/writes 00 when destination mode is programmed as end-of-burst enable FIFO, because end-of-burst operation only works for 32-bit FIFO.	00 = 32-bit destination port 01 = 8-bit destination port 10 = 16-bit destination port 11 = Reserved
SSIZ Bits 5–4	Source Size—Selects the source size of data transfer. Note: SSIZ1:SSIZ0 always reads/writes 00 when destination mode is programmed as end-of-burst enable FIFO, because end of burst operation only works for 32-bit FIFO.	00 = 32-bit source port 01 = 8-bit source port 10 = 16-bit source port 11 = Reserved
REN Bit 3	Request Enable—Enables/Disables the DMA request signal. When REN is set, the DMA burst is initiated by the DMA_REQ signal from the I/O FIFO. When REN is cleared, DMA transfer is initiated by CEN.	0 = Disables the DMA request signal (when the peripheral asserts a DMA request, no DMA transfer is triggered); DMA transfer is initiated by CEN only 1 = Enables the DMA request signal (when the peripheral asserts a DMA request, a DMA transfer is triggered)
RPT Bit 2	Repeat—Enables/Disables the data transfer repeat function. When enabled and when the counter reaches the value set in Count Register, the Count Register is reset to its zero, an interrupt is asserted, and the corresponding channel bit in the Interrupt Mask Register is cleared. The address is reloaded from the source and destination address register for the next DMA burst. Data transfer is carried out continuously until the channel is disabled or it completes the last cycle after RPT is cleared. If enabling the repeat function, do not change source and destination addresses on the fly. If it is necessary to change source and destination addresses, do it after a complete DMA cycle finishes and then re-start the channel again. Note: To correctly terminate a repeat enabled channel[x], user is required to first set RSSR[x] to 0, then set CCR[x]-REN to 1, and finally CCR[x]-CEN to 0.	0 = Disables repeat function 1 = Enables repeat function
FRC Bit 1	Force a DMA Cycle—Forces a DMA cycle to occur. FRC always reads 0.	0 = No effect 1 = Force DMA cycle

Freescale Semiconductor 13-23

Table 13-17. Channel Control Registers Description (continued)

Name	Description	Settings
CEN Bit 0	DMA Channel Enable—Enables/Disables the DMA channel. Note:	0 = Disables the DMA channel 1 = Enables the DMA channel
	Program all of the channel settings before enabling the channel. To restart a channel, clear CEN, and then set CEN to 1.	

When the source mode is set to end-of-burst enable FIFO, the burst length is determined by the input signals DMA_EOBI and DMA_EOBI_CNT, and the DMA burst (from peripheral to memory) can be terminated only by disabling the channel (clearing the corresponding CEN bit in channel control register). The count register (CNTR0-CNTR10) becomes read-only and indicates the number of bytes being transferred. This setting is typically used when the channel is configured to transfer data from an endpoint FIFO of a USB device to an endpoint data packet buffer in system memory.

When the destination mode is set to end-of-burst enable FIFO, the channel operates the same as in normal FIFO mode, the only difference is that at the end of each burst, the DMA controller generates a DMA_EOBO and DMA_EOBO_CNT signal to the peripheral. This setting is typically used when the I/O channel is configured to transfer data from an endpoint data packet buffer in system memory to an endpoint FIFO of a USB device.

Table 13-18. DMA_EOBO_CNT and DMA_EOBI_CNT Settings

DMA_EOBI_CNT [1:0] or DMA_EOBO_CNT [1:0]	Number of Bytes Per Transfer
00	4
01	1
10	2
11	3

13-24 Freescale Semiconductor

13.4.3.5 Channel Request Source Select Registers

Each of the 32-bit channel request source select registers (RSSRx) selects one of the 32 DMA request signals (DMA REQ [31:0]) to initiate a DMA transfer for the corresponding channel.

															1	Addr	
RSSR	0		С	hann	el 0 F	Reque	est So	ource	Sele	ect R	egist	er		0x	0020	9090	
RSSR	1		С	hann	el 1 F	Reque	est So	ource	Sele	ect R	egist	er		0x002090D0			
RSSR	2		С	hann	el 2 F	Reque	est So	ource	Sele	ect R	egist	er		0x00209110			
RSSR	3		С	hann	el 3 F	Reque	est So	ource	Sele	ect R	egist	er		0x	0020	9150	
RSSR4 Channel 4 Request Source Select Register										er		0x	0020	9190			
RSSR5 Channel 5 Request Source Select R									egist	er		0x0	0209	91D0			
RSSR	6		С	hann	el 6 F	Reque	est So	ource	Sele	ect R	egist	er		0x	0020	9210	
RSSR6 Channel 6 Request Source Select Register RSSR7 Channel 7 Request Source Select Register												0x	0020	9250			
RSSR8 Channel 8 Request Source Select Register												0x	0020	9290			
RSSR	9		С	hann	el 9 F	Reque	est So	ource	Sele	ect R	egist	er		0x002092D0			
RSSR	10		Cł	nanne	el 10	Requ	est S	ource	e Sel	ect F	Regis	ter		0x	0020	9310	
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
TILOLI								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
														RSS			
TYPE	r	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
								0x00	00								

Table 13-19. Channel Request Source Select Registers Description

Name	Description	Settings
Reserved Bits 31–5	Reserved—These bits are reserved and should read 0.	
RSS Bits 4–0	Request Source Select—Selects one of the 32 DMA_REQ signals that initiates a DMA transfer cycle for the channel.	00000 = select <u>DMA_REQ</u> [0] 00001 = select <u>DMA_REQ</u> [1] 11111 = select <u>DMA_REQ</u> [31]

13.4.3.6 Channel Burst Length Registers

The Channel Burst Length registers (BLRx) control the burst length of a DMA cycle. For a FIFO channel setting, the burst length is normally assigned according to the FIFO size of the selected I/O device, or by the FIFO level at which its DMA REQ signal is asserted.

For example, when the UART RxD FIFO is 12×8 and it asserts $\overline{DMA_REQ}$ when it receives more than 8 bytes of data, BL is 8. When the memory port size also is 8-bit, the DMA burst is 8-byte reads followed by 8-byte writes.

When the memory port size is smaller than the I/O port size, the burst length of the byte writes is doubled. For example, the I/O port is 32-bit, the memory port is 16-bit, and the burst length is set to 32. In this configuration, the DMA performs 8 word burst reads and 16 halfword burst writes for I/O to memory transfer.

BLR0 BLR1 BLR2 BLR3 BLR4 BLR5 BLR6 BLR7 BLR8 BLR9 BLR10	0				Cha Cha Cha Cha Cha Cha Cha Cha	nnel nnel nnel nnel nnel nnel nnel	0 Bur 1 Bur 2 Bur 3 Bur 5 Bur 6 Bur 8 Bur 9 Bur 0 Bu	est Le	ngth ngth ngth ngth ngth ngth ngth ngth	Reg Reg Reg Reg Reg Reg Reg Reg	ister 0x002090D4 ister 0x00209114 ister 0x00209154 ister 0x00209194 ister 0x002091D4 ister 0x00209214 ister 0x00209254 ister 0x00209294 ister 0x002092D4					90D4 9114 9154 9194 91D4 9214 9254 9294
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE RESET	r O	r 0	r 0	r 0	r 0	r 0	r 0	r 0 0x00	r 0	r 0	r 0	r 0	r 0	r 0	r 0	r O
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2 BL	1	0
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0 0x00	0 00	0	0	0	0	0	0	0

Table 13-20. Channel Burst Length Registers Description

Name	Description	Settings
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.	
BL Bits 5–0	Burst Length—Contains the number of data bytes that are transferred in a DMA burst.	000000 = 64 bytes read follow 64 bytes write 000001 = 1byte read follow 1 byte write 000010 = 2 bytes read follow 2 bytes write 111111 = 63 bytes read follow 63 bytes write

MC9328MXS Reference Manual, Rev. 1

13-26 Freescale Semiconductor

13.4.3.7 Channel Request Time-Out Registers

The channel request time-out registers (RTOx) set the time-out for $\overline{DMA_REQ}$ from the selected request source of the channel, which detects any discontinuity of data transfer. The request time-out takes effect only when the corresponding request enable (REN) bit in the channel control register (CCR) is set. An internal counter starts counting when a DMA channel is enabled, the burst is completed, and the counter is reset to zero when a DMA request is detected. When the counter reaches the count value set in the register, it asserts an interrupt and sets its error bit in the DMA request time-out status register. The input clock of the counter is selectable from either the system clock (HCLK) or input crystal (CLK32K).

NOTE:

This register shares the same address as the bus utilization control register.

RTOR RTOR RTOR RTOR RTOR RTOR RTOR RTOR	1 2 3 4 5 6 7 8		Channel 0 Request Time-Out Register Channel 1 Request Time-Out Register Channel 2 Request Time-Out Register Channel 3 Request Time-Out Register Channel 4 Request Time-Out Register Channel 5 Request Time-Out Register Channel 6 Request Time-Out Register Channel 7 Request Time-Out Register Channel 8 Request Time-Out Register Channel 9 Request Time-Out Register Channel 10 Request Time-Out Register										0x0 0x0 0x0 0x0 0x0 0x0 0x0	0x00209098 0x002090D8 0x00209118 0x00209158 0x00209198 0x002091D8 0x00209218 0x00209258 0x00209298 0x002092D8 0x00209318		
BIT	31	30 29 28 27 26 25 24 23 22 21 20 19											19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	EN	CLK	PSC							CNT						
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0 0x00	0 00	0	0	0	0	0	0	0

Table 13-21. Channel Request Time-Out Registers Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
EN Bit 15	Enable—Enables/Disables the DMA request time-out.	0 = Disables DMA request time-out 1 = Enables DMA request time-out

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor 13-27

Table 13-21. Channel Request Time-Out Registers Description (continued)

Name	Description	Settings
CLK Bit 14	Clock Source—Selects the counter of input clock source.	0 = HCLK 1 = 32.768 kHz
PSC Bit 13	Prescaler Count—Sets the prescaler of the input clock.	0 = Divide by 1 1 = Divide by 256
CNT Bits 12–0	Request Time-Out Count—Contains the time-out count down val remains unchanged through out the DMA process.	ue for the internal counter. This value

13.4.3.8 Channel 0 Bus Utilization Control Register

The Bus Utilization Control register (BUCRx) controls the bus utilization of an enabled channel when the request enable (REN) bit in channel control register (CCR) is cleared. The channel does not request a DMA transfer until the counter reaches the count value set in the register except for the very first burst. This counter is cleared when the channel burst is started. When the count value is set to zero, the DMA carries on burst transfers one after another until it reaches the value set in count register. In this case, the user must be careful not to violate the maximum bus request latency of other devices.

NOTE:

This register shares the same address of request time-out register.

MC9328MXS Reference Manual, Rev. 1 13-28 Freescale Semiconductor

BUCR	0		С	hann	el 0 E	3us L	Jtiliza	tion (Contr	ol Re	egiste	er		0x(0020	9098
BUCR	1		С	hann	el 1 E	3us L	Jtiliza	tion (Contr	ol Re	egiste	er		0x0	0209	90D8
BUCR	2		С	hann	el 2 E	3us L	Jtiliza	tion (Contr	ol Re	egiste	er		0x	0020	9118
BUCR	3		С	hann	el 3 E	3us L	Jtiliza	tion (Contr	ol Re	giste	er		0x00209158		
BUCR	4		С	hann	el 4 E	3us L	Jtiliza	tion (Contr	ol Re	giste	er		0x	0020	9198
BUCR5 Channel 5 Bus Utilization Control Register											0x0	0209	1D8			
BUCR	BUCR6 Channel 6 Bus Utilization Control Register												0x	0020	9218	
BUCR	BUCR7 Channel 7 Bus Utilization Control Register											0x	0020	9258		
BUCR	8		С	hann	el 8 E	3us L	Jtiliza	tion (Contr	ol Re	giste	er		0x	0020	9298
G											0x0	0209	2D8			
BUCR	10		CI	hanne	el 10	Bus I	Jtiliz a	ation	Cont	rol R	egist	er		0x	0020	9318
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r										
				'	'	'	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	r 0	r 0	r 0	r 0	r 0	r 0	r 0	r 0	r 0	r 0
RESET	0	0	0	•	-	•			0		•	•	•	•		
	0 15	0	0	•	-	•	0	0 0x00	0		•	•	•	•		
RESET	-	-		0	0	0		0	0 00 7	0	0	0	0	0	0	0
	-	-		0	0	0	0	0 0x00 8	0 00 7	0	0	0	0	0	0	0
BIT	15	14	13	12	11	10	9	0 0x00 8 CCN	0 00 7 IT	6	5	0	3	2	0	0

Table 13-22. Channel 0 Bus Utilization Control Registers Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
CCNT Bits 15–0	Clock Count—Sets the number of system clocks that must occur before the memory channel releases the AHB, before the next DMA request for the channel.

13.5 DMA Request Table

Table 13-23 identifies the dedicated DMA request signal and its associated peripheral.

Table 13-23. DMA Request Table

DMA Request	Peripheral
DMA_REQ [31]	UART 1 Receive DMA Request
DMA_REQ [30]	UART 1 Transmit DMA Request
DMA_REQ [29]	UART 2 Receive DMA Request
DMA_REQ [28]	UART 2 Transmit DMA Request
DMA_REQ [27]	Reserved
DMA_REQ [26]	Reserved
DMA_REQ [25]	USB Device End Point 5 DMA Request
DMA_REQ [24]	USB Device End Point 4 DMA Request
DMA_REQ [23]	USB Device End Point 3 DMA Request
DMA_REQ [22]	USB Device End Point 2 DMA Request
DMA_REQ [21]	USB Device End Point 1 DMA Request
DMA_REQ [20]	USB Device End Point 0 DMA Request
DMA_REQ [19]	Reserved
DMA_REQ [18]	Reserved
DMA_REQ [17]	SSI Receive DMA Request
DMA_REQ [16]	SSI Transmit DMA Request
DMA_REQ [15]	SPI 1 Transmit DMA Request
DMA_REQ [14]	SPI 1 Receive DMA Request
DMA_REQ [13]	Reserved
DMA_REQ [12]	Reserved
DMA_REQ [11]	DSPA MAC DMA Request
DMA_REQ [10]	DSPA DCT DIN DMA Request
DMA_REQ [9]	DSPA DCT DOUT DMA Request
DMA_REQ [8]	Reserved
DMA_REQ [7]	Reserved
DMA_REQ [6]	Reserved
DMA_REQ [5]	Reserved
DMA_REQ [4]	Reserved
DMA_REQ [3]	Reserved
DMA_REQ [2]	Reserved
DMA_REQ [1]	Reserved
DMA_REQ [0]	Reserved

13-30 Freescale Semiconductor

Chapter 14 **Watchdog Timer Module**

14.1 **General Overview**

The watchdog timer module of the MC9328MXS protects against system failures by providing a method of escaping from unexpected events or programming errors. Once activated, the timer must be serviced by software on a periodic basis. If servicing does not take place, the timer times out. Upon a time-out, the watchdog timer module either asserts a system reset signal WDT RST or a interrupt request signal WDT INT depending on software configuration. Table 14-1 on page 14-5 shows the watchdog timer module's input and output signals. A state machine that demonstrates the time-out operation of the counter operation is shown in Figure 14-2 on page 14-4.

14.2 Watchdog Timer Operation

The following sections describe the operation and programming of the watchdog timer module.

14.2.1 Timing Specifications

The watchdog timer provides time-out periods from 0.5 seconds up to 64 seconds with a time resolution of 0.5 seconds. As shown in Figure 14-1, the watchdog timer uses the CLK2HZ clock (from RTC module) as an input to achieve the resolution of 0.5 seconds and a frequency of 2 Hz. This clock is connected to the input of a 7-bit counter to obtain a range of 0.5 to 64 seconds. The user can determine the time-out period by writing to the watchdog time-out field (WT[6:0]) in the Watchdog Control Register (WCR).

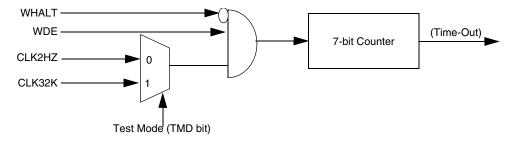


Figure 14-1. Watchdog Timer Functional Block Diagram

Watchdog After Reset

14.2.2 Watchdog During Reset

14.2.2.1 Power-On Reset

During a power-on reset (POR) all registers are reset to their reset values and the counter is placed in the idle state until the watchdog is enabled. The Watchdog Status Register (WSTR) contains the source of the reset event and the interrupt status bit TINT is reset to 0.

14.2.2.2 Software Reset

When software reset occurs, the software reset (SWR) bit in Watchdog Control Register (WCR) is set to 1, all registers of the Watchdog module are reset to their reset values and the counter is placed in the idle state until the watchdog is enabled.

14.3 Watchdog After Reset

After reset, watchdog timer operation can be divided into four states: initial load, countdown, reload, and time-out. The following sections define each of the watchdog timer states after reset.

14.3.1 Initial Load

The Watchdog Control Register (WCR) bits WT[6:0] must be written to before the watchdog is enabled. The watchdog is then enabled by setting the one-time writable watchdog enable (WDE) bit in the WCR. The time-out value is loaded into the counter after the service sequence is written to the Watchdog Service Register (WSR) or after the watchdog is enabled. The service sequence is described in Section 14.3.3, "Reload." The counter state machine is shown in Figure 14-2 on page 14-4.

14.3.2 Countdown

The counter is activated after the Watchdog is enabled and begins to count down from its initial programmed value. If any system errors have occurred which prevents the software from servicing the Watchdog Service Register (WSR), the timer will time-out when the counter reaches zero. If the WSR is serviced prior to the counter reaching zero, the watchdog reloads its counter to the time-out value indicated by bits WT[6:0] of the WCR and re-start the countdown. A reset will reset the counter and place it in the idle state at any time during the countdown. The counter state machine is shown in Figure 14-2 on page 14-4.

14.3.3 Reload

The recommended service sequence is to write a \$5555 followed by a \$AAAA to the WSR. To reload the counter, the writes must take place within the time-out value indicated by bits WT[6:0] of the WCR. Any number of instructions can be executed between the two writes. This service sequence is also used to activate the counter during the initial load. See Section 14.3.1, "Initial Load."

If the WSR is not loaded with a \$5555 prior to a write of \$AAAA to the WSR, the counter will not be reloaded. If any value other than \$AAAA is written to the WSR after \$5555, the counter will not be reloaded.

14-2 Freescale Semiconductor

14.3.4 Time-Out

If the counter reaches zero, the TOUT bit in WSTR (Watchdog Status Register) is set to 1 indicating that watchdog has timed out. Reading the TOUT bit will clear it.

If the counter reaches zero, the watchdog asserts either a system reset signal WDT_RST or an interrupt request signal WDT_INT depending on the state of the WIE bit in the WCR. A 1 written to WIE configures the watchdog to generate a interrupt request signal to the interrupt handler. When a watchdog time-out interrupt is asserted, the TINT bit in WSTR (Watchdog Status Register) is set to 1 to indicate that an interrupt request is generated and the reading of this bit clears the interrupt and this bit. A 0 written to the WIE bit configures the watchdog to generate a WDT_RST signal to reset the module. The counter state machine is shown in Figure 14-2 on page 14-4.

14.3.5 Halting the Counter

The watchdog counting can be halted at any time by setting the WHALT bit (WCR[15]) to 1. The counter immediately stops counting and the counter value is held at the last value. The WHALT bit can be cleared by writing 0 to it or it can be automatically cleared by the occurrence of any of three system events, fast interrupt, slow interrupt, or system reset. The counter resumes counting from the stopped value. No other configurations are affected.

14.4 Watchdog Control

14.4.1 Interrupt Control

The watchdog timer generates interrupt request signal WDT_INT as a result of a WDOG time-out when WIE bit of WCR set to 1. The TINT bit of WSTR is set to 1 to indicate that the interrupt request has been generated. Reading the TINT bit clears the interrupt and this status bit.

14.4.2 Reset Sources

The watchdog timer generates reset signal WDT_RST as a result of a WDOG time-out. This signal is an output to the Reset Module for system reset generation.

Freescale Semiconductor 14-3

14.5 State Machine

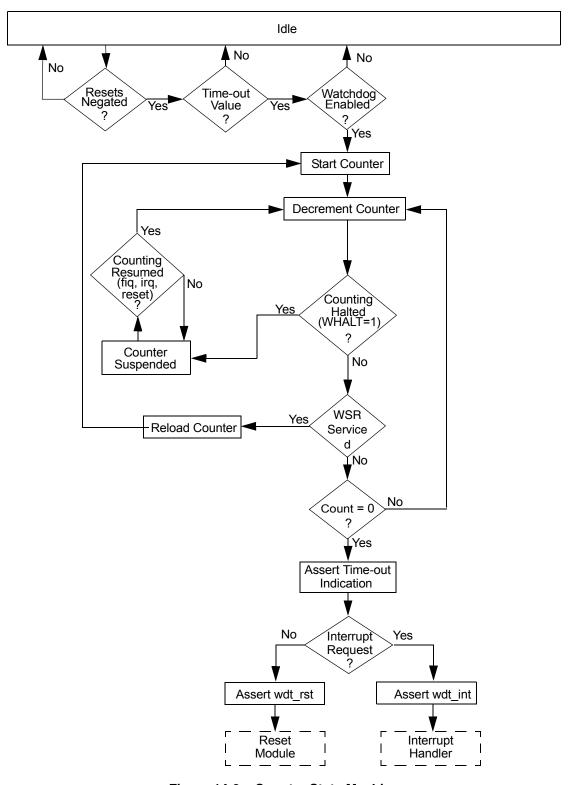


Figure 14-2. Counter State Machine

MC9328MXS Reference Manual, Rev. 1

14-4 Freescale Semiconductor

14.6 Watchdog Timer I/O Signals

Table 14-1shows the watchdog timer module input and output signals.

Table 14-1. Watchdog Timer I/O Signals

Signal Name	I/O	Description				
FIQ	I	Fast Interrupt				
ĪRQ	I	Normal Interrupt				
IPS_HARD_ASYNC_RESET	I	WDOG global reset from reset module				
IPS_CONT_CLK	I	96 MHz system clock				
IPS_CONT_CLK	I	96 MHz system clock inverted				
IPS_GATED_CLK	I	Bus clock				
IPS_GATED_CLK	I	Bus clock inverted				
CLK2HZ	I	2 Hz clock input from RTC module output				
CLK32K	I	in test mode, counter clock becomes 32 kHz clock				
IPS_MODULE_EN	I	Watchdog module enable				
IPS_BYTE_15_8	I	Bit 15 to 8 enable				
IPS_BYTE_7_0	I	Bit 7 to 0 enable				
IPS_MRW	I	Module read/write signal				
IPS_ADDR[11:2]	I	Module address bus				
IPS_WDATA[31:0]	I	Module write data bus				
SCAN_MODE	I	Indicates scan mode selection				
SCAN_RESET	I	Indicates scan reset				
IPS_CONT_CLK_EN	0	ips_cont_clk enable				
IPS_XFR_ERR	0	Transfer error acknowledge				
IPS_XFR_WAIT	0	Transfer wait acknowledge				
IPS_RDATA[31:0]	0	Module read data bus				

Freescale Semiconductor 14-5

The watchdog timer has three registers in its programming model: Watchdog Control Register (WCR), Watchdog Service Register (WSR), and Watchdog Status Register (WSTR).

Name		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
WCR (\$00201000)	R	WHAL T			,	WT[6:0]]			0	0	0	WIE	TMD	SWR	WDEC	WDE			
(\$00201000)	W																			
WSR	R								WSE	R[15:0]										
(\$00201004)	W								WSF	ւլ 13.0]										
WSTR	R	0	0	0	0	0	0	0	TINT	0	0	0	0	0	0	0	TOUT			
(\$00201008)	W																			

14.7.1 Watchdog Control Register

The WCR is a 32-bit read/write (byte writable) register. It controls the Watchdog operation. See Table 14-2 on page 14-6 for bit descriptions and settings.

WCR		Watchdog Control Register													Addr 0x00201000		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET									0x	0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	WHALT				WT							WIE	TMD	SWR	WDEC	WDE	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	r	r	rw	rw	rw	rw	rw	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET									0x	0000							

Table 14-2. Watchdog Control Register Description

Name	Description	Settings							
Reserved Bits 31–15	Reserved—These bits are reserved and should read 0.								
WHALT Bit 15	Watchdog Halt—When set, the watchdog counter immediately stops counting and the counter value is held at the last value. The WHALT bit can be cleared by writing 0 to it or it can be automatically cleared by the occurrence of any of three system events, fast interrupt, slow interrupt, or system reset.	0 = Counter is not halted 1 = Counter is halted							

14-6 Freescale Semiconductor

MC9328MXS Reference Manual, Rev. 1

Table 14-2. Watchdog Control Register Description (continued)

Name	Description	Settings
WT Bits 14–8	Watchdog Time-Out Field—This 7-bit field contains the time-out value and is loaded into the Watchdog counter after the service routine has been performed. After reset, WT[6:0] must be written before enabling the Watchdog.	Set to desired time-out value.
Reserved Bits 7–5	Reserved—These bits are reserved and should read 0.	
WIE Bit 4	Watchdog Interrupt Enable—Determines if the WDT_RST is asserted or WDT_INT is asserted upon a watchdog time-out.	1 = Assert WDT_INT 0 = Assert WDT_RST
TMD Bit 3	Test Mode Enable—Determines if WDOG timer is in test mode. Note: This bit is used only for test purposes	0 = Use 2 Hz clock as counter clock 1 = Use CLK32K as counter clock
SWR Bit 2	Software Reset Enable—Determines if a software reset is enabled.	0 = Software reset is not enabled 1 = Software reset is enabled
WDEC Bit 1	Watchdog Enable Control—Controls the write access of the WDE bit.	0 = WDE bit is write once only 1 = WDE bit is write multiple
WDE Bit 0	Watchdog Enable—Enables or disables the watchdog module. Write once-only if WDEC bit is low. Write multiple if WDEC bit is high	0 = Disable Watchdog 1 = Enable Watchdog

14.7.2 Watchdog Service Register

The Watchdog Service register contains the watchdog service sequence. When Watchdog is enabled, the Watchdog requires that a service sequence be written to the Watchdog Service Register (WSR) as described in Table 14-3.

WSR		Watchdog Service Register												Addr 0x00201004				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
TILOLI								0x0	0000									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
								W	SR									
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
								0x0	0000									

Table 14-3. Watchdog Service Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor 14-7

Table 14-3. Watchdog Service Register Description (continued)

Name	Description	Settings
WSR Bits 15–0	Watchdog Service Register—This 15-bit field contains the watchdog service sequence. Both writes must occur in the order listed prior to the time-out, however any number of instructions can be executed between the two writes.	The service sequence must be performed as follows: a) Write \$5555 to the Watchdog Service Register (WSR). b) Write \$AAAA to the Watchdog Service Register (WSR)

14.7.3 Watchdog Status Register

The WSTR is a read-only register which records the source of the RESET_OUT event and interrupt status. It is cleared by reset. It records the source of the RESET_OUT event and interrupt status. RESET_OUT can be generated by the following sources which are listed in priority from highest to lowest: Power-on reset, External reset (RESET_IN), and Watchdog Time-out.

WST	R				,	Watcl	hdog	Statu	Status Register							Addr 0x00201008		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESET								0x0	000									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
								TINT								TOUT		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESET								0x0	000									

Table 14-4. Watchdog Status Register Description

Name	Description	Settings					
Reserved Bits 31–9	Reserved—These bits are reserved and should read 0.						
TINT Bit 8	Time-Out Interrupt—Indicates whether the time-out interrupt generated	0 = No time-out interrupt generated 1 = Time-out interrupt generated					
Reserved Bits 7–1	Reserved—These bits are reserved and should read 0.						
TOUT Bit 0	Time-Out—Indicates whether the watchdog timer times out.	0 = Watchdog timer does not time-out. 1 = Watchdog timer times out.					

MC9328MXS Reference Manual, Rev. 1

14-8 Freescale Semiconductor

Chapter 15 Serial Peripheral Interface Module (SPI 1)

The MC9328MXS contains one serial peripheral interface module (SPI 1).

SPI 1 signals are multiplexed with GPIO ports as primary functions. See Chapter 2, "Signal Descriptions and Pin Assignments," for detailed pin assignments. The user must configure the corresponding GPIO registers to make SPI 1 signals available at the pins. See Section 15.2.3, "Pin Configuration," for more information about selecting SPI 1 signals.

SPI Signal Names	Connect to GPIO Signal
SPI1_SPI_RDY	Primary function of GPIO port C [13]
SPI1_SCLK	Primary function of GPIO port C [14]
SPI1_ SS	Primary function of GPIO port C [15]
SPI1_MISO	Primary function of GPIO port C [16]
SPI1_MOSI	Primary function of GPIO port C [17]

Table 15-1. SPI 1 Signal Multiplexing

15.1 SPI Block Diagram

This section describes how the SPI module communicates with external devices.

The SPI module has one 8×16 -bit receive buffer (RXFIFO) and one 8×16 -bit transmit buffer (TXFIFO). The SPI ready (SPI_RDY) and slave select (SS) control signals enable fast data communication with fewer software interrupts. The block diagram is shown in Figure 15-1 on page 15-2.

Freescale Semiconductor 15-1

Operation

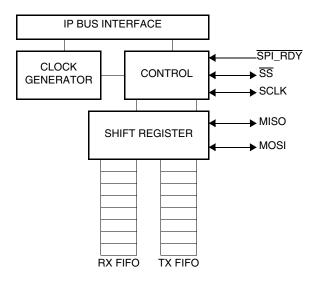


Figure 15-1. SPI Module Block Diagram

15.2 Operation

To use the internal transmit (TX) and receive (RX) data FIFOs when the SPI 1 module is configured as a master, two control signals are used for data transfer rate control: the \overline{SS} signal (output) and the \overline{SPI} _RDY signal (input). The SPI 1 Sample Period Control Register (PERIODREG1) can also be programmed to a fixed data transfer rate.

When the SPI 1 module is configured as a slave, the user can configure the SPI 1 Control Register (CONTROLREG1) to match the external SPI master's timing. In this configuration, \overline{SS} becomes an input signal, and is used to latch data into or load data out to the internal data shift registers, as well as to increment the data FIFO. Figure 15-2 on page 15-3 shows the generic SPI timing.

15.2.1 Phase and Polarity Configurations

The SPI master uses the SCLK signal to transfer data in and out of the shift register. Data is clocked by one of four programmable clock phase and polarity combinations, selected through the phase (PHA) and polarity (POL) bits in the CONTROLREG1 and CONTROLREG2 registers.

In Phase 0 operation (PHA=0) and SCLK Polarity active low (POL=0), output data changes on falling edges of the SCLK signal and input data is shifted in on rising edges. The most significant bit (MSB) is output when the CPU loads the transmitted data.

In Phase 0 operation (PHA=0) and SCLK Polarity active high (POL=1), output data changes on rising edges of the SCLK signal and input data is shifted in on falling edges. The most significant bit (MSB) is output on the first rising edge of the SCLK signal.

In Phase 1 operation (PHA=1) and SCLK Polarity active low (POL=0), output data changes on rising edges of the SCLK signal and input data is shifted in on falling edges. The MSB is output on the first rising edge of the SCLK signal.

In Phase 1 operation (PHA=1) and SCLK Polarity active high (POL=1), output data changes on falling edges of the SCLK signal and input data is shifted in on rising edges. The MSB is output when the CPU loads the transmitted data.

MC9328MXS Reference Manual, Rev. 1

15-2 Freescale Semiconductor

This flexibility allows the SPI modules to operate with most currently available serial peripheral devices. Figure 15-2 shows the relationship of the polarity and phase settings.

15.2.2 Signals

The following signals are used to control the serial peripheral interface master:

- Master Out Slave In (MOSI)—In master mode, this bidirectional signal is a TX output signal from the data shift register. In slave mode, it is an RX input.
- Master In Slave Out (MISO)—In master mode, this bidirectional signal is a RX input signal to the data shift register. In slave mode, it is a TX output.
- SPI Clock (SCLK)—In master mode, this bidirectional signal is an SPI clock output. In slave mode, it is an input.
- Slave Select (SS)—In master mode, this bidirectional signal is an output. In slave mode, it is an input.
- SPI Ready (SPI RDY)—Used only in master mode to edge- or level-trigger an SPI burst.

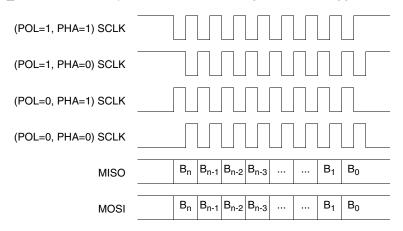


Figure 15-2. SPI Generic Timing

15.2.3 Pin Configuration

Table 15-1 lists the pins used for the SPI 1 module. These pins are multiplexed with other functions on the device, and must be configured for SPI operation.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Pin	Setting	Configuration Procedure
SPI1_SPI_RDY	Primary function of GPIO port C [13]	Clear bit 13 of Port C GPIO In Use Register (GIUS_C) Clear bit 13 of Port C General Purpose Register (GPR_C)
SPI1_SCLK	Primary function of GPIO port C [14]	Clear bit 14 of Port C GPIO In Use Register (GIUS_C) Clear bit 14 of Port C General Purpose Register (GPR_C)

Table 15-2. SPI Pin Configuration

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor 15-3

Table 15-2. SPI Pin Configuration (continued)

Pin	Setting	Configuration Procedure
SPI1_ SS	Primary function of GPIO port C [15]	Clear bit 15 of Port C GPIO In Use Register (GIUS_C) Clear bit 15 of Port C General Purpose Register (GPR_C)
SPI1_MISO	Primary function of GPIO port C [16]	Clear bit 16 of Port C GPIO In Use Register (GIUS_C) Clear bit 16 of Port C General Purpose Register (GPR_C)
SPI1_MOSI	Primary function of GPIO port C [17]	Clear bit 17 of Port C GPIO In Use Register (GIUS_C) Clear bit 17 of Port C General Purpose Register (GPR_C)

15.3 Programming Model

The SPI module includes eight 32-bit registers. Table 15-3 summarizes these registers and their addresses.

Table 15-3. SPI Module Register Memory Map

Description	Name	Address
SPI 1 Rx Data Register	RXDATAREG1	0x00213000
SPI 1 Tx Data Register	TXDATAREG1	0x00213004
SPI 1 Control Register	CONTROLREG1	0x00213008
SPI 1 Interrupt Control/Status Register	INTREG1	0x0021300C
SPI 1 Test Register	TESTREG1	0x00213010
SPI 1 Sample Period Control Register	PERIODREG1	0x00213014
SPI 1 DMA Control Register	DMAREG1	0x00213018
SPI 1 Soft Reset Register	RESETREG1	0x0021301C

15.3.1 Receive (RX) Data Register

The SPI receive data register is a read-only register that forms the top word of the 8×16 RXFIFO. This register holds data received from an external SPI device during a data transaction.

RXDA	SPI 1 Rx Data Register															Addr 3000
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HEGET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								DAT	Α							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
IILOLI								0x00	00							

Table 15-4. SPI 1 Rx Data Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
DATA Bits 15–0	DATA —Holds the top word of data received into the FIFO. Not valid when the Receive Data Ready (RR) bit in the corresponding Interrupt Control/Status Register (INTREG1) is cleared.

15.3.2 Transmit (TX) Data Register

The SPI transmit data register is a write-only data register that forms the top word of the 8×16 TXFIFO. The TXFIFO can be written to as long as it is not full, even when the exchange (XCH) bit in the corresponding SPI control register (CONTROLREG1) is set. This allows user write access to the TXFIFO during an SPI data exchange process. Writes to this register are ignored when the SPI module is disabled (SPIEN bit of the corresponding SPI control register is cleared).

TXDA ⁻	TXDATAREG1 SPI 1 Tx Data Register															Addr 0x00213004		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	W	W	w	W	W	W	W	w	w	W	W	W	w	w	w	W		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
TILOLI								0x00	00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
								DAT	A									
TYPE	W	w	w	W	w	w	W	w	w	W	W	W	w	W	w	W		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
TILOLI								0x00	00									

Table 15-5. SPI 1 Tx Data Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
DATA Bits 15–0	DATA —Holds the top word of data loaded into the FIFO. Data written to this register can be 8 or 16 bits. The number of bits actually transmitted is determined by the BIT_COUNT field of the corresponding SPI control register. If this field contains more bits than the number specified by BIT_COUNT, the extra bits are ignored. For example, to transfer 10 bits of data, a 16-bit word must be written to this register. Bits 9-0 are shifted out and bits 15-10 are ignored. When the SPI module is operating in slave mode, '0's are shifted out when the FIFO is not full.

15.3.3 Control Register

The SPI control register allows the user to enable the <u>SPI</u> module, select the operating mode, specify the divider value, phase, and polarity of the clock, configure the <u>SS</u> and <u>SPI_RDY</u> control signals, and define the transfer length.

CONT	ROL	REG	1			SP	SPI 1 Control Register								Addr 0x00213008			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
MESET								0x0	0000									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
	DATARATE			DRCTL		MODE	SPIEN	XCH	SSPOL	SSCTL	PHA	POL		BIT_C	OUNT			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
DECET	0	0	0	0	0	0/11	0	0	0	0	0	0	0	0	0	0		
RESET							(0000x	0x0400 ¹									

^{1.} In CONTROLREG2, the MODE bit is set to 1.

Table 15-6. SPI 1 Control Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
DATARATE Bits 15–13	Data Rate—Selects the divide value of SCLK from the PERCLK2 in the PLL and Clock Control Module.	000 = Divide by 4 001 = Divide by 8 010 = Divide by 16 011 = Divide by 32 100 = Divide by 64 101 = Divide by 128 110 = Divide by 256 111 = Divide by 512
DRCTL Bits 12–11	SPI_RDY Control—Selects the waveform of the SPI_RDY input signal when the SPI 1 module operates in master mode. In slave mode, DRCTL is ignored.	00 = Ignore SPI_RDY 01 = Falling edge triggers input 10 = Active low level triggers input 11 = Reserved
MODE Bit 10	SPI Mode Select—Selects the mode for the SPI 1 module. In CONTROLREG2, MODE is set by the hardware.	0 = Slave mode 1 = Master mode
SPIEN Bit 9	SPI Module Enable—Enables/Disables the serial peripheral interface. SPIEN must be asserted before an exchange is initiated. Writing 0 to SPIEN flushes the receive and transmit FIFOs.	0 = Disable the SPI 1 = Enable the SPI

Freescale Semiconductor 15-7

Table 15-6. SPI 1 Control Register Description (continued)

Name	Description	Settings
XCH Bit 8	Exchange—Initiates a data exchange in master mode. XCH remains set while the exchange is in progress, or while the SPI module is waiting for an active SPI_RDY control signal input. XCH is automatically cleared when all data in the TXFIFO and shift register are shifted out. In slave mode, XCH must be cleared.	0 = Idle 1 = Initiates exchange (write) or busy (read)
SSPOL Bit 7	SS Polarity Select—Selects the polarity of the SS signal (in both master and slave mode).	0 = Active low 1 = Active high
SSCTL Bit 6	SS Wave Form Select—Selects the output wave form for the SS signal when in master mode. Controls RXFIFO advancement when in slave mode.	In master mode: 0 = SS stays low between SPI bursts 1 = Insert pulse between SPI bursts In slave mode: 0 = RXFIFO advanced by BIT_COUNT 1 = RXFIFO advanced by SS rising edge
PHA Bit 5	Phase —Controls the clock/data phase relationship (see Figure 15-2 on page 15-3).	0 = Phase 0 operation 1 = Phase 1 operation
POL Bit 4	Polarity —Controls the polarity of the SCLK signal (see Figure 15-2 on page 15-3).	0 = Active high polarity (0 = idle) 1 = Active low polarity (1 = idle)
BIT_COUNT Bits 3-0	Bit Count—Selects the length of the transfer. A maximum of 16 bits can be transferred. In master mode, a 16-bit data word is loaded from TXFIFO to the shift register, however only the least n bits (n=BIT_COUNT) are shifted out. The next 16-bit word is then loaded to the shift register. Controls the number of bits in a receive data word (in slave	0000 = 1-bit transfer 0001 = 2-bit transfer 1111 = 16-bit transfer
	mode and when the SSCTL bit is 0). When the SSCTL bit is 1, this field is "don't care."	

15-8 Freescale Semiconductor

15.3.4 Interrupt Control/Status Register

The SPI interrupt control status register allows the user to enable various interrupt signals and monitor the status of those interrupts.

INTRE	NTREG1 SPI 1 Interrupt Control/Status Register													Addr 0x0021300C		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	BOEN	ROEN	RFEN	RHEN	RREN	TFEN	THEN	TEEN	ВО	RO	RF	RH	RR	TF	TH	TE
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	000							

Table 15-7. SPI 1 Interrupt Control/Status Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
BOEN Bit 15	Bit Count Overflow Interrupt Enable—Enables/Disables the Bit Count Overflow Interrupt.	0 = Disable interrupt 1 = Enable interrupt
ROEN BIT 14	RXFIFO Overflow Interrupt Enable —Enables/Disables the RXFIFO Overflow Interrupt.	0 = Disable interrupt 1 = Enable interrupt
RFEN Bit 13	RXFIFO Full Interrupt Enable —Enables/Disables the RXFIFO Full Interrupt.	0 = Disable interrupt 1 = Enable interrupt
RHEN Bit 12	RXFIFO Half Interrupt Enable—Enables/Disables the RXFIFO Half-Full Interrupt.	0 = Disable interrupt 1 = Enable interrupt
RREN Bit 11	RXFIFO Data Ready Interrupt Enable—Enables/Disables the RXFIFO Data Ready Interrupt.	0 = Disable interrupt 1 = Enable interrupt
TFEN Bit 10	TXFIFO Full Interrupt Enable —Enables/Disables the TXFIFO Full Interrupt.	0 = Disable interrupt 1 = Enable interrupt
THEN Bit 9	TXFIFO Half Interrupt Enable—Enables/Disables the TXFIFO Half-Empty Interrupt.	0 = Disable interrupt 1 = Enable interrupt
TEEN Bit 8	TXFIFO Empty Interrupt Enable —Enables/Disables the TXFIFO Empty Interrupt.	0 = Disable interrupt 1 = Enable interrupt

Freescale Semiconductor 15-9

Table 15-7. SPI 1 Interrupt Control/Status Register Description (continued)

Name	Description	Settings
BO Bit 7	Bit Count Overflow—Indicates that a bit count overflow has occurred. BO is applicable for the SPI 1 module only when the bits of CONTROLREG1 are set so that MODE = 0 and SSCTL = 1. The overflow occurs when the slave receives more than 16 bits in one burst. BO is cleared after a data read from the RXDATAREG1 register. There is no way to determine which data word overflowed, so the bad data word can still be in the FIFO if it is not empty.	0 = No bit count overflow error 1 = At least one data word in RXFIFO has a bit count overflow error
RO Bit 6	RXFIFO Overflow—Indicates that the RXFIFO has overflowed. At least one newly written data word has been lost. The RO flag is automatically cleared after a data read.	0 = No RXFIFO overflow error 1 = At least one data word in the RXFIFO has been overwritten
RF Bit 5	RXFIFO Full Status—Indicates that the RXFIFO is full.	0 = Less than 8 data words are in the RXFIFO 1 = 8 data words are in the RXFIFO
RH Bit 4	RXFIFO Half Status—Indicates that the RXFIFO is at least half-full.	0 = Less than 4 data words are in the RXFIFO 1 = At least 4 data words are in the RXFIFO
RR Bit 3	RXFIFO Data Ready Status—Indicates that the RXFIFO is empty.	0 = The RXFIFO is empty 1 = At least one data word is in the RXFIFO
TF Bit 2	TXFIFO Full Status—Indicates that the TXFIFO is full.	0 = Less than 8 data words are in the TXFIFO 1 = 8 data words are in the TXFIFO
TH Bit 1	TXFIFO Half Status—Indicates that the TXFIFO is at least half-empty.	0 = Less than 4 empty slots are in the TXFIFO 1 = At least 4 empty slots are in the TXFIFO
TE Bit 0	TXFIFO Empty Status—Indicates that the TXFIFO is empty.	0 = At least one data word is in the TXFIFO 1 = The TXFIFO is empty, however data shifting may still be on-going. To be sure no data transaction is on-going, check the XCH bit(s) in the Control Register(s).

15-10 Freescale Semiconductor

15.3.5 Test Register

The SPI test register allows the user to internally connect the receive and transmit sections, display the status of the state machine, and monitor the contents of the receive and transmit FIFOs.

TESTE	REG1					SF	РI 1 Т	est R	egist	er				0x	0021	Addr 3010
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		LBC				SSTA	ATUS			RX	CNT			TXC	CNT	
TYPE	r	rw	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							

Table 15-8. SPI 1 Test Register Description

Name	Description	Settings
Reserved Bits 31–15	Reserved—These bits are reserved and should read 0.	
LBC Bit 14	Loop Back Control—Internally connects the receive and transmit sections internally for test purposes.	0 = RX and TX sections are not internally connected 1 = RX and TX sections are internally connected
Reserved Bits 13–12	Reserved—These bits are reserved and should read 0.	
SSTATUS Bits 11–8	State Machine Status—Indicates the state machine status (used for test	purposes only).
RXCNT Bits 7–4	RXFIFO Counter—Indicates the number of data words in the RXFIFO.	0000 = RXFIFO is empty 0001 = 1 data word in RXFIFO 0010 = 2 data words in RXFIFO 0011 = 3 data words in RXFIFO 0100 = 4 data words in RXFIFO 0101 = 5 data words in RXFIFO 0110 = 6 data words in RXFIFO 0111 = 7 data words in RXFIFO 1000 = 8 data words in RXFIFO

Table 15-8. SPI 1 Test Register Description (continued)

Name	Description	Settings
TXCNT Bits 3–0	TXFIFO Counter—Indicates the number of data words in the TXFIFO.	0000 = TXFIFO is empty 0001 = 1 data word in TXFIFO 0010 = 2 data words in TXFIFO 0011 = 3 data words in TXFIFO 0100 = 4 data words in TXFIFO 0101 = 5 data words in TXFIFO 0110 = 6 data words in TXFIFO 0111 = 7 data words in TXFIFO 1000 = 8 data words in TXFIFO

15.3.6 Sample Period Control Register

The SPI sample period control register allows the user to select the clock source for the counter and to set the wait between data transactions. The wait is only applicable when the SPI module is operating in master mode.

PERIO	PERIODREG1 SPI 1 Sample Period Control Register													Addr 0x00213014		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	CSRC								WAIT							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							

Table 15-9. SPI 1 Sample Period Control Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
CSRC Bit 15	Clock Source—Selects the clock source for the counter.	0 = Bit clock 1 = 32.768 kHz or 32 kHz clock
WAIT Bits 14–0	Wait—Determines the number of clocks inserted between data transactions (when operating in master mode).	0x0000 = 0 clock 0x0001 = 1 clock 0x0002 = 2 clocks 0x7FFF = 32,767 clocks

MC9328MXS Reference Manual, Rev. 1

15-12 Freescale Semiconductor

15.3.7 DMA Control Register

The SPI DMA control register allows the user to enable DMA requests when the FIFOs are full, empty, or half-full. This register also contains status bits for FIFO full, empty, and half-empty conditions.

DMAI	DMAREG1 SPI 1 DMA Control Register 0x00213018															
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								C)x0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	THDEN	TEDEN	RFDEN	RHDEN					THDMA	TEDMA	RFDMA	RHDMA				
TYPE	rw	rw	rw	rw	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								C	0000x							

Table 15-10. SPI 1 DMA Control Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should	read 0.
THDEN Bit 15	THDEN—Enables/Disables the TXFIFO Half DMA Request.	0 = Disabled 1 = Enabled
TEDEN Bit 14	TEDEN—Enables/Disables the TXFIFO Empty DMA Request.	0 = Disabled 1 = Enabled
RFDEN Bit 13	RFDEN—Enables/Disables the RXFIFO Full DMA Request.	0 = Disabled 1 = Enabled
RHDEN Bit 12	RHDEN—Enables/Disables the RXFIFO Half DMA Request.	0 = Disabled 1 = Enabled
Reserved Bits 11–8	Reserved—These bits are reserved and should	read 0.
THDMA Bit 7	TXFIFO Half Status—Indicates when the transmit FIFO is half-empty.	0 = There are less than 4 empty slots in the TXFIFO 1 = There are at least 4 empty slots in the TXFIFO
TEDMA Bit 6	TXFIFO Empty Status—Indicates when the transmit FIFO is empty.	0 = There is at least one data word in the TXFIFO 1 = The TXFIFO is empty, however data shifting may still be on-going. To be sure no data transaction is on-going, read the XCH bit in the Control Registers.
RFDMA Bit 5	RXFIFO Full Status—Indicates when the receive FIFO is full.	0 = There are less than 8 data words in the RXFIFO 1 = There are 8 data words in the RXFIFO

MC9328MXS Reference Manual, Rev. 1

Table 15-10. SPI 1 DMA Control Register Description (continued)

Name	Description	Settings
RHDMA Bit 4	RXFIFO Half Status—Indicates when the receive FIFO is half-full.	0 = There are less than 4 data words in the RXFIFO 1 = There are at least 4 data words in the RXFIFO
Reserved Bits 3–0	Reserved—These bits are reserved and should	read 0.

15.3.8 Soft Reset Register

The SPI soft reset register allows the user to reset the SPI module.

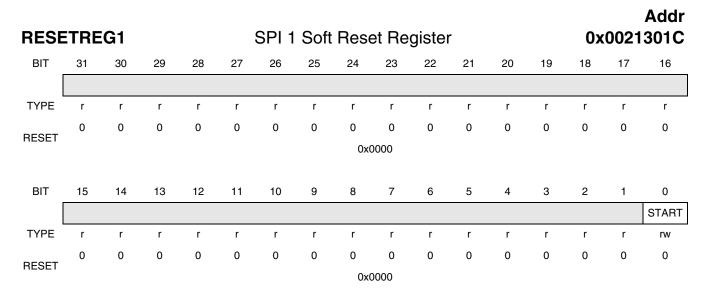


Table 15-11. SPI 1 Soft Reset Register Description

Name	Description	Settings
Reserved Bits 31–1	Reserved—These bits are reserved and should read 0.	
START Bit 0	Start—Executes soft reset.	0 = No soft reset 1 = Soft reset

15-14 Freescale Semiconductor

Chapter 16 LCD Controller

16.1 Introduction

The Liquid Crystal Display Controller (LCDC) provides display data for external gray-scale or color LCD panels. The LCDC is capable of supporting black-and-white, gray-scale, passive-matrix color, and active-matrix color LCD panels.

16.2 Features

- Support for single (non-split) screen monochrome/color LCD panels and self-refresh type LCD panels
- 16 simultaneous gray-scale levels from a palette of 16 for monochrome display
- Support for:
 - 4/8/12 bits per pixel (bpp) for passive color panel
 - 4/8/12/16 bpp for TFT panel
 - Up to 256 colors out of a palette of 4096 colors for an 8 bpp display and 4096 colors for a 12 bpp display
 - True 64K colors for 16 bpp
 - Additional support details are shown in Table 16-1

Table 16-1. Supported Panel Characteristics

Panel Type	Bit/Pixel	Panel Interface (Bits)	Number of Gray Level/Color
Monochrome	1	1, 2, 4, 8	Black-and-white
	2	1, 2, 4, 8	4
	4	1, 2, 4, 8	16
CSTN	4,8,12	8	16, 256, 4096
TFT	4, 8	16	16, 256
	12, 16	12, 16	4096, 64K

- Standard panel interface for common LCD drivers
- Panel interface of 16-, 12-, 8-, 4-, 2-, and 1-bit-wide LCD panel data bus for monochrome or color panels
- For 4 bpp and 8 bpp a palette table is used for re-mapping of data from memory, independent of type of panel used. For the 1 bpp, 2 bpp, 12 bpp and 16 bpp the palette table is by-passed.

LCDC Operation

- Direct interface to active color panels (TFT) such as NEC and Sharp
- Dedicated signals facilitate interface to Sharp HR-TFT panels such as 320 × 240
- Hardware-generated cursor with blink, color, and size programmability
- Logical operation between color hardware cursor and background
- Hardware panning (soft horizontal scrolling)
- 8-bit pulse-width modulator for software contrast control

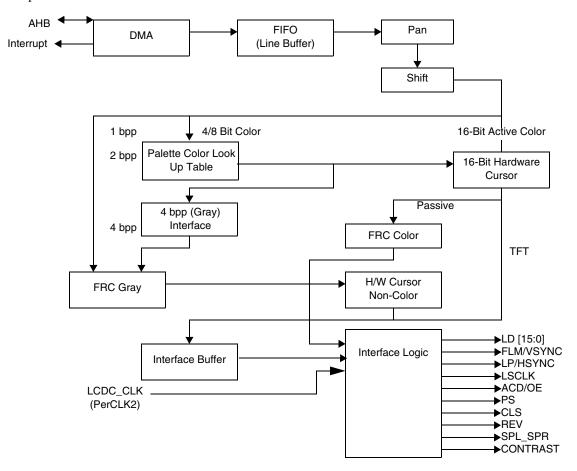


Figure 16-1. LCDC Block Diagram

16.3 LCDC Operation

16.3.1 LCD Screen Format

The number of pixels forming the screen width and screen height of the LCD panel are software programmable. Figure 16-2 shows the relationship between the screen size and memory window.

16-2 Freescale Semiconductor

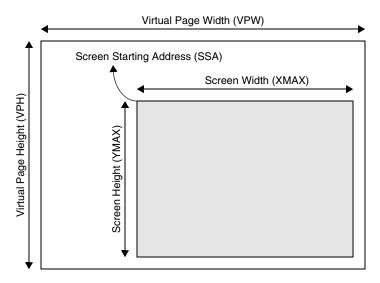


Figure 16-2. LCD Screen Format

The Screen Width (XMAX) and Screen Height (YMAX) parameters specify the LCD panel size. The LCDC will start scanning the display memory at the location pointed to by the Screen Starting Address (SSA) register, represented by the shaded area in Figure 16-2, for display on the LCD panel.

The maximum page width is specified by the Virtual Page Width (VPW) parameter. Virtual Page Height (VPH) does not affect the LCDC and is limited only by memory size. By changing the SSA register, a screen-sized window can be vertically or horizontally scrolled (panned) anywhere inside the virtual page boundaries. The software must control the starting address in the SSA properly so that the scanning logic's System Memory Pointer (SMP) stays within the VPW and VPH limits to prevent the display of strange artifacts on the screen.

VPH is used by the programmer only for boundary checks. There is no VPH parameter internal to the LCDC.

VPW is used in calculating the RAM starting address representing the beginning of each displayed line. SSA sets the address of data for the first line of a frame. For each subsequent line, VPW is added to an accumulation initialized by the SSA to yield the starting address of that line.

16.3.2 Panning

Panning Offset (POS) is expressed in bits, not pixels, so when operating in any mode other than 1 bpp, only even pixel boundaries are valid. In 12 bpp mode, the pixels are aligned to 16-bit boundaries, and POS also must align to these boundaries.

SSA and POS are located in isolated registers and are double buffered because they are dynamic parameters likely to change while the LCDC is running. New values of SSA and POS do not take effect until the beginning of the next frame. A typical panning algorithm includes an interrupt at the beginning of the frame. In the interrupt service routine, POS and/or SSA are updated (the old values are internally latched). The updates take effect on the next frame.

16.3.3 Display Data Mapping

The LCDC supports 1/2/4 bpp in monochrome mode and 4/8/12/16 bpp in color mode. System memory data mapping in 2/4/8/12/16 bpp modes is shown in Figure 16-4 and in Figure 16-5.

NOTE:

In 12 bpp mode, 16 bits of memory are used for each set of 12 bits, leaving 4 bits unused. In 16 bpp mode, all 16 bits are used. Refer to Figure 16-5 and Table 16-7.

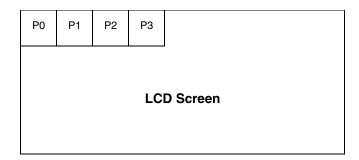


Figure 16-3. Pixel Location on Display Screen

16-4 Freescale Semiconductor

	1 bpp Mode, Little Endian							1 bpp Mode, Big Endian									
Byte Address		;	Sample	Bit-to-	Pixel N	/lappino	g		Byte Address		\$	Sample	Bit-to-	Pixel N	/lappino	g	
3	Bit 31	Bit 30	Bit 29	Bit 28	Bit 27	Bit 26	Bit 25	Bit 24	0	Bit 31	Bit 30	Bit 29	Bit 28	Bit 27	Bit 26	Bit 25	Bit 24
	P24	P25	P26	P27	P28	P29	P30	P31		P0	P1	P2	P3	P4	P5	P6	P7
2	Bit 23	Bit 22	Bit 21	Bit 20	Bit 19	Bit 18	Bit 17	Bit 16	1	Bit 23	Bit 22	Bit 21	Bit 20	Bit 19	Bit 18	Bit 17	Bit 16
	P16	P17	P18	P19	P20	P21	P22	P23		P8	P9	P10	P11	P12	P13	P14	P15
1	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	2	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
	P8	P9	P10	P11	P12	P13	P14	P15		P16	P17	P18	P19	P20	P21	P22	P23
0	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	3	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	P0	P1	P2	P3	P4	P5	P6	P7		P24	P25	P26	P27	P28	P29	P30	P31
		2 bpp	Mod	e, Littl	e End	lian					2 bp	р Мос	le, Biç	j Endi	an		
Byte Address		;	Sample	Bit-to-	Pixel N	/lappino	g		Byte Address		3	Sample	Bit-to-	Pixel N	/lappino	g	
3	Bit 31	Bit 30	Bit 29	Bit 28	Bit 27	Bit 26	Bit 25	Bit 24	0	Bit 31	Bit 30	Bit 29	Bit 28	Bit 27	Bit 26	Bit 25	Bit 24
	-	12		13		14		15		Р			1		2		23
2				Bit 20					1						Bit 18		
		8	-	9		10		11		P			5		6		7
1				Bit 12				Bit 8	2						Bit 10		Bit 8
0		P4		P5	_	6		P7		P	_		9		10		11
0	Bit 7	Bit 6	Bit 5	Bit 4 P1	Bit 3	Bit 2	Bit 1	Bit 0	3	Bit 7	Bit 6	Bit 5	Bit 4 13	Bit 3	Bit 2	Bit 1	Bit 0 15
	'	U				_		9		'	14	!	13	!	14		13
4 bpp Mode, Little Endian								•	i e								
ſ	•			-								=		g Endi			
Byte Address		;	Sample	Bit-to-	Pixel N	/lappino			Byte Address		(Sample	Bit-to-	Pixel N	/lappino		
•	Bit 31	Bit 30	Sample	-	Pixel N	/appino		Bit 24	,	Bit 31	(Sample Bit 29	Bit-to-	Pixel N		Bit 25	Bit 24
Address		Bit 30 F Bit 22	Sample Bit 29	Bit-to-	Pixel N	Mappino Bit 26 P Bit 18	Bit 25		Address		Bit 30 P Bit 22	Sample Bit 29	Bit-to-	Pixel N	Mappino Bit 26 P Bit 18	Bit 25	
Address 3	Bit 23	Bit 30 F Bit 22 F Bit 14	Bit 29 6 Bit 21 94 Bit 13	Bit 28	Bit 27	Bit 26 P Bit 18 P Bit 10	Bit 25 7 Bit 17 5 Bit 9		Address 0	Bit 23	Bit 30 P Bit 22 P Bit 14	Bit 29 0 Bit 21 2 Bit 13	Bit 28	Pixel N Bit 27 Bit 19	Bit 26 P Bit 18 P Bit 10	Bit 25 1 Bit 17 3 Bit 9	
Address 3 2	Bit 23	Bit 30 F Bit 22 F Bit 14 F Bit 6	Bit 29 6 Bit 21 24 Bit 13 22 Bit 5	Bit 28	Bit 27	Bit 26 P Bit 18 P Bit 10 P Bit 2	Bit 25 27 Bit 17 25 Bit 9 23 Bit 1	Bit 16	Address 0	Bit 23	Bit 30 P Bit 22 P Bit 14 P	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5	Bit 28	Pixel N Bit 27 Bit 19	Bit 26 P Bit 18 P Bit 10 P	Bit 25 1 Bit 17 3 Bit 9 5 Bit 1	Bit 16
Address 3 2	Bit 23	Bit 30 F Bit 22 F Bit 14 F Bit 6	Bit 29 P6 Bit 21 P4 Bit 13	Bit 28 Bit 20 Bit 12	Bit 27 Bit 19 Bit 11	Bit 26 P Bit 18 P Bit 10 P Bit 2	Bit 25 7 Bit 17 25 Bit 9	Bit 16	Address 0 1 2	Bit 23	Bit 30 P Bit 22 P Bit 14	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5	Bit 28 Bit 20 Bit 12	Pixel M Bit 27 Bit 19	Bit 26 P Bit 18 P Bit 10 P	Bit 25 1 Bit 17 3 Bit 9	Bit 16
Address 3 2	Bit 23	Bit 30 F Bit 22 F Bit 14 F Bit 6	Bit 29 P6 Bit 21 P4 Bit 13 P2 Bit 5	Bit 28 Bit 20 Bit 12	Bit 27 Bit 19 Bit 11 Bit 3	Bit 26 P Bit 18 P Bit 10 P Bit 2	Bit 25 27 Bit 17 25 Bit 9 23 Bit 1	Bit 16	Address 0 1 2	Bit 23	Bit 30 P Bit 22 P Bit 14 P Bit 6	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5	Bit 28 Bit 20 Bit 12 Bit 4	Pixel M Bit 27 Bit 19	Bit 26 P Bit 18 P Bit 10 P Bit 2	Bit 25 1 Bit 17 3 Bit 9 5 Bit 1	Bit 16
Address 3 2	Bit 23	Bit 30 F Bit 22 F Bit 14 F Bit 6 F	Bit 29 P6 Bit 21 P4 Bit 13 P2 Bit 5 P0 Mode	Bit 28 Bit 20 Bit 12 Bit 4	Bit 27 Bit 19 Bit 11 Bit 3	Bit 26 P Bit 18 P Bit 10 P Bit 2	Bit 25 P7 Bit 17 P5 Bit 9 P3 Bit 1	Bit 16	Address 0 1 2	Bit 23	Bit 30 P Bit 22 P Bit 14 P Bit 6 P	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5	Bit 28 Bit 20 Bit 12 Bit 4	Bit 27 Bit 19 Bit 11 Bit 3	Bit 26 P Bit 18 P Bit 10 P Bit 2	Bit 25 1 Bit 17 3 Bit 9 5 Bit 1	Bit 16
Address 3 2 1 0	Bit 23 Bit 15 Bit 7	Bit 30 F Bit 22 F Bit 14 F Bit 6 F	Bit 29 P6 Bit 21 P4 Bit 13 P2 Bit 5 P0 Mode	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4	Bit 27 Bit 19 Bit 11 Bit 3	Bit 26 P Bit 18 P Bit 10 P Bit 2 P	Bit 25 7 Bit 17 5 Bit 9 23 Bit 1	Bit 16 Bit 8 Bit 0	Address 0 1 2 3	Bit 23 Bit 15 Bit 7	Bit 30 P Bit 22 P Bit 14 P Bit 6 P	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5 6 P Mod	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4	Bit 27 Bit 19 Bit 11 Bit 3	Bit 26 Pit 18 Pit 10 Pit 10 Pit 2	Bit 25 21 Bit 17 23 Bit 9 25 Bit 1	Bit 16 Bit 8 Bit 0
Address 3 2 1 0 Byte Address	Bit 23 Bit 15 Bit 7	Bit 30 FBit 22 FBit 14 FBit 6 F8 bpp	Bit 29 6 Bit 21 24 Bit 13 2 Bit 5 0 Model Sample	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4	Bit 27 Bit 19 Bit 11 Bit 3 Be End Pixel M Bit 27	Bit 26 P Bit 18 P Bit 10 P Bit 2 P	Bit 25 27 Bit 17 25 Bit 9 23 Bit 1	Bit 16 Bit 8 Bit 0	Address 0 1 2 3 Byte Address	Bit 23 Bit 15 Bit 7	Bit 30 P Bit 22 P Bit 14 P Bit 6 P	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5 6 p Mod Sample	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4	Bit 27 Bit 19 Bit 11 Bit 3 Fixel M Bit 27	Bit 26 P Bit 18 P Bit 10 P Bit 2 P An	Bit 25 21 Bit 17 23 Bit 9 25 Bit 1 7	Bit 16 Bit 8 Bit 0
Address 3 2 1 0 Byte Address 3	Bit 23 Bit 15 Bit 7	Bit 30 FBit 22 FBit 14 FBit 6 F8 bpp	Bit 29 6 Bit 21 24 Bit 13 2 Bit 5 0 Model Sample	Bit 28 Bit 20 Bit 12 Bit 4 e, Little Bit 28 Bit 28 Bit 28 F Bit 20	Bit 27 Bit 19 Bit 11 Bit 3 Be End Pixel M Bit 27	Bit 26 P Bit 18 P Bit 10 P Bit 2 P	Bit 25 27 Bit 17 25 Bit 9 23 Bit 1	Bit 16 Bit 8 Bit 0	Address 0 1 2 3 Byte Address 0	Bit 23 Bit 15 Bit 7	Bit 30 P Bit 22 P Bit 14 P Bit 6 P	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5 6 p Mod Sample	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 28 Bit 28 Bit 28 Bit 28	Bit 27 Bit 19 Bit 11 Bit 3 Fixel M Bit 27	Bit 26 P Bit 18 P Bit 10 P Bit 2 P An Mapping	Bit 25 21 Bit 17 23 Bit 9 25 Bit 1 7	Bit 16 Bit 8 Bit 0
Address 3 2 1 0 Byte Address 3	Bit 23 Bit 15 Bit 7	Bit 30 F Bit 22 F Bit 14 F Bit 6 F 8 bpp	Bit 29 6 Bit 21 24 Bit 13 22 Bit 5 0 Mode Sample Bit 29	Bit 28 Bit 20 Bit 12 Bit 4 e, Little Bit 28 Bit 28 Bit 28 F Bit 20	Bit 19 Bit 11 Bit 3 Bit 27 Bit 19 Bit 11 Bit 3 Bit 27 Bit 27 Bit 27	Bit 26 Bit 18 P Bit 10 P Bit 2 P Bit 2 Bit 2 Bit 2 Bit 2 Bit 26 Bit 26	Bit 25 7 Bit 17 25 Bit 9 3 Bit 1	Bit 16 Bit 8 Bit 0	Address 0 1 2 3 Byte Address 0	Bit 23 Bit 15 Bit 7 Bit 31 Bit 23	Bit 30 P Bit 22 P Bit 14 P Bit 6 P 8 bp	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5 6 p Mod Sample Bit 29	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 28 Bit 4 Bit 4 Bit 4	Bit 19 Bit 11 Bit 3 Fixel M Bit 27 Bit 19 Bit 11 Bit 3	Bit 26 P Bit 18 P Bit 10 P Bit 2 P An Mapping	Bit 25 1 Bit 17 3 Bit 9 5 Bit 1 7 Bit 1	Bit 16 Bit 8 Bit 0
Address 3 2 1 0 Byte Address 3 2	Bit 23 Bit 15 Bit 7	Bit 30 F Bit 22 F Bit 14 F Bit 6 F 8 bpp	Bit 29 6 Bit 21 24 Bit 13 22 Bit 5 0 Mode Sample Bit 29	Bit 28 Bit 20 Bit 12 Bit 4 E, Littl Bit 28 Bit 20 Bit 12 Bit 20 Bit 20 Bit 20 Bit 20 Bit 20 Bit 20	Bit 19 Bit 11 Bit 3 Bit 27 Bit 19 Bit 11 Bit 3 Bit 27 Bit 27 Bit 27	Bit 26 Bit 18 P Bit 10 P Bit 2 P Bit 2 Bit 2 Bit 2 Bit 2 Bit 26 Bit 26	Bit 25 7 Bit 17 25 Bit 9 3 Bit 1	Bit 16 Bit 8 Bit 0	Address 0 1 2 3 Byte Address 0 1	Bit 23 Bit 15 Bit 7 Bit 31 Bit 23	Bit 30 P Bit 22 P Bit 14 P Bit 6 P 8 bp	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5 6 p Mod Sample Bit 29	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 28 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 12	Bit 19 Bit 11 Bit 3 Fixel N Bit 19 Bit 11 Bit 3 Bit 27 Bit 19 Bit 19 Bit 19 Bit 19	Bit 26 Bit 18 P Bit 10 P Bit 2 An Mapping Bit 26 Bit 26	Bit 25 1 Bit 17 3 Bit 9 5 Bit 1 7 Bit 1	Bit 16 Bit 8 Bit 0 Bit 16
Address 3 2 1 0 Byte Address 3 2	Bit 23 Bit 15 Bit 7	Bit 30 F Bit 22 F Bit 14 F Bit 6 F 8 bpp	Bit 29 6 Bit 21 2 Bit 13 2 Bit 5 0 Mode Sample Bit 29 Bit 21	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 12 Bit 12 Bit 12 Bit 12 Bit 12 Bit 12	Bit 27 Bit 19 Bit 11 Bit 3 Pixel M Pixel M Bit 27 Bit 19 2 Bit 11 Bit 3	Bit 26 Bit 18 P Bit 10 P Bit 2 P Bit 2 Bit 2 Bit 2 Bit 2 Bit 26 Bit 26	Bit 25 P7 Bit 17 P5 Bit 9 P3 Bit 1	Bit 16 Bit 8 Bit 0	Address 0 1 2 3 Byte Address 0 1	Bit 23 Bit 15 Bit 7 Bit 31 Bit 23	Bit 30 P Bit 22 P Bit 14 P Bit 6 P 8 bp	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5 6 p Mod Sample Bit 29	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 28 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 12	Bit 27 Bit 19 Bit 11 Bit 3 Fixel N Bit 27 Bit 11 Bit 3	Bit 26 Bit 18 P Bit 10 P Bit 2 An Mapping Bit 26 Bit 26	Bit 25 1 Bit 17 3 Bit 9 5 Bit 1 7 Bit 1	Bit 16 Bit 8 Bit 0 Bit 16
Address 3 2 1 0 Byte Address 3 2 1	Bit 23 Bit 15 Bit 7 Bit 31 Bit 23 Bit 15	Bit 30 F Bit 22 F Bit 14 F Bit 6 F 8 bpp Bit 30 Bit 22	Bit 29 6 Bit 21 24 Bit 13 22 Bit 5 0 Mod Sample Bit 29 Bit 21	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 4 Bit 12 Bit 12 Bit 12 Bit 12 Bit 12 Bit 12	Bit 27 Bit 19 Bit 11 Bit 3 Pixel N Bit 27 Bit 27 Bit 19 Bit 19 Calcal Service	Bit 26 Bit 18 Bit 10 P Bit 2 P Bit 2 Bit 2 Bit 2 Bit 3 Aapping Bit 26 Bit 18	Bit 25 P7 Bit 17 P5 Bit 9 P3 Bit 1	Bit 16 Bit 8 Bit 0 Bit 24 Bit 16 Bit 8	Address 0 1 2 3 Byte Address 0 1 2	Bit 23 Bit 15 Bit 7 Bit 31 Bit 23 Bit 15	Bit 30 P Bit 22 P Bit 14 P Bit 6 P Bit 30 Bit 30 Bit 30	Bit 29 0 Bit 21 2 Bit 13 4 Bit 5 6 P Mod Sample Bit 29 Bit 21	Bit 28 Bit 20 Bit 12 Bit 4 Bit 4 Bit 28 Bit 4 Bit 19 Bit 11 Bit 3 Fixel N Bit 19 Bit 11 Bit 3 Bit 27 Bit 19 Bit 19 Bit 19 Bit 19	Bit 26 Pit 18 Pit 10 Pit 2 Pit 2 Pit 2 Pit 2 Bit 2 Bit 26 Bit 18 Bit 10	Bit 25 11 Bit 17 3 Bit 9 25 Bit 1 7 Bit 25 Bit 17 Bit 9	Bit 16 Bit 8 Bit 0 Bit 24 Bit 16 Bit 8	

P0 = Red0Green0Blue0

P1 = Red1Green1Blue1

Figure 16-4. Display Data Mapping, 1/2/4/8 bpp Modes

MC9328MXS Reference Manual, Rev. 1

LCDC Operation

Table 16-2. Display Mapping in 12 bpp, CSTN Panel, Little Endian

16 bpp Mode, Little Endian

Byte Address	Sample Bit-to-Pixel Mapping								
3	Bit 31	Bit 30	Bit 29	Bit 28	Bit 27	Bit 26	Bit 25	Bit 24	
	Red1 [4]	Red1 [3]	Red1 [2]	Red1 [1]	Red1 [0]	Green1 [5]	Green1 [4]	Green1 [3]	
2	Bit 23	Bit 22	Bit 21	Bit 20	Bit 19	Bit 18	Bit 17	Bit 16	
	Green1 [2]	Green1 [1]	Green1 [0]	Blue1 [4]	Blue1 [3]	Blue1 [2]	Blue1 [1]	Blue1 [0]	
1	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	
	Red0 [4]	Red0 [3]	Red0 [2]	Red0 [1]	Red0 [0]	Green0 [5]	Green0 [4]	Green0 [3]	
0	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
	Green0 [2]	Green0 [1]	Green0 [0]	Blue0 [4]	Blue0 [3]	Blue0 [2]	Blue0 [1]	Blue0 [0]	

16 bpp Mode, Big Endian

Byte Address	Sample Bit-to-Pixel Mapping							
0	Bit 31	Bit 30	Bit 29	Bit 28	Bit 27	Bit 26	Bit 25	Bit 24
	Red0 [4]	Red0 [3]	Red0 [2]	Red0 [1]	Red0 [0]	Green0 [5]	Green0 [4]	Green0 [3]
1	Bit 23	Bit 22	Bit 21	Bit 20	Bit 19	Bit 18	Bit 17	Bit 16
	Green0 [2]	Green0 [1]	Green0 [0]	Blue0 [4]	Blue0 [3]	Blue0 [2]	Blue0 [1]	Blue0 [0]
2	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8
	Red1 [4]	Red1 [3]	Red1 [2]	Red1 [1]	Red1 [0]	Green1 [5]	Green1 [4]	Green1 [3]
3	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	Green1 [2]	Green1 [1]	Green1 [0]	Blue1 [4]	Blue1 [3]	Blue1 [2]	Blue1 [1]	Blue1 [0]

Table 16-3. Display Mapping in 12 bpp, CSTN Panel, Little Endian

Byte Address	Bit-to-Pixel Mapping									
3	B31	B30	B29	B28	B27	B26	B25	B24		
	_	-	-	_	R1 ³	R1 ²	R1 ¹	RI ⁰		
2	B23	B22	B21	B20	B19	B18	B17	B16		
	G1 ³	G1 ²	G1 ¹	GI ⁰	B1 ³	B1 ²	B1 ¹	BI ⁰		
1	B15	B14	B13	B12	B11	B10	В9	B8		
	_	-	_	_	R0 ³	R0 ²	R0 ¹	RO ⁰		
0	В7	В6	B5	B4	В3	B2	B1	ВО		
	GO3	G0 ²	G0 ¹	GO ⁰	ВО3	B0 ²	B0 ¹	BO ⁰		

PO = RGBo P1= RGB₁

16-6 Freescale Semiconductor

Byte Address Bit-to-Pixel Mapping 0 **B31** B30 B29 B28 B25 **B27 B26 B24** $R0^3$ $R0^2$ $R0^1$ RO⁰ 1 B23 B22 B21 B20 B19 **B18 B17 B16** GO3 $G0^2$ BO₃ BO⁰ GO⁰ $B0^2$ $G0^1$ B0¹ 2 B15 B14 B13 B12 B11 B₁₀ **B9** R8 R1³ R1² R1¹ RI^0 3 B7 B6 B5 B4 **B**3 B2 B1 RO B1³ B1² G1³ $G1^2$ $G1^1$ GI^0 B1¹ BI^0

Table 16-4. Display Mapping in 12 bpp, CSTN Panel, Big Endian

PO = RGBo P1= RGB₁

Figure 16-5. Display Data Mapping, 16 bpp Mode

16.3.4 Black-and-White Operation

The 1 bpp mode is also known as black-and-white mode because each pixel is always either fully on or fully off.

16.3.5 Gray-Scale Operation

The LCDC generates a maximum of 16 gray levels. These gray levels are defined by 2 or 4 bits of display data for each pixel. Using 2 bpp, the LCDC displays 4 shades of gray, and using 4 bpp, the LCDC displays all 16 shades. The shades of gray are obtained by controlling the number of frames in which the pixel is "on" over a period of 16 frames. This method is known as Frame Rate Control (FRC). For more information on FRC, see Section 16.3.7, "Frame Rate Modulation Control (FRC)."

The use of the mapping RAM is shown in Figure 16-6. When using 2 bpp, the 2-bit code is mapped to one of 4 gray levels, and when using 4 bpp, the 4-bit code is mapped to one of 16 gray levels. Because crystal formulations and driving voltages vary, the visual gray effect may or may not be linearly related to the frame rate. A logarithmic scale such as 0, 1/4, 1/2 and 1 might be more pleasing than a linearly spaced scale such as 0, 5/16, 11/16 and 1 for certain graphics.

Figure 16-6 illustrates gray-scale pixel generation. The flexible mapping scheme allows the user to optimize the visual effect for a specific panel or application.

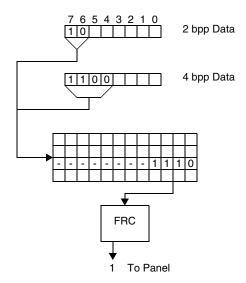


Figure 16-6. Gray-Scale Pixel Generation

16.3.6 Color Generation

The value corresponding to each color pixel on the screen is represented by a 4-, 8-, 12- or 16-bit code in the display memory.

For the 4- and 8- bit modes use the LCDC's color mapping RAM to map the data to a 12-bit RGB code. For passive matrix color displays, 4-bit and 8-bit mode, the 12-bit RGB code from the mapping RAM is output to the FRC blocks that independently process the code corresponding to the red, green, and blue components of each pixel to generate the required shade and intensity.

For active matrix display, the 12-bit output from the mapping RAM is output to the panel.

For 12-bit mode for passive matrix color display, the mapping RAM is by-passed and output directly to the FRC block.

In 16-bit mode, pixel data is simply moved from display memory to the 16-bit LCDC output bus.

For active matrix displays, the 16-bit RGB code from the mapping RAM is output to the panel. For passive color display, the maximum color depth is 12-bit and 16-bit color is not supported.

Figure 16-7 and Figure 16-8 on page 16-10 illustrate passive matrix and active matrix color pixel generation.

16-8 Freescale Semiconductor

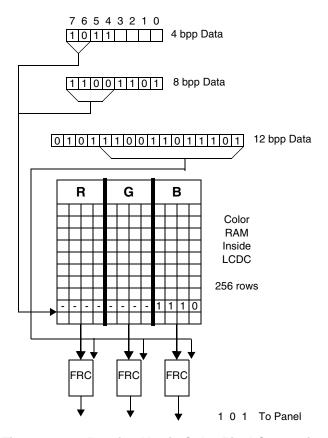


Figure 16-7. Passive Matrix Color Pixel Generation

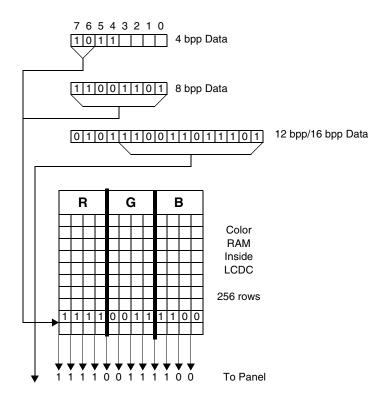


Figure 16-8. Active Matrix Color Pixel Generation

16.3.7 Frame Rate Modulation Control (FRC)

Circuitry inside the LCDC generates intermediate gray-scale colors on the panel by adjusting the density of zeroes and ones that appear over the frames. The LCDC can generate 16 simultaneous gray-scale levels.

Gray Code Density Density (Hexadecimal) (Decimal) 0 1 1/8 0.125 2 1/5 0.2 3 1/4 0.25 $0.\overline{333}$ 4 1/3 5 0.4 2/5 $0.\overline{444}$ 6 4/9 7 1/2 0.5 $0.\overline{555}$ 8 5/9 9 3/5 0.6 Α 2/3 $0.\overline{666}$

Table 16-5. Gray Palette Density

MC9328MXS Reference Manual, Rev. 1

16-10 Freescale Semiconductor

Gray Code (Hexadecimal)	Density	Density (Decimal)						
В	3/4	0.75						
С	4/5	0.8						
D	7/8	0.875						
E	14/15	0.933						
F	1	1						
Note: Overbars indic	Note: Overbars indicate repeating decimal numbers.							

Table 16-5. Gray Palette Density (continued)

16.3.8 Panel Interface Signals and Timing

The LCDC continuously provides pixel data to the LCD panel via the LCD panel interface. Panel interface signals are illustrated in Figure 16-9 on page 16-11.

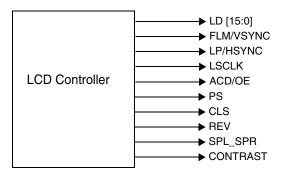


Figure 16-9. LCDC Interface Signals

The format, timing, and polarity of the panel interface signals are programmable. There are two basic modes, passive and active, selected by the TFT register bit. The user must also select either grayscale mode or color mode.

SPL_SPR, PS, CLS, and REV are additional interface signals required for Sharp HR-TFT panels.

16.3.8.1 Pin Configuration for LCDC

Figure 16-9 shows the signals used for the LCDC. These pins are multiplexed with other functions on the device, and must be configured for LCDC operation before they can be used.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Table 16-6. Pin Configuration

Pin	Setting	Configuration Procedure
LD [15:0]	Primary function of GPIO Port D [30:15]	Clear bits [30:15] of Port D GPIO In Use Register (GIUS_D) Clear bits [30:15] of Port D General Purpose Register (GPR_D)
FLM/VSYNC	Primary function of GPIO Port D [14]	Clear bit 14 of Port D GPIO In Use Register (GIUS_D) Clear bit 14 of Port D General Purpose Register (GPR_D)
LP/HSYNC	Primary function of GPIO Port D [13]	Clear bit 13 of Port D GPIO In Use Register (GIUS_D) Clear bit 13 of Port D General Purpose Register (GPR_D)
LSCLK	Primary function of GPIO Port D [6]	Clear bit 6 of Port D GPIO In Use Register (GIUS_D) Clear bit 6 of Port D General Purpose Register (GPR_D)
ACD/OE	Primary function of GPIO Port D [12]	Clear bit 12 of Port D GPIO In Use Register (GIUS_D) Clear bit 12 of Port D General Purpose Register (GPR_D)
CONTRAST	Primary function of GPIO Port D [11]	Clear bit 11 of Port D GPIO In Use Register (GIUS_D) Clear bit 11 of Port D General Purpose Register (GPR_D)
SPL_SPR	Primary function of GPIO Port D [10]	Clear bit 10 of Port D GPIO In Use Register (GIUS_D) Clear bit 10 of Port D General Purpose Register (GPR_D)
PS	Primary function of GPIO Port D [9]	Clear bit 9 of Port D GPIO In Use Register (GIUS_D) Clear bit 9 of Port D General Purpose Register (GPR_D)
CLS	Primary function of GPIO Port D [8]	Clear bit 8 of Port D GPIO In Use Register (GIUS_D) Clear bit 8 of Port D General Purpose Register (GPR_D)
REV	Primary function of GPIO Port D [7]	Clear bit 7 of Port D GPIO In Use Register (GIUS_D) Clear bit 7 of Port D General Purpose Register (GPR_D)

16.3.8.2 Passive Matrix Panel Interface Signals

Figure 16-10 shows the LCD interface timing for monochrome panels and Figure 16-11 shows the LCD interface timing for passive matrix color panels. Signal polarities are shown positive, however it can be reversed by clearing the bits in the Panel Configuration Register (PCR). The data bus timing for passive panels is controlled by the shift clock (LSCLK), line pulse (LP), first line marker (FLM), alternate crystal direction (ACD), and line data (LD) signals. Operation of the panel interface is accomplished in the following steps:

- 1. LSCLK clocks the pixel data into the display driver's internal shift register.
- 2. LP signifies the end of the current line of serial data and latches the shifted pixel data into a wide latch.
- 3. FLM marks the first line of the displayed page. The LD (and the associated LP), enclosed by the FLM signal, marks the first line of the current frame.
- 4. ACD toggles after a pre-programmed number of FLM pulses. This signal refreshes the LCD panel.

NOTE:

The LD bus width is programmable to 1, 2, 4, or 8 bits in monochrome mode (the COLOR bit in the Panel Configuration register is set to 0). Data is justified to the least significant bits of the LD [15:0] bus. Passive color displays use a fixed 2-2/3 pixels of data per 8-bit vector as shown in Figure 16-11 on page 16-13.

MC9328MXS Reference Manual, Rev. 1

16-12 Freescale Semiconductor

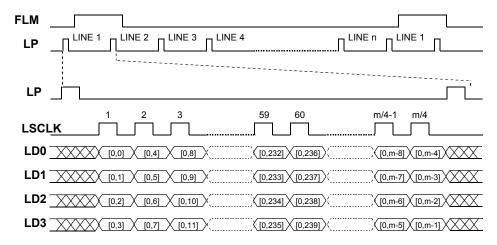


Figure 16-10. LCDC Interface Timing for 4-bit Data Width Gray-Scale Panels

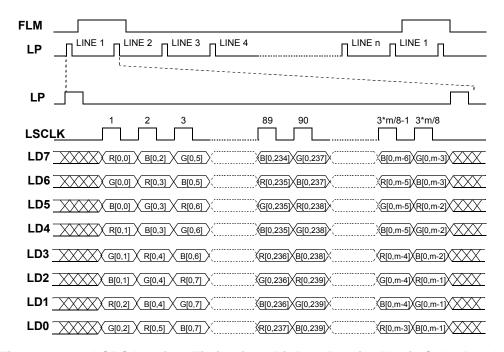


Figure 16-11. LCDC Interface Timing for 8-Bit Data Passive Matrix Color Panels

16.3.8.3 Passive Panel Interface Timing

Figure 16-12 on page 16-14 shows the horizontal timing (timing of one line), including both the line pulse (LP) and the data. The width of LP and delays both before and after LP are programmable. The parameters used for panel interface timing are:

- XMAX (X size) defines the number of pixels per line. XMAX is the total number of pixels per line.
- H WAIT 1 defines the delay from the end of data output to the beginning of LP.
- H_WIDTH (horizontal sync pulse width) defines the width of the FLM pulse, and H_WIDTH must be at least 1.
- H WAIT 2 defines the delay from the end of LP to the beginning of data output.

NOTE:

All parameters are defined in unit of pixel clock period, unless stated otherwise.

16.3.9 8 bpp Mode Color STN Panel

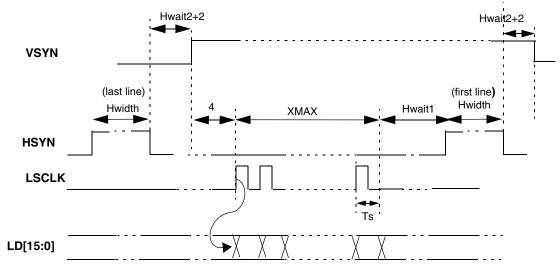


Figure 16-12. Horizontal Sync Pulse Timing in Passive Mode

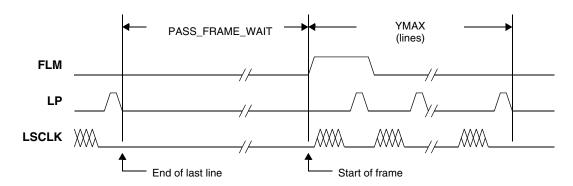


Figure 16-13. Vertical Sync Pulse Timing Passive, Color, (Non-TFT) Mode

16.3.9.1 Active Matrix Panel Interface Signals

Figure 16-14 on page 16-16 shows the LCD interface timing for an active matrix color TFT panel. In this figure signals are shown with negative polarity (FLMPOL=1, LPPOL=1, CLKPOL=0, OEPOL=1). In TFT mode, the LSCLK is automatically inverted. The panel interface timing for active matrix panels is sometimes referred to as a "digital CRT" and is controlled by the shift clock (LSCLK), horizontal sync pulse (HSYNC, the LP pin in passive mode), vertical sync pulse (VSYNC, the FLM pin in passive mode), output enable (OE, the ACD pin in passive mode), and line data (LD) signals. The sequence of events for active matrix interface timing is:

1. LSCLK latches data into the panel on its negative edge (when positive polarity is selected). In active mode, LSCLK runs continuously.

16-14 Freescale Semiconductor

- 2. HSYNC causes the panel to start a new line.
- 3. VSYNC causes the panel to start a new frame. It always encompasses at least one HSYNC pulse.
- 4. OE functions as an output enable signal to the CRT. This output enable signal is similar to the blanking output in a CRT and enables the data to be shifted onto the display. When disabled, the data is invalid and the trace is off.

In 4- and 8-bit mode, the LD [15:12] bits define red, the LD [10:7] bits define green, and the LD [4:1] bits define blue. In 16-bit mode, the LD [15:11] bits define red, the LD [10:5] bits define green, and the LD [4:0] bits define blue.

The actual TFT color channel assignments are shown in Table 16-7. In 4 bpp and 8 bpp, bits LD11, LD6, LD5 and LD0 are fixed at 0.

LD LD LD LD LD LD LD LD LD LD LD LD LD LD LD LD 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0 R3 R2 R1 R0 G3 G2 G1 G0 ВЗ B2 B1 B0 4 bpp R2 R1 B0 R3 R0 G3 G2 G1 G0 ВЗ B2 B1 8 bpp R2 R1 R0 G3 G2 G1 G0 ВЗ B2 B1 B0 12 bpp R4 R3 R2 R1 R0 G5 G4 G3 G2 G1 G0 B4 **B**3 B2 B1 B0 16 bpp

Table 16-7. TFT Color Channel Assignments

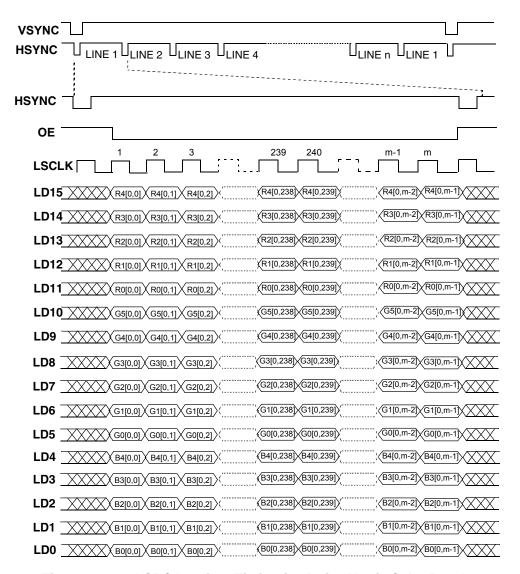


Figure 16-14. LCDC Interface Timing for Active Matrix Color Panels

16.3.9.2 Active Panel Interface Timing

Figure 16-15 on page 16-17 shows the horizontal timing (timing of one line), including both the horizontal sync pulse and the data. The width of HSYNC and delays both before and after HSYNC are programmable. The timing signal parameters are defined as follows:

- H WIDTH defines the width of the HSYNC pulse and must be at least 1.
- H WAIT 2 defines the delay from the end of HSYNC to the beginning of the OE pulse.
- H WAIT 1 defines the delay from end of OE to the beginning of the HSYNC pulse.
- XMAX defines the (total) number of pixels per line.

NOTE:

All parameters are defined in pixel periods, not LSCLK periods.

MC9328MXS Reference Manual, Rev. 1

16-16 Freescale Semiconductor

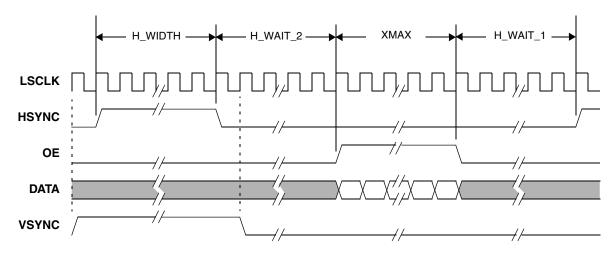


Figure 16-15. Horizontal Sync Pulse Timing in TFT Mode

Figure 16-16 shows the vertical timing (timing of one frame). The delay from the end of one frame until the beginning of the next is programmable. The memory timing signal parameters are:

- V_WAIT_1 is a delay measured in lines. For V_WAIT_1= 1 there is a delay of one HSYNC (time = one line period) before VSYNC. The HSYNC pulse is output during the V_WAIT_1 delay.
- For V_WIDTH (vertical sync pulse width) = 0, VSYNC encloses one HSYNC pulse. For V_WIDTH = 2, VSYNC encloses two HSYNC pulses.
- V_WAIT_2 is a delay measured in lines. For V_WAIT_2 = 1, there is a delay of one HSYNC (time = one line period) after VSYNC. The HSYNC pulse is output during the V_WAIT_2 delay.

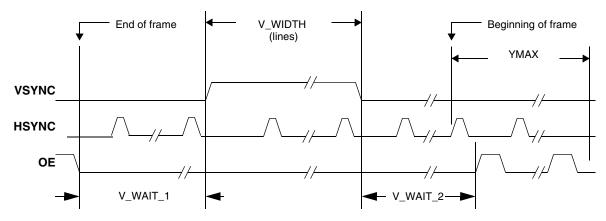


Figure 16-16. Vertical Sync Pulse Timing TFT Mode

16.4 Programming Model

The LCDC memory space contains fifteen 32-bit registers for display parameters, a read-only status register, and a 256 x 12 Color Mapping RAM. The color mapping RAM is physically located inside the Palette Lookup Table module.

Table 16-8 summarizes these registers and their addresses. Only WORD access is supported. Byte and halfword access is undefined.

Table 16-8. LCDC Register Memory Map

Description	Name	Address
Screen Start Address Register	SSA	0x00205000
Size Register	SIZE	0x00205004
Virtual Page Width Register	VPW	0x00205008
LCD Cursor Position Register	CPOS	0x0020500C
LCD Cursor Width Height and Blink Register	LCWHB	0x00205010
LCD Color Cursor Mapping Register	LCHCC	0x00205014
Panel Configuration Register	PCR	0x00205018
Horizontal Configuration Register	HCR	0x0020501C
Vertical Configuration Register	VCR	0x00205020
Panning Offset Register	POS	0x00205024
Sharp Configuration 1 Register	LSCR1	0x00205028
PWM Contrast Control Register	PWMR	0x0020502C
DMA Control Register	DMACR	0x00205030
Refresh Mode Control Register	RMCR	0x00205034
Interrupt Configuration Register	LCDICR	0x00205038
Interrupt Status Register	LCDISR	0x00205040

Figure 16-9 on page 16-19 provides a quick overview of the fields of all the registers. There are intentional gaps between the addresses for the read-write register section and the status register, and between the status register and the mapping RAM.

16-18 Freescale Semiconductor

Table 16-9. Register Memory Mapping Summary

			Tabl	e 16-	9. R	egiste	er Me				Summ	ary						
Register	Register		T.					R	egist	er Bit	s				ı			
Name	Location	31 (15)	30 (14)	29 (13)	28 (12)	27 (11)	26 (10)	25 (9)	24 (8)	23 (7)	22 (6)	21 (5)	20 (4)	19 (3)	18 (2)	17 (1)	16 (0)	
SSA	0x00205000							Screen	Start A	Address	- SSA							
	0.0020000					Sc	reen Sta	art Addr										
SIZE	0x00205004								Sc	reen Wi	dth - XMA							
												Scre	en He	ight - YN	MAX			
VPW	0x00205008							Virtual Page Width - VPW										
		CC1	CC0		OP			Cursor X Position - CXP										
CPOS	0x0020500C							Cursor Y Position - CYP										
LOWILID	000005040	BK_EN				Curso	r Width	- CW						C	ursor He	ight - CH		
LCWHB	0x00205010													BD				
LCHCC	0x00205014																	
		Cı	ursor Red	- CUR_	COL_R	ı		Cursor	Green	- CUR_	_COL_G			Curso	r Blue -	CUR_CC	L_B	
PCR	0x00205018	TFT	PBSIZ BPIX					ixel	PIX POL	FLM POL	LP POL	CLK POL	OE POL	SCLK IDLE	END_ SEL	END_ BYTE_ SWAP	REV_VS	
		ACD SEL	ıgle - AC	D	•	SCLK SEL	SHARP			Pixel Clo	ock Divid	ler - PCD						
HCR	0x0020501C	Н	orizontal S															
					Wait 1 -		T_1					Horiz	ontal \	Nait 2 -	H_WAIT	_2	I	
VCR	0x00205020	,	Vertical Sync Width - V_WIDTH									.,			14/4/-			
				ertical V	Vait 1 - \	/_WAII	_1					Veri	ical W	/ait 2 - V	_WAII_	2		
POS	0x00205024													Pai	nning Of	fset - PO	 S	
			PS_	RISE_[DELAY								CLS_I	RISE_DI				
LSCR1	0x00205028					REV	_TOGG	LE_DEI	AY		Gray					Gray 2		
												С	LS Hi	gh Width	1			
PWMR	0x0020502C	LD MSK					SCR1	SCR0	CC _EN				Pulse	Width -	PW			
DMACR	0x00205030	BURST														НМ		
																TM	ī	
RMCR	0x00205034															LCDC _EN	SELF _REF	
																	=.	
LCDICR	0x00205038														INT SYN		INT CON	
LCDISR	0x00205040													UDR	ERR	EOF	BOF	
														_ERR	_RES			
	0x00205800								Fire	st RAM	Location(F	R [3:0]	, G [3:	0], B [3:0	0])			
	0x00205BFC																	
	0,00200DI C								Las	st RAM	Location(F	R [3:0]	, G [3:	0], B [3:0	0])			

16.4.1 Screen Start Address Register

The Screen Start Address Register specifies the start address of the LCD screen. See Figure 16-2.

SSA	Screen Start Address Register														Addr 0x00205000			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
								SS	A									
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
						SS	A											
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	000									

Table 16-10. Screen Start Address Register Description

Name	Description
SSA Bits 31–2	Screen Start Address of LCD Panel—Holds pixel data for a new frame from the SSA address. This field must start at a location that enables a complete picture to be stored in a 4 Mbyte memory boundary (A [21:0]). A [31:22] has a fixed value for a picture's image.
Reserved Bits 1–0	Reserved—These bits are reserved and should read 0.

16-20 Freescale Semiconductor

16.4.2 Size Register

The Size Register defines the height and width of the LCD screen.

SIZE								Addr 0x00205004								
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
									XIV	IAX						
TYPE	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESEI	0x0000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												YMAX				
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESEI								0x00	000							

Table 16-11. Size Register Description

Name	Description
Reserved Bits 31–26	Reserved—These bits are reserved and should read 0.
XMAX Bits 25–20	Screen Width Divided by 16—Holds screen x-axis size, divided by 16. For black-and-white panels (1 bpp), XMAX [20] is ignored, forcing the x-axis of the screen size to be a multiple of 32 pixels/line.
Reserved Bits 19–9	Reserved—These bits are reserved and should read 0.
YMAX Bits 8–0	Screen Height—Specifies the height of the LCD panel in terms of pixels or lines. The lines are numbered from 1 to YMAX for a total of YMAX lines.

16.4.3 Virtual Page Width Register

The Virtual Page Width Register defines the width of the virtual page for the LCD panel. See Figure 16-2 on page 16-3.

VPW		Virtual Page Width Register														Addr 0x00205008			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
NESET	0x0000																		
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
											V	PW							
TYPE	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw			
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
RESET								0x00	00										

Table 16-12. Virtual Page Width Register Description

Name	Description
Reserved Bits 31–10	Reserved—These bits are reserved and should read 0.
VPW Bits 9–0	Virtual Page Width—Defines the virtual page width of the LCD panel. The VPW bits represent the number of 32-bit words required to hold the data for one virtual line. VPW is used in calculating the starting address representing the beginning of each displayed line.

16.4.4 Panel Configuration Register

The Panel Configuration Register defines all of the properties of the LCD screen.

PCR		Panel Configuration Register														
BIT	31	30	30 29 28 27 26 25 24 23 22 21 20 19 18												17	16
	TFT	COLOR	PBSIZ BPIX					PIX POL	FLM POL	LP POL	CLK POL	OE POL	SCLK IDLE	END_ SEL	SWAP_SEL	REV_ VS
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r	r	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NLOLI										0x0000						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	ACD SEL			,	ACD				SCLK SEL	SHARP				PCD		
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET										0x0000						

Table 16-13. Panel Configuration Register Description

Name	Description	Settings
TFT Bit 31	Interfaces to TFT Display—Controls the format and timing of the output control signals. Active and passive displays use different signal timing formats as described in Section 16.3.8, "Panel Interface Signals and Timing." TFT also controls the use of the FRC in color mode.	0 = The LCD panel is a passive display 1 = The LCD panel is an active display: "digital CRT" signal format, FRC is bypassed, LD bus width is fixed at 16-bits
COLOR Bit 30	Interfaces to Color Display—Activates three channels of FRC in passive mode to allow use of the special 2 2/3 pixels per output vector format.	0 = The LCD panel is a monochrome display 1 = The LCD panel is a color display Note: For a TFT panel, set COLOR=1
PBSIZ Bits 29–28	Panel Bus Width—Specifies the panel bus width. Applicable for monochrome or passive matrix color monitors. For active (TFT) color panels, the panel bus width is fixed at 16. For passive color panels, only an 8-bit panel bus width is supported.	00 = 1-bit 01 = 2-bit 10 = 4-bit 11 = 8-bit
BPIX Bits 27–25	Bits Per Pixel—Indicates the number of bits per pixel in memory.	000 = 1 bpp, FRC bypassed 001 = 2 bpp 010 = 4 bpp 011 = 8 bpp 100 = 12 bpp/16 bpp (16 bits of memory used) 11x = reserved 1x1 = reserved
PIXPOL Bit 24	Pixel Polarity—Sets the polarity of the pixels.	0 = Active high 1 = Active low

Table 16-13. Panel Configuration Register Description (continued)

Name	Description	Settings
FLMPOL Bit 23	First Line Marker Polarity—Sets the polarity of the first line marker symbol.	0 = Active high 1 = Active low
LPPOL Bit 22	Line Pulse Polarity—Sets the polarity of the line pulse signal.	0 = Active high 1 = Active low
CLKPOL Bit 21	LCD Shift Clock Polarity—Sets the polarity of the active edge of the LCD shift clock.	0 = Active negative edge of LSCLK (in TFT mode, active on positive edge of LSCLK) 1 = Active positive edge of LSCLK (in TFT mode, active on negative edge of LSCLK)
OEPOL Bit 20	Output Enable Polarity—Sets the polarity of the output enable signal.	0 = Active high 1 = Active low
SCLKIDLE Bit 19	LSCLK Idle Enable—Enables/Disables LSCLK when VSYNC is idle in TFT mode.	0 = Disable LSCLK 1 = Enable LSCLK
END_SEL Bit 18	Endian Select—Selects the image download into memory as big or little endian format.	0 = Little endian 1 = Big endian
SWAP_SEL Bit 17	Swap Select—Controls the swap of data in little endian mode (when END_SEL = 1 this bit has no effect).	0 = 16 bpp mode 1 = 8 bpp. 4 bpp, 2 bpp, 1 bpp mode
REV_VS Bit 16	Reverse Vertical Scan—Selects the vertical scan direction as normal or reverse (the image flips along the x-axis). The SSA register must be changed accordingly.	0 = Vertical scan in normal direction 1 = Vertical scan in reverse direction
ACDSEL Bit 15	ACD Clock Source Select—Selects the clock source used by the alternative crystal direction counter.	0 = Use FRM as clock source for ACD count 1 = Use LP/HSYN as clock source for ACD count
ACD Bits 14–8	Alternate Crystal Direction—Toggles the ACD signal once every 1-16 FLM cycles based on the value specified in this field. The actual number of FLM cycles between toggles is the programmed value plus one.	For active mode (TFT=1), this parameter is not used. For passive mode (TFT=0), see description.
SCLKSEL Bit 7	LSCLK Select—Selects whether to enable or disable LSCLK in TFT mode when there is no data output.	0 = Disable OE and LSCLK in TFT mode when no data output 1 = Always enable LSCLK in TFT mode even if there is no data output
SHARP Bit 6	Sharp Panel Enable—Enables/Disables signals for Sharp HR-TFT panels.	0 = Disable Sharp signals 1 = Enable Sharp signals

16-24 Freescale Semiconductor

Table 16-13. Panel Configuration Register Description (continued)

Name	Description	Settings
PCD Bits 5–0	Pixel Clock Divider—Specifies the divide ratio applied to LCDC_CLK. The LCDC_CLK (PerCLK2) is divided down by the Pixel Clock Divider to generate the pixel clock. The LSCLK will be the same as pixel clock in TFT mode, and will be 1/8 the frequency of the pixel clock in passive mode. For passive displays (TFT bit = 0), the frequency of LSCLK must be < 1/9 HCLK at 12 bpp and < 1/15 HCLK	TFT (TFT bit = 1) 000000 = divide ratio is 1 000001 = divide ratio is 2 000010 = divide ratio is 3 111111 = divide ratio is 64 Passive (TFT bit = 0) 000000 = divide ratio is 8 ¹
	at 4 or 8 bpp. For passive matrix color panels (COLOR = 1 and PBSIZ = 11), PCD must be ≥ 2 and PCLK_DIV2 (PCDR Register) must = 0 (divide by 1). See Phase-Locked Loop and Clock Controller chapter in this manual for PCDR register information.	000001 = divide ratio is 16 ¹ 000010 = divide ratio is 24 111111 = divide ratio is 512
	For active displays (TFT bit = 1), the frequency of LSCLK must be < 1/5 HCLK. When PCD = 0, the pixel clock frequency is equal to the LCDC_CLK frequency.	Note 1: Do not use. For passive panels, PCD must be greater than or equal to 2 or 000010.
	See application notes at http:\\www.freescale.com\imx.	

16.4.5 Horizontal Configuration Register

The Horizontal Configuration Register defines the horizontal sync pulse timing.

HCR		Horizontal Configuration Register													Addr 0x0020501C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
			H_W	IDTH														
TYPE	rw	rw	rw	rw	rw	rw	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0		
NESEI	0x0400																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
				H_WA	AIT_1							H_W	/AIT_2					
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESEI								0x00	000									

Table 16-14. Horizontal Configuration Register Description

Name	Description
H_WIDTH Bits 31–26	Horizontal Sync Pulse Width—Specifies the number of pixel clk periods that HSYNC is activated. The active time is equal to (H_WIDTH + 1) of the pixel clk period. For Sharp HR-TFT panels, H_WIDTH is typically set to 1.
Reserved Bits 25–16	Reserved—These bits are reserved and should read 0.
H_WAIT_1 Bits 15–8	Wait Between OE and HSYNC—Specifies the number of pixel clk periods between the last LD of each line and the beginning of the HSYNC. Total delay time equals (H_WAIT_1 + 1). For Sharp HR-TFT panels, H_WAIT_1 is typically set to 14.
H_WAIT_2 Bits 7–0	Wait Between HSYNC and Start of Next Line—Specifies the number of pixel clk periods between the end of HSYNC and the beginning of the first data of next line. Total delay time equals (H_WAIT_2 + 3).

16-26 Freescale Semiconductor

16.4.6 Vertical Configuration Register

The Vertical Configuration Register defines the vertical sync pulse timing.

VCR	Vertical Configuration Register														Addr 0x00205020						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16					
			V_W	IDTH																	
TYPE	rw	rw	rw	rw	rw	rw	r	r	rw	rw	rw	rw	rw	rw	rw	rw					
RESET	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	1					
HESET								0x04	01												
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0					
				V_WA	AIT_1							V_W	/AIT_2								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw					
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0					
NESEI								0x00	000												

Table 16-15. Vertical Configuration Register Description

Name	Description
V_WIDTH Bits 31–26	Vertical Sync Pulse Width—Specifies the width, in lines, of the VSYNC pulse for active (TFT =1) mode. For a value of "000001", the vertical sync pulse encompasses one HSYNC pulse. For a value of "000002", the vertical sync pulse encompasses two HSYNC pulses, and so on. For passive (TFT=0) mode and non-color mode, see Figure 16-12.
Reserved Bits 25–16	Reserved—These bits are reserved and should read 0.
V_WAIT_1 Bits 15–8	Wait Between Frames 1—Defines the delay, in lines, between the end of the OE pulse and the beginning of the VSYNC pulse for active (TFT=1) mode. This field has no meaning in passive non-color mode. The actual delay is (V_WAIT_1). In passive color mode, this field is the delay, measured in virtual clock periods, between the last line of the frame to the beginning of the next frame.
V_WAIT_2 Bits 7–0	Wait Between Frames 2—Defines the delay, in lines, between the end of the VSYNC pulse and the beginning of the OE pulse of the first line in active (TFT=1) mode. The actual delay is V_WAIT_2) lines. Set this field to zero for passive non-color mode. The minimum value of this field is 0x01.

16.4.7 Panning Offset Register

The Panning Offset Register sets up the panning for the image.

POS	Panning Offset Register															Addr 0x00205024				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16				
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r				
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0				
HLOLI	0x0000																			
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0				
														POS						
TYPE	r	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw				
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0				
NESEI								0x00	00											

Table 16-16. Panning Offset Register Description

Name	Description	Settings								
Reserved Bits 31–5	Reserved—These bits are reserved and should read 0.									
POS	Panning Offset—Defines the number of bits that the	To achieve panning of the final image by N bits:								
Bits 4–0	data from memory is panned to the left before processing. POS is read by the LCDC once at the beginning of each frame.		Bits Per Pixel	POS	Effective # of Bits Panned on Image					
			1	N	N					
			2	2N	N					
			4	4N	N					
			8	8N	N					
			12	16N	N					

16.4.8 LCD Cursor Position Register

The LCD Cursor Position Register is used to determine the starting position of the cursor on the LCD panel.

CPOS	S LCD Cursor Position Register														Addr 0x0020500C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
	C	C		OP														
TYPE	rw	rw	r	rw	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HEGET	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
												CYP						
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
TILOLI								0x0	000									

Table 16-17. LCD Cursor X Position Register Description

Name	Description	Settings
CC Bits 31–30	Cursor Control—Controls the format of the cursor and the type of arithmetic operations.	When OP = 0 00 = Transparent, cursor is disabled 01 = Full cursor (Black for non-color displays; full-color for color displays) 10 = Reversed video 11 = Full (white) cursor When OP = 1, and color mode 00 = Transparent, cursor is disabled 01 = OR between background and cursor 10 = XOR between background and cursor 11 = AND between background and cursor
Reserved Bit 29	Reserved—This bit is reserved and should read 0.	
OP Bit 28	Arithmetic Operation Control—Enables/Disables arithmetic operations between the background and the cursor.	0 = Disable arithmetic operation 1 = Enable arithmetic operation
Reserved Bits 27–26	Reserved—These bits are reserved and should read 0.	
CXP Bits 25–16	Cursor X Position—Represents the cursor's horizontal starti	ing position X in pixel count (from 0 to XMAX).
Reserved Bits 15–9	Reserved—These bits are reserved and should read 0.	
CYP Bits 8–0	Cursor Y Position—Represents the cursor's vertical starting	position Y in pixel count (from 0 to YMAX).

MC9328MXS Reference Manual, Rev. 1

16.4.9 LCD Cursor Width Height and Blink Register

The LCD Cursor Width Height and Blink Register is used to determine the width and height of the cursor, and how it blinks.

LCWF	3														Addr 0x00205010			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
	BK_EN					CW								СН				
TYPE	rw	r	r	rw	rw	rw	rw	rw	r	r	r	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	1		
NESET	0X0101																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
												E	3D					
TYPE	r	r	r	r	r	r	r	r	rw	rw								
RESET	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1		
NESEI								0X00	7F									

Table 16-18. LCD Cursor Width Height and Blink Register Description

Name	Description	Settings
BK_EN Bit 31	Blink Enable—Determines whether the blink enable cursor will blink or remain steady.	0 = Blink is disabled 1 = Blink is enabled
Reserved Bits 30–29	Reserved—These bits are reserved and should read 0.	
CW Bits 28–24	Cursor Width—Specifies the width of the hardware cursor in pixels.	This field can be any value between 1 and 31 (setting this field to zero disables the cursor)
Reserved Bits 23–21	Reserved—These bits are reserved and should read 0.	
CH Bits 20–16	Cursor Height—Specifies the height of the hardware cursor in pixels.	This field can be any value between 1 and 31 (setting this field to zero disables the cursor)
Reserved Bits 15–8	Reserved—These bits are reserved and should read 0.	
BD Bits 7–0	Blink Divisor—Sets the cursor blink rate. A 32 Hz clock from F the counter value equals BD, the cursor toggles on/off.	RTC is used to clock the 8-bit up counter. When

MC9328MXS Reference Manual, Rev. 1

16.4.10 LCD Color Cursor Mapping Register

The LCD Color Cursor Mapping Register defines the color of the cursor in passive or TFT color modes.

LCHC	С		LCD Color Cursor Mapping Register												Addr 0x00205014			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET		0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
		CU	IR_COL	_R				CUR_C	COL_G				Cl	JR_COL	B			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESEI								0x00	000									

Table 16-19. LCD Color Cursor Mapping Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
CUR_COL_R Bits 15–11	Cursor Red Field—Defines the red component of the cursor color in color mode.	For 8 bpp/12 bpp: 0000x = No red 1111x = Full red For 16 bpp: 00000 = No red 11111 = Full red
CUR_COL_G Bits 10–5	Cursor Green Field—Defines the green component of the cursor color in color mode.	For 8 bpp/12 bpp: 0000xx = No green 1111xx = Full green For 16 bpp: 000000 = No green 111111 = Full green
CUR_COL_B Bits 4–0	Cursor Blue Field—Defines the blue component of the cursor color in color mode.	For 8 bpp/12 bpp: 0000x = No blue 1111x = Full blue For 16 bpp: 00000 = No blue 11111 = Full blue

16.4.11 Sharp Configuration 1 Register

For 2 bpp modes, full black and full white are the two predefined display levels. The other two intermediate gray-scale shading densities can be adjusted within the Sharp Configuration 1 Register. This register also controls the relative delay timing of the additional signals CLS, REV, and PS required for Sharp TFT displays. The TFT timing diagram that shows the relationship between these signals is shown in Figure 16-17 on page 16-33.

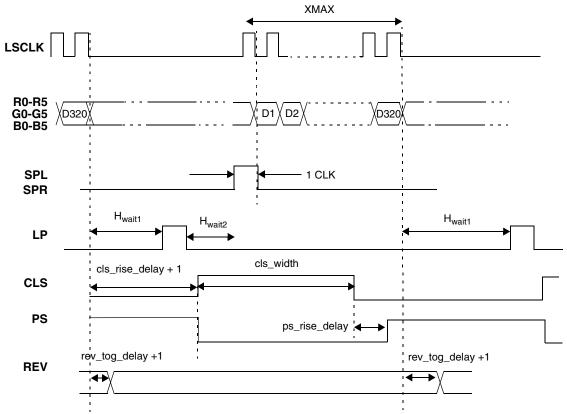
LSCR	1				Sh	arp C	p Configuration 1 Register								0x00205028			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
		F	PS_RISE	_DELA	′				CLS_RISE_DELAY									
TYPE	rw	rw	rw	rw	rw	rw	r	r	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0		
TILOLI	0x0400																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
					RE\	/_TOGO	GLE_DEI	LAY		GRA	AY 2			GRA	GRAY 1			
TYPE	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	1	1	0	1	1	1	0	0	1	1		
0x0373																		

Table 16-20. Sharp Configuration 1 Register Description

Name	Description	Settings
PS_RISE_DELAY Bits 31–26	PS Rise Delay—Controls the delay of the rising edge of PS relative to the falling edge of CLS. Delay is measured in LCDC_CLK (PerCLK2) periods.	000000 = 0 LSCLK periods 000001 = 1 LSCLK period 111111 = 63 LSCLK periods
Reserved Bits 25–24	Reserved—These bits are reserved and should read 0.	
CLS_RISE_DELAY Bits 23–16	CLS Rise Delay—Controls the delay of the rising edge of CLS relative to the last LD of the line. Delay is measured in LCDC_CLK (PerCLK2) periods.	00000000 = 1 LSCLK period 00000001 = 2 LSCLK periods 11111111 = 256 LSCCLK periods
Reserved Bits 15–12	Reserved—These bits are reserved and should read 0.	
REV_TOGGLE_DELAY Bits 11-8	REV Toggle Delay—Controls the transition delay of REV relative to the last LD of the line. Delay is measured in LCDC_CLK (PerCLK2) periods.	0000 = 1 LSCLK period 0001 = 2 LSCLK periods 1111 = 16 LSCLK periods
GRAY 2 Bits 7–4	Gray-Scale 2 —Represents one of the two gray-scale shading densities.	This field is programmable to any value between 0 and 16 (0 and 16 are defined as two of the four colors).
GRAY 1 Bits 3–0	Gray-Scale 1 —Represents the other gray-scale shading.	This field is programmable to any value between 0 and 16 (0 and 16 are already defined as two of the four colors).

MC9328MXS Reference Manual, Rev. 1

16-32 Freescale Semiconductor



Falling edge of PS aligns with rising edge of CLS
The rising edge delay of PS is programmed by PS_RISE_DELAY
CLS_HI_WIDTH is equal to PWM_SCR0 • 256 + PWM_WIDTH in units of LSCLK.
SPL/SPR pulse width is fixed and aligned to the first data of the line.
REV toggles every LP period.

Figure 16-17. Horizontal Timing in MC9328MXS

16.4.12 PWM Contrast Control Register

The PWM Contrast Control Register is used to control the signal output at the CONTRAST pin, which controls the contrast of the LCD panel.

PWMR F				PW	WM Contrast Control Register							Addr 0x0020502C				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
		CLS					CLS_	_HI_WIDTH								
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x0000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	LDMSK					SC	CR	CC_EN				Р	W			
TYPE	rw	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
								0x0000								

Table 16-21. PWM Contrast Control Register Description

Name	Description	Settings					
Reserved Bits 31–25	Reserved—These bits are reserved and should read 0.						
CLS_HI_ WIDTH Bit 24–16	CLS High Pulse Width—Controls the Hi Pulse width of CLS in units of SCLK. The actual pulse width = CLS_HI_WDITH +1.						
LDMSK Bit 15	LD Mask—Enables/Disables the LD outputs to zero for panel power-off sequence as required by Sharp TFT or other panels.	0 = LD [15:0] is normal 1 = LD [15:0] always equals 0					
Reserved Bits 14–11	Reserved—These bits are reserved and should read 0.						
SCR Bits 10–9	Source Select —Selects the input clock source for the PWM counter. The PWM output frequency is equal to the frequency of the input clock divided by 256.	00 = Line pulse 01 = Pixel clock 10 = LCD clock 11 = Reserved					
CC_EN Bit 8	Contrast Control Enable—Enables/Disables the contrast control function.	0 = Contrast control is off 1 = Contrast control is on					
PW Bits 7–0	Pulse-Width—Controls the pulse-width of the built-in pulse-width modulator, which controls the contrast of the LCD screen.						

16-34 Freescale Semiconductor

16.4.13 Refresh Mode Control Register

The Refresh Mode Control Register is used to control refresh characteristics.

RMCF	R Refresh Mode Control Register												Addr 0x00205034			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NEGET									0x000	0						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
															LCDC_EN	SELF_REF
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HLSEI									0x000	0						

Table 16-22. Refresh Mode Control Register Description

Name	Description	Settings				
Reserved Bits 31–2	Reserved—These bits are reserved and should read 0.					
LCDC_EN Bit 1	LCDC Enable—Enables/Disables the LCDC.	0 = Disable the LCDC 1 = Enable the LCDC				
SELF_REF Bit 0	Self-Refresh—Enables/Disables self-refresh mode.	0 = Disable self-refresh 1 = Enable self-refresh				

NOTE:

- 1. On entering self-refresh mode, the LSCLK and LD [15:0] signals stay low. HYSN and VSYN operate normally.
- 2. Except for the SSA and Mapping RAM registers, all configurations must be performed before enabling the LCDC to avoid a malfunction.
- 3. The SSA must always match the address range of the RAM selected. If the user wants to switch between various types of RAM, the LCDC must be disabled before switching.

Freescale Semiconductor 16-35

16.4.14 DMA Control Register

There is a 16×32 bit line buffer in the LCDC that stores DMA data from system memory. The DMA Control Register controls the DMA burst length and when to trigger a DMA burst in terms of the number of data bytes left in the pixel buffer.

DMAC	CR	DMA Control Register										Addr 0x00205030				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	BURST													Н	М	
TYPE	rw	r	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw
RESET	1	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0
NESET								0x800	8							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
														Т	М	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
NESEI								0x000)2							

Table 16-23. DMA Control Register Description

Name	Description Settings							
BURST Bit 31	Burst Length—Determines whether the burst length is fixed or dynamic.0 = Burst length is dynamic 1 = Burst length is fixed							
Reserved Bits 30–20	Reserved—These bits are reserved and should read 0.							
HM Bits 19–16	DMA High Mark —Establishes the high mark for DMA requests. For dynamic burst length, once the DMA request is made, data is loaded and the pixel buffer continues to be filled until the number of empty words left in the DMA FIFO is equal to the high mark minus 2. For fixed burst length, the burst length (in words) of each request is equal to the DMA high mark setting.							
Reserved Bits 15–4	Reserved—These bits are reserved and should read 0.							
TM Bits 3–0	DMA Trigger Mark —Sets the low level mark in the pixel buffer to trigger a DMA request. The low level mark equals the number of words left in the pixel buffer.							

NOTE:

For SDRAM access, a fixed burst length of 8 is recommended

fixed burst length = 1

high mark = 8

low mark = 4

For bus that is heavy loaded that requires SDRAM access, a dynamic burst length

is recommended

fixed burst length = 0

MC9328MXS Reference Manual, Rev. 1

16-36 Freescale Semiconductor

high mark = 3 low mark = 8

For an especially heavily loaded system, increasing the low mark value increases the chance of granting of the system bus, at the expense of more frequent bus requests.

The low mark should never be set higher than 10, and high mark should always be set to 3.

16.4.15 Interrupt Configuration Register

The Interrupt Configuration Register is used to configure the interrupt conditions.

LCDIC	CR	Interrupt Configuration Register										(Addr 0x00205038			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								(0000X							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
														INT SYN		INT CON
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	rw	r	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NLOEI								(0x0000							

Table 16-24. Interrupt Configuration Register Description

Name	Description	Settings
Reserved Bits 31–3	Reserved—These bits are reserved and should read 0.	
INTSYN Bit 2	Interrupt Source—Determines if an interrupt flag is set during last data/first data of frame loading or on last data/first data of frame output to the LCD panel. Note: There is a latency between loading the last/first data of frame to output to LCD panel.	0 = Interrupt flag is set on loading the last data/first data of frame from memory 1 = Interrupt flag is set on output of the last data/first data of frame to LCD panel
Reserved Bit 1	Reserved—This bit is reserved and should read 0.	
INTCON Bit 0	Interrupt Condition—Determines if an interrupt condition is set at the beginning or the end of frame condition.	0 = Interrupt flag is set when the End of Frame (EOF) is reached 1 = Interrupt flag is set when the Beginning of Frame (BOF) is reached

Freescale Semiconductor 16-37

16.4.16 Interrupt Status Register

The read-only Interrupt Status Register indicates whether an interrupt has occurred. The interrupt flag is cleared by reading the register.

LCDIS	R	Interrupt Status Register												Addr 0x00205040			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
								0x00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
													UDR_ ERR	ERR_ RES	EOF	BOF	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
TILOLI								0x00	00								

Table 16-25. Interrupt Status Register Description

Name	Description	Settings
Reserved Bits 31–4	Reserved—These bits are reserved and should read 0.	
UDR_ERR Bit 3	Under Run Error—Indicates whether the LCDC FIFO has hit an under-run condition. This is when the data output rate is faster than the data input rate to the FIFO. Under-run can cause erroneous data output to LD. The LD data output rate must be adjusted to prevent this error.	0 = Interrupt has not occurred 1 = Interrupt has occurred
ERR_RES Bit 2	Error Response —Indicates whether the LCDC has issued a read data request and has received a response from the memory controller not equal to 'OK.' It is cleared by reading the status register, at power on reset, or when the LCDC is disabled.	0 = Interrupt has not occurred 1 = Interrupt has occurred
EOF Bit 1	End of Frame —Indicates whether the end of frame has been reached. It is cleared by reading the status register, at power on reset, or when the LCDC is disabled.	0 = Interrupt has not occurred 1 = Interrupt has occurred
BOF Bit 0	Beginning of Frame —Indicates whether the beginning of frame has been reached. It is cleared by reading the status register, at power on reset, or when the LCDC is disabled.	0 = Interrupt has not occurred 1 = Interrupt has occurred

MC9328MXS Reference Manual, Rev. 1

16.4.17 Mapping RAM Registers

The mapping RAM is used for mapping 4-bit codes for grayscale to the 16 gray shades, and for mapping 4- or 8-bit color codes to either the 4096 (for active panels) or 512 colors (for passive panels). The color RAM (0x00205800-0x00205BFC) contains 256 entries and each entry is 12 bits wide. Each RAM entry use 4 bytes of address space. The RAM can be accessed with word transactions only and the address must be word aligned. Unimplemented bits are read as 0. Byte or halfword access to the RAM corrupts its contents. All read/write data use least significant twelve bits.

In 4 bpp mode, the first sixteen RAM entries are used. In 8 bpp mode, all 256 RAM entries are used. The color RAM is not initialized at reset. With any given panel, only one of the following settings is valid:

- 1 bpp monochrome mode
- 4 bpp gray-scale mode
- 4 bpp passive matrix color mode
- 8 bpp passive matrix color mode
- 4 bpp active matrix color mode
- 8 bpp active matrix color mode
- 12/16 bpp active matrix color mode

16.4.17.1 One Bit/Pixel Monochrome Mode

The mapping RAM is not used in this mode because the LCDC uses the display data in memory to drive the panel directly.

16.4.17.2 Four Bits/Pixel Gray-Scale Mode

In four bits/pixel gray-scale mode, a 4-bit code represents a gray-scale level. The first 16 mapping RAM entries must be written to define the codes for all 16 combinations.

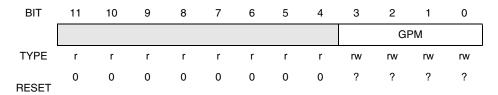


Table 16-26. Four Bits/Pixel Gray-Scale Mode

Name	Description
Reserved Bits 11–4	Reserved—These bits are reserved and should read 0.
GPM Bits 3–0	Gray Palette Map—Represents the gray-scale level for a given pixel code.

Freescale Semiconductor 16-39

16.4.17.3 Four Bits/Pixel Passive Matrix Color Mode

In four bits/pixel passive matrix color mode, a 4-bit code represents a 12-bit color. Because just four bits are used to encode the color, a maximum of 16 colors can be selected out of a palette of 4096. The first 16 mapping RAM entries must be written to define the codes for the 16 available combinations.

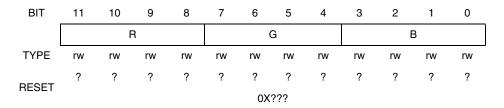


Table 16-27. Four Bits/Pixel Passive Matrix Color Mode

Name	Description
R Bits 11–8	Red Level (color display)—Represents the red component level in the color.
G Bits 7–4	Green Level (color display)—Represents the green component level in the color.
B Bits 3–0	Blue Level (color display)—Represents the blue component level in the color.

16.4.17.4 Eight Bits/Pixel Passive Matrix Color Mode

In eight bits/pixel passive matrix color mode, an 8-bit code represents a 12-bit color. Because eight bits are used to encode the color, a maximum of 256 colors can be selected out of a palette of 4096. All 256 mapping RAM entries must be written to define the codes for the 256 available combinations.

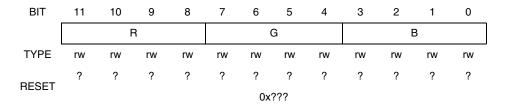


Table 16-28. Eight Bits/Pixel Passive Matrix Color Mode

Name	Description
R Bits 11–8	Red Level (color display)—Represents the red component level in the color.
G Bits 7–4	Green Level (color display)—Represents the green component level in the color.
B Bits 3–0	Blue Level (color display)—Represents the blue component level in the color.

16-40 Freescale Semiconductor

16.4.17.5 Four Bits/Pixel Active Matrix Color Mode

In four bits/pixel active color mode, a 4-bit code represents a 12-bit color. Because just four bits are used to encode the color, a maximum of 16 colors can be selected out of a palette of 4096. The first 16 mapping RAM entries must be written to define the codes for the 16 available combinations.

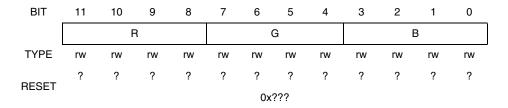


Table 16-29. Four Bits/Pixel Active Matrix Color Mode

Name	Description
R Bits 11–8	Red Level (color display)—Represents the red component level in the color.
G Bits 7–4	Green Level (color display)—Represents the green component level in the color.
B Bits 3–0	Blue Level (color display)—Represents the blue component level in the color.

16.4.17.6 Eight Bits/Pixel Active Matrix Color Mode

In eight bits/pixel active color mode, an 8-bit code represents a 12-bit color. Because eight bits are used to encode the color, a maximum of 256 colors can be selected out of a palette of 4096. All 256 mapping RAM entries must be written to define the codes for the 256 available combinations.

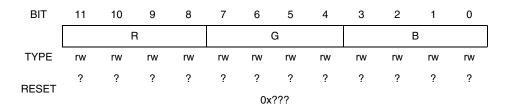


Table 16-30. Eight Bits/Pixel Active Matrix Color Mode

Name	Description
R Bits 11–8	Red Level (color display)—Represents the red component level in the color.
G Bits 7–4	Green Level (color display)—Represents the green component level in the color.
B Bits 3–0	Blue Level (color display)—Represents the blue component level in the color.

16.4.17.7 Twelve Bits/Pixel and Sixteen Bits/Pixel Active Matrix Color Mode

In this mode the mapping RAM is not used, because the LCDC uses the display data in memory to drive the panel directly.

16-42 Freescale Semiconductor

Chapter 17 Pulse-Width Modulator (PWM)

The pulse-width modulator (PWM) of the MC9328MXS is optimized to use 16-bit resolution and a 4×16 data FIFO to generate high quality sound from stored audio files and to generate tones. Figure 17-1 illustrates the block diagram of the pulse-width modulator.

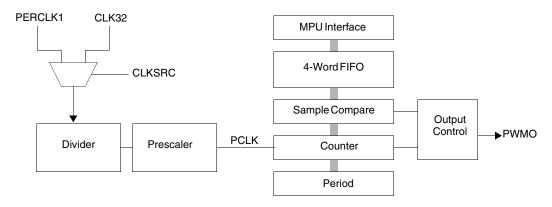


Figure 17-1. Pulse-Width Modulator Block Diagram

17.1 Introduction

The PWM can be programmed to select one of two clock signals as its source frequency. The selected clock signal is passed through a divider and a prescaler before being input to the counter. The output is available at the pulse-width modulator output (PWMO) external pin.

17.2 PWM Signals

17.2.1 Clock Signals

As shown in Figure 17-1, the clock source (CLKSRC) bit in the PWM control (PWMC) register selects the source clock—PERCLK1 (the default) or CLK32—to be used by the PWM. The selected clock signal is then sent through a divider and a prescaler to produce the PCLK signal.

The clock selection (CLKSEL) field in the PWMC selects the frequency of the output of the divider chain. The incoming clock source is divided by a binary value between 2 and 16.

For 16 kHz audio applications, CLKSEL = 01, divide by 4. For DC-level applications, CLKSEL = 11, divide by 16. See Table 17-7 on page 17-8 for a complete list of settings for the PWMC register.

PWM Operation

Adjust the 7-bit prescaler to achieve lower sampling rates by programming the PRESCALER field in the PWMC register with any number between 0 and 127 to scale down the incoming clock source by a corresponding factor of 1 to 128.

17.2.2 Pin Configuration for PWM

Figure 17-1 shows the signals used for the PWM module. The PWMO pin is multiplexed with other functions on the device, and must be configured for PWM operation. Table 17-1 describes the procedure for the PWM pin configuration.

NOTE:

The user must ensure that the data direction bit in the GPIO is set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Pin	Setting	Configuration Procedure
PWMO	Primary function of GPIO Port A [2]	1.Clear bit 2 of Port A GPIO In Use register (GIUS_A) 2. Clear bit 2 of Port A General Purpose register (GPR_A)

Table 17-1. Pin Configuration

17.3 PWM Operation

The pulse-width modulator has three modes of operation—playback, tone, and digital-to-analog (D/A) converter.

17.3.1 Playback Mode

In playback mode, the pulse-width modulator uses the data from a sound file to output the resulting audio through an external speaker. To reproduce the best quality of sound from a sound file, it is necessary to use a sampling frequency that is equal to or an even multiple of the sampling frequency used to record the sound.

The PWM produces variable-width pulses at a constant frequency. The width of the pulse is proportional to the analog voltage of a particular audio sample. At the beginning of a sample period cycle, the PWMO pin is set to 1 and the counter begins counting up from 0x0000. The sample value is compared on each count of the prescaler clock. When the sample and count values match, the PWMO signal is cleared to 0. The counter continues counting, and when it overflows from 0xFFFF to 0x0000, another sample period cycle begins. The prescaler clock (PCLK) runs 256 times faster than the sampling rate when the PERIOD field of the PWM period (PWMP) register is at its maximum value.

Figure 17-2 illustrates how variable width pulses affect an audio waveform.

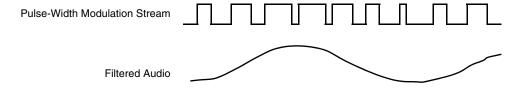


Figure 17-2. Audio Waveform Generation

MC9328MXS Reference Manual, Rev. 1

17-2 Freescale Semiconductor

Digital sample values are loaded into the pulse-width modulator as 16-bit words (big endian format). A 4-word FIFO minimizes interrupt overhead. A maskable interrupt is generated when there are 1 or 0 words in the FIFO, in which case the software can write two 16-bit samples into the FIFO. Interrupts occur every 50 μ s, if the REPEAT field of the PWMC register is set to 0, when a 16 kHz sampling frequency is being used to play back sampled data, when writing two 16-bit data at each interrupt.

17.3.2 Tone Mode

When the value stored in the PWMP register < 0xFFFE, the PWM operates in tone mode and generates a continuous tone at a single frequency which is determined by the settings in the PWM registers.

17.3.3 Digital-to-Analog Converter (D/A) Mode

The pulse-width modulator outputs a frequency with a different pulse width if a low-pass filter is added at the PWMO signal. It produces a different DC level when programmed using the sample fields in the PWM sample (PWMS) register. When used in this manner, the PWM becomes a D/A converter.

17.4 Programming Model

The PWM module includes 4 user-accessible 32-bit registers. Table 17-2 summarizes these registers and their addresses.

Description	Name	Address				
PWM Control Register	PWMC	0x00208000				
PWM Sample Register	PWMS	0x00208004				
PWM Period Register	PWMP	0x00208008				
PWM Counter Register	PWMCNT	0x0020800C				

Table 17-2. PWM Module Register Memory Map

17.4.1 PWM Control Register

The PWM Control Register controls the operation of the pulse-width modulator, and it also contains the status of the PWM FIFO. The register bit assignments are shown in the following register display. The register settings are described in Table 17-3 on page 17-4.

Freescale Semiconductor 17-3

PWMC		S														Addr 0x00208000			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
														HCTR	BCTR	SWR			
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	rw	rw	rw			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
TILOLI								0x00	000										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
	CLK SRC			PF	RESCAL	ER			IRQ	IRQ EN	FIFO AV	EN	REF	PEAT	CLK	SEL			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	r	rw		W	r	N			
RESET	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0			
TILOLI								0x00	20*										

Table 17-3. PWM Control Register Description

Name	Description	Settings
Reserved Bits 31–19	Reserved—These bits are reserved and should read 0.	
HCTR Bit 18	Halfword FIFO Data Swapping—Swapping upper and lower write data which to PWMS.	0 = Do not swap 1 = Swap
BCTR Bit 17	Byte FIFO Data Swapping —Swapping bits[15:8] and bits[7:0] data which from PWMS to FIFO.	0 = Do not swap 1 = Swap
SWR Bit 16	Software Reset —Enables a reset of the PWM. After five system clock cycles, the SWR bit releases automatically.	0 = No action taken 1 = Reset the PWM
CLKSRC Bit 15	Clock Source—Selects the clock source for the pulse-width modulator.	0 = Selects PERCLK1 source 1 = Selects CLK32 source The CLK32 frequency is determined by the frequency of the reference crystal.
PRESCALER Bits 14–8	Prescaler —Scales down the incoming clock by dividing the incoming clock the PRESCALER field+1. The prescaler is normally used to generate a lovoice modulation, these bits are set to 0 (divide by 1).	•
IRQ Bit 7	Interrupt Request—Indicates that the FIFO contains 1 or 0 words, which signals the need to write no more than three 16-bit words into the PWMS register. The IRQ bit automatically clears itself after this register is read, eliminating an extra write cycle in the interrupt service routine. If the IRQEN bit is 0, the IRQ bit can be polled to indicate the status of the period comparator. For debugging purposes, the IRQ bit can be set to immediately post a PWM interrupt.	0 = FIFO contains more than 1 sample word 1 = FIFO contains 1 or 0 sample words
IRQEN Bit 6	Interrupt Request Enable—Enables/Disables the pulse-width modulator interrupt. When IRQEN is low, the interrupt is disabled.	0 = PWM interrupt is disabled 1 = PWM interrupt is enabled

MC9328MXS Reference Manual, Rev. 1

17-4 Freescale Semiconductor

Table 17-3. PWM Control Register Description (continued)

Name	Description	Settings
FIFOAV Bit 5	FIFO Available—Indicates that the FIFO is available for at least one word be written to the FIFO as long as the FIFOAV bit is set. If the FIFO is written cleared, the write is ignored.	
EN Bit 4	Enable—Enables/Disables the pulse-width modulator. If the EN bit is not enabled, writes to any register in the PWM are ignored. When the pulse-width modulator is disabled, it is in low-power mode, the output pin is forced to 0, and the following events occur: • The clock prescaler is reset and frozen. • The counter is reset and frozen. • The FIFO is flushed. When the pulse-width modulator is enabled, it begins a new period, and the following events occur: • The output pin is set to start a new period. • The prescaler and counter are released and begin counting. • The IRQ bit is set, therefore indicating that the FIFO is empty.	0 = PWM is disabled 1 = PWM is enabled
REPEAT Bits 3–2	Sample Repeats—Selects the number of times each sample is repeated. The repeat feature reduces the interrupt overhead, reduces CPU loading when audio data is played back at a higher rate, and allows the use of a lower-cost low-pass filter. For example, if the audio data is sampled at 8 kHz and the data is played back at 8 kHz again, an 8 kHz hum (carrier) is generated during playback. To filter this carrier, a high-quality low-pass filter is required. For a higher playback rate, it is possible to reconstruct samples at 16 kHz by using the sample twice. This method shifts the carrier from an audible 8 kHz to a less sensitive 16 kHz frequency range, resulting in better output sound quality.	00 = No repeat
CLKSEL Bits 1–0	Clock Selection—Selects the output of the sampling clock. The approximate sampling rates are calculated using a 16 MHz clock source (PRESCALER = 0 and PERIOD = default).	00 = Divide by 2—produces a 32 kHz sampling rate 01 = Divide by 4—produces a 16 kHz sampling rate 10 = Divide by 8—produces an 8 kHz sampling rate 11 = Divide by 16—provides a 4 kHz sampling rate

Freescale Semiconductor 17-5

17.4.1.1 HCTR and BCTR Bit Description

When the endian format of the wave data stored in external memory is not compatible to the system endian format, these two bits control the swapping of the data to the PWM FIFO. The data port size used by the external memory must be used in conjunction with these two bits.

Table 17-4. HCTR and BCTR Bit Swapping

HCTR	BCTR	Swapping
0	0	No
0	1	Swapping bits[15:8] to bits[7:0] and bits[7:0] to bits[15:8]
1	0	Swapping bits[31:16] to bits[15:0] and bits[15:0] to bits[31:16]
1	1	Swapping bit[s31:16] to bits[15:0] and bits[15:0] to bits[15:0] to bits[31:16], and after that swapping bits[15:8] to bits[7:0] and bits[7:0] to bits[15:8]

Note: Only the lower 16 bits are passed to PWM 16-bit FIFO after swapping.

17.4.2 PWM Sample Register

The PWM Sample Register is the input to the FIFO. Writing successive audio sample values to this register automatically loads the values into the FIFO. The pulse-width modulator free-runs at the last set duty-cycle setting until the FIFO is reloaded or the pulse-width modulator is disabled. If the value in this register is higher than the PERIOD + 1, the output is never reset, which results in a 100% duty-cycle.

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The register bit assignments are shown in the following register display. The register settings are described in Table 17-5.

PWMS	6				PWM Sample Register										0x00208004		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								SAMF	PLE								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	Χ	Х	Х	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Χ	Х	Х	Х	Χ	
HESEI								0xXX	XX								

MC9328MXS Reference Manual, Rev. 1 17-6 Freescale Semiconductor

Table 17-5. PWM Sample Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
SAMPLE Bits 15–0	Sample—Contains a two-sample word. This word is written to the pulse-width modulator.

17.4.3 PWM Period Register

This register controls the pulse-width modulator period. When the counter value matches PERIOD + 1, the counter is reset to start another period. The following equation applies:

PWMO (Hz) = PCLK (Hz)
$$\div$$
 (PERIOD + 2)

Eqn. 17-1

Writing 0xFFFF to this register achieves the same result as writing 0xFFFE.

The register bit assignments are shown in the following register display. The register settings are described in Table 17-6.

PWMF	•					PW	М Ре	Addr 0x00208008								
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								PERI	OD							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw						
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0
TILOLI								0xFF	FE							

Table 17-6. PWM Period Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
PERIOD Bits 15–0	Period—Represents the pulse-width modulator's period control value.

Freescale Semiconductor 17-7

17.4.4 PWM Counter Register

The read-only PWM Counter Register contains the current count value and can be read at any time without disturbing the counter. The register bit assignments are shown in the following register display. The register settings are described in Table 17-7.

PWMC	VMCNT PWM Counter Register														Addr 0x0020800C			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HESET								0x00	00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
								COU	NT									
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HLOEI								0x00	00									

Table 17-7. PWM Counter Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
COUNT Bits 15–0	Count—Represents the current count value.

Chapter 18 Real-Time Clock (RTC)

This chapter discusses how to operate and program the real-time clock (RTC) module that maintains the system clock, provides stopwatch, alarm, and interrupt functions, and supports the following features:

- Full clock—days, hours, minutes, seconds
- Minute countdown timer with interrupt
- Programmable daily alarm with interrupt
- Sampling timer with interrupt
- Once-per-day, once-per-hour, once-per-minute, and once-per-second interrupts
- Operation at 32.768 kHz or 32 kHz (determined by reference clock crystal)

As shown in the RTC block diagram (Figure 18-1), the real-time clock module consists of the following blocks:

- Prescaler
- Time-of-day (TOD) clock counter
- Alarm
- · Sampling timer
- Minute stopwatch
- Associated control and bus interface hardware

Freescale Semiconductor 18-1

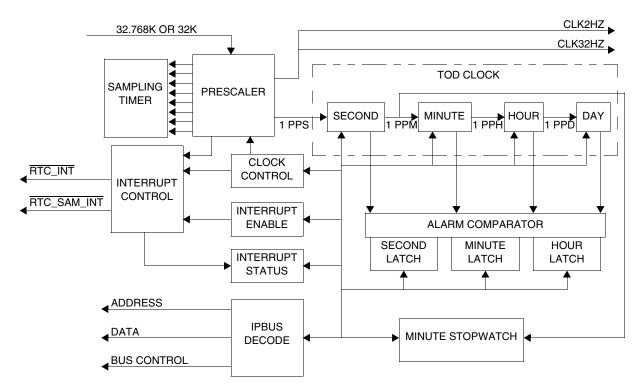


Figure 18-1. Real-Time Clock Block Diagram

18.1 Operation

The prescaler converts the incoming crystal reference clock to a 1 Hz signal which is used to increment the seconds, minutes, hours, and days TOD counters. The alarm functions, when enabled, generate RTC interrupts when the TOD settings reach programmed values. The sampling timer generates fixed-frequency interrupts, and the minute stopwatch allows for efficient interrupts on minute boundaries.

18.1.1 Prescaler and Counter

The prescaler divides the reference clock down to 1 Hz. The reference frequencies of 32.768 kHz and 32 kHz are supported. The prescaler stages are tapped to support the sampling timer.

The counter portion of the RTC module consists of four groups of counters that are physically located in three registers:

- The 6-bit seconds counter is located in the SECONDS register
- The 6-bit minutes counter and the 5-bit hours counter are located in the HOURMIN register
- The 9-bit day counter is located in the DAYR register

These counters cover a 24-hour clock over 512 days. All three registers can be read or written at any time.

Interrupts signal when each of the four counters increments, and can be used to indicate when a counter rolls over. For example, each tick of the seconds counter causes the 1 Hz interrupt flag to be set. When the seconds counter rolls from 59 to 00, the minute counter increments and the MIN interrupt flag is set. The same is true for the minute counter with the HR signal, and the hour counter with the DAY signal.

MC9328MXS Reference Manual, Rev. 1

18-2 Freescale Semiconductor

18.1.2 Alarm

There are three alarm registers that mirror the three counter registers. An alarm is set by accessing the real-time clock alarm registers (ALRM_HM, ALRM_SEC, and DAYALARM) and loading the exact time that the alarm should generate an interrupt. When the TOD clock value and the alarm value coincide, if the ALM bit in the real-time clock interrupt enable register (RTCIENR) is set, an interrupt occurs.

NOTE:

If the alarm is not disabled, it will reoccur every 512 days. If a single alarm is desired, the alarm function must be disabled through the RTC Interrupt Enable register (RTCIENR).

18.1.3 Sampling Timer

The sampling timer is designed to support application software. The sampling timer generates a periodic interrupt with the frequency specified by the SAMx bits of the RTCIENR register. This timer can be used for digitizer sampling, keyboard debouncing, or communication polling. The sampling timer operates only if the real-time clock is enabled. Table 18-1 lists the interrupt frequencies of the sampling timer for the possible reference clocks.

Multiple SAMx bits may be set in the RTC Interrupt Enable Register (RTCIENR). The corresponding bits in the RTC Interrupt Status Register (RTCISR) will be set at the noted frequencies.

Sampling Frequency	32.768 kHz Reference Clock	32 kHz Reference Clock
SAM7	512 Hz	500 Hz
SAM6	256 Hz	250 Hz
SAM5	128 Hz	125 Hz
SAM4	64 Hz	62.5 Hz
SAM3	32 Hz	31.25 Hz
SAM2	16 Hz	15.625 Hz
SAM1	8 Hz	7.8125 Hz
SAM0	4 Hz	3.90625 Hz

Table 18-1. Sampling Timer Frequencies

18.1.4 Minute Stopwatch

The minute stopwatch performs a countdown with a one minute resolution. It can be used to generate an interrupt on a minute boundary—for example, to turn off the LCD controller after five minutes of inactivity, program a value of 0x04 into the Stopwatch Count (CNT) field of the Stopwatch Minutes (STPWCH) register (see Table 18-12 on page 18-16 for a complete list of settings for the STPWCH register). At each minute, the value in the stopwatch is decremented. When the stopwatch value reaches -1, the interrupt occurs. The value of the register does not change until it is reprogrammed. Note that the actual delay includes the seconds from setting the stopwatch to the next minute tick.

Freescale Semiconductor 18-3

The RTC module includes ten 32-bit registers. Table 18-2 summarizes these registers and their addresses.

Table 18-2. RTC Module Register Memory Map

Description	Name	Address
RTC Days Counter Register	DAYR	0x00204020
RTC Hours and Minutes Counter Register	HOURMIN	0x00204000
RTC Seconds Counter Register	SECONDS	0x00204004
RTC Day Alarm Register	DAYALARM	0x00204024
RTC Hours and Minutes Alarm Register	ALRM_HM	0x00204008
RTC Seconds Alarm Register	ALRM_SEC	0x0020400C
RTC Control Register	RCCTL	0x00204010
RTC Interrupt Status Register	RTCISR	0x00204014
RTC Interrupt Enable Register	RTCIENR	0x00204018
Stopwatch Minutes Register	STPWCH	0x0020401C

18.2.1 RTC Days Counter Register

The real-time clock days counter register (DAYR) is used to program the day for the TOD clock. When the HOUR field of the HOURMIN register rolls over from 23 to 00, the day counter increments. It can be read or written at any time. After a write, the time changes to the new value. This register cannot be reset because the real-time clock is always enabled at reset.

NOTE:

This day counter only supports halfword and word write operations. That means that all 9 bits must be set simultaneously.

18-4 Freescale Semiconductor

DAYR	RTC Days Counter Register												Addr 0x00204020			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NLOLI	0x0000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			DAYS													
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	?	?	?	?	?	?	?	?	?
NLOEI								0x0?	??							

Table 18-3. RTC Days Counter Register Description

Name	Description	Settings
Reserved Bits 31–9	Reserved—These bits are reserved and should read 0.	
DAYS Bits 8–0	Day Setting—Indicates the current day count.	DAYS can be set to any value between 0 and 511.

18.2.2 RTC Hours and Minutes Counter Register

The real-time clock hours and minutes counter register (HOURMIN) is used to program the hours and minutes for the TOD clock. It can be read or written at any time. After a write, the time changes to the new value. This register cannot be reset because the real-time clock is always enabled at reset.

HOUR	MIN			RT	RTC Hours and Minutes Counter Register											Addr 0x00204000			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
RESET								0x00	000										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
						HOURS	3						MINU	JTES					
TYPE	r	r	r	rw	rw	rw	rw	rw	r	r	rw	rw	rw	rw	rw	rw			
DEOET	0	0	0	?	?	?	?	?	0	0	?	?	?	?	?	?			
RESET								0x??	???										

Table 18-4. RTC Hours and Minutes Counter Register Description

Name	Description	Settings							
Reserved Bits 31–13	Reserved—These bits are reserved and should rea	ad 0.							
HOURS Bits 12–8	Hour Setting—Indicates the current hour.	HOURS can be set to any value between 0 and 23.							
Reserved Bits 7–6	Reserved—These bits are reserved and should rea	ad 0.							
MINUTES Bits 5–0	Minute Setting—Indicates the current minute.	MINUTES can be set to any value between 0 and 59.							

18.2.3 RTC Seconds Counter Register

The real-time clock seconds register (SECONDS) is used to program the seconds for the TOD clock. It can be read or written at any time. After a write, the time changes to the new value. This register cannot be reset because the real-time clock is always enabled at reset.

SECO	NDS				RT	C Sec	Addr 0x00204004									
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							
ВІТ	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
													SEC	ONDS		
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw
	0	0	0	0	0	0	0	0	0	0	?	?	?	?	?	?
RESET								0X00	??							

Table 18-5. RTC Seconds Counter Register Description

Name	Description	Settings							
Reserved Bits 31–6	Reserved—These bits are reserved and should rea	d 0.							
SECONDS Bits 5–0	Seconds Setting—Indicates the current second.	SECONDS can be set to any value between 0 and 59.							

18.2.4 RTC Day Alarm Register

The real-time clock day alarm (DAYALARM) register is used to configure the day for the alarm. The alarm settings can be read or written at any time.

DAYA	ALARM RTC Day Alarm Register													0x(Addr 0x00204024			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
												DAYSA	L					
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw		
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									

Table 18-6. RTC Day Alarm Register Description

Name	Description	Settings
Reserved Bits 31–9	Reserved—These bits are reserved and should read 0.	
DAYSAL Bits 8–0	Day Setting of the Alarm—Indicates the current day setting of the alarm.	DAYSAL can be set to any value between 0 and 511.

18.2.5 RTC Hours and Minutes Alarm Register

The real-time clock hours and minutes alarm (ALRM_HM) register is used to configure the hours and minutes setting for the alarm. The alarm settings can be read or written at any time.

ALRM	_HM			RT	C Ho	Addr 0x00204008										
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET	0x0000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						HOURS							MINU	JTES		
TYPE	r	r	r	rw	rw	rw	rw	rw	r	r	rw	rw	rw	rw	rw	rw
DEOLT	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							

Table 18-7. RTC Hours and Minutes Alarm Register Description

Name	Description	Settings
Reserved Bits 31–13	Reserved—These bits are reserved and should read 0.	
HOURS Bits 12–8	Hour Setting of the Alarm—Indicates the current hour setting of the alarm.	HOURS can be set to any value between 0 and 23.
Reserved Bits 7–6	Reserved—These bits are reserved and should read 0.	
MINUTES Bits 5–0	Minute Setting of the Alarm—Indicates the current minute setting of the alarm.	MINUTES can be set to any value between 0 and 59.

18.2.6 RTC Seconds Alarm Register

The real-time clock seconds alarm (ALRM_SEC) register is used to configure the seconds setting for the alarm. The alarm settings can be read or written at any time.

ALRM	_SEC	;			RT	C Se	ls Ala	Alarm Register						Addr 0x0020400C				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
													SEC	SECONDS				
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw		
DEOET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									

Table 18-8. RTC Seconds Alarm Register Description

Name	Description	Settings
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.	
SECONDS Bits 6–0	Seconds Setting of the Alarm—Indicates the current seconds setting of the alarm.	SECONDS can be set to any value between 0 and 59.

18.2.7 RTC Control Register

The real-time clock control (RTCCTL) register is used to enable the real-time clock module and specify the reference frequency information for the prescaler.

RCCT	L					RTC Control Register									Addr 0x00204010		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESET	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
									EN	X	ΓL					SWR	
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	r	r	r	r	rw	
DEGET	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	
RESET								0x0	080								

Table 18-9. RTC Control Register Description

Name	Description	Settings
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.	
EN Bit 7	Enable —Enables/Disables the real-time clock. The software reset bit (SWR) has no effect on this bit.	0 = Disable the real-time clock 1 = Enable the real-time clock
XTL Bits 6–5	Crystal Selection—Selects the proper input crystal frequency. It is important to set these bits correctly or the real-time clock will be inaccurate.	00 = 32.768 kHz 01 = 32 kHz 11 = 32.768 kHz
Reserved Bits 4–1	Reserved—These bits are reserved and should read 0.	
SWR Bit 0	Software Reset—Resets the module to its default state. However, a software reset will have no effect on the clock enable (EN) bit.	0 = No effect. 1 = Reset the module to its default state.

18.2.8 RTC Interrupt Status Register

The real-time clock interrupt status register (RTCISR) indicates the status of the various real-time clock interrupts, except for the 2Hz bit. When an event of the types included in this register occurs, if the corresponding bit in the RTC Interrupt Enable Register (RTCIENR) is set, then the bit will be set in this register. These bits are cleared by writing a value of 1, which also clears the interrupt. Interrupts may occur when the system clock is idle or in sleep mode. For more information about the frequency of the sampling timer interrupts (SAM7-SAM0), refer to Table 18-1.

RTCIS	,													Addr 0x00204014			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
T) (D.E.																	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
TILOLI	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	SAM7	SAM6	SAM5	SAM4	SAM3	SAM2	SAM1	SAM0	2HZ		HR	1HZ	DAY	ALM	MIN	SW	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET								0x00	00								

Table 18-10. RTC Interrupt Status Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
SAM7 Bit 15	Sampling Timer Interrupt Flag at SAM7 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 512, 500, or 600 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM7 interrupt occurred 1 = A SAM7 interrupt occurred
SAM6 Bit 14	Sampling Timer Interrupt Flag at SAM6 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 256, 250, or 300 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM6 interrupt occurred 1 = A SAM6 interrupt occurred
SAM5 Bit 13	Sampling Timer Interrupt Flag at SAM5 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 128, 125, or 150 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM5 interrupt occurred 1 = A SAM5 interrupt occurred
SAM4 Bit 12	Sampling Timer Interrupt Flag at SAM4 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 64, 62.5, or 75 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM4 interrupt occurred 1 = A SAM4 interrupt occurred

18-12 Freescale Semiconductor

Table 18-10. RTC Interrupt Status Register Description (continued)

Name	Description	Settings
SAM3 Bit 11	Sampling Timer Interrupt Flag at SAM3 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 32, 31.25, or 37.5 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM3 interrupt occurred 1 = A SAM3 interrupt occurred
SAM2 Bit 10	Sampling Timer Interrupt Flag at SAM2 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 16, 15.625, or 18.75 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM2 interrupt occurred 1 = A SAM2 interrupt occurred
SAM1 Bit 9	Sampling Timer Interrupt Flag at SAM1 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 8, 7.8125, or 9.375 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM1 interrupt occurred 1 = A SAM1 interrupt occurred
SAM0 Bit 8	Sampling Timer Interrupt Flag at SAM0 Frequency—Indicates that an interrupt has occurred. If enabled, this bit is periodically set at a rate of 4, 3.90625, or 4.6875 Hz. The actual rate of the interrupt depends on the input clock value. See Table 18-1.	0 = No SAM0 interrupt occurred 1 = A SAM0 interrupt occurred
2HZ Bit 7	2 Hz Flag —Indicates that a 2Hz status event has occurred. If enabled, this bit is set at intervals of every 2 Hz.	0 = No 2 Hz event occurred 1 = A 2 Hz interval event occurred
Reserved Bit 6	Reserved—This bit is reserved and should read 0.	
HR Bit 5	Hour Flag —Indicates that the hour counter has incremented. If enabled, this bit is set on every increment of the hour counter in the time-of-day clock.	0 = No 1-hour interrupt occurred 1 = A 1-hour interrupt occurred
1HZ Bit 4	1 Hz Flag—Indicates that the second counter has incremented. If enabled, this bit is set on every increment of the second counter of the time-of-day clock.	0 = No 1 Hz interrupt occurred 1 = A 1 Hz interrupt occurred
DAY Bit 3	Day Flag—Indicates that the day counter has incremented. If enabled, this bit is set on every increment of the day counter of the time-of-day clock.	0 = No 24-hour rollover interrupt occurred 1 = A 24-hour rollover interrupt occurred
ALM Bit 2	Alarm Flag—Indicates that the real-time clock matches the value in the alarm registers. Note that the alarm will reoccur every 512 days. For a single alarm, clear the interrupt enable for this bit in the interrupt service routine.	0 = No alarm interrupt occurred 1 = An alarm interrupt occurred
MIN Bit 1	Minute Flag—Indicates that the minute counter has incremented. If enabled, this bit is set on every increment of the minute counter in the time-of-day clock.	0 = No 1-minute interrupt occurred 1 = A 1-minute interrupt occurred
SW Bit 0	Stopwatch Flag—Indicates that the stopwatch countdown timed out.	0 = The stopwatch did not time-out. 1 = The stopwatch timed out.

Freescale Semiconductor 18-13

18.2.9 RTC Interrupt Enable Register

The real-time clock interrupt enable register (RTCIENR) is used to enable/disable the various real-time clock interrupts except the 2HZ bit (RTCIENR[7]). When an event of the types included in this register occurs, if that bit in this register is set, then the corresponding bit will be set in the RTC Interrupt Status Register (RTCISR). For more information about the frequency of the sampling timer interrupts (SAM7-SAM0), refer to Table 18-1.

RTCIE	NR	3														Addr 0x00204018			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r			
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
RESET	0x0000																		
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
	SAM7	SAM6	SAM5	SAM4	SAM3	SAM2	SAM1	SAM0	2HZ		HR	1HZ	DAY	ALM	MIN	SW			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw			
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
RESET								0x00	00										

Table 18-11. RTC Interrupt Enable Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
SAM7 Bit 15	Sampling Timer Interrupt Flag at SAM7 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 7. The frequency of this interrupt is shown in Table 18-1.	0 = SAM7 interrupt is disabled 1 = SAM7 interrupt is enabled
SAM6 Bit 14	Sampling Timer Interrupt Flag at SAM6 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 6. The frequency of this interrupt is shown in Table 18-1.	0 = SAM6 interrupt is disabled 1 = SAM6 interrupt is enabled
SAM5 Bit 13	Sampling Timer Interrupt Flag at SAM5 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 5. The frequency of this interrupt is shown in Table 18-1.	0 = SAM5 interrupt is disabled 1 = SAM5 interrupt is enabled
SAM4 Bit 12	Sampling Timer Interrupt Flag at SAM4 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 4. The frequency of this interrupt is shown in Table 18-1.	0 = SAM4 interrupt is disabled 1 = SAM4 interrupt is enabled
SAM3 Bit 11	Sampling Timer Interrupt Flag at SAM3 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 3. The frequency of this interrupt is shown in Table 18-1.	0 = SAM3 interrupt is disabled 1 = SAM3 interrupt is enabled
SAM2 Bit 10	Sampling Timer Interrupt Flag at SAM2 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 2. The frequency of this interrupt is shown in Table 18-1.	0 = SAM2 interrupt is disabled 1 = SAM2 interrupt is enabled

18-14 Freescale Semiconductor

Table 18-11. RTC Interrupt Enable Register Description (continued)

Name	Description	Settings
SAM1 Bit 9	Sampling Timer Interrupt Flag at SAM1 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 1. The frequency of this interrupt is shown in Table 18-1.	0 = SAM1 interrupt is disabled 1 = SAM1 interrupt is enabled
SAM0 Bit 8	Sampling Timer Interrupt Flag at SAM0 Interrupt Enable—Enables/Disables the real-time sampling timer interrupt 0. The frequency of this interrupt is shown in Table 18-1.	0 = SAM0 interrupt is disabled 1 = SAM0 interrupt is enabled
2HZ Bit 7	2 Hz Interrupt Enable—Enables/Disables the 2 Hz bit at a 2 Hz rate.	0 = The 2 Hz clock is disabled 1 = The 2 Hz clock is enabled
Reserved Bit 6	Reserved—This bit is reserved and should read 0.	
HR Bit 5	Hour Interrupt Enable—Enables/Disables an interrupt whenever the hour counter of the real-time clock increments.	0 = The 1-hour interrupt is disabled 1 = The 1-hour interrupt is enabled
1HZ Bit 4	1 Hz Interrupt Enable—Enables/Disables an interrupt whenever the second counter of the real-time clock increments.	0 = The 1 Hz interrupt is disabled 1 = The 1 Hz interrupt is enabled
DAY Bit 3	Day Interrupt Enable—Enables/Disables an interrupt whenever the hours counter rolls over from 23 to 0 (midnight rollover).	0 = The 24-hour interrupt is disabled 1 = The 24-hour interrupt is enabled
ALM Bit 2	Alarm Interrupt Enable—Enables/Disables the alarm interrupt.	0 = The alarm interrupt is disabled 1 = The alarm interrupt is enabled
MIN Bit 1	Minute Interrupt Enable—Enables/Disables an interrupt whenever the minute counter of the real-time clock increments.	0 = The 1-minute interrupt is disabled 1 = The 1-minute interrupt is enabled
SW Bit 0	Stopwatch Interrupt Enable—Enables/Disables the stopwatch interrupt. Note: The stopwatch counts down and remains at decimal -1 until it is reprogrammed. If this bit is enabled with -1 (decimal) in the STPWCH register, an interrupt will be posted on the next minute tick.	0 = Stopwatch interrupt is disabled 1 = Stopwatch interrupt is enabled

18.2.10 Stopwatch Minutes Register

The stopwatch minutes (STPWCH) register contains the current stopwatch countdown value. When the minute counter of the TOD clock increments, the value in this register decrements.

STPW	STPWCH Stopwatch Minutes Register														Addr 0x0020401C		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HESET		0x0000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
													C	NT			
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	
RESET								0x00									
					MC93	328MX	S Refe	rence l	Manua	I, Rev	. 1						

Freescale Semiconductor 18-15

Table 18-12. Stopwatch Minutes Register Description

Name	Description	Settings	
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.		
CNT Bits 5–0	Stopwatch Count—Contains the stopwatch countdown value. Note: The stopwatch counter is decremented by the minute (MIN) tick output from the real-time clock, so the average tolerance of the count is 0.5 minutes. For better accuracy, enable the stopwatch by polling the MIN bit of the RTCISR register or by polling the minute interrupt service routine.	These bits can be set to any value between 0 and 62. When the countdown has completed, the value will not change until a nonzero value (1–62) is written.	

18-16 Freescale Semiconductor

Chapter 19 SDRAM Memory Controller

This chapter describes the SDRAM controller (SDRAMC) on the MC9328MXS.

19.1 Features

The SDRAM Controller includes these distinctive features:

- Supports 4 banks of 64-, 128-, or 256-Mbit synchronous DRAMs
- Includes 2 independent chip-selects
 - Up to 64 Mbyte per chip-select
 - Up to four banks simultaneously active per chip-select
 - JEDEC standard pinout and operation
- Supports Micron SyncFlash® SDRAM-interface burst flash memory
 - Boot capability from $\overline{\text{CSD1}}$
- Supports burst reads of word (32-bit) data types
- PC100 compliant interface
 - 100 MHz system clock achievable with "-8" option PC100 compliant memories
 - single and fixed-length (8-word) word access
 - Typical access time of 8-1-1-1 at 100 MHz
- Software configurable bus width, row and column sizes, and delays for differing system requirements
- Built in auto-refresh timer and state machine
- Hardware supported self-refresh entry and exit which keeps data valid during system reset and low-power modes
- Auto-powerdown (clock suspend) timer

19-1

19.2 Block Diagram

Figure 19-1 is a block diagram of the SDRAM Controller.

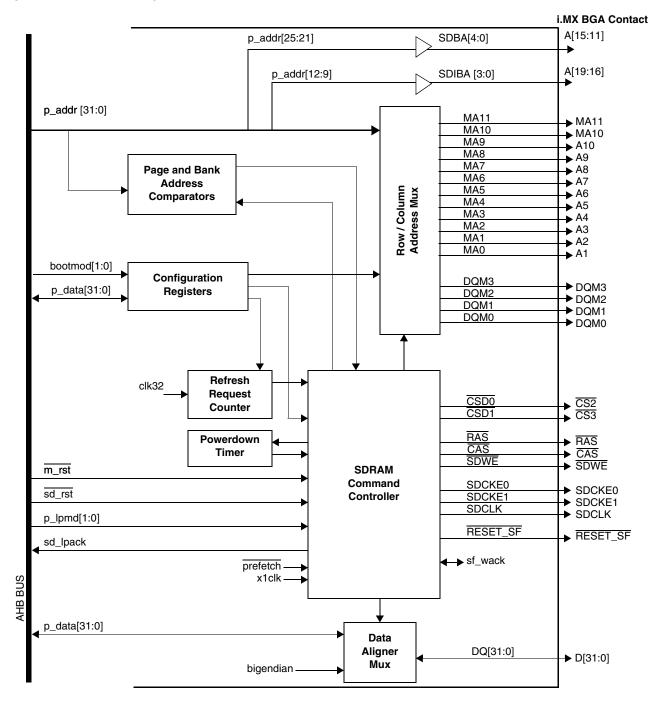


Figure 19-1. SDRAM Controller Block Diagram

19-2 Freescale Semiconductor

19.3 Functional Overview

The SDRAM Controller consists of 7 major blocks, including the SDRAM command controller, page and bank address comparators, row and column address multiplexer, data aligner–multiplexer, configuration registers, refresh request counter, and the powerdown timer.

19.3.1 SDRAM Command Controller

The command controller handles the majority of the actions within the SDRAM controller including sequencing accesses to the memories, initializing the DRAM, keeping track of active banks within each memory region, scheduling refresh operations, transitioning into and out of low-power modes, and controlling the address and data multiplexers.

19.3.2 Page and Bank Address Comparators

There are a total of 8 address comparators. Each chip-select has a unique comparator for each of its four banks. The comparators are used to determine if a requested access falls within the address range of a currently active DRAM page.

19.3.3 Row and Column Address Multiplexer

All synchronous DRAMs incorporate a multiplexed address bus, although the address folding points vary according to memory density, data I/O size, and processor data bus width. The address folding point is described as the point where the column address bits end and the row (or bank) address begin. The SDRAM Controller takes these variables into account and provides the proper alignment of the multiplexed address through the row and column address multiplexer, non-multiplexed address pins, and the connections between the controller and the memory devices.

19.3.4 Data Aligner and Multiplexer

The data alignment block is responsible for aligning the data between the internal AHB bus and the external memory device(s) including little endian byte swapping.

19.3.5 Configuration Registers

Configuration registers determine the operating mode of the SDRAM Controller by selecting memory device density and bus width, the number of memory devices, CAS latency, row-to-column delay, and the burst length. Enable bits are provided for refresh and the auto-powerdown timer. Control bits provide a mechanism for software-initiated SDRAM initialization, SDRAM mode register settings, and all bank precharge and auto-refresh cycles.

19.3.6 Refresh Request Counter

SDRAM memories require a periodic refresh to retain data. The refresh request counter generates requests to the SDRAM Command Controller to perform these refresh cycles. Requests are scheduled according to a 32 kHz clock input with 1, 2, or 4 refresh cycles generated per clock.

Freescale Semiconductor 19-3

Functional Overview

19.3.7 Powerdown Timer

The powerdown timer detects periods of inactivity to the SDRAM and disables the clock when the inactive period surpasses the selected time-out. Data is retained during the powerdown state. Subsequent requests to the SDRAM incur only a minimal added start-up delay (beyond the normal access time). The powerdown timer may be programmed to expire anytime the controller is not actively reading or writing the memory, after 64 or 128 clocks of inactivity, or may be disabled entirely.

19.3.8 DMA Operation with the SDRAM Controller

The DMA controller has the capability to perform burst transfers (reads and writes) of byte and half word data types while the SDRAM controller support is restricted to internal AHB burst transfers of word (32-bit) data types. Therefore, when using the DMA in conjunction with the SDRAM controller, ensure that all burst transfers to or from the SDRAM controller are of word data types. This is configured in the DMA Channel Control register. When choosing SDRAM memory as the source address, set the Source Size bits as a 32-bit port, and likewise when setting up the destination address. Refer to the "Chapter 13, "DMA Controller," for more details.

This section discusses input and output signals between the SDRAM Controller and the external memory devices. Other than the chip-select outputs (CSD0 / CSD1) and clock enables (SDCKE0 / SDCKE1), all signals are shared between the two chip-select regions. The interface signals are summarized in Table 19-1 and detailed in Section 19.3.9 through Section 19.3.19. Interconnect and timing diagrams are included as part of the detailed discussion on controller operation in Section 19.5, "Operating Modes."

All external interface signals are referenced to the SDRAM clock, SDCLK.

 Name
 Function
 Direction

 clk32
 32.0 kHz Clock Reference
 Input

 sf_wack
 WMIMI bus time-out suppression for SyncFlash low-power mode wake-up
 Output

 DQ [31:0]
 Internal data I/O bus
 I/O

Table 19-1. AHB Bus and Internal Interface Signals

Table 10.2	CDDVM	Intorfood	Characteristics

SDRAMC Signal Name	BGA Contact Name	Function	Direction	Reset State
SDCLK	SDCLK	Clock to SDRAM	Output	Enabled
SDCKE0	SDCLKE0	Clock enable to SDRAM 0	Output	High
SDCKE1	SDCLKE1	Clock enable to SDRAM 1	Output	High
CSD0	CS2	Chip-select to SDRAM array 0	Output	High
CSD1	CS3	Chip-select to SDRAM array 1	Output	High
MA [11:10]	MA [11:10]	Multiplexed Address	Output	Low
MA [9:0]	A [10:1]	Multiplexed Address	Output	Low
SDBA [4:0] / A [25:21]	A [15:11]	Non-multiplexed Address	Output	Low
SDIBA [3:0] / A [12:9]	A [19:16]	Non-multiplexed Address	Output	Low
DQM3	DQM3	Data Qualifier Mask byte 3 (D [31:24])	Output	Low

MC9328MXS Reference Manual, Rev. 1

19-4 Freescale Semiconductor

d)
C

SDRAMC Signal Name	BGA Contact Name	Function	Direction	Reset State
DQM2	DQM2	Data Qualifier Mask byte 2 (D [23:16])	Output	Low
DQM1	DQM1	Data Qualifier Mask byte 1 (D [15:8])	Output	Low
DQM0	DQM0	Data Qualifier Mask byte 0 (D [7:0])	Output	Low
DQ[31:0]	D[31:0]	Data bus	I/O	High
SDWE	SDWE	Write Enable	Output	High
RAS	RAS	Row Address Strobe	Output	High
CAS	CAS	Column Address Strobe	Output	High
RESET_SF	RESET_SF	SyncFlash Reset/Powerdown	Output	Low

19.3.9 SDCLK—SDRAM Clock

The SDCLK output provides the timing reference for the memory devices. All other SDRAM interface signals are referenced to this clock. SDCLK is synchronous to the system clock, however it is gated off during low-power operating modes when both SDCKE0 and SDCKE1 are negated.

19.3.10 SDCKE0, SDCKE1—SDRAM Clock Enables

The SDCKE0 and SDCKE1 pins are clock enable outputs to the SDRAM memory devices. SDCKE0 corresponds to SDRAM array 0 and SDCKE1 to SDRAM array 1. When these pins are asserted high, the memory's clock input is active, which means that a stable clock is being supplied. The low assertion deactivates the memory's clock input. A low assertion of SDCKEx initiates Powerdown, Self Refresh, and Suspend modes to the SDRAM.

19.3.11 CSD0, CSD1—SDRAM Chip-Select

CSD0 and CSD1 are used to select SDRAM array 0 and SDRAM array 1, respectively. When a valid command is present on the other control signals, the chip-select signals are used to indicate which device the command is directed towards.

19.3.12 DQ [31:0]—Data Bus (Internal)

The 32 data lines are used to transfer data between the SDRAM Controller and memory. Data bit 31 is the most significant bit and bit 0 is the least significant.

19.3.13 MA [11:0]—Multiplexed Address Bus

The multiplexed address bus specifies the SDRAM page and the location within the page targeted by the current access. The multiplexed address pins are used in conjunction with some of the non-multiplexed ARM920T processor address signals to comprise the complete SDRAM address. Connections between the SDRAM Controller and memory vary depending on the SDRAM device density. See Section 19.6.1, "Address Multiplexing," on page 19-29 and specifically Table 19-20 and Table 19-22 for details on supported SDRAM configurations.

MC9328MXS Reference Manual, Rev. 1

Functional Overview

19.3.14 SDBA [4:0], SDIBA [3:0]—Non-Multiplexed Address Bus

The non-multiplexed address pins specify the SDRAM bank to which the current command is targeted. In some density or width configurations, these pins also supply the most significant bits of the row address. Table 19-20 on page 19-46 and Table 19-21 on page 19-47 document which address pins are used for any given configuration.

19.3.15 DQM3, DQM2, DQM1, DQM0—Data Qualifier Mask

During read cycles, the DQMx pins control the SDRAM data output buffers. DQMx asserted high disables the output buffers leaving them in a high-impedance state. DQMx asserted low allows the data buffers to drive normally.

During write cycles, DQMx controls which bytes are written in the SDRAM. DQMx asserted low enables a write to the corresponding byte, whereas DQMx asserted high leaves the byte unchanged.

DQM3 corresponds to the most significant byte and DQM0 to the least significant. Sixteen bit memories require only two DQM connections. Memories aligned to the upper data bus (D [31:16]) connect to DQM3 and DQM2, while memories aligned to the lower data bus (D [15:0]) connect to DQM1 and DQM0. Memory alignment is selected in the SDCTLx Registers.

19.3.16 SDWE—Write Enable

Write enable is part of the three bit command field (\overline{RAS} and \overline{CAS} make up the other two bits) used by the SDRAM. Generally, \overline{SDWE} will be asserted low if a command transfers data to the memory. A detailed summary of the supported SDRAM commands is provided in Table 19-50 on page 19-71.

19.3.17 RAS—Row Address Strobe

Row address strobe is also part of the \underline{SDRAM} command field. It is generally used to indicate an operation affecting an entire bank or row. When \overline{RAS} is asserted (low), a new SDRAM row address must be latched. Table 19-50 on page 19-71 provides details on SDRAM command encoding.

19.3.18 CAS—Column Address Strobe

The column address strobe is the third signal comprised in the command field. It generally signifies a column oriented command. When $\overline{\text{CAS}}$ is asserted (low), the column address has changed. Table 19-50 on page 19-71 provides details on SDRAM command encoding.

19.3.19 RESET_SF—Reset or Powerdown

This output signal is only used for SyncFlash memories. When asserted low, the SyncFlash memory state machines are reset and the device is placed in the lowest power operating mode. Bringing this signal high returns the device to a normal operating condition, ready to accept commands following a stabilization delay.

Three conditions force the RESET_SF pin to be asserted: SDRAM reset (SD_RST), disabling the chip-select via the SDE bit in the SDCTL1 control register, and entering one of the low-power modes. In each case, the system integrator must guarantee that the SyncFlash stabilization period between RESET_SF negation and the first access to the device has been met.

19-6 Freescale Semiconductor

NOTE:

Programming hardware-protected blocks within the SyncFlash requires RESET_SF to be raised to 5V +/-10%. This feature is not supported by the SDRAM Controller.

19.3.20 Pin Configuration for SDRAMC

Table 19-3 lists the pins used for the SDRAM controller. These pins are multiplexed with other functions on the device, and must be configured for SDRAM operation.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Table 19-3. Pin Configuration

Pin	Setting	Set-Up Procedure
SDCLK	Not multiplexed	
SDCKE0	Not multiplexed	
SDCKE1	Not multiplexed	
CSD0	Alternate function of CS2/CSD0 pin	Set bit 0 (SDCS0_SEL) in the Function Multiplexing Control register of the System Control module.
CSD1	Alternate function of CS3/CSD1 pin	Set bit 1 (SDCS1_SEL) in the Function Multiplexing Control register of the System Control module.
MA [11:10]	Not multiplexed	
MA [9:0]	Multiplexed with A [10:1]	Internal signal from SDRAMC, asserted for SDRAM accesses
SDBA [4:0]	Multiplexed with A [15:11]	Internal signal from SDRAMC, asserted for SDRAM accesses
SDIBA [3:0]	Multiplexed with A [19:16]	Internal signal from SDRAMC, asserted for SDRAM accesses
DQM3	Not multiplexed	
DQM2	Not multiplexed	
DQM1	Not multiplexed	
DQM0	Not multiplexed	
SDWE	Not multiplexed	
RAS	Not multiplexed	
CAS	Not multiplexed	
RESET_SF	Not multiplexed	

Programming Model

19.4 Programming Model

The SDRAM controller includes four 32-bit registers. Table 19-4 summarizes these registers and their addresses. Registers are accessible in supervisor mode only. Attempts to access the registers in user mode will result in a transfer error (TEA) being returned on the ARM920T processor's local bus.

Table 19-4. SDRAM Module Register Memory Map

Description	Name	Address			
SDRAM 0 Control Register	SDCTL0	0x00221000			
SDRAM 1 Control Register	SDCTL1	0x00221004			
SDRAM Reset Register	SDRST	0x00221018			
Miscellaneous Register	MISCELLANEOUS	0x00221014			

The SDRAM arrays are mapped according to Table 19-5. A 64 Mbyte space is allocated to each chip-select. Memories smaller than the allocated region are redundantly mapped throughout the remainder of the region. Attempted accesses to a disabled chip-select region (SDE bit of the SDCTLx = 0) and User accesses to a protected (SP bit of the SDCTL = 1) region will result in a transfer error.

Table 19-5. SDRAM Array Memory Map

Address	Use	Access
0x0800 0000 – 0x0BFF FFFF	SDRAM 0 Memory array	R/W
0x0C00 0000 – 0x0FFF FFFF	SDRAM 1 Memory array	R/W

19-8 Freescale Semiconductor

19.4.1 SDRAM Control Registers

There are two SDRAM Control Registers, one for each of the two memory regions. SDCTL0 defines the operating characteristics for the SDRAM 0 region (selected by $\overline{\text{CSD0}}$), while SDCTL1 does the same for the SDRAM 1 region (selected by $\overline{\text{CSD1}}$). Bit and field assignments within the registers are identical.

SDCT SDCT		DRA DRA				•					0022 0022					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	SDE		SMODE		SP		RC)W			COL		IAM		DSIZ	
TYPE	rw	rw	rw	rw	rw	r	rw	rw	r	r	rw	rw	rw	r	rw	rw
RESET	0*	0	0	0	0	0	0	1	0	0	0	0	0	0	0*	0*
TILOLI								0x01	00*							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	SRE	FR	CLF	KST			S	SCL		SRP	SRCD				SRC	
TYPE	rw	rw	rw	rw	r	r	rw	rw	r	rw	rw	rw	r	rw	rw	rw
RESET	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0
HLOEI								0x03	00							

^{*} For SDCTL1, the reset state is affected by bootmod [1:0]

Table 19-6. SDRAM 0 Control Register and SDRAM 1 Control Register Description

Name	Description	Settings
SDE Bit 31	SDRAM Controller Enable—Enables/Disables the SDRAM controller. The module is disabled on reset. For SDRAM 1, if the selected boot mode is the SyncFlash memory, the module will be enabled on reset. Disabling the module shuts off all clocks within the module with the exception of register accesses.	0 = Disabled 1 = Enabled
SMODE Bits 30–28	SDRAM Controller Operating Mode—Determines the operating mode of the SDRAM controller. The controller is capable of operating in six different modes. These modes are primarily used for SDRAM initialization and programming of the SyncFlash memory. Any access to the SDRAM memory space, while in one of the alternate modes, will result in the corresponding special cycle being run. Moving from Normal to any other mode does not close (precharge) any banks that may be open (activated). Under most circumstances, software must run a precharge-all cycle when transitioning out of Normal Read/Write mode. SyncFlash command register read/write sequences are the one exception that does not require a software initiated precharge. Operating mode details are provided in Section 19.7, "SDRAM Operation," and Section 19.8, "SyncFlash Operation." Reset initializes the operating mode to "Normal Read/Write".	000 = Normal Read/Write 001 = Precharge Command 010 = Auto-Refresh Command 011 = Set Mode Register Command 100 = Reserved 101 = Reserved 110 = SyncFlash Load Command Register 111 = SyncFlash Program Read/Write

Programming Model

Table 19-6. SDRAM 0 Control Register and SDRAM 1 Control Register Description (continued)

Name	Description	Settings
SP Bit 27	Supervisor Protect—Restricts user accesses within the chip-select region.	0 = User mode accesses are allowed to this chip-select region. 1 = User mode accesses are prohibited. An attempted access to this chip-select region while in user mode will result in a BUS ERROR being returned back to the CPU. The chip-select will not be asserted. Read Accesses are not affected.
Reserved Bit 26	Reserved—This bit is reserved and should read 0.	
ROW Bits 25–24	Row Address Width—Specifies the number of row addresses used by the memory array. This number does not include the bank, column, or data qualifier addresses. Parameters affected by the programming of this field include the page-hit address comparators and the bank address bit locations (non-interleaved mode only).	00 = 11 01 = 12 10 = 13 11 = Reserved
Reserved Bits 23–22	Reserved—These bits are reserved and should read 0.	
COL Bits 21–20	Column Address Width—Specifies the number of column addresses in the memory array and will determine the break point in the address multiplexer. Column width is the number of multiplexed column addresses and does not include bank and row addresses, or addresses used to generate the DQM signals.	00 = 8 01 = 9 10 = 10 11 = 11

19-10 Freescale Semiconductor

Table 19-6. SDRAM 0 Control Register and SDRAM 1 Control Register Description (continued)

Name	Description	Settings
IAM Bit 19	(Bank¹) Interleaved Address Mode—Controls bank address alignment. Bank addresses fall between the row and column addresses, resulting in an interleaved memory map with the banks alternately striped through the memory region. They are more significant than row and column addresses and result in a linear addressing of the banks through the memory map. Bank address bit placement has a significant effect on how well the SDRAM page buffers are used, with a corresponding impact on system performance. The SDRAM Controller supports two bank address alignments which will satisfy most system requirements. See Figure 19-2 for memory bank interleaving options. Note: Memory address linearity is of little concern to the user when the memory is comprised of RAM devices, however, it is of utmost importance when the memory is not-volatile and erase/program is block oriented. Flash memories are an example of a block oriented memory. Choosing the interleaved (IAM = 1) address option will generally require the user to erase the memory in multiples of 4 times the block size (for example, 256k x 4, or 1 Mbyte for the 64 Mbit Micron SyncFlash). Programming can still occur on a page by page basis, however executing out of the device being programmed may not be possible because the code is likely to cross a page boundary into the bank being programmed. If the device is programmed outside the system, the data must be shuffled to account for the interleaved blocks. For these reasons, it is recommended that the user choose linear addressing (IAM = 0) for block oriented devices.	 0 = Linear Address Map. Addresses flow through each page in the first bank, into the second bank, and so on. See Figure 19-2. Linear Addressing is best suited to applications with large continuous blocks of linear accessed data such as an LCD display buffer. 1 = Interleaved Address Map. Addresses flow through one page in the first bank, to one page in the second, to the third, etc. The banks alternate at each SDRAM page boundary. See Figure 19-2. Interleaved Mapping is better suited for ARM9 code space. The interleaving of the banks eliminates the need to continually open and close pages when loops and LRW constants cross page boundaries, resulting in higher system throughput.
Reserved Bit 18	Reserved—This bit is reserved and should read 0.	
DSIZ Bits 17–16	SDRAM Memory Data Width—Defines the width of the SDRAM memory and its alignment on the external data bus. 16-bit ports may be aligned to either the high or low half-word to equalize capacitive loading on the bus. A hardware reset loads this control field from the boot source selection (bootmod[1:0]) to the SDRAM1 control register.	00 = 16-bit aligned to D[31:16] 01 = 16-bit aligned to D[15:0] 1x = 32-bit memory
SREFR Bits 15–14	SDRAM Refresh Rate—Enables/Disables SDRAM refresh cycles and controls the refresh rate. Refresh cycles are referenced to a 32 kHz clock. At each rising edge, 1, 2, or 4 rows will be refreshed. Multiple refresh cycles are separated by the row cycle delay specified in the SRC control field.	See Table 19-7 on page 19-13 for bit and field settings.

Programming Model

Table 19-6. SDRAM 0 Control Register and SDRAM 1 Control Register Description (continued)

Name	Description	Settings
CLKST Bits 13–12	Clock Suspend Time-out—Determines if and when the SDRAM will be placed in a clock suspend condition. The suspend time-out can be triggered either on the absence of an active bank also called Precharge Powerdown (CLKST = 01) or on a clock count from the last access also called Active Powerdown (CLKST = 10 or 11). Count-based time-outs do not force the SDRAM into an idle condition (for example, any active banks remain open). Section 19.6.4, "Clock Suspend Low-Power Mode," provides a comprehensive description of this operating mode.	00 = Disabled 01 = Anytime all banks are inactive 10 = 64 clocks after completion of last access (Precharge Powerdown). 11 = 128 clocks after completion of last access (Active Powerdown).
Reserved Bits 11–10	Reserved—These bits are reserved and should read 0	
SCL Bits 9–8	SDRAM CAS Latency—Determines the latency between a read command and the availability of data on the bus. This field does not affect the second and subsequent data words in a burst, and has no effect on write cycles.	00 = Reserved 01 = 1 clock 10 = 2 clocks 11 = 3 clocks Note: See Figure 19-3 on page 19-14 CAS Latency Timing diagram.
Reserved Bit 7	Reserved—This bit is reserved and should read 0.	
SRP Bit 6	SDRAM Row Precharge Delay—Determines the number of idle clocks inserted between a precharge command and the next-row activate command to the same bank.	0 = 3 clocks inserted 1 = 2 clocks inserted
SRCD Bits 5–4	SDRAM Row-to-Column Delay—Determines the number of clocks inserted between a row activate command and a subsequent read or write command to the same bank. See Figure 19-5.	00 = 4 clocks inserted 01 = 1 clock inserted 10 = 2 clocks inserted 11 = 3 clocks inserted
Reserved Bit 3	Reserved—This bit is reserved and should read 0.	
SRC Bits 2–0	SDRAM Row Cycle Delay—Determines the minimum delay (in number of clocks) between a refresh and any subsequent refresh or read/write access. This delay corresponds to the minimum row cycle time captured in the tRC/tRFC memory timing spec. An example timing diagram for SRC = 3 can be found in Figure 19-6. Note: The SRC control field is not used to enforce t_{RC} timing for row activate to row activate within the same bank. The sum of t_{RCD} + CAS latency + t_{RP} (reads) and t_{RCD} + t_{WR} + t_{RP} (writes) must be greater than t_{RC} (SRC).	000 = 8 clocks 001 = 1 clock 010 = 2 clocks 011 = 3 clocks 100 = 4 clocks 101 = 5 clocks 110 = 6 clocks 111 = 7 clocks

^{1.} Placing the MC9328MXS SDRAM controller in Bank Interleaved mode is not the same as SDRAM Interleaved mode. For Bank Interleaved mode, the SDRAM memory must be programmed to sequential or linear mode in the SDRAM mode register.

19-12 Freescale Semiconductor

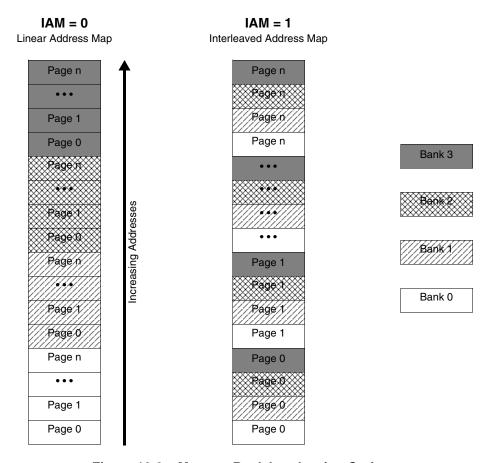


Figure 19-2. Memory Bank Interleaving Options

Table 19-7. Settings for SREFR Field

SREFR	Rows Each Refresh Clock	~Row/64ms @ 32 kHz	Row Rate @ 32 kHz	~Row/64ms @ 32.768 kHz	Row Rate @ 32.768 kHz							
00		Refresh disabled										
01	1	2048	31.25 μs	2097	30.52 μs							
10	2	4096	15.62 μs	4194	15.26 μs							
11	4	8192	7.81 μs	8388	7.63 μs							

Programming Model

CAS Latency = 3

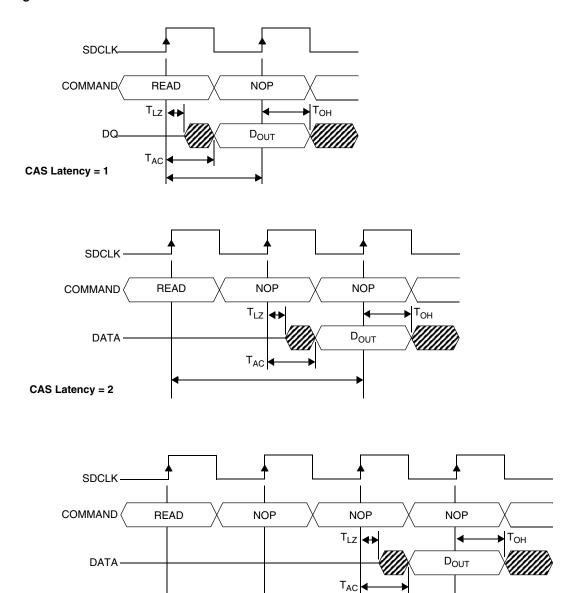


Figure 19-3. CAS Latency Timing

19-14 Freescale Semiconductor

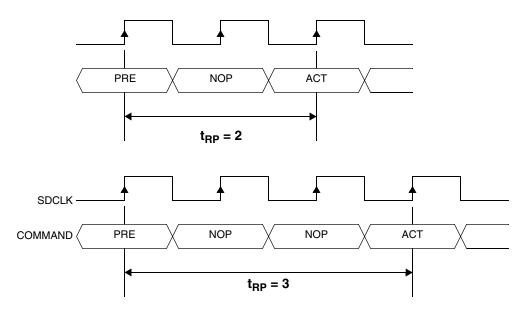


Figure 19-4. Precharge Delay Timing

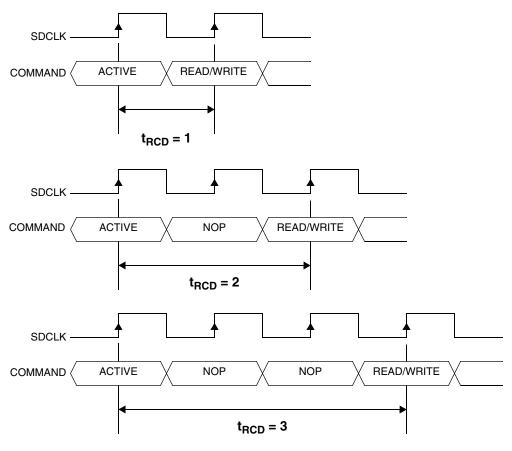


Figure 19-5. Row-to-Column Delay Timing

Programming Model

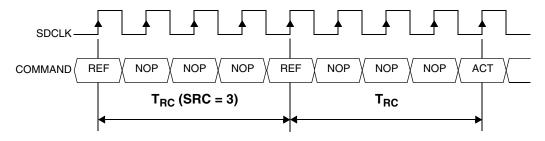


Figure 19-6. Row Cycle Timing

19.4.2 SDRAM Reset Register

The write-only SDRAM Reset Register controls the reset pulse timing.

SDRS	Т			SDRAM Reset Register								Addr 0x00221018				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	RS	ST														
TYPE	W	W	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET	0x0000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							

Table 19-8. SDRAM Reset Register Description

Name	Description	Settings
RST Bits 31–30	Software Initiated Local Module Reset Bits—Generates local module reset to SDRAM/SyncFlash controller.	00 = No effect to the SDRAMC 01 = One HCLK cycle reset pulse 10 = One HCLK cycle reset pulse 11 = Two HCLK cycle reset pulse
Reserved Bits 29–0	Reserved—These bits are reserved and should read 0.	

19-16 Freescale Semiconductor

19.4.3 Miscellaneous Register

MISCE	CELLANEOUS Miscellaneous Register												0x(Addr 0x00221014		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	OMA															
TYPE	rw	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
																RMA0
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESEI								0x00	00							

Table 19-9. Miscellaneous Register Description

Name	Description	Settings					
OMA Bit 31	Multiplexed Address Override—Enables/Disables the MA0 pin to be a meaningful bit. The multiplexed address, original MA0, is always zero at read access in 16-bit port memory configuration. This introduces difficulty with the SyncFlash read-device configuration which requires that the address ranges from 0 to 3. Working with bit 0 in tandem, this overrides the original MA0 generated by the internal address multiplexer during the 16-bit SyncFlash read-device configuration command.	0 = Address from internal address multiplexed is routed out to MA0 1 = Force RMA0, bit 0, out to MA0 pin					
Reserved Bits 30–1	Reserved—These bits are reserved and should read 0.						
RMA0 Bit 0	MA0 Replacement—Contains value of MA0 when OMA is set.						

Code Example 19-1 is a programming example for SyncFlash read-device configurations.

Code Example 19-1. Read-Device

```
HWSF read device ID
                     r2, 0x8000001
              ldr
                                                  //force ma0 to 1
              ldr
                     r8, 0x00221014
                     r2, (r8)
              str
                                                  //read SyncFlash device ID
                     r8, 0x0c000000
              ldr
                     r2, (r8,0)
r1, 0x00d3
r1, r2
              ldrh
              ldr
              cmp
                     ERROR OUT
              bt
                                                  //release ma0
              ldr
                     r2, 0x00000000
                     r8, 0x00221014
              ldr
              str
                     r2, (r8)
```

MC9328MXS Reference Manual, Rev. 1

Operating Modes

19.5 Operating Modes

Each of the SDRAM Controller operating modes is described in this section, including details on basic operation, relationship to SDRAM/SyncFlash operating modes, and any special precautions to observe. State and timing diagrams are included where appropriate.

19.5.1 SDRAM and SyncFlash Command Encoding

Table 19-10 summarizes the command encodings used by the SDRAM controller. This command list is a subset of the commands defined by the JEDEC standard. Note that the SDRAM Auto, Self-Refresh, and SyncFlash Load Command register commands share the same encoding. Also note, that encodings are based from the view of the SDRAM memory to the controller, and therefore use SDRAM signal names. See Figure 19-46 on page 19-51 for an example.

Function	Symbol	CKEn-1	CKEn	CS	RAS	CAS	WE	A11	A10	BA[1:0]	A[9:0]
Deselect	DSEL	Н	Х	Н	Х	Х	Х	Х	Х	Х	Х
No operation	NOP	Н	Х	L	Н	Н	Н	Х	Х	Х	Х
Read	READ	Н	Х	L	Н	L	Н	V	L	V	V
Write	WRIT	Н	Х	L	Н	L	L	V	L	V	V
Bank activate	ACT	Н	Х	L	L	Н	Н	V	V	V	V
Burst terminate	TBST	Н	Х	L	Н	Н	L	Х	Х	V	Х
Precharge select bank	PRE	Н	Х	L	L	Н	L	Х	L	V	Х
Precharge all banks	PALL	Н	Х	L	L	Н	L	Х	Н	Х	Х
Auto-refresh	CBR	Н	Х	L	L	L	Н	Х	Х	Х	Х
SyncFlash load command register	LCR	Н	Х	L	L	L	Н	Х	Х	V	V
Self refresh entry	SLFRSH	Н	L	L	L	L	Н	Х	Х	Х	Х
Self refresh exit	SLFRSHX	L	Н	Н	Х	Х	Х	Х	Х	Х	Х
Power-down entry	PWRDN	Н	L	Х	Х	Х	Х	Х	Х	Х	Х
Power-down exit	PWRDNX	L	Н	Н	Х	Х	Х	Х	Х	Х	Х
Mode register set	MRS	Н	Х	L	L	L	L	L	L	V	V

Table 19-10. SDRAM and SyncFlash Command Encoding

Assertion of the sd_rst signal initializes the controller into the idle state. As long as the SDRAM Controller is not the boot source, that assertion also disables the module. While disabled, the controller remains in the idle state with the internal clocks stopped.

If the SDRAM Controller has been selected as the boot device, then the module is enabled following reset. The reset state of the control register allows for basic read/write operations sufficient to fetch the reset vector and execute the initialization code. A complete initialization of the controller must be performed as part of the start-up code sequence.

19-18 Freescale Semiconductor

Read/write cycles, refresh and low-power mode requests, and clock suspend time-outs will all trigger transitions out of the idle state. State transitions due to a read or write request depend on the operating mode. Other transitions require the corresponding function to be enabled in the SDCTL register. Some state transitions have been removed to minimize complexity and allow an easier understanding of the basic controller operation.

The following subsections document the operation of each of the operating modes.

19.5.2 Normal Read/Write Mode (SMODE = 000)

The Normal Read/Write mode (SMODE = 000) is used for general read and write access to the SDRAM controller, and for reads of the SyncFlash. SyncFlash writes use the SyncFlash Program mode (See Section 19.5.7, "SyncFlash Program Mode.") Both single and burst accesses are supported, although burst requests are limited to a length of 8 words (one word = 32 bits).

Read or write requests to the SDRAM Controller initiate a check to see whether the page is already open. This check consists of comparing the request address against the last row accessed within the corresponding bank. If the rows are different, it indicates that a precharge has occurred after the last access, or there has never been an access to the bank. In that case, the access must follow the "off-page" sequence. If the requested row and last row match, the shorter "on-page" access is used.

An off-page sequence must first activate the requested row, an operation which is analogous to a conventional DRAM RAS cycle. An activate cycle is the first operation depicted in Figure 19-7. During the activate cycle, the appropriate chip-select is driven low, the row addresses are placed on the multiplexed address pins, the non-multiplexed addresses are driven to their respective values, write enable is driven high, \overline{CAS} is driven high, and \overline{RAS} is driven low. These latter three pins form the SDRAM command word. The data bus is unused during the activate command.

When the selected row has been activated, the read operation begins after the row-to-column delay (t_{RCD}) has been met. This delay is either 2 or 3 clocks, as determined by the SRCD field of the appropriate control register. During the read cycle, the chip-select is once again asserted, the column addresses are driven onto the multiplexed address bus, the non-multiplexed addresses remain driven to the value presented during the activate cycle, the write enable is driven high, \overline{RAS} is driven high, and \overline{CAS} is driven low. After the CAS latency has expired, data is transferred across the data bus. CAS latency is programmable via the SCL field of the control register. As data is being returned across the AHB, transfer acknowledge is asserted back to the CPU indicating that the CPU must latch data. While data is still on the bus, the SDRAM Controller must begin monitoring transfer requests because the CPU is free to issue the next bus request on the same edge that data is being latched.

Data transfers can be either single operand or a burst of up to 8 operands. Burst requests are designated as such by the \overline{P} -BURST attribute. It is activated by the load multiple command from the ARM920T core when the data or instruction cache is enabled. This AHB signal is asserted low for all except the last operand of a burst transfer. Non-burst transfers do not assert the signal.

SDRAM memories assume that all transfers are burst transfers unless terminated early. Burst transfers can be terminated by a variety of mechanisms: another read or write cycle, a precharge operation, or a burst terminate command. Burst terminate commands are the general mechanism used by the SDRAM controller for early burst termination. The burst terminate command is subject to the CAS latency and must be pipelined similar to the Read command, as shown in Figure 25-7 and Figure 25-8. When a load-multiple command is executed, the SDRAM controller will not issue a burst terminate command.

SDRAM write cycles are different than read cycles in one important aspect. Whereas read data was delayed by the CAS latency, write data has no delay and is supplied at the same time as the Write command. Figure 25-13 illustrates an off-page write cycle followed by an on-page write cycle. Note that the write data is driven during the same clock that the Write command is issued. The SDRAM controller only supports single burst writes and does not issue a burst terminate after each write. Therefore, the user must make sure to program the SDRAM memory's

Operating Modes

mode control register for single burst writes for proper operation. The SDRAM controller does, however, have the capability to issue "single-clock-cycle" writes. This is different than the traditional burst writes, where the WRITE command and column address are presented on the bus during the first write data, and the SDRAM memory internally increments its address. In the case of the MC9328MXS, each data to be written to the SDRAM is accompanied with both the WRITE command and the associated column address that is being written to. This still achieves the same bandwidth that the burst write would. However, to take advantage of this feature, the data cache of the ARM920T core must be enabled and the MMU set up with a page table such that the desired region of the SDRAM memory map is cacheable. Also, the SDRAM controller does not issue a burst terminate command after the end of a series of burst write, it simply discontinues the WRITE command.

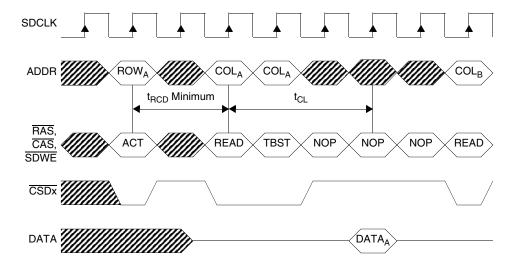


Figure 19-7. Off-Page Single Read Timing Diagram (32-Bit Memory)

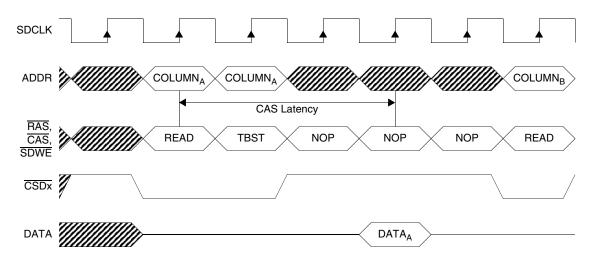


Figure 19-8. On-Page Single Read Timing Diagram (32-Bit Memory)

19-20 Freescale Semiconductor

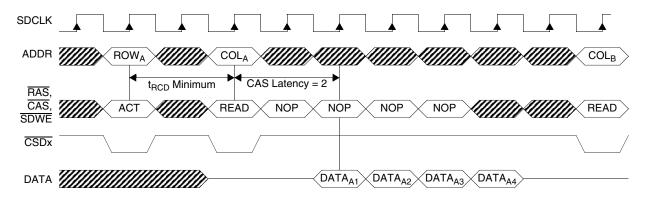


Figure 19-9. Off-Page Burst Read Timing Diagram (32-Bit Memory)

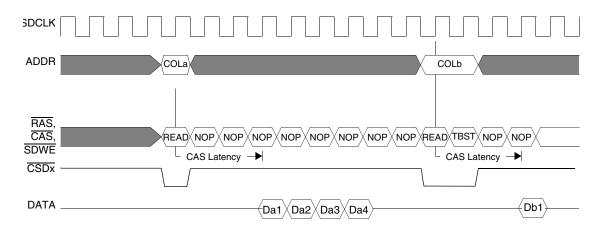


Figure 19-10. On-Page Burst Read Timing Diagram (32-Bit Memory)

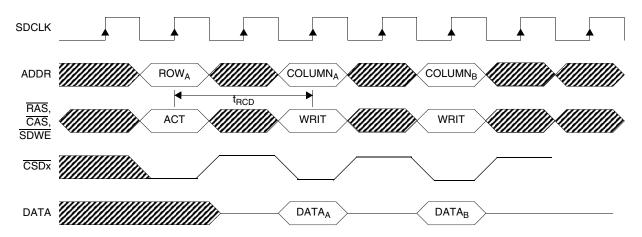


Figure 19-11. Off-Page Write Followed by On-Page Write Timing Diagram

Operating Modes

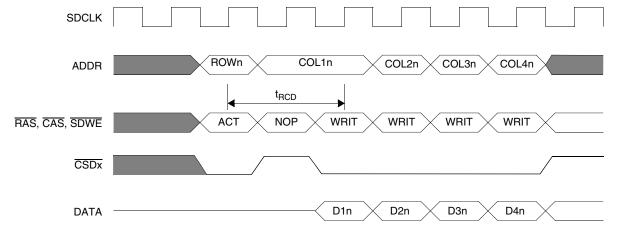


Figure 19-12. Off-Page Burst Write Timing Diagram

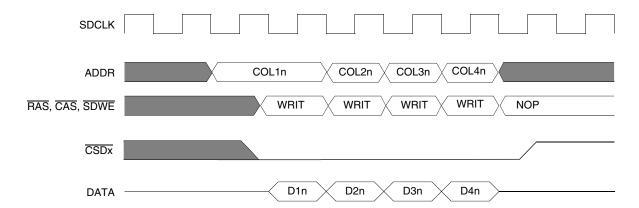


Figure 19-13. On-Page Burst Write Timing Diagram

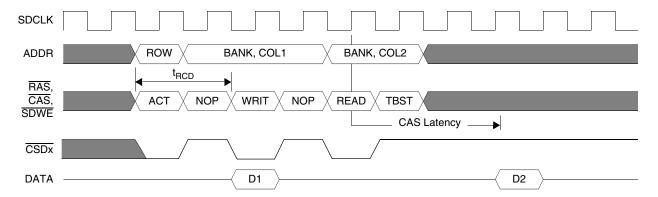


Figure 19-14. Single Write Followed by On-Page Read Timing Diagram

19-22 Freescale Semiconductor

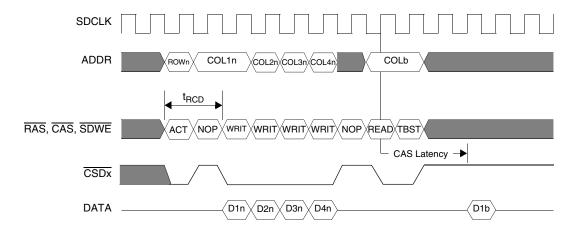


Figure 19-15. Burst Write Followed by On-Page Read Timing Diagram

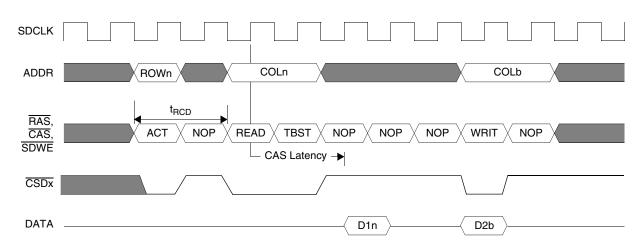


Figure 19-16. Single Read Followed by On-Page Write Timing Diagram

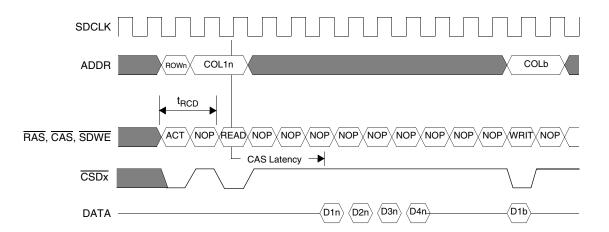
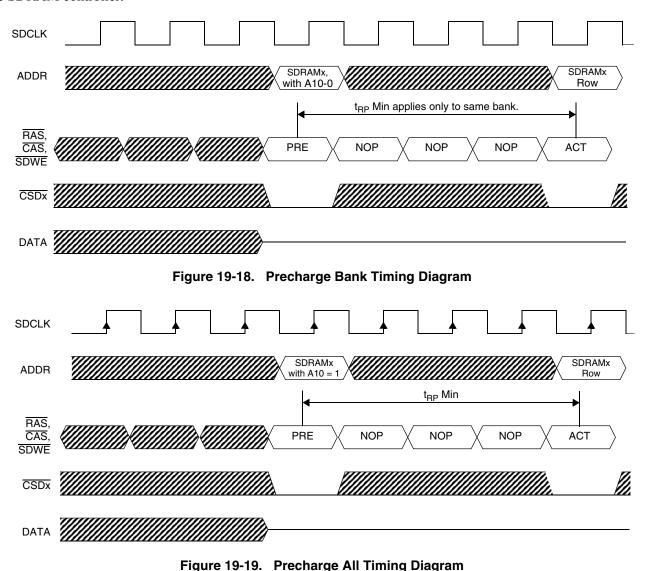


Figure 19-17. Burst Read Followed by On-Page Write Timing Diagram

19.5.3 Precharge Command Mode (SMODE = 001)

The Precharge Command Mode (SMODE = 001) is used during SDRAM device initialization, and to manually deactivate any and all active banks. While in this mode, an access (either read or write) to the SDRAM address space will generate a precharge command cycle. SDRAM address bit A10 determines whether a single bank, or all banks, are precharged by the command. (See Figure 19-18). Accessing an address with the SDRAM address A10 low will precharge only the bank selected by the bank address. Conversely, accesses with A10 high will precharge all banks regardless of the bank address. Note that A10 is the SDRAM pin, not the ARM920T processor's address. Translation of the SDRAM A10 address bit to the corresponding ARM920T processor's address is dependent on the memory configuration. The precharge command access is two clocks in length on the AHB, and one cycle to the SDRAM controller.



rigule 13-13. Flecharge All Hilling Diagram

19-24 Freescale Semiconductor

19.5.4 Auto-Refresh Mode (SMODE = 010)

The Auto-Refresh Mode (SMODE = 010) is used to manually request SDRAM refresh cycles. It is normally used only during device initialization because the SDRAM Controller will automatically generate refresh cycles when properly configured. The auto-refresh command refreshes all banks in the device, so the address supplied during the refresh command only needs to specify the correct SDRAM device. The lower address lines are ignored. Either a read or write cycle may be used. If a write is used, the data will be ignored and the external data bus will not be driven. The cycle will be 2 clocks on the AHB and a single clock to the SDRAM device.

The SDRAM Controller guarantees that the SDRAM is in the idle state before the auto-refresh command is given. If one or more rows are active, a precharge-all command will be issued prior to the auto-refresh command. The precharge-all command adds one additional clock to the access time.

Figure 19-20 on page 19-25 provides the software initiated Auto-Refresh timing diagram.

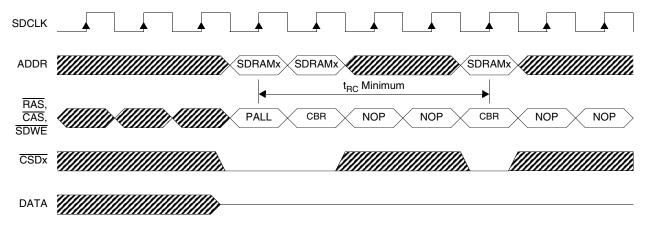


Figure 19-20. Software Initiated Auto-Refresh Timing Diagram

NOTE:

SDRAM devices require a minimum delay of t_{RC} between refresh cycles. The SDRAM Controller incorporates a timer to guarantee this timing is met. The timer is user configurable through the SRC field in the SDCTLx register.

19.5.5 Set Mode Register Mode (SMODE = 011)

The Set Mode Register mode (SMODE = 011) is used to program the SDRAM/SyncFlash mode register. This mode differs from normal SDRAM write cycles because the data to be written is transferred across the address bus. Reads of the mode register are not allowed.

Either a read or write cycle may be used for this transfer. In the case of a write, the AHB data will be ignored and the external data bus will not be driven. The row and bank address signals are used to transfer the data. The cycle will be 2 clocks on the AHB and a single clock to the SDRAM device.

Figure 19-21 and Figure 19-22 illustrate the bus sequence for a mode register set operation. Mode register set commands must be issued while the SDRAM is idle.

The SDRAM Controller does not guarantee that the SDRAMs have returned to the idle state before issuing the mode register set command. Therefore, software must generate a precharge all sequence before issuing the mode register set command if there is any possibility that one or more banks could be active. Also keep in mind that the row cycle time (t_{RC}) must be met before the mode register set command is issued.

Operating Modes

Section 19.7.4, "Mode Register Programming," provides a detailed example of the mode register data value calculation and mapping to the ARM920T processor's address.

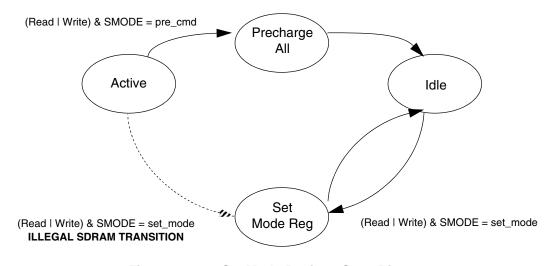


Figure 19-21. Set Mode Register State Diagram

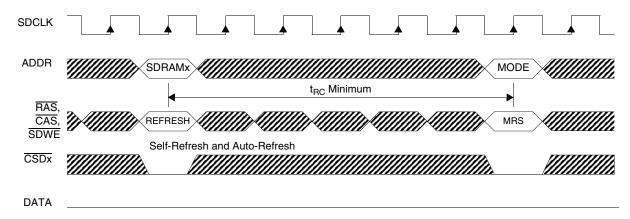


Figure 19-22. Set Mode Register Timing Diagram

19.5.6 SyncFlash Load Command Mode

SyncFlash memories extend the standard SDRAM command set to include device-specific program, erase, and configure commands. These proprietary operations use a 3 command sequence: Load Command register, Activate, and Read or Write. The Load Command Register serves as an "escape" code to provide special meaning to the read or write commands which follow. The 3 command sequences must always occur in the correct order, however any number of NOPs can be inserted between them. The Load Command Register command is mapped to the same encoding as the SDRAM Auto-Refresh and Self-Refresh commands.

The SyncFlash Load Command mode provides the mechanism for software to generate the first command in the sequence. By toggling between this mode and Normal Read/Write any of the command triplets can be generated.

An example of a configuration register read is shown in Figure 19-23. The first bus cycle places the SDRAM Controller in the Load Command Register Mode. The following bus cycle begins the first command of the triplet by loading the command register with the desired operation code. Because the operation code is transferred across the address bus, either a read or write bus cycle could have been used for this cycle. The third bus cycle returns the

MC9328MXS Reference Manual, Rev. 1

19-26 Freescale Semiconductor

SDRAM Controller to the normal read/write mode. Finally, the fourth cycle performs the actual read of the configuration register. Although not shown in the diagram, the device configuration data would be returned across the data bus after the CAS latency had been met. The activate and read comprise the final two commands in the triplet and must refer to the same bank as the original command register load. Changes to the bank address within the triplet will return indeterminate results. Details on command register encodings and operation are covered in Section 19.8.4, "SyncFlash Configuration."

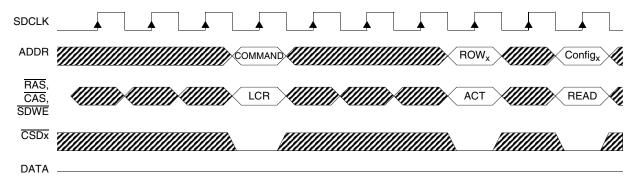


Figure 19-23. Load Command Register Timing Diagram

19.5.7 SyncFlash Program Mode

SyncFlash programming and status checking operations require the same 3 command sequence described in Section 19.5.6. Because these operations are repeated many thousands of times to program the entire array, a hardware programming mode is provided as an alternative to the software-intensive method previously described.

SyncFlash programming mode implements two command sequence triplets: a program sequence (write) and a status check sequence (read). The state diagram for these two sequences is illustrated in Figure 19-24.

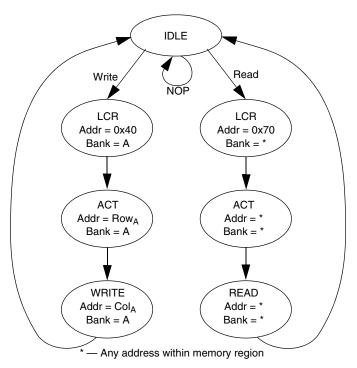


Figure 19-24. SyncFlash Program Mode State Diagram

MC9328MXS Reference Manual, Rev. 1

General Operation

A write to an address within the memory region initiates the program sequence. The first command issued to the SyncFlash is Load Command register. A [7:0] determines which operation the command performs. For this write setup operation, an address of 0x40 is hardware generated. The bank and other address lines are driven with the address to be programmed. The second command, Active, registers the row address and confirms the bank address. The third command supplies the column address, re-confirms the bank address, and supplies the data to be written. SyncFlash does not support burst writes, therefore a Burst Terminate command is not required.

A read to the memory region initiates the status read sequence. The first command issued to the SyncFlash is the Load Command Register with A [7:0] set to 0x70 which corresponds to the Read Status Register operation. The bank and other address lines are driven to the selected address. The second command, Active, sets up the status register read. The bank and row addresses are driven during this command. The third command of the triplet is Read. Bank and column addresses are driven on the address bus during this command. Data is returned from memory on the low-order 8 data bits following the CAS latency.

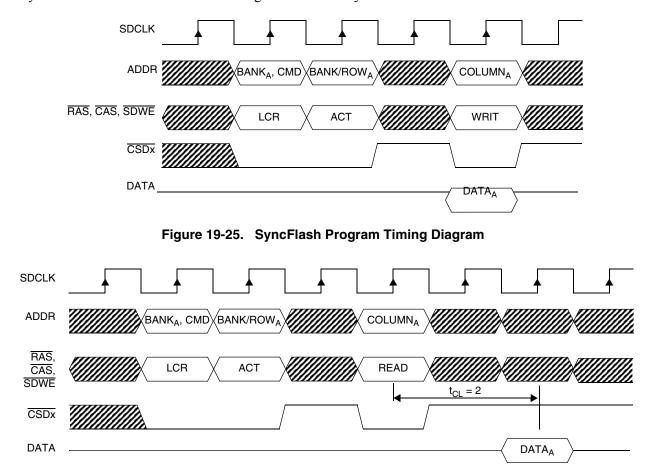


Figure 19-26. SyncFlash Read Status Register Timing Diagram

19.6 General Operation

The general operation of the SDRAM controller is discussed in this section and includes address multiplexing, refresh and self-refresh modes. The SDRAM Controller is designed to support a broad range of JEDEC standard SDRAM configurations including devices of 64-, 128-, and 256-Mbit densities. Given the physical size constraints of the target applications, the design was optimized for a memory device data width of 32 bits. Table 19-11

MC9328MXS Reference Manual, Rev. 1

19-28 Freescale Semiconductor

summarizes the devices targeted by the design. The controller is capable of interfacing with devices of other widths and densities, however, only devices with 4 banks are supported. A 100 MHz system bus operation is possible with PC100 compliant single data rate memory devices.

	SDRAM Configuration										
Item	64 1	Mbit	128	Mbit	256 Mbit						
Bus Width	16	32	16	32	16	32					
Depth	4 Mword	2 Mword	8 Mword	4 Mword	16 Mword	8 Mword					
Refresh Rows	4096 (15.62 μs)	4096 (15.62 μs)	4096 (15.62 μs)	4096 (15.62 μs)	8192 (7.81 μs)	8192 (7.81 μs)					
# Banks	4	4	4	4	4	4					
Bank Address	2	2	2	2	2	2					
Row Address	12	11	12	12	13	13					
Column Address	8	8	9	8	9	8					
Data Qualifiers	2	4	2	4	2	4					

Table 19-11. JEDEC Standard Single Data Rate SDRAMs

19.6.1 Address Multiplexing

The JEDEC standard SDRAMs for which the controller was optimized, use an asymmetrical array architecture with more row than column address lines. The SDRAM Controller multiplexes only those pins which change between the row and column addresses. The remaining (most significant) row addresses and the bank addresses are not multiplexed.

19.6.1.1 Multiplexed Address Bus

The SDRAM Controller multiplexed address bus is aligned to the column addresses so that address line A1 always appears on pin MA0. With this alignment, the "folding point" in the multiplexor is driven solely by the number of column address bits, although interleave mode causes a two bit shift to account for the bank addresses. Column bus widths of 8 to 11 bits are supported in non-interleave mode, although only 8 and 9 bit widths are allowed in interleave mode. Table 19-12 summarizes the multiplex options supported by the controller. Column addresses through A10 are driven regardless of the multiplexor configuration, although some of the lines will be unused for the smaller page sizes.

Memory width does not affect the multiplexer; however, it does affect how the memories are connected to the SDRAM Controller pins. The width of the multiplexed bus is one bit larger than in previous generations of the SDRAMC so that 32-bit memory systems can be supported with a minimal impact on the multiplex hardware because 32-bit memory systems are shifted left by one bit and use MA [n+1:1]. This is demonstrated in the last two rows of Table 19-12 by the grayed-out boxes. Note that the AP signal is duplicated in two bit positions to permit this signal to always appear on memory pin A10. Table 19-13 lists the SDRAM interface connections for different configurations of JEDEC SDRAM.

General Operation

Table 19-12. Address Multiplexing by Column Width

Column Bits		Memory	SDRAM Controller Pin												
IAM=0	IAM=1	Width	MA1 1	MA1 0	MA9	MA8	MA7	MA6	MA5	MA4	МАЗ	MA2	MA1	MA0	
			ROW												
8	-	32	A20	A19	A18	A17	A16	A15	A14	A13	A12	A11	A10	A9	
9	-	32	A21	A20	A19	A18	A17	A16	A15	A14	A13	A12	A11	A10	
10	8	32	A22	A21	A20	A19	A18	A17	A16	A15	A14	A13	A12	A11	
11	9	32	A23	A22	A21	A20	A19	A18	A17	A16	A15	A14	A13	A12	
			COLUMN												
Α	LL	32	AP	AP	A10	A9	A8	A7	A6	A 5	A4	А3	A2	A1	

Indicates address lines not required for this memory width.

Table 19-13. MC9328MXS to SDRAM Interface Connections

Memory Configuration			8Mx16Bits x 2 Chips (32 Mbyte)		16M x 16 Bits x 2 Chips (64 Mbyte)		2M x 32 Bits x 1 Chip (8 Mbyte)		4Mx32Bits x 1 Chip (16 Mbyte)		8M x32Bits x 1 Chip (32 Mbyte)	
i.MX Pins		SDRAM Memory Address Pins										
Rows	1	2	1	2	1	3	1	1	1	2	13	
Columns	;	3	9	9	,	9	8	3	8	3	8	3
Data size	3	32	3	2	3	2	3	2	3	2	3	2
Refresh rows	40	96	40	96	81	92	20	48	40	96	8192	
IAM	0	1	0	1	0	1	0	1	0	1	0	1
i.MX Pins					SDRA	M Memo	ry Addre	ess Pins	1			
A19				BA1		BA1						
A18		BA1		BA0		BA0		BA1		BA1		BA1
A17		BA0						BA0		BA0		BA0
A16												
A15					BA1	A12						
A14			BA1	A11	BA0	A11					BA1	A12
A13	BA1	A11	BA0		A12				BA1	A11	BA0	A11
A12	BA0		A11		A11		BA1		BA0		A12	
A11	A11						BA0		A11		A11	

MC9328MXS Reference Manual, Rev. 1

19-30 Freescale Semiconductor

Memory Configuration	4M x16Bits x 2 Chips (16 Mbyte)		8Mx16Bits x 2 Chips (32 Mbyte)		16M x 16 Bits x 2 Chips (64 Mbyte)		2M x32Bits x 1 Chip (8 Mbyte)		4Mx32Bits x 1 Chip (16 Mbyte)		8M x32Bits x 1 Chip (32 Mbyte)	
i.MX Pins		SDRAM Memory Address Pins										
MA11	A10	A10	A10	A10	A10	A10	A10	A10	A10	A10	A10	A10
MA10	A9	A9	A9	A9	A9	A9	A9	A9	A9	A9	A9	A9
A10	A8	A8	A8	A8	A8	A8	A8	A8	A8	A8	A8	A8
A9	A7	A7	A7	A7	A7	A7	A7	A7	A7	A7	A7	A7
A8	A6	A6	A6	A6	A6	A6	A6	A6	A6	A6	A6	A6
A7	A5	A 5	A 5	A 5	A5	A 5	A 5	A5	A 5	A 5	A 5	A5
A6	A4	A4	A4	A4	A4	A4	A4	A4	A4	A4	A4	A4
A5	A3	А3	A3	A3	A3	A3	A3	A3	A3	A3	А3	А3
A4	A2	A2	A2	A2	A2	A2	A2	A2	A2	A2	A2	A2
А3	A1	A1	A1	A1	A1	A1	A1	A1	A1	A1	A1	A1
A2	A0	A0	A0	A0	A0	A0	A0	A0	A0	A0	A0	A0

Table 19-13. MC9328MXS to SDRAM Interface Connections (continued)

19.6.1.2 Non-Multiplexed Address Bus

The most significant row address bits are not sampled when the column addresses are being driven, and therefore do not need to be multiplexed. The SDRAM Controller implementation takes advantage of this fact and uses the existing non-multiplexed address bus to provide these signals. Addresses A21 through A25 are needed across the supported configurations. The specific connections which will need to be made are dependent on the memory device type, density and bank interleave mode. These configuration-dependent connections are handled through the design of the external hardware. Examples are provided in Section 19.7, "SDRAM Operation," and Section 19.8, "SyncFlash Operation."

19.6.1.3 Bank Addresses

Which bank addresses of the SDRAM controller are multiplexed with which MC9328MXS address pins, depends on whether or not the memory system is in interleaved mode. For non-interleaved mode, the SDRAM controller bank addresses SDBA[4:0] are multiplexed with the address pins A[15:11]. For interleaved mode, the SDRAM controller "interleaved" bank addresses SDIBA[3:0] are multiplexed with the MC9328MXS address pins A[19:16]. Instead of detailing the complexity of how these bank addresses are multiplexed with the corresponding MC9328MXS address pins with different memory configurations, the user is directed to Table 19-13. This table explicitly shows which SDRAM memory bank address pin must be connected to which corresponding MC9328MXS address pins given different the JEDEC standard memory configurations. Also, if the user wants to derive how the density of the memory is calculated or how to derive the page size, they use the following equations:

Page Size (Bytes) = 2^{#Column Address Bits} × (Memory Width in Bits / 8) Eqn. 19-1

^{1.} Grayed-out boxes are unused.

Density (Bytes) = 2^(# Column Address Bits + # Row Address Bits) × (Memory Width in Bits / 2)

Egn. 19-2

19.6.2 Refresh

SDRAM Controller hardware satisfies all SDRAM refresh requirements after an initial configuration by the user software. 0, 1, 2, or 4 refresh cycles are scheduled at 31.25 μ S (nominal 32 kHz clock) intervals, providing 0, 2048, 4096, or 8192 refresh cycles every 64 ms. The refresh rate is programmed through the SREFR field in the SDCTLx registers. Each array can have a different rate, allowing a mix of different density SDRAMs. Refresh is disabled by hardware reset.

A refresh request is made pending at each rising edge on the 32 kHz clock. In response to this request, the hardware gains control of the SDRAM as soon as any in-process bus cycle completes. Once it has gained control of the memory, commands are issued to precharge all banks. Following a row precharge delay (t_{RP}) , an auto-refresh command is issued. At t_{RC} intervals, additional auto-refresh cycles are issued until the specified number of cycles have been run. Figure 19-27 illustrates a 2 refresh sequence.

Burst transfers in progress when the refresh request arrives are allowed to complete prior to the refresh operation. SDRAM bus accesses queued after the refresh request are held off until the refresh completes. In Figure 19-28, an access is queued just as the refresh begins. This cycle is delayed until the precharge and single refresh (SREFR = 01) cycles are run. Bus cycles targeted to other memory or peripheral devices are allowed to progress normally while the refresh is in progress. None of the pins shared between the SDRAM and other devices are required for the refresh operation.

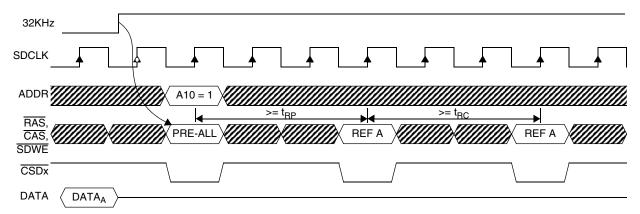


Figure 19-27. Hardware Refresh Timing Diagram

19-32 Freescale Semiconductor

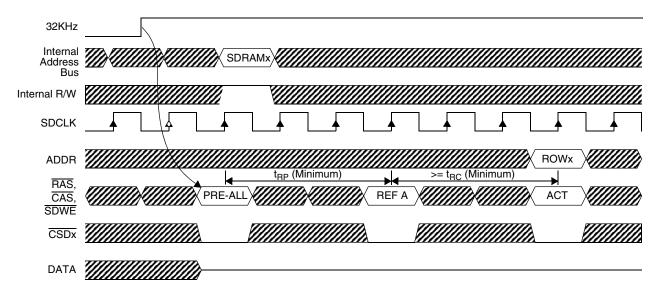


Figure 19-28. Hardware Refresh With Pending Bus Cycle Timing Diagram

19.6.3 Self-Refresh

SDRAM data must be retained during assertion of system reset (RESET_IN) and power conservation modes if refresh has been enabled. The SDRAM Controller detects these conditions and places the memory in self-refresh. If refresh has not been enabled, the SDRAM Controller places the memories in a lower power consumption mode known as Powerdown. This operation is described in Section 19.6.3.3, "Powerdown Operation During Reset and Low-Power Modes."

19.6.3.1 Self-Refresh During RESET_IN

The assertion of system reset (RESET_IN) triggers the SDRAM Controller to place the memory in self-refresh provided refresh had been previously enabled. Refresh during system reset is disabled by an SDRAM Controller reset. It remains disabled until the refresh rate is programmed to a non-zero value. Once enabled, self-refresh is invoked anytime system reset is asserted without a corresponding SDRAM reset.

19.6.3.2 Self-Refresh During Low-Power Mode

If refresh is enabled, low-power mode also forces the SDRAM into self-refresh mode. When the SDRAM Controller detects that the bus masters are entering a low-power condition it begins a self-refresh sequence once any in-progress bus access has completed. A Precharge All command is issued to close any open memory pages, the Self-Refresh command is issued, and the clock enable is brought low. Once the memories are safely in their low-power state, the SDRAMC tells the system clock controller to enter sleep mode.

19.6.3.3 Powerdown Operation During Reset and Low-Power Modes

The powerdown mode is used instead of self-refresh whenever system reset or any of the low-power modes occur and refresh has not been enabled. This memory operating mode does not remove power, as the name might imply. It simply lowers power consumption by disabling the clock input buffer and halting all internal activity. Because powerdown can only be entered if all banks are idle, a Precharge All command must be issued to the memories prior to stopping the clock. Figure 19-31 illustrates the powerdown sequence following assertion of system reset.

General Operation

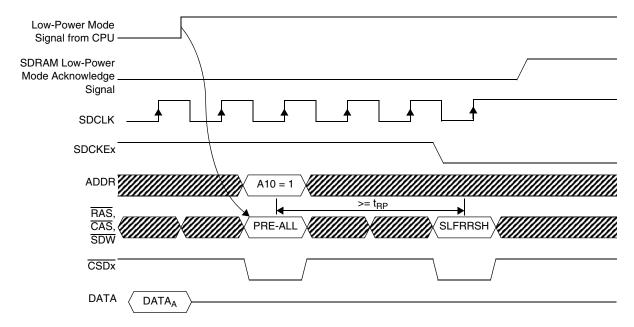


Figure 19-29. Self-Refresh Entry Due to Low-Power Mode Timing Diagram

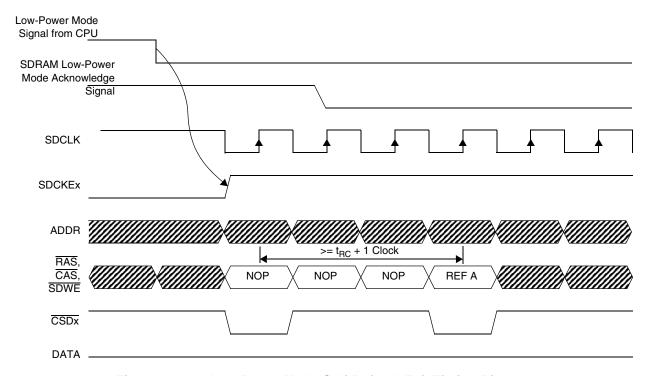


Figure 19-30. Low-Power Mode Self-Refresh Exit Timing Diagram

19-34 Freescale Semiconductor

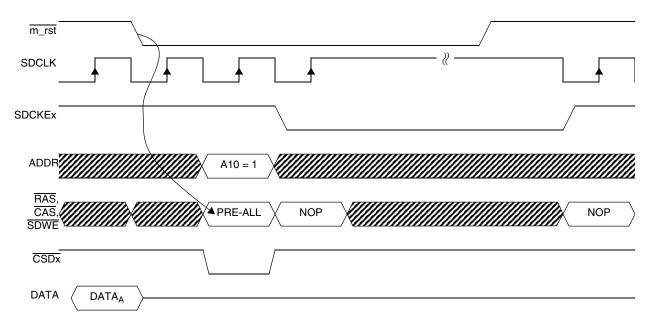


Figure 19-31. Powerdown Mode Resulting From Reset with Refresh Disabled

19.6.4 Clock Suspend Low-Power Mode

SDRAM and SyncFlash memories incorporate a command sequence to disable the clock input buffer and suspend internal activity, lowering power consumption as much as an order of magnitude. The SDRAM Controller implements a clock suspend time-out mechanism to take advantage of this feature. Several software selectable time-outs are provided to accommodate for varying system conditions, with the time-out condition being specified in the Clock Suspend Timeout (CLKST) field in the SDCTLx register. The feature is disabled out of reset.

SDRAM/SyncFlash clock suspend actually consists of two sub-modes: Clock Suspend and Powerdown. The distinguishing factor between the two is whether banks remain active while the clock is stopped. Clock suspend allows banks to remain activated, while Powerdown does not.

19.6.4.1 Powerdown (Precharge Powerdown)

Programming CLKST [1:0] = 01 causes the SDRAM Controller to place the memories in powerdown mode anytime the controller detects that no banks are active. The Precharge Powerdown mode is useful in applications where a memory array is accessed infrequently and the chances of another access to the same page are minimal.

Reading or writing to memory activates a page within the addressed bank. Reset, software generated precharge, and hardware initiated refresh are three ways to close an active bank. The periodically occurring refresh will be the normal means that invokes the powerdown mode. At each refresh interval, all banks will be closed by a precharge-all command, followed by the refresh operation. The controller will then issue the powerdown command to the memories. A few cycle delays are incurred with the first read or write cycle to restart the clocks, however only on the first cycle. After that, the clocks will continue to run until the next refresh operation or until any active banks are manually precharged.

Page misses on read and write cycles cause the addressed bank to be closed (precharged) and a new page opened within the bank. This operation does not cause the clocks to stop, nor does manually precharging only a single bank within the memory. All banks within the memory must be inactive before the powerdown mode is invoked.

19.6.4.2 Clock Suspend (Active Powerdown)

The second clock suspend mode is selected whenever CLKST [1:0] = 1x. In Active Powerdown mode the clocks are stopped after a selectable delay from the last access to the array. Active banks are not closed prior to disabling the SDRAM clock. Either 64 (CLKST [1:0] = 10) or 128 (CLKST [1:0] = 11) cycle delays are possible. SDRAM clocks are counted from the end of the last read or write access. Subsequent read or write accesses, and self-refresh modes reset the counter. Auto-refresh cycles do not affect the counter; however, if the counter expires during a refresh operation the clock will be disabled immediately following the refresh.

19.6.4.3 Refresh During Powerdown or Clock Suspend

Refresh requests queued while the clock is suspended will restart the clock, run the appropriate number of refresh cycles, and then disable the clock again.

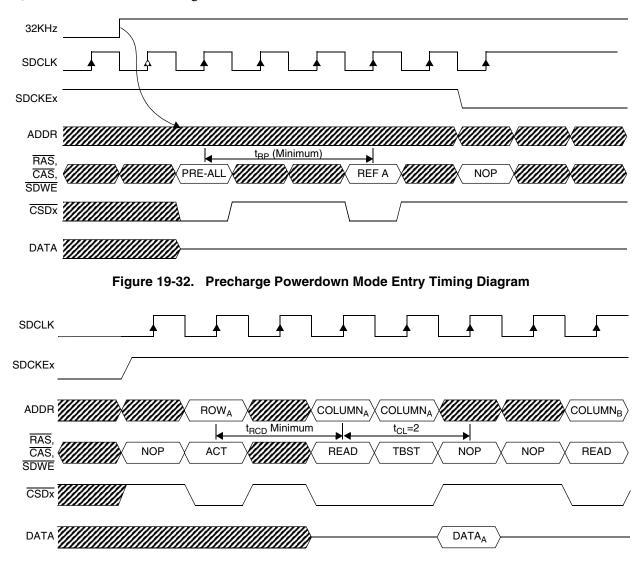


Figure 19-33. Precharge Powerdown Exit Timing Diagram

19-36 Freescale Semiconductor

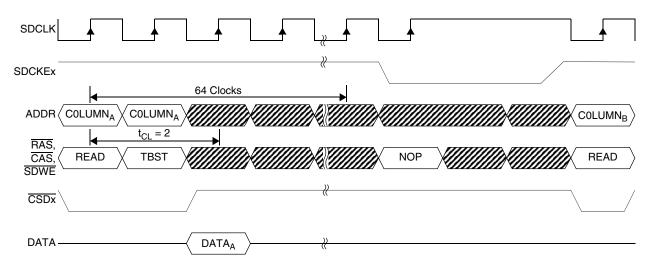


Figure 19-34. Clock Suspend (Active Powerdown) Timing Diagram

NOTE:

For each of the previous Precharge and Active Powerdown figures, it is assumed that only one chip-select has been enabled. If both chip-selects are enabled and one of the two chip-selects is not currently in a powerdown mode, then the SDCLK will continue to run even while the other chip-select is in powerdown mode since both chip selects share the SDCLK.

19.7 SDRAM Operation

The following subsections provide details on selecting compatible SDRAM memories and configuring the controller to work with the memory system.

19.7.1 SDRAM Selection

Table 19-11 on page 19-29 lists the memories around which the controller is optimized, however many other memory types are also suitable for use. Important characteristics to consider when choosing a memory module are:

- Page comparators expect 4 bank memories—2 bank devices are not supported. Their use results in the memory and controller losing synchronization when crossing page boundaries.
- Page (column) addressing must match one of the supported sizes.
- Memory density can be larger or smaller than those directly supported, although some memory may be inaccessible or redundantly mapped. In linear mode (IAM bit of the Control Register is 0), the bank addresses are the most significant addresses and connecting a memory smaller than the selected density will result in one or more banks being inaccessible.
- Controller design is for memories meeting PC100 timing specifications at 100 MHz system operation. Use of non-compliant memories or other system clock rates require a thorough analysis of all timing parameters.

SDRAM Operation

19.7.2 Configuring Controller for SDRAM Memory Array

Configuration register programming options and controller-memory physical connections provide flexibility to accommodate different memory types and system configurations. Options are broadly grouped into 3 categories:

- Physical Characteristics: row and column address bus widths, data bus width, and interleave mode
- Timing Parametrics: CAS latency, row precharge and cycle delays, and refresh rate
- Functional Features: clock suspend timer and supervisor/user protection

Table 19-20 on page 19-46 and Table 19-21 on page 19-47 are provided to assist the designer with the selection of the correct physical parameters for a number of preferred memory configurations. Timing parametrics are addressed in the following subsections.

19.7.2.1 CAS Latency

CAS latency is determined by the operating frequency and access time of the memories. For a 100 MHz system clock frequency and PC100 compliant memories, the CAS latency will generally be programmed to 3 clocks, although the memory specifications must always be consulted to confirm this value. CAS latency must be programmed in two places: the chip-select Control Register and the SDRAM Mode Register. See Table 19-6 on page 19-9 for a description of the control register encoding and Section 19.7.4, "Mode Register Programming," for the details on programming the SDRAM mode register.

19.7.2.2 Row Precharge Delay

Row precharge delay is defined as the delay between a precharge command and the next row activate command to the same bank. The SDRAM memory specification provides the minimum precharge delay as t_{RP} , usually in terms of ns. Therefore the user will have to calculate the number clocks needed for the row precharge delay and program this value into the SRP bit in SDRAM Control register described in Table 19-6 on page 19-9. For example, a t_{RP} specification of 15 ns with a 100 MHz clock (10 ns period) results in 1.5 clocks, rounded to 2.

19.7.2.3 Row-to-Column Delay

The row-to-column delay is defined as the delay between a row activate command and a subsequent read or write command. The SDRAM memory specification provides the minimum row-to-column (or ACTIVE to READ or WRITE) delay as $t_{\rm RCD}$, usually in terms of ns. Given the system bus speed, the user must calculate the number of clocks needed after an activate command is given before the subsequent read or write command and program this value into the SRCD bit field in the SDRAM Control register, as described in Table 19-6 on page 19-9. For example, a $t_{\rm RCD}$ specification of 15 ns with a 100 MHz clock (10 ns period) results in 1.5 clocks, rounded to 2.

19.7.2.4 Row Cycle Delay

Row cycle delay is defined as the delay between a refresh and any subsequent refresh or read/write access. Because the t_{RC} timing for row activate to row activate with the same bank is implicitly guaranteed by the sum of $t_{RCD} + t_{CL} + t_{RP}$, the value programmed into the SRC field in the SDRAM Control register must depend on the AUTO REFRESH period, t_{RCF} , specified in the SDRAM memory.

19-38 Freescale Semiconductor

19.7.2.5 Refresh Rate

The refresh rate is the rate by which the SDRAM controller is required to refresh each row in the SDRAM memory. The SDRAM memory specification provides the total number of rows per bank, and the corresponding refresh rate must be programmed into the SREFR field in the SDRAM control register (See Table 19-6 on page 19-9). For example, if the SDRAM memory contains 8192 rows, or requires 8192 AUTO REFRESH cycles every 64 ms, then the refresh rate can be calculated as 64 ms / 8192 rows = 7.81 µs per row. Therefore the user programs the SREFR field with 11. Refer to Section 19.6.2, "Refresh," on page 19-32 for more information.

19.7.2.6 Memory Configuration Examples

Twelve different examples of SDRAM configurations are provided in this section and shown in Figure 19-35 on page 19-40 through Figure 19-56 on page 19-70. These examples are 64 Mbit, 128 Mbit, and 256 Mbit SDRAM memories in single x16, dual x16, and single x32 configurations. All examples use bank and non-bank interleaving for address configuration. Each figure is accompanied with the control register values in Table 19-14 on page 19-40 through Table 19-49 on page 19-70.

NOTE:

The following examples assume that the number of rows and columns for each given SDRAM density follow the JEDEC standard. The SDRAM Controller can interface to SDRAMS which do not follow the JEDEC standards for row and column sizes, however the user must take care to ensure that the SDRAM Control Register bits ROW and COL are programmed to the appropriate number of rows and columns given in the SDRAM data sheet. These examples do not cover non-JEDEC standard SDRAMS.

Table 19-14. Single 4M x 16 Control Register Values

Control Field	Value				
Density	8 Mbyte				
Page Size	512				
ROW	12				
COL	8				
DSIZ	16 (D[15:0])				
IAM	Bank Interleaved				

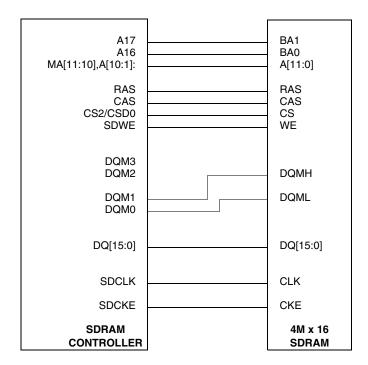


Figure 19-35. Single 64 Mbit (4M x 16) Connection Diagram (IAM = 1)

19-40 Freescale Semiconductor

Table 19-15. Single 4M x 16 Control Register Values

Control Field	Value
Density	8 Mbyte
Page Size	512
ROW	12
COL	8
DSIZ	16 (D[15:0])
IAM	Non-bank Interleaved

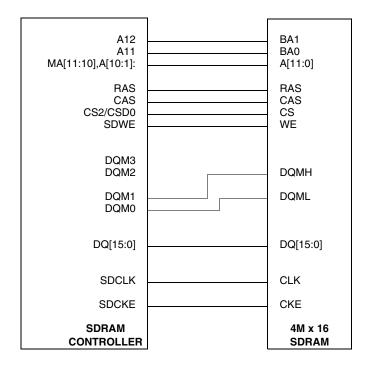


Figure 19-36. Single 64 Mbit (4M x 16 x 1) Connection Diagram (IAM = 0)

Table 19-16. Single 8M x 16 Control Register Values

Control Field	Value
Density	16 Mbyte
Page Size	1024 bytes
ROW	12
COL	9
DSIZ	16 (D[15:0])
IAM	Bank Interleaved

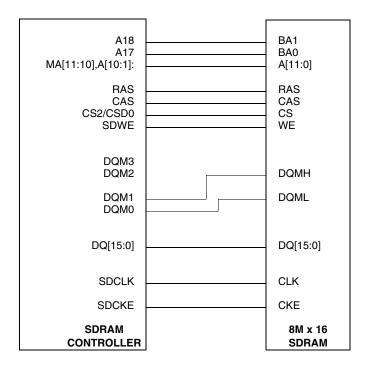


Figure 19-37. Single 128 Mbit (8M x 16) Connection Diagram (IAM = 1)

19-42 Freescale Semiconductor

Table 19-17. Single 8M x 16 Control Register Values

Control Field	Value
Density	16 Mbyte
Page Size	1024 bytes
ROW	12
COL	9
DSIZ	16 (D[15:0])
IAM	Non-bank Interleaved

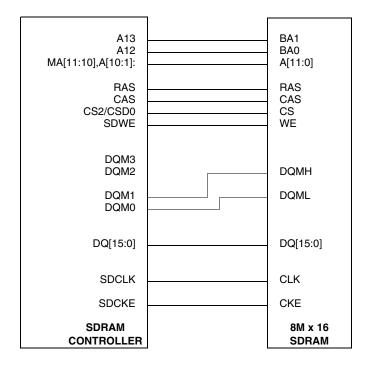


Figure 19-38. Single 128 Mbit (8M x 16) Connection Diagram (IAM = 0)

Table 19-18. Single 16M x16 Control Register Values

Control Field	Value
Density	32 Mbyte
Page Size	1024
ROW	13
COL	9
DSIZ	16 (D[15:0])
IAM	Bank-Interleaved

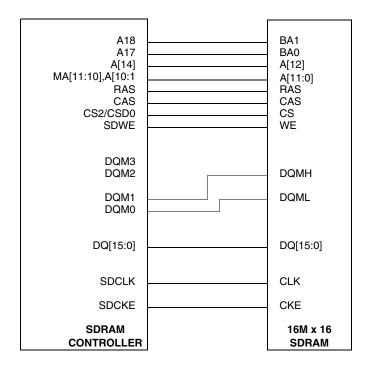


Figure 19-39. Single 256 Mbit (16M x 16) Connection Diagram (IAM = 1)

19-44 Freescale Semiconductor

Table 19-19. Single 16M x16 Control Register Values

Control Field	Value
Density	32 Mbyte
Page Size	1024
ROW	13
COL	9
DSIZ	16 (D[15:0])
IAM	Non-Bank-Interleaved

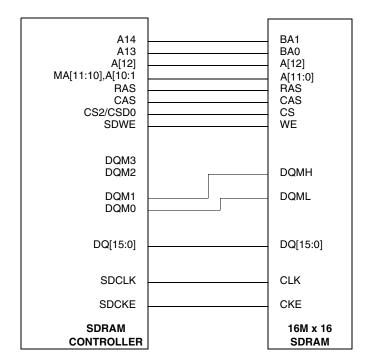


Figure 19-40. Single 256 Mbit (16M x 16) Connection Diagram (IAM = 1)

Table 19-20. Dual 64 Mbit (4M x 16 x 2) Control Register Values (IAM = 1)

Control Field	Value
Density	16 Mbyte
Page size	1024 bytes
ROW	12
COL	8
DSIZ	32 (D [31:0])
IAM	Bank-interleaved

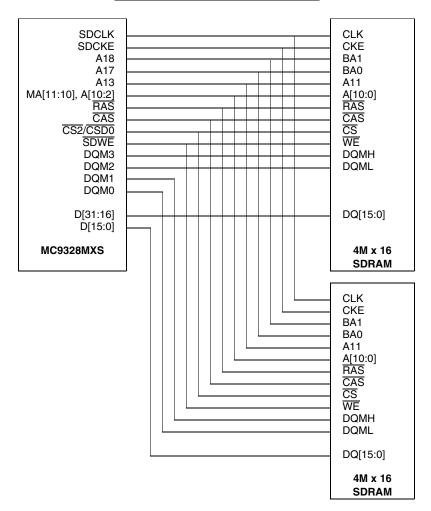


Figure 19-41. Dual 64 Mbit (4M x 16 x 2) Connection Diagram (IAM = 1)

MC9328MXS Reference Manual, Rev. 1

19-46 Freescale Semiconductor

Table 19-21. Dual 64 Mbit (4M x 16 x 2) Control Register Values (IAM = 0)

Control Field	Value
Density	16 Mbyte
Page size	1024 bytes
ROW	12
COL	8
DSIZ	32 (D [31:0])
IAM	Non-bank-interleaved

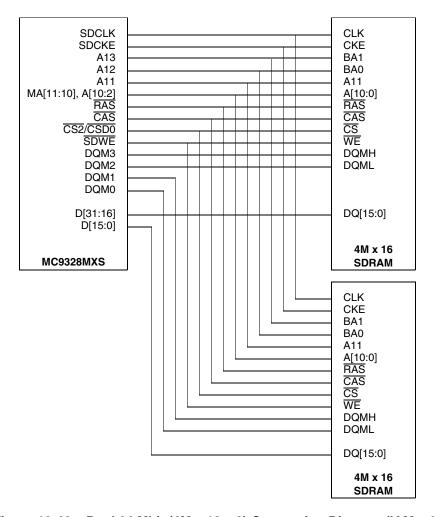


Figure 19-42. Dual 64 Mbit (4M x 16 x 2) Connection Diagram (IAM = 0)

Table 19-22. Dual 128 Mbit (8M x 16 x 2) Control Register Values (IAM = 1)

Control Field	Value
Density	32 Mbyte
Page size	2048 bytes
ROW	12
COL	9
DSIZ	32 (D [31:0])
IAM	Bank-interleaved

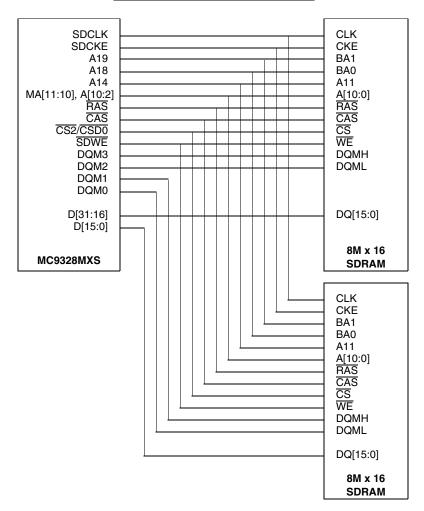


Figure 19-43. Dual 128 Mbit (8M x 16 x 2) Connection Diagram (IAM = 1)

MC9328MXS Reference Manual, Rev. 1 19-48

Table 19-23. Dual 128 Mbit (8M x 16 x 2) Control Register Values (IAM = 0)

Control Field	Value
Density	32 Mbyte
Page size	2048 bytes
ROW	12
COL	9
DSIZ	32 (D [31:0])
IAM	Non-bank-interleaved

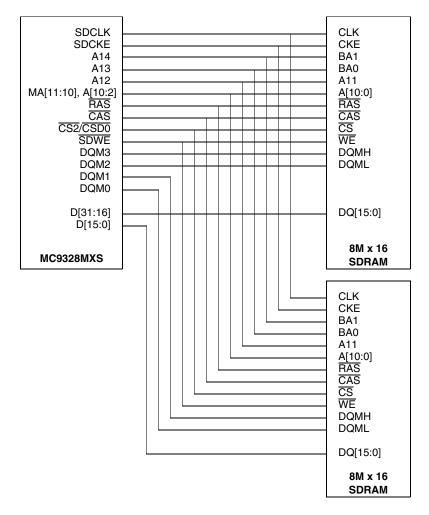


Figure 19-44. Dual 128 Mbit (8M x 16 x 2) Connection Diagram (IAM = 0)

Table 19-24. Dual 256 Mbit (16M x 16 x 2) Control Register Values (IAM = 1)

Control Field	Value
Density	64 Mbyte
Page size	2048 bytes
ROW	13
COL	9
DSIZ	32 (D [31:0])
IAM	Bank-interleaved

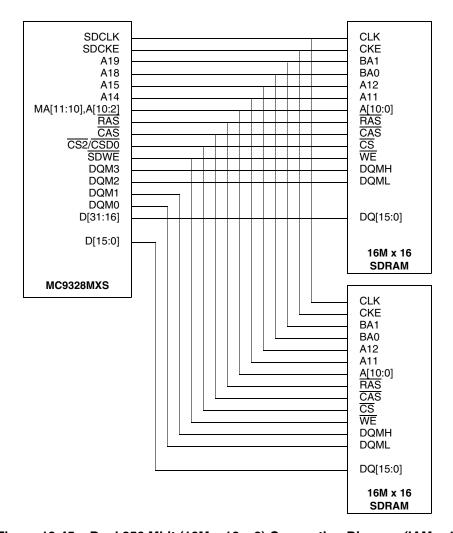


Figure 19-45. Dual 256 Mbit (16M x 16 x 2) Connection Diagram (IAM = 1)

MC9328MXS Reference Manual, Rev. 1

19-50 Freescale Semiconductor

Table 19-25. Dual 256 Mbit (16M x 16 x 2) Control Register Values (IAM = 0)

Control Field	Value
Density	64 Mbyte
Page size	2048 bytes
ROW	13
COL	9
DSIZ	32 (D [31:0])
IAM	Non-bank-interleaved

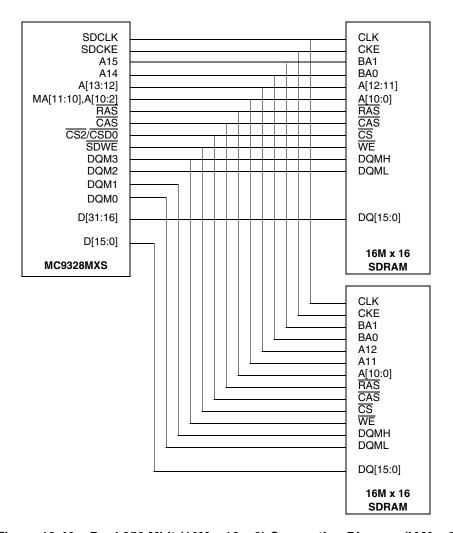


Figure 19-46. Dual 256 Mbit (16M x 16 x 2) Connection Diagram (IAM = 0)

Table 19-26. Single 64 Mbit (2M x 32) Control Register Values (IAM = 1)

Control Field	Value
Density	8 Mbyte
Page size	1024 bytes
ROW	11
COL	8
DSIZ	32 (D [31:0])
IAM	Bank-interleaved

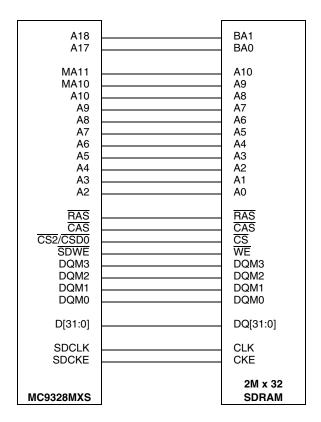


Figure 19-47. Single 64 Mbit (2M x 32) Connection Diagram (IAM = 1)

Table 19-27. Single 64 Mbit (2M x 32) Control Register Values (IAM = 0)

Control Field	Value
Density	8 Mbyte
Page size	1024 bytes
ROW	11
COL	8
DSIZ	32 (D [31:0])
IAM	Non-bank-interleaved

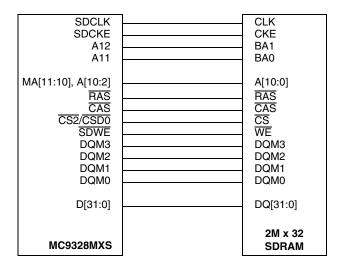


Figure 19-48. Single 64 Mbit (2M x 32) Connection Diagram (IAM = 0)

MC9328MXS Reference Manual, Rev. 1

Table 19-28. Single 128 Mbit (4M x 32) Control Register Values (IAM = 1)

Control Field	Value
Density	16 Mbyte
Page size	1024 bytes
ROW	12
COL	8
DSIZ	32 (D [31:0])
IAM	Bank-interleaved

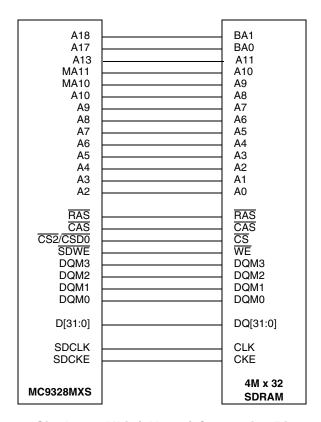


Figure 19-49. Single 128 Mbit (4M x 32) Connection Diagram (IAM = 1)

19-54 Freescale Semiconductor

Table 19-29. Single 128 Mbit (4M x 32) Control Register Values (IAM = 0)

Control Field	Value
Density	16 Mbyte
Page size	1024 bytes
ROW	12
COL	8
DSIZ	32 (D [31:0])
IAM	Non-bank-interleaved

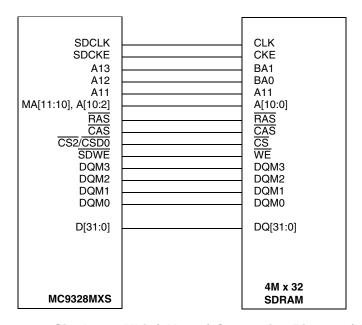


Figure 19-50. Single 128 Mbit (4M x 32) Connection Diagram (IAM = 0)

NOTE:

JEDEC has not issued a standard pinout and array configuration for the 128 Mbit density memories in a x32 package option. This connection diagram is based on the PC100 Standard.

Table 19-30. Single 256 Mbit (8M x 32) Control Register Values (IAM = 1)

Control Field	Value
Density	32 Mbyte
Page size	2048 bytes
ROW	12
COL	9
DSIZ	32 (D [31:0])
IAM	Bank-interleaved

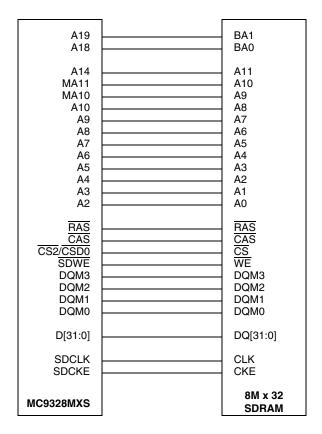


Figure 19-51. Single 256 Mbit (8M x 32) Connection Diagram (IAM = 1)

19-56 Freescale Semiconductor

Control Field	Value
Density	32 Mbyte
Page size	2048 bytes
ROW	12
COL	9
DSIZ	32 (D [31:0])
IAM	Non-bank-interleaved

Table 19-31. Single 256 Mbit (8M x 32) Control Register Values (IAM = 0)

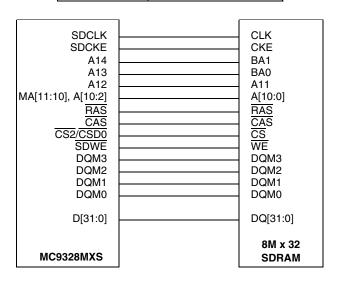


Figure 19-52. Single 256 Mbit (8M x 32) Connection Diagram (IAM = 0)

NOTE:

JEDEC has not issued a standard pinout and array configuration for the 256 Mbit density memories in a x32 package option. This connection diagram is based on the PC100 Standard.

19.7.3 SDRAM Reset Initialization

SDRAM initialization must follow a defined sequence following the power-on condition. The steps are as follows:

- 1. Apply power and start clock. Attempt to maintain CKE high, DQM high and NOP conditions at the command inputs.
- 2. Maintain stable power, clock, and NOP conditions for a minimum of 200 µs.
- 3. Issue precharge commands for all banks either with precharge all or precharge individual bank commands.
- 4. After all banks are in the idle state for a minimum time of t_{RP}, issue 8 or more auto-refresh commands.

SDRAM Operation

- 5. Issue a mode register set command to initialize the mode register.
- 6. SDRAM is now ready for normal operation.

The SDRAM Controller accomplishes steps 1 and 2 in hardware, however it relies on software assistance to complete the remaining actions. The 200 µs stabilization period is guaranteed by the use of 2 reset signals whose negations are separated by this amount. An SDRAM reset signal (SD_RST) is asserted to coincide with the system reset used by the rest of the chip, however it negates 200 ms prior to the negation of system reset. The SDRAM Controller leaves the SDRAM arrays in a NOP condition following the negation of the DRAM reset. Figure 19-53 shows the SDRAM Power-on initialization sequence.

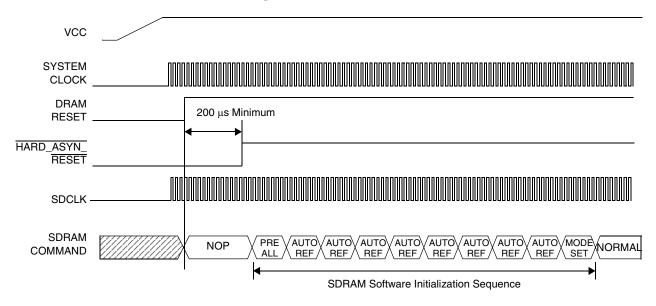


Figure 19-53. SDRAM Power-On Initialization Sequence

Following negation of system reset, initialization software must complete steps 3 through 5 using the special operating modes enabled by the SMODE field in the SDRAM Control Register. To precharge the SDRAM array, the SDRAM Controller operating mode is set to "precharge command" and an access is made to the SDRAM address range with address bit A10 = 1. Instead of running a normal read or write cycle, the controller issues a precharge all command to the addressed array. The operating mode is then switched to "auto-refresh" and 8 accesses are made to the SDRAM address space. Each of the accesses results in a refresh command to the addressed array. A "mode register set" command is required to complete the initialization sequence. The value written is system dependent. Consult Section 19.7.4, "Mode Register Programming," for details. Finally, the controller is placed back in the normal mode of operation so that subsequent accesses to the address space result in normal read and write cycles to the SDRAM array.

Although the initialization sequence described in the previous paragraphs is only required at power-on, it may be repeated at any time the programmer deems necessary.

Code Example 19-2 on page 19-59 provides the code necessary for the initialization sequence.

19-58 Freescale Semiconductor

Code Example 19-2. init_sdram

```
init sdram:
                  r2,CSD REGS
                                              // base address of registers
         ldr
                  r3, PRE ALL CMD
         st
                  r3, (0, r2)
                                              // put array 0 in precharge command mode
                                              // put array 1 in precharge command mode // get address of first array
                  r3, (4, r2)
         st
                  r4, SDRAM ARRAY 0
         ldr
                  r5, SDRAM ARRAY 1
                                              // get address of second array
                  r3, (0, r4)
         ld
                                                 precharge array 0
                  r3, (0, r5)
                                              // precharge array 1
         ldr
                  r3, AUTO REF CMD
                                              // put array 0 in auto-refresh mode
                  r3, (0, r\overline{2})
         st
                  r3, (4, r2)
                                                 put array 1 in auto-refresh mode
         st
         movi
                                                 load loop counter
                  r6,7
                  r3, (0, r4)
                                                 run auto-refresh cycle to array 0
L1
         1d
         ld
                                              // run auto-refresh cycle to array 1
                  r3, (0, r5)
         decat
                  r6
                                              // 8 refresh cycles complete?
         bt.
                  T.1
         ldr
                  r3,SET MODE REG CMD
                  r3, (0, \overline{r}2)
                                              // setup CSD0 for mode register write
         st
                  r3, (4, r2)
                                              // setup CSD1 for mode register write
                  r3, MODE REG VALO
                                              // array 0 mode register value
         ldr
         1 d
                  r3, (0, r3)
                                              // New mode register value on address bus
         ldr
                  r3, MODE REG VAL1
                                              // array 1 mode register value
                                              // Write CSD1 mode register
         1 d
                  r3, (0, r\overline{3})
         ldr
                  r3, NORMAL MODE
                  r3, (0, r2)
                                              // setup CSD0 for normal operation
         st
         st
                  r3, (4, r2)
                                              // setup CSD1 for normal operation
CSD REGS
                  .long
                           0x00221000
SDRAM ARRAY 0:
                  .long
                           0x0800000
SDRAM ARRAY 1:
                           0x0c000000
                  .lona
PRE ALL CMD
                           0xxxxxxxxx
                  .long
AUTO REF CMD
                           0xxxxxxxxx
                   .long
SET MODE REG CMD.long
                           0xxxxxxxxx
MODE REG_VALO
                           0xxxxxxxxx
                  .long
                           Oxxxxxxxxx
                  .long
NORMĀL MŌDE
                  .long
                           0xxxxxxxxx
```

19.7.4 Mode Register Programming

This section describes how to program the SDRAM mode register using the MC9328MXS external address bus. The mode register is used to set the SDRAM operating characteristics including CAS latency, burst length, burst mode, and write data length. The settings depend on system characteristics including the operating frequency, memory device type, burst buffer/cache line length, and bus width. Operating characteristics vary by device type, so the data sheet must be consulted to determine the actual value to be written.

Table 19-32 through Table 19-37 provide examples of the SDRAM memory mode register configuration for different SDRAM memory densities. These tables depict which mode register bit is connected to the SDRAM memory address pin. Because the mode register is written via the MC9328MXS external address bus, and the SDRAM data sheet specifies the SDRAM addresses on which to place the data, the next step is to then determine the address translation from the MC9328MXS internal address bus to the MC9328MXS external address pins. Table 19-38 on page 19-61 provides an example of which mode bits are mapped to which internal address bit for each of the given memory densities.

BA₁ BA0 A11 A10 Α9 Α8 **A7** Α6 A5 A4 АЗ A2 Α1 A0 **SDRAM Address** M13 M12 M11 M10 M9 M7 M5 M1 M0 M8 M6 M4 M3 M2 **Mode Register Bit** Reserved **WB** Reserved CAS latency BT Burst length Content

Table 19-32. 4M x 16 Memory Configuration

MC9328MXS Reference Manual, Rev. 1

Table 19-33. 8M x 16 Memory Configuration

SDRAM Address	BA1	BA0	A11	A10	A9	A8	A7	A6	A5	A4	А3	A2	A1	A0
Mode Register Bit	M13	M12	M11	M10	М9	M8	M7	M6	M5	M4	МЗ	M2	M1	МО
Content		Rese	erved		WB	Rese	erved	CA	S late	ncy	ВТ	Bu	rst len	gth

Table 19-34. 16M x 16 Memory Configuration

SDRAM Address	A12	A11	A10	A9	A8	A7	A6	A 5	A4	А3	A2	A1	A0
Mode Register Bit	M12	M11	M10	M9	M8	M7	M6	M5	M4	МЗ	M2	M1	МО
Content	F	Reserve	d	WB	Rese	erved	CA	S later	псу	ВТ	Bu	rst len	gth

Table 19-35. 2M x 32 Memory Configuration

SDRAM Address	BA1	BA0	A10	A9	A8	A7	A6	A 5	A4	А3	A2	A1	A0
Mode Register Bit	M12	M11	M10	M9	M8	M7	M6	M5	M4	МЗ	M2	M1	МО
Content	F	Reserve	d	WB	Rese	erved	CA	S later	псу	ВТ	Bu	rst len	gth

Table 19-36. 4M x 32 Memory Configuration

SDRAM Address	BA1	BA0	A11	A10	A9	A8	A7	A6	A5	A4	А3	A2	A1	A0
Mode Register Bit	M13	M12	M11	M10	М9	M8	M7	M6	M5	M4	МЗ	M2	M1	МО
Content		Rese	erved		WB	Rese	erved	CA	S late	псу	ВТ	Bu	rst len	gth

Table 19-37. 8M x 32 Memory Configuration

SDRAM Address	A12	A11	A10	A9	A8	A7	A6	A 5	A4	А3	A2	A1	A0
Mode Register Bit	M12	M11	M10	М9	M8	M7	M6	M5	M4	МЗ	M2	M1	MO
Content	F	Reserve	d	WB	Rese	erved	CA	S later	псу	ВТ	Bu	rst lenç	gth

19-60 Freescale Semiconductor

MC9328MXS Reference Manual, Rev. 1

Table 19-38. MC9328MXS SDRAM Memory Configuration

							1	MC93	28M)	XS Int	ternal	Addı	ress E	Bus (ii	nterna	al add	ress l	bits a	re dif	ferent	iated	using	the r	nome	nclat	ture A	A'x)						
Memory Config.	IAM	A'31	A'30	A'29	A'28	A'27	A'26	A'25	A'24	A'23	A'22	A'21	A'20	A'19	A'18	A'17	A'16	A'15	A'14	A'13	A'12	A'11	A'10	A'9	A'8	A'7	A'6	A'5	A'4	A'3	A'2	A'1	A'0
4Mx16Bit x 2 Chips	0	0	0	0	0	Х	Х	0	0	M13	M12	M11	M10	6W	M8	M7	M6	M5	M4	M3	M2	M F	MO	0	0	0	0	0	0	0	0	0	0
(16Mbyte)	1	0	0	0	0	Х	Х	0	0	M11	M10	6W	M8	M7	M6	M5	M4	M3	M2	M 1	MO	M13	M12	0	0	0	0	0	0	0	0	0	0
8Mx16Bit x 2 Chips	0	0	0	0	0	Х	Х	0	M13	M12	M11	M10	6W	M8	M7	M6	M5	M	МЗ	M2	M L	MO	0	0	0	0	0	0	0	0	0	0	0
(32 Mbyte)	1	0	0	0	0	Х	Х	0	M11	M10	6W	M8	M7	M6	M5	M	M3	M2	M1	MO	M13	M12	0	0	0	0	0	0	0	0	0	0	0
16Mx16Bit x 2 Chips	0	0	0	0	0	Х	Х	0	0	M12	M11	M10	6W	M8	M7	M6	M5	M	M3	M2	M	MO	0	0	0	0	0	0	0	0	0	0	0
(64 Mbyte)	1	0	0	0	0	Х	Х	M12	M11	M10	6W	M8	M7	M6	M5	M	M3	M2	M	MO	0	0	0	0	0	0	0	0	0	0	0	0	0
2Mx32Bit x 1 Chip	0	0	0	0	0	Х	Х	0	0	0	M12	M11	M10	6W	M8	M7	M6	M5	M	M3	M2	M1	MO	0	0	0	0	0	0	0	0	0	0
(8 Mbtye)	1	0	0	0	0	Х	Х	0	0	0	M10	6W	M8	M7	M6	M5	M	M3	M2	M1	MO	M12	M11	0	0	0	0	0	0	0	0	0	0
4Mx32Bit x 1 Chip	0	0	0	0	0	Х	Х	0	0	M13	M12	M11	M10	6W	M8	M7	M6	M5	M	M3	M2	M	MO	0	0	0	0	0	0	0	0	0	0
(16 Mbyte)	1	0	0	0	0	Х	Х	0	0	M11	M10	6W	M8	M7	M6	M5	M	M3	M2	M1	MO	M13	M12	0	0	0	0	0	0	0	0	0	0
8Mx32Bit x 1 Chip	0	0	0	0	0	Х	Х	0	0	0	M12	M11	M10	6W	M8	M7	M6	M5	4M	МЗ	M2	M 1	MO	0	0	0	0	0	0	0	0	0	0
(32 Mbyte)	1	0	0	0	0	Х	Х	0	M12	M11	M10	6W	M8	M7	M6	M5	M	МЗ	M2	M 1	МО	0	0	0	0	0	0	0	0	0	0	0	0
	CS	Dx Ba	ise					SDI	RAM	Mem	ory M	lode I	Regis	ter Bi	ts				•		•	•											

SDRAM Operation

19.7.5 Mode Register Programming Examples

To illustrate how these tables are used and as a demonstration of the programming procedure for the mode register, two examples are provided. Refer to the SDRAM data sheet for up-to-date characteristics, as the values used in the example may change from the date of this document's publication.

19.7.5.1 Example 1—256 Mbit SDRAM Mode Register

For Example 1, the following system characteristics will be used:

- 2 Micron MT48LC16M16A2-7E SDRAMs configured as a x32 memory (16M × 16 bits × 2 chips)
- 100 MHz system clock frequency
- Non-bank interleaved mode (IAM = 0)
- Burst length of 8 (not optional as the MC9328MXS performs 8 word burst reads)
- Single word writes (not optional as the MC9328MXS performs single writes only and does not provide a burst terminate after each write)

Table 19-39 illustrates the Mode register bit assignments for the Micron 256 Mbit SDRAM.

Table 19-39. 256 Mbit SDRAM Mode Register

SDRAM Address	A12	A11	A10	A9	A8	A7	A6	A 5	A4	А3	A2	A1	A0
Mode Register Bit	M12	M11	M10	M9	M8	M7	M6	M5	M4	МЗ	M2	M1	MO
Content	Reserved			WB	Rese	erved	C	AS laten	СУ	ВТ	В	urst leng	th

Table 19-40. 256 Mbit SDRAM Mode Register Description

Name	Description	Settings
WB Bit M9	Write Burst Mode—Needs to be programmed to 1 for single location accesses.	0 = Burst writes (not supported by MC9328MXS) 1 = Single word writes
CAS Latency Bits M6-M4	CAS Latency—Sets latency between column address and data. Note, the MC9328MXS does not support CAS Latencies of 1.	000 = Reserved 001 = Reserved 010 = 2 clocks 011 = 3 clocks 1xx = Reserved
BT Bit M3	Burst Type—Selects sequential or interleaved bursts.	0 = Sequential 1 = Interleaved

19-62 Freescale Semiconductor

Table 19-40. 256 Mbit SDRAM Mode Register Description (continued)

Name	Description	Settings
Burst Length Bits M2-M0	Burst Length —A burst length of 8 matches the ARM920T cache line length.	000 = 1 001 = 2 010 = 4 011 = 8 111 = Full page (if BT = 0) 10x = Reserved 1x0 = Reserved

The values programmed into the SDRAM Mode register for example 1 are as follows:

- Sequential burst (BT = 0)
- Burst length of 8 (BL = 011), not optional
- Single word writes (WB = 1), not optional
- 2 Clock latency (LTMODE = 010)

When the Mode register value has been determined, it must be converted to an address. The Mode register is written via the address bus and the memory data sheet specifies the SDRAM address bits on which to place the data. One final transformation is necessary to align the address to the multiplexed outputs of the SDRAM controller. Memory density and bus width determine the alignment of the SDRAM to the controller pins and must be considered during the calculation.

The first step is to determine the value of the 256 Mbit SDRAM Mode register and convert this into an SDRAM address. Table 19-41 is the same as Table 19-39, however it includes the values for this 256 Mbit SDRAM example. This table illustrates what value needs to be placed on the address bus to the SDRAM memory.

SDRAM Address A12 A11 A10 Α9 Α8 **A7** A6 A5 Α4 АЗ Α2 Α1 Α0 M12 M10 M9 M8 M7 МЗ M2 М1 M0 **Mode Register Bit** M11 M6 M5 M4 WB Reserved ВТ Content Reserved CAS latency Burst length Value 0 0 0 1 0 1

Table 19-41. 256 Mbit SDRAM Mode Register with Values

The next step is to determine that the proper value is written to the MC9328MXS internal address bus to ensure that the SDRAM controller's ROW/COLUMN ADDRESS MUX writes these values to the correct address pins of the MC9328MXS's external address bus and then to the SDRAM memory. Table 19-38 simplifies this procedure by allowing the user to simply plug in the Mode register bits into this table therefore generating the correct address to write from the MC9328MXS. Referring to Table 19-38 and locating the proper SDRAM memory density (in this case the $16M \times 16$ SDRAM), proceed by plugging in the Mode register bits into this table. Table 19-42 illustrates this procedure.

Table 19-42. MC9328MXS Address Calculation for Given Mode Register Values

Internal Address	A'31	A'30	A'29	A'28	A'27	A'26	A'25	A'24	A'23	A'22	A'21	A'20	A'19	A'18	A'17	A'16	A'15	A'14	A'13	A'12	A'11	A'10	A'9	A'8	A'7	A'6	A'5	A'4	A'3	A'2	A'1	Α'0
Mode Register Bit	0	0	0	0	Х	Х	0	0	M13	M12	M11	M10	M9	M8	M7	M6	M5	M4	M3	M2	M1	MO	0	0	0	0	0	0	0	0	0	0
Mode Register Bit Value	0	0	0	0	1	0	0	0	0	0	0	0	1	0	0	0	1	0	0	0	1	1	0	0	0	0	0	0	0	0	0	0

Table 19-42 assumes CSD0 is being used as the chip-select for the SDRAM memory, therefore the chip-select base address bits, A'31 through A'24, are set to 00001000 for the memory map region 0x08000000. As a result, for this example, the final value (in hexadecimal format) written to the MC9328MXS internal address for proper translation to the SDRAM memory mode register is 0x08111800. The procedure would then be to issue a Set Mode Register Command to the SDRAM memory, followed by an access (either READ or WRITE) to the SDRAM memory at address 0x08111800. This value is also written into the MODE_REG_VAL0 variable of Code Example 19-2 on page 19-59. Refer to Section 19.5.5, "Set Mode Register Mode (SMODE = 011)," on page 19-25 for more information on the Set Mode Register Command.

19.7.5.2 Example 2—64 Mbit SDRAM Mode Register

For Example 2, the following system characteristics are used:

- 2 Mitsubishi M5M4V64S40ATP-8 64Mbit ($4M \times 16$) SDRAMs configured as a x32 memory ($4M \times 16$ bits \times 2 chips)
- 100 MHz system clock frequency
- Bank-interleaved mode (IAM = 1)
- Burst length of 8 (not optional as the MC9328MXS performs 8 word burst reads)
- Single word writes (not optional as the MC9328MXS performs single writes only and does not provide a burst terminate after each write)

Table 19-43 illustrates the Mode Register bit assignments for the Mitsubishi 64 Mbit SDRAM and Table 19-44. provides the register descriptions.

Table 19-43. 64 Mbit SDRAM Mode Register

SDRAM Address	BA1	BA0	A11	A10	A9	A8	A7	A6	A 5	A4	АЗ	A2	A1	A0
Mode Register Bit	M13	M12	M11	M10	М9	M8	M7	M6	M5	M4	МЗ	M2	M1	MO
Content		Rese	erved		WB	Rese	erved	CA	S late	псу	ВТ	Bu	rst len	gth

Table 19-44. 64 Mbit SDRAM Mode Register Description

Name	Description	Settings
WB Bit M9	Write Burst Mode—Needs to be programmed to 1 for single location accesses.	0 = Burst writes (not supported by MC9328MXS) 1 = Single word writes

MC9328MXS Reference Manual, Rev. 1

19-64 Freescale Semiconductor

Table 19-44. 64 Mbit SDRAM Mode Register Description (continued)

CAS Latency Bits M6–M4	CAS Latency—Sets latency between column address and data. Note, the MC9328MXS does not support CAS Latencies of 1.	000 = Reserved 001 = Reserved 010 = 2 clocks 011 = 3 clocks 1xx = Reserved
BT Bit M3	Burst Type—Selects sequential or interleaved bursts.	0 = Sequential 1 = Interleaved
Burst Length Bits M2–M0	Burst Length—A burst length of 8 matches the ARM920T cache line length.	000 = 1 001 = 2 010 = 4 011 = 8 111 = Full page (if BT = 0) 10x = Reserved 1x0 = Reserved

The values programmed into the SDRAM mode register for Example 2 are as follows:

- Sequential burst (BT = 0)
- Burst length of 8 (BL = 011), not optional
- Single word writes (WB = 1), not optional
- 3 clock latency (LTMODE = 011)

In example 1, we saw that once the mode register value has been determined, it must be converted to an address. The mode register is written via the address bus and the data sheet for the memory being used specifies the SDRAM address bits on which to place the data. One final transformation is necessary to align the address to the multiplexed outputs of the SDRAM controller. Memory density and bus width determine the alignment of the SDRAM to the controller pins and must be defined during the calculation.

To defined memory density and bus width, the value of the 64 Mbit SDRAM mode register must be determined and converted into a SDRAM address. Table 19-45 is the same as Table 19-43, however it includes the values given in the 64 Mbit SDRAM mode register—example 2. Table 19-45 illustrates what value needs to be placed on the address bus to the SDRAM memory.

Table 19-45. 64 Mbit SDRAM Mode Register with Values

SDRAM Address	BA1	BA0	A11	A10	A9	A8	A7	A6	A 5	A4	А3	A2	A1	A0
Mode Register Bit	M13	M12	M11	M10	M9	M8	M7	M6	M5	M4	МЗ	M2	M1	MO
Content		Rese	erved		WB	Rese	erved	CA	S late	псу	ВТ	Bu	rst len	gth
Value		0	0	0	1	0	0	0	1	1	0	0	1	1

The next step is to determine the proper value that is written to the MC9328MXS internal address bus so the SDRAM controller ROW/COLUMN ADDRESS MUX may properly write these values to the correct address pins of the MC9328MXS external address bus and then to the SDRAM memory. Table 19-38 on page 19-61 simplifies this procedure by allowing the user to simply plug in the correct mode register bits into this table therefore generating the correct address to write from the MC9328MXS. Referring to Table 19-38 and locating the proper SDRAM memory density (in this case the 4M×16 SDRAM), we can proceed by entering the mode register bits into this table. Table 19-46 illustrates this procedure.

MC9328MXS Reference Manual, Rev. 1

SDRAM Operation

Table 19-46. MC9328MXS Address Calculation for Given Mode Register Value

Internal Address	A'31	A'30	A'29	A'28	A'27	A'26	A'25	A'24	A'23	A'22	A'21	A'20	A'19	A'18	A'17	A'16	A'15	A'14	A'13	A'12	A'11	A'10	A'9	A'8	A'7	A'6	A'5	A'4	A'3	A'2	A'1	A'0
Mode Register Bit	0	0	0	0	Х	Х	0	0	M11	M10	M9	M8	M7	M6	M5	M4	M3	M2	M1	Mo	M13	M12	0	0	0	0	0	0	0	0	0	0
Mode Register Bit Value	0	0	0	0	1	0	0	0	0	0	1	0	0	0	1	1	0	0	1	1	0	0	0	0	0	0	0	0	0	0	0	0

Table 19-42 assumes CSD0 is being used as the chip-select for the SDRAM memory, therefore the chip-select base address bits, A'31 through A'24, are set to 00001000 for the memory map region 0x08000000. Therefore, for this example, the final value (in hexadecimal format) that is written to the MC9328MXS internal address for proper translation to the SDRAM memory mode register is 0x08233000. The procedure then must issue a Set Mode Register Command to the SDRAM memory, followed by an access (either READ or WRITE) to the SDRAM memory at address 0x08233000. This value will also be written into the "MODE_REG_VAL0" variable of Code Example 19-2 on page 19-59. Refer to Section 19.5.5, "Set Mode Register Mode (SMODE = 011)," for more information on the Set Mode Register Command.

19-66 Freescale Semiconductor

19.7.6 SDRAM Memory Refresh

SDRAM memory specifications generally specify an interval during which all rows in the device must be refreshed. The memory refresh requirements are outlined in Table 19-47. The SDRAM Controller refresh rate (SREFR field of the Control Register) is programmable to meet these varying requirements. Refresh must be enabled prior to storing data in the memory.

Device Size	Array Size	Refresh Interval	Refresh Rate	Requirement	SREFR Value
64 Mbit	4096 rows	64 ms	1 row every 15.6 μs	2 rows refreshed during each 32 kHz clock	10
128 Mbit	4096 rows	64 ms	1 row ever 15.6 μs	2 rows refreshed during each 32 kHz clock	10
256 Mbit	8192 rows	64 ms	1 row every 7.8 μs	4 rows refreshed during each 32 kHz clock	11

Table 19-47. SDRAM Memory Refresh

NOTE:

The memory data sheet must always be consulted to determine the correct refresh interval and array architecture (number of rows). Refresh clock rates other the nominal value require recalculation of the value to be programmed into REFR.

19.8 SyncFlash Operation

Micron SyncFlash memories are 3 V electrically sector-erasable, non-volatile memories architected to comply with the SDRAM interface specifications. With few exceptions, they are capable of matching all SDRAM operating modes.

19.8.1 SyncFlash Reset Initialization

SyncFlash initialization is considerably more straightforward than SDRAM. The SyncFlash sequence is:

- 1. Apply power to Vcc, VccQ, and VccP simultaneously.
- 2. Apply clock.
- 3. After clock is stable, transition $\overline{RESET_SF}$ from low to high.
- 4. Maintain power, stable clock, and $\overline{RESET_SF}$ high for minimum of 100 μs .
- 5. Initialization is now complete.

The SDRAM Controller asserts RESET_SF low anytime sd_rst is asserted. The 200 μs delay between the negation of sd_rst and negation of m_rst easily meets the 100 μs stabilization requirement of the SyncFlash.

SyncFlash Operation

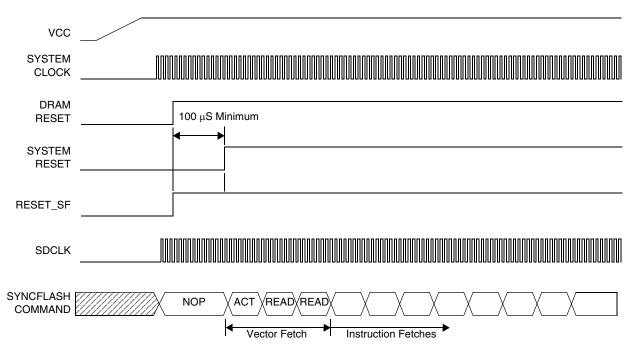


Figure 19-54. Sync Flash Reset Timing

19.8.2 SyncFlash Mode Register Programming

The mode register can be programmed following the initialization sequence, although generally it is not required. A non-volatile mode register is initially programmed at the same time as the rest of the array. This non-volatile register is copied into the mode register automatically during device initialization, and does not require reloading prior to the first operational command. Software may overwrite the default value at any time the memory is idle using the same sequence as an SDRAM mode register. Consult Section 19.7.4, "Mode Register Programming," for details.

Programming the SyncFlash non-volatile mode register requires a specialized sequence of load command register triplets with VccP applied. Consult the SyncFlash data sheet for details.

19.8.3 Booting From SyncFlash

The SDRAM Controller is designed to permit booting from the SyncFlash device immediately out of reset. Default values in the configuration register allow booting at frequencies up to 100 MHz. Complete initialization of the controller is still required, however, and must be completed as quickly as possible.

19.8.4 SyncFlash Configuration

Hardware connections are <u>similar</u> to those for SDRAM of like <u>density</u>. One difference is that a SyncFlash boot device is limited to using <u>CSD1</u>. SyncFlash can be connected to <u>CSD0</u>, <u>however</u>, it cannot be the boot device. The second difference is the added connection to the reset/powerdown pin (<u>RESET_SF</u>). An example of a 32-bit configuration is provided in Figure 19-56.

19-68 Freescale Semiconductor

The only significant difference in the software configuration is that refresh *must* be disabled. SyncFlash maps the control register access commands to the same basic commands as SDRAM refresh. Enabling hardware refresh would most likely result in unexpected behavior.

Table 19-48. Single 4M x 16 SyncFlash Control Register Values

Control Field	Value
Density	8 Mbyte
Page Size	512
ROW	12
COL	8
DSIZ	16 (D[15:0])
IAM	Non-Interleaved

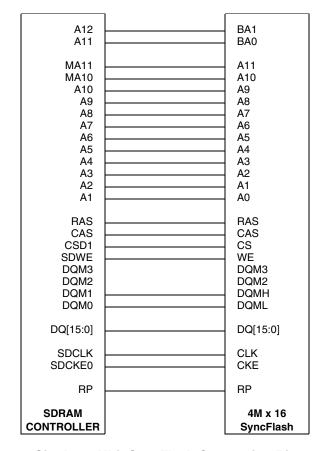


Figure 19-55. Single 64 Mbit SyncFlash Connection Diagram (IAM = 0)

Table 19-49. Dual 4M x 16 SyncFlash Control Register Values (IAM = 0)

Control Field	Value
Density	16 Mbyte
Page size	1024
ROW	12
COL	8
DSIZ	32 (D [31:0])
IAM	Non-Interleaved

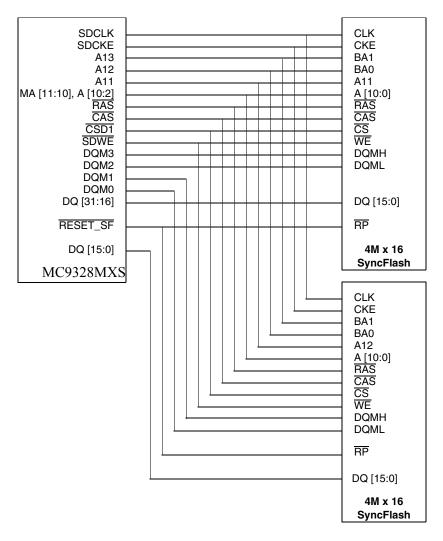


Figure 19-56. Dual 64 Mbit SyncFlash Connection Diagram (IAM = 0)

MC9328MXS Reference Manual, Rev. 1

19-70 Freescale Semiconductor

19.8.5 SyncFlash Programming

Table 19-50 provides a quick reference of the available commands for SyncFlash operation. The detailed command encoding for SDRAM compatibility, is located in Table 19-10. All SyncFlash operations with LCR (LOAD COMMAND REGISTER), LCR/ACTIVE/READ, or LCR/ACTIVE/WRITE commands and command sequences are defined in Table 19-50 and Table 19-10.

Table 19-50. SyncFlash Command Sequences

Onevetien		1st C	ycle			2nd C	ycle			3rd C	ycle	
Operation	CMD	ADDR	ADDR	DQ	CMD	ADDR	ADDR	DQ	CMD	ADDR	ADDR	DQ
Read Device Configuration	LCR	90H	Bank	Х	ACT	Row	Bank	Х	READ	CA	Bank	Х
Read Status Register	LCR	70H	Х	Х	ACT	Х	Х	Х	READ	Х	Х	Х
Clear Status Register	LCR	50H	Х	Х	_	_	_	_	_	_	_	_
Erase Setup/ Confirm	LCR	20H	Bank	Х	ACT	Row	Bank	Х	WRITE	Х	Bank	D0H
Write Setup/ Confirm	LCR	40H	Bank	Х	ACT	Row	Bank	Х	WRITE	Col	Bank	D1H
Protect Block/ Confirm	LCR	60H	Bank	Х	ACT	Row	Bank	Х	WRITE	Х	Bank	01H
Protect Device/ Confirm	LCR	60H	Bank	Х	ACT	Х	Bank	Х	WRITE	Х	Bank	F1H
Unprotect Blocks/ Confirm	LCR	60H	Bank	Х	ACT	Х	Bank	Х	WRITE	Х	Bank	D0H
Erase NVMODE Register	LCR	30H	Bank	Х	ACT	Х	Bank	Х	WRITE	Х	Bank	C0H
Write NVMODE Register	LCR	A0H	Bank	Х	ACT	Х	Bank	Х	WRITE	Х	Bank	Х

MC9328MXS Reference Manual, Rev. 1 Freescale Semiconductor 19-71

19.8.6 Clock Suspend Timer Use with SyncFlash

The SyncFlash enters clock suspend mode when the CLKST[1:0] bits are set to 10 or 11 in the SDRAM control register (SDCTL0/1). The clock to the SyncFlash memory will stop after a programmable delay following the last access to the SyncFlash (64 clock cycles for CLKST=10 or 128 clock cycles for CLKST = 11). When CLKST is set to 10 or 11, the active bank is not closed (no Precharge command is issued) before the entry into the clock suspend mode. Figure 19-57 illustrates this timing relationship.

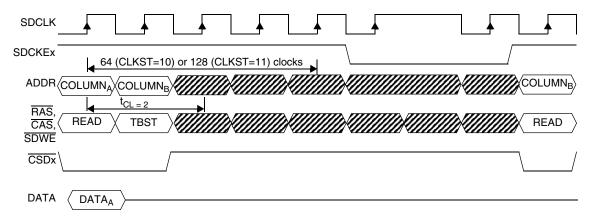


Figure 19-57. SyncFlash Clock Suspend Timer Operation Timing Diagram

19.8.7 Powerdown Operation with SyncFlash

The SyncFlash enters powerdown mode when the (CLKST [1:0] bits are set to 01 in the SDRAM control register (SDCTL0/1) and only when no bank is active. In powerdown mode, the clock to the SyncFlash memory will stop. Again, the powerdown mode can only entered when all banks within the memory area are inactive. Figure 19-58 illustrates the operation of SyncFlash powerdown mode.

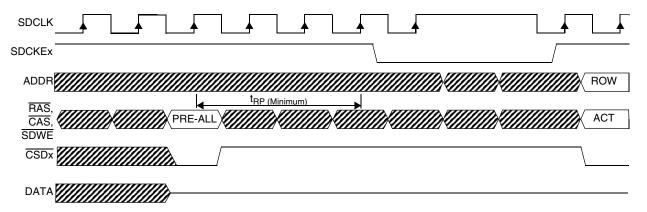


Figure 19-58. SyncFlash Powerdown Operation Timing Diagram

19.9 Deep Powerdown Operation with SyncFlash

The SyncFlash enters deep powerdown mode when the MC9328MXS enters stop mode (both the MCU PLL and System PLL are shut down). Upon entry of deep powerdown mode, all active memory banks are closed, the clock input to the SyncFlash stops, and the RESET_SF signal is asserted. The SyncFlash exits deep powerdown mode

19-72 Freescale Semiconductor

after the MC9328MXS exits stop mode (when the MCU PLL and System PLL have waken up) and the clock to the SyncFlash is stable. The RESET_SF signal is then deasserted. Figure 19-59 illustrates the operation of the SyncFlash when entering deep powerdown mode.

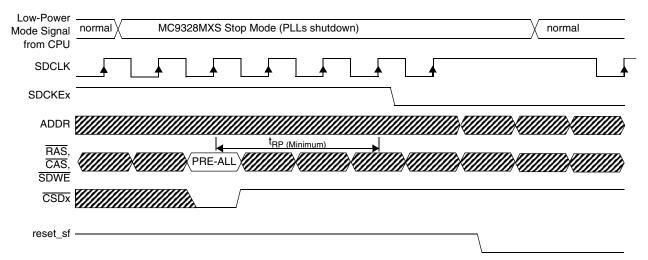


Figure 19-59. SyncFlash Deep Powerdown Operation Timing Diagram



19-74 Freescale Semiconductor

Chapter 20 General-Purpose Timers

The MC9328MXS contains two identical general-purpose 32-bit timers with programmable prescalers and compare and capture registers. Each timer counter value can be captured using an external event and can be configured to trigger a capture event on either the leading or trailing edges of an input pulse. The timer can also generate an interrupt when the timer reaches a programmed value. Each timer has an 8-bit prescaler providing a programmable clock frequency derived from PERCLK1. Figure 20-1 illustrates the general-purpose timers block diagram.

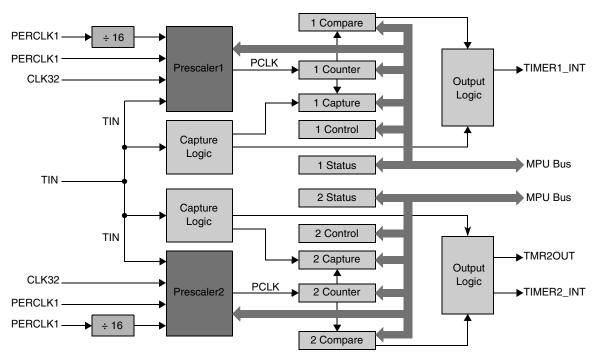


Figure 20-1. General-Purpose Timers Block Diagram

The timers have the following features:

- Maximum period of 512×65536 seconds at 32.768 kHz
- 10 ns resolution at 100 MHz
- Programmable sources for the clock input, including external clock
- Input capture capability with programmable trigger edge
- Output compare with programmable mode
- Free-run and restart modes
- Software reset function

Operation

20.1 Operation

The clock that feeds the prescaler can be selected from the main clock (divided by 1 or by 16), from the timer input pin (TIN), or from the 32 kHz clock (CLK32). The clock input source is determined by the clock source (CLKSOURCE) field in the timer control registers (TCTL1 and TCTL2). The timer prescaler registers (TPRER1 and TPRER2) are used to select the divide ratio of the input clock that drives the main counter. The prescaler can divide the input clock by a value between 1 and 256. When CLK32 is selected as the clock source, the timer operates even while the PLL is in sleep mode (at that time, the PERCLK1 from the PLL is off).

Each timer can be configured for free-run or restart mode by programming the free-run/restart (FRR) bit in the corresponding TCTLx register. In restart mode, after the compare value is reached, the counter resets to 0x00000000, the compare event (COMP) bit of the timer status register is set, an interrupt is issued if the interrupt request enable (IRQEN) bit of the corresponding TCTLx register is set, and the counter resumes counting. This mode is useful when you need to generate periodic events or audio tones when the free-running timer is used with the timer output signals. In free-run mode, the compare function operates as it does in restart mode, however the counter continues counting without resetting to 0x00000000. When 0xFFFFFFFF is reached, the counter rolls over to 0x00000000 and keeps counting.

Each timer has a 32-bit capture register that takes a "snapshot" of the counter when a defined transition of the timer input (TIN) is detected by the capture edge detector. The type of transition that triggers this capture is selected by the capture edge (CAP) field of the corresponding TCTLx register. Pulses that produce the capture edge can be as short as 20 ns. The minimum time between pulses is two PCLK periods.

When a capture or compare event occurs, the corresponding (CAPT or COMP) status bit is set in the timer status register and an interrupt is posted if the capture function is enabled or if the IRQEN bit of the corresponding TCTLx register is set. The free-running timer is disabled at reset.

When 1 is written to the software reset (SWR) bit in the TCTLx register, the module resets immediately. The reset signal is asserted for three times the period of the 96 MHz SystemCLK cycle. For example, if the system clock period is 10 ns, the reset signal is asserted for 30 ns and then is automatically released.

20.1.1 Pin Configuration for General-Purpose Timers

Figure 20-1 shows the pins used for the General-Purpose Timer module. These pins are multiplexed with other functions on the device, and must be configured for General-Purpose Timer operation. Table 20-1 lists the pin configuration for the General-Purpose Timers.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Pin	Setting	Configuration Procedure
TIN	Primary function of GPIO Port A [1]	Clear bit 1 of Port A GPIO In Use Register (GIUS_A) Clear bit 1 of Port A General Purpose Register (GPR_A)
TMR2OUT	Primary function of GPIO Port D [31]	Clear bit 31 of Port D GPIO In Use Register (GIUS_D) Clear bit 31 of Port D General Purpose Register (GPR_D)

Table 20-1. Pin Configuration

MC9328MXS Reference Manual, Rev. 1

20-2 Freescale Semiconductor

20.2 Programming Model

The General-Purpose Timers module includes 6 user-accessible 32-bit registers for each timer. Table 20-2 summarizes these registers and their addresses.

Table 20-2. GP Timers Module Register Memory Map

Description	Name	Address
Timer Control Register 1	TCTL1	00202000
Timer Prescaler Register 1	TPRER1	00202004
Timer Compare Register 1	TCMP1	00202008
Timer Capture Register 1	TCR1	0020200C
Timer Counter Register 1	TCN1	00202010
Timer Status Register 1	TSTAT1	00202014
Timer Control Register 2	TCTL2	00203000
Timer Prescaler Register 2	TPRER2	00203004
Timer Compare Register 2	TCMP2	00203008
Timer Capture Register 2	TCR2	0020300C
Timer Counter Register 2	TCN2	00203010
Timer Status Register 2	TSTAT2	00203014

20.2.1 Timer Control Registers 1 and 2

Each timer control register (TCTL1 or TCTL2) controls the overall operation of the corresponding general-purpose timer. Table 20-3 provides the register description. The TCTLx registers control the following:

- Selecting the free-running or restart mode after a compare event
- Selecting the capture trigger event
- Controlling the output compare mode
- Enabling the compare event interrupt
- Selecting the prescaler clock source
- Enabling and disabling the GP timer

TCTL1 TCTL2								ontro ontro	•	-						Addr 02000 03000
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET			0x0000													
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	SWR							FRR	C	AP	ОМ	IRQEN	CLI	KSOUR	CE	TEN
TYPE	rw	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x	0000							

Table 20-3. Timer 1 and 2 Control Registers Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
SWR Bit 15	Software Reset—Controls the software reset function. When 1 is written to this bit, a reset signal is generated to the reset timer module. The reset signal is active for 3 system clock cycles, and then is automatically released. The software reset does not reset the timer enable (TEN) bit.	0 = No software reset sent 1 = Software reset sent to timer module
Reserved Bits 14–9	Reserved—These bits are reserved and should read 0.	
FRR Bit 8	Free-Run/Restart—Controls how the timer operates after a compare event occurs. In free-run mode, the timer continues running. In restart mode, the counter resets to 0x00000000 and resumes counting.	0 = Restart mode 1 = Free-run mode
CAP Bits 7–6	Capture Edge—Controls the operation of the capture function. The direction (DIRx) bit in the corresponding port register must be set to 0 for the capture function to operate correctly.	00 = Disable the capture function 01 = Capture on the rising edge and generate an interrupt 10 = Capture on the falling edge and generate an interrupt 11 = Capture on the rising and falling edges and generate an interrupt
OM Bit 5	Output Mode—Controls the output mode of the timer after a reference-compare event occurs. This bit has no function unless the CAP field is set to 0. When the counter value (COUNT) period is less than 40 ns, timer out (TMR2OUT) is not valid.	0 = Active-low pulse for one IPG_CLK period 1 = Toggle output
IRQEN Bit 4	Interrupt Request Enable—Enables/Disables the generation of an interrupt on a compare event.	0 = Disable the compare interrupt 1 = Enable the compare interrupt

MC9328MXS Reference Manual, Rev. 1

20-4 Freescale Semiconductor

Table 20-3. Timer 1 and 2 Control Registers Description (continued)

Name	Description	Settings
CLKSOURCE Bits 3–1	Clock Source—Selects the source of the clock to the prescaler. The stop-count setting freezes the timer at its current value.	000 = Stop count (clock disabled) 001 = PERCLK1 to prescaler 010 = PERCLK1 ÷16 to prescaler 011 = TIN to prescaler 1xx = 32 kHz clock to prescaler
TEN Bit 0	Timer Enable—Enables/Disables the general-purpose timer. The TEN bit can be reset only by a hardware asynchronous reset, not by the SWR reset. Note: When configuring this control register, configure all other bits before configuring the TEN bit.	0 = Timer is disabled (counter reset to 0x00000000) 1 = Timer is enabled

20.2.2 Timer Prescaler Registers 1 and 2

Each timer prescaler register (TPRER1 and TPRER2) controls the divide ratio of the associated 8-bit prescaler. The settings for the registers are described in Table 20-4.

TPREI						imer imer			_						0020	Addr 2004 3004
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												PRES	CALER			
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESEI								0x00	000							

Table 20-4. Timer 1 and 2 Prescaler Registers Description

Name	Description	Settings
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.	
PRESCALER Bits 7–0	Prescaler —Determines the division value (1–256) of the prescaler.	0x00 = Divide by 1 0x01 = Divide by 2 0xFF = Divide by 256

Programming Model

20.2.3 Timer Compare Registers 1 and 2

Each timer compare register (TCMP1 and TCMP2) contains the value that is compared with the free-running counter. A compare event is generated when the counter matches the value in this register. This register is set to 0xFFFFFFF at system reset. Table 20-5 provides the register description.

TCMP						imer imer		•	_						0020 0020	
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
							CC	MPARE	VALUE	=						
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
TILOLI								0xFF	FF							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							CC	MPARE	VALUE	Ī						
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F	F
RESET								0xFF	FF							

Table 20-5. Timer 1 and 2 Compare Registers Description

Name	Description
COMPARE VALUE Bits 31–0	Compare Value—Holds the value at which a compare event will be triggered.

20.2.4 Timer Capture Registers 1 and 2

Each read-only timer capture register (TCR1 and TCR2) stores the counter value when a capture event occurs. This register is read-only, and resets to 0x000000000. Table 20-6 provides the register description.

TCR1 TCR2						Timeı Timeı	•		_						0202	Addr 200C 300C
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
							CA	APTURE	VALUE							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HLOLI								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							CA	APTURE	VALUE							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HLOET								0x00	000							

Table 20-6. Timer 1 and 2 Capture Registers Description

Name	Description
CAPTURE VALUE Bits 31–0	Capture Value—Stores the counter value that existed at the time of the capture event.

Programming Model

20.2.5 Timer Counter Registers 1 and 2

Each read-only timer counter register (TCN1 and TCN2) contains the current count. The timer counter registers can be read at any time without affecting the current count. Table 20-7 describes the register descriptions.

TCN1 TCN2							Cou Cou		_						0020	Addr 2010 3010
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								COU	NT							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								COU	NT							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ITEGET								0x00	00							

Table 20-7. Timer 1 and 2 Counter Registers Description

Name	Description
COUNT Bits 31–0	Counter Value—Contains the current count value.

20.2.6 Timer Status Registers 1 and 2

Each read-only timer status register (TSTAT1 and TSTAT2) indicates the corresponding timer's status. When a capture event occurs, the CAPT bit is set. When a compare event occurs, the COMP bit is set. These bits must be cleared to clear the interrupt, if it is enabled. These bits are cleared by writing 0x0, write 0 to clear—w0c, and will clear only if they have been read while set. This ensures that an interrupt is not missed if it occurs between the status read and the interrupt clear. The registers and settings are described Table 20-8.

TSTAT1 TSTAT2							r Sta r Sta		_							Addr 02014 03014
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x0	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
															CAPT	COMP
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r/w0c	r/w0c
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x0	000							

Table 20-8. Timer 1 and 2 Status Registers Description

Name	Description	Settings					
Reserved Bits 31–2	Reserved—These bits are reserved and should read 0.						
CAPT Bit 1	Capture Event—Indicates when a capture event occurs.	0 = No capture event occurred 1 = A capture event occurred					
COMP Bit 0	Compare Event—Indicates when a compare event occurs.	0 = No compare event occurred 1 = A compare event occurred					

Programming Model

MC9328MXS Reference Manual, Rev. 1

20-10 Freescale Semiconductor

Chapter 21 Universal Asynchronous Receiver/Transmitters (UART) Modules

21.1 Introduction

This chapter describes the universal asynchronous receiver/transmitter (UART) modules in the MC9328MXS. The UART modules are capable of standard RS-232 non-return-to-zero (NRZ) encoding format and IrDA-compatible infrared modes. Each UART provides serial communication capability with external devices through an RS-232 cable or through use of external circuitry that converts infrared signals to electrical signals (for reception) or transforms electrical signals to signals that drive an infrared LED (for transmission) to provide low speed IrDA compatibility to the MC9328MXS.

UARTs transmit and receive characters that are either 7 or 8 bits in length (program selectable). To transmit, data is written from the peripheral data bus to a 32-byte transmitter FIFO (TxFIFO). This data is passed to the shift register and shifted serially out on the transmitter pin (TXD). To receive, data is received serially from the receiver pin (RXD) and stored in a 32-half-words-deep receiver FIFO (RxFIFO). The received data is retrieved from the RxFIFO on the peripheral data bus. The RxFIFO and TxFIFO generate maskable interrupts as well as DMA Requests when the data level in each of the FIFO reaches a programmed threshold level.

The UARTs generate baud rates based on a configurable divisor and input clock. The UARTs also contain configurable auto baud detection circuitry to receive 1 or 2 stop bits as well as odd, even, or no parity. The receiver detects framing errors, idle conditions, BREAK characters, parity errors, and overrun errors.

The TXD pin is configurable for open-drain operation at the chip boundary. The UART modules use a software interface for control of modem operations and have a serial infrared (IR) module that decodes and encodes IrDA-compatible serial IR data.

21.2 Features

- 7 or 8 data bits
- 1 or 2 stop bits
- Programmable parity (even, odd, and no parity)
- Full 8-wire serial DCE interface¹ for modem flow control on UART
- Hardware flow control support for request to send (RTS) and clear to send (CTS) signals
- Software flow control support for data set ready (DSR), data carrier detect (DCD), and ring indicator (RI) signals on UART
- Edge selectable RTS and data terminal ready (DTR) edge detect interrupts
- Status flags for various flow control and FIFO states
- Serial IR interface (low speed, IrDA-compatible) enable via UART Control Register 1
- 1. UART GPIO pins must be used for DTR, DSR, DCD, and RI functions.

Features

- Voting logic for improved noise immunity (16x oversampling)
- Transmitter FIFO empty interrupt suppression
- UART internal clocks enable/disable
- Auto baud rate detection
- Receiver and transmitter enable/disable
- RTS, IrDA asynchronous wake (AIRINT), and receive asynchronous wake (AWAKE) interrupts wake the ARM920T processor from STOP mode
- Twenty maskable interrupts
- Two DMA Requests (TxFIFO DMA Request and RxFIFO DMA Request)
- Escape character sequence detection
- Software reset (\overline{SRST})

21.2.1 Module Interface

The serial and modem control signals used by the UART module are identified and described in Table 21-1.

Table 21-1. UART Module Interface Signals

Signal Name	I/O	Active	UART	Comments						
	Serial Signals									
UART1_TXD UART2_TXD	OUT	HIGH		Transmitter serial output (multiplexed IR or NRZ encoding format)						
UART1_RXD UART2_RXD	IN	HIGH		Receiver serial input (multiplexed IR or NRZ encoding format)						
	I	1		Modem Control Signals						
UART1_RTS UART2_RTS	IN	LOW		Controls the transmitter. By asserting RTS, the modem signals ready to receive to the UART. Normally, the transmitter waits until UARTx_RTS is active (low) before transmitting a character, however when the ignore UARTx_RTS pin (IRTS) bit is set, the transmitter sends each character as it is ready to transmit. When this pin serves as a general purpose input, its status is read in the RTSS bit. This pin can post an interrupt on any transition of this pin and wake the ARM9 core from STOP mode on its assertion. When RTS is negated during a transmission, the UART transmitter finishes transmitting the current character and shuts off. The contents of the TxFIFO (characters to be transmitted) remain undisturbed.						
UART1_CTS UART2_CTS	OUT	LOW		This output pin serves two purposes. Normally, the receiver indicates that it is ready to receive data by asserting this pin (low). When the receiver detects a pending overrun, it negates this pin. For other applications, this pin functions as a general purpose output controlled by the CTS bit in UART Control Register 2.						
UART2_DSR	OUT	LOW	2	DSR signal for modem control						
UART2_RI	OUT	LOW	2	RI signal for modem control						
UART2_DCD	OUT	LOW	2	DCD signal for modem control						

MC9328MXS Reference Manual, Rev. 1

21-2 Freescale Semiconductor

Table 21-1. UART Module Interface Signals (continued)

Signal Name	I/O	Active	UART	Comments
UART2_DTR	IN	LOW	2	DTR signal for modem control

21.2.2 UART Pin Configuration

Table 21-2 lists the pins used for the UART 1 UART 2 modules. These pins are multiplexed with other functions on the device, and must be configured for UART operation.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Table 21-2. Pin Configuration

Pin	Setting	Configuration Procedure
UART1_RXD	Primary function of GPIO Port C [12]	1.Clear bit 12 of Port C GPIO In Use Register (GIUS_C) 2.Clear bit 12 of Port C General Purpose Register (GPR_C)
UART1_TXD	Primary function of GPIO Port C [11]	1.Clear bit 11 of Port C GPIO In Use Register (GIUS_C) 2.Clear bit 11 of Port C General Purpose Register (GPR_C)
UART1_RTS	Primary function of GPIO Port C [10]	1.Clear bit 10 of Port C GPIO In Use Register (GIUS_C) 2.Clear bit 10 of Port C General Purpose Register (GPR_C)
UART1_CTS	Primary function of GPIO Port C [9]	1.Clear bit 9 of Port C GPIO In Use Register (GIUS_C) 2.Clear bit 9 of Port C General Purpose Register (GPR_C)
UART2_RXD	Primary function of GPIO Port B [31]	1.Clear bit 31 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 31 of Port B General Purpose Register (GPR_B)
UART2_TXD	Primary function of GPIO Port B [30]	1.Clear bit 30 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 30 of Port B General Purpose Register (GPR_B)
UART2_RTS	Primary function of GPIO Port B [29]	1.Clear bit 29 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 29 of Port B General Purpose Register (GPR_B)
UART2_CTS	Primary function of GPIO Port B [28]	1.Clear bit 28 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 28 of Port B General Purpose Register (GPR_B)
UART2_DSR	Alternate function of GPIO Port D [10]	1.Clear bit 10 of Port D GPIO In Use Register (GIUS_D) 2.Set bit 10 of Port D General Purpose Register (GPR_D)
UART2_RI	Alternate function of GPIO Port D [9]	1.Clear bit 9 of Port D GPIO In Use Register (GIUS_D) 2.Set bit 9 of Port D General Purpose Register (GPR_D)
UART2_DCD	Alternate function of GPIO Port D [8]	1.Clear bit 8 of Port D GPIO In Use Register (GIUS_D) 2.Set bit 8 of Port D General Purpose Register (GPR_D)

MC9328MXS Reference Manual, Rev. 1

Interrupts and DMA Requests

Table 21-2. Pin Configuration (continued)

Pin	Setting	Configuration Procedure
UART2_DTR	Alternate function of GPIO Port D [7]	1.Set bit 7 of Port D GPIO In Use Register (GIUS_D) 2.Set bit 7 of Port D General Purpose Register (GPR_D)

21.3 Interrupts and DMA Requests

Table 21-3 lists all of the interrupts that are output on each interrupt output. See the individual register descriptions for explanation of available enables and status flags.

Table 21-3. Interrupts and DMA

Interrupt	Interrupt	Enable Register	Interrupt	Flag Register
Output	Enable	Location	Flag	Location
UART_MINT_DTR	DTREN	UCR3_2 (bit 13)	DTRF	USR2_2 (bit 13)
UART_MINT_RTS	RTSDEN	UCR1_1/UCR1_2 (bit 5)	RTSD	USR1_1/USR1_2 (bit 12)
	RTSEN	UCR2_1/UCR2_2 (bit 4)	RTSF	USR2_1/USR2_2 (bit 4)
UART_MINT_RX	RRDYEN	UCR1_1/UCR1_2 (bit 9)	RRDY	USR1_1/USR1_2 (bit 9)
	IDEN	UCR1_1/UCR1_2 (bit 12)	IDLE	USR2_1/USR2_2 (bit 12)
	DREN	UCR4_1/UCR4_2 (bit 0)	RDR	USR2_1/USR2_2 (bit 0)
	RXDSEN	UCR3_1/UCR3_2 (bit 6)	RXDS	USR1_1/USR1_2 (bit 6)
UART_MINT_TX	TXMPTYEN	UCR1_1/UCR1_2 (bit 6)	TXFE	USR2_1/USR2_2 (bit 14)
	TRDYEN	UCR1_1/UCR1_2 (bit 13)	TRDY	USR1_1/USR1_2 (bit 13)
	TCEN	UCR4_1/UCR4_2 (bit 3)	TXDC	USR2_1/USR2_2 (bit 3)
UART_MINT_UARTC	OREN BKEN WKEN ADEN ESCI ENIRI AIRINTEN AWAKEN	UCR4_1/UCR4_2 (bit 1) UCR4_1/UCR4_2 (bit 2) UCR4_1/UCR4_2 (bit 7) UCR1_1/UCR1_2 (bit 15) UCR2_1/UCR2_2 (bit 15) UCR4_1/UCR4_2 (bit 8) UCR3_1/UCR3_2 (bit 5) UCR3_1/UCR3_2 (bit 4)	ORE BRCD WAKE ADET ESCF IRINT AIRINT AWAKE	USR2_1/USR2_2 (bit 1) USR2_1/USR2_2 (bit 2) USR2_1/USR2_2 (bit 7) USR2_1/USR2_2 (bit 15) USR1_1/USR1_2 (bit 11) USR2_1/USR2_2 (bit 8) USR1_1/USR1_2 (bit 5) USR1_1/USR1_2 (bit 4)
UART_MINT_PFRERR	FRAERREN	UCR3_1/UCR3_2 (bit 11)	FRAERR	USR1_1/USR1_2 (bit 10)
	PARERREN	UCR3_1/UCR3_2 (bit 12)	PARITYERR	USR1_1/USR1_2 (bit 15)
UART_RX_DMAREQ	RDMAEN	UCR1_1/UCR1_2 (bit 8)	RRDY	USR1_1/USR1_2 (bit 9)
UART_TX_DMAREQ	TDMAEN	UCR1_1/UCR1_2 (bit 3)	TRDY	USR1_1/USR1_2 (bit 13)

21.4 General UART Definitions

Definitions of terms that occur the following discussions are given in this section.

• **Bit time**—The period of time required to serially transmit or receive 1 bit of data (1 cycle of the baud rate frequency).

MC9328MXS Reference Manual, Rev. 1

21-4 Freescale Semiconductor

- **Start bit**—The bit time of a logic 0 that indicates the beginning of a data frame. A start bit begins with a 1-to-0 transition, and is preceded by at least 1 bit time of logic 1.
- **Stop bit**—1 bit time of logic 1 that indicates the end of a data frame.
- **BREAK**—A frame in which all of the data bits, including the stop bit, are logic 0. This type of frame is usually sent to signal the end of a message or the beginning of a new message.
- Frame—A start bit followed by a specified number of data or information bits and terminated by a stop bit. The number of data or information bits depends on the format specified and must be the same for the transmitting device and the receiving device. The most common frame format is 1 start bit followed by 8 data bits (least significant bit first) and terminated by 1 stop bit. An additional stop bit and a parity bit also can be included.
- Framing error—An error condition that occurs when the stop bit of a received frame is missing, usually when the frame boundaries in the received bit stream are not synchronized with the receiver bit counter. Framing errors can go undetected if a data bit in the expected stop bit time happens to be a logic 1. A framing error is always present on the receiver side when the transmitter is sending BREAKs. However, when the UART is programmed to expect 2 stop bits and only the first stop bit is received, this is not a framing error by definition.
- **Parity error**—An error condition that occurs when the calculated parity of the received data bits in a frame does not match the parity bit received on the RXD input. Parity error is calculated only after an entire frame is received.
- **Idle**—One in NRZ encoding format and selectable polarity in IrDA mode.
- Overrun error—An error condition that occurs when the latest character received is ignored to prevent overwriting a character already present in the UART receive buffer (RxFIFO). An overrun error indicates that the software reading the buffer (RxFIFO) is not keeping up with the actual reception of characters on the RXD input.

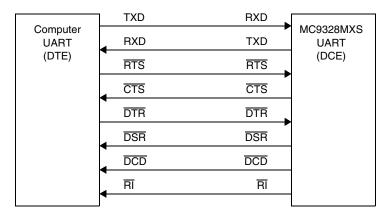


Figure 21-1. General Connections for a UART with a Modem

21.4.1 RTS—UART Request To Send

The UART request to send input controls the transmitter. The modem or other terminal equipment signals the UART when it is ready to receive by asserting RTS on the UARTx_RTS pin. Normally, the transmitter waits until this signal is active (low) before transmitting a character, however when the ignore UARTx_RTS pin (IRTS) bit is set, the transmitter sends a character as soon as it is ready to transmit. This pin can post an interrupt on any

General UART Definitions

transition of this pin and wakes the ARM920T processor from STOP mode on its assertion. When $\overline{\text{RTS}}$ is negated during a transmission, the UART transmitter finishes transmitting the current character and shuts off. The contents of the TxFIFO (characters to be transmitted) remain undisturbed.

21.4.2 RTS Edge Triggered Interrupt

The input to the <u>UARTx_RTS</u> pin can be programmed to generate an interrupt on a selectable edge. The operation of the <u>RTS</u> edge triggered interrupt (RTSF) is summarized in Table 21-4.

To enable the $\overline{\text{UARTx}_\text{RTS}}$ pin to generate an interrupt, set the request to send interrupt enable (RTSEN) bit in the UART Control Register 2 (UCR2_x) to 1. Writing 1 to the RTS edge triggered interrupt flag (RTSF) bit in UCR2_x clears the interrupt flag. The interrupt can occur on the rising edge, falling edge, or either edge of the $\overline{\text{RTS}}$ input. The request to send edge control (RTEC) field in UCR2_x programs the edge that generates an interrupt. When RTEC is set to 0x00 and RTSEN = 1, the interrupt occurs on the rising edge (default). When RTEC is set to 0x01 and RTSEN = 1, the interrupt occurs on the falling edge. When RTEC is set to 0x1X and RTSEN = 1, the interrupt occurs on either edge. This is a synchronous interrupt. The RTSF bit is cleared by writing 1 to it. Writing 0 to RTSF has no effect.

RTS	RTSEN	RTEC [1]	RTEC [0]	RTSF	Interrupt Occurs On	UART_MINT_RTS
Х	0	Х	Х	0	Interrupt disabled	1
1->0	1	0	0	0	Rising edge	1
0->1	1	0	0	1	Rising edge	0
1->0	1	0	1	1	Falling edge	0
0->1	1	0	1	0	Falling edge	1
1->0	1	1	Х	1	Either edge	0
0->1	1	1	Х	1	Either edge	0

Table 21-4. RTS Edge Triggered Interrupt Truth Table

There is another RTS interrupt that is not programmable, however it asserts the RTS Delta (RTSD) bit when the RTS pin changes state. The status bit RTSD asserts the UART_MINT_RTS interrupt when the RTS delta interrupt enable = 1. This is an asynchronous interrupt. The RTSD bit is cleared by writing 1 to it. Writing 0 to the RTSD bit has no effect.

21.4.3 DTR—Data Terminal Ready

The data terminal ready signal to the UART2_DTR indicates the general readiness of the data terminal equipment (DTE). When the connection between the UART and the DTE is established, the DTR signal must remain active throughout the whole connection time. The DTR signal is only available on UART2. In general, the DTR and DSR signals establish the connection and the RTS and CTS signals control the data transfer and the transfer direction (for half-duplex configurations). The DTR signal is like a main switch—when the DTR signal is inactive the RTS and CTS signals have no effect and the modem does not respond to control signals. This functionality is not implemented in the hardware and is the result of how the registers in the UART are programmed.

21-6 Freescale Semiconductor

21.4.4 DTR Edge Triggered Interrupt

The DTR signal can be used to generate an interrupt on a selectable edge. To enable the DTR signal to generate an interrupt, set the data terminal ready interrupt enable (DTREN) bit in UART Control Register 3 (UCR3 x). Clear the DTRF bit by writing 1 to it. Writing 0 to the DTRF bit has no effect.

Write to the DTR interrupt edge control (DPEC) field in UCR3_x to select the edge that generates an interrupt. When the DPEC field is set to 00b and DTREN = 1, the interrupt occurs on the rising edge (default). When the bits are set to 01b and DTREN = 1, the interrupt occurs on the falling edge. When the bits are set to 1Xb and DTREN = 1, the interrupt occurs on either edge. This is a synchronous interrupt.

DTR	DTREN	DPEC [1]	DPEC [0]	DTRF	Interrupt Occurs On	UART_MINT_DTR
Х	0	Х	Х	0	Interrupt disabled	1
1->0	1	0	0	0	Rising edge	1
0->1	1	0	0	1	Rising edge	0
1->0	1	0	1	1	Falling edge	0
0->1	1	0	1	0	Falling edge	1
1->0	1	1	Х	1	Either edge	0
0->1	1	1	Х	1	Either edge	0

Table 21-5. DTR Edge Triggered Interrupt Truth Table

21.4.5 DSR—Data Set Ready

The UART uses the DSR signal to inform the DTE that it is powered on, all preparations are complete, and that it is ready to communicate with the DTE.

21.4.6 DCD—Data Carrier Detect

The UART uses this signal to inform the DTE that it detected the carrier signal and the connection is established. This signal remains active as long as the connection remains established.

21.4.7 RI—Ring Indicator

The UART uses this signal to inform the DTE when a ring occurs.

21.4.8 CTS—Clear To Send

Normally, the receiver indicates that it is ready to receive data by asserting this pin (low). When the CTS trigger level is programmed to trigger at 32 characters received and the receiver detects the valid start bit of the 33rd character, it deasserts this pin.

General UART Definitions

21.4.9 Programmable CTS Deassertion

The CTS output can also be programmed to deassert when the RxFIFO reaches a certain level. Setting the CTS trigger level at any value less than 32 deasserts the CTS pin on detection of the valid start bit of the N + 1 character (where N is the trigger level setting). The receiver continues to receive characters until the RxFIFO is full.

21.4.10 TXD—UART Transmit

This is the transmitter serial output. When operating in normal mode, NRZ encoded data is output. When operating in infrared mode, a 3/16 bit-period pulse is output for each 0 bit transmitted, and no pulse is output for each 1 bit transmitted. For RS-232 applications, this pin must be connected to an RS-232 transmitter.

21.4.11 RXD—UART Receive

This is the receiver serial input. When operating in normal mode, NRZ encoded data is expected. When operating in infrared mode, a narrow pulse is expected for each 0 bit received and no pulse is expected for each 1 bit received. External circuitry must convert the IR signal to an electrical signal. RS-232 applications require an external RS-232 receiver to convert voltage levels.

21-8 Freescale Semiconductor

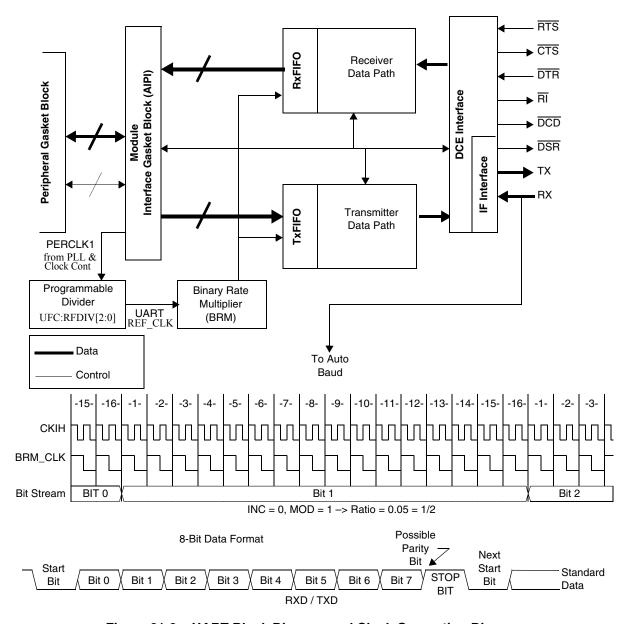


Figure 21-2. UART Block Diagram and Clock Generation Diagram

21.5 Sub-Block Description

The UART module is easy to use from both hardware and software perspectives. The working registers shown in Table 21-6 provide all status (USR1_x, USR2_x) and control (UCR1_x through UCR4_x) functions. A separate test register is provided for applications that require it. The binary rate multiplier (BRM) registers (UBIR_x, UBMR_x, BMPR1_x, and BMPR4_x) control the UART bit rate and there is a transmitter register and a receiver register all shown in Table 21-6.

UART	Status Registers	Control Registers	BRM Registers	BRC Registers	Esc Character Registers	Transmitter Registers	Receiver Registers
1	USR1_1 USR2_1	UCR1_1 UCR2_1 UCR3_1 UCR4_1	UBIR_1 UBMR_1 BMPR1_1 BMPR4_1	UBRC_1	UESC_1 UTIM_1	UTXD_1	URXD_1
2	USR1_2 USR2_2	UCR1_2 UCR2_2 UCR3_2 UCR4_2	UBIR_2 UBMR_2 BMPR1_2 BMPR4_2	UBRC_2	UESC_2 UTIM_2	UTXD_2	URXD_2

The transmit and receive registers are optimized for a 32-bit bus. All status bits associated with the received data are accessible along with the data in a single read. Except for the transmit data (TX_DATA) field in the UART Transmitter Registers, all register bits are readable and most are read/write. The UART Baud Rate Count (BRC) Register performs automatic baud rate detection. There are also two registers for the escape sequence detection, the UART Escape Character Register (UESC_x) and the UART Escape Timer Register (UTIM_x). The following sections describe the basic functionality of the major blocks in UART module.

The MC9328MXS only supports a 16 MHz reference frequency. The reference frequency is defined as the input peripheral clock, PERCLK1, divided by the value of the RFDIV [2:0] bits in the UFCR. Also note that the frequency of the system/CPU clock (HCLK/BCLK) must be greater than the UART reference frequency. For example, if the UART reference frequency is 16 MHz, BCLK must be greater than 16 MHz. If the BCLK frequency is not greater, some of the UART features may not operate properly. For more details on BLCK please refer to Chapter 12, "Phase-Locked Loop and Clock Controller."

It is recommended to use a reference frequency of 16 MHz. Since the default (a maximum) System PLL frequency is 96 MHz, 16 MHz is an integer multiple of 96 MHz. The accuracy of the reference frequency is needed to accurately determine auto baud frequencies and break detect. The System PLL default setting of 96 Mhz also assumes the use of a 32 kHz crystal. If a different crystal frequency is used (such as a 32.768 kHz crystal), the PLL would need to be re-programmed for 96 MHz in order for an accurate 16 MHz ref frequency to be produced. Although reference frequencies of 25 MHz and 30 MHz can also be used to determine features such as auto baud detection and break detect, these are not integer multiples of the default (and maximum) System PLL of 96 MHz.

21.5.1 Transmitter

The transmitter accepts a parallel character from the ARM920T processor and transmits it serially. The start, stop, and parity (when enabled) bits are added to the character. When the ignore RTS bit (IRTS) is set, the transmitter sends a character as soon as it is ready to transmit. RTS can be used to provide flow-control of the serial data. When RTS is negated (high), the transmitter finishes sending the character in progress (if any), stops, and waits for RTS to be asserted (low) again. Generation of BREAK characters and parity errors (for debugging purposes) is supported. The transmitter operates from the 1x clock provided by the BRM. Normal NRZ encoded data is transmitted when the IR interface is disabled.

The transmitter FIFO (TxFIFO) contains 32 bytes. The data is written to TxFIFO by writing to the appropriate register (UTXnD_x) with the byte data to the [7:0] bits. The TxFIFO is addressed using UTXnD_x register (depending on if you are using UART 12) with any one of the 16 addresses (0x00212040–0x0021207C) and the

21-10 Freescale Semiconductor

data is written consecutively if the TxFIFO is not full or is read consecutively if the TxFIFO is not empty. If the TxFIFO is full and data is again attempted to be written to the FIFO, the overrun bit will be set and data cannot be written unless a read is first performed.

21.5.2 Transmitter FIFO Empty Interrupt Suppression

The transmitter FIFO empty interrupt suppression logic suppresses the interrupt between writes to the TxFIFO. When a character is written to the TxFIFO, it is immediately transferred to the transmitter shift register (PISO_OUT) on the next transmit baud rate clock (when the transmitter is enabled). The suppression logic allows the software to write another character to the TxFIFO before the interrupt is asserted. When the transmitter shift register empties before another character is written to the TxFIFO, the interrupt is asserted. Writing data (even a single character) to the TxFIFO releases the interrupt. The interrupt is asserted on the following conditions:

- System reset
- UART module reset
- When a single character has been written to Transmitter FIFO and then the Transmitter FIFO and the Transmitter Shift Register become empty until another character is written to the Transmitter FIFO.
- The last character in the TxFIFO is transferred to the shift register, when TxFIFO contains two or more characters. See Figure 21-3 on page 21-12.

To provide system bus bandwidth efficiency when filling the transmit FIFO, there is a threshold called Transmitter Trigger Level control (TXTL) which allows a maskable interrupt to be generated whenever the data level in the TxFIFO falls below the selected threshold. The following conditions are required to avoid the TxFIFO being overwritten, thus affecting parity calculation and data pattern transmission.

- Maximum 32 bytes can be written into TxFIFO when transmission is completed.
 USR2 bit[3] TXDC = 1, requires the use of polling or interrupt service routine via source UART_MINT_TX with UCR1/TXEMPTYEN = 0, UCR1/TRDYEN = 0 and UCR4/TCEN = 1
- Maximum 31 bytes can be written into TxFIFO when the FIFO is empty.
 USR2 bit[14] TXFE = 1, requires the use of polling or interrupt service routine via source
 UART MINT TX with UCR1/TXEMPTYEN = 1, UCR1/TRDYEN = 0 and UCR4/TCEN = 0
- 3. Write 32-TXTL bytes into TxFIFO when data level in TxFIFO falls below the selected threshold TXTL.

USR1 bit[13] TRDY = 1, scenario where DMA is used with UCR1/TDMAEN = 1

Table 21-7. Number of Characters Allowed to be Written into TxFIFO

USR2	/TXDC	USR2	/TXFE	USR1/TRDY		
1	1	1	32	-	_	
0	1	1	31	-	_	
0	0	1	32–n	-	_	

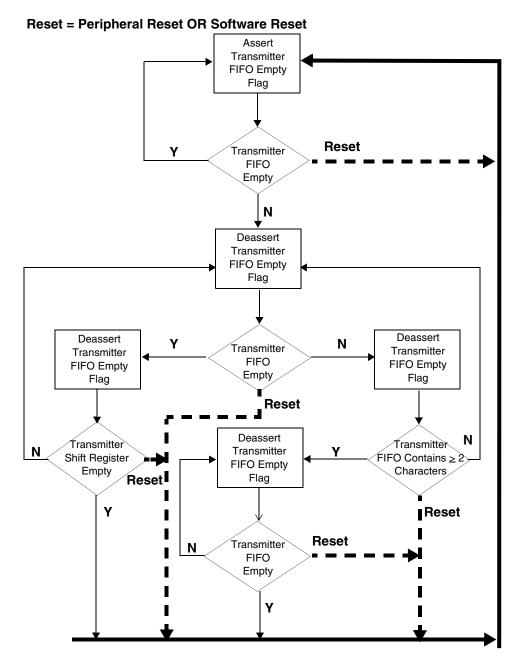


Figure 21-3. Transmitter FIFO Empty Interrupt Suppression Flow Chart

21.5.3 Receiver

The receiver accepts a serial data stream and converts it into parallel characters. When enabled, it searches for a start bit, qualifies it, and samples the following data bits at the bit-center. Jitter tolerance and noise immunity are provided by sampling at a 16x rate and using voting techniques to clean up the samples. Once the start bit is found, the data bits, parity bit (if enabled), and stop bits (either 1 or 2 depending on user selection) are shifted in. Parity is checked and its status reported in the appropriate register (either URXDn_1 2) when parity is enabled. Frame errors and BREAKs are also checked and reported. When a new character is ready to be received by the RxFIFO, the receive data ready (RDR) bit in the UART Status Register 2 (USR2_x) is asserted and an interrupt is posted (if

MC9328MXS Reference Manual, Rev. 1

21-12 Freescale Semiconductor

DREN = 1). If the receiver trigger level is set to 0, the receiver ready interrupt flag (RRDY) is asserted and an interrupt is posted if the receiver ready interrupt enable bit is set (RRDYEN = 1). If any UART Receiver Register (URXD n_x) is read as a word and there is only 1 character in the RxFIFO, the interrupt generated by the RRDY bit is automatically cleared and the data along with 4 status bits are read by the ARM920T processor (see the bit descriptions in Section 21.7.8, "UART Status Register 1," on page 21-40 and Section 21.7.9, "UART Status Register 2," on page 21-42). The RRDY bit is cleared when the data in the RxFIFO falls below the programmed trigger level.

Normal NRZ encoded data is expected when the IR interface is disabled.

The RxFIFO contains 32 half-words. The data is read from the RxFIFO by reading the half-word data in the [15:0] bits in the appropriate register for the UART being used (URXD n_x). The RxFIFO is addressed using the aforementioned register with any one of the 16 addresses and the data is written consecutively if the RxFIFO is not full, or is read consecutively if the RxFIFO is not empty. When additional data is written to the RxFIFO while it is full, the write operation cannot complete unless a read is performed. If a write is performed on the RxFIFO when it is full, the ORE bit is set in the appropriate USR2 x register. The ORE bit is cleared by writing 1 to it.

21.5.4 Idle Line Detect

The receiver logic block includes the ability to detect an idle line. Idle lines indicate the end or the beginning of a message. For an idle condition to occur, there must be at least 1 word in the RxFIFO and the RXD pin must be idle for more than a configured number of frames.

When the idle condition detected interrupt enable (IDEN) bit in the UART Control Register 1 (UCR1_x) is set and the line is idle for 4 (default), 8, 16, or 32 (maximum) frames, the detection of an idle condition flags an interrupt. When an idle condition is detected, the IDLE bit in the appropriate register (USR2_x) is set. Clear the IDLE bit by writing 1 to it. Writing 0 to the IDLE bit has no effect.

21.5.4.1 Idle Condition Detect Configuration

The idle condition detect (ICD [1:0]) field is located in the UART Control Register 1. If the bits are set to 00b, RXD must be idle for more than 4 frames before the IDLE bit is asserted. If the bits are set to 01b, RXD must be idle for more than 8 frames before the IDLE bit is asserted. If the bits are set to 10b, RXD must be idle for more than 16 frames before the IDLE bit is asserted. If the bits are set to 11b, RXD must be idle for more than 32 frames before the IDLE bit is asserted (see Table 21-8).

IDEN	ICD [1]	ICD [0]	IDLE	UART_MINT_RX
0	Х	Х	0	1
1	0	0	asserted after 4 idle frames	asserted after 4 idle frames
1	0	1	asserted after 8 idle frames	asserted after 8 idle frames
1	1	0	asserted after 16 idle frames	asserted after 16 idle frames
1	1	1	asserted after 32 idle frames	asserted after 32 idle frames

Table 21-8. IDLE Detection Truth Table

Note: This table assumes that no other interrupt is set at the same time this interrupt is set for the $\overline{\text{MINT_RX}}$ signal. This table shows how this interrupt affects the $\overline{\text{MINT_RX}}$ signal.

Sub-Block Description

During a normal message there is no idle time between frames. When all of the information bits in a frame are logic 1s, the start bit ensures that at least one logic 0 bit time occurs for each frame so that the IDLE bit is not asserted.

21.5.5 Receiver Wake

The receiver logic block includes the WAKE bit in the USR2_x register that is set when the receiver detects the start bit. The WAKE bit is not set until the start bit is qualified. When the wake interrupt enable (WKEN) bit is enabled, the receiver flags an interrupt (UART_MINT_UARTC) if the WAKE status bit is set. The WAKE bit is cleared by writing 1 to it. Writing 0 to the WAKE bit has no effect.

When the asynchronous wake interrupt (AWAKE) is enabled (AWAKEN = 1) and the ARM920T processor is in STOP mode, a falling edge detected on the receive pin asserts the AWAKE bit and the UART_MINT_UARTC interrupt to wake the ARM920T processor from STOP mode. Clear the AWAKE bit by writing 1 to it. Writing 0 to the AWAKE bit has no effect.

If the asynchronous IR WAKE interrupt is enabled (AIRINTEN = 1), the UART is configured for IR mode, the ARM920T processor is in STOP mode, and a falling edge is detected on the receive pin, this asserts the AIRINT bit and the <u>UART_MINT_UARTC</u> interrupt and wakes the ARM920T processor from STOP mode. Clear the AIRINT bit by writing 1 to it. Writing 0 to the AIRINT bit has no effect.

The recommended procedure for programming the asynchronous interrupts is to first clear them by writing 1 to the appropriate bit in the UART Status Register 1 (USR1_x). Poll or enable the interrupt for the Receiver IDLE Interrupt Flag (RXDS) in the appropriate register (USR1_x). When asserted, the RXDS bit indicates to the software that the receiver state machine is in the idle state, the next state is idle, and the RXD pin is idle (high). After following this procedure, enable the asynchronous interrupt and enter STOP mode.

21.5.6 Receiving a BREAK Condition

A BREAK condition is received when the receiver detects all 0s (including a 0 during the bit time of the stop bit) in a frame. The BREAK condition asserts the BRCD bit in the appropriate register (USR2_x) and writes only the first BREAK character to the RxFIFO. Clear the BRCD bit by writing 1 to it. Writing 0 to the BRCD bit has no effect. The BRCD bit remains asserted as long as a BREAK condition exists. The BREAK condition ends when the receiver detects a 0-to-1 transition.

21.5.7 Vote Logic

The vote logic block provides jitter tolerance and noise immunity by sampling with respect to VOTE_CLK and using voting techniques to clean up the samples. The voting is implemented by sampling the incoming signal constantly on the rising edge of VOTE_CLK. The receiver is provided with the majority vote value, which is 2 out of the 3 samples. Examples of the majority vote results of the vote logic are shown in Table 21-9.

Table 21-9. Majority Vote Results

Samples	Vote
000	0
101	1
001	0
111	1

The vote logic captures a sample on every rising edge of BRM_CLK, however the receiver uses 16x oversampling to take its value in the middle of the sample frame. The idle character may be longer or shorter than 16 counts, however the receiver looks for a 1-to-0 transition. The receiver starts to count when the Start bit is set however it does not capture the contents of the RxFIFO at the time the Start bit is set. The start bit is validated when 0s are received for 7 consecutive bit times following the 1-to-0 transition. Once the counter reaches 0xF, it starts counting on the next bit and captures it in the middle of the sampling frame (see Figure 21-4). All data bits are captured in the same manner. Once the stop bit is detected, the receiver shift register (SIPO OUT) data is parallel shifted to the RxFIFO.

There is a special case when the BRM_CLK period is longer than the period of the IR 0 pulse (when the baud rate is configured for less than 31.25 Kbps). In this case, the software sets the IRSC bit so that the MC9328MXS reference clock is the clock for the voting logic. The pulse is validated by counting the length of the pulse. This logic only works with 16 MHz, 25 MHz, and 30 MHz reference clock frequencies. Enabling this bit with any other reference frequency is undefined. When setting IRSC = 1, either:

- Ignore the first character received, clear the status flags after the RDR bit is set, and proceed,
- OR enables the software reset of the UART module after the initial configuration of UART including setting of the reference frequency bit (Ref16/Ref25/Ref30), however before setting IRSC bit to high. Using this method, insures the first character received is correct.

21.5.8 Binary Rate Multiplier (BRM)

The BRM submodule generates all baud rates that required integer and non-integer division. The input and output frequency ratio is programmed in the UART BRM Incremental Register (UBIR_x) and UART BRM Modulator Register (UBMR_x). The output frequency is divided by the input frequency to produce this ratio. For integer division, set the appropriate UBIR_x register to equal 0x000F and write the divisor to the UBMR_x register. All values written to these registers must be one less than the actual value to eliminate division by 0 (undefined), and to increase the maximum range of the registers.

Updating the BRM registers requires writing to both registers. The UBIR_x register must be written before writing to the UBMR_x register. If only one register is written to by the software, the BRM continues to use the previous values.

The following examples show how to determine what values are to be programmed into UBIR and UBMR for a given reference frequency and desired baud rate. The following equation can be used to help determine these values:

[(Desired Baud Rate)*16]/(reference frequency)=NUM/DENOM

UBIR = NUM - 1

UBMR = DENOM - 1

reference frequency = PERCLK1 / RFDIV [2:0]

MC9328MXS Reference Manual, Rev. 1

Sub-Block Description

Example: Integer Division $\div 2$

```
Reference Frequency = 19.44 MHz

NUM = 0 \times 0000

DENOM = 0 \times 0001

UBIR = NUM - 1

UBMR = DENOM - 1
```

NOTE:

Notice each value written to the registers is one less than the actual value.

Example: Non-integer Division

```
Reference Frequency = 16 MHz Output Frequency = 920 kbps \times 16 (sampling) = 14.72 MHz Ratio --> 14.72 \div 16 = 0.92 NUM = 92 (decimal) = 0x5C DENOM = 100 (decimal) = 0x64 UBIR = NUM - 1 UBMR = DENOM - 1
```

NOTE:

The ratio is derived directly from the division with no factoring (easiest). To derive the exact ratio, some factoring must be performed. Factoring the above ratio produces:

```
Factored Ratio: 23 \div 25

NUM = 22 (decimal) = 0 \times 0016

DENOM = 25 (decimal) = 0 \times 0019
```

Example: Non-integer Division

```
Reference Frequency = 25 MHz Output Frequency = 920 kbps \times 16 (sampling) = 14.72 MHz Ratio --> 14.72 \div 25 = 0.5888 NUM = 5888 (decimal) = 0x1700 DENOM = 10000 (decimal) = 0x2710 UBIR = NUM - 1 UBMR = DENOM - 1
```

NOTE:

The ratio is derived directly from the division with no factoring (easiest). To derive the exact ratio, some factoring must be performed. Factoring the above ratio produces:

```
Factored Ratio = 184 \div 313

NUM = 183 (decimal) = 0 \times 00B7

DENOM = 313 (decimal) = 0 \times 0139
```

Example: Non-integer Division:

```
Reference Frequency: 30 MHz Output Frequency: 920 kbps \times 16 (sampling) = 14.72 MHz Ratio --> 14.72 \div 30 = 0.4907 NUM = 4907 (decimal) = 0x132B DENOM = 10000 (decimal) = 0x2710
```

NOTE:

The ratio is derived directly from the division with no factoring (easiest). To derive the exact ratio, some factoring must be perform. Factoring the above ratio produces:

Factored Ratio: 184 ÷ 325

MC9328MXS Reference Manual, Rev. 1

21-16 Freescale Semiconductor

```
NUM = 183 (decimal) = 0x00B7
DENOM = 325 (decimal) = 0x0144

Baud Rate = (CKIH) ÷ (16 × Divisor)
or
Divisor = (CKIH) ÷ (16 × Baud Rate)
Transmitter Clock = 16 × Baud Rate
Receiver Clock = CKIH ÷ Divisor = 16 × Baud Rate
```

21.5.9 Baud Rate Automatic Detection Logic

When the baud rate automatic detection logic is enabled, the UART locks onto the incoming baud rate. To enable this feature, set the automatic detection of baud rate bit (ADBR = 1) in the UART Control Register 1 and write 1 to the ADET bit in the UART Status Register 2 to clear it. When ADET=0 and ADBR=1, the UART automatically sets the INC=0x0 in the appropriate UBIR_x register and MOD =0x0 in the UBMR_x register. The UART waits for the start bit (transition from 1-to-0) and tries to lock onto the incoming baud rate. Once the start bit is detected, the length of the start bit is calculated by counting until the 0-to-1 transition (see Figure 21-4 and Section 21.5.9.1). The new baud rate is determined using this equation:

Eqn. 21-5

$$BaudRate = \langle \frac{Count}{16} \rangle$$

Table 21-10. Baud Rate Automatic Detection

ADBR	ADET	Baud Rate Detection	UART_MINT_UARTC
0	Х	Manual Configuration	1
1	0	Auto Detection	1
1	1	Auto Detection Complete	0

Note: This table assumes that no other interrupt is set at the same time this interrupt is set for the $\overline{UART_MINT_UARTC}$ signal.

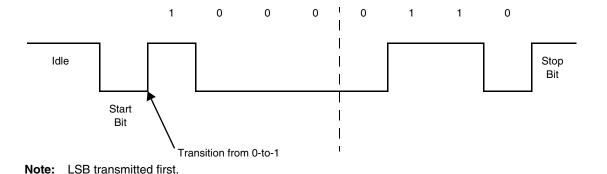


Figure 21-4. Baud Rate Detection Protocol Diagram

The BRM Incremental Preset registers (BIPR1_x through BIPR4_x) and BRM Modulator Preset registers (BMPR1_x through BMPR4_x) are used when detecting the special baud rates (when BPEN = 1). These registers are written by software before the start of automatic baud sequence detection. After the auto baud MC9328MXS Reference Manual, Rev. 1

Sub-Block Description

count value is divided by 16 and a remainder higher than 3 is detected, the appropriate BIPR*n_x* and BMPR*n_x* registers are selected (if the BPEN bit is asserted). This feature is available for 16 MHz, 25 MHz, or 30 MHz reference frequencies only. Enabling this feature with any other reference frequency is not supported and is undefined. The corresponding reference frequency bits in the control register (they are in different registers) must also be set (REF16, REF25, or REF30).

When the BPEN bit is not asserted (BPEN = 0), non-integer division is performed for all detections. This method works with any reference frequency. Based on the reference frequency, the UART computes the baud rate on the fly.

If any of the UART BRM registers are written to simultaneously by the baud rate automatic detection logic and peripheral data bus, the peripheral data bus has priority.

21.5.9.1 Baud Rate Automatic Detection Protocol

The receiver must receive an ASCII character "A" or "a" to verify proper detection of the incoming baud rate. When an ASCII character "A" or "a" is received and no error occurs, the Automatic Detect baud rate bit is set (ADET=1) and if the interrupt is enabled (ADEN=1),an interrupt <u>UART_MINT_UARTC</u> is generated.

When an ASCII character "A" or "a" is not received (because of a bit error or the transmission of another character), the value written into the associated UBIR_x and UBMR_x registers may not be accurate. When the ADET bit is not asserted after the required time-out value (based on baud rate, word size, parity, and number of stop bits), look out for the parity/frame error interrupt (UART_MINT_PFERR = 0) if enabled. After the interrupt is asserted, re-send the character "A" or "a" and repeat the above procedure until the ADET bit is set.

As long as ADET = 0 and ADBR = 1, the UART continues to try to lock onto the incoming baud rate. Once the ASCII character "A" or "a" is detected and the ADET bit is set, the receiver ignores the ADBR bit and continues normal operation with the calculated baud rate divisor.

The UART interrupt is active ($\overline{UART_MINT_UARTC} = 0$) as long as ADET = 1 and ADBR = 1. This can be disabled by clearing the automatic baud rate detection interrupt enable bit (ADEN = 0). Before starting an automatic baud rate detection sequence, set ADET = 0 and ADBR = 1.

The RxFIFO must contain the ASCII character "A" or "a" following the automatic baud rate detection interrupt, which can be cleared by reading it. Because this UART has standard reference frequencies of 16 MHz, 25 MHz, or 30 MHz, the highest achievable baud rate is determined by the value of the reference frequency \div 16.

Reference Frequency (MHz)	Highest Baud Rate (bps)
16 MHz	1 Mbps
25 MHz	1.5625 Mbps
30 MHz	1.875 Mbps

Table 21-11. Highest Baud Rates

The 16-bit UART Baud Rate Count Register (UBRC_x) is reset to 8 and stays at 0xFFFF when an overflow occurs. The appropriate UBRC_x register counts the start bit of the incoming baud rate. When the start bit is detected and counted, the UART Baud Rate Count Register retains its value until the next automatic baud rate detection sequence is initiated.

The read only Baud Rate Count Register counts only when auto detection is enabled.

MC9328MXS Reference Manual, Rev. 1

21-18 Freescale Semiconductor

21.5.10 Escape Sequence Detection

An escape sequence typically consists of 3 characters entered in rapid succession (such as ++++). Because these are valid characters by themselves, the time between characters determines if it is a valid escape sequence. Too much time between two of the + characters is interpreted as two + characters, and not part of an escape sequence.

The software chooses the escape character and writes its value to the associated UART Escape Character Register (UESC x). The hardware compares this value to incoming characters in the RxFIFO. When an escape character is detected, the internal escape timer starts to count. The software specifies a time-out value for the maximum allowable time between escape characters. The escape timer is programmable in intervals of 2 msec to a maximum interval of 8.192 seconds.

Table 21-12. Escape Timer Scaling

UTIM_1/ UTIM_2 Register	Maximum Time Between Specified Escape Characters					
0x000	2 msec					
0x001	4 msec					
0x002	6 msec					
0x003	8 msec					
0x004	10 msec					
0F8	498 msec					
0F9	500 msec					
9C3	5 sec					
FFD	8.188 sec					
FFE	8.190 sec					
FFF	8.192 sec					
Note: To calculate the time interval:						

 $(UTIM_Value + 1) \times 0.002 = Time_Interval$

Example: $(09C3 + 1) \times 0.002 = 5 \text{ sec}$

The escape sequence detection feature is available for 16 MHz, 25 MHz, or 30 MHz reference frequencies only. Enabling this feature with any other reference frequency is not supported and is undefined. Set the corresponding reference frequency bits (REF16 in the UCR4 x register, REF25 or REF30 in UCR3 x register).

The escape sequence detection feature asserts the escape sequence interrupt flag (ESCF) bit when the escape sequence interrupt enable (ESCI) bit is set and an escape sequence is detected. Clear the ESCF bit by writing 1 to it. Writing 0 to the ESCF bit has no effect.

MC9328MXS Reference Manual, Rev. 1

Infrared Interface

21.6 Infrared Interface

The IR interface converts data to be transmitted or received as specified in the IRDA Serial Infrared Physical Layer Specification.

For each 0 to be transmitted, a narrow positive pulse (3/16 of a bit time) is generated. For each 1 to be transmitted, no pulse is generated (output is low). The data is muxed out onto the TXD pin when the infrared interface enable bit is set (IREN = 1). External circuitry must be provided to drive an infrared LED.

When receiving, a narrow negative pulse is expected for each 1 transmitted and no pulse is expected for each 0 transmitted (input is high). The data from the RXD pin is demuxed to the appropriate IR decoder logic when the infrared interface enable bit is set (IREN = 1). Circuitry external to the MC9328MXS transforms the IR signal into an electrical signal.

Serial infrared mode (SIR) uses an edge triggered interrupt flag (the serial infrared interrupt flag, IRINT, in the associated USR2_x register) that validates 0 bits as they are received. When INVR =0, detection of a falling edge on the UART_RXD pin assets the IRINT bit. When INVR=1, detection of a rising edge on the UART_RXD pin assets the IRINT bit. When both the IRINT and ENIRI bits are asserted, the UART_MINT_UARTC interrupt is asserted. Clear the IRINT bit by writing 1 to it. Writing 0 to the IRINT bit has no effect.

In many applications, the ability to detect IrDA pulses $< 2\mu s$ (micro-seconds) has caused data to be misread or missed all together. The work around to this is to allow enough oversampling of the UART clock when receiving narrow IR pulses $< 2\mu s$ by configuring PerCLK1 greater than the selected reference frequency of 16 MHZ, 25 MHz, or 30 MHz as selected in the UART registers UCR3 and UCR4. The UART module will think that it is using a certain reference frequency, however, in fact it will be over driven by a higher frequency PerCLK1. However, caution must be used when employing this method as this will render features that are dependant on an accurate reference frequencies useless, such as the auto baud detection and break detection. Also, baud rates will need to be re-calculated based on the PerCLK1 clock frequency. An example suggestion is to simply set PerCLK1 to 32 MHz, while setting the UART reference frequency to 16 MHz (make sure that the RFDIV bits are set to divide by one in the UFCR register and REF16 is set in the UCR4 register). This oversampling ensures that IR pulses $< 2\mu s$ will be detected. Also, make sure to remember to re-calculate the baud rates based on the value of 32 MHz and not 16 MHz when using this example.

21-20 Freescale Semiconductor

21.7 Programming Model

The UART modules include user-accessible 32-bit registers and user-accessible 16-bit registers. All registers use word, halfword, or byte access. The UART Receiver Registers and the UART Transmitter Registers are each mapped to 16 word-length addresses to support the load multiple registers (LDM) instruction and the store multiple registers (STM) instruction, respectively

Table 21-13 summarizes these registers and their addresses.

Table 21-13. UART Module Register Memory Map

Description	Name	Address					
UART 1	<u> </u>						
UART1 Receiver Register n	URXDn_1	0x00206000+4*n					
UART1 Transmitter Register n	UTXnD_1	0x00206040+4*n					
UART1 Control Register 1	UCR1_1	0x00206080					
UART1 Control Register 2	UCR2_1	0x00206084					
UART1 Control Register 3	UCR3_1	0x00206088					
UART1 Control Register 4	UCR4_1	0x0020608C					
UART1 FIFO Control Register	UFCR_1	0x00206090					
UART1 Status Register 1	USR1_1	0x00206094					
UART1 Status Register 2	USR2_1	0x00206098					
UART1 Escape Character Register	UESC_1	0x0020609C					
UART1 Escape Timer Register	UTIM_1	0x002060A0					
UART1 BRM Incremental Register	UBIR_1	0x002060A4					
UART1 BRM Modulator Register	UBMR_1	0x002060A8					
UART1 Baud Rate Count Register	UBRC_1	0x002060AC					
UART1 BRM Incremental Preset Register 1	BIPR1_1	0x002060B0					
UART1 BRM Incremental Preset Register 2	BIPR2_1	0x002060B4					
UART1 BRM Incremental Preset Register 3	BIPR3_1	0x002060B8					
UART1 BRM Incremental Preset Register 4	BIPR4_1	0x002060BC					
UART1 BRM Modulator Preset Register 1	BMPR1_1	0x002060C0					
UART1 BRM Modulator Preset Register 2	BMPR2_1	0x002060C4					
UART1 BRM Modulator Preset Register 3	BMPR3_1	0x002060C8					
UART1 BRM Modulator Preset Register 4	BMPR4_1	0x002060CC					
UART1 Test Register 1	UTS_1	0x002060D0					
UART 2							
UART2 Receiver Register n	URXDn_2	0x00207000+4*n					
UART2 Transmitter Register n	UTXnD_2	0x00207040+4*n					
UART2 Control Register 1	UCR1_2	0x00207080					
UART2 Control Register 2	UCR2_2	0x00207084					
UART2 Control Register 3	UCR3_2	0x00207088					

MC9328MXS Reference Manual, Rev. 1

Programming Model

Table 21-13. UART Module Register Memory Map (continued)

Description	Name	Address
UART2 Control Register 4	UCR4_2	0x0020708C
UART2 FIFO Control Register	UFCR_2	0x00207090
UART2 Status Register 1	USR1_2	0x00207094
UART2 Status Register 2	USR2_2	0x00207098
UART2 Escape Character Register	UESC_2	0x0020709C
UART2 Escape Timer Register	UTIM_2	0x002070A0
UART2 BRM Incremental Register	UBIR_2	0x002070A4
UART2 BRM Modulator Register	UBMR_2	0x002070A8
UART2 Baud Rate Count Register	UBRC_2	0x002070AC
UART2 BRM Incremental Preset Register 1	BIPR1_2	0x002070B0
UART2 BRM Incremental Preset Register 2	BIPR2_2	0x002070B4
UART2 BRM Incremental Preset Register 3	BIPR3_2	0x002070B8
UART2 BRM Incremental Preset Register 4	BIPR4_2	0x002070BC
UART2 BRM Modulator Preset Register 1	BMPR1_2	0x002070C0
UART2 BRM Modulator Preset Register 2	BMPR2_2	0x002070C4
UART2 BRM Modulator Preset Register 3	BMPR3_2	0x002070C8
UART2 BRM Modulator Preset Register 4	BMPR4_2	0x002070CC
UART2 Test Register 1	UTS_2	0x002070D0

21-22 Freescale Semiconductor

21.7.1 UART Receiver Registers

The read-only UART Receiver Registers contain the received character and its status. After reset, when the receiver enable bit is set (RXEN = 1), these registers contain random data and the CHARRDY bit is 0 until the first character is received. The $URXDn_x$ registers are each mapped to 16 word-length addresses to support the LDM instruction.

URXDn_1 UART1 Receiver Register n URXDn_2 UART2 Receiver Register n											4 -000 -7000					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	CHAR RDY	ERR	OVR RUN	FRM ERR	BRK	PR ERR						RX_	DATA			
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	?	?	?	?	?	?	?	?
TILOLI								0x00	00							

Note: n = (0 through 15)

Table 21-14. UART 1 2 Receiver Register Descriptions

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
CHARRDY Bit 15	Character Ready—Indicates an invalid read when the RxFIFO is empty and the software attempts to read the previously read data.	0 = The character in the RX_DATA field and its associated flags are invalid. 1 = The character in the RX_DATA field and its associated flags are valid and ready to read
ERR Bit 14	Error Detect —Indicates whether the character present in the RX_DATA field has an error (OVRRUN, FRMERR, BRK or PRERR) status. The ERR bit is updated and valid for each received character.	0 = No error status was detected 1 = An error status was detected
OVRRUN Bit 13	Receiver Overrun—Indicates whether the receiver ignored data to prevent overwriting the data in the RxFIFO. This error indicates that the software is not keeping up with the incoming data rate. OVRRUN is set for the last (32nd) character written to the RxFIFO to indicate that all characters following this character will be ignored if a read is not performed by the software. OVRRUN is updated and valid for each received character. Under normal circumstances, OVRRUN is never set.	0 = No RxFIFO overrun was detected 1 = A RxFIFO overrun was detected

MC9328MXS Reference Manual, Rev. 1

Programming Model

Table 21-14. UART 1 2 Receiver Register Descriptions (continued)

Name	Description	Settings		
FRMERR Bit 12	Frame Error—Indicates whether the current character had a framing error (a missing stop bit) and is possibly corrupted. FRMERR is updated for each character read from the RxFIFO.	0 = The current character has no framing error 1 = The current character has a framing error		
BRK Bit 11	BREAK Detect—Indicates whether the current character was detected as a BREAK character. The data bits and the stop bit are all 0. The FRMERR bit is set when BRK is set. When odd parity is selected, PRERR is also set when BRK is set. BRK is valid for each character read from the RxFIFO.	0 = The current character is not a BREAK character 1 = The current character is a BREAK character		
PRERR Bit 10	Parity Error—Indicates whether the current character was detected with a parity error and is possibly corrupted. PRERR is updated for each character read from the RxFIFO. When parity is disabled, PRERR always reads as 0.	0 = No parity error was detected for data in the RX_DATA field 1 = A parity error was detected for data in the RX_DATA field		
Reserved Bits 9–8	Reserved—These bits are reserved and should read 0.			
RX_DATA Bits 7–0	Received Data —Holds the received character. In 7-bit mode, the to 0. In 8-bit mode, all bits are active.	e most significant bit (MSB) is forced		

21.7.2 UART Transmitter Registers

The write-only UART Transmitter Registers are where the ARM920T processor writes the data to be transmitted. When these registers are read, the TX_DATA bits are always read as 0. The UTXnD_x registers are each mapped to 16 word-length addresses to support the STM instruction.

UTXnD_1 UART1 Transmitter Register n UTXnD_2 UART2 Transmitter Register n								Add 0x00206040+4*r 0x00207040+4*r								
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NEGET								0x0	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
[TX_I	DATA			
TYPE	r	r	r	r	r	r	r	r	w	w	w	W	W	W	W	W
RESET	0	0	0	0	0	0	0	0	?	?	?	?	?	?	?	?
NESET								0x0	000							

Note: n = (0 through 15)

Table 21-15. UART 1 2 Transmitter Register Descriptions

Name	Description
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.
TX_DATA Bits 7–0	Transmit Data —Holds the parallel transmit data inputs. In 7-bit mode, D7 is ignored. In 8-bit mode, all bits are used. Data is transmitted least significant bit (LSB) first. A new character is transmitted when the TX_DATA field is written. The TX_DATA field must be written only when the TRDY bit is high to ensure that corrupted data is not sent.

Programming Model

21.7.3 UART Control Register 1

UART Control Register 1 enables the respective UART features and controls the transmit and receive blocks. This register also controls the TxFIFO and RxFIFO levels and enables the TRDY and RRDY interrupts.

Λddr

UCR1	_							l Reg I Reg							0206 0207 0207	
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI		0x0000														
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	ADEN	ADBR	TRDY EN	IDEN	IC	D	RRDY EN	RDMA EN	IREN	TXMPTY EN	RTSD EN	SND BRK	TDMA EN	UARTCLK EN	DOZE	UART EN
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
NESEI									0x000	04						

Table 21-16. UART 1 2 Control Register 1 Descriptions

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
ADEN Bit 15	Automatic Baud Rate Detection Interrupt Enable—Enables/Disables the automatic baud rate detect complete (ADET) bit to generate an interrupt (UART_MINT_UARTC = 0).	0 = Disable the automatic baud rate detection interrupt 1 = Enable the automatic baud rate detection interrupt
ADBR Bit 14	Automatic Detection of Baud Rate—Enables/Disables automatic baud rate detection. When the ADBR bit is set and the ADET bit is cleared, the receiver detects the incoming baud rate automatically. The ADET flag is set when the receiver verifies that the incoming baud rate is detected properly by detecting an ASCII character "A" or "a" (0x61 or 0x41).	0 = Disable automatic detection of baud rate 1 = Enable automatic detection of baud rate
TRDYEN Bit 13	Transmitter Ready Interrupt Enable—Enables/Disables the transmitter Ready Interrupt (TRDY) when the transmitter has one or more slots available in the TxFIFO. The fill level in the TXFIFO at which an interrupt is generated is controlled by TxTL bits. When TRDYEN is negated, the transmitter ready interrupt is disabled.	0 = Disable the transmitter ready interrupt 1 = Enable the transmitter ready interrupt
IDEN Bit 12	Idle Condition Detected Interrupt Enable—Enables/Disables the IDLE bit to generate an interrupt (UART_MINT_RX = 0).	0 = Disable the IDLE bit 1 = Enable the IDLE bit

MC9328MXS Reference Manual, Rev. 1

21-26 Freescale Semiconductor

Table 21-16. UART 1 2 Control Register 1 Descriptions (continued)

Name	Description	Settings
ICD Bits 11–10	Idle Condition Detect—Controls the number of frames RXD is allowed to be idle before an idle condition is reported.	00 = Idle for more than 4 frames 01 = Idle for more than 8 frames 10 = Idle for more than 16 frames 11 = Idle for more than 32 frames
RRDYEN Bit 9	Receiver Ready Interrupt Enable—Enables/Disables the RRDY interrupt when the RxFIFO contains data. The fill level in the RXFIFO at which an interrupt is generated is controlled by the RXTL bits. When RRDYEN is negated, the receiver ready interrupt is disabled.	0 = Disables the RRDY interrupt 1 = Enables the RRDY interrupt
RDMAEN Bit 8	Receive Ready DMA Enable—Enables/Disables the receive DMA request UART_RX_DMAREQ when the receiver has data in the RxFIFO. The fill level in the RxFIFO at which a DMA request is generated is controlled by the RXFL bits. When negated, the receive DMA request is disabled.	0 = Disable UART_RX_DMAREQ DMA request 1 = Enable UART_RX_DMAREQ DMA request
IREN Bit 7	Infrared Interface Enable—Enables/Disables the IR interface. See the IR interface description in Section 21.6 for more information.	0 = Disable the IR interface 1 = Enable the IR interface
TXMPTYEN Bit 6	Transmitter Empty Interrupt Enable—Enables/Disables the transmitter FIFO empty (TXFE) interrupt. UART_MINT_TX. When negated, the TXFE interrupt is disabled.	0 = Disable the transmitter FIFO empty interrupt 1 = Enable the transmitter FIFO empty interrupt
RTSDEN Bit 5	RTS Delta Interrupt Enable—Enables/Disables the RTSD interrupt. The current status of the UARTx_RTS pin is read in the RTSS bit.	0 = Disable RTSD interrupt 1 = Enable RTSD interrupt
SNDBRK Bit 4	Send BREAK—Forces the transmitter to send a BREAK character. The transmitter finishes sending the character in progress (if any) and sends BREAK characters until SNDBRK is reset. Because the transmitter samples SNDBRK after every bit is transmitted, it is important that SNDBRK is asserted high for a sufficient period of time to generate a valid BREAK. After the BREAK transmission completes, the UART transmits 2 mark bits. The user can continue to fill the TxFIFO and any characters remaining are transmitted when the BREAK is terminated.	0 = Do not send a BREAK character 1 = Send a BREAK character (continuous 0s)
TDMAEN Bit 3	Transmitter Ready DMA Enable—Enables/Disables the transmit DMA request UART_TX_DMAREQ when the transmitter has one or more slots available in the TxFIFO. The fill level in the TxFIFO that generates the UART_TX_DMAREQ is controlled by the TXTL bits.	0 = Disable transmit DMA request 1 = Enable transmit DMA request
UARTCLKEN Bit 2	UART Clock Enable—Enables/Disables all of the internal clocks of the UART module	0 = Disable UART clocks 1 = Enable UART clocks

Programming Model

Table 21-16. UART 1 2 Control Register 1 Descriptions (continued)

Name	Description	Settings
DOZE Bit 1	DOZE—Determines the UART enable condition in the DOZE state. When the ARM9 core executes a DOZE instruction and the system is placed in the DOZE state, the DOZE bit affects the operation of the UART. When the system is in the DOZE state and the DOZE bit is asserted, the UART is disabled. See Section 21.8, "UART Operation in Low-Power System States," on page 21-52 for more information.	0 = The UART is enabled when in DOZE state 1 = The UART is disabled when in DOZE state
UARTEN Bit 0	UART Enable —Enables/Disables the UART. If UARTEN is negated in the middle of a transmission, the transmitter stops and pulls the TXD line to a logic 1.	0 = Disable the UART 1 = Enable the UART

MC9328MXS Reference Manual, Rev. 1 21-28 Freescale Semiconductor

21.7.4 UART Control Register 2

The UART Control Register 2 controls the overall operation of its respective UART. The bits in these registers set the BITSEL and its source, specify the number of bits per character, enable or disable parity generation and checking, and control the RTS and CTS pins.

UCR2_1 UART1 Control Register 2 UCR2_2 UART2 Control Register 2								_	Addr 0x00206084 0x00207084							
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x0	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	ESCI	IRTS	CTSC	CTS	ESC EN	RT	EC	PREN	PROE	STPB	ws	RTS EN		TXEN	RXEN	SRST
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
RESET								0x0	001							

Table 21-17. UART 1 2 Control Register 2 Descriptions

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
ESCI Bit 15	Escape Sequence Interrupt Enable—Enables/Disables the ESCF bit to generate an interrupt.	0 = Disable the escape sequence interrupt 1 = Enable the escape sequence interrupt
IRTS Bit 14	Ignore UARTx_RTS Pin—Forces the UARTx_RTS input signal presented to the transmitter to always be asserted, effectively ignoring the external pin. When in this mode, the UARTx_RTS pin serves as a general purpose input.	0 = Transmit only when the UARTx_RTS pin is asserted 1 = Ignore the UARTx_RTS pin
CTSC Bit 13	UARTx_CTS Pin Control—Controls the operation of the UARTx_CTS output pin. When CTSC is asserted, the UARTx_CTS output pin is controlled by the receiver. When the RxFIFO is filled to the level of the programmed trigger level and the start bit of the overflowing character (TRIGGER LEVEL + 1) is validated, the UARTx_CTS output pin is negated to indicate to the far-end transmitter to stop transmitting. When the trigger level is programmed for less than 32, the receiver continues to receive data until the RxFIFO is full. When the CTSC bit is negated, the UARTx_CTS output pin is controlled by the CTS bit. On reset, because CTSC is cleared to 0, the UARTx_CTS pin is controlled by the CTS bit, which again is cleared to 0 on reset. This means that on reset the UARTx_CTS signal is negated.	0 = The UARTx_CTS pin is controlled by the CTS bit 1 = The UARTx_CTS pin is controlled by the receiver

MC9328MXS Reference Manual, Rev. 1

Table 21-17. UART 1 2 Control Register 2 Descriptions (continued)

Name	Description	Settings			
CTS Bit 12	Clear to Send—Controls the UARTx_CTS pin when the CTSC bit is negated. CTS has no function when CTSC is asserted.	0 = The UARTx_CTS pin is high (inactive) 1 = The UARTx_CTS pin is low (active)			
ESCEN Bit 11	Escape Enable—Enables/Disables the escape sequence detection logic.	0 = Disable escape sequence detection 1 = Enable escape sequence detection			
RTEC Bits 10–9	Request to Send Edge Control—Selects the edge that triggers the RTS interrupt. This has no effect on the RTS delta interrupt. RTEC has an effect only when RTSEN = 1 (see Table 21-4).	00 = Trigger interrupt on a rising edge 01 = Trigger interrupt on a falling edge 1X = Trigger interrupt on any edge			
PREN Bit 8	Parity Enable—Enables/Disables the parity generator in the transmitter and parity checker in the receiver. When PREN is asserted, the parity generator and checker are enabled, and disabled when PREN is negated.	0 = Disable parity generator and checker 1 = Enable parity generator and checker			
PROE Bit 7	Parity Odd/Even—Controls the sense of the parity generator and checker. When PROE is high, odd parity is generated and expected. When PROE is low, even parity is generated and expected. PROE has no function if PREN is low.	0 = Even parity 1 = Odd parity			
STPB Bit 6	Stop—Controls the number of stop bits transmitted after a character. When STPB is high, 2 stop bits are sent. When STPB is low, 1 stop bit is sent. STPB has no effect on the receiver, which expects 1 or more stop bits.	0 = 1 stop bit transmitted 1 = 2 stop bits transmitted			
WS Bit 5	Word Size—Controls the character length. When WS is high, the transmitter and receiver are in 8-bit mode. When WS is low, they are in 7-bit mode. The transmitter ignores bit 7 and the receiver sets bit 7 to 0. WS can be changed in-between transmission (reception) of characters, however not when a transmission (reception) is in progress, in which case the length of the current character being transmitted (received) is unpredictable.	0 = 7-bit transmit and receive character length (not including START, STOP or PARITY bits) 1 = 8-bit transmit and receive character length (not including START, STOP or PARITY bits)			
RTSEN Bit 4	Request to Send Interrupt Enable—Controls the RTS edge sensitive interrupt. When RTSEN is asserted and the programmed edge is detected on the UARTx_RTS pin, the RTSF bit is asserted (see Table 21-4).	0 = Disable request to send interrupt 1 = Enable request to send interrupt			
Reserved Bit 3	Reserved—This bit is reserved and should read 0.				
TXEN Bit 2	Transmitter Enable—Enables/Disables the transmitter. When TXEN is negated the transmitter is disabled and idle. When the UARTEN and TXEN bits are set the transmitter is enabled. If TXEN is negated in the middle of a transmission, the UART disables the transmitter immediately, and starts marking 1s.	0 = Disable the transmitter 1 = Enable the transmitter			

MC9328MXS Reference Manual, Rev. 1

21-30 Freescale Semiconductor

Table 21-17. UART 1 2 Control Register 2 Descriptions (continued)

Name	Description	Settings				
RXEN Bit 1	Receiver Enable—Enables/Disables the receiver. When the receiver is enabled, if the RXD input is already low, the receiver does not recognize BREAK characters, because it requires a valid 1-to-0 transition before it can accept any character.	0 = Disable the receiver 1 = Enable the receiver				
SRST Bit 0	Software Reset—Resets the transmitter and receiver state machines, all FIFOs, and all status registers. Once the software writes 0 to SRST, the software reset remains active for 4 clock cycles of CKIH before the hardware deasserts SRST. The software can only write 0 to SRST. Writing 1 to SRST is ignored.	0 = Reset the transmit and receive state machines, all FIFOs and all status registers 1 = No reset				

21.7.5 UART Control Register 3

The UART Control Register 3 controls the features and operation of UART 1.

21.7.5.1 UART1 Control Register 3

UCR3	_1			U	ART1 Co	ont	rol	Re	egis	ster 3				0x0		Addr 6088
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								02	k000	0						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
				PARERREN	FRAERREN					RXDS EN	AIRINT EN	AWAK EN	REF25	REF30	INVT	BPEN
TYPE	r	r	r	rw	rw	r	r	r	r	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ILOLI								02	k000	0						

Table 21-18. UART 1 Control Register 3 Descriptions

Name	Description	Settings				
Reserved Bits 31–13						
PARERREN Bit 12	Parity Error Interrupt Enable—Enables/Disables the interrupt. When asserted, PARERREN causes the PARITYERR bit to generate an interrupt (UART_MINT_PFERR = 0)	0 = Disable the parity error interrupt 1 = Enable the parity error interrupt				
FRAERREN Bit 11	Frame Error Interrupt Enable—Enables/Disables the interrupt. When asserted, FRAERREN causes the FRAMERR bit to generate an interrupt (UART_MINT_PFERR = 0)	0 = Disable the frame error interrupt 1 = Enable the frame error interrupt				
Reserved Bits 10–7	Reserved—These bits are reserved and should read 0 always read 0.	For proper operation, ensure these bits				
RXDSEN Bit 6	Receive Status Interrupt Enable—Controls the receive status interrupt (UART_MINT_RX). When this bit is enabled and RXDS status bit is set, the interrupt UART_MINT_RX will be generated.	0 = Disable the RXDS interrupt 1 = Enable the RXDS interrupt				
AIRINTEN Bit 5	Asynchronous IR WAKE Interrupt Enable—Controls the asynchronous IR WAKE interrupt. An interrupt is generated when AIRINTEN is asserted and a pulse is detected on the UART_RX pin.	0 = Disable the AIRINT interrupt 1 = Enable the AIRINT interrupt				

MC9328MXS Reference Manual, Rev. 1

21-32 Freescale Semiconductor

Table 21-18. UART 1 Control Register 3 Descriptions

Name	Description	Settings
AWAKEN Bit 4	Asynchronous WAKE Interrupt Enable—Controls the asynchronous WAKE interrupt. An interrupt is generated when AWAKEN is asserted and a falling edge is detected on the RXD pin.	0 = Disable the AWAKE interrupt 1 = Enable the AWAKE interrupt
REF25 Bit 3	Reference Frequency 25 MHz—Indicates to the hardware that a reference clock frequency of 25 MHz is used. The reference clock is derived from the input clock IPG_CLK via the programmable divider.	0 = 25 MHz reference clock not used 1 = 25 MHz reference clock used
REF30 Bit 2	Reference Frequency 30 MHz—Indicates to the hardware that a reference clock frequency of 30 MHz is used. The reference clock is derived from the input clock IPG_CLK via the programmable divider.	0 = 30 MHz reference clock not used 1 = 30 MHz reference clock used
INVT Bit 1	Inverted Infrared Transmission—Sets the active level for the transmission. When INVT is cleared, the infrared logic block transmits a positive IR 3/16 pulse for all 0s and 0s are transmitted for 1s. When INVT is set (INVT = 1), the infrared logic block transmits an active low or negative infrared 3/16 pulse for all 0s and 1s are transmitted for 1s.	0 = Active low transmission 1 = Active high transmission
BPEN Bit 0	Preset Registers Enable—Activates the BRM preset registers for use during automatic baud rate detection mode. When BPEN is deasserted, the remainder from the automatic baud count register divided by 16 is ignored. When BPEN is asserted, the remainder and the dividend chooses the appropriate preset register on the detection of special baud rates. If the criteria is not met for selecting one of the preset registers, integer division is performed by writing one less than the dividend to the UBMR_1/UBMR_2 register.	0 = The BRM preset registers are not used (normal operation) 1 = The BRM preset registers are used (auto detect special baud rates)

Programming Model 21.7.5.2 UART2 Control Register 3

UCR3	_2			ι	JART2	Cor	ntrol	Re	gist	er 3				0x0		4ddr 7088
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NEGET								0x(0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	DPE	EC	DTR EN	PARERR EN	FRAERR EN	DSR	DCD	RI		RXDS EN	AIR INT EN	AWAK EN	REF25	REF30	INVT	BPEN
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ILOLI								0x	0000							

Table 21-19. UART 2 Control Register 3 Descriptions

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0).
DPEC Bits 15–14	DTR Interrupt Edge Control —Controls the edge that generates an interrupt. An interrupt is generated only if the DTREN bit is set.	00 = Interrupt generated on rising edge 01 = Interrupt generated on falling edge 1X = Interrupt generated on either edge
DTREN Bit 13	Data Terminal Ready Interrupt Enable—Controls the DTR edge sensitive interrupt. When DTREN is asserted and the programmed edge is detected on the UART2_DTR pin, the DTRF bit is asserted (see Table 21-4).	 0 = Disable the data terminal ready interrupt 1 = Enable the data terminal ready interrupt
PARERREN Bit 12	Parity Error Interrupt Enable—Enables/Disables the interrupt. When asserted, PARERREN causes the PARITYERR bit to generate an interrupt (UART_MINT_PFERR = 0)	0 = Disable the parity error interrupt 1 = Enable the parity error interrupt
FRAERREN Bit 11	Frame Error Interrupt Enable—Enables/Disables the interrupt. When asserted, FRAEREN causes the FRAMERR bit to generate an interrupt (UART_MINT_PFERR = 0)	0 = Disable the frame error interrupt 1 = Enable the frame error interrupt
DSR Bit 10	Data Set Ready—Selects the logic level for the UART_DSR pin for the modem interface.	0 = The UART_DSR pin is logic 0 1 = The UART_DSR pin is logic 1
DCD Bit 9	Data Carrier Detect—Selects the logic level for the UART_DCD pin for the modem interface.	0 = The UART_DCD pin is logic 0 1 = The UART_DCD pin is logic 1
RI Bit 8	Ring Indicator—Selects the logic level for the UART_RI pin for the modem interface.	0 = The UART_RI pin is logic 0 1 = The UART_RI pin is logic 1

MC9328MXS Reference Manual, Rev. 1

21-34 Freescale Semiconductor

Table 21-19. UART 2 Control Register 3 Descriptions (continued)

Name	Description	Settings
Reserved Bit 7	This bit is reserved and should read zero. For proper of	operation, ensure this bit always reads 0.
RXDSEN Bit 6	Receive Status Interrupt Enable—Controls the receive status interrupt (UART_MINT_RX). When this bit is enabled and RXDS status bit is set, the interrupt UART_MINT_RX will be generated.	0 = Disable the RXDS interrupt 1 = Enable the RXDS interrupt
AIRINTEN Bit 5	Asynchronous IR WAKE Interrupt Enable—Controls the asynchronous IR WAKE interrupt. An interrupt is generated when AIRINTEN is asserted and a pulse is detected on the UART_RX pin.	0 = Disable the AIRINT interrupt 1 = Enable the AIRINT interrupt
AWAKEN Bit 4	Asynchronous WAKE Interrupt Enable—Controls the asynchronous WAKE interrupt. An interrupt is generated when AWAKEN is asserted and a falling edge is detected on the RXD pin.	0 = Disable the AWAKE interrupt 1 = Enable the AWAKE interrupt
REF25 Bit 3	Reference Frequency 25 MHz—Indicates to the hardware that a reference clock frequency of 25 MHz is used. The reference clock is derived from the input clock IPG_CLK via the programmable divider.	0 = 25 MHz reference clock not used 1 = 25 MHz reference clock used
REF30 Bit 2	Reference Frequency 30 MHz—Indicates to the hardware that a reference clock frequency of 30 MHz is used. The reference clock is derived from the input clock IPG_CLK via the programmable divider.	0 = 30 MHz reference clock not used 1 = 30 MHz reference clock used
INVT Bit 1	Inverted Infrared Transmission—Sets the active level for the transmission. When INVT is cleared, the infrared logic block transmits a positive IR 3/16 pulse for all 0s and 0s are transmitted for 1s. When INVT is set (INVT = 1), the infrared logic block transmits an active low or negative infrared 3/16 pulse for all 0s and 1s are transmitted for 1s.	0 = Active low transmission 1 = Active high transmission
BPEN Bit 0	Preset Registers Enable—Activates the BRM preset registers for use during automatic baud rate detection mode. When BPEN is deasserted, the remainder from the automatic baud count register divided by 16 is ignored. When BPEN is asserted, the remainder and the dividend chooses the appropriate preset register on the detection of special baud rates. If the criteria is not met for selecting one of the preset registers, integer division is performed by writing one less than the dividend to the UMBR_2/UMBR_3 register.	0 = The BRM preset registers are not used (normal operation) 1 = The BRM preset registers are used (auto detect special baud rates)

21.7.6 UART Control Register 4

The UART Control Register 4 provides configuration control for the UARTs and is used to enable/disable several UART interrupts.

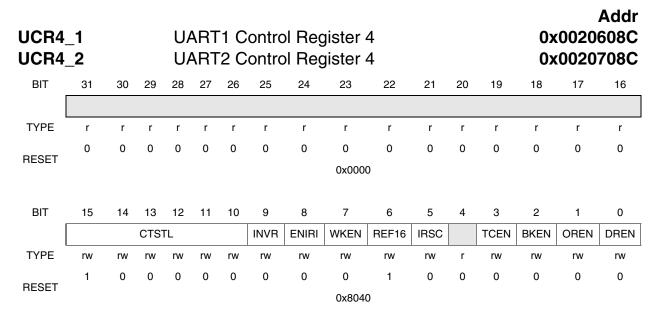


Table 21-20. UART 1 2 Control Register 4 Descriptions

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
CTSTL Bits 15–10	CTS Trigger Level—Controls the threshold at which the CTS pin is deasserted by the RxFIFO. After the trigger level is reached and the CTS pin is deasserted, the RxFIFO continues to receive data until it is full. The CTSTL bits are encoded as shown in the Settings column.	000000 = 0 characters received 000001 = 1 characters in the RxFIFO 100000 = 32 characters in the RxFIFO (maximum) All Other Settings Reserved
INVR Bit 9	Inverted Infrared Reception—Determines the logic level for the detection. When cleared, the infrared logic block expects an active low or negative IR 3/16 pulse for 0s and 1s are expected for 1s. When INVR is set (INVR = 1), the infrared logic block expects an active high or positive IR 3/16 pulse for 0s and 0s are expected for 1s.	0 = Active low detection 1 = Active high detection
ENIRI Bit 8	Serial Infrared Interrupt Enable—Enables/Disables the serial infrared interrupt.	0 = Serial infrared Interrupt disabled 1 = Serial infrared Interrupt enabled
WKEN Bit 7	WAKE Interrupt Enable —Enables/Disables the WAKE bit to generate an interrupt. The WAKE bit is set at the detection of a start bit by the receiver.	0 = Disable the WAKE interrupt 1 = Enable the WAKE interrupt
REF16 Bit 6	Reference Frequency 16 MHz—Indicates to the hardware that a reference clock of 16 MHz is used. The reference clock is derived from input clock IPG_CLK via the programmable divider.	0 = 16 MHz reference clock not used 1 = 16 MHz reference clock is used

MC9328MXS Reference Manual, Rev. 1

21-36 Freescale Semiconductor

Table 21-20. UART 1 2 Control Register 4 Descriptions (continued)

Name	Description	Settings			
IRSC Bit 5	IR Special Case—Selects the clock for the vote logic. When set, IRSC switches the vote logic clock from the sampling clock to the UART reference clock. The IR pulses are counted a predetermined amount of time depending on the reference frequency.	0 = The vote logic uses the sampling clock (16x baud rate) for normal operation 1 = The vote logic uses the UART reference clock			
Reserved Bit 4	Reserved—This bit is reserved and should read 0.				
TCEN Bit 3	Transmit Complete Interrupt Enable —Enables/Disables the TXDC bit to generate an interrupt (UART_MINT_TX = 0).	0 = Disable TXDC interrupt 1 = Enable TXDC interrupt			
BKEN Bit 2	BREAK Condition Detected Interrupt Enable—Enables/Disables the BRCD bit to generate an interrupt (UART_MINT_UARTC = 0).	0 = Disable the BRCD interrupt 1 = Enable the BRCD interrupt			
OREN Bit 1	Receiver Overrun Interrupt Enable—Enables/Disables the ORE bit to generate an interrupt (UART_MINT_UARTC = 0).	0 = Disable ORE interrupt 1 = Enable ORE interrupt			
DREN Bit 0	Receive Data Ready Interrupt Enable—Enables/Disables the RDR bit to generate an interrupt (MINT_RX = 0).	0 = Disable RDR interrupt 1 = Enable RDR interrupt			

21.7.7 UART FIFO Control Registers

The UART FIFO Control Registers control the operation of the UART FIFO trigger levels and interrupts.

UFCF	_						O Control Register O Control Register						Addr 0x00206090 0x00207090			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x000	0							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			TXTL	_				RFDIV					F	RXTL		
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	r	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	1
. ILOL I								0x088	1							

Table 21-21. UART 1 2 FIFO Control Register Descriptions

Name	Description	Settings								
Reserved Bits 31–16	Reserved—These bits are reserved and should re	Reserved—These bits are reserved and should read 0.								
TXTL Bits 15–10	Transmitter Trigger Level—Controls the threshold at which a maskable interrupt is generated by the TxFIFO. A maskable interrupt is generated whenever the data level in the TxFIFO falls below the selected threshold. The bits are encoded as shown in the Settings column. You must ensure the corresponding Interrupt Service Routine (ISR) or DMA configuration are correct in that every FIFO update does not exceed the maximum 32 bytes or size of 32 for TXTL. Exceeding limit can lead to incorrect data or an invalid parity bit. For details refer to Section 21.5.2, "Transmitter FIFO Empty Interrupt Suppression."	000000 = Reserved 00001 = Reserved 000010 = TxFIFO has 2 or fewer characters 011111 = TxFIFO has 31 or fewer characters 100000 = TxFIFO has 32 characters (maximum) All Other Settings Reserved								
RFDIV Bits 9–7	Reference Frequency Divider—Controls the divide ratio for the reference clock. The input clock is IPG_CLK. The output from the divider must be synchronous with the bus clock IPB_CLK.	000 = Divide input clock by 6 001 = Divide input clock by 5 010 = Divide input clock by 4 011 = Divide input clock by 3 100 = Divide input clock by 2 101 = Divide input clock by 1 110 = Divide input clock by 7								

MC9328MXS Reference Manual, Rev. 1

21-38 Freescale Semiconductor

Table 21-21. UART 1 2 FIFO Control Register Descriptions (continued)

Name	Description	Settings
Reserved Bit 6	Reserved—This bit is reserved and should read 0.	
RXTL Bits 5–0	Receiver Trigger Level—Controls the threshold at which a maskable interrupt is generated by the RxFIFO. A maskable interrupt is generated whenever the data level in the RxFIFO reaches the selected threshold. The RXTL bits are encoded as shown in the Settings column.	000000 = 0 characters received 000001 = RxFIFO has 1 character 011111 = RxFIFO has 31 characters 100000 = RxFIFO has 32 characters (maximum) All Other Settings Reserved

21.7.8 UART Status Register 1

The UART Status Register 1 reports errors and status flags for both UARTs.

USR1_ USR1_					UART1 Status Register 1 UART2 Status Register 1										Addr 0x00206094 0x00207094		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
112021							0x0	0000									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	PARITY ERR	RTSS	TRDY	RTSD	ESCF	FRAM ERR	RRDY			RXDS	AIR INT	AWAKE					
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	
TILOLI							0x2	2000									

Table 21-22. UART 1 2 Status Register Descriptions

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
PARITYERR Bit 15	Parity Error Interrupt Flag—Indicates a parity error is detected. PARITYERR is cleared by writing 1 to it. Writing 0 to PARITYERR has no effect. When parity is disabled, PARITYERR always reads 0. At reset, PARITYERR is set to 0	0 = No parity error detected 1 = Parity error detected
RTSS Bit 14	RTS Pin Status—Indicates the current status of the UARTx_RTS pin. A "snapshot" of the pin is taken immediately before RTSS is presented to the data bus. RTSS cannot be cleared because all writes to RTSS are ignored. At reset, RTSS is set to 0.	0 = The UARTx_RTS pin is high (inactive) 1 = The UARTx_RTS pin is low (active)
TRDY Bit 13	Transmitter Ready Interrupt / DMA Flag—Indicates that the TxFIFO emptied below its target threshold and requires data. TRDY is automatically cleared when the data level in the TxFIFO goes beyond above the set threshold level by TXFL bits. At reset, TRDY is set to 1.	0 = The transmitter does not require data 1 = The transmitter requires data (interrupt posted)
RTSD Bit 12	RTS Delta—Indicates whether the RTS pin changed state. It (RTSD) generates a maskable interrupt. When in STOP mode, only RTS assertion sets RTSD and wakes the ARM9 core. The current state of the UARTx_RTS pin is available on the RTSS bit. Clear RTSD by writing 1 to it. Writing 0 to RTSD has no effect. At reset, RTSD is set to 0.	0 = UARTx_RTS pin did not change state since last cleared 1 = UARTx_RTS pin changed state (write 1 to clear)

MC9328MXS Reference Manual, Rev. 1

21-40 Freescale Semiconductor

Table 21-22. UART 1 2 Status Register Descriptions (continued)

Name	Description	Settings
ESCF Bit 11	Escape Sequence Interrupt Flag—Indicates if an escape sequence was detected. ESCF is asserted when the ESCEN bit is set and an escape sequence is detected in the RxFIFO. Clear ESCF by writing 1 to it. Writing 0 to ESCF has no effect.	0 = No escape sequence detected 1 = Escape sequence detected (write 1 to clear)
FRAMERR Bit 10	Frame Error Interrupt Flag—Indicates that a frame error is detected. The UART_PFERR interrupt generated by this. Clear FRAMERR by writing 1 to it. Writing 0 to FRAMERR has no effect.	0 = No frame error detected 1 = Frame error detected
RRDY Bit 9	Receiver Ready Interrupt / DMA Flag—Indicates that the RxFIFO data level is above the threshold set by the RXFL bits. (See the RXFL bits description for setting the interrupt threshold.) When asserted, RRDY generates a maskable interrupt or DMA request. In conjunction with the CHARRDY bit in the URXDn_1 or URXDn_2 register, the software can continue to read the RxFIFO in an interrupt service routine until the RxFIFO is empty. RRDY is automatically cleared when data level in the RxFIFO goes below the set threshold level. At reset, RRDY is set to 0.	0 = No character ready 1 = Character(s) ready (interrupt posted)
Reserved Bits 8-7	Reserved—This bit is reserved and should read 0.	
RXDS Bit 6	Receiver IDLE Interrupt Flag—Indicates that the receiver state machine is in an IDLE state, the next state is IDLE, and the receive pin is high. RXDS is automatically cleared when a character is received. RXDS is active only when the receiver is enabled.	0 = Receive in progress 1 = Receiver is IDLE
AIRINT Bit 5	Asynchronous IR WAKE Interrupt Flag—Indicates that the IR WAKE pulse was detected (on the RXD pin). Clear AIRINT by writing 1 to it. Writing 0 to AIRINT has no effect.	0 = No pulse was detected on the RXD pin 1 = A pulse was detected on the RXD pin
AWAKE Bit 4	Asynchronous WAKE Interrupt Flag—Indicates that a falling edge was detected on the RXD pin. Clear AWAKE by writing 1 to it. Writing 0 to AWAKE has no effect.	0 = No falling edge was detected on the RXD pin 1 = A falling edge was detected on the RXD pin
Reserved Bits 3–0	Reserved—These bits are reserved and should read 0.	

21.7.9 UART Status Register 2

The read-only UART Status Register 2 is used to store data about errors and status flags. There is a status register for each UART.

USR2					ACT1 Status Register 2 0x002060 RT2 Status Register 2 0x002070											
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET						0x0000										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	ADET	TXFE	DTRF	IDLE				IRINT	WAKE			RTSF	TXDC	BRCD	ORE	RDR
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	1	0	0	0	0	0	0	0	0	0	0	1	0	0	0
NESEI								0x40	800							

Table 21-23. UART 1 2 Status Register 2 Descriptions

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	
ADET Bit 15	Automatic Baud Rate Detect Complete—Indicates that an "A" or "a" was received and that the receiver detected and verified the incoming baud rate. Clear ADET by writing 1 to it. Writing 0 to ADET has no effect.	0 = ASCII "A" or "a" was not received 1 = ASCII "A" or "a" was received (write 1 to clear)
TXFE Bit 14	Transmit Buffer FIFO Empty—Indicates that the transmit buffer (TxFIFO) is empty. TXFE is cleared automatically when data is written to the TxFIFO. Even though TXFE is high, the transmission might still be in progress.	0 = The transmit buffer (TxFIFO) is not empty 1 = The transmit buffer (TxFIFO) is empty
DTRF (USR2_2 ONLY) Bit 13	DTR Edge Triggered Interrupt Flag—Indicates if a programmed edge was detected on the UART2_DTR pin. The DPEC bits select the edge that generates an interrupt (see Table 21-4). The DTRF assertion will cause an interrupt if the DTREN bit in the UCR3 is set. The DTRF interrupt (UART_MINT_DTR) is cleared by writing 1 to it. Writing 0 to DTRF has no effect.	0 = Programmed edge not detected on UART2_DTR 1 = Programmed edge detected on UART2_DTR (write 1 to clear)
IDLE Bit 12	Idle Condition—Indicates that an idle condition has existed for more than a programmed amount frame (see Section 21.5.4.1). The UART_MINT_RX interrupt generated by this IDLE bit is cleared by writing 1 to IDLE. Writing 0 to IDLE has no effect.	0 = No idle condition detected 1 = Idle condition detected (write 1 to clear)
Reserved Bits 11–9	Reserved—These bits are reserved and should read 0.	

MC9328MXS Reference Manual, Rev. 1

21-42 Freescale Semiconductor

Table 21-23. UART 1 2 Status Register 2 Descriptions (continued)

Name	Description	Settings
IRINT Bit 8	Serial Infrared Interrupt Flag—Indicates if a valid edge was detected on the RX pin during SIR mode. When ENIRI is asserted and IRINT is asserted, this asserts the common interrupt, UART_MINT_UARTC. Clear IRINT by writing 1 to it. Writing 0 to IRINT has no effect.	0 = no edge detected 1 = valid edge detected (write 1 to clear) When INVR = 1, valid edge is 0-to-1 transition edge When INVR = 0, valid edge is 1-to-0 transition edge
WAKE Bit 7	Wake—Indicates the start bit is detected. WAKE can generate an interrupt on UART_MINT_UARTC that can be masked using the WKEN bit. Clear WAKE by writing 1 to it. Writing 0 to WAKE has no effect.	0 = start bit not detected 1 = start bit detected (write 1 to clear)
Reserved Bits 6–5	Reserved—These bits are reserved and should read 0.	
RTSF Bit 4	RTS Edge Triggered Interrupt Flag—Indicates if a programmed edge is detected on the RTS pin. The RTEC bits select the edge that generates an interrupt (see Table 21-4). RTSF can generate an interrupt on UART_MINT_RTS that can be masked using the RTSEN bit. Clear RTSF by writing 1 to it. Writing 0 to RTSF has no effect.	0 = Programmed edge not detected on RTS 1 = Programmed edge detected on RTS (write 1 to clear)
TXDC Bit 3	Transmitter Complete—Indicates that the transmit buffer (TxFIFO) and Shift Register is empty; therefore the transmission is complete. TXDC is cleared automatically when data is written to the TxFIFO.	0 = Transmit is incomplete 1 = Transmit is complete
BRCD Bit 2	BREAK Condition Detected—Indicates that a BREAK condition was detected by the receiver. Clear BRCD by writing 1 to it. Writing 0 to BRCD has no effect.	0 = No BREAK condition was detected 1 = A BREAK condition was detected (write 1 to clear)
ORE Bit 1	Overrun Error—Indicates that the receive buffer (RxFIFO) was full when data was being received. Clear ORE by writing 1 to it. Writing 0 to ORE has no effect.	0 = No overrun error 1 = Overrun error (write 1 to clear)
RDR Bit 0	Receive Data Ready—Indicates that at least 1 character is received and written to the RxFIFO. If the URXDn_1 or URXDn_2 register is read and there is only 1 character in the RxFIFO, RDR is automatically cleared.	0 = No receive data ready 1 = Receive data ready

21.7.10 UART Escape Character Registers

The UART Escape Character Registers establish the software-selected escape character.

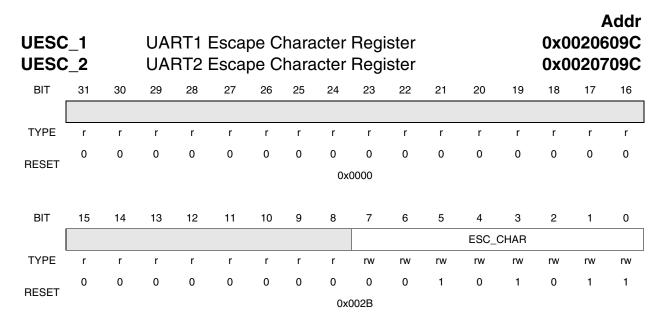


Table 21-24. UART 1 2 Escape Character Register Descriptions

Name	Description
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.
ESC_CHAR Bits 7–0	UART Escape Character —Holds the selected escape character that all received characters are compared against to detect an escape sequence.

21.7.11 UART Escape Timer Registers

The UART Escape Timer Registers establish the software-selected maximum interval between escape characters. These registers are scalable in intervals of 2 msec to a maximum of 8.192 sec.

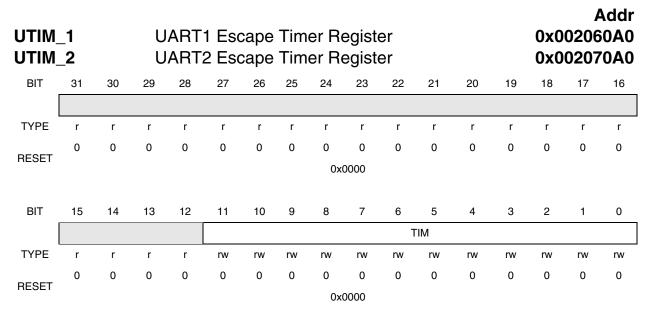


Table 21-25. UART 1 2 Escape Timer Register Descriptions

Name	Description
Reserved Bits 31–12	Reserved—These bits are reserved and should read 0.
TIM Bits 11–0	UART Escape Timer—Holds the maximum interval allowed between escape characters.

21.7.12 UART BRM Incremental Registers

The BRM (Binary Rate Multiplier) Incremental registers hold the numerator value (minus one) of the BRM ratio. These registers can be written to at any time. Hardware updates the value in the UART BRM Modulator Registers (UBMR_x) at the appropriate time to avoid glitches on the BRM_CLK output (sampling clock). The BRM is not updated until both the modulator of the respective UBMR_x register and its incremental UBIR_x registers are written to by software. If only one register of the two registers is written to by the software, the BRM ignores this data until the other register is also written.

UBIR_1 UBIR_2					UART1 BRM Incremental Register UART2 BRM Incremental Register											Addr 0x002060A4 0x002070A4		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
TILOLI								0x	0000									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
								II.	NC									
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET								0x	0000									

Table 21-26. UART 1 2 BRM Incremental Register Descriptions

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
INC Bits 15–0	Incremental Numerator—Holds the numerator value minus one of the BRM ratio (see Section 21.5.8). Updating this field using byte accesses is not recommended and is undefined. This register cannot be written to by the user if ADBR=1.

21-46 Freescale Semiconductor

21.7.13 UART BRM Modulator Registers

The UART BRM (Binary Rate Multiplier) Modulator Registers hold the denominator value (minus one) of the BRM ratio. These registers can be written to at any time. Hardware updates the value in the UART BRM Modulator Registers (UBMR_x) at the appropriate time to avoid glitches on the BRM_CLK output (sampling clock). The BRM is not updated until both the modulator of the respective UBMR_x register and its incremental UBIR_x registers are written to by software. If only one register of the two registers is written to by the software, the BRM ignores this data until the other register is also written.

UBMF UBMF	_				ART1 ART2					_					0206	Addr 60A8 70A8
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET								0x(0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								М	OD							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x0	0000							

Table 21-27. UART 1 2 BRM Modulator Register Descriptions

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
MOD Bits 15–0	Modulator Denominator —Holds the value of the denominator minus one of the BRM ratio (see Section 21.5.8). Updating this register using byte accesses is not recommended and undefined.

21.7.14 UART Baud Rate Count Registers

The read-only UART Baud Rate Count Registers count the start bit of the incoming baud rate. When the start bit is detected and counted, these registers retain their value until the next automatic baud rate detection sequence is initiated. The registers are reset to 0x00000008, however they stay at 0x0000FFFF in the case of an overflow.

UBRO UBRO				RT1 RT2					_						0206	Addr 0AC 0AC
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x	0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								В	CNT							
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0
ILOLI								0x	8000							

Table 21-28. UART 1 2 Baud Rate Count Register Descriptions

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
BCNT Bits 15–0	Baud Rate Count Register —Counts or measures the length of the incoming baud rate start bit when in automatic baud rate detection mode. This register is clocked by the BRM_CLK.

21.7.15 UART BRM Incremental Preset Registers 1-4

The eight 32-bit UART BRM Incremental Preset Registers (BIPR*n_x*) are used in conjunction with the automatic baud detection logic. These registers are assigned preset values for the special baud rates 920 Kbps, 460 Kbps, 230 Kbps, and 115.2 Kbps. When the BPEN bit is asserted, these registers are used on the detection of a remainder. These registers must be written to prior to enabling the auto baud detection logic. This feature supports 16 MHz, 25 MHz, and 30 MHz reference frequencies only. Enabling this feature with other reference frequencies is not supported.

BIPRE BIPRE BIPRE BIPRE BIPRE BIPRE	1_2 2_1 2_2 3_1 3_2 4_1		UA UA UA UA UA	RT1 RT2 RT1 RT2 RT1 RT2 RT1	BRM BRM BRM BRM BRM BRM	1 Inc 1 Inc 1 Inc 1 Inc 1 Inc 1 Inc	remeremente remeremente remeremente reme	ental ental ental ental ental ental	Pres Pres Pres Pres Pres	et Reset Res	egiste egiste egiste egiste egiste	er 1 er 2 er 2 er 3 er 3 er 4		0x0 0x0 0x0 0x0 0x0 0x0	0206 0207 0206 0207 0206 0207 0206	70B0 60B4 70B4 60B8 70B8 0BC
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x	0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								IN	ICPI			_	_	_		
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?
TILOLI								0x	????							

Table 21-29. UART 1 2 Incremental Preset Registers 1-4 Descriptions

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
INCPI Bits 15–0	BRM Incremental Preset Register—Holds the appropriate numerator for the special baud rates when in automatic detect mode. BIPR1_x register is for the 920 Kbps BIPR2_x register is for the 460 Kbps BIPR3_x register is for the 230 Kbps BIPR4_x register is for the 115.2 Kbps

21.7.16 UART BRM Modulator Preset Registers 1–4

															F	Addr
BMPF	R1_1		UAF	RT1 B	RM I	Modu	ulato	r Pre	set F	Regis	ter 1			0x0	0206	0C0
BMPF	R1_2		UAF	RT2 B	RM I	Modu	ulato	r Pre	set F	Regis	ter 1			0x0	0207	0C0
BMPF	R2_1		UAF	RT1 B	RM I	Modu	ulato	r Pre	set F	Regis	ter 2			0x0	0206	0C4
BMPF	R2 2		UAF	T2 E	RM I	Modu	ulato	r Pre	set F	Regis	ter 2			0x0	0207	OC4
BMPF	R3 1				RM N					•				0x0	0206	80C8
BMPF	_				RM N					•				0x0	0207	OC8
BMPF	_				RM N					•					0206	
BMPF	_				RM N					•						OCC
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESEI								0x0	0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								M	ODI							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?	?
HESEI								0x'	????							

Table 21-30. UART 1 2 Modulator Preset Registers 1-4 Descriptions

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
MODI Bits 15–0	BRM MOD Preset Registers —Holds the appropriate numerator for the special baud rates when in automatic detect mode.
	BMPR1_x register is for 920 Kbps BMPR2_x register is for 460 Kbps BMPR3_x register is for 230 Kbps BMPR4_x register is for 115.2 Kbps

21.7.17 UART Test Register 1

The UART Test Register 1 controls the various test features of the UART module.

UTS_2				UAR UAR				_							020	Addr 60D0 70D0
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NEGET								0	x0000)						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
			FRCP ERR	LOOP						TX EMPTY	RX EMPTY	TX FULL	RX FULL			SOFT RST
TYPE	r	r	rw	rw	r	rw	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	1	1	0	0	0	0	0
NESET								0	x0060)						

Table 21-31. UART 1 2 Test Register Descriptions

Name	Description	Settings
Reserved Bits 31–14	Reserved—These bits are reserved and should read 0.	
FRCPERR Bit 13	Force Parity Error—Forces the transmitter to generate a parity error if parity is enabled. FRCPERR is provided for system debugging.	0 = Generate normal parity 1 = Generate inverted parity (error)
LOOP Bit 12	Loop TX and RX for Test—Controls loopback for test purposes. When LOOP is high, the receiver input is internally connected to the transmitter and ignores the RXD pin. The transmitter is unaffected by LOOP.	0 = Normal receiver operation 1 = Internally connect the transmitter output to the receiver input
Reserved Bits 11–7	Reserved—These bits are reserved and should read 0.	
TXEMPTY Bit 6	TxFIFO Empty—Indicates that the TxFIFO is empty.	0 = The TxFIFO is not empty 1 = The TxFIFO is empty
RXEMPTY Bit 5	RxFIFO Empty—Indicates the RxFIFO is empty.	0 = The RxFIFO is not empty 1 = The RxFIFO is empty
TXFULL Bit 4	TxFIFO FULL—Indicates the TxFIFO is full.	0 = The TxFIFO is not full 1 = The TxFIFO is full
RXFULL Bit 3	RxFIFO FULL—Indicates the RxFIFO is full.	0 = The RxFIFO is not full 1 = The RxFIFO is full

UART Operation in Low-Power System States

Table 21-31. UART 1 2 Test Register Descriptions (continued)

Name	Description	Settings
Reserved Bits 2–1	Reserved—These bits are reserved and should read 0.	
SOFTRST Bit 0	Software Reset—Indicates the status of the software reset (SRST).	0 = No software reset 1 = Generate software reset

21.8 UART Operation in Low-Power System States

The UART's serial interface will operate as long as the 16x bit clock generator is provided with the PerCLK1. The RXEN, TXEN and UARTEN bits are set by the user and provide software control of low-power modes.

When in DOZE state, the UART's behavior depends on the DOZE bit. If the DOZE bit is negated and the system is in DOZE state, the UART serial interface is operational. If the system is in DOZE state and the DOZE bit is asserted, the UART transmitter and receiver operations are halted.

If the DOZE state is entered with the DOZE bit asserted when the UART's serial interface is receiving or transmitting data, the reception/transmission of the current character is completed and signal to the far-end transmitter/receiver to stop sending/receiving. The control/status/data registers do not change when entering or exiting low-power modes.

The following UART interrupts wake the ARM920T processor from STOP mode:

- RTS
- IrDA Asynchronous WAKE (AIRINT)
- Asynchronous WAKE (AWAKE)

The UART_CLK_EN bit (UCR1_x) enables the clock inputs to the UART module. If the control bit is set to 0, it abruptly enables the clock inputs to the UART module. To get maximum power conservation when the module is shut off, make sure that the above clock control bit is set to 0. Setting the UARTEN (UCR1 x) bit to 0 only shuts off the receiver and transmitter logic and the associated clocks.

When an asynchronous WAKE interrupt exits the ARM920T processor from STOP mode, make sure that a dummy character is sent first because the first character may not be received correctly. After the settling time of the USB_PLL, actual characters can be sent to the UART. Even though the dummy character is written to RxFIFO, just ignore it.

21-52 Freescale Semiconductor

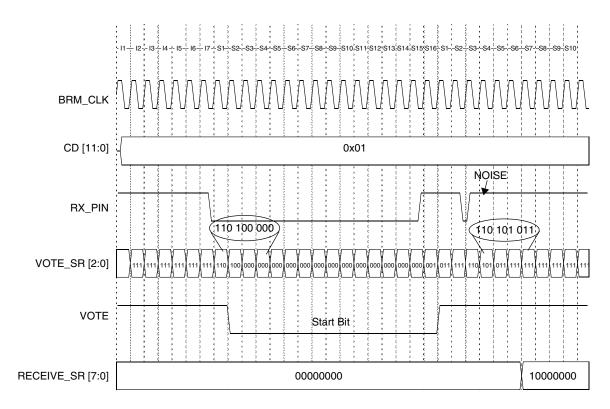


Figure 21-5. Majority Vote Results

UART Operation in Low-Power System States

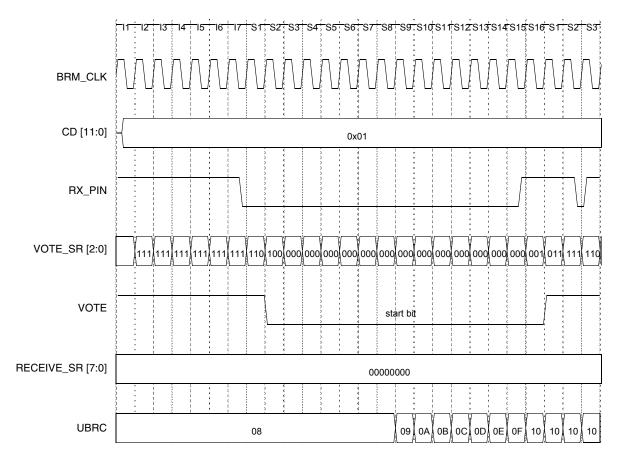


Figure 21-6. Baud Rate Detection of Divisor = 1

21-54 Freescale Semiconductor

Chapter 22 USB Device Port

This chapter describes the USB device port of the MC9328MXS. It also provides configuration, interface description and detailed programming information for designers to achieve the optimum performance from this device.

22.1 Introduction

The Universal Serial Bus specification describes a USB system as having the following three parts:

- A USB host—The bus master that periodically polls peripherals to initiate data transfers. There is only one host on the bus.
- A USB device—A bus slave that communicates only with a USB host. It does not generate bus traffic and only responds to requests from the host.
- A USB Interconnect—A special class of USB devices that add additional connection points to the bus for more USB devices.

From the user's perspective, the USB module hides all direct interaction with the USB protocol. The registers allow the user to enable or disable the module, control the characteristics of individual endpoints, and monitor traffic flow through the module without ever seeing the low level details of the USB protocol.

Even though this module hides all direct interaction with the protocol, some knowledge of the USB is required to properly configure the device for operation on the bus. Programming requirements are covered in this chapter.

22.1.1 Features

The USB device module on the MC9328MXS provides the following USB features:

- Complies with Universal Serial Bus Specification Revision 1.1.
- Endpoint configurations are shown in Table 22-1. Six pipes are available for mapping. Endpoint 0 is required by the USB specification, however all other endpoints are optional. While endpoints 1, 2, 3, 4, and 5 can be configured as Bulk, Interrupt or Isochronous pipes (IN or OUT).
- Control, bulk and interrupt pipes are supported. The packet sizes are limited to 8, 16, 32, or 64 bytes, and the maximum packet size depends on the endpoint's FIFO size.
- Isochronous communications pipes are also supported. A frame match interrupt feature that notifies the user when a specific USB frame occurs is supported. For DMA access, the maximum packet size for the isochronous endpoint is restricted by the endpoint's FIFO size. For programmed I/O, isochronous data packets can take any size from 0 to 1023 bytes.
- Remote wake-up feature is supported through a register bit.
- The USB module operation is operates in both bus-powered and self-powered mode.
- Full speed (12 Mbps) operation.

Module Components

Table 22-1. Endpoint Configurations

Endpoint	Туре	Physical FIFO Size	Endpoint Configuration	Comments
0	IN and OUT	32 bytes	Control	Mandatory
1	IN or OUT	64 bytes	Ctrl, Int, Bulk, or Iso	Optional
2	IN or OUT	64 bytes	Ctrl, Int, Bulk, or Iso	Optional
3	IN or OUT	32 bytes	Ctrl, Int, Bulk, or Iso	Optional
4	IN or OUT	32 bytes	Ctrl, Int, Bulk, or Iso	Optional
5	IN or OUT	32 bytes	Ctrl, Int, Bulk, or Iso	Optional

Table 22-2. USB Specific Interrupts

Name of Interrupt (from Interrupt Assignment Table)	Description	Associated Status Register			
USBD_INT[0]	Endpoint 0 Interrupt	USB_EP0_INTR			
USBD_INT[1]	Endpoint 1 Interrupt	USB_EP1_INTR			
USBD_INT[2]	Endpoint 2 Interrupt	USB_EP2_INTR			
USBD_INT[3]	Endpoint 3 Interrupt	USB_EP3_INTR			
USBD_INT[4]	Endpoint 4 Interrupt	USB_EP4_INTR			
USBD_INT[5]	Endpoint 5 Interrupt	USB_EP5_INTR			
USBD_INT[6]	USBd Interrupt	USB_INTR			

22.2 Module Components

A block diagram of the complete USB Device is shown in Figure 22-1. This section briefly describes each of the components within the module.

22-2 Freescale Semiconductor

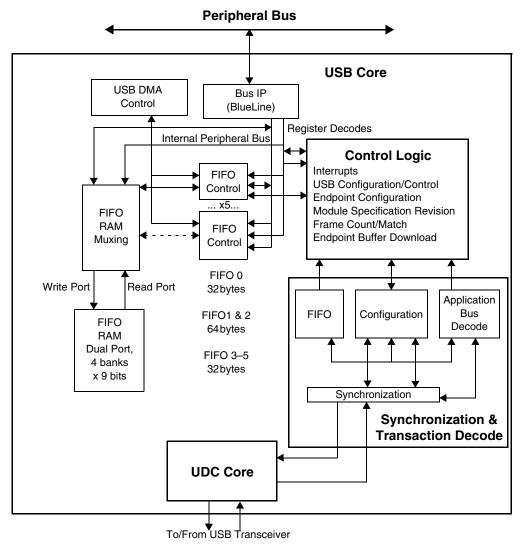


Figure 22-1. USB Device Module Block Diagram

22.2.1 Universal Serial Bus Device Controller

The Universal Serial Bus Device Controller Core (UDC) interfaces the USB function device to the Universal Serial Bus. The UDC handles all the USB protocol and provides a simple read/write protocol on the function interface (application bus). The UDC handles all details of managing the USB protocol and presents a simple set of handshakes to the application for managing data flow, vendor commands, and configuration information. It provides the following features:

- Complies with USB Specification revision 1.1
- Supports USB protocol handling
- Requires no microcontroller or firmware support
- Provides USB device state handling
- Enables clock and data recovery from USB
- Supports bit stripping and bit stuffing functions

Module Components

- Supports CRC5 checking and CRC16 generation and checking
- Provides serial to parallel data conversion
- Maintains data synchronization bits (DATA0/DATA1) toggle bits
- Understands and decodes standard USB commands to endpoint 0

22.2.2 Synchronization and Transaction Decode

The synchronization and transaction decode block performs two functions:

- It synchronizes the front-end logic timing to the UDC's application bus timing. The front-end logic is targeted for a maximum of 96 MHz operation, while the UDC's application bus runs at 12 MHz for full-speed devices.
- The synchronization layer contains a transaction decoder. The application bus protocol is very simple and makes no distinction between RAM, FIFO, and configuration access. The decoder examines the type of transaction requested by the UDC and generates control signals appropriate to that transaction type (RAM, FIFO, and so on).

The transaction decoder ensures that all packet transfers occur in units of the maximum packet size for the selected endpoint. This block decodes the buffer address from the UDC's application bus to determine the maximum packet size for the current endpoint. It also looks at bytes free and end-of-frame (EOF) information from the FIFO module to determine when a packet transfer occurs.

In general, all transfers are of the maximum packet size *except* when all of these conditions apply:

- The endpoint is isochronous
- The transmit FIFO has less than the maximum packet size worth of data available
- There is an end-of-frame indicator in the FIFO

The transaction decoder also handles hardware retries of USB packets containing errors. The hardware is capable of retransmitting an IN packet to the host or discarding an OUT packet from the host.

The synchronization and transaction decode section contains logic related to the UDC module's clock enable. The UDC module is designed with low-power operation in mind. It includes a gated clock and part of the enable logic for that clock with low-power operation in mind.

22.2.3 Endpoint FIFO Architecture

The USB protocol has some specialized requirements that affect FIFO implementation and essentially require one FIFO per USB endpoint. The USB host can access any endpoint on the function in any order, even the same endpoint in back-to-back transactions, however there is a latency requirement that means the USB device must respond to the USB host within a certain number of USB bit times or the device loses its time slice on the USB until some point in the future. To achieve maximum USB bandwidth use, the USB device must provide full packets of data to the USB host immediately on request and receive full packets from the host on request. This requirement results in one FIFO per USB endpoint.

Depending on the traffic requirements, the FIFO sizes are adjustable to support double buffering. Typically, bulk and isochronous endpoints are double buffered, while interrupt and control endpoints usually are single buffered.

Six endpoint FIFOs are available in the USB device module:

- FIFO 0, 32 bytes
- FIFO 1, 64 bytes

MC9328MXS Reference Manual, Rev. 1

22-4 Freescale Semiconductor

- FIFO 2, 64 bytes
- FIFO 3, 32 bytes
- FIFO 4, 32 bytes
- FIFO 5, 32 bytes

22.2.4 Control Logic

The USB module's control logic section implements the logic and registers that allow the user to control and communicate with the USB module. The register functions include interrupt status/mask, USB configuration download, FIFO control and access, and device request processing from the control endpoint.

22.2.5 USB Transceiver Interface

The MC9328MXS provides support for a low-cost external USB transceiver interface. Generic USB transceivers that support 3.0 V I/O levels are supported. The transceiver interface signals are illustrated in Figure 22-2 and each signal is described in the following section.

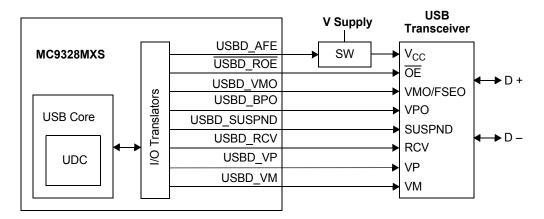


Figure 22-2. USB Module Transceiver Interface

22.2.6 Signal Description

The USB module has seven signals that can be used to interface with the external USB driver.

- USBD_AFE—Analog Front-End Enable. This signal is used to enable the front-end transceiver (optional).
- USBD_ROE—Reverse Output Enable. This active low signal is used to control the transceiver to drive its D+/D- signal (to the host connection) according to the signal in USBD_VPO and USBD_VMO (output signal), respectively.
- USBD_VMO/USBD_VPO—USB Module Data Output. These signals provide single ended data to the USB Transceiver Transmitter differential driver.
- USBD_SUSPND—Transceiver Suspend Enable. This signal, when high, activates a low-power state in the USB transceiver. Normally, when suspended, the transceiver drives USBD_RCV low and tri-state the USB bus signals D+ and D-.
- USBD_RCV—USB Module Receive Data. This signal is a CMOS level driven signal provided by the external USB transceiver. The signal is derived from the D+ and D- differential input to the transceiver.

- **USBD_VP**—Input D+ signal connected directly to the D+.
- USBD_VM—Input D- signal connected directly to the D-.

22.2.7 Pin Configuration for USB

Table 22-3 lists the pins used by the USB module. These pins are multiplexed with other functions on the device and must be configured for USB operation.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Table 22-3. Pin Configuration for USB Module

Pin	Setting	Configuration Procedure
USBD_AFE	Primary function of GPIO Port B [20]	1.Clear bit 20 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 20 of Port B General Purpose Register (GPR_B)
USBD_SUSPND	Primary function of GPIO Port B [23]	1.Clear bit 23 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 23 of Port B General Purpose Register (GPR_B)
USBD_VMO	Primary function of GPIO Port B [27]	1.Clear bit 27 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 27 of Port B General Purpose Register (GPR_B)
USBD_VPO	Primary function of GPIO Port B [26]	1.Clear bit 26 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 26 of Port B General Purpose Register (GPR_B)
USBD_ROE	Primary function of GPIO Port B [21]	1.Clear bit 21 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 21 of Port B General Purpose Register (GPR_B)
USBD_VM	Primary function of GPIO Port B [25]	1.Clear bit 25 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 25 of Port B General Purpose Register (GPR_B)
USBD_VP	Primary function of GPIOP Port B [24]	1.Clear bit 24 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 24 of Port B General Purpose Register (GPR_B)
USBD_RCV	Primary function of GPIO Port B [22]	1.Clear bit 22 of Port B GPIO In Use Register (GIUS_B) 2.Clear bit 22 of Port B General Purpose Register (GPR_B)

22.3 Programming Model

The USB module includes 20 required and 55 optional 32-bit registers. Table 22-4 summarizes these registers and their addresses.

Table 22-4. USB Module Register Memory Map

Description	Name	Address
USB Frame	USB_FRAME	0x00212000
USB Specification	USB_SPEC	0x00212004
USB Status	USB_STAT	0x00212008

MC9328MXS Reference Manual, Rev. 1

22-6 Freescale Semiconductor

Table 22-4. USB Module Register Memory Map (continued)

Description	Name	Address
USB Control	USB_CTRL	0x0021200C
USB Descriptor RAM Address	USB_DADR	0x00212010
USB Descriptor RAM/Endpoint Buffer Data	USB_DDAT	0x00212014
USB Interrupt	USB_INTR	0x00212018
USB Interrupt Mask	USB_MASK	0x0021201C
USB Enable	USB_ENAB	0x00212024
Endpoint n Status/Control	USB_EPn_STAT	0x00212030+ (n*0x30) ¹
Endpoint n Interrupt Status	USB_EPn_INTR	0x00212034+ (n*0x30) ¹
Endpoint n Interrupt Mask	USB_EPn_MASK	0x00212038+ (n*0x30) ¹
Endpoint n FIFO Data	USB_EPn_FDAT	0x0021203C+ (n*0x30) ¹
Endpoint n FIFO Status	USB_EPn_FSTAT	0x00212040+ (n*0x30) ¹
Endpoint n FIFO Control	USB_EPn_FCTRL	0x00212044+ (n*0x30) ¹
USB Endpoint n Last Read Frame Pointer	USB_EPn_LRFP	0x00212048+ (n*0x30) ¹
USB Endpoint n Last Write Frame Pointer	USB_EPn_LWFP	0x0021204C+ (n*0x30) ¹
Endpoint n FIFO Alarm	USB_EPn_FALRM	0x00212050+ (n*0x30) ¹
Endpoint n FIFO Read Pointer	USB_EPn_FRDP	0x00212054+ (n*0x30) ¹
Endpoint n FIFO Write Pointer	USB_EPn_FWRP	0x00212058+ (n*0x30) ¹

^{1.} The parameter 'n' refers to the number of endpoints programmed into this device through MPP software in RTL and ranges from 0 to 5.

22.3.1 USB Frame Register

The USB Frame Number and Match register (USB_FRAME) is used to detect a specific frame.

USB_	SB_FRAME USB Frame									0x	Addr 0x00212000					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
											MATCH					
TYPE	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET								0x000	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
											FRAME					
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
neoel								0x000	00							

Table 22-5. USB Frame Register Description

Name	Description
Reserved Bits 31–27	Reserved—These bits are reserved and should read 0.
MATCH Bits 26–16	Match Field—Sets compare value for FRAME_MATCH interrupt. When the value in the FRAME field equals the value in the MATCH field, a FRAME_MATCH interrupt is generated (if not masked).
Reserved Bits 15–11	Reserved—These bits are reserved and should read 0.
FRAME Bits 10–0	Frame Field—Holds the frame number decoded from the SOF (Start of Frame) packet that leads each USB frame.

22.3.2 USB Specification Register

The read-only USB Specification and Release Number register (USB_SPEC) stores information about the version of the USB specification with which the USB module complies.

USB_	USB_SPEC USB Specification								0x	Addr 0x00212004						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HLJLI								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	SPEC															
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
DECET	0	0	0	0	0	0	0	1	0	0	0	1	0	0	0	0
RESET								0x01	10							

Table 22-6. USB Specification Register Description

Name	Description	
Reserved Bits 31–12	Reserved—These bits are reserved and should be set to 0.	
SPEC Bits 11–0	Specification Number—Contains the version of USB specification with which the underlying USB core complies.	These 12 bits represent the version number of the specification. 0x110 = version 1.1

22.3.3 USB Status Register

The read-only USB Status register (USB_STAT) reports the current state of various features of the USB module. Certain bits are used only for hardware debug mode and always read 0 when debug mode is not enabled.

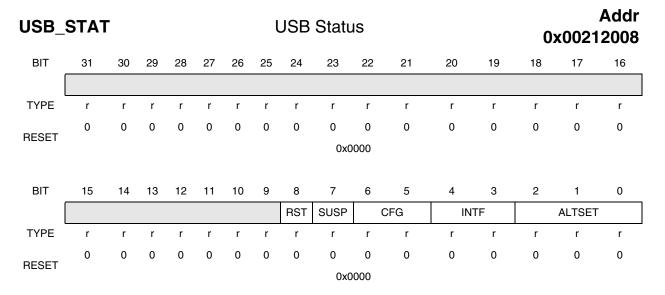


Table 22-7. USB Status Register Description

Name	Description	Settings					
Reserved Bits 31–9	eserved—These bits are reserved and should read 0.						
RST Bit 8	Reset Signaling—Indicates type of reset signaling.	0 = Normal signaling in progress on USB 1 = Reset signaling in progress on USB					
SUSP Bit 7	Suspend—Indicates USB suspend condition.	0 = USB is not suspended 1 = USB is suspended					
CFG Bits 6–5	Configuration—Represents the currently selected USB configuration. See Section 22.5.1, "Configuration Download."						
INTF Bits 4–3	Interface—Identifies the USB interface in the current configuration that is associated with the Alternative Interface Indicator (AINTF).						
ALTSET Bits 2–0	Alternate Setting—Contains the currently selected USB alternate setting.						

22.3.4 USB Control Register

The USB Control register (USB_CTRL) configures numerous features of the USB module.

USB_C	CTRL		USB Control												Addr 0x0021200C		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
										CMD_ OVER	CMD_ ERROR	USB_ SPD	USB_ ENA	UDC_ RST	AFE_ ENA	RESUME	
TYPE	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	W	rw	W	
RESET	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	
HESEI									0x0	010							

Table 22-8. USB Control Register Description

Name	Description	Settings
Reserved Bits 31–7	Reserved—These bits are reserved and should read 0.	
CMD_OVER Bit 6	Command Over—Indicates status of command processing. See Table 22-9 for more information. CMD_OVER clears automatically after the UDC core has completed the status phase of a control transfer.	0 = Command complete 1 = Command in process
CMD_ERROR Bit 5	Command Error—Indicates if an error was encountered during processing of a device request. See Table 22-9 for more information. CMD_OVER and CMD_ERROR combine to create the handshaking code for the status phase of a device request transaction.	0 = If the command was processed, there was no error 1 = If the command was processed, an error occurred
USB_SPD Bit 4	USB Speed—Sets the operating speed for the USB module. Note: The USB module supports only full speed operation of the device. Attempts to set to slow speed results in unpredictable operation.	0 = Low speed 1 = Full speed
USB_ENA Bit 3	USB Enable—Determines whether the USB module responds to requests from the USB host. The USB module comes out of reset in the disabled state. The user must ensure that the USB endpoint configuration and USB registers are programmed appropriately before enabling communications. USB_ENA does not affect the underlying UDC core, only the front-end logic's ability to communicate with the core.	0 = USB module front-end logic is disabled. All transactions to or from the UDC are ignored. 1 = USB module front-end logic is enabled and ready to communicate with the host.

MC9328MXS Reference Manual, Rev. 1

Table 22-8. USB Control Register Description (continued)

Name	Description	Settings
UDC_RST Bit 2	UDC Reset —Executes a hard reset sequence on the UDC module in accordance with the UDC specification. It allows the system software to force a reset of the UDC's logic when the system is first connected to the USB, or for debugging purposes.	0 = No effect 1 = Hard reset of the UDC
AFE_ENA Bit 1	Analog Front-End Enable—Enables/Disables the analog front-end to the USB. This can be either an external chip or an on-chip transceiver module. Use AFE_ENA to power-down the AFE.	0 = AFE disabled 1 = AFE enabled
RESUME Bit 0	Resume—Initiates resume signaling on the USB. Automatically resets to 0 after a write. Remote wake-up capability is controlled in the UDC through the CLEAR_FEATURE request. Software must have a time-out feature that aborts the remote wake-up attempt when the RESUME interrupt does not occur after a specified time.	0 = No effect 1 = Initiate resume signaling on the bus when the remote wake-up capability is enabled for the current USB configuration. When the remote wake-up capability is disabled, RESUME has no effect.

Table 22-9. Device Request Status

Result of Transfer	CMD_OVER	CMD_ERROR
Application processed the device request successfully	0	0
Application encountered an error while processing the request	0	1
Application is busy completing the request	1	Х

22-12 Freescale Semiconductor

22.3.5 USB Descriptor RAM Address Register

This register allows user access to the USB descriptor RAM. The user programs a desired address into the 9-bit desired RAM address (DADR) field and follows it with a read or write to the USB_DDAT register to complete the access. On read/write access to the USB Descriptor RAM/Endpoint Buffer Data (USB_DDAT), the address in the DADR field increments automatically. When the CFG bit is set to 1, the DADR address is ignored.

USB_	DADF	2			US	B De	escrip	tor R	AM A	Addr 0x00212010						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	CFG	BSY														
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	0x8000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NLOEI								0x00	00							

Table 22-10. USB Descriptor RAM Address Register Description

Name	Description	Settings										
CFG Bit 31	Configuration—Determines the function of USB_DDAT Register. The Configuration versus Descriptor access indicator is set automatically at power-on or hard reset and clears after the last byte of endpoint buffer configuration data is downloaded into the UDC.	0 = The USB_DDAT register is set to access the descriptor storage RAM. Configuration load has completed. The USB_DDAT writes have no effect. 1 = The USB_DDAT register is set to download endpoint buffer configuration data to the UDC.										
BSY Bit 30	Busy—Indicates if a write is in progress to the endpoint buffer. Because the front-end logic and the UDC module operate on different clocks, the configuration download interface busy signal is provided to ensure that writes from the USB_DDAT register have sufficient time to successfully enter the UDC's clock domain.	 0 = No write is in progress. 1 = A write is in progress to the UDC module's endpoint buffer. Attempt no other operations on the USB Core module until BSY has cleared. 										
Reserved Bits 29–9	Reserved—These bits are reserved and should read 0.											
DADR Bits 8–0		Desired RAM Address—Holds the desired RAM address. The user programs a desired descriptor RAM address into the DADR field and follows it with a read or write to the USB_DDAT register to complete the access.										

22.3.6 USB Descriptor RAM/Endpoint Buffer Data Register

This register allows user access to the endpoint buffer download facility. For endpoint buffer access, when the CFG bit in the USB_DADR register is set, writes to this register cause the data to be loaded into the UDC module's endpoint buffers, and reads are undefined. When the CFG bit in the USB_DADR register is cleared, writes have no effect and reads are zero.

Access to this register is allowed only when the USB_ENA bit in the USB Control (USB_CTRL) is set to 0. Access at other times is ignored and reads are undefined.

USB_	DDAT		U	Addr 0x00212014												
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET		0x0000														
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												DI	DAT			
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESEI								0x00	00							

Table 22-11. USB Descriptor RAM/Endpoint Buffer Data Register Description

Name	Description
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.
DDAT Bits 7–0	DDAT —Allows user access to the endpoint buffer in the UDC module when the endpoint configuration is happening. (When the CFG bit in the USB_DADR is set) Writing to this field loads the data written into the UDC endpoint buffers.

22.3.7 USB Interrupt Register

The USB Interrupt register (USB_INTR) maintains the status of interrupt conditions that pertain to USB functions.

An interrupt, when set, remains set until 1 is written to the corresponding bit. Interrupts do not clear automatically when the event that caused them goes away. For example, when reset signaling comes and goes with no intervention from software, both RESET_START and RESET_STOP are set and stay set. Writing 0 to this register has no effect.

If a register write occurs at the same time an interrupt is received, the interrupt takes precedence over the write.

USB_INTR								US	B Inte		Addr 0x00212018					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	WAKEUP															
TYPE	rw	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
112021										0x0000	1					
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
									MSOF	SOF	RESET _STOP	RESET _START	RES	SUSP	FRAME _MATCH	CFG_ CHG
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HEOLI										0x0000)					

Table 22-12. USB Interrupt Register Description

Name	Description	Settings
WAKEUP Bit 31	Wakeup—Indicates a state change from suspend to resume (wakeup) in the UDC module. Clearing the interrupt has no effect on the actual state of the USB module (WAKEUP can be written to even when the module is disabled.)	0 = No state change since last interrupt 1 = USB has changed state from suspend to resume (wakeup)
	Note: Use the asynchronous WAKEUP interrupt to power-down the module clocks and to power-up the USB module.	
Reserved Bits 30–8	Reserved—These bits are reserved and should read 0.	
MSOF Bit 7	Missed Start-of-Frame Interrupt—Indicates if a start-of-frame was missed.	0 = No missed start-of-frame 1 = A SOF interrupt was set, however not cleared before the next one was received
SOF Bit 6	Start-of-Frame Interrupt—Indicates if a start-of-frame was received.	0 = No start-of-frame received 1 = The UDE module received a start-of-frame token (the USB frame number is current)

MC9328MXS Reference Manual, Rev. 1

Table 22-12. USB Interrupt Register Description (continued)

Name	Description	Settings
RESET_STOP Bit 5	Reset Signaling Stop—Indicates the end of reset signaling on the USB.	0 = Reset signaling has not stopped (does not imply that reset signaling is occurring, just that no end-of-reset event has occurred) 1 = Reset signaling has stopped
RESET_START Bit 4	Reset Signaling Start—Indicates start of reset signaling on the USB.	0 = Reset signaling has not started (does not imply that reset signaling is occurring, but only that no start of reset event has occurred) 1 = Reset signaling in progress
RES Bit 3	Suspend to Resume—Indicates a change of state from suspend to resume in the UDC module (indicates only the change from suspended to active mode). Clearing the interrupt has no effect on the actual state of the USB.	0 = The USB has not left the suspended state (does not imply that the bus is, or ever was, suspended) 1 = USB has left the suspend state
SUSP Bit 2	Active to Suspend—Indicates the suspend state of the UDC module (indicates only the change from active to suspended mode). Clearing the interrupt has no effect on the actual state of the USB.	0 = USB is not suspended, or the interrupt was cleared 1 = USB is suspended
FRAME_MATCH Bit 1	Frame Match—Indicates whether there is a match between the USB frame number and the value in the USB Frame.	0 = No match occurred 1 = Match occurred
CFG_CHG Bit 0	Configuration Change—Indicates if a change occurred in the USB configuration (configuration, interface, alternate) which requires the software to reread the USB Status.	0 = No configuration change occurred 1 = Configuration change occurred

22.3.8 USB Interrupt Mask Register

The USB Interrupt Mask register (USB_MASK) is used to mask the corresponding interrupt in the USB_INTR register.

USB_N	MASK						US	B Ir		Addr 0x0021201C						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
	WAKEUP															
TYPE	rw	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
		0x8000														
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
									MSOF	SOF	RESET_ STOP	RESET_ START	RES	SUSP	FRAME_ MATCH	CFG_ CHG
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
NESEI									0>	(00FF						

Table 22-13. USB Interrupt Mask Register Description

Name	Description	Settings
WAKEUP Bit 31	Wakeup Mask—Enables/Disables the WAKEUP interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
Reserved Bits 30–8	Reserved—These bits are reserved and should read 0.	
MSOF Bit 7	Missed Start-of-Frame Mask—Enables/Disables the MSOF interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
SOF Bit 6	Start-of-Frame Mask—Enables/Disables the SOF interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
RESET_STOP Bit 5	Reset Signaling Stop Mask—Enables/Disables the RESET_STOP interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
RESET_START Bit 4	Reset Signaling Start Mask—Enables/Disables the RESET_START interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
RES Bit 3	Suspend to Resume Mask—Enables/Disables the RES interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
SUSP Bit 2	Suspend Mask—Enables/Disables the SUSP interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
FRAME_MATCH Bit 1	Frame Match Mask—Enables/Disables the FRAME_MATCH interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
CFG_CHG Bit 0	Configuration Change Mask—Enables/Disables the CFG_CHG interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)

22.3.9 USB Enable Register

The USB Enable register (USB_ENAB) controls the operation of the USB functions.

USB_I	ENAB		USB Enable												Addr 0x00212024			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
	RST	ENAB	SUSPEND	ENDIAN_ MODE														
TYPE	rw	rw	r	r/w	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0		
NLOLI							0x10	00										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
																PWRMD		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	rw		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1		
TILOLI							0x00	01										

Table 22-14. USB Enable Register Description

Name	Description	Settings
RST Bit 31	Reset—Indicates the USB's software reset state. Automatically clears after the USB module is reset.	0 = No USB reset in progress 1 = USB reset in progress
	Note: Setting RST automatically sets the ENAB bit.	
ENAB Bit 30	Enable—Indicates the USB's enable state. When the USB is disabled, all write access to the USB registers is ignored except for writes to ENAB and to the WAKEUP bit in the USB_INTR register.	0 = Disable the USB 1 = Enable the USB
SUSPEND Bit 29	Suspend—Indicates whether the UDC module is in the suspend state.	0 = Module is in resume/active state 1 = Module is in suspend state
ENDIAN_MODE Bit 28	Endian Mode Select—Selects whether the USB module is in Big Endian mode or Little Endian mode.	1 = USBd module is in Little Endian mode 0 = USBd module is in Big Endian mode
Reserved Bits 27–1	Reserved—These bits are reserved and should read 0.	
PWRMD Bit 0	Power Mode —Determines the power mode of USBD. The default power mode is self powered.	0 = Bus powered mode 1 = Self-powered mode

22.3.10 Endpoint n Status/Control Registers

The Endpoint n Status/Control registers allow the user to configure the endpoints and contains a field for maintaining a count of the FIFO contents.

The number of Endpoint n Status/Controls in the MC9328MXS depends on the number of endpoints configured.

USB_ USB_ USB_ USB_ USB_ USB_	EP1 EP2 EP3 EP4	STA STA STA STA	T T T		Endp Endp Endp Endp Endp	oint 2 oint 2 oint 3 oint 4	O Sta 1 Sta 2 Sta 3 Sta 4 Sta 5 Sta	tus/C tus/C tus/C tus/C	Contro Contro Contro	ol Reg ol Reg ol Reg ol Reg	gister gister gister gister			(0x002 0x002 0x002 0x002	Addr 12030 12060 12090 120C0 120F0 12120
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
												В	YTE_C	OUNT		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HLOLI								0	x0000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								SIP	DIR	MA	ΑX	TY	P	ZLPS	FLUSH	FORCE_ STALL
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	W	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0	x0000							

Table 22-15. Endpoint n Status/Control Register Description

Name	Description Settings								
Reserved Bits 31–23	Reserved—These bits are reserved and should read 0.								
BYTE_COUNT Bits 22–16	syte Count—Represents the number of bytes currently stored in the associated FIFO.								
Reserved Bits 15–9	Reserved—These bits are reserved and should read 0.								
SIP Bit 8	Setup Packet In Progress—Indicates whether the setup packet is being transferred from host to device.	0 = Setup data is not being transferred from host to device 1 = Setup data is currently being transferred from host to device							
DIR Bit 7	Transfer Direction —Sets the endpoint direction (DIR is ignored for control endpoints).	0 = OUT endpoint (from host to device) 1 = IN endpoint (from device to host)							

MC9328MXS Reference Manual, Rev. 1

Table 22-15. Endpoint n Status/Control Register Description (continued)

Name	Description	Settings
MAX Bits 6–5	Maximum Packet Size—Sets the maximum packet size for the endpoint (MAX is ignored for -ronous endpoints). Note: The maximum packet size cannot be greater than the endpoint's FIFO size. See Table 22-1 for FIFO sizes.	00 = Packet is 8 Bytes 01 = Packet is 16 Bytes 10 = Packet is 32 Bytes 11 = Packet is 64 Bytes
TYP Bits 4–3	Endpoint Type—Sets up the type of endpoint being used. Endpoint 0 is defined as a control endpoint, however all other endpoints can be any type.	00 = Control 01 = Isochronous 10 = Bulk 11 = Interrupt
ZLPS Bit 2	Zero Length Packet Send—Determines if a zero length packet will be sent to the host. If the FIFO is empty and the USB host requests an IN transaction, the USB module can send a zero length packet in response. ZLPS automatically clears after the transaction completes successfully. ZLPS signifies to the USB host that the end of data was reached in a data transmission when the end of data lands on a packet boundary and there is no short packet to signify the end of data.	0 = No zero length packet to send 1 = A zero length packet to send
FLUSH Bit 1	Flush—Flushes the associated FIFO to its empty state.	0 = Do nothing 1 = Initiate flush operation
FORCE_STALL Bit 0	Force a Stall Condition—Causes the endpoint to respond with a STALL to the next poll, and automatically clears when the stall takes effect. Note: There is no endpoint stalled indicator because one is not	0 = Do nothing 1 = Force a stall condition
	returned from the UDC. The USB host is expected to communicate with the USB device through device requests to fix the stall condition. The USB host sends a CLEAR_FEATURE request to the UDC module to clear the stall and resume normal operations.	

22.3.11 Endpoint n Interrupt Status Registers

The Endpoint n Interrupt Status registers monitor the status of a specific endpoint and generates CPU interrupts each time a monitored event occurs.

When an interrupt is set, it remains set until cleared by writing 1 to the corresponding bit. Interrupts do not clear automatically when the event that caused them goes away (for example, when reset signaling comes and goes with no intervention from software, both RESET_START and RESET_STOP are set). Writing 0 has no effect.

If a register write occurs at the same time an interrupt is received, the interrupt takes precedence over the write.

The number of Endpoint n Interrupt Statuss in the MC9328MXS depends on the number of endpoints configured.

22-20 Freescale Semiconductor

USB_E USB_E USB_E USB_E USB_E	:P1_IN :P2_IN :P3_IN :P4_IN	NTR NTR NTR NTR			En En En	dpo dpo dpo dpo	int 2 int 2 int 3 int 4	1 Inter 2 Inter 3 Inter 4 Inter	rupt St rupt St rupt St rupt St	atus Reatus Re	egiste egiste egiste egiste	r r r r		0x0 0x0 0x0	0021 0021 0021 0021 0021	Addr 2034 2064 2094 20C4 20F4 2124
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI									0x000	0						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								FIFO_ FULL	FIFO_ EMPTY	FIFO_ ERROR	FIFO_ HIGH	FIFO_ LOW	MDEV REQ	EOT	DEV REQ	EOF
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
HESET									0x008	0						

Table 22-16. Endpoint n Interrupt Status Register Description

Name	Description	Settings				
Reserved Bits 31–9	Reserved—These bits are reserved and should read 0.					
FIFO_FULL Bit 8	FIFO Full—Indicates whether the FIFO is full or not.	0 = The FIFO is not full 1 = The FIFO is full				
FIFO_EMPTY Bit 7	FIFO Empty—Indicates whether the FIFO is empty or not.	0 = The FIFO is not empty 1 = The FIFO is empty				
FIFO_ERROR Bit 6	FIFO Error—Indicates an error condition in the FIFO controller. The specific error condition can be checked by reading the Endpoint n FIFO Status (USB_EPn_FSTAT).	0 = No error condition pending 1 = Error condition pending				
FIFO_HIGH Bit 5	FIFO High—Asserts when the FIFO has hit a high level alarm. FIFO_HIGH applies only when the FIFO is in receive mode (USB OUT).	0 = The number of data bytes in the FIFO is less than GR value from the Endpoint n FIFO Control 1 = The number of free bytes in the FIFO is less than ALRM value from the Endpoint n FIFO Alarm				

Table 22-16. Endpoint n Interrupt Status Register Description (continued)

Name	Description	Settings
FIFO_LOW Bit 4	FIFO Low—Asserts when the FIFO has hit a low level alarm. FIFO_LOW applies only when the FIFO is in transmit mode (USB IN).	0 = The number of free bytes in the FIFO is less than 4xGR value from the Endpoint n FIFO Control 1 = The number of data bytes in the FIFO is less than ALRM value from the Endpoint n FIFO Alarm
MDEVREQ Bit 3	Multiple Device Requests—Asserts when a DEVREQ interrupt is pending and another setup packet is received. MDEVREQ asserts only for control endpoints.	0 = Multiple setup packets are not pending 1 = Multiple setup packets pending
EOT Bit 2	End-of-Transfer—Asserts when the last packet of a USB data transfer has crossed into, or out of, the UDC module. The last packet is identified by its length. Any packet shorter than the maximum packet size for the associated endpoint is considered to be an end-of-transfer marker. The EOT interrupt also asserts (for control endpoints only) when the number of bytes specified in the wLength field of the setup packet has been transferred.	0 = Last packet of data not sent/received 1 = Last packet of data sent/received
DEVREQ Bit 1	Device Request —Indicates whether there is a device request on the current endpoint. DEVREQ asserts only for control endpoints.	0 = No request pending 1 = Request pending
EOF Bit 0	End-of-Frame—Indicates whether there is end-of-frame activity for this endpoint. EOF monitors the data flow between the FIFO and the UDC and indicates when the end of a USB packet is written into the FIFO or the UDC as the end of a frame.	0 = End-of-frame (USB packet) not sent/received 1 = End-of-frame (USB packet) sent/received

22-22 Freescale Semiconductor

22.3.12 Endpoint n Interrupt Mask Register

The Endpoint n Interrupt Mask registers allow the user to mask individual interrupts for each endpoint. Writing 1 to a bit in this register masks the corresponding interrupt in the USB_EPn_STAT register. Writing 0 unmasks the interrupt.

The number of Endpoint n Interrupt Masks in the MC9328MXS depends on the number of endpoints configured.

USB_E USB_E USB_E USB_E USB_E	P1_N P2_N P3_N P4_N	IASH IASH IASH IASH	< < < < < < < < < < < < < < < < < < <		Ei Ei Ei	ndpo ndpo ndpo ndpo	oint oint oint oint	1 Inte 2 Inte 3 Inte 4 Inte	rrupt M rrupt M rrupt M rrupt M rrupt M	lask Re lask Re lask Re lask Re lask Re	egister egister egister egister			0x0 0x0 0x0	0021 0021 0021 0021 0021	Addr 2038 2068 2098 20C8 20F8 2128
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESET									0x000	0						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								FIFO_ FULL	FIFO_ EMPTY	FIFO_ ERROR	FIFO_ HIGH	FIFO_ LOW	MDEV REQ	EOT	DEV REQ	EOF
TYPE	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1
NESEI									0x01F	F						

Table 22-17. Endpoint n Interrupt Mask Register Description

Name	Description	Settings
Reserved Bits 31–9	Reserved—These bits are reserved and should read 0.	
FIFO_FULL Bit 8	FIFO Full Mask—Enables/Disables the FIFO Full interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
FIFO_EMPTY Bit 7	FIFO Empty Mask—Enables/Disables the FIFO Empty interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
FIFO_ERROR Bit 6	FIFO Error Mask—Enables/Disables the FIFO Error interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
FIFO_HIGH Bit 5	FIFO High Alarm Mask—Enables/Disables the FIFO High Alarm interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)
FIFO_LOW Bit 4	FIFO Low Alarm Mask—Enables/Disables the FIFO Low Alarm interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)

MC9328MXS Reference Manual, Rev. 1

Table 22-17. Endpoint n Interrupt Mask Register Description (continued)

Name	Description	Settings				
MDEVREQ Bit 3	Multiple Device Requests Mask—Enables/Disables the Multiple Device Requests interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)				
EOT Bit 2	End-of-Transfer Mask—Enables/Disables the End-of-Transfer interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)				
DEVREQ Bit 1	Device Request Mask —Enables/Disables the Device Request interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)				
EOF Bit 0	End-of-Frame Mask—Enables/Disables the end-of-frame interrupt.	0 = Interrupt enabled (unmasked) 1 = Interrupt disabled (masked)				

22-24 Freescale Semiconductor

22.3.13 Endpoint n FIFO Data Registers

The Endpoint n FIFO Data registers are the main interface port for each FIFO. Data to be buffered in the FIFO, or currently buffered in the FIFO, is accessed through this register. This register can access data from the FIFO independent of the transmit or receive configuration in byte, word, or longword formats, however each access must be aligned with the most significant byte (big endian) of the data port. Byte 0 is bits 31:24, byte 1 is bits 23:16, byte 2 is bits 15:8, and byte 3 is bits 7:0. Byte transfers must access byte 0. Word transfers must access bytes 0 and 1, and longword transfers must access all four bytes. USB FIFO data write is in big-endian format.

The direction of the FIFO is determined by the value of the DIR field in the Endpoint n Status/Control.

The number of Endpoint n FIFO Datas in the MC9328MXS depends on the number of endpoints configured.

USB_I USB_I USB_I USB_I USB_I	EP1_I EP2_I EP3_I EP4_I	FDAT FDAT FDAT FDAT	•		End End End	Endpoint 0 FIFO Data Register Endpoint 1 FIFO Data Register Endpoint 2 FIFO Data Register Endpoint 3 FIFO Data Register Endpoint 4 FIFO Data Register Endpoint 5 FIFO Data Register									Addr 0x0021203C 0x0021206C 0x0021209C 0x002120CC 0x002120FC 0x0021212C		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
					R	XDATA [[31:16] (F	Read) or	TXDAT	A [31:10	6] (Write)					
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
HEGET								0X00	00								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
					F	RXDATA	. [15:0] (F	Read) or	TXDAT	A [15:0]	(Write)						
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
TILOLI								0x00	00								

Table 22-18. Endpoint n FIFO Data Register Description

Name	Description
TXDATA [31:0] Bits 31–0	Transmit Data—Contains the transmit FIFO write data.
RXDATA [31:0] Bits 31–0	Read Data—Contains the receive FIFO read data.

22.3.14 Endpoint n FIFO Status Registers

The Endpoint n FIFO Status registers are the main status registers for the FIFOs, and contain information about frame status, underflow, overflow, alarm, and FIFO content.

The number of Endpoint n FIFO Status registers in the MC9328MXS depends on the number of endpoints configured.

USB_ USB_ USB_	EP1 EP2 EP3 EP4	FSTA FSTA FSTA FSTA FSTA	AT AT AT AT		End End End End	dpoint 1 dpoint 2 dpoint 3 dpoint 4	FIFO FIFO FIFO FIFO	Status Status Status Status Status Status	Re Re Re	gister gister gister gister				0	0x002 ⁻ 0x002 ⁻ 0x0021 0x002 ⁻ 0x002 ⁻	12070 20A0 20D0 12100
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
					FRAME0	FRAME1	FRAME2	FRAME3		ERROR	OF	UF	FR	FULL	ALARM	EMPTY
TYPE	r	r	r	r	r	r	r	r	r	rw	rw	rw	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
NESET							0x	:0001								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESEI							0x	0000								

Table 22-19. Endpoint n FIFO Status Register Description

Name	Description	Settings
Reserved Bits 31–28	Reserved—These bits are reserved and should read 0.	
FRAME0 Bit 27	Frame Status Bit 0—Indicates whether a frame boundary exists in bus bits [31:24] for non-DMA applications.	0 = No frame boundary on the [31:24] byte 1 = A frame boundary has occurred on the [31:24] byte of the bus
FRAME1 Bit 26	Frame Status Bit 1—Indicates whether a frame boundary exists in bus bits [23:16] for non-DMA applications.	0 = No frame boundary on the [23:16] byte 1 = A frame boundary has occurred on the [23:16] byte of the bus
FRAME2 Bit 25	Frame Status Bit 2—Indicates whether a frame boundary exists in bus bits [15:8] for non-DMA applications.	0 = No frame boundary on the [15:8] byte 1 = A frame boundary has occurred on the [15:8] byte of the bus

22-26 Freescale Semiconductor

Table 22-19. Endpoint n FIFO Status Register Description (continued)

Name	Description	Settings
FRAME3 Bit 24	Frame Status Bit 3—Indicates whether a frame boundary exists in bus bits [7:0] for non-DMA applications.	0 = No frame boundary on the [7:0] byte 1 = A frame boundary has occurred on the [7:0] byte of the bus
Reserved Bit 23	Reserved—This bit is reserved and should read 0.	
ERROR Bit 22	FIFO Error—Signifies that an error condition has happened in the FIFO controller. Writing 1 to ERROR clears it. Writing 0 has no effect.	0 = No error 1 = Underflow, overflow, pointer out of bounds, or other error condition occurred
UF Bit 21	FIFO Underflow—Indicates FIFO underflow status. Writing 1 to UF clears it. Writing 0 has no effect.	0 = No underflow 1 = Read pointer has passed the write pointer
OF Bit 20	FIFO Overflow—Indicates FIFO overflow status. Writing 1 to OF clears it. Writing 0 has no effect.	0 = No overflow 1 = Write pointer has passed the read pointer
FR Bit 19	Frame Ready—Indicates frame ready status. FR is inactive when the FIFO is not programmed for frame mode.	0 = No complete frames exist in the FIFO 1 = One or more complete frames exists in the FIFO
FULL Bit 18	FIFO Full—Indicates FIFO full status. Read FULL to clear it.	0 = The FIFO is not full 1 = The FIFO is full
ALARM Bit 17	FIFO Alarm—Indicates FIFO alarm status. The specific alarm condition detected depends on the FIFO direction. The signal relies on the values of the alarm (ALRM) field of the Endpoint n FIFO Alarm and the granularity (GR) field of the Endpoint n FIFO Control.	0 = The alarm not set 1 = The alarm is set
	For IN (transmit) FIFOs, the ALARM bit indicates a low level. It asserts when there are less than ALRM bytes of data remaining in the FIFO, and deasserts when there are less than 4 times GR free bytes remaining.	
	When the FIFO is configured to receive (OUT FIFOs), the ALARM bit indicates a high level. It asserts when there are less than ALRM bytes free in the FIFO, and deasserts when there are less than GR bytes of data remaining.	
	This signal is cleared by reading or writing (as appropriate) the FIFO, or by manipulating the FIFO pointers.	
EMPTY Bit 16	FIFO Empty—Indicates FIFO empty status. Write 1 to EMPTY to clear it.	0 = The FIFO is not empty 1 = The FIFO is empty
Reserved Bits 15–0	Reserved—These bits are reserved and should read 0.	

22.3.15 Endpoint n FIFO Control Registers

The Endpoint n FIFO Control registers are the primary control registers regarding data in the FIFO. This includes frame mode and low and high data service requests.

The number of Endpoint n FIFO Controls in the MC9328MXS depends on the number of endpoints configured.

USB_E USB_E USB_E USB_E USB_E USB_E	P1_F0 P2_F0 P3_F0 P4_F0	TRL TRL TRL			Endpo Endpo Endpo Endpo	Endpoint 1 FIFO Control Register Endpoint 2 FIFO Control Register Endpoint 3 FIFO Control Register Endpoint 4 FIFO Control Register O O O O O O O O O O O O										Addr 0x00212044 0x00212074 0x002120A4 0x002120D4 0x00212104 0x00212134		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
			WFR		FRAME		GR											
TYPE	r	r	rw	r	rw	rw	rw	rw	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0		
TILOLI							0x0	0100										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
NESET							0x0	0000										

Table 22-20. Endpoint n FIFO Control Register Description

Name	Description	Settings
Reserved Bits 31–30	Reserved—These bits are reserved and should read 0.	
WFR Bit 29	Write Frame End—Determines the end of the current data frame in the FIFO. Setting WFR means that the next write is the end of the current data frame.	0 = Next write to FIFO data register is not the end-of-frame 1 = Next write to FIFO data register is the end-of-frame
Reserved Bit 28	Reserved—This bit is reserved and should read 0.	•

Table 22-20. Endpoint n FIFO Control Register Description (continued)

Name	Description	Settings
FRAME Bit 27	Frame Mode—Indicates whether the USB module is in FRAME mode. In FRAME mode, the FIFO uses its internal frame pointer and information from the peripheral to transfer only full frames of data, as defined by the peripheral. Because the controller only keeps a pointer to the end of the last complete frame, a read request can contain more than one frame of data. The MC9328MXS supports only FRAME = 1.	0 = Frame mode disabled 1 = Frame mode enabled
GR Bits 26–24	Granularity—Defines the deassertion point for the "high level" and "low level" service requests. See the ALARM field of the Endpoint n FIFO Status for more information. A "high level" service request is deasserted when there are less than GR data bytes remaining in the FIFO. A "low level" service request is deasserted when there are less than four times GR free bytes remaining in the FIFO. The direction, type, and packet size are defined in the Endpoint n Status/Control.	000 = FIFO has 1 data byte or 1 free location 001 = FIFO has 2 data bytes or 2 free locations 010 = FIFO has 3 data bytes or 3 free locations 011 = FIFO has 4 data bytes or 4 free locations 100 = FIFO has 5 data bytes or 5 free locations 101 = FIFO has 6 data bytes or 6 free locations 110 = FIFO has 7 data bytes or 7 free locations 111 = FIFO has 8 data bytes or 8 free locations
Reserved Bits 23–0	Reserved—These bits are reserved and should read 0.	

22.3.16 USB Endpoint n Last Read Frame Pointer Registers

The USB Endpoint n Last Read Frame Pointer registers hold the location of the most recently read frame or the start of the frame currently in transmission.

The number of USB Endpoint n Last Read Frame Pointers in the MC9328MXS depends on the number of endpoints configured.

USB_ USB_ USB_ USB_	EP1_ EP2_ EP3_ EP4_	LRFP LRFP LRFP LRFP LRFP LRFP		End End End End	dpoin dpoin dpoin dpoin	t 1 La t 2 La t 3 La t 4 La	ast Ro ast Ro ast Ro ast Ro	ead F ead F ead F ead F	rame rame rame rame rame rame	Poi Poi Poi Poi	inter inter inter inter	Regis Regis Regis Regis	ster ster ster ster	0x0 0x0 0x0	0021: 0021: 0021: 0021: 0021:	Addr 2048 2078 20A8 20D8 2108 2138
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
													LR	RFP		
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	00							

Table 22-21. USB Endpoint n Last Read Frame Pointer Register Description

Name	Description
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.
LRFP Bits 5–0	Last Read Frame Pointer—Indicates the start of the most recently read frame or the start of the frame currently in transmission. The LRFP can be read and written for debugging purposes. For the frame retransmit function, the LRFP indicates the point to begin retransmission of the data frame. There are no safeguards to prevent retransmitting data that was overwritten. When the FRAME bit is not set, this pointer has no meaning.

22-30 Freescale Semiconductor

22.3.17 USB Endpoint n Last Write Frame Pointer Registers

The USB Endpoint n Last Write Frame Pointer registers hold the location of the most recently written frame.

The number of USB Endpoint n Last Write Frame Pointers in the MC9328MXS depends on the number of endpoints configured.

USB_ USB_ USB_ USB_	EP1_ EP2_ EP3_ EP4_	LWFP LWFP LWFP LWFP LWFP		End End End	dpoin dpoin dpoin dpoin	nt 1 La nt 2 La nt 3 La nt 4 La	ast W ast W ast W ast W	rite f rite f rite f rite f	Frame Frame Frame Frame Frame Frame	Poi Poi Poi Poi	nter nter nter nter	Regis Regis Regis Regis	ster ster ster ster	0x0 0x0 0x0 0x0	00212 00212 00212 00212 00212	207C 20AC 20DC 210C
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
													LW	/FP		
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
nesel								0x00	000							

Table 22-22. USB Endpoint n Last Write Frame Pointer Register Description

Name	Description
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.
LWFP Bits 5–0	Last Write Frame Pointer—Indicates the start of the last frame written into the FIFO. The LWFP can be read and written for debugging purposes. For the frame retransmit function, the LRFP indicates the point to begin retransmission of the data frame. For the frame discard function, the LWFP divides the valid data region of the FIFO (the area in-between the read and write pointers) into framed and unframed data. Data between the LRFP and write pointer is an incomplete frame, while data between the read pointer and the LWFP is received as whole frames. When the FRAME bit is not set, this pointer has no meaning.

22.3.18 Endpoint n FIFO Alarm Registers

The Endpoint n FIFO Alarm registers define the high/low level alarm setting. The number of Endpoint n FIFO Alarms in the MC9328MXS depends on the number of endpoints configured.

USB_ USB_ USB_ USB_	B_EP0_FALRM B_EP1_FALRM B_EP2_FALRM B_EP3_FALRM B_EP4_FALRM B_EP5_FALRM					Ipoint Ipoint Ipoint Ipoint Ipoint	1 FII 2 FII 3 FII 4 FII	=O A =O A =O A =O A	larm larm larm larm	Regi Regi Regi Regi	ster ster ster ster	ter 0x00212080 ter 0x002120B0 ter 0x002120E0 ter 0x00212110					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
													AL	RM			
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
TILGET								0x00	00								

Table 22-23. Endpoint n FIFO Alarm Register Description

Name	Description	Settings
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.	
ALRM Bits 5–0	Alarm Information—Provides the assertion point for the "high level" and "low level" service requests. See the ALARM field of the Endpoint n FIFO Status for more information. A low level alarm reports lack of data while a high level alarm reports lack of space. The integrator must decide which alarm is necessary for each application. When the amount of data or space in the FIFO is above the indicated amount, the alarm sets in non-frame mode. In frame mode, the alarm sets when the amount of data or space in the FIFO is above the amount indicated by the ALRM setting or when there are end-of-frame bytes in the FIFO (see frame mode operation). A "high level" service request is asserted when there are less than ALRM bytes free in the FIFO. A "low level" service request asserts when there are less than ALRM bytes of data in the FIFO.	0x00 = 1 data byte left or 1 free byte available 0x01 = 2 data bytes left or 2 free bytes available 0x3F = 64 data bytes left or 64 free bytes available

MC9328MXS Reference Manual, Rev. 1

22-32 Freescale Semiconductor

22.3.19 Endpoint n FIFO Read Pointer Registers

The Endpoint n FIFO Read Pointer registers hold the location of the next FIFO location to read.

The number of Endpoint n FIFO Read Pointers in the MC9328MXS depends on the number of endpoints configured.

USB_ USB_ USB_ USB_	EP1_ EP2_ EP3_ EP4_	FRDP FRDP FRDP FRDP FRDP FRDP		Er Er Er	Idpoi Idpoi Idpoi Idpoi	nt 0 F nt 1 F nt 2 F nt 3 F nt 4 F nt 5 F	IFO I IFO I IFO I	Read Read Read Read	Poin Poin Poin Poin	ter F ter F ter F ter F	Regis [.] Regis [.] Regis [.] Regis [.]	ter ter ter ter		0x 0x(0x(0x	0021 0021 0021 0021 0021	Addr 2054 2084 2084 20E4 2114 2144
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HESEI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
													F	lP		
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
nESET								0x00	00							

Table 22-24. Endpoint n FIFO Read Pointer Register Description

Name	Description
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.
RP Bits 5–0	Read Pointer—Points to the next FIFO location to read. The physical address of this FIFO location is actually the sum of the read pointer and the FIFO base, provided through a port to the FIFO controller. This base address can vary, however if chosen properly, the FIFO RAM address can be concatenated with the read pointer instead of requiring hardware for addition. The read pointer can be both read and written. This ability facilitates the debugging of the FIFO controller and peripheral drivers. The current maximum size of the write pointer is twelve bits, however it can be reduced through parameterization.

22.3.20 Endpoint n FIFO Write Pointer Registers

The Endpoint n FIFO Write Pointer registers hold the location of the next FIFO location to write.

The number of Endpoint n FIFO Write Pointers in the MC9328MXS depends on the number of endpoints configured.

USB_ USB_ USB_ USB_ USB_ USB_	EP1 EP2 EP3 EP4	FWRI FWRI FWRI FWRI	P P P	Er Er Er	Idpoii Idpoii Idpoii	nt 0 F nt 1 F nt 2 F nt 3 F nt 4 F nt 5 F	IFO VIFO VIFO VIFO V	Write Write Write Write	Poir Poir Poir Poir	iter F iter F iter F iter F	Regis Regis Regis Regis	ter ter ter ter		0x(0x(0x(0021; 0021; 0021; 0021; 0021;	Addr 2058 2088 20B8 20E8 2118 2148
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
													V	/P		
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	000							

Table 22-25. Endpoint n FIFO Write Pointer Register Description

Name	Description
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.
WP Bits 5–0	Write Pointer—Points to the next FIFO location to write. The physical address of this FIFO location is actually the sum of the read pointer and the FIFO base, provided through a port to the FIFO controller. This base address can vary, however if chosen properly, the FIFO RAM address can be concatenated with the read pointer instead of requiring hardware for addition. The read pointer can be both read and written. This ability facilitates the debugging of the FIFO controller and peripheral drivers.

22.4 Programmer's Reference

The programmer's reference guide gives details on how to program the USB module. This section covers device initialization, processing vendor requests, normal datapath operations, interrupt services, and reset operation.

MC9328MXS Reference Manual, Rev. 1

22.5 Device Initialization

During device initialization, user software downloads critical configuration information to the UDC module and prepares the USB module datapath for processing. This process is performed at two different times: at reset (hard reset or software reset via RST bit in the USB DDAR register) and when the device is first connected to the USB.

At power-up, the USB module contains no configuration information—such as, how many endpoints are available or how to locate the descriptors. Device initialization consists of downloading this information to the appropriate memories and to configure the datapath to match the intended application. The following steps are involved in the initialization process:

- 1. Perform a hard reset or a software reset (by setting the RST bit in USB Enable-USB ENAB).
- 2. Wait for the device to be properly reset (after writing to RST bit, wait for it to clear) before accessing the device registers.
- 3. Wait for the CFG bit in the USB_DDAR register to assert before attempting to communicate with the UDC. Setting the RST bit forces the ENAB bit to set automatically.
- 4. Download configuration data (ENDPTBUFs, see Table 22-26 on page 22-36) to the device's USB Descriptor RAM/Endpoint Buffer Data-USB DDAT).
- 5. Program the USB Interrupt Mask (USB_MASK) to enable interrupts not associated with a particular endpoint.
- 6. Program each Endpoint n Status/Control (USB_EPn_STAT) and Endpoint n Interrupt Mask (USB_EPn_MASK) to support the intended data transfer modes.
- 7. Program endpoint type, direction, and maximum packet size in the USB_EPn_STAT register for each endpoint.
- 8. Program the FIFO control registers. For each enabled endpoint, program frame mode, granularity, alarm level, and so on (USB_EPn_FCTRL and USB_EPn_FALRM). Normally, all endpoints should be programmed with FRAME mode enabled. To ensure proper operation of the DMA request lines for frame mode endpoints, program the alarm level to a value equal to or a multiple of the packet size of the endpoint.
- 9. Enable the USB for processing (set the USB ENA bit in the USB Control, USB CTRL).

NOTE:

Initialization of the USB module is a time critical process. The USB host waits about 100ms after power-on or a connection event to begin enumerating devices on the bus. This device must have all of the configuration information available when the host requests it.

After the device is enumerated, the USB host selects a specific configuration and set of interfaces on the device. Software on the device must beware of USB configuration changes to maintain proper communication with the USB host. The software retains sole responsibility for always knowing the current configuration and alternate interface. The CFG_CHG interrupt in the USB_INTR register reports changes in device configuration and alternate interface settings to the software. The software is required to respond to the CFG_CHG interrupt. To prevent the state of the device from becoming out of sync with respect to the host, the device halts further traffic on the USB while this interrupt is pending.

Device Initialization

22.5.1 Configuration Download

The configuration download process initializes 6 endpoint buffers (ENDPTBUF-see Table 22-26 on page 22-36) within the UDC module to define its personality on the USB. The first ENDPTBUF is reserved for the default pipe (Control Endpoint) and must contain the value 0x0000080000. Endpoint buffers 1–5 can have a maximum of two configurations. Because endpoint buffers 1–5 can have up to two configurations, both configurations are downloaded to the device. A total of 55 bytes will transfer because endpoint buffer 0 is restricted to one configuration.

The endpoint buffers are 40-bit data strings per physical endpoint (pipe) that are loaded directly into the UDC module. They associate "logical" endpoint numbers in the USB software stack with hardware within the UDC. Specifically, they attach each endpoint to a USB configuration, interface, and alternate setting, and they specify transfer type, packet size, data direction, and hardware FIFO numbers.

Table 22-26. ENDPTBUF—UDC Endpoint Buffers Format

Bit/Field	Туре	Description
[39:36]	EPNUM	Logical Endpoint Number
[35:34]	CONFIG	Configuration Number (maximum of 2 configurations: 1 and 2)
[33:32]	INTERFACE	Interface Number (maximum of 4 interfaces)
[31:29]	ALTSETTING	Alternate Setting Number (maximum of 8 alternate settings)
[28:27]	TYPE	Type of Endpoint: 00 = Control 01 = Isochronous 10 = Bulk 11 = Interrupt
[26]	DIR	Direction of the Endpoint: 0 = OUT endpoint 1 = IN endpoint
[25:16]	MAXPKTSIZE	Maximum packet size for the endpoint 0x08 = 8 bytes 0x10 = 16 bytes 0x20 = 32 bytes 0x40 = 64 bytes
[15:14]	TRXTYP	These bits must be set to 00 for endpoint 0, and 11 for all other endpoints.
[13:3]	Reserved	Reserved
[2:0]	FIFONUM	This field maps the endpoint to one of the < <block name="">> module's hardware FIFOs. Multiple UDC endpoints can map to a single hardware FIFO. It is up to the software to monitor and control any data hazards related to this type of operation in this way: The hardware FIFOs that are available are: FIFO0 (32 bytes) FIFO1 (64 bytes) FIFO2 (64 bytes) FIFO3 (32 bytes) FIFO4 (32 bytes) FIFO5 (32 bytes)</block>

MC9328MXS Reference Manual, Rev. 1

22-36 Freescale Semiconductor

To download the configuration data, perform the following steps:

- 1. Verify that the CFG bit (in the USB_DADR register) is set. This ensures that the UDC is fully reset and is ready to take data.
- 2. Write the endpoint buffers (EnfPtBufs) to the USB_DDAT register. (the first byte written is EPn[39:32] and the last byte written is EPn[7:0]). After writing each byte, and before performing any other operation on the peripheral, verify that the BSY bit (in the USB_DADR register) is clear.
- 3. After writing all endpoint buffer configuration bytes, check the CFG bit of the USB_DADR to verify that the configuration download is complete. CFG changes from 1 to 0 after the last byte is loaded into the UDC.

22.5.1.1 USB Endpoint to FIFO Mapping

The USB protocol recognizes a maximum of 31 endpoints on a USB device. The endpoint numbers available on a specific USB device are based on the functionality present in the device, and on the configuration and alternate interfaces currently selected. Regardless of the logical endpoint number programmed in the interface descriptors, some hardware must be associated with each endpoint.

The USB module supports a maximum of 6 endpoints, including endpoint 0. Each hardware endpoint consists of a single FIFO that is independently programmable for direction, transfer type, frame mode, and low/high alarms. To fit these hardware endpoints to the USB's logical endpoints, mapping is established in the UDC module's endpoint buffer (EndPtBufs). Endpoint FIFO 0 is reserved for the default pipe (Control Endpoint).

Endpoint type, direction and packet size are defined in the USB_EPn_STAT register for each endpoint. FIFO characteristics are programmed in the USB_EPn_FCTRL and USB_EPn_FALRM registers. At power-up, the USB endpoints are mapped to specific hardware FIFOs when the UDC endpoint buffers are downloaded to the device from the CPU. The endpoint buffer makes 16 bits available to identify each hardware endpoint. These bits are the UDC_BufAdrPtr field [15:0] in the USB_SPEC register (see Table 22-26). Depending on the transaction selected by the UDC, this bus includes the indicator for a setup packet, or endpoint specific encoding. The UDC_BufAdrPtr [15:0] fields defined for the USB module are shown in Table 22-26 -EndPtBuf[15:0].

22.5.1.2 USB Interrupt

If the application uses the interrupt registers, the specific interrupts must be enabled. During reset, all interrupts revert to the masked state. USB global interrupts (interrupts that affect the whole module) are programmed separately from those affecting a single endpoint.

22.5.1.3 Endpoint Registers

The characteristics of the FIFO and a number of interrupt sources can be programmed for each endpoint. The integrator must program the following registers:

- USB Endpoint Interrupt Mask (USB_EPn_MASK)
 Separate interrupt registers are provided for each hardware FIFO. Enable the interrupts pertaining to the application by writing 0 to the mask bit for that interrupt.
- Endpoint FIFO Controller Configuration (USB_EPn_FCTRL). Each FIFOs programming is based on the type of data transmission used by the endpoint. Normally, all endpoints are programmed with FRAME mode.
- FIFO Alarm Register (USB_EPn_FALRM).

 For bulk traffic (FRAME = 1), the alarm level is normally programmed to a multiple of the USB packet size (for 8 byte packets and a 16 byte FIFO, the alarm is programmed to 8 bytes) to allow the DMA request lines

Exception Handling

to request full packets. For single buffered endpoints (packet size = 8, FIFO depth = 8 bytes), the alarm is normally programmed to 0. For isochronous traffic, the alarm is programmed to allow streaming operation to occur on the isochronous endpoint.

22.5.1.4 Enable the Device

The last step in initializing the USB module is to enable it for processing in the USB_CTRL register. Most applications set the USB_SPD bit, the AFE_ENA bit and the USB_ENA bit in the USB_CTRL register.

NOTE:

The USB_SPD bit must be set at 1 (high speed mode, default). The USB device does not support low speed.

22.6 Exception Handling

Exception handling occurs in two situations:

- When corrupted frames must be discarded
- When an error occurs on the USB

The hardware automatically discards corrupted frames, so no software intervention is required.

If the device cannot respond to the host in the time allotted, the hardware automatically handles retries. No software intervention is required.

There are four error situations that must be dealt with by the software:

- Unable to Complete Device Request
- Aborted Device Request
- Unable to Fill or Empty FIFO Due to Temporary Problem
- Catastrophic Error.

Explanations for each of the errors are described in the following sections.

22.6.1 Unable to Complete Device Request

In the event that the software receives a device request it cannot interpret, it asserts the CMD_ERROR and CMD_OVER bits (in the USB_CTRL register) to the UDC. This results in a STALL to the endpoint in question and requires intervention from the USB host to clear. When the CMD_OVER bit clears, it means that the USB host has cleared the stall condition.

22.6.2 Aborted Device Request

When the host sends a setup packet to the device, the ACK handshake from the device can become corrupted and lost on its way to the host. If this happens, the host retries the setup packet, and the device can wind up with two or more setup packets in its FIFO. There are two ways to detect this condition:

- The presence of a MDEVREQ interrupt (in the USB EPn INTR register)
- The SIP bit in the Endpoint n Status/Control (USB_EPn_STAT) is active

MC9328MXS Reference Manual, Rev. 1

22-38 Freescale Semiconductor

In either case, the presence of more than one setup packet invalidates the first one in the FIFO. When MDEVREQ is active, software must discard the first one, and process the second one. When SIP is active, software must discard the first one, clear the device request, and wait for it to reassert.

22.6.3 Unable to Fill or Empty FIFO Due to Temporary Problem

When the USB module is unable to fill or empty a FIFO due to a temporary problem (such as the OS did not service the FIFO in time and it overflowed), the software stalls the endpoint through the FORCE_STALL bit in the USB_EPn_STAT register. This aborts the transfer in progress and forces intervention from the USB host to clear the stall condition. The FORCE_STALL register bit automatically clears after the stall takes effect. The application software on the host must deal with the stall condition and notify the device on how to proceed.

22.6.4 Catastrophic Error

In the case of a catastrophic error, the software executes a hard reset, re-initializes the USB module, and waits for the USB host to re-enumerate the bus.

22.7 Data Transfer Operations

Four types of data transfer modes exist for the USB module: control transfers, bulk transfers, isochronous transfers and interrupt transfer. From the perspective of the USB module, the interrupt transfer type is identical to the bulk data transfer mode, and no additional hardware is supplied to support it. This section covers the transfer modes and how they work.

Data moves across the USB in packets. Groups of packets are combined to form data transfers. The same packet transfer mechanism applies to bulk, interrupt, and control transfers. Isochronous data is also moved in the form of packets, however, because isochronous pipes are given a fixed portion of the USB bandwidth at all times, there is no end-of-transfer (EOT).

22.7.1 USB Packets

Packets range in size from 0 to 1023 bytes, depending on the transfer mode. For bulk, control, and interrupt traffic, packet sizes are limited to 8-, 16-, 32-, or 64-bytes. Isochronous packets can range from 0 bytes to 1023 bytes. The packet size is programmed within the UDC module on an endpoint by endpoint basis. For DMA access, the maximum packet size for isochronous endpoints is restricted by the endpoint's FIFO size.

The terms *packet* and *frame* are used interchangeably within this document. While USB traffic occurs in units called packets, the FIFO mechanism uses the term frames for the same blocks of data. The only difference between frames and packets from the user's standpoint is that packets can be as little as zero bytes in length, while a frame must be at least one byte in length.

22.7.1.1 Short Packets

Each endpoint has a maximum packet size associated with it. The packet size is set with the MAX field in the Endpoint n Status/Control. In most cases, packets transferred across an endpoint are sent at the maximum size. Because the USB does not indicate a data transfer size, or include an end-of-transfer token, short packets are used

Data Transfer Operations

to mark the end of data. Software writes short packets into the FIFO to indicate the end of data. Incoming short packets are identified by examining the length of a received packet or by looking at the end-of-transfer and end-of-frame interrupts.

22.7.1.2 Sending Packets

To send a packet of data to the USB host using programmed I/O, use these steps:

- 1. For an N byte packet, write the first N-1 bytes to the Endpoint n FIFO Data (USB_EPn_FDAT). Data can be written as bytes, words, or longwords.
- 2. For the Nth byte, set the WFR bit in the USB_EPn_FCTRL register before writing the last data byte to the USB_EPn_FDAT register. Data is written in big-endian format. The most significant byte (byte 3) is held in bits 7 through 0.

When using the DMA controller for a memory I/O transfer to send packets, the sequence is as follows:

- 1. Program the DMA controller to write data to the endpoint FIFO and enable the DMA channel for the USB endpoint DMA.
- 2. When the FIFO byte count has dropped below the alarm level, a DMA request is generated. The DMA writes data to the FIFO until the DMA request deasserts.
- 3. For an N byte packet, the first N-1 bytes are written to the FIFO data register (USB_EPn_FDAT) as bytes, words, or long words.
- 4. On the Nth byte, to signal the end of a frame, the DMA controller signals to the USB that it is writing the final byte of the USB_EPn_FDAT register. The last byte in the transfer gets the end-of-frame tag (bits 31–24 for byte, bits 23–16 for word, and bits 7–0 for longword).

In a double-buffered system, the FIFO depth is twice the size of the USB packet size. Program the FIFO alarm level to be the same as a single packet. This causes the DMA request to assert whenever there is the equivalent to one packet of data or less in the FIFO. The system can write data until the DMA request deasserts, as long as the last byte of each USB packet is tagged as the end-of-frame.

22.7.1.3 Receiving Packets

Perform the following steps to receive a packet of data from the USB host using programmed I/O.

- 1. Monitor the EOF interrupt for the endpoint.
- 2. On receiving the EOF interrupt, prepare to read a complete packet of data. Clear the EOF interrupt so that software receives notification of the next frame.
- 3. Read the USB EPn FDAT register for the next piece of data.
- 4. Read the USB_EPn_FSTAT register to get the end-of-frame status bits (see note below). When the end-of-frame bit is set for the current transfer, stop reading data.
- 5. Go to step 3.

NOTE:

When reading end-of-frame indicators from USB_EPn_FSTAT, the USB_EPn_FSTAT (FRAME [3:0]) field contains valid frame byte lanes used on the bus (31:24, 23:16, 15:8, 7:0). Currently, more than one bit can be set when there are multiple end-of-frame bytes on word or longword transfers. Extra software might be required to determine the first valid end-of-frame maker. The value of this

MC9328MXS Reference Manual, Rev. 1

22-40 Freescale Semiconductor

field is computed directly from the frame boundary bits stored in the RAM. The user must ensure that the RAM data is valid when accessing these bits. For example, when there are only two bytes of data marked EOF in the RAM, and the user does a longword access, bits 1:0 of this field are undefined.

22.7.1.4 Programming the FIFO Controller

The FIFO controller has two modes of operation, Frame and Non-Frame. Only Frame mode is normally used for the USB application.

In Frame mode, the FIFO controller can handle automatic hardware retry of bad packets. During device initialization, the user configures the FIFOs through the USB_EPn_FCTRL register for FRAME mode. Data flow is controlled with the end-of-frame and end-of-transfer interrupts, or with the DMA request lines. For isochronous endpoints, no data retries are performed.

22.7.2 USB Transfers

Data transfers on the USB are composed of one or more packets. Instead of maintaining a transfer count, the USB host and device send groups of packets to each other in units called transfers. In a transfer, all packets are the same size, except the last one. The last packet in a transfer is a short packet, as small as 0 bytes (when the last data byte ends on a packet boundary).

This section describes how data transfers work from both the device to the host, and from the host to the device.

22.7.2.1 Data Transfers to the Host

The user starts by determining the number of packets in the data block, based on the maximum packet size of the target endpoint.

When the number of packets is an integer, the transfer ends on a packet boundary. A zero length packet is required to terminate the transfer. When the number of packets is not an integer, the last packet of the transfer is a short packet and no zero length packet is required.

For each packet in the transfer, write the data to the USB_EPn_FDAT register. The last byte in each packet must be tagged with the end-of-frame marker through the USB_EPn_FCTRL register (WFR bit) or DMA service request lines. Monitor the FIFO_LOW interrupt, EOF interrupt, or DMA service requests to determine when the FIFO can accept another packet.

When a zero length packet is required to terminate the transfer after the last byte is written to the FIFO, set the ZLPS bit in the USB EPn STAT register for the endpoint.

Wait for the EOT interrupt to determine when the transfer is complete.

NOTE:

For DMA operation, a zero length frame is not defined so it is necessary to have the user software monitor the EOT interrupts and use them as a basis for delineating individual transfers. USB traffic flow is halted until the EOT interrupt is serviced to ensure that data from different data transfers does not get mixed-up in the FIFOs.

Data Transfer Operations

22.7.2.2 Data Transfers to the Device

The length of data transfer from the host is generally not known in advance. The device receives a continuous stream of packets and uses the EOT interrupt to determine when the transfer ended.

Software on the device monitors the EOF interrupt and/or the DMA transfer requests to manage packet traffic. Each time a packet is received, the device must pull the data from the FIFO. When an end-of-frame is transferred from the UDC module into the data FIFO, the EOF interrupt asserts. At the end of a complete transfer, the EOT interrupt asserts. For a bulk endpoint, until the CPU has serviced the EOT interrupt, the device Negative Acknowledges (NAKs) any further requests to that endpoint from the host. This guarantees that data from two different transfers never get intermixed within the FIFO.

22.7.3 Control Transfers

The USB host sends commands to the device through control transfers. Control transfers can be addressed to any control endpoint. Control transfers consist of three distinct phases: beginning with a setup phase, followed by an optional data phase, and ending with a status phase. Command processing occurs in the following steps:

- 1. Receive the SETUP packet on a control endpoint. DEVREQ and EOF interrupts assert for that endpoint.
- 2. Read 8 bytes of the setup packet from the appropriate FIFO data register and decode the command.
- 3. Clear EOF and DEVREQ interrupts.
- 4. Set up and perform the data transfer when a data transfer is implied by the command. Do not send more bytes to the USB host than were requested in the wLength field of the SETUP packet. Hardware does not check for incorrect data phase length. The EOT interrupt asserts on completion of the data phase.
- 5. Assert the CMD_OVER and CMD_ERROR bits (in the USB_CTRL register) to indicate processing or error status. The UDC module generates appropriate handshakes on the USB to implement the status phase. CMD_OVER automatically clears at the end of the status phase.
- 6. Wait for CMD OVER to clear, indicating that the device request has completed.

The USB module assumes that the UDC module handles most of the standard requests without software intervention. User software does not need to be concerned with handling any of the so-called "Chapter 9" requests listed in the USB specification, except for SYNCH_FRAME, GET_DESCRIPTOR and SET_DESCRIPTOR. The requests are passed through endpoint 0 as a device request and must be processed by the device driver software.

22.7.4 Bulk Traffic

Bulk traffic guarantees the error-free delivery of data in the order that it was sent, however the rate of transfer is not guaranteed. Bandwidth is allocated to bulk, interrupt, and control packets based on the bandwidth usage policy of the USB host.

22.7.4.1 Bulk OUT

For OUT transfers (from host to device), internal logic marks the start of packet location in the FIFO. When a transfer does not complete without errors, the logic forces the FIFO to return to the start of the current packet and try again. No software intervention is required to handle packet retries.

22-42 Freescale Semiconductor

User software reads packets from the FIFOs as they appear and stops reading when an EOT interrupt is received. To enable further data transfers, software services and clears the pending interrupts (EOF or EOT) and waits for the next transfer to begin. For Bulk Out endpoint, until the CPU has serviced the EOT interrupt, the device NAKs any further requests to that endpoint from the host. This guarantees that data from two different transfers never get intermixed within the FIFO.

22.7.4.2 Bulk IN

For IN transfers (from device to host), software tags the last byte in a packet to mark the end-of-frame. When a transfer does not complete without errors, the hardware automatically forces the FIFO to return to the start of the current packet and re-send the data. User software is expected to write data to the FIFO data register in units of the associated endpoint's maximum packet size. The end-of-frame can be indicated through the WFR bit in the Endpoint n FIFO Control (USB EPn FCTRL) or via the end-of-frame tag signal from the DMA controller.

In the USB protocol, the last packet in a transfer is allowed to be short (smaller than endpoint's maximum packet size) or even zero length. To indicate a zero length packet, the software sets the ZLPS bit in the associated Endpoint n Status/Control. The ZLPS bit automatically clears after the zero length packet is successfully sent to the host.

The EOT interrupt asserts to indicate that the last packet of the IN transfer has completed. Software clears any pending interrupts (EOT and EOF) to begin the next data transfer.

22.7.5 Interrupt Traffic

Interrupt endpoints are a special case of bulk traffic. Interrupt endpoints are serviced on a periodic basis by the USB host. Interrupt endpoints are guaranteed to transfer one packet per polling interval. Therefore, an endpoint with an 8 byte packet size and serviced every 2 ms would move 16 Kb/sec across the USB.

The only difference between interrupt transfers and bulk transfers from the device standpoint is that every time an interrupt packet is transferred, regardless of size, the EOT interrupt asserts. The device driver software must service this interrupt packet before the next interrupt servicing interval to prevent the device from NAKing the poll.

Device driver software must ensure that the interrupt endpoint polling interval is longer than the device's interrupt service latency.

22.7.6 Isochronous Operations

Isochronous operations are a special case of USB traffic. Instead of guaranteeing delivery with unbounded latency, isochronous traffic flows over the bus at a guaranteed rate with no error checking.

22.7.6.1 Isochronous Transfers in a Nutshell

The USB host guarantees an endpoint exactly one isochronous packet per frame. Isochronous packets can range from 0 bytes to 1023 bytes. See the USB specification for more information on isochronous transfer.

Because isochronous packets can be as large as 1023 bytes, it is not practical to implement large FIFOs for each endpoint. Instead, the software drivers are responsible for keeping the FIFOs serviced. When an IN or OUT request is received on an isochronous endpoint, the software drivers must ensure that the correct amount of data can be transferred without emptying the FIFO. When the FIFO empties during an isochronous packet transfer, the host terminates the packet immediately and the device loses its time slot until the next USB frame.

Interrupt Services

For DMA access, the maximum packet size for isochronous endpoints is restricted by the endpoint's FIFO size. For programmed I/O, isochronous data packets can take any size from 0 to 1023 bytes.

To allow the driver software to maintain synchronization with the USB host, the <<BLOCK NAME>> maintains a register that holds the current USB frame number. An interrupt is asserted each time the frame number changes or when a specific USB frame number is received. The interrupts are maskable.

The EOT interrupt asserts for isochronous packet transfers when the UDC module reports that the packet data is error free. This can be used along with the EOF interrupt to determine when a transfer error of some sort occurs on an isochronous endpoint.

22.7.6.2 The SYNCH_FRAME Standard Request

The SYNCH_FRAME standard request allows synchronization between the USB host and device during isochronous operations. The command is passed through endpoint 0 as a device request and must be processed by the device driver software.

22.8 Interrupt Services

The USB module generates a number of interrupts to indicate situations requiring attention from the host. The types of interrupts are broken into two categories: USB general interrupts and Endpoint specific interrupts. These interrupts are discussed in this section, as well as missed interrupts and their behaviors.

22.8.1 USB General Interrupts

The USB general interrupts indicate such things as global configuration and status changes pertaining to the USB. All of these interrupts are maskable. When an event causes an interrupt condition to occur, and the corresponding bit in the interrupt mask register is zero, an interrupt signal asserts on the module's interface. Writing 1 to the associated bit in the interrupt register clears the interrupt. After a hard reset, all interrupts are masked by default. This section describes each of the USB General Interrupts.

22.8.1.1 MSOF—Missed Start-of-Frame

The MSOF interrupt is used to inform software that it did not service the SOF interrupt before another SOF interrupt was received.

22.8.1.2 SOF—Start-of-Frame

The SOF interrupt means that a start-of-frame token was received by the device. The current USB frame number can be read from the USB_FRAME register. The start-of-frame interrupt is usually used by isochronous devices to provide a stable timebase.

22.8.1.3 RESET_STOP—End of USB Reset Signaling

The RESET STOP interrupt means that reset signaling on the USB has stopped.

22-44 Freescale Semiconductor

22.8.1.4 RESET_START—Start of USB Reset Signaling

The RESET_START interrupt indicates that reset signaling on the USB has begun. When reset signaling is active on the USB, the device does not expect to receive any transactions on the bus. This interrupt results in a reset of the UDC into the powered state, however it does not cause any specific actions in the <<BLOCK NAME>> front-end logic. User software must clear any pending interrupts and ensure that the module is configured properly after the reset. This interrupt indicates the start of reset signaling. Status of the USB at any given moment can be verified by examining the USB STAT register.

Presence of USB reset signaling invalidates any transaction in progress. On detection of RESET_START, user software reads any remaining valid data from the receive FIFOs and flushes all others. When reset signaling is detected, user software must clear any pending interrupts and ensure that the module is configured properly after the reset.

22.8.1.5 WAKEUP—Resume (Wakeup) Signaling Detected

This interrupt asserts when resume signaling is detected on the USB. The device uses this interrupt to wake up from suspend mode and resume normal operations. This interrupt is independent of the clock to the USB module.

22.8.1.6 SUSP—USB Suspended

This interrupt asserts when the USB goes into suspend mode. Suspend mode occurs when the device fails to receive any traffic from the USB for a period of 6 ms. When suspend mode is detected, the device puts itself into a low power standby mode.

22.8.1.7 FRAME_MATCH—Match Detected in USB_FRAME Register

This interrupt asserts when the frame number programmed into the MATCH field of the USB_FRAME register is the same as the FRAME field of the USB_FRAME register. Isochronous pipes can use this interrupt for synchronization between the data source and sink.

22.8.1.8 CFG_CHG—Host Changed USB Device Configuration

This interrupt means that the USB host selected a different configuration or alternate interface. Software reads the USB STAT register to determine the current configuration and interfaces and reconfigures itself accordingly.

22.8.2 Endpoint Interrupts

The endpoint interrupts indicate requests for service by specific USB endpoints. All bits are maskable. Each endpoint's interrupt output is connected to a separate hardware interrupt line. When an event occurs that causes an interrupt condition to occur, and the corresponding bit in the interrupt mask register is zero, an interrupt signal asserts on the module's interface. Writing 1 to the associated bit in the interrupt register clears the interrupt.

22.8.2.1 FIFO_FULL

This interrupt asserts when the FIFO is full.

Interrupt Services

22.8.2.2 FIFO_EMPTY

This interrupt asserts when the FIFO is empty.

22.8.2.3 FIFO ERROR

This interrupt means some abnormal condition occurred in the FIFO. The cause of the error can be verified by reading the USB EPn FSTAT register associated with the FIFO that had the error.

22.8.2.4 FIFO_HIGH

Each FIFO has an alarm register. The FIFO_HIGH interrupt asserts when the number of free bytes in the FIFO is below the level specified by the alarm register.

22.8.2.5 FIFO LOW

Each FIFO has an alarm register. The FIFO_LOW interrupt asserts when the byte count in the FIFO is below the level specified by the alarm register.

22.8.2.6 EOT—End of Transfer

This interrupt asserts after the last data byte of a USB transfer crosses from the <<BLOCK NAME>> into the UDC module or vice versa. The end of a USB transfer is indicated by either a zero byte packet or by a data packet shorter than the maximum packet size for the endpoint.

The EOT never asserts along with the DEVREQ interrupt for setup packets. The EOT interrupt asserts after every interrupt packet transfer, every complete bulk data transfer and data phase of control transfer. The EOT interrupt generally asserts along with an EOF interrupt, although an EOT interrupt can occur without an EOF interrupt when a transfer terminates on a USB packet boundary. The EOT interrupt asserts for isochronous packet transfers when the UDC module reports that the packet data is error free. This can be used along with the EOF interrupt to determine when a transfer error of some sort occurs on an isochronous endpoint.

22.8.2.7 DEVREQ—Device Request

The Device Request (Setup Packet) interrupt means that the most recently received packet was a setup or device request packet. Software on the USB device must decode and respond to the packet to complete a Vendor, Class, or Standard request.

22.8.2.8 MDEVREQ—Multiple Device Request

The Multiple Device Requests indicator asserts when two or more setup packets have been received before the DEVREQ interrupt was cleared. This interrupt is used to determine when the USB host has aborted a transfer in progress. In this case, the device receives a setup packet, followed by a new setup packet before it has completed processing of the original command.

22-46 Freescale Semiconductor

22.8.2.9 EOF—End of Frame

This interrupt means that an end-of-frame marker was sent or received on the FIFO/UDC interface. This interrupt asserts when a DEVREQ is received for bulk, control, isochronous, and interrupt data. While packet retries are not supported for isochronous endpoints, the end-of-frame indicator is still valid and can be used along with the SOF interrupt to control data flow.

22.8.3 Interrupts, Missed Interrupts, and the USB

Improper operation of the device can result when interrupts are not serviced in a timely manner. For example, a CFG_CHG interrupt is received, the device does not service it, and another CFG_CHG interrupt is received. This could leave the device in an incorrect operating mode. The interrupts of concern in this manner are SOF, CFG_CHG, EOT, and DEVREQ. The missed-interrupt behaviors are discussed in the following subsections.

22.8.3.1 SOF

When the device misses a start-of-frame interrupt, the MSOF bit asserts in the USB_INTR register.

22.8.3.2 CFG_CHG

When the device receives a CFG_CHG interrupt, the module NAKs all traffic from the USB host until software clears the interrupt bit. This prevents the device configuration from getting out of sync with what the host has requested.

22.8.3.3 EOT

When an end-of-transfer is received on a BULK OUT endpoint, the device NAKs all traffic on that endpoint until software clears the interrupt bit. This prevents data from two different transfers from becoming mixed up in a FIFO

22.8.3.4 **DEVREQ**

When a device request is received, the device NAKs all IN/OUT traffic on the affected endpoint until software clears the interrupt bit. This ensures that the device correctly identifies the setup packet in the FIFO and can clear the FIFO before the data phase is allowed to begin. When multiple setup packets are received, the MDEVREQ interrupt asserts.

22.9 Reset Operation

The USB module includes four reset modes: Hard Reset, Software Reset, UDC reset and USB Reset signaling.

The UDC reset allows software to force a hard reset of the UDC module only, leaving all register bits in the front-end logic intact. A UDC reset is normally used only as a debug option, however it can also be used in the event of a connect/disconnect bus event. A hard reset requires that MCU PLL and System PLL be locked.

Reset Operation

22.9.1 Hard Reset

A hard reset is generated from the USB module's bus interface, and resets all storage elements in both the front-end logic and in the UDC module. A hard reset also issues a UDC reset. Both the MCU PLL and System PLL must be locked before issuing a Software Reset.

22.9.2 USB Software Reset

The USB device allows the reset of all the storage elements in both the front-end logic and in the UDC module through the RST bit in the USB_ENAB register. On initial power-up, the user issues a Software reset. This causes the module to be enabled and the internal logic to be reset. Both the MCU PLL and USB PLL must be locked before issuing a Software Reset.

22.9.3 UDC Reset

A UDC reset is accomplished by setting the UDC_RST bit in the USB Control (USB_CTRL.) The UDC must be reset any time a connect/disconnect occurs on the USB. Any time the device is plugged in or unplugged from the USB, software must initiate either a hard reset or a UDC reset to ensure that the module can properly communicate with the USB host. Reset signaling is discussed in chapter 7 of the USB Specification. UDC Reset can invalidate data remaining in the data FIFOs. Depending on the application, software might need to flush the data FIFOs before proceeding.

22.9.4 USB Reset Signaling

Reset signaling can occur on the USB for a number of reasons. When the device receives reset signaling, it means that the host is preparing to re-enumerate the bus. All transactions in progress must be invalidated, and the device software prepared to receive configuration changes.

Because the device can contain valid, but as-yet unread, data in the FIFOs when USB reset signaling occurs, the hardware does not flush the FIFOs. When device software receives reset signaling, it completes reading any unread data from the FIFOs and execute FIFO flush operations on all of the FIFOs. This guarantees that the datapath is empty and ready for new data transfer operations when reset signaling and re-enumeration are complete.

22-48 Freescale Semiconductor

Chapter 23 I²C Module

23.1 Overview

I²C is a two-wire bidirectional serial bus that provides a simple and efficient method of data exchange while minimizing the interconnection between devices. This bus is most suitable for applications requiring occasional communication between many devices in close proximity. The flexible I²C bus allows additional devices to be connected to the bus for expansion and system development.

The I²C system is a true multiple-master bus. It features collision and arbitration detection to prevent data corruption when multiple devices attempt to control the bus simultaneously. This allows for complex applications with multiprocessor control and can support rapid testing and alignment of end products through external connections to an assembly-line computer.

23.2 Interface Features

The following are key features of the I²C module:

- Compatible with the I²C bus standard
- Supports 3.3V tolerant devices
- Multiple-master operation
- Software programmable clock frequencies (supports 64 different frequencies)
- Software selectable acknowledge bit
- Interrupt driven, byte-by-byte data transfer
- Arbitration lost interrupt with automatic switching from master to slave mode
- Calling address identification interrupt
- START and STOP signal generation and detection
- Repeated START signal generation
- Acknowledge bit generation and detection
- · Bus-busy detection

Figure 23-1 on page 23-2 shows a block diagram of the I²C module.

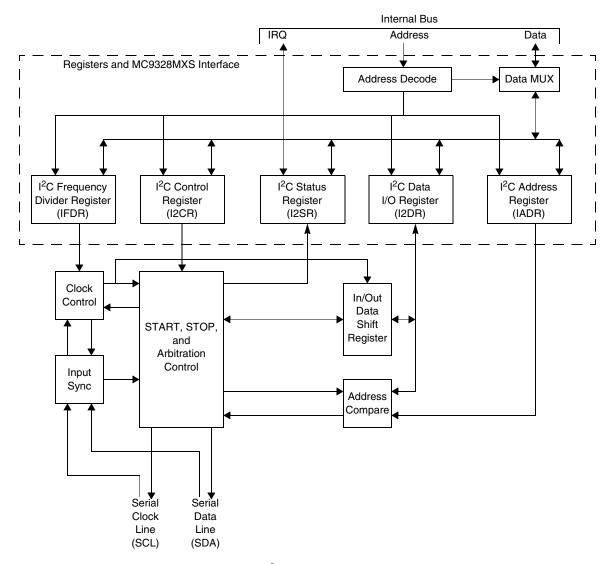


Figure 23-1. I²C Module Block Diagram

23.3 I²C System Configuration

The I²C module uses a serial data line (SDA) and a serial clock line (SCL) for data transfer. For I²C compliance, all devices connected to these two signals must have open drain or open collector outputs. (There is no such requirement for inputs.) The logic AND function is exercised on both lines with external pull-up resistors.

The default state of the I²C is slave receiver. When not programmed to be a master or responding to a slave transmit address, the I²C module always returns to the default state. Exceptions are described in Section 23.7.1, "Initialization Sequence."

NOTE:

The I²C module is designed to be compatible with *The I*²C *Bus Specification*, Version 2.1 (Philips Semiconductor: 2000). For detailed information on system configuration, protocol, and restrictions, see the Philips I²C standard.

MC9328MXS Reference Manual, Rev. 1

23-2 Freescale Semiconductor

23.4 I²C Protocol

The I²C communication protocol consists of six components: START, Data Source/Recipient, Data Direction, Slave Acknowledge, Data, Data Acknowledge and STOP. These are shown in Figure 23-2 and described in the text following the figure.

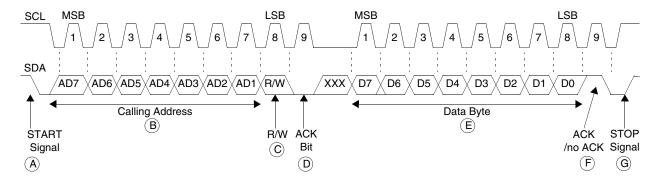


Figure 23-2. I²C Standard Communication Protocol

- START (A)—When the bus is free (both the SCL and the SDA lines are at logic high), a device can initiate communication by sending a START signal. This is defined as a high-to-low transition of SDA while SCL is high. This signal denotes the beginning of a data transfer and awakens all the slave devices on the bus.
- **Data Source/Recipient (B)**—The master sends out the 7-bit address of the slave that it intends to transfer data to or receive data from. Each slave must have a unique address. An I²C master cannot transmit to its own slave address—a device cannot be master and slave at the same time.
- **Data Direction (C)**—This single bit sets the data transfer direction.
- Acknowledge (D)—The addressed slave device responds to the master by returning an acknowledge bit. This is defined as the SDA line pulled low on the ninth clock after the START signal. This acknowledge is independent of the values of the Acknowledge Enable bit in the Control Register.
- Data (E)—The data transfer is done on a byte-by-byte basis in the direction specified by the Data Direction bit. Data can be changed only while the SCL is low and must be held stable while the SCL is high. The SCL is pulsed once for each data bit and the most significant bit (MSB) is sent first.
- Acknowledge (F)—The receiving device must acknowledge each byte by pulling the SDA low on the ninth clock, so a data byte transfer takes nine clock pulses. For multi-byte data transactions, an end-of-data condition is indicated when the receiver does not send an acknowledge.

When the master transmits data to the slave and the slave does not acknowledge the master, this indicates an end-of-data condition to the master. The SDA line is left high and the master can generate a STOP signal to abort the data transfer or generate a START signal (repeated START, shown in Figure 23-3 on page 23-4) to restart the transfer.

When the master receives data from the slave and the master does not acknowledge the slave, this indicates an end-of-data condition to the slave. The slave releases the SDA and the master generates a STOP or START signal.

• STOP (G)—A STOP signal is sent to free the bus after data is transmitted or when the master stops communication. A STOP signal is defined as a low-to-high transition of the SDA while the SCL is at logical high.

NOTE:

A master can generate a STOP even when the slave sent an acknowledge. The slave must release the bus.

• Repeated START (H)—Instead of sending a STOP signal, the master can repeat the START signal and the rest of the communication protocol. When a START signal is generated without a preceding STOP signal, a repeated START occurs. This is shown in Figure 23-3. The master generates a repeated START to communicate with another slave or with the same slave in a different mode (transmit/receive mode) without releasing the bus.

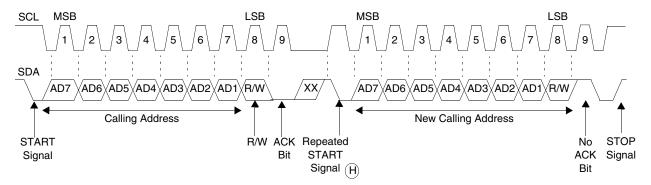


Figure 23-3. Repeated START

23.4.1 Clock Synchronization

When multiple devices simultaneously request the bus, the bus clock is determined by a synchronization procedure in which the clock lines from the individual devices are compared. The system clock line (SCL) is the result of an AND operation on all individual clock lines.

After the master drives the SCL low, the internal clocks begin counting their low periods. By performing an AND operation, the system clock stays low until ALL of the individual device clocks on the bus have transitioned to the high state. At this point, the individual clocks begin counting their high periods. The system clock remains high until ANY of the device clocks on the bus transition to the low state.

As a result, the devices with the longest low periods and shortest high periods control the SCL.

Devices with shorter low periods transition to high before the SCL transitions. This wait is shown in Figure 23-4.

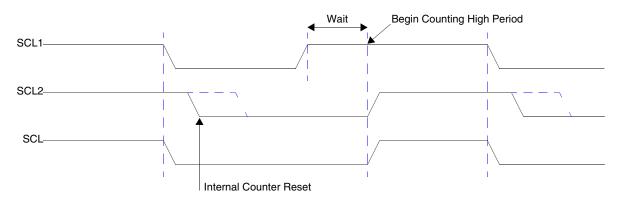


Figure 23-4. Synchronized Clock SCL

MC9328MXS Reference Manual, Rev. 1

23-4 Freescale Semiconductor

23.4.2 Arbitration Procedure

The relative priority of competing devices is determined by a data arbitration procedure. A device loses arbitration when it sends a logic high while another device sends a logic low. The device that loses arbitration immediately switches to slave-receive mode, stops driving SDA, and sets the Arbitration Lost (IAL) bit in its I²C Status Register (I2SR). In this case, the transition from master to slave mode does not generate a STOP condition.

23.4.3 Handshaking

Clock synchronization can function as a handshake in data transfers. When slave devices hold the SCL low after completing a one byte transfer (9 bits), the clock synchronization feature halts the bus clock and forces the master clock into a wait state until the slave releases the SCL.

23.4.4 Clock Stretching

Clock synchronization allows slaves to slow down the transfer bit rate. After the master drives the SCL low, the slave can hold the SCL low. When the slave SCL low period is longer than the master SCL low period, the SCL bus signal low period is stretched.

23.5 Pin Configuration for I²C

Two pins are available for the I²C module. These pins are multiplexed with other functions on the device and must be configured for SPI operation.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Table 23-1. Pin Configuration

Pin	Setting	Configuration Procedure
I2C_SCL	I ² C CLOCK—This pin is open-drain when not in GPIO. This is the primary function of GPIO Port A [16].	Clear bit 16 of Port A GPIO In Use Register (GIUS_A) Clear bit 16 of Port A General Purpose Register (GPR_A)
I2C_SDA	I ² C Data—This pin is open-drain when not in GPIO. This is the primary function of GPIO Port A [15].	Clear bit 15 of Port A GPIO In Use Register (GIUS_A) Clear bit 15 of Port A General Purpose Register (GPR_A)

23.6 Programming Model

The I^2C module includes five 32-bit registers. Table 23-2 summarizes these registers and their addresses.

Table 23-2. I²C Module Register Memory Map

Description	Name	Address
I ² C Address Register	IADR	0x00217000
I ² C Frequency Divider Register	IFDR	0x00217004
I ² C Control Register	I2CR	0x00217008
I ² C Status Register	I2SR	0x0021700C
I ² C Data I/O Register	I2DR	0x00217010

23.6.1 I²C Address Register

The I²C Address Register (IADR) holds the address to which the I²C responds when addressed as a slave.

NOTE

As part of the I²C communications protocol, the master sends out the 7-bit address of the slave it intends to transfer data to or receive data from. When the MC9328MXS is the bus master, the address it sends out is the address of its intended slave device. It is NOT the address in this register. This value is only referenced when another device is bus master and it intends to communicate with the MC9328MXS.

IADR	I ² C Address Register													Addr 0x00217000		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
												ADR				
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	000							

Table 23-3. I²C Address Register Description

Name	Description
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.
ADR Bits 7–1	Slave Address—Contains the specific slave address to be used by the I ² C module. Slave mode is the default I ² C mode for an address match on the bus.
Reserved Bit 0	Reserved—This bit is reserved and should read 0.

23.6.2 I²C Frequency Divider Register

The I^2C Frequency Divider Register (IFDR) holds the prescaler value that configures the clock for bit-rate selection.

IFDR					I ² C	Freq	uenc	y Div	ider I	Regis	ster			Addr 0x00217004			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET								0x00	000								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
													I	С			
TYPE	r	r	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET								0x00	00								

Table 23-4. IFDR Register Description

Name	Description	Settings
Reserved Bits 31–6	Reserved—These bits are reserved and should read 0.	
IC Bits 5–0	I ² C Clock Rate Divider—Prescales the clock for bit-rate selection. Due to potentially slow rise and fall times of SCL and SDA, bus signals are sampled at the prescaler frequency. The input clock from the PLL is HCLK. The serial bit clock for the I ² C module is HCLK divided by the divider shown in Table 23-5. Note: The IC value can be changed at any point.	See Table 23-5 on page 23-9.

Table 23-5. HCLK Dividers

IC	Divider	IC	Divider	IC	Divider	IC	Divider
0x00	30	0x10	288	0x20	22	0x30	160
0x01	32	0x11	320	0x21	24	0x31	192
0x02	36	0x12	384	0x22	26	0x32	224
0x03	42	0x13	480	0x23	28	0x33	256
0x04	48	0x14	576	0x24	32	0x34	320
0x05	52	0x15	640	0x25	36	0x35	384
0x06	60	0x16	768	0x26	40	0x36	448
0x07	72	0x17	960	0x27	44	0x37	512
0x08	80	0x18	1152	0x28	48	0x38	640
0x09	88	0x19	1280	0x29	56	0x39	768
0x0A	104	0x1A	1536	0x2A	64	0x3A	896
0x0B	128	0x1B	1920	0x2B	72	0x3B	1024
0x0C	144	0x1C	2304	0x2C	80	0x3C	1280
0x0D	160	0x1D	2560	0x2D	96	0x3D	1536
0x0E	192	0x1E	3072	0x2E	112	0x3E	1792
0x0F	240	0x1F	3840	0x2F	128	0x3F	2048

23.6.3 I²C Control Register

The I^2C Control Register (I2CR) enables the I^2C module and the I^2C interrupt. This register also contains bits that select whether the device operates as a slave or a master.

I2CR		I ² C Control Register												Addr 0x00217008		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x0	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
									IEN	IIEN	MSTA	MTX	TXAK	RSTA		
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	$\overline{0}$	0	ō
NESEI								0x0	000							

Table 23-6. I²C Control Register Description

Name	Description	Settings
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.	
IEN Bit 7	I ² C Enable—Controls the software reset of the entire I ² C module. When the module is enabled in the middle of a byte transfer, slave mode ignores the current bus transfer and begins operating whenever a subsequent START condition is detected. Master mode is not aware that the bus is busy, so when a START cycle is initiated, the current bus cycle can	0 = Disable the I ² C module (registers can still be accessed) 1 = Enable the I ² C module (this bit must be set before any other I2CR bits have any effect)
	become corrupted and cause either the current bus master or the I ² C module to lose arbitration, after which bus operation returns to normal.	
IIEN Bit 6	I ² C Interrupt Enable—Enables the I ² C interrupts.	0 = Disable the I ² C module interrupts (currently pending interrupt conditions are not cleared) 1 = Enable the I ² C module interrupts (an I ² C interrupt occurs when the I ² C interrupt (IIF) bit in the I2SR Register is also set)
MSTA Bit 5	Master/Slave Mode Select—Selects master or slave mode operation. When the device loses arbitration while running in master mode, MSTA is cleared without generating a STOP signal.	0 = Slave mode (changing MSTA from 1 to 0 generates a STOP and selects slave mode) 1 = Master mode (changing MSTA from 0 to 1 signals a START on the bus and selects master mode)

MC9328MXS Reference Manual, Rev. 1

23-10 Freescale Semiconductor

Table 23-6. I²C Control Register Description (continued)

Name	Description	Settings
MTX Bit 4	Transmit/Receive Mode Select —Selects the direction of master and slave transfers.	0 = Receive 1 = Transmit
	Note: When a slave is addressed during transmit mode, software sets MTX according to the Slave Read/Write (SRW) bit in the I2SR Register. In master mode, MTX is set according to the type of transfer required. Therefore, for address cycles, MTX is always set for master mode and cleared for slave mode.	
TXAK Bit 3	Transmit Acknowledge Enable—Specifies the value driven onto SDA during data acknowledge cycles for both master mode and slave mode receivers.	0 = Sends an acknowledge signal to the bus at the ninth clock bit after receiving one byte of data 1 = No acknowledge signal response is sent (the data acknowledge bit in the protocol = 1)
	Note: TXAK applies only when the I ² C bus is a receiver.	acknowledge bit in the protocol = 1)
RSTA Bit 2	Repeated START—Generates a repeated START condition. This bit always reads 0. Attempting a repeated START without bus mastership causes loss of arbitration.	0 = No repeated START 1 = Generates a repeated START
Reserved Bits 1–0	Reserved—These bits are reserved and should read 0.	•

23.6.4 I²C Status Register

The I^2C Status Register (I2SR) indicates transaction direction and status.

I2SR	I ² C Status Register													Addr 0x0021700C		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
									ICF	IAAS	IBB	IAL		SRW	IIF	RXAK
TYPE	r	r	r	r	r	r	r	r	r	r	r	rw	r	r	rw	r
DECET	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1
RESET								0x00	81							

Table 23-7. I2SR Register Description

Name	Description	Settings
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.	
ICF Bit 7	Data Transfer —Indicates data transfer condition. ICF is cleared while one byte of data is transferred.	0 = Transfer in progress 1 = Transfer complete (set at the falling edge of the ninth clock of a byte transfer)
IAAS Bit 6	I ² C Addressed As a Slave—Indicates that the device slave address matches the address sent on the data line. When the I ² C Enable (IIEN) bit in the I2CR Register is set, an interrupt is generated to the ARM9 core when this match occurs. The ARM9 core must check the Slave Read/Write (SRW) bit and set the Transmit/Receive Mode Select (MTX) bit of the I2CR Register accordingly. Writing to the I2CR Register clears this bit.	0 = Not addressed 1 = Addressed as a slave (set when the MC9328MXS slave address in the IADR Register matches the calling address)
IBB Bit 5	I ² C Bus Busy—Indicates the status of the bus. When a STOP signal is detected, IBB is cleared, and when a START signal is detected, IBB is set.	0 = Bus is idle 1 = Bus is busy
IAL Bit 4	Arbitration Lost—Indicates that this device will not operate as bus reset by the hardware in the following circumstances: • SDA samples low when the master drives high during an ad • SDA samples low when the master drives high during the acc • A START is attempted when the bus is busy • A repeated START is requested in slave mode • A STOP condition is detected when the master did not reque	dress or data-transmit cycle cknowledge bit of a data-receive cycle
Reserved Bit 3	Reserved—This bit is reserved and should read 0.	
SRW Bit 2	Slave Read/Write—Indicates the value of the R/W command bit of the I ² C protocol when the device is the addressed as a slave (IAAS bit is set). SRW is valid only when a complete transfer occurs, no other transfers have been initiated, and the I ² C module is a slave with an address match.	0 = Slave receiver, master writing to slave 1 = Slave transmitter, master reading from slave
IIF Bit 1	 I²C interrupt—Indicates an interrupt condition. Cleared by writing 0 in the interrupt routine. Set when one of the following occurs: Completion of one byte transfer (set at the falling edge of the ninth clock) Calling address matches MC9328MXS slave address Arbitration is lost 	0 = No I ² C interrupt pending 1 = An interrupt is pending, which causes a processor interrupt request (when IIEN = 1).
RXAK Bit 0	Received Acknowledge—Indicates whether an acknowledge signal (to the data) was received on SDA.	0 = An acknowledge signal was received after the completion of 8-bit data transmission on the bus 1 = No acknowledge signal was detected at the ninth clock

MC9328MXS Reference Manual, Rev. 1

23-12 Freescale Semiconductor

23.6.5 I²C Data I/O Register

The I²C Data I/O Register (I2DR) contains the data received or the data to be transmitted during I/O operations. In transmission mode, this value is sent out after the receiving device sends an acknowledge signal. In master-receive mode, the last byte received is held in this register. Reading this register initiates the transfer of the next byte of receive data. In slave mode, the same function is available after the device is addressed.

I2DR		I ² C Data I/O Register														Addr 0x00217010			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
NESET								0x00	000										
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
													D						
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw			
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0			
RESET								0x00	00										

Table 23-8. I2DR Register Description

Name	Description
Reserved Bits 31–8	Reserved—These bits are reserved and should read 0.
D Bits 7–0	I ² C Data—Holds last data byte received or next data byte to be transferred.

23.7 I²C Programming Examples

This section describes programming sequences for I^2C , including initialization, START signalling, post-transfer software response, STOP signalling, and repeated START generation. The flowchart in Figure 23-5 on page 23-16 illustrates an interrupt routine.

I²C Programming Examples

23.7.1 Initialization Sequence

The registers must be initialized before the interface can transfer serial data. The procedure to initialize the registers is as follows:

- 1. Set the Clock Rate Divider (IC field) in the I²C Frequency Divider Register (IFDR) for the appropriate SCL frequency.
- 2. Write the device slave address in the I²C Address Register (IADR).
- 3. Enable the I²C module by setting the I²C Enable bit (IEN) in the I²C Control Register (I2CR).
- 4. Modify the bits in the I²C Control Register (I2CR) to select master/slave mode, transmit/receive mode, and interrupt enable/disable.

NOTE:

Before enabling the I^2C module, ensure that another communication is not in progress by verifying that the I^2C Bus Busy bit (IBB) of the I^2C Status Register (I2SR) is cleared. When it is not cleared, execute the following code sequence to force the slave device into an idle condition by issuing a STOP command before enabling the I^2C module.

23.7.2 Generation of START

After the initialization procedure is complete and the serial bus is free, the MC9328MXS transmits serial data by selecting the master transmitter mode. The IBB bit in the I2SR Register indicates the bus condition. When the bus is free (IBB bit in the I2SR Register = 0), the START signal and the slave address can be sent. The address of the appropriate slave is written to the I^2C Data I/O Register (I2DR), where the least significant bit (LSB) indicates the transfer direction.

The bus free time between a STOP signal and the next START signal is built into the hardware that generates the START. Depending on the relative frequencies of the system clock and the SCL period, it is sometimes necessary to wait after writing the calling address to the I2DR before proceeding with the following instructions.

23.7.3 Post-Transfer Software Response

When one byte is sent or received, the Data Transfer (ICF) and the I²C Interrupt (IIF) bits in the I²C Status Register (I2SR) are set. An interrupt occurs when interrupts are enabled by the IIEN bit of the I²C Control Register (I2CR).

First, the software must clear IIF in the interrupt routine. ICF is cleared either by reading the data from the I²C Data I/O Register (I2DR) in receive mode or by writing to the I2DR in transmit mode. Clearing ICF triggers the start of the next communication byte.

The software can service the I²C I/O in the main program by disabling the interrupts (clear IIEN) and polling the IIF bit.

When an interrupt occurs at the end of the address cycle, the master is still in transmit mode. When master receive mode is required, toggle the MTX bit in the I2CR Register.

When the device is functioning as the addressed slave (the IAAS bit in the I2SR is set), the SRW bit in the I2SR Register is read to determine the direction of the next transfer, and MTX is programmed accordingly. For slave-mode data cycles (IAAS = 0), the SRW bit is invalid. The MTX bit is read to determine the current transfer direction.

23-14 Freescale Semiconductor

The following is an example of a software response by a master transmitter in the interrupt routine (see Figure 23-5 on page 23-16).

23.7.4 Generation of STOP

A data transfer ends when the master signals a STOP, which can occur after all data is sent. When the master receiver intends to terminate a data transfer, it must inform the slave transmitter by not acknowledging the last data byte. This is done by setting the TXAK bit in the I2CR Register before reading the next-to-last byte. Before the last byte is read, a STOP signal must be generated.

23.7.5 Generation of Repeated START

After the data transfer is complete, the master can retain control of the bus by issuing a repeated START. Instead of sending a STOP signal, the master sends another START signal and sends out another slave calling address. See Figure 23-3 on page 23-4 for more information.

23.7.6 Slave Mode

When another device initiates communication on the bus, the MC9328MXS I²C module must verify whether it is addressed as the slave device by checking the I²C Addressed as a Slave bit (IAAS) in the I2SR Register. When IAAS is set, the software reads the SRW bit in the I2SR Register and sets the Transmit/Receive Mode Select bit (MTX) in the I2CR Register accordingly. Writing to the I2CR Register clears the IAAS bit automatically. The IAAS bit is set only at the end of the address cycle, even when there are multiple data bytes transferred.

Initiate a data transfer by writing data to the I2DR Register for slave transmits, or by reading data from the I2DR Register in slave receive mode. A dummy read of the I2DR Register in slave receive mode releases the SCL, allowing the master to send data.

In the slave transmitter routine, the Receive Acknowledge bit (RXAK) in the I2SR Register must be tested before sending the next byte of data. When RXAK is high, the master receiver intends to terminate the data transfer. The software must switch the MC9328MXS from transmitter to receiver mode. Reading the I2DR Register releases the SCL so the master can generate a STOP signal.

23.7.7 Arbitration Lost

When several devices try to engage the bus at the same time, one becomes the master and the hardware immediately switches the other devices to slave receive mode. Data output to the SDA line stops, however the serial clock continues to be generated until the end of the byte during which arbitration is lost. An interrupt occurs at the falling edge of the ninth clock of this transfer.

When a device that is not a master tries to transmit or generate a START, hardware automatically clears the Master/Slave Mode Select bit (MSTA) in the I2CR Register without signalling a STOP, generates an interrupt to the ARM920T processor, and sets the Arbitration Lost bit (IAL) in the I2SR Register to indicate a failed attempt to engage the bus. The slave service routine must first test the IAL bit and clear it when it is set.

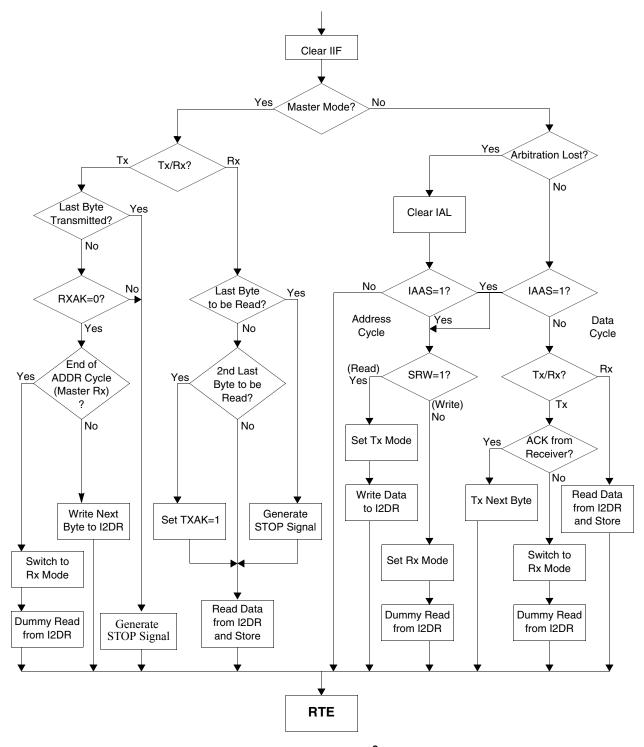


Figure 23-5. Flow Chart of Typical I²C Interrupt Routine

23-16 Freescale Semiconductor

Chapter 24 Synchronous Serial Interface (SSI)

24.1 Introduction

This chapter describes the Synchronous Serial Interface (SSI) and provides descriptions of the architecture, programming model, operating modes, and initialization procedures of SSI module. The SSI is a full-duplex serial port that allows the MC9328MXS to communicate with a variety of serial devices. These serial devices include standard codecs, digital signal processors (DSPs), microprocessors, peripherals that implement the Motorola Serial Peripheral Interface (SPI), and popular industry audio codecs that implement the inter-IC sound bus standard (I²S).

The SSI typically transfers samples in a periodic manner. The SSI consists of independent transmitter and receiver sections with independent clock generation and frame synchronization functions.

The capabilities of the SSI include:

- Independent (asynchronous) or shared (synchronous) transmit and receive sections with separate or shared internal/external clocks and frame syncs, operating as master or slave
- Normal mode operation using frame sync
- Network mode operation allowing multiple devices to share the port with as many as 32 time slots
- Gated clock mode operation requiring no frame sync
- Programmable internal clock divider
- Programmable data interface modes such as I²S, left-, and right-justified
- Programmable word length (8, 10, 12, or 16 bits)
- Program options for frame sync and clock generation
- Programmable I²S mode (master, slave, or normal) selection
- Completely separate clock and frame sync selections for the receive and transmit sections
- Programmable oversampling output clock SYS_CLK (PerCLK3) of the sampling frequency in master mode which is available at the SSI_RXCLK pin when operated in sync mode.
- SSI power-down feature
- SSI signals are connected to Port B or Port C I/O pins

24.2 SSI Architecture

Figure 24-1 shows that the SSI functions can use Port B or Port C pins. For SSI output signals, the signal appears on both pins. However, SSI input or bidirectional signals require that the user configure one of the ports for the signal. This is done by setting up the desired pin in the Function Muxing Control Register (FMCR) in the system control module and then setting up the GPIO pins appropriately for Primary/Alternate and GPIO/Peripheral functions. For more information, see Section 24.2.3, on page 24-5.

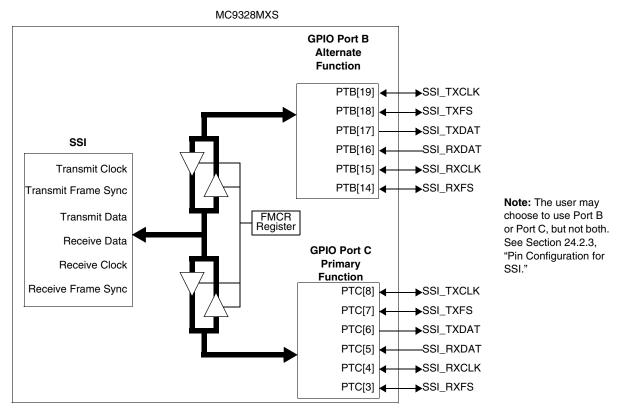


Figure 24-1. MC9328MXS SSI Input/Output Block Diagram

Figure 24-2 shows a block diagram of the SSI module. The SSI modules uses three control registers to configure the port, one status register, separate transmit and receive circuits with FIFO registers, and separate serial clock and frame sync generation for the transmit and receive sections.

24-2 Freescale Semiconductor

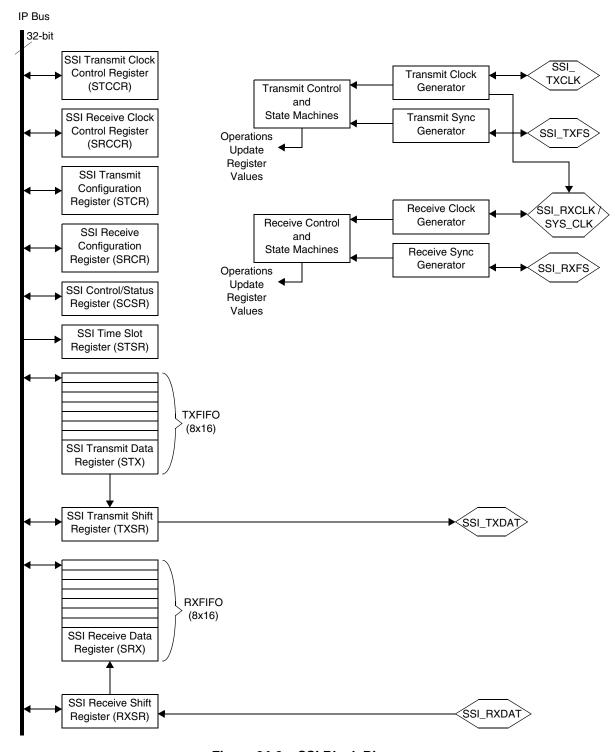


Figure 24-2. SSI Block Diagram

SSI Architecture

24.2.1 SSI Clocking

The SSI uses the following clocks:

- Serial bit clock—Serially clocks the data bits in and out of the SSI port
- Word clock—Counts the number of data bits per word (8, 10, 12, or 16 bits)
- Frame clock—Counts the number of words in a frame
- SYS_CLK—Input Clock from the PLL Clock Controller Module (PerCLK3). Made available on an output pin in synchronous master mode.

24.2.1.1 Normal Operating Mode

In normal operating mode, when the I²S Mode Select bits (I2S_MODE1 and I2S_MODE0) in the SSI Control/Status Register (SCSR) are both clear, the serial bit clock is available on the serial transmit clock (SSI_TXCLK) and serial receive clock (SSI_RXCLK) pins. The word clock is an internal clock that determines when transmission of an 8-, 10-, 12-, or 16-bit word is complete. The word clock also clocks the frame clock, which counts the number of words in the frame. The frame sync clock is available on the SSI_TXFS and SSI_RXFS frame sync pins because a frame sync is generated after the correct number of words in the frame are transmitted/received. See Section 24.5, "SSI Operating Modes," on page 24-38 for a detail description about the SSI operating modes.

24.2.1.2 Master / Synchronous Mode

In master mode and synchronous mode, the unused SSI_RXCLK pin outputs the serial system clock (SYS_CLK) enabled by the SYS_CLK_EN bit in the SSI Control/Status Register (SCSR). The SYS_CLK (PerCLK3) is the input clock into the SSI module. The SSI Clock Generator uses the word length (WL), prescaler range (PSR), prescaler modulus select (PM), and frame rate divider control (DC) to generate the other clocks from SYS_CLK (PerCLK3). The relationship between the clocks and the dividers is shown in Figure 24-3. A serial bit clock may be received from a SSI clock pin or can be generated internally from the PerCLK3 clock by a series of dividers, as shown in Figure 24-4.

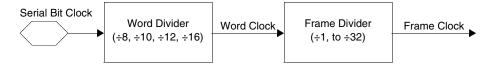


Figure 24-3. SSI Clocking

24.2.2 SSI Clock and Frame Sync Generation

Data clock and frame sync signals are generated internally by the MC9328MXS or can be obtained from external sources. When generated internally, the SSI clock generator derives bit clock and frame sync signals from an input clock signal. The SSI clock generator consists of a selectable, fixed prescaler and a programmable prescaler for bit rate clock generation. In gated clock mode, the data clock is valid only when data is being transmitted. If the pull-up is disabled for this pin in the GPIO Module's Pull-Up Enable Register, then the clock pin is tri-stated when data is not transmitting.

A programmable frame rate divider and a word length divider are used for frame rate sync signal generation.

24-4 Freescale Semiconductor

Figure 24-4 on page 24-5 shows a block diagram of the clock generator for the transmit section. Whether the serial bit clock is generated internally or derived from an external source depends on the transmit direction bit in the SSI Transmit Configuration Register (STCR). The receive section contains a similar clock generator circuit. However, for the receiver, because SSI_RXCLK is used for the receive clock, SYS_CLK (PerCLK3) is not made available on any output pins.

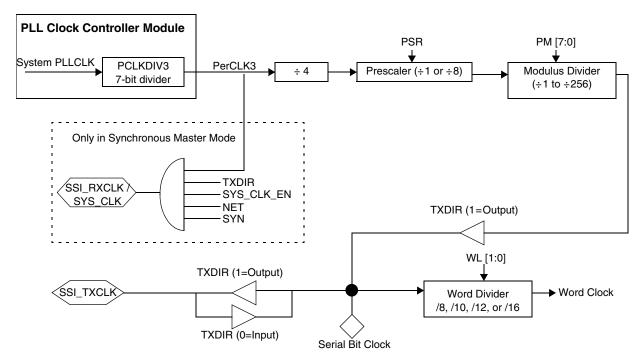


Figure 24-4. SSI Transmit Clock Generator Block Diagram

Figure 24-5 shows the frame sync generator block for the transmit section. When generated internally, both receive and transmit frame sync signals are generated from the word clock and are defined by the DC and WL bits of the SSI Transmit Clock Control Register (STCCR). The receive section contains an equivalent circuit for the frame sync generator.

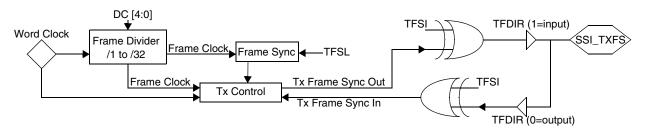


Figure 24-5. SSI Transmit Frame Sync Generator Block Diagram

24.2.3 Pin Configuration for SSI

Figure 24-1 illustrates the pins used for the SSI module. Table 24-1 on page 24-6 provides the pin configuration for the SSI module. These pins are multiplexed with other functions on the device, and must be configured for SSI operation.

NOTE:

The user must ensure that the data direction bits in the GPIO are set to the correct direction for proper operation. See Section 25.5.1, "Data Direction Registers," on page 25-8 for details.

Table 24-1. SSI Pin Configuration

Pin	Setting ¹	Configuration Procedure
SSI_TXCLK	Primary function of GPIO Port C [8]	Clear bit 8 of Port C GPIO In Use Register (GIUS_C) Clear bit 8 of Port C General Purpose Register (GPR_C) Clear bit 3 in the Function Muxing Control Register (FMCR) in the System Control Module
	Alternate function of GPIO Port B [19]	Clear bit 19 of Port B GPIO In Use Register (GIUS_B) Set bit 19 of Port B General Purpose Register (GPR_B) Set bit 3 in the Function Muxing Control Register (FMCR) in the System Control Module
SSI_TXFS	Primary function of GPIO Port C [7]	Clear bit 7 of Port C GPIO In Use Register (GIUS_C) Clear bit 7 of Port C General Purpose Register (GPR_C) Clear bit 4 in the Function Muxing Control Register (FMCR) in the System Control Module
	Alternate function of GPIO Port B [18]	Clear bit 18 of Port B GPIO In Use Register (GIUS_B) Set bit 18 of Port B General Purpose Register (GPR_B) Set bit 4 in the Function Muxing Control Register (FMCR) in the System Control Module
SSI_TXDAT	Primary function of GPIO Port C [6]	Clear bit 6 of Port C GPIO In Use Register (GIUS_C) Clear bit 6 of Port C General Purpose Register (GPR_C) (This is an output-only pin and therefore does not require a control signal in the Function Muxing Control Register (FMCR))
	Alternate function of GPIO Port B [17]	Clear bit 17 of Port B GPIO In Use Register (GIUS_B) Set bit 17 of Port B General Purpose Register (GPR_B) (This is an output-only pin and therefore does not require a control signal in the Function Muxing Control Register (FMCR))
SSI_RXDAT	Primary function of GPIO Port C [5]	Clear bit 5 of Port C GPIO In Use Register (GIUS_C) Clear bit 5 of Port C General Purpose Register (GPR_C) Clear bit 5 in the Function Muxing Control Register (FMCR) in the System Control Module
	Alternate function of GPIO Port B [16]	Clear bit 16 of Port B GPIO In Use Register (GIUS_B) Set bit 16 of Port B General Purpose Register (GPR_B) Set bit 5 in the Function Muxing Control Register (FMCR) in the System Control Module

24-6 Freescale Semiconductor

Table 24-1. SSI Pin Configuration (continued)

Pin	Setting ¹	Configuration Procedure
SSI_RXCLK	Primary function of GPIO Port C [4]	Clear bit 4 of Port C GPIO In Use Register (GIUS_C) Clear bit 4 of Port C General Purpose Register (GPR_C) Clear bit 6 in the Function Muxing Control Register (FMCR) in the System Control Module
	Alternate function of GPIO Port B [15]	Clear bit 15 of Port B GPIO In Use Register (GIUS_B) Set bit 15 of Port B General Purpose Register (GPR_B) Set bit 6 in the Function Muxing Control Register (FMCR) in the System Control Module
SSI_RXFS	Primary function of GPIO Port C [3]	Clear bit 3 of Port C GPIO In Use Register (GIUS_C) Clear bit 3 of Port C General Purpose Register (GPR_C) Clear bit 7 in the Function Muxing Control Register (FMCR) in the System Control Module
	Alternate function of GPIO Port B [14]	Clear bit 14 of Port B GPIO In Use Register (GIUS_B) Set bit 14 of Port B General Purpose Register (GPR_B) Set bit 7 in the Function Muxing Control Register (FMCR) in the System Control Module

^{1.} Only one of the two pins should be set-up for each SSI signal.

24.2.3.1 Pin Configuration Example Software

Code Example 24-1 sets up the SSI pins as the alternate function of Port B by following the configuration in Table 24-1 on page 24-6.

Code Example 24-1. SSI Pin Setup

```
// Configure Pad to Peripheral Function instead of GPIO
                         // GPIO PORT B GIUS register
LDR r1,=GIUS B
LDR r2,=0xFF\overline{F}03FFF
                          // Pins 14-19 should be cleared
STR r2, [r1]
// Configure Pad for Alternate Function instead of Primary
LDR r1,=GPR B // GPIO PORT B GPR register
LDR r2,=0x0\overline{0}0FC000
                         // Pins 14-19 should be set
STR r2, [r1]
// Configure FMCR to Select SSI input from SSI/SIM Pads
                // CRM FMCR register
LDR r1,=FMCR
LDR r2,=0x000000F8
                         // Pins 7-3 should be set
STR r2, [r1]
// The SSI default is in pull-up state. Disable the pull-up, making them tristate
LDR r2,=0xFFF03FFF
                        // GPIO PORTB PUEN register
                         // Disable pullup for SSI input pins
STR r2, [r1]
```

24.3 Programming Model

The SSI module includes ten user-accessible 32-bit registers. It also includes two 16-bit internal registers and two 8×16 bit internal FIFOs. Table 24-2 summarizes these registers and their addresses.

MC9328MXS Reference Manual, Rev. 1

Table 24-2. SSI Module Register Summary

Description	Name	Address										
SSI Transmit Data Register	STX	0x00218000										
SSI Receive Data Register	SRX_1	0x00218004										
SSI Control/Status Register	SCSR	0x00218008										
SSI Transmit Configuration Register	STCR	0x0021800C										
SSI Receive Configuration Register	SRCR	0x00218010										
SSI Transmit Clock Control Register	STCCR	0x00218014										
SSI Receive Clock Control Register	SRCCR	0x00218018										
SSI Time Slot Register	STSR	0x0021801C										
SSI FIFO Control/Status Register	SFCSR	0x00218020										
SSI Option Register	SOR	0x00218028										
SSI Transmit and Receive FIFO Registers												
SSI Transmit Shift Register	SSI Transmit Shift Register TXSR —											
SSI Receive Shift Register	RXSR	_										

NOTE:

To use SSI, the Port B General Purpose Register (GPR) and GPIO In Use (GIUS) registers must be set correctly. See Section 24.2.3, "Pin Configuration for SSI," for more information.

24.3.1 SSI Transmit Data Register

The SSI Transmit Data Register (STX) holds the data to be transmitted. The data is transferred to the SSI Transmit Shift Register (TXSR), and when that register is empty, the data is shifted out onto the serial transmit data (SSI TXDAT) pin.

The STXregister is implemented as the first word of the transmit FIFO. When the transmit FIFO enable (TFEN) bit in STCR is set, 8 data values are written to the STX register and these values are held in the transmit FIFO. They are then transmitted out one word at a time.

When the transmit interrupt enable (TIE) bit in the SSI Transmit Configuration Register (STCR1 is set, an interrupt occurs if no data is waiting to be transferred to the shift register (the transmit data empty (TDE) bit in the SCSR register is set) and the transmit register is empty.

When multiple writes to the STX register occur, data already in the register is not overwritten by incoming data. Multiple writes are accomplished as shown in the following examples:

- When the transmit FIFO is enabled and the user writes data1, data2, ..., data9 to the STX register, data1, data2, ..., data8 are stored in the FIFO, and data9 is discarded.
- When the transmit FIFO is disabled and user writes data1, data2 to the STX register, data2 is discarded.

NOTE:

Enable the SSI (SSI EN = 1) in the SCSR before writing to the STX register.

MC9328MXS Reference Manual, Rev. 1

24-8 Freescale Semiconductor

STX		SSI Transmit Data Register														Addr 0x00218000		
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
				HIGH	BYTE							LOW	BYTE					
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw		
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									

Table 24-3. SSI1 Transmit Data Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
HIGH BYTE Bits15–8	Transmit Data High Byte—Holds the high byte of the data to be transmitted out of the SSI.
LOW BYTE Bits 7–0	Transmit Data Low Byte—Holds the low byte of the data to be transmitted out of the SSI.

24.3.2 SSI Transmit FIFO Register

The SSI transmit FIFO is a 8×16-bit register that holds up to 8 words to be transmitted out by the SSI. The STX register is the first word of this FIFO, and data is transmitted first-in–first-out. The transmit FIFO is enabled by setting the Transmit FIFO Enable (TFEN) in the STCR register.

When the TIE bit in the STCR is enabled and the Transmit FIFO Empty (TFE) bit in the SCSR is set, an interrupt occurs if the data level in the transmit FIFO falls below the threshold value.

When the transmit FIFO is full, all further writes are ignored until the data is transmitted.

24.3.3 SSI Transmit Shift Register

The SSI Transmit Shift Register (TXSR) is a 16-bit shift register containing the data ready to be transmitted.

When a continuous clock is used, data is shifted out to the SSI_TXDAT pin by the selected (internal/external) bit clock when the associated (internal/external) frame sync is asserted. When a gated clock is used, data is shifted out to the SSI_TXDAT pin by the selected (internal/external) gated clock.

The WL bits in the STCCR register determine the number of bits that will be shifted out of the TXSR before it is considered empty and can be written to again. This word length can be 8, 10, 12, or 16 bits.

The Transmit Shift Direction (TSHFD) bit and Transmit Bit Position(TXBIT0) in the STCR determines how the data is transmitted. Table 24-4 displays the data bit shifting configuration and Figure 24-6 through Figure 24-9 visually the data path for each configuration.

			yy
TXBIT0	TSHFD	WL[1:0]	Shifting from Bit
0	0	xx	Bit 15 (MSB) first
0	1	00	Bit 8 (LSB) first, bit 15 (MSB) last
0	1	01	Bit 6 (LSB) first, bit 15 (MSB) last
0	1	10	Bit 4 (LSB) first, bit 15 (MSB) last
0	1	11	Bit 0 (LSB) first, bit 15 (MSB) last
1	0	00	Bit 7 (MSB) first, bit 0 (LSB) last
1	0	01	Bit 9 (MSB) first, bit 0 (LSB) last
1	0	10	Bit 11 (MSB) first, bit 0 (LSB) last
1	0	11	Bit 15 (MSB) first, bit 0 (LSB) last
1	1	XX	Bit 0 (LSB) first

Table 24-4. Data Bit Shifting Configuration

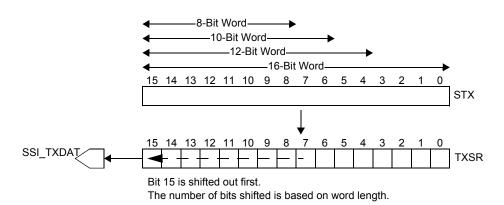


Figure 24-6. Transmit Data Path (TXBIT0 = 0, TSHFD = 0)

24-10 Freescale Semiconductor

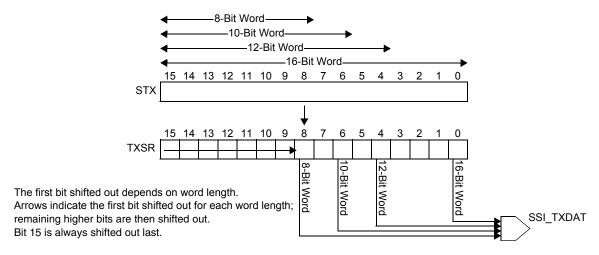


Figure 24-7. Transmit Data Path (TXBIT0 = 0, TSHFD = 1)

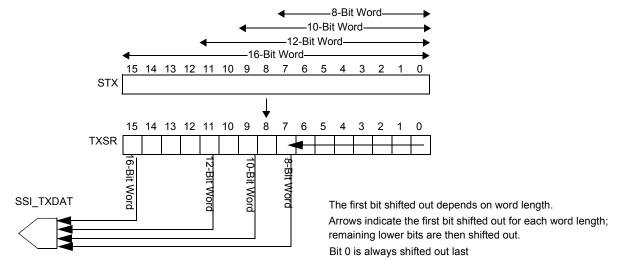


Figure 24-8. Transmit Data Path (TXBIT0 = 1, TSHFD = 0)

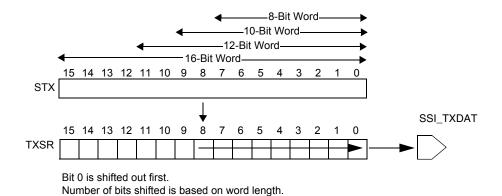


Figure 24-9. Transmit Data Path (TXBIT0 = 1, TSHFD = 1)

24.3.4 SSI Receive Data Register

The read-only SSI Receive Data Register (SRX) holds the most recently received data. Incoming data from the serial receive data (SSI_RXDAT) pin is held in the SSI Receive Shift Register (RXSR) as it is received. When the transmission is complete, the data is transferred to the SRX register.

The SRX register is implemented as the first word of the receive FIFO. When the receive FIFO is enabled in the SSI Receive Configuration Register (SRCR), 8 data values are received into the SSI receive FIFO.

When the receive interrupt enable (RIE) bit in the SRCR is set, an interrupt occurs when a new value is loaded into the SRX register from the RXSR.

. . .

SRX	SSI Receive Data Register														Addr 0x00218004			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
				HIGH	BYTE							LOW	BYTE					
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
DE0E=	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									

Table 24-5. SSI Receive Data Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
HIGH BYTE Bits 15–8	Receive Data High Byte—Holds the high byte of the data received from the RXSR.
LOW BYTE Bits 7–0	Receive Data Low Byte—Holds the low byte of the data received from the RXSR.

24.3.5 SSI Receive FIFO Register

SSI receive FIFO is an 8×16-bit register that holds the last 8 words received by the SSI. The SRX register is the first word of this FIFO. The receive FIFO is enabled by setting the Receive FIFO Enable (RFEN) in the SRCR

When the RIE bit is enabled and the Receive FIFO Full (RFF) bit in the SCSR is set, an interrupt occurs if the data level in the receive FIFO reaches the threshold value.

When the receive FIFO is full, all further received data is ignored until the data is read out.

MC9328MXS Reference Manual, Rev. 1

24-12 Freescale Semiconductor

24.3.6 SSI Receive Shift Register

The SSI Receive Shift Register (RXSR) is a 16-bit shift register that contains the data being received from the SSI RXDAT pin. When the register is full, received data fills the receive FIFO.

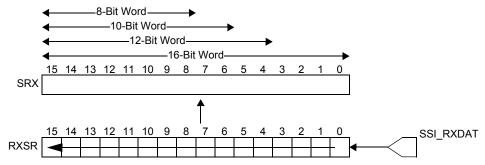
When a continuous clock is used, data is shifted in by the selected (internal/external) bit clock when the associated (internal/external) frame sync is asserted. When a gated clock is used, data is shifted in from the SSI_TXDAT pin by the selected (internal/external) gated clock.

The Receive shift direction (RSHFD) bit and Receive bit position(RXBIT0) in the SRCR determines how the data is stored. Table 24-6 contains all of the information about data bit shifting configurations and Figure 24-10 through Figure 24-13 visually the data path for each configuration.

The WL bits in the SSI Receive Clock Control Register (SRCCR) determine the number of bits to be shifted in from the SSI_RXDAT pin. This word length can be 8, 10, 12, or 16 bits. When receiving 8, 10, or 12 bits of data, 0s are appended to the end of the data string to fill the 16-bit register.

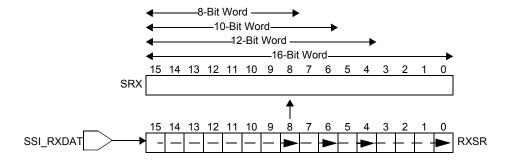
Table 24-6. Data Bit Shifting Configuration

RXBIT0	RSHFD	WL[1:0]	Shifting to bit
0	0	00	Bit 15 (MSB) first, bit 8 (LSB) last
		01	Bit 15 (MSB) first, bit 6 (LSB) last
		10	Bit 15 (MSB) first, bit 4 (LSB) last
		11	Bit 15 (MSB) first, bit 0 (LSB) last
0	1	00	Bit 8 (MSB) first, bit 15 (LSB) last
		01	Bit 6 (MSB) first, bit 15 (LSB) last
		10	Bit 4 (MSB) first, bit 15 (LSB) last
		11	Bit 0 (MSB) first, bit 15 (LSB) last
1	0	00	Bit 0 (MSB) first, bit 7 (LSB) last
		01	Bit 0 (MSB) first, bit 9 (LSB) last
		10	Bit 0 (MSB) first, bit 11 (LSB) last
		11	Bit 0 (MSB) first, bit 15 (LSB) last
1	1	00	Bit 7 (MSB) first, bit 0 (LSB) last
		01	Bit 9 (MSB) first, bit 0 (LSB) last
		10	Bit 11 (MSB) first, bit 0 (LSB) last
		11	Bit 15 (MSB) first, bit 0 (LSB) last



Bit 15 is shifted in first. The number of bits shifted is based on word length. Zeros are added to end of data string for smaller words (8, 10 or 12 bits).

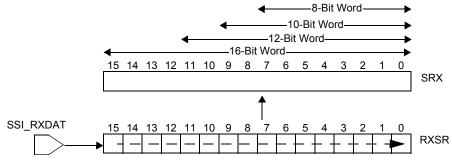
Figure 24-10. Receive Data Path (RXBIT0 = 0, RSHFD = 0)



The first bit shifted in depends on word length.

Arrowheads indicate the bit shifted in first in each case; remaining higher bits are then shifted in. Bit 15 is always shifted in last.

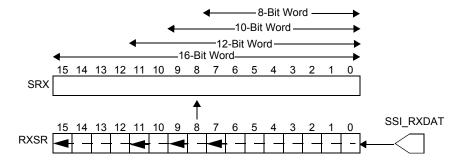
Figure 24-11. Receive Data Path (RXBIT0 = 0, RSHFD = 1)



Bit 0 is shifted in first. The number of bits shifted is based on word length. Zeros are added to end of the data string for smaller words (8, 10 or 12 bits).

Figure 24-12. Receive Data Path (RXBIT0 = 1, RSHFD = 0)

24-14 Freescale Semiconductor



The first bit shifted in depends on word length.

Arrowheads indicate the bit shifted in first in each case; all lower bits are then shifted in. Bit 0 is always shifted in last.

Figure 24-13. Receive Data Path (RXBIT0 = 1, RSHFD = 1)

24.3.7 SSI Control/Status Register

The SSI Control/Status Register sets up and monitors the SSI. The SSI status bits are updated when the SSI is enabled, and then after the transmission or reception of the first bit of the next SSI word is complete. The Receive Overrun Error (ROE) and Transmitter Underrun Error (TUE) bits are cleared by reading this register, followed by a read of the SRX register (to clear ROE), or a write to the STX register (to clear TUE).

SCSR	1				SSI Control/Status Register									Addr 0x00218008			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
DECET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
RESET							0x000	0									
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
	SYS_CLK_ EN	12S_N	MODE	SYN	NET	RE	TE	SSI_EN	RDR	TDE	ROE	TUE	TFS	RFS	RFF	TFE	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	r	r	r	r	r	r	r	r	
	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	1	
RESET							0x004	1									

Table 24-7. SSI Control/Status Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.	

Table 24-7. SSI Control/Status Register Description (continued)

Name	Description	Settings
SYS_CLK_EN Bit 15	System Clock Enable—Determines whether the input clock PerCLK3 is output as SYS_CLK on the SSI_RXCLK pin. When SYS_CLK_EN is set, PerCLK3 is output on the SRCK pin if the network mode, synchronous mode, and transmit internal clock mode bits are also set. The timing relationship between SYS_CLK and the internal serial bit clock is controlled by the STCCR and/or SRCCR registers.	0 = SYS_CLK is not output on the SSI_RXCLK pin 1 = SYS_CLK is output on the SSI_RXCLK pin
I2S_MODE Bits 14–13	I ² S Mode Select—Determines whether the SSI operates in normal mode, I ² S master mode, or I ² S slave mode.	See Section 24.3.7.1, "I2S Mode Selection."
SYN Bit 12	Synchronous Mode —Enables/Disables the synchronous mode of operation. In synchronous mode, the transmit and receive sections share a common clock pin (SSI_TXCLK) and frame sync pin (SSI_TXFS).	0 = Disable synchronous mode 1 = Enable synchronous mode
NET Bit 11	Network Mode—Selects the operational mode of the SSI. See Section 24.5.2, "Network Mode," for more information on Network Mode.	0 = Normal mode 1 = Network mode
RE Bit 10	Receive Enable—Enables/Disables the receive portion of the SSI. When disabled data transfers into the SRX register/receive FIFO are inhibited. If data is being received when the RE bit is disabled, the rest of the word is ignored. If the RE bit is re-enabled before the second-to-last bit of the same word is received, the word is received.	0 = Disable SSI receive 1 = Enable SSI receive
TE Bit 9	Transmit Enable—Enables/Disables the transfer of the contents of the STX register to the TXSR. When the TE bit is set and a word boundary is detected, the transmit portion of the SSI is enabled. When the TE bit is cleared, the transmitter continues to send the data currently in the TXSR and then disables the transmitter. The serial output is disabled and any data present in the STX register is not transmitted. Data can be written to the STX register with the TE bit cleared. The TDE bit is cleared, however data is not transferred to the TXSR. When the TE bit is cleared and then set again during the same transmitted word, the data continues to be transmitted. When the TE bit is set again during a different time slot, data is not transmitted until the next word boundary. The normal transmit enable sequence is to write data to the STX register or to the SSI Time Slot Register (STSR) before setting the TE bit. The normal transmit disable sequence is to clear the TE bit and the TIE bit in the STCR after the TDE bit is set.	0 = Disable SSI transmit 1 = Enable SSI transmit
	When an internal gated clock is used, the gated clock runs during valid time slots when the TE bit is set. When the TE bit is cleared, the transmitter continues to send the data currently in the TXSR until the TXSR register is empty, then the clock stops. When the TE bit is set again, the gated clock starts immediately and runs during any valid time slots.	

MC9328MXS Reference Manual, Rev. 1

24-16 Freescale Semiconductor

Table 24-7. SSI Control/Status Register Description (continued)

Name	Description	Settings
SSI_EN Bit 8	SSI Enable—Enables/Disables the SSI. The SSI Enable bit must be set prior to setting other bits.	0 = Disable the SSI 1 = Enable the SSI
	When the SSI is set up for internal frame sync, enabling causes an output frame sync to be generated. When the SSI is set up for external frame sync, enabling causes the SSI to wait for the input frame sync. When the SSI is disabled, the SSI_TXCLK, SSI_TXFS, and SSI_TXFS pins are tri-stated, the status register bits hold their reset value, and all internal clocks are disabled (other than clocking for register access).	
	Reset the SSI by clearing the SSI_EN bit. The contents of the transmit FIFO and receive FIFO are cleared when the SSI_EN bit is reset.	
RDR Bit 7	Receive Data Ready—Indicates that the SRX register or the receive FIFO contains a new value. It is automatically cleared when the CPU reads the SRX register or when the receive FIFO (when enabled) is empty.	0 = SRX does not contain a new value or the receive FIFO is empty 1 = SRX or receive FIFO
	When the RIE bit in the SRCR is set, an interrupt occurs when the RDR bit is set.	contains a new value
TDE Bit 6	Transmit Data Register Empty—Indicates that no data is waiting to be transferred to the TXSR. This occurs when the STX register is empty. Because the STX register is the first word of the transmit FIFO, the TDE bit is not set until the transmit FIFO is empty. When the TDE bit is set and data is not written to the STX register or to the SSI Time Slot Register (STSR) before the TXSR empties, an underrun error occurs.	0 = Data is waiting to be transmitted (transferred to the TXSR) 1 = No data is waiting to be transmitted (transferred to the TXSR)
	To clear the TDE bit, write transmission data to the STX register or write any data to the STSR register.	
	When the TIE bit in the STCR is set, an interrupt occurs when the TDE bit is set.	
ROE Bit 5	Receive Overrun Error—Indicates when the RXSR is filled and ready to transfer to the SRX register or the receive FIFO register (when enabled), and these registers are already full. This is also indicated by the RFF and Receive Data Ready (RDR) bits of this register.	0 = SRX and/or receive FIFO can hold more data 1 = RXSR is ready to transfer data, however SRX and/or receive FIFO is full
	When ROE is set, the contents of the RXSR are not transferred. However, when the ROE bit is set, it causes a change in the interrupt vector used, allowing the use of a different interrupt handler for a receive overrun condition. When a receive interrupt occurs with the ROE bit set, the Receive Data with Exception interrupt is generated. When a receive interrupt occurs with the ROE bit cleared, the Receive Data interrupt is generated.	
	ROE is cleared by reading this register, and then reading the SRX register.	

Table 24-7. SSI Control/Status Register Description (continued)

Name	Description	Settings
TUE Bit 4	Transmitter Underrun Error—Indicates that the TXSR is empty AND a transmit time slot occurs. The TDE bit in this register indicates the first condition. When a transmit underrun error occurs, the data that was in the TXSR is retransmitted. In normal mode, a transmit time slot occurs when the frame sync is asserted. In network mode, each time slot requires data transmission and is a transmit time slot (TE = 1). When the TUE bit is set, there is no data transferred to the TXSR.	0 = TXSR is empty and no transmit time slot has occurred OR the TXSR is not empty 1 = TXSR is empty and a transmit time slot has occurred
	However, the TUE bit does cause a change in the interrupt vector used for transmit interrupts so that a different interrupt handler can be used for a transmit underrun condition. When a transmit interrupt occurs with the TUE bit set, the Transmit Data with Exception interrupt is generated. When a transmit interrupt occurs with the TUE bit cleared, the Transmit Data interrupt is generated.	
	TUE is cleared by reading this register, and then writing to the STX register or to the SSI Time Slot Register (STSR).	
TFS Bit 3	Transmit Frame Sync—Indicates that a frame sync occurred during transmission of the last word written to the STX register. Data written to the STX register during the time slot when the TFS bit is set is sent during the second time slot (in network mode) or in the next first	0 = No frame sync occurred during transmission 1 = A frame sync occurred during transmission
	time slot (in normal mode). In network mode, the TFS bit is set during transmission of the first slot of the frame. It is then cleared when starting transmission of the next slot.	
RFS Bit 2	Receive Frame Sync—Indicates that a frame sync occurred when receiving a word into the SRX register.	0 = No frame sync occurred when receiving 1 = A frame sync occurred when receiving
	In network mode, the RFS bit is set when the first slot of the frame is being received. It is cleared when the next slot of the frame begins to be received.	
RFF Bit 1	Receive FIFO Full—Indicates that the data level in the receive FIFO reaches the Receive FIFO Full Water Mark. The Water Mark is defined in the RFWM field of the SSI FIFO Control/Status Register (SFCSR). The receive FIFO must be enabled or RFF is meaningless.	0 = Data level in the receive FIFO exceeds Water Mark level 1 = Data level in receive FIFO reaches Water Mark
	When RFF is set, data can be read from the receive FIFO via the SRX register. When the RX FIFO has received 8 bytes of data, all further received data is ignored until the data is read out of the receive FIFO.	
	Note: An interrupt is generated only when both the RFF and RIE bits in the SRCR are set and the receive FIFO (the RFEN bit in the SRCR) is enabled.	

MC9328MXS Reference Manual, Rev. 1

24-18 Freescale Semiconductor

Table 24-7. SSI Control/Status Register Description (continued)

Name	Description	Settings
TFE Bit 0	Transmit FIFO Empty—Indicates that the data level in the transmit FIFO reaches the Transmit FIFO Empty Water Mark. The Water Mark is defined in the TFWM field of the SSI FIFO Control/Status Register (SFCSR). The transmit FIFO must be enabled or TFE is meaningless. When TFE is set, data can be written to the transmit FIFO via the STX register. Note: An interrupt is generated only when both the TFE and TIE (of the STCR) are set and the transmit FIFO is enabled (the TFEN bit in the STCR is set).	0 = Data level in the transmit FIFO exceeds Water Mark 1 = Data level in the transmit FIFO below Watermark

24.3.7.1 I²S Mode Selection

The SSI is able to emulate certain features of the I²S standard. Both early frame sync and 1-word-wide frame sync are supported. Data can be up to 16-bits per channel. However, dummy clocks are not supported. If the data is 16-bit and there are 2 channels per frame, the number of bit clock should be exactly 32. Use of dummy clocks is forbidden.

The SCSRcontains two bits, the I²S Mode Select (I2S MODE1 and I2S MODE0) bits, that determine the mode of the SSI module. This section explains how the mode of the module affects the bits in the other SSI registers. Table 24-8 summarizes the mode settings.

 I2S_MODE [1]
 I2S_MODE [0]
 Remark

 0
 0
 Normal mode

 0
 1
 I²S master mode

0

1

I²S slave mode

Normal mode

Table 24-8. I²S Mode Selection

In normal mode operation, no register bits are forced to any particular state internally and the SSI can be programmed to work in any operating condition.

When entering I^2S modes (I^2S master or I^2S slave), several control bits are fixed in the hardware. Attempts to write to these bits when in I^2S master or I^2S slave mode are ignored. These bits are described in Table 24-9.

The user must configure the bit clock in the STCCR and the SRCCR.

1

1

Table 24-9. I²S Master or I²S Slave Mode Settings

I ² S Mode	Bit Name	Register Location	Forced Value	Function
Master or slave	SYN	SCSR [12]	1	Synchronous mode enabled
Master or slave	NET	SCSR [11]	1	Network mode enabled

MC9328MXS Reference Manual, Rev. 1

Table 24-9. I²S Master or I²S Slave Mode Settings (continued)

I ² S Mode	Bit Name	Register Location	Forced Value	Function
Master or slave	TSHFD	STCR [4]	0	Transmission direction is MSB first
Master or slave	RSHFD	SRCR [4]	0	Receive direction is MSB first
Master or slave	TSCKP	STCR [3]	1	Falling edge of bit clock clocks data out
Master or slave	RSCKP	SRCR [3]	1	Rising edge of bit clock clocks data in
Master or slave	TFSI	STCR [2]	1	Transmit frame sync is active low
Master or slave	RSFI	SRCR [2]	1	Receive frame sync is active low
Master or slave	TFSL	STCR [1]	0	Transmit frame sync length is 1 word
Master or slave	RFSL	SRCR [1]	0	Receive frame sync length is 1 word
Master or slave	TEFS	STCR [0]	1	Transmit frame sync initiated sync one bit-clock before transmission
Master or slave	REFS	SRCR [0]	1	Receive frame sync initiated one bit-clock before receive
Master	TXDIR	STCR [5]	1	Clock source is generated internally bit clock
Master	TFDIR	STCR [6]	1	Transmit frame sync is generated internally
Slave	TXDIR	STCR [5]	0	Clock source is externally generated bit clock
Slave	TFDIR	STCR [6]	0	Transmit frame sync is generated externally

When the SSI is configured as an I²S master, the external codec may require an oversampling clock in addition to the sampling rate frequency and bit clock. This oversampling clock is usually required to be 256 times the sampling frequency.

As an example, if a sampling frequency of 44.1 kHz was required, and the word length was set to 16-bits. Then a frame sync would be $2 \times 16 = 32$ bit clocks. This makes the bit clock frequency 1.4112 MHz.

The frequency ratios that must hold would be the following:

SYS_CLK (PerCLK3) =
$$256 \times$$
 Frame Sync Eqn. 24-1
Frame_Sync = Bit Clock / 32 Eqn. 24-2

Therefore,

SYS_CLK (PerCLK3) =
$$8 \times Bit Clock$$
 Eqn. 24-3

If the divide ratio is set to 8—that is, PM = 1 and PSR = 0, SYS_CLK_EN is set, the module is in I^2S master mode and the incoming frequency of PerCLK3 is 11.2896 MHz, then SYS_CLK will meet the requirements. The external codec will not need a crystal oscillator for clocking.

24-20 Freescale Semiconductor

24.3.8 SSI Transmit Configuration Register

The SSI Transmit Configuration Register (STCR) controls the transmit operation of the SSI. This register controls the frame synchronization signal, clocking, and data direction. It also contains enables for the DMA, transmit FIFO, and the transmit interrupt.

As with all on-chip peripheral interrupts for the MC9328MXS, the STCR must first be set to enable maskable interrupts. Next, the AITC (ARM9 Interrupt Controller) is configured to handle the SSI interrupts. For example, the SSI interrupt bits (bits 45 through 42) in the AITC's Interrupt Enable High Register (INTENABLEH) must be set to enable the interrupt. Also be sure to enable interrupts to the core (either the IRQ or FIQ interrupts). After all of these steps are completed, an interrupt is generated when any of the desired transmit status bits of the SCSR (TDE, TUE, TFS, or TFE) are set.

NOTE:

SSI reset does not affect the STCR bits. Power-on-reset clears all STCR bits.

STCR	SSI Transmit Configuration Register										0x	Addr 0x0021800C				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET									(0x0000						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						TXBIT0	TDMAE	TIE	TFEN	TFDIR	TXDIR	TSHFD	TSCKP	TFSI	TFSL	TEFS
TYPE	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET									(0x0000						

Table 24-10. SSI Transmit Configuration Register Description

Name	Description	Settings		
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.			
TXBIT0 Bit 10	Transmit Bit0 —This bit determines which bit in the Transmit Shift Register (TXSR) triggers the TXSR to transmit its data word. By default, shifting of data is triggered by bit position 15 of TXSR. The shifting data direction (MSB or LSB bit transmitted first) is controlled by the TSHFD bit.	0 = Bit position 15 of TXSR triggers transfer1 = Bit position 0 of TXSR triggers transfer		

Table 24-10. SSI Transmit Configuration Register Description (continued)

Name	Description	Settings
TDMAE Bit 9	Transmit DMA Enable—Enables DMA requests to be issued when certain conditions are met.	0 = No DMA request issued 1 = DMA request issued
	When the transmit FIFO is enabled and the TDMAE bit is set, a DMA request is issued when the TFE bit in the SCSR is set.	
	When the transmit FIFO is disabled and the TDMAE bit is set, a DMA request is issued when the TDE bit in the SCSR is set.	
	The TIE bit (in this register) has higher priority than the TDMA bit. When TIE is set, an interrupt is generated to the CPU instead of the DMA.	
TIE Bit 8	Transmit Interrupt Enable —Enables/Disables the transmit interrupt when certain conditions are met. TIE works with the Transmit Enable (TE) bit in the SCSR.	0 = Transmit interrupt disabled 1 = Transmit interrupt enabled
	When the transmit FIFO is enabled and the TIE and TE bits are both set, an interrupt occurs when the TFE bit in the SCSR register is set.	0.1000
	When the transmit FIFO is disabled and the TIE and TE bits are both set, an interrupt occurs when the TDE bit in the SCSR register is set.	
	Two transmit data interrupts with separate interrupt vectors are available: transmit data with exception status and transmit data without exceptions. Table 24-11 shows the conditions that generate these interrupts and lists the interrupt vectors.	
TFEN Bit 7	Transmit FIFO Enable—Enables/Disables the transmit FIFO. When the transmit FIFO is enabled, a maximum of 8 values are written to the STX register at a time. These values are then transmitted out first-in-first-out. When the transmit FIFO is disabled, only one value is written to the STX register at a time.	0 = Transmit FIFO disabled 1 = Transmit FIFO enabled
TFDIR Bit 6	Transmit Frame Direction —Selects the direction and source of the transmit frame sync signal. When the TFDIR bit is set, the frame sync is generated internally and output to the SSI_TXFS pin (if not configured as GPIO). When the TFDIR bit is cleared, the transmit frame sync is supplied from an external source. Table 24-14 shows the clock pin configuration.	0 = Frame sync generated externally 1 = Frame sync generated internally
TXDIR Bit 5	Transmit Direction—Selects the direction and source of the clock signal that clocks the TXSR. When the TXDIR bit is set, the clock is generated internally and output to the SSI_TXCLK pin (if not configured as GPIO). When the TXDIR bit is cleared, the clock source is external, the internal clock generator is disconnected from the SSI_TXCLK pin, and an external clock source can drive this pin to clock the TXSR.	0 = External source must drive SSI_TXCLK pin 1 = Clock generated internally and output to SSI_TXCLK pin
TSHFD Bit 4	Transmit Shift Direction —Controls whether the MSB or LSB is transmitted first for the transmit section.	0 = MSB transmitted first 1 = LSB transmitted first
	Note: The codec device labels the MSB as bit 0, however the MC9328MXS labels the LSB as bit 0. When using a standard codec, the MC9328MXS MSB (or codec bit 0) is shifted out first, and the TSHFD bit is cleared.	

MC9328MXS Reference Manual, Rev. 1

24-22 Freescale Semiconductor

24-23

Table 24-10. SSI Transmit Configuration Register Description (continued)

Name	Description	Settings
TSCKP Bit 3	Transmit Clock Polarity —Controls the bit clock edge that clocks out data for the transmit functions.	0 = Rising edge of clock clocks data out 1 = Falling edge of clock clocks data out
TFSI Bit 2	Transmit Frame Sync Invert —Selects the logic of the transmit frame sync I/O.	0 = Active high 1 = Active low
TFSL Bit 1	Transmit Frame Sync Length —Selects the length of the frame sync signal to be generated or recognized. When the word-long frame sync is selected, this frame sync length is determined by the WL field of the STCCR.	0 = Frame sync is 1 word long 1 = Frame sync is 1 bit-clock long
TEFS Bit 0	Transmit Early Frame Sync —Controls when the frame sync is initiated for the transmit section. The frame sync is disabled after one bit for bit-length frame sync and after one word for word-length frame sync (based on the TFSL bit of this register).	0 = Frame sync is initiated with first data bit transmission 1 = Frame sync is initiated one bit-clock before transmission starts

Table 24-11. SSI Transmit Data Interrupts

Interrupt	Interrupt Source Register High ¹	TIE	TUE	TFE/TDE
Transmit Data with Exception	Bit 11 (IN43)	1	1	1
Transmit Data Without Exception	Bit 10 (IN42)	1	0	1

^{1.} Refer to Chapter 10, "Interrupt Controller (AITC)," for more information about interrupts.

24.3.9 SSI Receive Configuration Register

The SSI Receive Configuration Register (SRCR) controls the receive operation of the SSI—which controls the frame synchronization signal, clocking, and data direction configurations. It also contains enables for the DMA, receive FIFO, and the receive interrupt settings.

As with all on-chip peripheral interrupts for the MC9328MXS, the SRCR must first be set to enable maskable interrupts. Next, the AITC (ARM9 Interrupt Controller) is configured to handle the SSI interrupts. For example, the SSI interrupt bits (bits 45 through 42) in the AITC's Interrupt Enable High Register (INTENABLEH) must be set to enable the interrupt. Also be sure to enable interrupts to the core (either the IRQ or FIQ interrupts). When all of these steps are complete, then an interrupt is generated when any of the desired transmit status bits of the SCSR (RDR, ROE, RFS, or RFF) are set.

NOTE:

An SSI reset does not affect the bits in the SRCR register. Power-on-reset clears all SRCR register bits.

SRCF	SSI Receive Configuration Register									0x	Addr 0x00218010					
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
DEOFT	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET									0x0000)						
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						RXBIT0	RDMAE	RIE	RFEN	RFDIR	RXDIR	RSHFD	RSCKP	RFSI	RFSL	REFS
TYPE	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
DEOFT	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESET									0x0000)						

Table 24-12. SSI Receive Configuration Register Description

Name	Description	Settings
Reserved Bits 31–11	Reserved—These bits are reserved and should read 0.	
RXBIT0 Bit 10	Receive Bit 0—This bit determines which bit in the Receive Shift Register (RXSR) triggers the RXSR to transmit its data word. By default, shifting of data is triggered by bit position 15 of TXSR. The shifting data direction (MSB or LSB bit transmitted first) is controlled by the RSHFD bit.	0 = Bit position 15 of RXSR triggers transfer 1 = Bit position 0 of RXSR triggers transfer
RDMAE Bit 9	Receive DMA Enable—Enables DMA requests to be issued when certain conditions are met.	0 = No DMA request issued 1 = DMA request issued
	When the receive FIFO is enabled and the RDMAE bit is set, a DMA request is issued when the RFF bit in the SCSR is set.	
	When the receive FIFO is disabled and the RDMAE bit is set, a DMA request is issued when the RDR bit in the SCSR is set.	
	The RIE bit (in this register) has higher priority than the RDMAE bit. When the RIE bit is set, an interrupt is generated to the CPU instead of the DMA.	

24-24 Freescale Semiconductor

Table 24-12. SSI Receive Configuration Register Description (continued)

Name	Description	Settings
RIE Bit 8	Receive Interrupt Enable—Enables/Disables the receive interrupt when certain conditions are met. The RIE bit works with the RE bit in the SCSR.	0 = Disable transmit interrupt 1 = Enable transmit interrupt
	When the receive FIFO is enabled and the RIE and RE bits are both set, an interrupt occurs when the RFF bit in the SCSR is set.	
	When the receive FIFO is disabled and the RIE and RE bits are both set, an interrupt occurs when the RDR bit in the SCSR is set.	
	Two receive data interrupts with separate interrupt vectors are available, Receive Data with Exception and Receive Data Without Exception. Table 24-13 on page 24-26 shows the conditions that generate these interrupts and lists the interrupt vectors.	
RFEN Bit 7	Receive FIFO Enable—Enables/Disables the receive FIFO. When the receive FIFO is enabled, a maximum of 8 values can be received by the SSI without losing data. A ninth value can be received into the RXSR, however it is not transferred to the receive FIFO. When the receive FIFO is disabled, only one value can be received into the SRX register (that value must be read out before another value can be transferred in from the RXSR).	0 = Disable receive FIFO 1 = Enable transmit FIFO
RFDIR Bit 6	Receive Frame Direction—Selects the direction and source of the receive frame sync signal. When the RFDIR bit is set, the frame sync is generated internally and output to the SSI_RXFS pin (if not configured as a GPIO). When the RFDIR bit is cleared, the receive frame sync is supplied from an external source.	0 = Receive frame sync generated externally 1 = Receive frame sync generated internally
RXDIR Bit 5	Receive Direction—Selects the direction and source of the clock signal that clocks the RXSR. When the RXDIR bit is set, the clock is generated internally and output to the SSI_RXCLK pin (if not configured as a GPIO). When the RXDIR bit is cleared, the internal clock generator is disconnected from the SSI_RXCLK pin so an external clock source can drive this pin to clock the RXSR. Table 24-14 on page 24-26 shows the clock pin configuration.	0 = External source drives SSI_RXCLK pin 1 = Clock generated internally and output to SSI_RXCLK pin
RSHFD Bit 4	Receive Shift Direction—Controls whether the MSB or LSB is received first. Note: The codec device labels the MSB as bit 0, whereas the MC9328MXS labels the LSB as bit 0. When using a standard codec, the MC9328MXS MSB (or codec bit 0) is shifted in first, and the RSHFD bit is cleared.	0 = MSB received first 1 = LSB received first
RSCKP Bit 3	Receive Clock Polarity—Controls the bit clock edge that latches in data.	0 = Falling edge of clock latches data in 1 = Rising edge of clock latches data in
RFSI Bit 2	Receive Frame Sync Invert—Selects the logic of the receive frame sync I/O.	0 = Active high 1 = Active low
RFSL Bit 1	Receive Frame Sync Length—Selects the length of the frame sync signal to be generated or recognized. When the word-long frame sync is selected, this frame sync length is determined by the WL field of the SRCCR.	0 = Frame sync is 1 word long 1 = Frame sync is 1 bit-clock long

Table 24-12. SSI Receive Configuration Register Description (continued)

Name	Description	Settings
REFS Bit 0	Receive Early Frame Sync—Controls when the frame sync is initiated for the receive section. The frame sync is disabled after one bit for bit-length frame sync and after one word for word-length frame sync (based on the RFSL bit of this register).	0 = Frame sync is initiated with first data bit received 1 = Frame sync is initiated one bit-clock before data received

Table 24-13. SSI Receive Data Interrupts

Interrupt	Interrupt Source Register High ¹	RIE	ROE	RFF/RDR
Receive Data with Exception	Bit 13 (IN45)	1	1	1
Receive Data Without Exception	Bit 12 (IN44)	1	0	1

^{1.} Refer to Chapter 10, "Interrupt Controller (AITC)," for more information about interrupts.

Table 24-14. Clock Pin Configuration

SYN	RXDIR	TXDIR	RFDIR	TFDIR	SSI_RXFS SSI_TXFS		SSI_RXCLK	SSI_TXCLK			
	Asynchronous Mode ¹										
0	0	0	0	0	Receive Frame Sync (RFS) in	Transmit Frame Sync (TFS) in	Receive Clock (RCK) in	Transmit Clock (TCK) in			
0	0	1	0	1	RFS in	TFS out	RCK in	TCK out			
0	1	0	1	0	RFS out	TFS in	RCK out	TCK in			
0	1	1	1	1	RFS out	TFS out	RCK out	TCK out			
					Synchronous M	lode ²					
1	0	0	х	0	GPIO	TFS in	GPIO	TCK in			
1	0	1	х	1	GPIO	TFS out	GPIO	TCK out			
1	1	0	х	х	GPIO	GPIO	GPIO	Gated Clock in			
1	1	1	х	х	GPIO	GPIO	GPIO	Gated Clock out			

^{1.} See Figure 24-14 on page 24-36.

24-26 Freescale Semiconductor

^{2.} See Figure 24-15 on page 24-37.

24.3.10 SSI Transmit Clock Control Register and SSI Receive Clock Control Register

The SSI Transmit Clock Control Register (STCCR) and SSI Receive Clock Control Register (SRCCR) control the clocks for the SSI. These registers control the prescaler, word length, and frame rate for the transmit and receive clocks. The fields of this register control the dividers that generate the serial bit clock, the word clock and the frame clock from the PerCLK3 input. See Section 24.3.10.1, "Calculating the SSI Bit Clock from the Input Clock Value," for detailed information on clock values.

The STCCR is dedicated to the transmit section, and the SRCCR register is dedicated to the receive section (except in synchronous mode, when the STCCR controls both the receive and transmit sections). The bit structure for both registers is identical, however they are two distinct registers and must be individually programmed.

NOTE

SSI reset does not affect the STCCR and SRCCR bits. Power-on reset clears all STCCR and SRCCR bits.

STCCR SRCCR										rol Re	•				0021	Addr 8014 8018
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
112021								0x0	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ы Г				12	- 11		9	0	/	0	- 5				- 1	
	PSR	V	/L			DC						F	M			
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x0	000							

Table 24-15. SSI Transmit Clock Control Register and SSI Receive Clock Control Register Description

Name	Description Settings					
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.					
PSR Bit 15	Prescaler Range —Selects whether the fixed divide-by-eight prescaler will be used to generate the serial bit clock. See Figure 24-4. Using this prescaler allows a 128 kHz master clock to be generated for Motorola MC1440x series codecs.	0 = Bypass divide-by-eight prescaler 1 = Use divide-by-eight prescaler				

Table 24-15. SSI Transmit Clock Control Register and SSI Receive Clock Control Register Description

Name	Description	Settings
WL Bits 14–13	Word Length—Selects the length (8, 10, 12, or 16 bits) of the data words being transferred by the SSI. WL also controls the frame sync pulse length when the length of the frame sync (SRCR:RFSL or STCR:TFSL) is set to 1 word. The value of this field is used as a divider value to convert serial bit clock to word clock as shown in Figure 24-4.	00 = 8 Bits per word 01 = 10 Bits per word 10 = 12 Bits per word 11 = 16 Bits per word
DC Bits 12–8	Frame Rate Divider Control—Specifies the divide ratio for the programmable frame rate divider shown in Figure 24-5. The divider converts the word clock to the frame clock. In normal mode, this ratio determines the word transfer rate. In network mode, this ratio sets the number of words per frame. In network mode, a divide ratio of one (DC = 00000) is a special case (on-demand mode). In normal mode, a divide ratio of one (DC = 00000) provides continuous periodic data word transfer (a bit-length sync must be used).	00000 = Divide Ratio is 1 00001 = Divide Ratio is 2 11111 = Divide Ratio is 32 In network mode, DC = 00000 is a special case.
PM Bits 7–0	Prescale Modulus Select—Specifies the divide ratio for the modulus divider shown in Figure 24-4. This divider is one of three dividers that convert the PerCLK3 signal to the serial bit clock.	0x00 = Divide ratio is 1 0x01 = Divide ratio is 2 0xFF = Divide ratio is 256

24.3.10.1 Calculating the SSI Bit Clock from the Input Clock Value

The serial bit clock is the result of the Clock Controller input PerCLK3 being divided by one fixed, one selectable, and one programmable divider. Serial bit clock may range from the value (PerCLK3 / $4\times1\times1$) to (PerCLK3 / $(4\times8\times256)$). See Figure 24-4 on page 24-5. Note that WL has a value of 8, 10, 12, or 16.

$$f_{INT_BIT_CLK} = f_{PerCLK3} \div [4 \times (7 \times PSR + 1) \times (PM + 1)]$$
 Eqn. 24-4
 $f_{FRAME_SYN_CLK} = (f_{INT_BIT_CLK}) \div [(DC + 1) \times WL]$ Eqn. 24-5

Example 1: When the 7-bit clock controller divider, PCLKDIV3 in the PLL and Clock Control module, is set to 5, then PerCLK3 is $96 \text{ MHz} \div 5 = 19.2 \text{ MHz}$.

The SSI is set up in normal mode with a word length of 8 (WL = 00), a frame rate divider control of 1 (DC = 0001), a prescale modulus of 74 (decimal) (PM = 01001010), and the PSR bit cleared (PSR = 0).

In this case, the bit clock rate is 19.2 MHz \div (4 × 1 × 75) = 64 kHz.

That means that the frame sync clock (SSI TXFS) is 64 kHz \div (2 × 8) = 4 kHz.

Example 2: When the 7-bit clock controller divider, PCLKDIV3, is set to 8, then PerCLK3 is 96 MHz \div 8 = 12 MHz.

The SSI is set up in network mode, with a word length of 16 (WL = 11), a frame rate divider control of 1 (DC = 0001), a prescale modulus of 1 (decimal) (PM = 00000001), and the PSR bit cleared (PSR = 0).

In this case, the bit clock rate is 12 MHz \div (4 × 1 × 2) = 1.5 MHz.

That means that the frame sync clock (SSI TXFS) is 1.5 MHz \div (2 × 16) = 46.875 kHz.

Table 24-16 shows various combinations of the PSR and PM fields that achieve different bit clock frequencies.

MC9328MXS Reference Manual, Rev. 1

24-28 Freescale Semiconductor

Table 24-16. SSI Bit and Frame Clock as a Function of PSR and PM in Normal Mode

System PLL output in the clock Controller Module (MHz)	System Clock Divider PCLKDIV3 (7 Bit)	PerCLK3 (MHz) Input to the SSI Module	PSR (0 or 1)	PM [7:0]	Actual Bit_Clk Frequency (kHz) SSI_TXCLK, SSI_RXCLK	Ideal Bit_CIk Frequency (kHz)
96	15	6.4	1	24 (0x18)	8.0	8.0
96	10	9.6	1	24(0x18)	12.0	12.0
96	20	4.8	0	74(0x4A)	16.0	16.0
96	5	19.2	0	74(0x4A)	64.0	64.0
96	5	19.2	0	37(0x25)	126.3	128.0
96	2	48.0	0	46(0x2E)	255.3	256.0
96	1	96.0	0	46(0x2E)	510.6	512.0
96	1	96.0	0	23(0x0F)	1000.0	1024
96	1	96.0	0	11 (0x0B)	2000.0	2048
96	1	96.0	0	5 (0x05)	4000.0	4096

Table 24-17 shows the effect of changing the clock controller divider value to generate SYS_CLK and bit clock frequencies close to the ideal. In these examples, master mode was selected by setting the I²S Mode Select (I2S_MODE1 and I2S_MODE0) bits in the SCSR to 01, or individually programming the SSI into network, synchronous, and transmit internal modes.

Table 24-17. SSI Sys, Bit and Frame Clock in Master Mode

Ideal Sampling Rate (kHz)	Ideal Bit Clock Frequency (kHz)	Ideal SYS_CLK Frequency (MHz)	CRM Clock Controller Divider Value (with 96 MHz input)	PerCLK3 (MHz)	Actual SYS_CLK Frequency (MHz) SSI_RXCLK	Actual Bit Clock Frequency (kHz) SSI_TXCLK	Actual Sampling Rate (kHz) SSI_TXFS
8.0	256.0	2.048	47	2.043	2.043	255.32	7.98
11.025	352.8	2.822	32	3.000	3.000	375.00	11.72
16.00	512.0	4.096	23	4.173	4.173	510.64	15.96
22.05	705.6	5.644	17	5.647	5.647	705.88	22.06
32.00	1024.0	8.192	12	8.000	8.000	1000.0	31.25
44.10	1411.0	11.289	9	10.677	10.677	1334.63	41.71
48.00	1536.0	12.288	8	12.000	12.000	1500.00	48.88

24.3.11 SSI Time Slot Register

The write-only SSI Time Slot Register (STSR) is used when data should not be transmitted in an available transmit time slot. For the purposes of timing, the time slot register behaves like an alternate transmit data register. Instead of transmitting data, the SSI_TXDAT pin is either tri-stated or pulled high, depending on the setting for that pin in the Pull-Up Enable Register in the GPIO Module. Using this register is important for avoiding overflow/underflow during inactive time slots.

STSR						SSI ⁻	Time	Slot	Reg	ister				0x0		Addr 801C
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								DUM	MY							
TYPE	W	w	W	W	W	W	W	W	W	W	W	W	W	w	W	W
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							

Table 24-18. SSI Time Slot Register Description

Name	Description
Reserved Bits 31–16	Reserved—These bits are reserved and should read 0.
DUMMY Bits 15–0	Dummy Bits —Holds data that is not intended for transmission. This register can be used during inactive time slots.

24-30 Freescale Semiconductor

24.3.12 SSI FIFO Control/Status Register

The SSI FIFO Control/Status Register (SFCSR) tracks the number of data words held in the transmit and receive FIFOs and holds the Water Mark levels for each FIFO. The Water Mark is a user-defined value that determines when the RFF and TFE bits in the SCSR are set.

SFCSI	SSI FIFO Control/Status Register									Addr 0x00218020						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		RFC	NT			TFC	CNT			RF	WM			TF\	ΛM	
TYPE	r	r	r	r	r	r	r	r	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	1
NESEI								0X00	81							

Table 24-19. SSIFIFO Control/Status Register Description

Name	Description	Settings
Reserved Bits 31–16	Reserved—These bits are reserved	ed and should read 0.
RFCNT Bits 15–12	Receive FIFO Counter—Indicates how many data words are in the receive FIFO. This count does not include words that are being received or were received into the RXSR_1 yet not transferred to the receive FIFO.	0000 = 0 data words in the receive FIFO 0001 = 1 data word in the receive FIFO 0010 = 2 data words in the receive FIFO 0011 = 3 data words in the receive FIFO 0100 = 4 data words in the receive FIFO 0101 = 5 data words in the receive FIFO 0110 = 6 data words in the receive FIFO 0111 = 7 data words in the receive FIFO 1000 = 8 data words in the receive FIFO All other settings reserved
TFCNT Bits 11–8	Transmit FIFO Counter—Indicates how many data words are in the transmit FIFO. This count does not include words that were transferred to the TXSR.	0000 = 0 data words in the transmit FIFO 0001 = 1 data word in the transmit FIFO 0010 = 2 data words in the transmit FIFO 0011 = 3 data words in the transmit FIFO 0100 = 4 data words in the transmit FIFO 0101 = 5 data words in the transmit FIFO 0110 = 6 data words in the transmit FIFO 0111 = 7 data words in the transmit FIFO 1000 = 8 data words in the transmit FIFO All other settings reserved

Table 24-19. SSIFIFO Control/Status Register Description (continued)

Name	Description	Settings
RFWM Bits 7–4	Receive FIFO Full Water Mark— Specifies the Receive FIFO Water Mark. When the data level of the receive FIFO reaches the Water Mark level, the RFF bit in the SCSR register is set.	0000 = Reserved 0001 = RFF sets when at least one data word is written to the receive FIFO (RFCNT = 1, 2, 3, 4, 5, 6, 7, 8 data words) 0010 = RFF sets when 2 or more data words are written to the receive FIFO (RFCNT = 2, 3, 4, 5, 6, 7, 8 data words) 0011 = RFF sets when 3 or more data words are written to the receive FIFO (RFCNT = 3, 4, 5, 6, 7, 8 data words) 0100 = RFF sets when 4 or more data words are written to the receive FIFO (RFCNT = 4, 5, 6, 7, 8 data words) 0101 = RFF sets when 5 or more data words are written to the receive FIFO (RFCNT = 5, 6, 7, 8 data words) 0110 = RFF sets when 6 or more data words are written to the receive FIFO (RFCNT = 6, 7, 8 data words) 0111 = RFF sets when 7 or more data words are written to the receive FIFO (RFCNT = 7, 8 data words) 1000 = RFF sets when exactly 8 data words are written to the receive FIFO (RFCNT = 8 data words) All other settings reserved
TFWM Bits 3–0	Transmit FIFO Empty Water Mark— Specifies the Transmit FIFO Water Mark. When the data level of the transmit FIFO falls below the Water Mark level, the TFE bit in the SCSR register is set.	0000 = Reserved 0001 = TFE sets when there are 1 or more empty slots in the transmit FIFO (TFCNT = 7, 6, 5, 4, 3, 2, 1, 0 data words) 0010 = TFE sets when there are 2 or more empty slots in the transmit FIFO (TFCNT = 6, 5, 4, 3, 2, 1, 0 data words) 0011 = TFE sets when there are 3 or more empty slots in the transmit FIFO (TFCNT = 5, 4, 3, 2, 1, 0 data words) 0100 = TFE sets when there are 4 or more empty slots in the transmit FIFO (TFCN = 4, 3, 2, 1, 0 data words) 0101 = TFE sets when there are 5 or more empty slots in the transmit FIFO (TFCNT = 3, 2, 1, 0 data words) 0110 = TFE sets when there are 6 or more empty slots in the transmit FIFO (TFCNT = 2, 1, 0 data words) 0111 = TFE sets when there are 7 or more empty slots in the transmit FIFO (TFCNT = 1, 0 data words) 1000 = TFE sets when there are 8 empty slots are in the transmit FIFO (TFCNT = 0 data words) All other settings reserved

24-32 Freescale Semiconductor

Table 24-20. Value of Transmit FIFO Empty (TFE) and Receive FIFO Full (RFF)

Transmit FIFO Water Mark (TFWM)	Number of Data Words in TXFIFO								Number of Data Words in RXFIFO									
or Receive FIFO Water Mark (RFWM)		1	2	3	4	5	6	7	8	0	1	2	3	4	5	6	7	8
1 (0001)	1	1	1	1	1	1	1	1	0	0	1	1	1	1	1	1	1	1
2 (0010)	1	1	1	1	1	1	1	0	0	0	0	1	1	1	1	1	1	1
3 (0011)	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
4 (0100)	1	1	1	1	1	0	0	0	0	0	0	0	0	1	1	1	1	1
5 (0101)	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1
6 (0110)	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1
7 (0111)	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1
8 (1000)	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1

24.3.13 SSI Option Register

The SSI Option Register (SOR) allows the user to clear out the receive FIFO and/or the transmit FIFO, turn the clock off when the SSI is disabled, and reset the frame synchronization and the state machine. This register also includes a user-programmable field to set wait states.

SOR	SSI Option Register													Addr 0x00218028			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
										CLK OFF	RX_CLR	TX_CLR				SYN RST	
TYPE	r	r	r	r	r	r	r	r	r	rw	rw	rw	r	r	r	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET									0x0	000							

Table 24-21. SSI Option Register Description

Name	Description	Settings				
Reserved Bits 31–7	Reserved—These bits are reserved and should read 0.					
CLKOFF Bit 6	Clock Off—Turns off the clocks when the SSI is disabled to further reduce power consumption.	0 = Clocks enabled when SSI disabled 1 = Clocks disabled when SSI disabled				
RX_CLR Bit 5	Receiver Clear—Controls whether the receive FIFO is flushed. The transmit portion of the SSI is not affected. The software must clear RX_CLR before the SSI transmitter can operate.	0 = No effect 1 = Clear receive FIFO				
TX_CLR Bit 4	Transmitter Clear —Controls whether the transmit FIFO is flushed. The receiver portion of the SSI is not affected. The software must clear TX_CLR before the SSI transmitter can operate.	0 = No effect 1 = Clear transmit FIFO				
Reserved Bits 3–1	Reserved—These bits are reserved and should read 0.					
SYNRST Bit 0	Frame Sync Reset—Resets the accumulation of data in the SRX register and receive FIFO (RXFIFO) on frame synchronization.	0 = No effect 1 = Reset data accumulation				

24-34 Freescale Semiconductor

24.4 SSI Data and Control Pins

SSI has six I/O pins. The pins are shared with either Port B or Port C pins, depending on the configuration of the ports. See Section 24.2.3, "Pin Configuration for SSI," for more information. Each pin is described in detail in the sections following Table 24-22.

Pin Description	Pin Name	Port C Multiplexed Pin	Port B Multiplexed Pin
Serial Transmit Data	SSI_TXDAT	PTC [6]	PTB [17]
Serial Receive Data	SSI_RXDAT	PTC [5]	PTB [16]
Serial Transmit Clock	SSI_TXCLK	PTC [8]	PTB [19]
Serial Receive Clock	SSI_RXCLK	PTC [4]	PTB [15]
Serial Transmit Frame Sync	SSI_TXFS	PTC [7]	PTB [18]
Serial Receive Frame Sync	SSI_RXFS	PTC [3]	PTB [14]

Table 24-22. SSI Pin Description

24.4.1 SSI_TXDAT, Serial Transmit Data

The SSI_TXDAT pin transmits data from the TXSR. While data is being transmitted, the SSI_TXDAT pin is an output pin. This pin is disabled between data word transmissions and on the trailing edge of the bit clock after the last bit of a word is transmitted. This pin has an internal pull-up controlled by the GPIO's PUEN bit. For more information, refer to the Chapter 25, "GPIO Module and I/O Multiplexer (IOMUX)."

24.4.2 SSI_RXDAT, Serial Receive Data

The SSI RXDAT pin brings serial data into the SSI Receive Shift Register (RXSR).

24.4.3 SSI_TXCLK, Serial Transmit Clock

The SSI_TXCLK pin can be used as either an input or an output. This clock signal is used by the transmitter and can be either continuous or gated. During gated clock mode, data on the SSI_TXCLK pin is valid only during the transmission of data. If the pull-up is disabled for this pin in the GPIO Module's Pull-Up Enable Register, then the clock pin is tri-stated when data is not transmitting. In synchronous mode, this pin is used by both the transmit and receive sections. When using gated clock mode, an external resistor is connected to this pin to prevent the signal from floating when not being driven.

24.4.4 SSI_RXCLK, Serial Receive Clock

The SSI_RXCLK pin can be used as either an input or an output. This clock signal is used by the receiver and is always continuous. During gated clock mode, the SSI_TXCLK pin is used instead for clocking in data. In I²S master mode, this pin is used as an output pin for the oversampling clock, SYS_CLK (PerCLK3).

24.4.5 SSI_TXFS, Serial Transmit Frame Sync

The SSI_TXFS pin can be used as either an input or an output. The frame sync is used by the transmitter to synchronize the transfer of data. The frame sync signal can be 1 bit-clock or 1 word in length and can occur one bit before the transfer of data or with the transfer of data. (These configurations are set in the STCR.) In synchronous mode, this pin is used by both the transmit and receive sections. In gated clock mode, frame sync signals are not used. When SSI_TXFS is configured as input, the external device should drive SSI_TXFS at the rising or falling edge of SSI_TXCLK, depending on the setting of the TSCKP bit of the SSI Transmit Configuration Register. SSI_TXFS should sync with the rising edge of SSI_TXCLK if the data is clocking out at the rising edge of SSI_TXCLK. SSI_TXFS should sync with the falling edge of SSI_TXCLK if the data is clocking out at the falling edge of SSI_TXCLK.

24.4.6 SSI_RXFS, Serial Receive Frame Sync

The SSI_RXFS pin can be used as either an input or an output. The frame sync is used by the receiver to synchronize the transfer of data. The frame sync signal can be 1 bit-clock or 1 word in length and can occur one bit before the transfer of data or with the transfer of data. (These configurations are set in the SRCR.) When SSI_RXFS is configured as an input, the external device can drive SSI_RXFS at the rising or falling edge of SSI_RXCLK, depending on the setting of the RSCKP bit of the SRCR Register. SSI_RXFS should sync with the rising edge of SSI_RXCLK if the data is clocking out at the rising edge of SSI_RXCLK. SSI_RXFS should sync with the falling edge of SSI_RXCLK if the data is clocking out at the falling edge of SSI_RXCLK.

Figure 24-14 and Figure 24-15 on page 24-37 show the main SSI configurations. These pins support all transmit and receive functions with continuous or gated clocks as shown. Note that gated clock implementations do not require the use of the frame sync pins (SSI_TXFS and SSI_RXFS). In this case, these pins also can be used as GPIO pins.

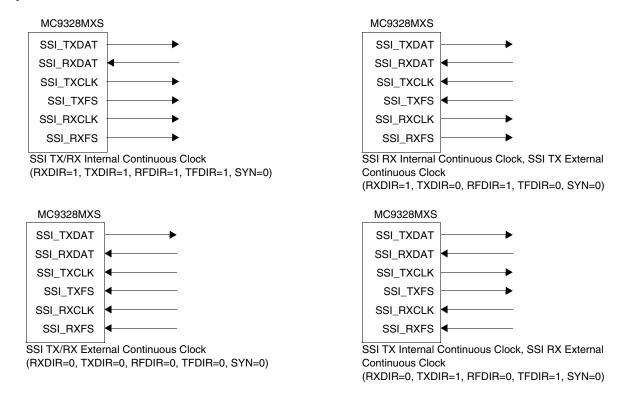


Figure 24-14. Asynchronous (SYN = 0) SSI Configurations—Continuous Clock

24-36 Freescale Semiconductor

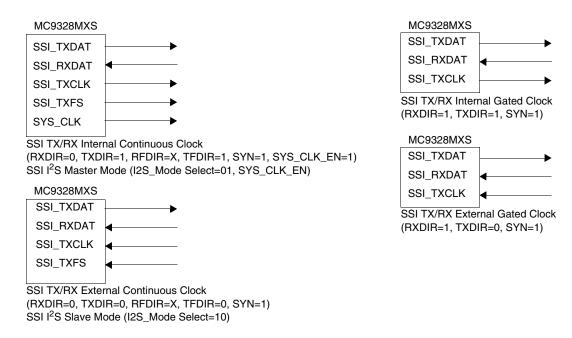


Figure 24-15. Synchronous SSI Configurations—Continuous and Gated Clock

An example of the pin signals for an 8-bit data transfer is shown in Figure 24-16. Continuous and gated clock signals are shown, as well as the bit-length frame sync signal and the word-length frame sync signal.

NOTE:

The shift direction can be defined as MSB first or LSB first.

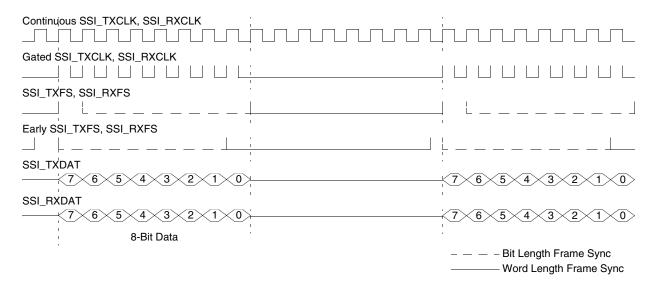


Figure 24-16. Serial Clock and Frame Sync Timing

SSI Operating Modes

24.5 SSI Operating Modes

SSI module three basic operating modes, with the option of asynchronous or synchronous protocol for most modes

- Normal mode
 - asynchronous protocol
 - synchronous protocol
- Network mode
 - asynchronous protocol
 - synchronous protocol
- Gated clock mode
 - synchronous protocol only

The mode of the SSI is determined by several bits in the SSI control registers. Table 24-23 lists these operating modes and gives examples of applications that typically use each mode.

TX, RX Sections	Serial Clock	Mode	Typical Application				
Asynchronous	Continuous	Normal	Multiple synchronous codecs				
Asynchronous	Continuous	Network	TDM codec or DSP networks				
Synchronous	Continuous	Normal	Multiple synchronous codecs				
Synchronous	Continuous	Network	TDM codec or DSP network				
Synchronous	Gated	Normal	SPI-type devices; DSP to MCU				

Table 24-23. SSI Operating Modes

The transmit and receive sections of the SSI can be synchronous or asynchronous. In synchronous mode, the transmitter and the receiver use a common clock and frame synchronization signal. In asynchronous mode, the transmitter and receiver each have their own clock and frame synchronization signals. Continuous or Gated clock mode can be selected. In continuous mode, the clock runs continuously. In gated clock mode, the clock is only functioning during transmission.

Normal or network mode also can be selected. In normal mode, the SSI functions with one data word of I/O per frame. In network mode, a frame can contain between 2 and 32 data words. Network mode is typically used in star or ring-time division multiplex networks with other processors or codecs, allowing interface to time division multiplexed networks without additional logic. Use of the gated clock is not allowed in network mode. These distinctions result in the basic operating modes that allow the SSI to communicate with a wide variety of devices.

The SSI supports both normal and network modes, and these can be selected regardless of whether the transmitter and receiver are synchronous or asynchronous. Typically these protocols are used in a periodic manner, when data is transferred at regular intervals, such as at the sampling rate of an external codec. Both modes use the concept of a frame. The beginning of the frame is marked with a frame sync when programmed with continuous clock. The frame sync occurs at a periodic interval. The length of the frame is determined by the DC field in either the SRCCR or STCCR register, depending on whether data is being transferred or received. The number of words transferred per frame depends on the mode of the SSI.

24-38 Freescale Semiconductor

In normal mode, one data word is transferred per frame. In network mode, the frame is divided into anywhere between 2 and 32 time slots, when one data word can optionally be transferred in each time slot.

24.5.1 Normal Mode

Normal mode is the simplest mode of the SSI. It transfers one word per frame. In continuous clock mode, a frame sync occurs at the beginning of each frame. The length of the frame is determined by the fields of the STCCR or SRCCR registers:

- The period of the serial bit clock. For external clocking, this is based on the frequency on the SSI_TXCLK pin. For an internal clock, this is determined by the values of the PSR bit and the PM field.
- The number of bits per sample (WL)
- The number of time slots per frame (DC)

When normal mode is configured to provide more than one time slot per frame, data is transmitted only in the first time slot. No data is transmitted in subsequent time slots.

24.5.1.1 Normal Mode Transmit

The conditions for data transmission from the SSI in normal mode are:

- 1. SSI enabled (SCSR:SSI EN = 1)
- 2. Enable the FIFO (STCR:TFEN = 1) and configure the transmit (SFCSR:TFWM) and receive (SFCSR:RFWM) Water Marks if the FIFO is used.
- 3. Write data to the STX register
- 4. Enable transmitter (SCSR:TE = 1)
- 5. Active frame sync (required for continuous clock)
- 6. Active bit clock (the bit clock is active when the transmitter is enabled; for a gated clock, see Table 24-14)

When these conditions occur in normal mode, the next data word is transferred into the TXSR. When the transmit FIFO is enabled, the data word is transferred from the transmit FIFO. When the transmit FIFO is disabled, the data word is transferred from the STX register.

The new data word is transmitted immediately and the TDE bit is set.

When the transmit FIFO is disabled and the TIE bit in the STCR is set, the transmit interrupt occurs. When the transmit FIFO is enabled, the FIFO waits until the Transmit Water Mark level has been reached. The transmit interrupt then occurs if the TIE bit is set. In this case, an eighth data word is transferred and shifted out before the MC9328MXS writes new data to the STX register.

The SSI_TXDAT pin is disabled except during the data transmission period. For a continuous clock, the optional frame sync output and clock outputs are not tri-stated, even when both receiver and transmitter are disabled.

24.5.1.2 Normal Mode Receive

The conditions for data reception from the SSI are:

- 1. SSI enabled (SCSR:SSI EN = 1)
- 2. Receiver enabled (SCSR:RE = 1)
- 3. Active frame sync (required for continuous clock)

SSI Operating Modes

4. Active bit clock (the bit clock is active when the receiver is enabled; for a gated clock, see Table 24-14)

With these conditions are met in normal mode with a continuous clock, each time the frame sync signal is generated (or detected), a data word is clocked in. Also given these conditions and a gated clock, each time the clock begins, a data word is clocked in.

When the receive FIFO is not enabled, after receiving a data word, the data is transferred from the RXSR to the SRX register. The RDR bit is set, and the receive interrupt occurs if it is enabled (the RIE bit is set).

When the receive FIFO is enabled, after receiving the data word, it is transferred to the receive FIFO. The RFF bit is set when the SRX register is full and receive FIFO register reaches the select threshold (Receive Water Mark), and the receive interrupt occurs if the RIE bit is set.

The MC9328MXS program must read the data from the SRX register before a new data word is transferred from the RXSR, otherwise the ROE bit is set. When the receive FIFO is enabled, the ROE bit is set when the SRX register and the receive FIFO are full of data and a new data word is ready to be transferred to the receive FIFO. Figure 24-17 shows transmitter and receiver timing for an 8-bit word with two words per time slot in normal mode, with a continuous clock and a late word length frame sync.

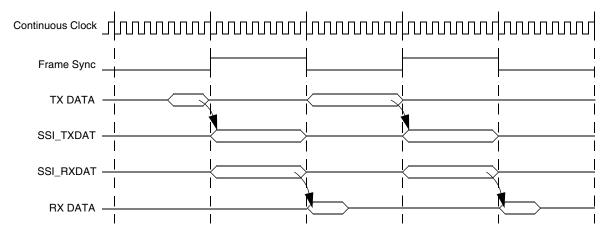


Figure 24-17. Normal Mode Timing—Continuous Clock

Figure 24-18 shows a similar case for a gated clock. A pull-down resistor is required in the gated clock example because the clock pin is tri-stated between transmissions.

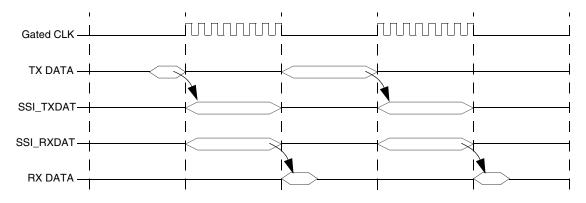


Figure 24-18. Normal Mode Timing—Gated Clock

MC9328MXS Reference Manual, Rev. 1

24-40 Freescale Semiconductor

24.5.2 Network Mode

Network mode is used for creating a Time Division Multiplexed (TDM) network, such as a TDM codec network or a network of DSPs. In continuous clock mode, a frame sync occurs at the beginning of each frame. In this mode, the frame is divided into more than one time slot. During each time slot, one data word can be transferred. Each time slot is then assigned to an appropriate codec or DSP on the network. The DSP can be a master device that controls its own private network, or a slave device that is connected to an existing TDM network and occupies a few time slots.

The frame sync signal indicates the beginning of a new data frame. Each data frame is divided into time slots and transmission and/or reception of one data word can occur in each time slot (rather than in just the frame sync time slot as in normal mode). The frame rate divider, controlled by the DC bits of the STCCR or SRCCR, selects 2 to 32 time slots per frame.

The length of the frame is determined by the fields of the STCCR or SRCCR registers:

- The period of the serial bit clock
 - for external clocking, this is based on the frequency on the SSI TXCLK pin
 - for internal clocking, this is based on the values of the PSR bit and the PM field
- The number of bits per sample (WL)
- The number of time slots per frame (DC)

In network mode, data can be transmitted in any time slot. The distinction of the network mode is that each time slot is identified with respect to the frame sync (data word time). This time slot identification allows the option of transmitting data during the time slot by writing to the STX register or ignoring the time slot by writing to SSI Time Slot Register (STSR). The receiver is treated in the same manner, except that data is always being shifted into the RXSR and transferred to the SRX register. The MC9328MXS reads the SRX register and either uses it or discards it.

24.5.2.1 Network Mode Transmit

The transmit portion of the SSI is enabled when the SSI_EN and the TE bits in the SCSR are both set. However, for a continuous clock, when the TE bit is set, the transmitter is enabled only after detection of a new time slot (if the TE bit is set during a slot other than the first). The software must find the start of the next frame.

The normal start-up sequence for transmission is as follows:

- 1. Write the data to be transmitted to the STX register. This clears the TDE bit.
- 2. Set the TE bit to enable the transmitter on the next word boundary (for continuous clock).
- 3. Enable transmit interrupts.

If the programmer decides not to transmit in a time slot by writing to the SSI Time Slot Register (STSR), this clears the TDE bit, however the SSI_TXDAT pin remains disabled during the time slot. When the frame sync is detected or generated (continuous clock), the first enabled data word is transferred from the STX register to the TXSR and is shifted out (transmitted). When the STX register is empty, the TDE bit is set. When the TIE bit in the STCR is set, setting the TDE bit causes a transmitter interrupt to occur.

The software can poll the TDE bit or use interrupts to reload the STX register with new data for the next time slot, or can write to the STSR to prevent transmitting in the next time slot. Failing to write to the STX register (or the STSR) before the TXSR is finished shifting (empty) causes a transmitter underrun. This is detected by the TUE bit of the SCSR. When this happens, the SSI TXDAT pin continuously sends the last transmitted data.

SSI Operating Modes

Clearing the TE bit disables the transmitter (and the SSI_TXDAT pin) after transmission of the current data word is complete. Setting the TE bit enables transmission of the next word. The TE bit is cleared after the TDE bit is set to ensure that all pending data is transmitted.

To summarize, in network mode, the transmitter can generate an interrupt during every enabled time slot or require the DSP program to poll the TDE bit. When the TDE bit is set, the MC9328MXS responds with one of the following actions:

- Write data to the STX register—enables transmission in the next time slot.
- Write to the SSI Time Slot Register (STSR)—disables transmission in the next time slot.
- Do nothing—causes a transmit underrun to occur at the beginning of the next time slot (the previous data is re-transmitted).

24.5.2.2 Network Mode Receive

The receiver portion of the SSI is enabled when both the SSI_EN and the RE bits in the SCSR are set. However, the receive enable takes place during that time slot only if the RE bit is enabled before the second to last bit of the word. When the RE bit is cleared, the receiver is disabled immediately. SSI is capable of finding the start of the next frame automatically. The word is received into the RXSR and then transferred to the SRX register when the whole word is received. The transfer to the SRX register sets the RDR bit. When the RIE bit is set, setting the RDR bit causes a receive interrupt to occur.

After the received word is transferred to the SRX register, the second data word (second time slot in the frame), begins shifting in immediately. The DSP program must read the data from the SRX register (this clears the RDR bit) before the second data word is completely received into the RXSR or a receive overrun error occurs. This is detected by the ROE bit of the SCSR.

To summarize, in network mode, the receiver can generate an interrupt during every enabled time slot or require the DSP program to poll the RDR bit. When the TDE bit is set, the MC9328MXS responds with one of the following actions:

- Read the SRX register and use the data.
- Read the SRX register and ignore the data.
- Do nothing—a receiver overrun occurs at the end of the current time slot.

NOTE:

For a continuous clock, the optional frame sync output and clock output signals are not affected even when the transmitter or receiver is disabled. The TE and RE bits do not disable the bit clock or the frame sync generation. The only way to disable the bit clock and the frame sync generation is to disable the SSI_EN bit in the SCSRregister.

Figure 24-19 on page 24-43 shows the transmitter and receiver timing for an 8-bit word with continuous clock, with the FIFO disabled, and with a frame size of three words per frame sync, operating in network mode.

24-42 Freescale Semiconductor

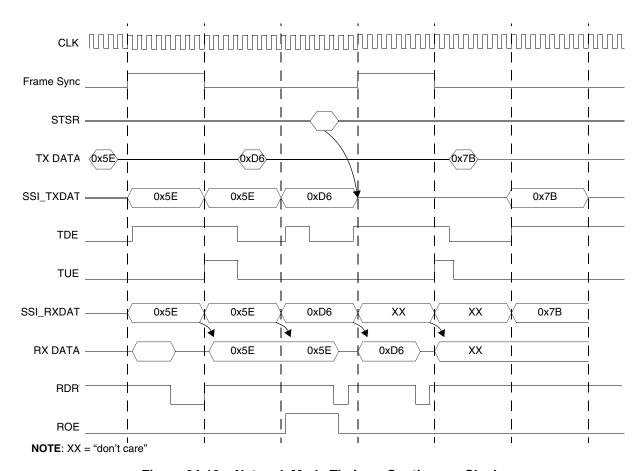


Figure 24-19. Network Mode Timing—Continuous Clock

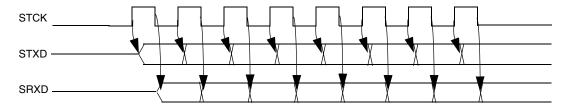
24.6 Gated Clock Mode

The gated clock mode is often used to connect to SPI-type interfaces on Microcontroller Units (MCUs) or external peripheral chips. In gated clock mode, the presence of the clock indicates that valid data is on the SSI_TXDAT or SSI_RXDAT pins. For this reason, no frame sync is needed in this mode. When transmission of data is complete, the clock pin is tri-stated. Gated clocks are allowed for both the transmit and receive sections with either internal or external clock and in Normal mode. Gated clocks are not allowed in Network mode.

The clock runs when the TE bit or the RE bit in the SCSR are appropriately enabled. For clocks that are generated internally, all internal bit clocks, word clocks, and frame clocks continue to operate. When a valid time slot occurs, such as the first time slot in normal mode, the internal bit clock is enabled onto the appropriate clock pin. This allows data to be transferred out in periodic intervals in gated clock mode. When an external clock is used, the SSI waits for a clock signal to be received. When the clock begins, valid data is shifted in.

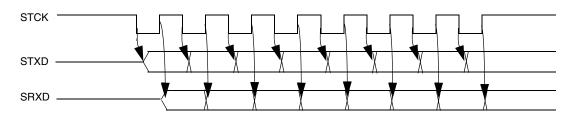
For gated clock operation in external clock mode, a proper clock signal must be applied to the SSI STCK for proper function. If the SSI uses a rising edge transition to clock data (TSCKP=0) and a falling edge transition to latch data(RSCKP=0), the clock must be in an active low state when idle. If the SSI uses a falling edge transition to clock data (TSCKP=1) and a rising edge transition to latch data (RSCKP=1), the clock must be in an active high state when idle. The following diagrams illustrate the different edge clocking and latching.

External Frame and Clock Operation



TSCKP=0, RSCKP=0

Figure 24-20. Rising Edge Clocking with Falling Edge Latching



TSCKP=1, RSCKP=1

Figure 24-21. Falling Edge Clocking with Rising Edge Latching

For gated clock operation in internal clock mode, only the rising edge transition to clock data (TSCKP=0) and falling edge transition to latch data (RSCKP=0) is supported. The clock will always be in an active low state when idle. TSCKP=1 and RSCKP=1 are not supported in internal clock mode.

NOTE:

The bit clock pins must be kept free of timing glitches. A single glitch causes all subsequent transfers to lose synchronization.

When there is new data to be transmitted after the idle state has been entered, the data written to the Transmit FIFO will be transmitted immediately.

24.7 External Frame and Clock Operation

When applying external frame sync and clock signals to SSI, at least 4 clock cycle delays should occur before the rising edge of the frame sync signal. The transition of SSI_TXFS or SSI_RXFS is synchronized with the rising edge of the external clock signal, SSI_TXCLK or SSI_RXCLK.

24.8 SSI Reset and Initialization Procedure

The SSI is affected by three types of reset:

• Power-on reset—The power-on reset is generated by asserting either the RESET pin or the Computer Operating Properly (COP) timer reset. The power-on reset clears the SSI_EN bit in the SCSR and disables the SSI.

MC9328MXS Reference Manual, Rev. 1

24-44 Freescale Semiconductor

• SSI reset—The SSI reset is generated when the SSI_EN bit in the SCSR is cleared. The SSI status bits are reset to the same state produced by the power-on reset. The SSI control bits are unaffected. The control bits in the top half of the SCSR are also unaffected. The SSI reset is useful for selective reset of the SSI without changing the present SSI control bits and without affecting the other peripherals.

The correct sequence to initialize the SSI is as follows:

- 1. Issue a power-on or SSI reset.
- 2. Set the SSI EN bit in the SCSR.
- 3. Set all other control bits (such as TXDIR and RXDIR).
- 4. Set the TE and RE bits in the SCSR.

To ensure proper operation of the SSI, use the power-on or SSI reset before changing any of the control bits listed in Table 24-24. These control bits should not be changed during SSI operation.

Table 24-24. SSI Control Bits Requiring Reset Before Change

Control Register	Bit
SRCCR and STCCR	[14:13] = WL [1:0]
STCR and SRCR	[9] = TDMAE / RDMAE [6] = TFDIR / RFDIR [5] = TXDIR / RXDIR [4] = TSHFD / RSHFD [3] = TSCKP / RSCKP [2] = TFSI / RFSI [1] = TFSL / RFSL [0] = TEFS / REFS
SCSR	[15] = SYS_CLK_EN [14:13] = I2S_MODE [12] = SYN [11] = NET

NOTE:

The SSI bit clock must go low for at least one complete period to ensure proper SSI reset.

SSI Reset and Initialization Procedure

MC9328MXS Reference Manual, Rev. 1

24-46 Freescale Semiconductor

Chapter 25 GPIO Module and I/O Multiplexer (IOMUX)

25.1 General Description

This chapter describes the four GPIO ports of the MC9328MXS. All of the GPIO port pins are multiplexed with other signals.

NOTE:

See Chapter 2, "Signal Descriptions and Pin Assignments," for detailed I/O multiplexing information.

This section contains the description of the top level I/O multiplexing strategy in the MC9328MXS, which consists of two modules:

- Software controllable multiplexing performed in the GPIO module
- Hardware multiplexing performed in the IOMUX module

The I/O multiplexing strategy is designed to configure the inputs and outputs of the MC9328MXS to allow the same I/O pad to be used for peripheral functions and GPIO. The I/O multiplexing is designed to be as flexible as possible and to allow the simple and quick reuse of this system in future derivatives of the MC9328MXS. In addition to the I/O multiplexing, the IOMUX module contains the JTAG shift registers, which significantly simplify the I/O design.

There are four GPIO ports on the MC9328MXS: Port A, Port B, Port C, and Port D. Each port consists of 32 pins, however not all pins are used. The usable port pins are:

- Port A—pins 0–31
- **Port B**—pins 8–31
- Port C—pins 3–17
- **Port D**—pins 6–31

Figure 25-1 on page 25-2 depicts a top-level view of the IOMUX and GPIO modules for a single port pin. This circuitry is duplicated for each of the 97 port pins.

MC9328MXS Reference Manual, Rev. 1

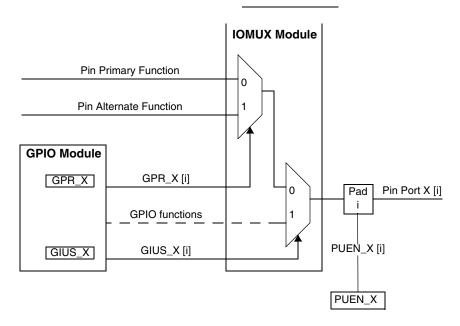


Figure 25-1. Top Level of Circuitry for Port X, Pin [i]

25.2 GPIO Module Overview

Most of this chapter focuses on the GPIO module, which provides general purpose I/O capability to the device. The GPIO module communicates with the ARM920T processor through an IPBUS interface connected as an IP peripheral. The complete module controls 97 bidirectional port pins. Software configurability allows each I/O to be configured as general purpose input (optionally routed to two different destinations) or general purpose output (from one out of four selectable sources).

25.2.1 GPIO Module Features

The GPIO module features include:

- 97 direction-configurable port pins
- Software controllable input/output selection through four 32-bit direction registers
- Software control for multiplexing one of four different sources (a data register and three peripheral modules on the MC9328MXS) for every output pin
- Software control for routing every input to other modules
- Input data sampling on each clock
- Software control of the IOMUX module through four 32-bit general purpose registers
- Configurability of each input port pin interrupt as positive edge triggered, negative edge triggered, positive level sensitive, negative level sensitive or as a masked interrupt
- Ability to logically OR each port's 32 interrupt lines to a single interrupt to the ARM920T processor
- Software reset

MC9328MXS Reference Manual, Rev. 1

25.2.2 Interrupts

The interrupt block inside the GPIO module controls all GPIO interrupt signals. Inside this block, interrupts are defined as positive edge triggered, negative edge triggered, positive level sensitive, negative level sensitive, or masked. For edge triggered interrupts, the edge is detected by the GPIO interrupt block and is converted to a low level interrupt that is routed to other internal modules. When the interrupt is masked, a value of 1 is driven to the interrupt controller regardless of the GPIO input value. The interrupts waiting for service are stored in the Interrupt Status Register (ISR) for that port. Write a value of 1 to the ISR to clear the interrupt. The logical OR of all the non-masked interrupt lines is available as an output from the port. Individual interrupts for each port pin may also be output to other internal modules.

25.2.3 GPIO Signal Description

The circuitry for a single pin of the GPIO module is shown in Figure 25-2 on page 25-4. The signals shown in that figure and the signals shown in Figure 25-1 on page 25-2 are described in Table 25-1.

Table 25-1. GPIO External Pins Description

Signal Name	Direction	Description
AIN	Input	A 32-bit input from MC9328MXS. Any signal may be connected. This input may be reflected to GPIO output (GPIO-Out in Figure 25-2) by appropriate GPIO configuration.
BIN	Input	Same as AIN.
CIN	Input	Not Used.
AOUT	Output	A 32-bit output from the GPIO that connects external pins to internal signals in the MC9328MXS, sends an interrupt signal to an internal module, or is connected high or low.
BOUT	Output	Not Used.
GIUS_X	Output	Represents one of four GPIO In-Use Registers (GIUS). Connects to the IOMUX module and selects whether a pin is used for GPIO or a peripheral function.
GPR_X	Output	Represents one of the four General Purpose Registers (GPR). Connects to the IOMUX module and selects whether a pin is used for its primary or alternate function.
PUEN_X	Output	Selects whether the port pin is pulled up to a logic high.
GPIO_INT	Output	The OR value of all 32 interrupt lines. Each pin [i] of the port corresponds to pin [i] of the ISR register.

25.3 GPIO Module Block Diagram

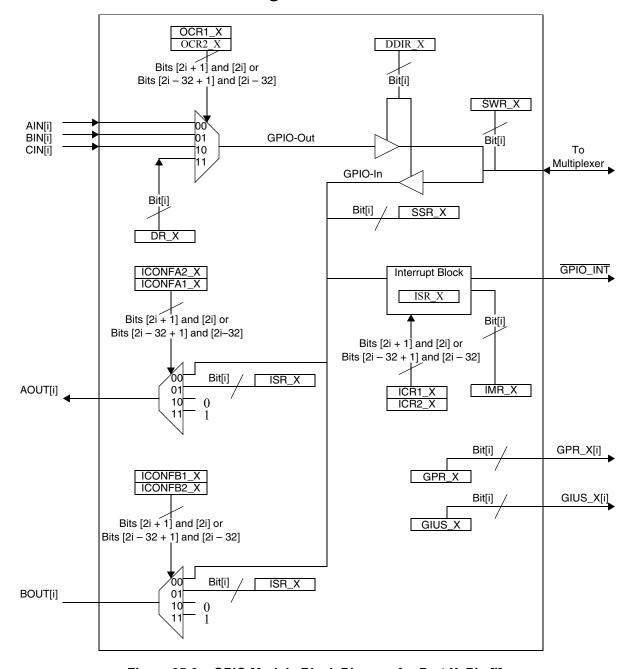


Figure 25-2. GPIO Module Block Diagram for Port X, Pin [i]

25.4 Pin Configuration for GPIO

The GPIO port pins on the MC9328MXS are multiplexed with signals from peripheral modules on the device. These pins must be configured for GPIO operation. Table 25-2 on page 25-5 shows the pin configuration.

25-4 Freescale Semiconductor

To further expand the multiplexing features of the GPIO module, added functionality was incorporated to route the input and output signals of selected peripherals. These signals are routed to the GPIO module via AIN[i], BIN[i], CIN[i], AOUT[i], and BOUT[i], where "i" denotes any bit from bit 31 to bit 0. There are a set of these signals available for each GPIO Port (Port A, Port B, Port C, and Port D). The "IN" signals denote inputs to the GPIO module whereas the "OUT" signals are outputs from the GPIO module, as can be seen in Figure 25-2 on page 25-4. In the case of the "IN" signals, these signals are passed through the GPIO module from the selected peripheral and are output to the MC9328MXS pins. Therefore, the Data Direction Register for the desired "IN" signal must be set as an output. On the other hand, in the case of the "OUT" signals, these signals are also passed through the GPIO module, however their inputs come from the MC9328MXS pins and are output to the selected peripheral. Therefore, the Data Direction register for the desired "OUT" signal must be set as an input. For example, if the user wants to route the SPI2 RXD input via the PA1 pin, they must set GIUS A bit 1 for GPIO function (set bit 1). The next step would then be to clear the ICONFA1 A bits 2 and 3 (to 00) to select the GPIO-IN to allow PA1 to drive AOUT[1]. Finally, the DDIR bit 1 must be set as an input (clear bit 1). Should the user need to route the SPI2 CLK output via pin PD7, they must first set bit 7 of GIUS D. The next step is to clear bits 15 and 14 of OCR1 D to select AIN[7] as an input to the GPIO module. Finally, bit 7 of DDIR must be set to select this signal as an output from the GPIO module to the external pin. Table 25-3 shows the signals that use this expanded functionality.

Table 25-2. Pin Configuration

Pin	Configuration Procedure
Port A Pins 31–0	 For each pin [i] that is used as a GPIO, set bit [i] in the Port A GPIO In Use Register (GIUS_A). When pin [i] is used as an input: Clear bit [i] in the Port A Data Direction Register (DDIR_A) Read the Port A Sample Status Register (SSR_A) as needed When pin [i] is used as an output: Set bits [2i + 1] and [2i] in the Port A Output Configuration Register 1 (OCR1_A) or Set bits [2i - 32 + 1] and [2i - 32] in the Port A Output Configuration Register 2 (OCR2_A) Write desired output value to bit [i] of the Port A Data Register (DR_A) Set bit [i] in the Port A Data Direction Register (DDIR_A)
Port B Pins 31–8	 For each pin [i] that is used as a GPIO, set bit [i] in thePort B GPIO In Use Register (GIUS_B). When pin [i] is used as an input: Clear bit [i] in the Port B Data Direction Register (DDIR_B) Read the Port B Sample Status Register (SSR_B) as needed When pin [i] is used as an output: Set bits [2i + 1] and [2i] in the Port B Output Configuration Register 1 (OCR1_B) or Set bits [2i - 32 + 1] and [2i - 32] in the Port B Output Configuration Register 2 (OCR2_B) Write desired output value to bit [i] of the Port B Data Register (DR_B) Set bit [i] in the Port B Data Direction Register (DDIR_B)

Table 25-2. Pin Configuration (continued)

Pin	Configuration Procedure
Port C Pins 17–3	 For each pin [i] that is used as a GPIO, set bit [i] in the Port C GPIO In Use Register (GIUS_C). When pin [i] is used as an input:
	 Clear bit [i] in the Port C Data Direction Register (DDIR_C) Read the Port C Sample Status Register (SSR_C) as needed When pin [i] is used as an output:
	 Set bits [2i + 1] and [2i] in the Port C Output Configuration Register 1 (OCR1_C) or Set bits [2i - 32 + 1] and [2i - 32] in the Port C Output Configuration Register 2 (OCR2_C) Write desired output value to bit [i] of the Port C Data Register (DR_C) Set bit [i] in the Port C Data Direction Register (DDIR_C)
Port D Pins 31–6	 For each pin [i] that is used as a GPIO, set bit [i] in the Port D GPIO In Use Register (GIUS_D). When pin [i] is used as an input: Clear bit [i] in the Port D Data Direction Register (DDIR_D) Read the Port D Sample Status Register (SSR_D) as needed When pin [i] is used as an output: Set bits [2i + 1] and [2i] in the Port D Output Configuration Register 1 (OCR1_D) or Set bits [2i - 32 + 1] and [2i - 32] in the Port D Output Configuration Register 2 (OCR2_D) Write desired output value to bit [i] of the Port D Data Register (DR_D) Set bit [i] in the Port D Data Direction Register (DDIR_D)

25.5 Programming Model

There are four sets of control registers corresponding to the four GPIO ports. Each port has 17 registers associated with it, located at sequential addresses in the memory map. Table 25-3 summarizes these registers and their addresses.

The starting address of each register set is known as the *base address* and is referred to by the term \$BA. The base addresses for the four GPIO ports are as follows:

- GPIO Port A \$BA = 0x0021C000
- GPIO Port B \$BA = 0x0021C100
- GPIO Port C \$BA = 0x0021C200
- GPIO Port D \$BA = 0x0021C300

Table 25-3. GPIO Module Register Memory Map

Description ¹	Name ¹	Address
Port X Data Direction Register	DDIR_X	\$BA + \$000
Port X Output Configuration Register 1	OCR1_X	\$BA + \$004
Port X Output Configuration Register 2	OCR2_X	\$BA + \$008
Port X Input Configuration Register A1	ICONFA1_X	\$BA + \$00C

MC9328MXS Reference Manual, Rev. 1

25-6 Freescale Semiconductor

Table 25-3. GPIO Module Register Memory Map (continued)

Description ¹	Name ¹	Address
Port X Input Configuration Register A2	ICONFA2_X	\$BA + \$010
Port X Input Configuration Register B1	ICONFB1_X	\$BA + \$014
Port X Input Configuration Register B2	ICONFB2_X	\$BA + \$018
Port X Data Register	DR_X	\$BA + \$01C
Port X GPIO In Use Register	GIUS_X	\$BA + \$020
Port X Sample Status Register	SSR_X	\$BA + \$024
Port X Interrupt Configuration Register 1	ICR1_X	\$BA + \$028
Port X Interrupt Configuration Register 2	ICR2_X	\$BA + \$02C
Port X Interrupt Mask Register	IMR_X	\$BA + \$030
Port X Interrupt Status Register	ISR_X	\$BA + \$034
Port X General Purpose Register	GPR_X	\$BA + \$038
Port X Software Reset Register	SWR_X	\$BA + \$03C
Port X Pull_Up Enable Register	PUEN_X	\$BA + \$040

^{1.} X is a variable representing A, B, C or D. The actual register names include the port.

MC9328MXS Reference Manual, Rev. 1

25.5.1 Data Direction Registers

The data direction registers specify whether each pin of the port is an input or an output pin.

There are four distinct Data Direction Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

DDIR_A Port A Data Direction Register Port B Data Direction Register Port C Data Direction Register DDIR_D Port D Data Direction Register										0x0 0x0	00210 00210 00210	Addr C000 C100 C200 C300				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								DE	DIR							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESET	0x0000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								DE	DIR							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
. ILOL I								0x0	000							

Table 25-4. Data Direction Registers Description

Name	Description	Settings
DDIR [i] Bits 31–0	Data Direction—Controls the direction of the pins.	0 = Pin [i] is an input 1 = Pin [i] is an output

25.5.2 Output Configuration Registers

The output configuration registers specify the output signal for each pin. There are two bits in the output configuration registers for each port pin.

There are two output configuration registers for each port; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

25.5.2.1 Output Configuration Register 1

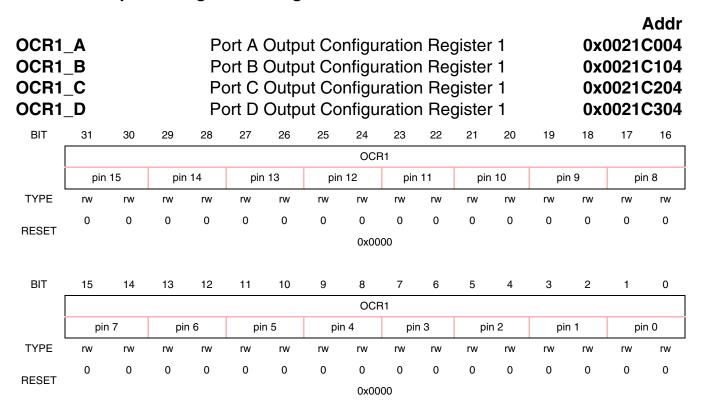


Table 25-5. Output Configuration Register 1 Description

Name	Description	Settings						
OCR1 [i] Bits 31–0	Output Configuration—Corresponds to pins 0–15 of the port and defines which one of the four options is selected as the output signal GPIO-Out. Each port pin [i] (i = 0 through	OCR1 [2i + 1]	OCR1 [2i]	Output Selected				
	15) requires two OCR1 bits to determine the output signal.	0	0	External input AIN [i]				
		0	1	External input BIN [i]				
		1	0	External input CIN [i]				
		1	1	Data Register [i]				

25.5.2.2 Output Configuration Register 2

OCR2 OCR2 OCR2 OCR2	_B _C			Po Po	ort B	Outpu Outpu Outpu Outpu	ut Co ut Co	nfigu nfigu	ratior ratior	n Reg n Reg	giste giste	r 2 r 2		0x0	00210 00210 00210 00210	C108 C208
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								OCF	R2							
	pin	31	pin	30	pin	29	pin	28	pin	27	pir	1 26	pin	25	pin	24
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								OCF	R2							
	pin	23	pin	22	pin	21	pin	20	pin	19	pir	18	pin	17	pin	16
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							

Table 25-6. Output Configuration Register 2 Description

Name	Description		Settin	gs
OCR2 [i] Bits 31–0	Output Configuration—Corresponds to pins 16–31 of the port and defines which one of the four options is selected as the output signal GPIO-Out. Each port pin [i] (i	OCR2 [2i-32 + 1]	OCR2 [2i–32]	Output Selected
	= 16 through 31) requires two OCR2 bits to determine the output signal.	0	0	External input AIN [i]
		0	1	External input BIN [i]
		1	0	External input CIN [i]
		1	1	Data Register [i]

25.5.3 Input Configuration Registers

The input configuration registers ICONFA1 and ICONFA2 specify the signal or value driven to the AOUT bus. The input configuration registers ICONFB1 and ICONFB2 specify the signal or value driven to the BOUT bus. There are two bits in the input configuration registers for each port pin.

There are four distinct input configuration registers for each port; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

25.5.3.1 Input Configuration Register A1

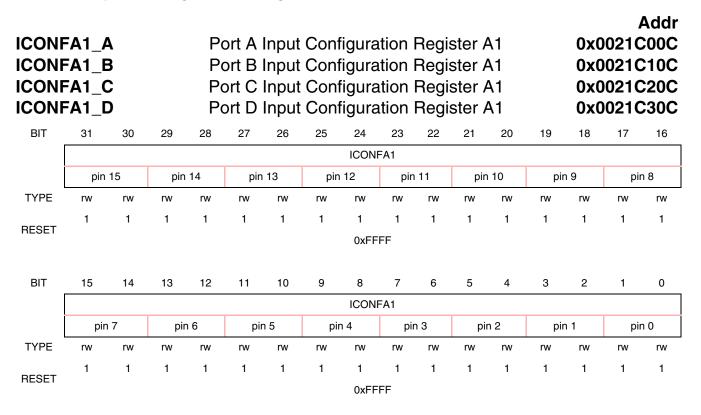


Table 25-7. Input Configuration Register A1 Description

Name	Description		Se	ettings
ICONFA1 [i] Bits 31–0	Input Configuration—Corresponds to pins 0–15 of the port and defines which one of the four options is driven to AOUT [i]. Each port pin [i] (i = 0	ICONFA1 [2i + 1]	ICONFA1 [2i]	Input Selected
	through 15) requires two ICONFA1 bits to determine the input value.	0	0	GPIO-In [i]
	·	0	1	Interrupt Status Register [i]
		1	0	0
		1	1	1

25.5.3.2 Input Configuration Register A2

ICONF ICONF ICONF	FA2_E FA2_(3		Po Po	ort B ort C	Input Input Input Input	Conf Conf	igura igura	tion ation	Regi: Regi:	ster A ster A	A2 A2		Addr 0x0021C010 0x0021C110 0x0021C210 0x0021C310			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
								ICON	FA2								
	pin	31	pin	30	pin	29	pin	28	pin	27	pin	ı 26	pin	25	pin	24	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
HEOLI								0xFF	FF								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								ICON	FA2								
	pin	23	pin	22	pin	21	pin	20	pin	19	pin	18	pin	17	pin	16	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
TILOLI								0xFF	FF								

Table 25-8. Input Configuration Register A2 Description

Name	Description	Settings							
ICONFA2 [i] Bits 31–0	Input Configuration—Corresponds to pins 16–31 of the port and defines which one of the four options is driven to AOUT [i]. Each port pin [i]	ICONFA2 [2i – 32 + 1]	ICONFA2 [2i – 32]	Input Selected					
	(i = 16 through 31) requires two ICONFA2 bits to determine the input value.	0	0	GPIO-In [i]					
	·	0	1	Interrupt Status Register [i]					
		1	0	0					
		1	1	1					

25.5.3.3 Input Configuration Register B1

ICONF ICONF ICONF	B1_E B1_0	3			Addr 0x0021C014 0x0021C114 0x0021C214 0x0021C314											
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								ICON	FB1							
	pin	15	pin	14	pin	13	pin	12	pin	11	pin	10	pir	ı 9	pir	n 8
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
TILOLI								0xFF	FF							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								ICON	FB1							
	pir	า 7	pir	า 6	piı	า 5	pir	า 4	pir	า 3	piı	า 2	pin	1	pir	า 0
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
ITEGET								0xFF	FF							

Table 25-9. Input Configuration Register B1 Description

Name	Description		Se	ttings
ICONFB1 [i] Bits 31–0	Input Configuration—Corresponds to pins 0–15 of the port and defines which one of the four options is driven to BOUT [i]. Each port pin [i] (i = 0 through	ICONFB1 [2i + 1]	ICONFB1 [2i]	Input Selected
	15) requires two ICONFB1 bits to determine the input value.	0	0	GPIO-In [i]
	•	0	1	Interrupt Status Register [i]
		1	0	0
		1	1	1

25.5.3.4 Input Configuration Register B2

ICONF ICONF ICONF	B2_E B2_0	3		Po Po	ort B	Input Input Input Input	Conf Conf	igura igura	tion lation	Regi: Regi:	ster E ster E	32 32		Addr 0x0021C018 0x0021C118 0x0021C218 0x0021C318			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
								ICON	FB2								
	pin	31	pin	30	pin	29	pin	28	pin	27	pin	26	pin	25	pin	24	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
NLOLI								0xFF	FF								
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								ICON	FB2								
	pin	23	pin	22	pin	21	pin	20	pin	19	pin	18	pin	17	pin	16	
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
TILGET								0xFF	FF								

Table 25-10. Input Configuration Register B2 Description

Name	Description		Setti	ngs
ICONFB2 [i] Bits 31–0	Input Configuration—Corresponds to pins 16–31 of the port and defines which one of the four options is driven to BOUT [i]. Each port	ICONFB2 [2i – 32 + 1]	ICONFB2 [2i – 32]	Input Selected
	pin [i] (i = 16 through 31) requires two ICONFB2 bits to determine the input value.	0	0	GPIO-In [i]
	,	0	1	Interrupt Status Register [i]
		1	0	0
		1	1	1

25.5.4 Data Registers

The Port X Data Register holds the value to be output from port X when a pin is configured as an output and the Data Register is chosen in the Output Configuration Register 1 and Output Configuration Register 2.

There are four distinct Data Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

DR_A DR_B DR_C DR_D						Po Po	rt A C rt B C rt C C rt D C	ata F ata F	Regis Regis	ter ter				0x0 0x0	0210 0210 0210	Addr 001C 011C 021C 031C
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								DF	}							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	000							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								DF	₹							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
ILOLI								0x00	00							

Table 25-11. Data Register Description

Name	Description	Settings
DR [i] Bits 31–0	Data —Contains the GPIO output values when the Output Configuration Registers select the Data Register as the output for the pin (selection 11).	0 = Drives the output signal low 1 = Drives the output signal high

Freescale Semiconductor 25-15

Programming Model

25.5.5 GPIO In Use Registers

The GPIO In Use Registers control a multiplexer in the IOMUX module. The settings in these registers choose whether a pin is used for a peripheral function or for its GPIO function (see Figure 25-1 on page 25-2).

There are four distinct GPIO In Use Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

GIUS_ GIUS_ GIUS_ GIUS_	B C				Port A GPIO In Use Register Port B GPIO In Use Register Port C GPIO In Use Register Port D GPIO In Use Register											Addr 0x0021C020 0x0021C120 0x0021C220 0x0021C320			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16			
								GIU	S										
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw			
RESET					Rese Rese	et Value et Value et Value et Value	B = INU: C = INU	SE_RES	SET_SE SET_SE	L [31:16 L [31:16	[] = 0xFl [] = 0x0	FFF 007							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0			
								GIU	S										
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw			
RESET					Res Res	et Value et Value et Value et Value	B = INU C = INU	SE_RE ISE_RE	SET_SE SET_SE	L [15:0] L [15:0]	= 0xFF = 0xFF	FF							

Table 25-12. GPIO In Use Register Description

Name	Description	Settings
GIUS [i] Bits 31–0	GPIO In Use —Informs the IOMUX module whether the port pin in used for its GPIO function. When the pin is used for its GPIO function, the multiplexed functions are not available. The reset value of this register is determined by the input value of the signal INUSE_RESET_SEL [31:0].	0 = Pin used for multiplexed function 1 = Pin used for GPIO function

25-16 Freescale Semiconductor

25.5.6 Sample Status Registers

The read-only Sample Status Registers contain the value of the GPIO pins for the port. The register is updated on every clock. The contents are used as a status value when the pins are configured as inputs.

There are four distinct Sample Status Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

SSR_/ SSR_(SSR_(SSR_)	B C				Po Po	rt B S rt C S	Sampl Sampl Sampl Sampl	e Sta e Sta	itus F atus F	Regis Regis	ter ster			Addr 0x0021C024 0x0021C124 0x0021C224 0x0021C324				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16		
								SS	R									
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
HEGET	0x0000																	
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
								SS	R									
TYPE	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r	r		
DEOET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
RESET								0x00	00									

Table 25-13. Sample Status Register Description

Name	Description	Settings
SSR [i] Bits 31–0	Sample Status—Contains the value of the GPIO pin [i]. It is sampled on every clock.	0 = Pin value is low 1 = Pin value is high

Freescale Semiconductor 25-17

Programming Model

25.5.7 Interrupt Configuration Registers

These registers specify the external interrupt configuration for each of the 32 interrupts. There are two bits in the interrupt configuration registers for each port pin.

There are two interrupt configuration registers for each port; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

25.5.7.1 Interrupt Configuration Register 1

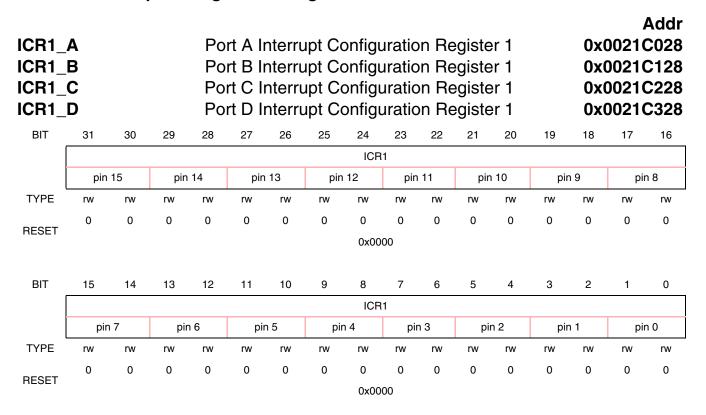


Table 25-14. Interrupt Configuration Register 1 Description

Name	Description		Settings					
ICR1 [i] Bits 31–0	Interrupt Configuration—Corresponds to interrupts 0–15 of the port and defines which one of the four options is the sensitivity of the interrupt.	ICR1 [2i + 1]	ICR1 [2i]	Sensitivity Selected				
	Each interrupt [i] (i = 0 through 15) requires two ICR1 bits to determine the sensitivity.	0	0	Positive edge sensitive				
	,	0	1	Negative edge sensitive				
		1	0	Positive level sensitive				
		1	1	Negative level sensitive				

25-18 Freescale Semiconductor

25.5.7.2 Interrupt Configuration Register 2

ICR2_ ICR2_ ICR2_ ICR2_	B		Port A Interrupt Configuration Register 2 Port B Interrupt Configuration Register 2 Port C Interrupt Configuration Register 2 Port D Interrupt Configuration Register 2 Port D Interrupt Configuration Register 2 Port D Interrupt Configuration Register 2													
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								ICF	R2							
	pin	pin 31 pin 30 pin 29 pin 28 pin 27 pin 26													pin	24
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NLOLI	0x0000															
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								ICF	12							
	pin	23	pin	22	pin	21	pin	20	pin	19	pir	18	pin	17	pin	16
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NESEI								0x00	000							

Table 25-15. Interrupt Configuration Register 2 Description

Name	Description		Settin	gs
ICR2 [i] Bits 31–0	Interrupt Configuration—Corresponds to interrupts 16–31of the port and defines which one of the four options is the sensitivity of the interrupt. Each	ICR2 [2i – 32 + 1]	ICR2 [2i – 32]	Sensitivity Selected
	interrupt [i] (i = 16 through 31) requires two ICR2 bits to determine the sensitivity.	0	0	Positive edge sensitive
	,	0	1	Negative edge sensitive
		1	0	Positive level sensitive
		1	1	Negative level sensitive

Programming Model

25.5.8 Interrupt Mask Registers

The Interrupt Mask Registers determine whether an interrupt is active. When an interrupt event occurs and the bit in this register is set (active), then the corresponding bit in the Interrupt Status Register (ISR) is set.

There are four distinct Interrupt Mask Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

IMR_A IMR_E IMR_C IMR_C	3				Po Po	rt A II rt B II rt C II rt D II	Addr 0x0021C030 0x0021C130 0x0021C230 0x0021C330									
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								IMF	7							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								IMF	٦							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							

Table 25-16. Interrupt Mask Register Description

Name	Description	Settings
IMR [i] Bits 31–0	Interrupt Mask—Masks the interrupts for this module.	0 = Interrupt is masked 1 = Interrupt is not masked

25-20 Freescale Semiconductor

25.5.9 Interrupt Status Registers

The Interrupt Status Registers indicate whether an interrupt has occurred. When an interrupt event occurs and the corresponding bit in the Interrupt Mask Register (IMR) is set (interrupt is active), then the bit in this register is set.

There are four distinct Interrupt Status Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

ISR_A ISR_B ISR_C ISR_D	Port B Interrupt Status Register Port C Interrupt Status Register Port D Interrupt Status Register Port D Interrupt Status Register													Addr 0x0021C034 0x0021C134 0x0021C234 0x0021C334			
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	
								ISF	3								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
NESET	0x0000																
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
								ISF	3								
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
ITEGET								0x00	00								

Table 25-17. Interrupt Status Register Description

Name	Description	Settings
ISR [i] Bits 31–0	Interrupt Status—Indicates whether the interrupt [i] has occurred for this module. Write 1 to clear.	0 = Interrupt has not occurred 1 = Interrupt has occurred

Freescale Semiconductor 25-21

Programming Model

25.5.10 General Purpose Registers

The General Purpose Registers control a multiplexer in the IOMUX module. The settings in these registers choose whether a pin is used for its primary peripheral function or for its alternate peripheral function (see Figure 25-1 on page 25-2).

There are four distinct General Purpose Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

GPR_ GPR_ GPR_ GPR_	B C				Port Port	A Ge B Ge C Ge D Ge	Addr 0x0021C038 0x0021C138 0x0021C238 0x0021C338									
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								GP	R							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								GP	R							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
NLOEI								0x00	00							

Table 25-18. General Purpose Register Description

Name	Description	Settings
GPR [i] Bits 31–0	General Purpose—Selects between the primary and alternate functions of the pin. When the associated bit in the GIUS register is set, this bit has no meaning. Note: Ensure that this bit is cleared when there is no alternate function for a particular pin.	0 = Select primary pin function 1 = Select alternate pin function

25-22 Freescale Semiconductor

25.5.11 Software Reset Registers

The Software Reset Registers control the reset of the GPIO module. When the SWR bit of the Port X Software Reset Register is set, the GPIO circuitry for Port X resets immediately.

There are four distinct Software Reset Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

SWR_ SWR_ SWR_ SWR_	Port A Software Reset Register Port B Software Reset Register Port C Software Reset Register Port D Software Reset Register									Addr 0x0021C03C 0x0021C13C 0x0021C23C 0x0021C33C						
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
																SWR
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TILOLI								0x00	00							

Table 25-19. Software Reset Register Description

Name	Description	Settings
Reserved Bits 31–1	Reserved—These bits are reserved and should read 0.	
SWR Bit 0	Software Reset —Controls software reset of the port. The reset signal is active for 3 system clock cycles and then it is released automatically.	0 = No effect 1 = GPIO circuitry for Port X reset

Programming Model

25.5.12 Pull_Up Enable Registers

The Pull_Up Enable Registers enable or disable the pull-up on each port pin. When the pull-up is disabled, then the pin is tri-stated when not driven.

There are four distinct Pull_Up Enable Registers; each holds the data for one of the four GPIO ports (Port A, Port B, Port C, and Port D).

NOTE:

The Port C Pull_Up Enable Register has a different reset value than the other Port A, B or D Pull Up Enable Registers.

PUEN PUEN PUEN PUEN	_ _B _C				Port A Pull_Up Enable Register Port B Pull_Up Enable Register Port C Pull_Up Enable Register Port D Pull_Up Enable Register							Addr 0x0021C040 0x0021C140 0x0021C240 0x0021C340				
BIT	31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16
								PUE	EN							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	1	1	1	1	1	1 ¹	1 ¹	1	1 ¹	1 ¹	1 ¹	1	1 ¹	1 ¹	1 ¹	1 ¹
HESET							02	xFFFF/0)xF910 ¹							
BIT	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
								PUE	EN							
TYPE	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw	rw
RESET	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
. ILOL I								0xFF	FF							

^{1.} The reset value for PUEN_C is 0xF910FFFF.

Table 25-20. Pull_Up Enable Register Description

Name	Description	Settings
PUEN [i] Bits 31–0	Pull_Up Enable—Determines whether the port pin [i] is pulled up ¹ to a logic high. When the pin is configured as an input, clearing this bit causes the signal to be tri-stated when not driven by an external source. When the pin is configured as an output, clearing this bit causes the signal to be tri-stated when it is not enabled.	0 = Pin [i] is tri-stated when not driven internally or externally 1 = Pin [i] is pulled high ¹ when not driven internally or externally

^{1.} PUEN_B bit 11 is pulled down when the bit is set.

25-24 Freescale Semiconductor

Index

Numerics	control coprocessor, 4-4
	exception types, 4-5
32 kHz Clock signal, see CLK32 signal	instruction classes, 4-5-4-7
	instruction set, 4-7
A	introduction, 4-1
	macrocell, 4-2
AIPI	MMUs, 4-3
data access to 16-bit peripherals, 7-16	modes and exception handling, 4-4
data access to 32-bit peripherals, 7-17	modes and registers, 4-9
data access to 8-bit peripherals, 7-15	PATAG RAM, 4-3
features, 7-1	prioritization of exception sources, 10-33
general information, 7-1	Registers, 4-4
non-natural size access, 7-18	reset, 6-2
overview, 7-1	status registers, 4-5
programming example, 7-15	system controller, 4-3
programming model, 7-8	typical interrupt entry sequences, 10-34
AIPI 1 & 2 peripheral size register 0, see PSR0 n,	write buffer, 4-3
AIPI 1 & 2 peripheral size register 1, see PSR1 n,	Atomic read/modify/write sequence, 10-10
AIPI module register memory map, 7-8	AUCR3 1 register
AIPI peripheral address MODULE_EN numbers, 7-8	WAKEN bit, 21-33
AIPI registers	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
PAR <i>n</i> , 7-12	В
PCR_n, 7-13	
PSR0 n, 7-10	BIPRx x
$PSR1^{-1}$, 7-11	INCPI field, 21-49
$TSR \stackrel{-}{n}$, 7-14	BIPRx x, 21-49
AITC	BLRx register
assigning interrupt sources, 10-33	BL bit, 13-26
enabling interrupt sources, 10-33	BLRx register, 13-26
features, 10-1	BMPRx x register
input signals, 10-3	MODI field, 21-50
interrupt assignments, 10-3	BMPR x x register, 21-50
introduction, 10-1	Bootstrap mode
operation, 10-2-10-3	bootloader flowchart, 9-7
prioritization of interrupt sources, 10-33	B-record examples, 9-3
programming model, 10-4	changing communication speed, 9-3
register field summary, 10-5	entering, 9-1
register memory map, 10-4	instruction buffer, 9-3
writing reentrant normal interrupt routines, 10-35	operation of, 9-1
ALRM HM register	programming notes, 9-7
HOURS field, 18-9	read/write examples, 9-5
MINUTES field, 18-9	record format, 9-2
ALRM HM register, 18-9	register usage, 9-2
ALRM SEC register	setting up RS-232 terminal, 9-3
SECONDS field, 18-10	BUCRx register
ALRM SEC register, 18-10	CCNT field, 13-29
ARM Thumb	BUCRx register, 13-29
instruction set, 4-7	Beeter register, 13 2)
ARM920T processor	C
ARMv4T Architecture, 4-4	_
cache lock-down, 4-3	CAP field, 20-4
caches, 4-3	CAPT bit, 20-9
	Capture edge field, see CAP field
conditional execution, 4-5	Capture edge, see CAP bit
	Γ · · · · · · · · · · · · · · · · · · ·

MC9328MXS Reference Manual, Rev. 1

Freescale Semiconductor Index-i

Capture event, see CAPT bit	CC field, 16-29
CAPTURE VALUE field, 20-7	CXP field, 16-29
CCRx register	CYP field, 16-29
CEN bit, 13-24	OP bit, 16-29
DMOD field, 13-22	CPOS register, 16-29
DSIZ field, 13-23	CS0L register, 11-12
FRC bit, 13-23	CS0U register, 11-11
MDIR bit, 13-23	CS1L register, 11-13
MSEL bit, 13-23	CS2L register, 11-13
REN bit, 13-23	CS3L register, 11-13
RPT bit, 13-23	CS4L register, 11-13
SMOD field, 13-23	CS5L register, 11-13
SSIZ field, 13-23	CSCR register
CCRx register, 13-22	BCLK DIV field, 12-7
Channel x burst length register, see BLRx register 13-26	CLKO SEL field, 12-6
Channel x bus utilization control register, see BUCRx	MPEN bit, 12-7
register	MPLL RESTART bit, 12-7
Channel x control register, see CCRx register	OSC EN bit, 12-7
Channel x count register, see CNTRx register	PRESC bit, 12-7
Channel x destination address register, see DARx register	SD CNT field, 12-6
Channel x request source select register, see RSSRx register	SPEN bit, 12-7
Channel x request time-out register, see RTORx register	SPLL RESTART bit, 12-7
Channel x source address register, see SARx register	System SEL bit, 12-7
Chip select 0 control registers <i>see</i> CSOU and CSOL registers	USB DIV field, 12-6
Chip select 1 - 5 control registers see CS1U - CS5U and	CSCR register, 12-6
CS1L - CS5L registers	CTS
CLK32 signal, 6-3	de-assertion, programmable, 21-8
CLK32 Signal, 0-3	de-assertion, programmable, 21-6
	,1 6
CLKSOURCE field, 20-5	
CLKSOURCE field, 20-5 Clock source control register, <i>see</i> CSCR register	D
CLKSOURCE field, 20-5 Clock source control register, <i>see</i> CSCR register Clock source, <i>see</i> CLKSOURCE field	D
CLKSOURCE field, 20-5 Clock source control register, <i>see</i> CSCR register Clock source, <i>see</i> CLKSOURCE field CNTRx register	D DAR <i>x</i> register
CLKSOURCE field, 20-5 Clock source control register, <i>see</i> CSCR register Clock source, <i>see</i> CLKSOURCE field CNTRx register CNT field, 13-21	DARx register DA field, 13-20
CLKSOURCE field, 20-5 Clock source control register, <i>see</i> CSCR register Clock source, <i>see</i> CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21	DARx register DA field, 13-20 DARx register, 13-20
CLKSOURCE field, 20-5 Clock source control register, <i>see</i> CSCR register Clock source, <i>see</i> CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register
CLKSOURCE field, 20-5 Clock source control register, <i>see</i> CSCR register Clock source, <i>see</i> CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, <i>see</i> COMP bit	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-7	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-7 SSCTL bit, 15-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-7 SSCTL bit, 15-8 SSPOL bit, 15-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15 DBTOCR register
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-8 SSPOL bit, 15-8 XCH bit, 15-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15 DBTOSR register bits CH10 through CH0, 13-11
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-8 SSPOL bit, 15-8 XCH bit, 15-8 Core test reset, see CORE_TRST signal	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register, 13-11
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-7 SSCTL bit, 15-8 SSPOL bit, 15-8 XCH bit, 15-8 Core test reset, see CORE_TRST signal CORE_TRST signal, 6-3	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register, 13-11 DCR register, 13-11
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-7 SSCTL bit, 15-8 SSPOL bit, 15-8 Core test reset, see CORE_TRST signal CORE_TRST signal, 6-3 COUNT field, 20-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register, 13-15
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 SPIEN bit, 15-8 SPIEN bit, 15-8 SSPOL bit, 15-8 XCH bit, 15-8 Core test reset, see CORE_TRST signal CORE_TRST signal, 6-3 COUNT field, 20-8 Counter value, see COUNT field	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register DAYS field, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register, 13-15 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register, 13-15
CLKSOURCE field, 20-5 Clock source control register, see CSCR register Clock source, see CLKSOURCE field CNTRx register CNT field, 13-21 CNTRx register, 13-21 COMP bit, 20-9 Compare event, see COMP bit COMPARE VALUE field, 20-6 CONTROLREG1 register, 15-7 CONTROLREGx register BIT_COUNT field, 15-8 DATARATE field, 15-7 DRCTL field, 15-7 MODE bit, 15-7 PHA bit, 15-8 POL bit, 15-8 SPIEN bit, 15-7 SSCTL bit, 15-8 SSPOL bit, 15-8 Core test reset, see CORE_TRST signal CORE_TRST signal, 6-3 COUNT field, 20-8	DARx register DA field, 13-20 DARx register, 13-20 DAYALARM register DAYSAL field, 18-8 DAYALARM register, 18-8 DAYR register DAYS field, 18-5 DAYR register, 18-5 DBOSR register bits CH10 through CH0, 13-14 DBOSR register, 13-14 DBTOCR register CNT field, 13-15 EN bit, 13-15 DBTOCR register, 13-15 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register bits CH10 through CH0, 13-11 DBTOSR register, 13-15

Index-ii Freescale Semiconductor

DDIR_B register, 25-8 DDIR_C register, 25-8	DSESR register, 13-13 DTR edge triggered interrupt, 21-7
DDIR D register, 25-8	
DDIR x	E
DDIR field, 25-8	
DIMR register	EIM
bits CH10 through CH0, 13-10	address bus, 11-1
DISNUM field, 10-10	burst mode signals, 11-3
DISR register, 13-9	chip select outputs, 11-2
DMA buffer overflow status register, see DBOSR register	control signals, 11-2
DMA burst time-out control register, see DBTOCR register	data bus, 11-1
DMA burst time-out control register, see DBTOCK register	I O signals, 11-1
DMA control register, see DCR register	overview, 11-1
DMA control register, see DMACR register DMA control register, see DMACR register	pin configuration, 11-3
	programming model, 11-10
DMA interrupt mask register, see DIMR register	read and write signals, 11-1
DMA interrupt status register, see DISR register	system connections, typical, 11-5
DMA request time-out status register, see DRTOSR register	EIM configuration register <i>see</i> EIM register
DMA transfer error status register, see DSESR register	EIM functionality
DMAC	burst clock divisor, 11-8
2D memory registers (A & B), 13-16	burst clock start, 11-9
big endian/little endian byte-ordering, 13-4	burst mode operation, 11-8
block diagram, 13-2	configurable bus sizing, 11-8
channel registers, 13-18	error conditions, 11-9
DMA request table, 13-29	page mode emulation, 11-9
features, 13-1	i e
general registers, 13-8	programmable output generation, 11-8
programming model, 13-4	EIM register, 11-21
signal description, 13-3	Embedded Trace Macrocell, see ETM
DMACR register	Endpointx data register, see USB_EPx_FDAT register
BURST bit, 16-36	Endpointx FIFO alarm register, see USB_EPx_FALRM
HM field, 16-36	register
TM field, 16-36	Endpointx FIFO write pointer register, see
DMACR register, 16-36	USB_EPx_FWRP register
DMAREG1 register, 15-13	Endpointx interrupt mask register, see USB_EPx_MASK
DMAREGx register	register
RFDEN bit, 15-13	Endpointx interrupt status register, see USB_EPx_INTR
RHDEN bit, 15-13	register
RHDMA bit, 15-14	Endpointx last read frame pointer register, see
TEDEN bit, 15-13	USB_EPx_LRFP register
TEDMA bit, 15-13	Endpointx last write frame pointer register, see
THDEN bit, 15-13	USB_EPx_LWFP register
THDMA bit, 15-13	EndpointxFIFO read pointer register, see USB_EPx_FRDP
DR_A register, 25-15	register,
DR_B register, 25-15	EndpointxFIFO Status Register, see USB_EPx_FSTAT
DR C register, 25-15	register
DR D register, 25-15	ENNUM field, 10-9
\overline{DR} x register	ETM
DR field, 25-15	block diagram, 5-1
DRAM reset, see RESET DRAM signal	introduction, 5-1
DRTOSR register	pin configuration, 5-2
bits CH10 through CH0, 13-12	registers, programming and reading, 5-2
DRTOSR register, 13-12	EXR bit, 6-4
DSESR register	External Interface Module see EIM module
bits CH10 through CH0, 13-13	External reset bit, see EXR bit

Freescale Semiconductor Index-iii

F	GPR_A register, 25-22 GPR_B register, 25-22
Fast interrupt	GPR C register, 25-22
arbiter disable, see FIAD bit	GPR_D register, 25-22
pending bit, see FIPEND field	GPR_x register
pending register high, see FIPNDH register	GPR field, 25-22
pending register low, see FIPNDL register	
vector and status register, see FIVECSR register	Н
vector, see FIVECTOR field	
Fast interrupt pending bit, see FIPEND field	Hard asynchronous reset, see HARD_ASYN_RESET signal
FIPEND field, 10-31, 10-32	Hard reset signal, see HARD_RESET signal
FIPNDH register, 10-31	HARD_ASYN_RESET signal, 6-3
FIPNDL register, 10-32	HCR register
FIVECSR register, 10-24	H_WAIT_1 field, 16-26
FIVECTOR field, 10-24	H_WAIT_2 field, 16-26
FORCE field, 10-27, 10-28	H_WIDTH field, 16-26
Four bits/pixel grayscale mode	HCR register, 16-26
GPM field, 16-39	Horizontal configuration register, see HCR register
Free-run/restart, see FRR bit	HOURMIN register
FRR bit, 20-4	HOURS field, 18-6
Function multiplexing control register, see FMCR register	HOURMIN register, 18-6
Tuneston manapiering control register, see Timest register	HOURMIN register, MINUTES field, 18-6
G	HRESET signal, 6-3
General purpose timers	I
programming model, 20-3	I^2C
GIUS_A register, 25-16	
GIUS_B register, 25-16	Address Register, see IADR register
GIUS_C register, 25-16	arbitration procedure, 23-4, 23-5
GIUS_D register, 25-16	clock stretching, 23-5
GIUS_x register	clock synchronization, 23-4
GIUS field, 25-16	handshaking, 23-5
Global peripheral control register, see GPCR register	initialization sequence, 23-14
GPIO	interface features, 23-1
data direction registers, 25-8	lost arbitration, 23-15
data registers, 25-15	module, see I ² C
general description, 25-1	overview, 23-1
general purpose registers, 25-22	pin configuration, 23-5
in use registers, 25-16	programming
Input configuration registers, 25-11	examples, 23-13
interrupt configuration registers, 25-18	model, 23-6
interrupt mask registers, 25-20	protocol, communication, 23-3
interrupt status registers, 25-21	repeated START generation, 23-15
interrupts, 25-3	slave mode, 23-15
module block diagram, 25-4	software response, post transfer, 23-14
module features, 25-2	START signal, generation, 23-14
module overview, 25-2	STOP generation, 23-15
output configuration registers, 25-9	I ² C control register, see I2CR register
pin configuration, 25-4	I ² C data I/O register, see I2DR register
programming model, 25-5	I ² C frequency divider register, see IFDR register
pull_up enable registers, 25-24	I ² C status register, <i>see</i> I2CSR register
sample status registers, 25-17	I2CR register
signal description, 25-3	IEN bit, 23-10
software reset registers, 25-23	IIEN bit, 23-10

MC9328MXS Reference Manual, Rev. 1

Index-iv

Freescale Semiconductor

MSTA bit, 23-10	ICR2 field, 25-19			
MTX bit, 23-11	IFDR register			
RSTA bit, 23-11	IC field, 23-8			
TXAK bit, 23-11	IFDR register, 23-8			
I2CR register, 23-10	IMR A register, 25-20			
I2CSR register	IMR B register, 25-20			
IAAS bit, 23-12	IMR C register, 25-20			
IAL bit, 23-12	IMR D register, 25-20			
IBB bit, 23-12	IMR x register			
ICF bit, 23-12	IMR field, 25-20			
IIF bit, 23-12	INTCNTL register			
RXAK bit, 23-12	FIAD bit, 10-7			
SRW bit, 23-12	NIAD bit, 10-7			
I2CSR register, 23-11	INTCNTL register, 8-6, 10-6			
I2DR register	INTDISNUM register, 10-10			
D field, 23-13	INTENABLE field, 10-11, 10-12			
I2DR register, 23-13	INTENABLEH register, 10-11			
IADR register	INTENABLEL register, 10-12			
ADR field, 23-7	INTENNUM register, 10-9			
IADR register, 23-7	Interrupt configuration register, see LCDICR register			
ICONFA1 A register, 25-11	Interrupt control register, see INTCNTL register			
ICONFA1 C register, 25-11	Interrupt controller, see AITC			
ICONFA1 D register, 25-11	Interrupt disable number register, see INTDISNUM register			
ICONFA1_x register	Interrupt disable number, see DISNUM field			
ICONFA1 field, 25-11	Interrupt enable number register, see INTENNUM register			
ICONFA2_A register, 25-12	Interrupt enable number, see ENNUM field			
ICONFA2_B register, 25-12	Interrupt enable register high, see INTENABLEH register			
ICONFA2_C register, 25-12	Interrupt enable register low, see INTENABLEL register			
ICONFA2_D register, 25-12	Interrupt enable, see INTENABLE field			
ICONFA2_x register	Interrupt Force Register High, see INTFRCH register			
ICONFA2 field, 25-12	Interrupt force register low, see INTFRCL register			
ICONFB1_A register, 25-13	Interrupt request enable, see IRQEN bit			
ICONFB1_B register, 25-13	Interrupt source force request, see FORCE field			
ICONFB1_C register, 25-13	Interrupt source register high, see INTSRCH register			
ICONFB1_D register, 25-13	Interrupt source register low, see INTSRCL register			
ICONFB1_x register	Interrupt source, see INTIN field			
ICONFB1 field, 25-13	Interrupt source, see INTIN field			
ICONFB2_A register, 25-14	Interrupt status register, see LCDISR register			
ICONFB2_B register, 25-14	Interrupt type register high, see INTTYPEH register			
ICONFB2_C register, 25-14	Interrupt type register low, see INTTYPEL register			
ICONFB2_D register, 25-14	Interrupt type, see INTTYPE field			
ICONFB2_x register	INTFRCH register, 10-27			
ICONFB2 field, 25-14	INTFRCL register, 10-28			
ICR1_A register, 25-18	INTIN field, 10-25, 10-26			
ICR1_B register, 25-18	INTREG1 register, 15-9			
ICR1_C register, 25-18	INTREGx register			
ICR1_D register, 25-18	BO bit, 15-10			
ICR1_x register	BOEN bit, 15-9			
ICR1 field, 25-18	RF bit, 15-10			
ICR2_A register, 25-19	RFEN bit, 15-9			
ICR2_B register, 25-19	RH bit, 15-10			
ICR2_C register, 25-19	RHEN bit, 15-9			
ICR2_D register, 25-19	RO bit, 15-10			
ICR2_x register	ROEN bit, 15-9			
MC9328MXS Reference Manual, Rev. 1				

Freescale Semiconductor Index-v

RR bit, 15-10	using VPH for boundary checks, 16-3
RREN bit, 15-9	LCDICR register
TE bit, 15-10	INTCON bit, 16-37
TEEN bit, 15-9	INTSYN bit, 16-37
TF bit, 15-10	LCDICR register, 16-37
TFEN bit, 15-9	LCDISR register
TH bit, 15-10	BOF bit, 16-38
THEN bit, 15-9	EOF bit, 16-38
INTSRCH register, 10-25	ERR_RES bit, 16-38
INTSRCL register, 10-26	UDR ERR bit, 16-38
INTTYPE field, 10-13, 10-14	LCDISR register, 16-38
INTTYPEH register, 10-13	LCHCC register
INTTYPEL register, 10-14	CUR_COL_B register, 16-31
IRQEN bit, 20-4	CUR COL G register, 16-31
ISR_A register, 25-21	CUR COL R register, 16-31
ISR B register, 25-21	LCHCC register, 16-31
ISR C register, 25-21	LCWHB register
ISR D register, 25-21	BD field, 16-30
ISR x register	BK EN bit, 16-30
ISR field, 25-21	CH field, 16-30
	CW field, 16-30
L	LCWHB register, 16-30
	LGPMR register, see LSCR1 register
LCD color cursor mapping register, see LCHCC register	LSCR1 register
LCD cursor position, see CPOS register	CLS_RISE_DELAY field, 16-32
LCD cursor width height and blink register, see LCWHB	GRAY 1 register, 16-32
register	GRAY 2 register, 16-32
LCD gray palette mapping register, see LSCR1 register	PS RISE DELAY field, 16-32
LCDC	REV TOGGLE DELAY field, 16-32
active matrix panel interface signals	
"digital CRT", 16-14	M
active matrix panel interface signals, 16-14	
active panel interface timing, 16-16	Mapping RAM registers
black-and-white operation, 16-7	eight bits/pixel active matrix color mode register, 16-41
color generation, 16-8	eight bits/pixel passive matrix color mode, 16-40
display data mapping, 16-3	four bits/pixel active matrix color mode, 16-41
features, 16-1	four bits/pixel gray-scale mode, 16-39
frame rate modulation control, 16-10	four bits/pixel passive matrix color mode, 16-40
gray scale operation, 16-7	one bit/pixel mono mode, 16-39
introduction, 16-1	twelve bits/pixel active matrix color mode, 16-42
mapping RAM registers, 16-39	MC9328MXS
operation, 16-2	features of, 1-8
panel interface signals, 16-11	internal registers, 3-6
panning	MCU PLL and system clock control register 1, see MPCTL1
typical panning algorithm, 16-3	register
panning, 16-3	MCU PLL control register 0, see MPCTL0 register
passive panel interface timing, 16-13	Memory space
pin configuration	double map image, 3-5
setting data direction, 16-11	external memory, 3-5
pin configuration, 16-11	internal register space, 3-4
programming model, 16-18	memory map description, 3-1
screen format	Memory space, 3-1
maximum page width, 16-3	MISCELLANEOUS register
screen format, 16-2	OMA bit, 19-17

Index-vi Freescale Semiconductor

MC9328MXS Reference Manual, Rev. 1

RMA0 bit, 19-17	OCR2 A register, 25-10
MISCELLANEOUS register, 19-17	OCR2 B register, 25-10
MPCTL0 register	OCR2 C register, 25-10
MFD field, 12-10	OCR2 D register, 25-10
MFI field, 12-10	OCR2 x register
MFN field, 12-10	OCR2 field, 25-10
PD field, 12-10	OM bit, 20-4
MPCTL0 register, 12-9	Output mode, see OM bit
MPCTL1 register	
BRMO bit, 12-11	P
MPCTL1 register, 12-11	
WITCHEI TOGISCH, 12 11	Panel Configuration Register, see PCR register
N	Panning offset register, see POS register,
•	PAR_n register
NIMASK field, 10-8	ACCESS field, 7-13
NIMASK register, 10-8	PAR <i>n</i> register, 7-12
NIPEND field, 10-29, 10-30	Passive matrix panel
NIPNDH register, 10-29	interface signals
NIPNDL register, 10-30	LD bus, 16-12
NIPRO though NIPR64 fields, 10-15-10-22	passive matrix panel interface signals, 16-12
NIPRILVL field, 10-23	PCDR register
NIVECSR register, 10-23	PCLK DIV1 field, 12-8
NIVECTOR field, 10-23	PCLK DIV2 field, 12-8
Normal interrupt	PCLK DIV3 field, 12-8
arbiter disable, see NIAD bit	PCDR register, 12-8
mask, see NIMASK register	PCR register
pending bit, see NIPEND field	ACD field, 16-24
pending register high, see NIPNDH register	ACD field, 10-24 ACDSEL bit, 16-24
priority level register 0, see NIPRIORITY0 register	BPIX field, 16-23
priority level register 1, see NIPRIORITY1 register	CLKPOL bit, 16-24
priority level register 1, see NIPRIORITY 1 register	
	COLOR bit, 16-23
priority level register 3, <i>see</i> NIPRIORITY3 register priority level register 4, <i>see</i> NIPRIORITY4 register	END_SEL bit, 16-24
priority level register 5, see NIPRIORITY 5 register	FLMPOL bit, 16-24
priority level register 6, see NIPRIORITY 6 register	LPPOL bit, 16-24 OEPOL bit, 16-24
priority level register 7, see NIPRIORITY register	PBSIZ field, 16-23
priority level, see NIPRILVL field	PCD field, 16-25
vector, see NIVECTOR field	PIXPOL bit, 16-23
Normal interrupt mask, see NIMASK field	REV VS bit, 16-24
Normal interrupt pending bit, see NIPEND field	SCLKIDLE bit, 16-24
Normal interrupt priority level fields, see NIPRxx	SCLKIDLE bit, 16-24 SCLKSEL bit, 16-24
Normal interrupt priority level registers	SHARP bit, 16-24
	TFT bit, 16-23
description of, 10-14 Normal interrupt vector and status register, <i>see</i> NIVECSR	PCR register, 16-23
	<u> </u>
register	PCR_n register
0	ACCESS_MODE field, 7-14
	PCR_n register, 7-13
OCR1_A register, 25-9	PERIODREG register, 15-12
OCR1 B register, 25-9	PERIODREGx register
OCR1 C register, 25-9	CSRC bit, 15-12
OCR1_D register, 25-9	WAIT field, 15-12
OCR1 x register	peripheral access registers, see PAR_n,
OCR1 field, 25-9	Peripheral clock divider register, <i>see</i> PCDR register peripheral control registers, <i>see</i> PCR <i>n</i> ,
	peripheral control registers, see PCK_n,

Freescale Semiconductor Index-vii

peripheral size registers, *see* PSR*n_n* registers Phase-locked loop and clock control, *see* PLL and clock control

PLL and clock control

ARM920T processor low power modes, 12-4 clock sources, 12-1

DPLL output frequency calculation, 12-3

DPLL phase and frequency jitter, 12-3

generation of 48 MHz clocks, 12-11

high frequency clock source, 12-2

introduction, 12-1

low frequency clock source, 12-1

PLL operation at power-up, 12-4

PLL operation at wake-up, 12-4

power management in clock controller, 12-4 programming digital phase locked loops, 12-9

programming model, 12-5

SDRAM power modes, 12-4

POR signal, 6-3

Port A data direction register, see DDIR_A register

Port A data register, see DR A register

Port A general purpose register, see GPR_A register

Port A GPIO in use register, see GIUS A register

Port A input configuration register A1, see ICONFA1_A register

Port A input configuration register A2, see ICONFA2_A register

Port A input configuration register B1, see ICONFB1_A register

Port A input configuration register B2, see ICONFB2_A register

Port A interrupt configuration register 1, see ICR1_A register

Port A interrupt configuration register 2, see ICR2_A register

Port A interrupt mask register, see IMR_A register

Port A interrupt status register, see ISR A register

Port A output configuration register 1, see OCR1_A register,

Port A output configuration register 2, see OCR1 A register

Port A pull_up enable register, see PUEN_A register

Port A sample status register, see SSR A register

Port A software reset register, see SWR_A register

Port B data direction register, see DDIR_B register

Port B data register, see DR B register

Port B general purpose register, see GPR_B register

Port B GPIO in use register, see GIUS B register

Port B input configuration register A1, see ICONFA1_B register

Port B input configuration register A2, see ICONFA2_B register

Port B input configuration register B1, see ICONFB1_B register

Port B input configuration register B2, see ICONFB2_B register

Port B interrupt configuration register 1, see ICR1_B register

Port B interrupt configuration register 2, see ICR2_B register

Port B interrupt mask register, see IMR B register

Port B interrupt status register, see ISR B register

Port B output configuration register 1, see OCR1_B register

Port B output configuration register 2, see OCR1_B register

Port B pull_up enable register, see PUEN_B register

Port B sample status register, see SSR_B register

Port B software reset register see SWR B register

Port C data direction register, see DDIR_C register

Port C data register, see DR C register

Port C general purpose register, see GPR C register

Port C GPIO in use register, see GIUS_C register

Port C input configuration register A1, see ICONFA1_C register

Port C input configuration register A2 see ICONFA2_C register

Port C input configuration register B1, see ICONFB1_C register

Port C input configuration register B2, see ICONFB2_C register

Port C interrupt configuration register 1, see ICR1_C register

Port C interrupt configuration register 2, see ICR2_C register

Port C interrupt mask register, see IMR C register

Port C interrupt status register, see ISR C register

Port C output configuration register 1, see OCR1 C register

Port C output configuration register 2, see OCR1 C register

Port C pull_up enable register, see PUEN_C register

Port C sample status register, see SSR C register

Port C software reset register, see SWR_C register

Port D data direction register, see DDIR D register

Port D data register, see DR D register

Port D general purpose register, see GPR D register

Port D GPIO in use register, see GIUS D register

Port D input configuration register A1, see ICONFA1_D register

Port D input configuration register A2, see ICONFA2_D register

Port D input configuration register B1, see ICONFB1_D register

Port D input configuration register B2, see ICONFB2_D register

Port D interrupt configuration register 1, see ICR1_D register

Port D interrupt configuration register 2, see ICR2_D register

Port D interrupt mask register, *see* IMR_D register Port D interrupt status register, *see* ISR D register

MC9328MXS Reference Manual, Rev. 1

Index-viii Freescale Semiconductor

Port D output configuration register 1, see OCR1_D register	playback mode, 17-2
Port D output configuration register 2, see OCR1_D register	programming model, 17-3
Port D pull_up enable register, see PUEN_D register	tone mode, 17-3
Port D sample status register, see SSR D register	PWM contrast control register, see PWMR register
Port D software reset register, see SWR D register	PWM counter register, see PWMCNT register
POS register	PWM Period Register, see PWMP register
POS bit, 16-28	PWM sample register, see PWMS register
POS register, 16-28	PWMCNT register, 17-8
Power-on reset, see POR signal	PWMCNT register, COUNT field, 17-8
PRESCALER field, 20-5	PWMP register
Prescaler, see PRESCALER field	PERIOD field, 17-7
Programming model	PWMP register, 17-7
AITC, 10-4	PWMR register
DMAC, 13-4	CC EN bit, 16-34
EIM, 11-10	LDMSK bit, 16-34
GP timers, 20-3	PW field, 16-34
GPIO, 25-5	SCR field, 16-34
I ² C, 23-6	PWMR register, 16-34
LCDC, 16-18	PWMS register
PLL and clock control, 12-5	SAMPLE field, 17-7
PWM, 17-3	PWMS register, 17-6
reset module, 6-3	R
RTC, 18-4	••
SDRAM memory controller, 19-8	RCCTL register
SPI, 15-4	EN bit, 18-11
SSI, 24-7	SWR bit, 18-11
system control, 8-1	XTL field, 18-11
UART, 21-21	RCCTL register, 18-11
USB device port 22-6	- Control of the Cont
PSR0_n register	Refresh mode control register, <i>see</i> RMCR register,
MOD_EN_L field, 7-10	RESERREG <i>x</i> register
PSR0_ <i>n</i> register, 7-10	START bit, 15-14
PSR1_ <i>n</i> register	Reset module
MOD_EN_U field, 7-11	functional description, 6-1
PSR1_ <i>n</i> register, 7-11	RESET signal, 6-3
PUEN_A register, 25-24	Reset signal, see RESET signal
PUEN_B register, 25-24	Reset source register, see RSR register
PUEN_C register, 25-24	RESET_DRAM signal, 6-3
PUEN_D register, 25-24	RESETREG1 register, 15-14
PUEN_x register	RMCR register
PUEN field, 25-24	LCDC_EN bit, 16-35
Pulse-width modulator, see PWM	SELF_REF bit, 16-35
PWM	RMCR register, 16-35
clock signals, 17-1	RSR register, 6-3
clock source selection, 17-1	RSSRx register
D/A mode, 17-3	RSS field, 13-25
digital-to analog converter mode, 17-3	RSSRx register, 13-25
introduction, 17-1	RTC
operation, 17-2	alarm, 18-3
period frequency, calculating, 17-7	minute stopwatch, 18-3
playback mode	operation, 18-2
digital sample values, 17-3	prescaler and counter, 18-2
maskable interrupt generation, 17-3	programming model, 18-4
variable pulse width, 17-2	sampling timer, 18-3
·	

Freescale Semiconductor Index-ix

RTC control register, see RCCTL register	DATA field, 15-5
RTC day alarm register, see DAYALARM register	
RTC days counter register, see DAYR register	S
RTC hours and minutes alarm register, see ALRM_HM	
register	SARx register
RTC hours and minutes counter register, see HOURMIN	SA field, 13-19
register	SARx register, 13-19
RTC interrupt enable register, see RTCIENR register	Screen start address register, see SSA register
RTC interrupt status register, see RTCISR register	SCSR register, 24-15
RTC seconds alarm register, see ALRM SEC register	SDCTL0 register, 19-9
RTC seconds counter register, see SECONDS register	SDCTL1 register, 19-9
RTCIENR register	SDCTLx register
1HZ bit, 18-15	CLKST field, 19-12
2HZ bit, 18-15	COL field, 19-10
ALM bit, 18-15	DSIZ field, 19-11
DAY bit, 18-15	IAM bit, 19-11
HR bit, 18-15	ROW field, 19-10
MIN bit, 18-15	SCL field, 19-12
SAM0 bit, 18-15	SDE bit, 19-9
SAM1 bit, 18-15	SMODE field, 19-9
SAM2 bit, 18-14	SP bit, 19-10
SAM3 bit, 18-14	SRC field, 19-12
SAM4 bit, 18-14	SRCD field, 19-12
SAM5 bit, 18-14	SREFR field, 19-11
SAM6 bit, 18-14	SRP bit, 19-12
SAM7 bit, 18-14	SDRAM
SW bit, 18-15	memory refresh, 19-67
RTCIENR register, 18-14	SDRAM 0 control register, see SDCTL0 register
RTCISR register	SDRAM 1 control register, see SDCTL1 register
1HZ bit, 18-13	SDRAM control registers, 19-9
2HZ bit, 18-13	SDRAM memory controller, see SDRAMC
ALM bit, 18-13	SDRAM operation, 19-37
DAY bit, 18-13	SDRAM reset register, see SDRST register
HR bit, 18-13	SDRAM/SyncFlash command encoding, 19-18
MIN bit, 18-13	SDRAMC
SAM0 bit, 18-13	address multiplexing, 19-29
	auto-refresh mode, 19-25
SAM1 bit, 18-13 SAM2 bit, 18-13	bank addresses, 19-31
	block diagram, 19-2
SAM3 bit, 18-13 SAM4 bit, 18-12	clock suspend low power mode, 19-35
SAM5 bit, 18-12	column address strobe, 19-6
SAM6 bit, 18-12	command controller, 19-3
	configuration registers, 19-3
SAM7 bit, 18-12	configuring controller for memory array, 19-38
SW bit, 18-13	data aligner/multiplexer, 19-3
RTCISR register, 18-12	data bus (internal), 19-5
RTORx register	data qualifier mask, 19-6
CLK bit, 13-28	features, 19-1
CNT field, 13-28	functional overview, 19-3
EN bit, 13-27	general operation, 19-28
PSC bit, 13-28	memory configuration examples, 19-39
RTORx register, 13-27	miscellaneous register, see miscellaneous register
RTx BRM incremental register, see UBIR_x register	mode register programming example, 19-62
RXDATAREG1 register, 15-5	multiplexed address bus, 19-5
RXDATAREGx register	manipronou address ous, 17-3

Index-x Freescale Semiconductor

non-multiplexed address bus, 19-6	Silicon ID register, see SIDR register
normal read/write mode, 19-19	SIZE register
operating modes, 19-18	XMAX field, 16-21
page and bank address comparators, 19-3	YMAX field, 16-21
pin configuration, 19-7	SIZE register, 16-21
powerdown operation in reset and low-power	Size register, see SIZE register
modes, 19-33	Software reset, see SWR bit
powerdown timer, 19-4	SOR register, 24-34
powerdown, 19-35	SPCTL0 register
precharge command mode, 19-24	MFD field, 12-13
programming example	MFI field, 12-13
mode register	MFN field, 12-13
bit assignments, 19-64	PD field, 12-12
converting to an address, 19-63	SPCTL0 register, 12-12
example 1, 19-62	SPCTL1 register
example 2, 19-64	BRMO bit, 12-14
programming model 19-8	LF bit, 12-14
refresh request counter, 19-3	SPCTL1 register, 12-13
refreshing SDRAM, 19-32	SPI
reset initialization, 19-57	
reset/powerdown, 19-6	block diagram, 15-1
± '	control registers, 15-7
row address strobe, 19-6	DMA control registers, 15-13
row/column address multiplexer, 19-3	Interrupt control/status registers, 15-9
SDCLK SDRAM clock, 19-5	operation, 15-2
SDRAM chip select, 19-5	phase/polarity configurations, 15-2
SDRAM clock enable, 19-5	pin configuration SPI1 and SPI2, 15-3
SDRAM selection, 19-37	programming model 15-4
self-refresh during low power mode, 19-33	receive (RX) data registers, 15-5
self-refresh, 19-33	sample period control registers, 15-12
set mode register mode, 19-25	signals, 15-3
syncflash	soft reset registers, 15-14
booting from, 19-68	test registers, 15-11
clock suspend timer, 19-72	transmit (TX) data registers, 15-6
configuration, 19-68	SPI 1 control register, see CONTROLREG1 register
deep powerdown operation, 19-72	SPI 1 DMA control register, see DMAREG1 register
mode register programming, 19-68	SPI 1 interrupt control/status register, see INTREG1 registe
operation, 19-67	SPI 1 Rx data register, see RXDATAREG1
powerdown operation, 19-72	SPI 1 sample period control register, see PERIODREG1
programming, 19-71	register
reset initialization, 19-67	SPI 1 soft reset register, see RESETREG1 register
syncflash load command mode, 19-26	SPI 1 test register, see TESTREG1 register
syncflash programming, 19-27	SPI 1 Tx data register, see TXDATAREG1 register
write enable, 19-6	SRCR register, 24-24
SDRST register	SSA register
RST field, 19-16	SSA field, 16-20
SDRST register, 19-16	SSA register, 16-20
SECONDS register	SSI
SECONDS field, 18-7	architecture, 24-2
SECONDS register, 18-7	calculating bit clock from input clock, 24-28
SFCSR register, 24-31	clock and frame sync generation, 24-4
Sharp configuration 1 register, see LSCR1 register	clocking, 24-4
SIDR register	data and control pins
SID field, 8-2	SSI RXCLK pin, 24-35
SID register, 8-2	SSI_RXDAT pin, 24-35
DIDIC TOGISTOT, U.Z.	001_101D111 piii, 2T-33

Freescale Semiconductor Index-xi

SSI_RXFS pin, 24-36	system boot mode selection, 8-7
SSI_TXCLK pin, 24-35	System PLL control register 1, see SPCTL1 register
SSI_TXDAT pin, 24-35	_
SSI_TXFS pin, 24-36	Т
data and control pins, 24-35	
data bit shifting configuration, 24-10	TCMP1 register, 20-6
external frame and clock operation, 24-44	TCMP2 register, 20-6
I ² S mode selection, 24-19	TCN1 register, 20-8
introduction, 24-1	TCN2 register, 20-8
operating modes	TCR1 register, 20-7
gated clock mode, 24-43	TCR2 register, 20-7
network mode, 24-41	TCTL1 register, 20-4
normal mode, 24-39	TCTL2 register, 20-4
operating modes, 24-38	TEN bit, 20-5
pin config software example, 24-7	Test reset pin signal, see TRST signal
pin configuration, 24-5	TESTREG1 register, 15-11
programming model, 24-7	TESTREGx register
receive data register, 24-12	LBC bit, 15-11
receive FIFO register, 24-12	RXCNT field, 15-11
receive shift register, 24-13	SSTATUS field, 15-11
reset and initialization procedure, 24-44	TXCNT field, 15-12
transmit FIFO register, 24-9	time-out status registers, see TSR n ,
transmit shift register, 24-9	Timer 1 control register, see TCTL1 register
SSI clocking	Timer 2 control register, see TCTL2 register
master / synchronous mode, 24-4	Timer capture register, see TCRx register
normal input mode, 24-4	Timer compare register, see TCMPx register
SSI control/status register, see SCSR register	Timer control registers, see TCTLx register
SSI FIFO control/status register, see SFCSR register	Timer counter register, see TCNx register
SSI option register, see SOR register	Timer enable, see TEN bit
SSI receive configuration register, see SRCR register	Timer prescaler registers, see TPRERx register
SSI time slot register, see STSR register	Timer status register, see TSTATx register
SSI transmit configuration register, see STCR register	TPRER1 register, 20-5
SSR_A register, 25-17	TPRER2 register, 20-5
SSR B register, 25-17	TRST signal, 6-3
SSR C register, 25-17	TSR <i>n</i> register
SSR D register, 25-17	ADDR field, 7-15
SSR_x register	BE1 bit, 7-15
SSR field, 25-17	BE2 bit, 7-15
STCR register, 24-21	BE3 bit, 7-15
stem PLL control register 0, see SPCTL0 register	BE4 bit, 7-15
Stopwatch Minutes Register see CNT register	MODULE EN field, 7-15
STPWCH register	RW bit, 7-15
CNT field, 18-16	TO bit, 7-15
STPWCH register, 18-15	TSR <i>n</i> register, 7-14
STSR register, 24-30	TSTAT1 register, 20-9
SWR bit, 20-4	TSTAT2 register, 20-9
	TUSR1_x register
SWR_A register, 25-23 SWR B register, 25-23	RDY bit, 21-40
SWR C register, 25-23	TXDATAREGx register
= •	DATA field, 15-6
SWR_D register, 25-23 SWR_x register	
	U
SWR bit, 25-23	
System control	UART
programming, 8-1	
MC9328MXS Reference Manual, Rev. 1	

Index-xii Freescale Semiconductor

baud rate	UARTX BRM incremental preset registers 1-4, see BIPRx_x
automatic detection logic, 21-17	register
binary rate multiplier (BRM)	UARTx BRM modulator preset registers 1-4, see BMPRxx
programming examples, 21-15	register
updating, 21-15	UARTx BRM modulator register, see UBMR_x register
binary rate multiplier (BRM), 21-15	UARTx Control register 1, see UCR1_x register
definitions	UARTx Control register 2, see UCR2 x register
clear to send, 21-7	UARTx Control register 4, see UCR4 x register
data carrier detect, 21-7	UARTx escape character register, see UESC x register
data set ready, 21-7	UARTx FIFO control register, see UFCR x register
data terminal ready, 21-6	UARTx Receiver register n, see URXDn x register
request to send, 21-5	UARTx status register 1, see USR1 x register
ring indicator, 21-7	UARTx Status register 2, see USR2 x register
UART receive, 21-8	UARTx Test register 1, see UTS_x register
UART transmit, 21-8	UART x transmitter register n, see UTXnD x register
DMA requests, 21-4	UBIR x register
escape sequence detection, 21-19	INC field, 21-46
features, 21-1	UBIR x register, 21-46
general definitions, 21-4	UBMR x register
infrared interface	= •
	MOD field, 21-47
description, 21-20	UBMR_x register, 21-47
receiving, 21-20	UBRC_x register
serial infrared mode (SIR), 21-20	BCNT field, 21-48
transmitting, 21-20	UBRC_x register, 21-48
interrupts, 21-4	UCR1_x register
introduction, 21-1	ADBR bit, 21-26
module interface signals, 21-2	ADEN bit, 21-26
operation	DOZE bit, 21-28
in low-power system states, 21-52	ICD field, 21-27
pin configuration, 21-3	IDEN bit, 21-26
programming model, 21-21	IREN bit, 21-27
receiver	RDMAEN bit, 21-27
description, 21-12	RRDYEN bit, 21-27
idle line detect, 21-13	RTSDEN bit, 21-27
receiving a BREAK condition, 21-14	SNDBRK bit, 21-27
vote logic	TDMAEN bit, 21-27
operation, 21-15	TRDYEN bit, 21-26
special case operation, 21-15	TXMPTYEN bit, 21-27
vote logic, 21-14	UARTCLKEN bit, 21-27
wake, 21-14	UARTEN bit, 21-28
RTS edge	UCR1_x register, 21-26
triggered interrupt, 21-6	UCR2 x register
sub-block description, 21-9	CTS bit, 21-30
transmitter	CTSC bit, 21-29
description, 21-10	ESCEN bit, 21-30
FIFO empty interrupt suppression, 21-11	ESCI bit, 21-29
ART 1, see UART	IRTS bit, 21-29
ART 2, see UART	PREN bit, 21-30
ART 3, see UART	PROE bit, 21-30
ART FIFO Control registers, 21-38	RTEC field, 21-30
ART x escape timer register, see UTIM_x register	RTSEN bit, 21-30
ART1 control register 3, see UCR3_1 register	RXEN bit, 21-31
ART1 control register 3, see UCR3_1 register ART2 control register 3, see UCR3_2 register ARTx baud rate count register, see UBRC_x register	SRST bit, 21-31 STPB bit, 21-30

.....,,,

Freescale Semiconductor Index-xiii

TXEN bit, 21-30	FRMERR bit, 21-24
WS bit, 21-30	OVRRUN bit, 21-23
UCR2_x register, 21-29	PRERR bit, 21-24
UCR3 1 register	RX DATA field, 21-24
AIRINTEN bit, 21-32	URXDn x register, 21-23
BPEN bit, 21-33	USB control register, see USB CTRL register
FRAERREN bit, 21-32	USB descriptor RAM address register, see USB_DADR
INVT bit, 21-33	register
PARERREN bit, 21-32	USB descriptor RAM/endpoint buffer data register, see
REF25 bit, 21-33	USB DDAT register
REF30 bit, 21-33	USB device port
RXDSEN bit, 21-32	aborted device request, 22-38
UCR3 1 register, 21-32	bulk traffic, 22-42
UCR3_2 register	catastrophic error, 22-39
AIRINTEN bit, 21-35	configuration download, 22-36
AWAKEN bit, 21-35	control logic, 22-5
	control logic, 22-3 control transfers, 22-42
BPEN bit, 21-35	
DCD bit, 21-34	data transfer operations, 22-39
DPEC field, 21-34	device initialization, 22-35
DSR bit, 21-34	endpoint FIFO architecture, 22-4
DTREN bit, 21-34	endpoint interrupts, 22-45
FRAERREN bit, 21-34	exception handling, 22-38
INVT bit, 21-35	features, 22-1
PARERREN bit, 21-34	general interrupts, 22-44
REF25 bit, 21-35	hard reset, 22-48
REF30 bit, 21-35	interrupt services, 22-44
RI bit, 21-34	interrupt traffic, 22-43
RXDSEN bit, 21-35	introduction, 22-1
UCR3_2 register, 21-34	isochronous operations, 22-43
UCR4_x register	module components, 22-2
BKEN bit, 21-37	pin configuration, 22-6
CTSTL field, 21-36	programmer's reference, 22-34
DREN bit, 21-37	programming model, 22-6
ENIRI bit, 21-36	reset operation, 22-47
INVR bit, 21-36	reset signaling, 22-48
IRSC bit, 21-37	signal description, 22-5
OREN bit, 21-37	software reset, 22-48
REF16 bit, 21-36	synchronization and transaction decode, 22-4
TCEN bit, 21-37	transceiver interface, 22-5
UCR4_x register, 21-36	UDC reset, 22-48
UESC_x register	unable to complete device request, 22-38
ESC_CHAR field, 21-44	USB packets, 22-39
UESC_x register, 21-44	USB transfers, 22-41
UFCR_x register	USB enable register, see USB_ENAB register
RFDIV field, 21-38	USB Frame Number and Match Register, see USB_FRAME
RXTL field, 21-39	register
TXTL field, 21-38	USB interrupt mask register, see USB MASK register
UFCR x register, 21-38	USB interrupt status register, see USB INTR register
universal asynchronous receiver/transmitter, see UART	USB Specification and Release Number Register, see
universal serial bus, see USB device	USB_SPEC register
URXDn_x register	USB Status Register, see USB_STAT register
BRK bit, 21-24	USB CTRL register
CHARRDY bit, 21-23	AFE ENA bit, 22-12
ERR bit, 21-23	CMD ERROR bit, 22-11

Index-xiv Freescale Semiconductor

CMD OVER bit, 22-11	FR bit, 22-27
RESUME bit, 22-12	FRAME bit, 22-29
UDC RST bit, 22-12	FRAME0 bit, 22-26
USB ENA bit, 22-11	FRAME1 bit, 22-26
USB SPD bit, 22-11	FRAME2 bit, 22-26
USB CTRL register, 22-11	FRAME3 bit, 22-27
USB DADR register	FULL bit, 22-27
BSY bit, 22-13	GR field, 22-29
CFG bit, 22-13	OF bit, 22-27
DADR field, 22-13	UF bit, 22-27
USB_DADR register, 22-13	WFR bit, 22-28
USB DDAT register	USB_EPx_FSTAT register, 22-26
DDAT field, 22-14	USB EPx FWRP register
USB_DDAT register, 22-14	WP field, 22-34
USB_EP x _STAT register	USB EPx FWRP register, 22-34
DIR bit, 22-19	USB EPx INTR register
USB EP0x MASK register	DEVREQ bit, 22-22
DEVREQ bit, 22-24	EOF bit, 22-22
EOF bit, 22-24	EOT bit, 22-22 EOT bit, 22-22
EOT bit, 22-24 EOT bit, 22-24	FIFO EMPTY bit, 22-21
FIFO EMPTY bit, 22-23	FIFO_ERROR bit, 22-21
FIFO_ERROR bit, 22-23	FIFO FULL bit, 22-21
FIFO FULL bit, 22-23	FIFO_FOLL bit, 22-21 FIFO HIGH bit, 22-21
<u> </u>	<u> </u>
FIFO_HIGH bit, 22-23	FIFO_LOW bit, 22-22
FIFO_LOW bit, 22-23	MDEVREQ bit, 22-22
MDEVREQ bit, 22-24	USB_EPx_INTR register, 22-21
USB_EP0x_MASK register, 22-23	USB_EPx_LRFP register
USB_EP1_STAT register, 22-19	LRFP field, 22-30
USB_EP2_STAT register, 22-19	USB_EPx_LRFP register, 22-30
USB_EP3_STAT register, 22-19	USB_EPx_LWFP register
USB_EP4_STAT register, 22-19	LWFP field, 22-31
USB_EP5_STAT register, 22-19	USB_EPx_LWFP register, 22-31
USB_EPx_STAT register	USB_FRAME register
BYTE_COUNT field, 22-19	FRAME field, 22-8
FLUSH bit, 22-20	MATCH field, 22-8
FORCE_STALL bit, 22-20	USB_FRAME register, 22-8
MAX bit, 22-20	USB_INTR register
SIP bit, 22-19	CFG_CHG bit, 22-16
TYP field, 22-20	FRAME_MATCH bit, 22-16
ZLPS bit, 22-20	MSOF bit, 22-15
USB_EPx_FALRM register	RES bit, 22-16
ALRM field, 22-32	RESET_START bit, 22-16
USB_EPx_FALRM register, 22-32	RESET_STOP bit, 22-16
USB_EPx_FDAT register	SOF bit, 22-15
RXDATA register, 22-25	SUSP bit, 22-16
TXDATA field, 22-25	WAKEUP bit, 22-15
USB_EPx_FDAT register, 22-25	USB_INTR register, 22-15
USB_EPx_FRDP register	USB_MASK register
RP field, 22-33	CFG_CHG bit, 22-17
USB_EPx_FRDP register, 22-33	FRAME_MATCH bit, 22-17
USB_EPx_FSTAT register	MSOF bit, 22-17
ALARM bit, 22-27	RES bit, 22-17
EMPTY bit, 22-27	RESET_START bit, 22-17
ERROR bit, 22-27	RESET_STO bit, 22-17

Freescale Semiconductor Index-xv

SOF bit, 22-17	$\bigcup I XnD_x$ register
SUSP bit, 22-17	TX_DATA field, 21-25
WAKEUP bit, 22-17	$UTXnD_x$ register, 21-25
USB_MASK register, 22-17	.,
USB_MCTL register	V
ENAB bit, 22-18	
RST bit, 22-18	VCR register
SUSPEND bit, 22-18	V_WAIT_1 field, 16-27
USB_SPEC register	V_WAIT_2 field, 16-27
SPEC field, 22-9	V_WIDTH field, 16-27
USB_SPEC register, 22-9	VCR register, 16-27
USB STAT register	Vertical configuration register, see VCR register
ALTSET field, 22-10	Virtual page width register, see VPW register
CFG field, 22-10	VPW register
INTF field, 22-10	VPW field, 16-22
RST bit, 22-10	VPW register, 16-22
SUSP bit, 22-10	147
USB_STAT register, 22-10	W
USR1 x register	
AIRINT bit, 21-41	WAT_RESET signal, 6-3
AWAKE bit, 21-41	Watchdog reset bit, see WDR bit
ESCF bit, 21-41	Watchdog timer reset, see WAT_RESET signal
FRAMERR bit, 21-41	WDR bit, 6-4
PARITYERR bit, 21-40	W-size register A, see WSRA register
RRDY bit, 21-41	W-size register B, see WSRB register
RTSD bit, 21-40	WSRA register, 13-16
RTSS bit, 21-40	WSRB register, 13-16
RXDS bit, 21-41	WSRx register
USR1 x register, 21-40	WS field, 13-16
USR2_x register	WUCR4_x register
ADET bit, 21-42	KEN bit, 21-36
BRCD bit, 21-43	V
DTRF bit, 21-42	X
IDLE bit, 21-42	Transaction According to
IRINT bit, 21-43	X-size register A, see XSRA register
ORE bit, 21-43	X-size register B, see XSRB register
RDR bit, 21-43	XSRA register, 13-17
RTSF bit, 21-43	XSRB register, 13-17
TXDC bit, 21-43	XSRx register
TXFE bit, 21-42	XS field, 13-17
WAKE bit, 21-43	Υ
USR2_x register, 21-42	ı
UTIM x register	V siza ragistar A saa VSD A ragistar
TIM field, 21-45	Y-size register A, <i>see</i> YSRA register Y-size register B, <i>see</i> YSRB register
UTIM x register, 21-45	YSRA register, 13-18
	YSRB register
UTS_x register	<u> </u>
FRCPERR bit, 21-51 LOOP bit, 21-51	YS field, 13-18
	YSRB register, 13-18
RXEMPTY bit, 21-51	
RXFULL bit, 21-51	
SOFTRST bit, 21-52	
TXEMPTY bit, 21-51	
TXFULL bit, 21-51	
UTS_x register, 21-51	

MC9328MXS Reference Manual, Rev. 1

Index-xvi

Freescale Semiconductor

Freescale Semiconductor Index-xvii

Index-xviii Freescale Semiconductor

Freescale Semiconductor Index-xix

Index-xx Freescale Semiconductor

Freescale Semiconductor Index-xxi

Index-xxii Freescale Semiconductor